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C. Y. Ho, M. W. Ackerman, K. Y. Wu, S. G. Oh, and T. N. Havill



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# Thermal Conductivity of Ten Selected Binary Alloy Systems

C. Y. Ho, M. W. Ackerman, K. Y. Wu, S. G. Oh, and T. N. Havill

Center for Information and Numerical Data Analysis and Synthesis, Purdue University, West Lafayette, Indiana 47906

This work reviews and discusses the available data and information on the thermal conductivity of ten selected binary alloy systems and presents the recommended values resulting from critical evaluation, analysis, and synthesis of the available data. The ten binary alloy systems selected are the systems of aluminum-copper, aluminum-magnesium, copper-gold, copper-nickel, copper-palladium, copper-zinc, gold-palladium, gold-silver, iron-nickel, and silver-palladium. The recommended values given include values of the total thermal conductivity, electronic thermal conductivity, and lattice thermal conductivity. The uncertainty of the values is generally of the order of  $\pm 10\%$ . The values for each of the alloy systems except two are given for 25 alloy compositions: 0.5, 1, 3, 5, 10(5)95, 97, 99, and 99.5%. For most of the alloy compositions, the values cover the temperature range from 4 K to the solidus temperature or 1200 K. In addition, reliable methods for the estimation of the electronic and lattice thermal conductivities of alloys have been developed in this study.

Key words: Alloys; conductivity; critical evaluation; data analysis; data compilation; data synthesis; electrical resistivity; metals; recommended values; thermal conductivity; thermoelectric power.

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## Nomenclature

<i>a</i>	Lattice constant
<i>e</i>	Electronic charge; base of natural logarithm (2.71828)
<i>E</i>	Electron energy
<i>E<sub>k</sub></i>	Energy of electron in <i>k</i> th state
<i>f(k)</i>	Distribution function representing the number of carriers in <i>k</i> th state
<i>f<sup>o</sup></i>	Fermi-Dirac distribution function at equilibrium
<i>h̄</i>	Reduced Planck constant
<i>I<sub>a</sub>, I<sub>b</sub>, I<sub>c</sub></i>	Transport integrals
<i>I<sub>n</sub></i>	Modified transport integrals
<i>J<sub>n</sub></i>	Standard transport integrals
<i>k</i>	Total thermal conductivity
<i>k<sub>e</sub></i>	Electronic thermal conductivity
<i>k<sub>ei</sub></i>	Intrinsic electronic thermal conductivity
<i>k<sub>g</sub></i>	Lattice thermal conductivity
<i>k<sub>u</sub></i>	Lattice thermal conductivity of a virtual crystal
<i>k</i>	Electron wave vector
<i>K</i>	Kelvin temperature unit
<i>K<sub>n</sub></i>	Electronic transport integrals
<i>L</i>	Lorenz function
<i>L<sub>0</sub></i>	Lorenz number ( $2.443 \times 10^{-8} V^2 K^{-2}$ )
<i>M</i>	Average atomic mass

<i>M<sub>H</sub></i>	Atomic mass of the heavier element
<i>M<sub>L</sub></i>	Atomic mass of the lighter element
<i>n</i>	Number of conduction electrons per atom
<i>S</i>	Absolute thermoelectric power
<i>T</i>	Temperature
<i>v</i>	Speed of sound
<i>v(E)</i>	Electron velocity in spherical symmetry
<i>v(k)</i>	Velocity of electron in <i>k</i> th state
<i>V</i>	Average atomic volume
<i>V<sub>H</sub></i>	Atomic volume of the heavier element
<i>V<sub>L</sub></i>	Atomic volume of the lighter element
<i>W<sub>e</sub></i>	Electronic thermal resistivity
<i>W<sub>ei</sub></i>	Intrinsic electronic thermal resistivity
<i>W<sub>e0</sub></i>	Residual electronic thermal resistivity
<i>W<sub>Hi</sub></i>	Contribution to <i>W<sub>ei</sub></i> of electrons moving parallel to the Fermi surface
<i>W<sub>Vi</sub></i>	Contribution to <i>W<sub>ei</sub></i> of electrons moving perpendicular to the Fermi surface
<i>ΔW</i>	Deviation from thermal analog of Matthiessen's rule
<i>x</i>	Reduced phonon frequency
<i>x<sub>0</sub></i>	Reduced phonon frequency at which the relaxation times for point-defect scattering and U-processes are equal
<i>y</i>	Atomic fraction of the solute

$y_H$	Atomic fraction of the heavier element
$y_L$	Atomic fraction of the lighter element
$\alpha$	Ratio of reciprocal relaxation times for N- and U-processes
$\beta$	Impurity-imperfection parameter of elements
$\gamma$	Grüneisen parameter
$\epsilon$	Quantity characterizing the perturbation due to mass defects and lattice distortion
$\zeta$	Fermi energy
$\eta$	Reduced electron energy
$\theta$	Debye temperature
$x$	Boltzmann constant
$\mu$	Ferromagnetic ordering parameter
$\rho$	Total electrical resistivity
$\rho^*$	Resistivity of ferromagnetic metal in the absence of ferromagnetic ordering
$\rho_0$	Residual electrical resistivity
$\rho_i$	Intrinsic electrical resistivity
$\Delta\rho$	Deviation of electrical resistivity from Matthiessen's rule
$\tau(k)$	Relaxation time for electron in $k$ th state
$\tau(E)$	Relaxation time for electron with energy $E$ in spherical symmetry
$\tau_c$	Combined relaxation time
$\tau_N$	Relaxation time for N-processes
$\tau_p$	Relaxation time for point-defect scattering
$\tau_U$	Relaxation time for U-processes
$\omega$	Frequency of lattice wave
$\omega_0$	Phonon frequency at which the relaxation times for point-defect scattering and U-processes are equal

## 1. Introduction

The primary objective of this study was to critically evaluate, analyze, and synthesize all the available data and information on the thermal conductivity of ten selected binary alloy systems and to generate recommended values over the widest practicable ranges of temperature and alloy composition for each of the alloy systems. The ten binary alloy systems selected are the systems of aluminum-copper, aluminum-magnesium, copper-gold, copper-nickel, copper-palladium, copper-zinc, gold-palladium, gold-silver, iron-nickel, and silver-palladium. Most of these alloy systems are among those for which the largest amounts of experimental data are available. However, it will become evident that even for these alloy systems serious gaps still exist in the thermal conductivity data, as concerns dependence on both composition and temperature, and that most of the available experimental data show large uncertainties or wide divergences. It was, therefore, necessary to set additional objectives: (1) to develop reliable methods for the estimation of the thermal conductivity of alloys, (2) to determine the extent to which the methods of data estimation developed in this study are applicable in general, and (3) to identify those areas where further theoretical and experimental research is needed.

The systems selected include all three different kinds of binary alloy systems: nontransition-metal and nontransition-metal systems (aluminum-copper, aluminum-magnesium, copper-gold, copper-zinc, and gold-silver), nontransition-metal

and transition-metal systems (copper-nickel, copper-palladium, gold-palladium, and silver-palladium), and a transition-metal and transition-metal system (iron-nickel). The inclusion of this wide range of alloy systems in this study has tested the broad applicability of the methods developed for data estimation and synthesis.

The resulting thermal conductivity values presented in this work include values of the total thermal conductivity, electronic thermal conductivity, and lattice thermal conductivity. These values are designated as recommended or provisional values depending upon the level of confidence placed on the values and, hence, upon the uncertainty of the values assigned. The ranges of uncertainties of recommended and provisional values are less than  $\pm 15\%$  and between  $\pm 15\%$  and  $\pm 30\%$ , respectively. Some of the lattice thermal conductivity values are designated also as typical values, of which the uncertainty is greater than  $\pm 30\%$ . It should be noted that most of the resulting values are designated as recommended values and the uncertainty of the values is generally of the order of  $\pm 10\%$ .

The values generated are for alloys which are not ordered and have not been cold worked severely; the values would be higher for ordered alloys and lower at low temperatures for cold-worked alloys.

The methods developed for the estimation of the thermal conductivity of alloys are detailed in section 2. These methods have been extensively tested with selected key sets of experimental data that are considered reliable through critical evaluation and analysis of the data and the details of measurement and through careful examination of the internal consistency of the data and the consistency with other data. In these methods the electronic and lattice components of thermal conductivity are estimated separately.

In alloys the principal carriers of thermal energy are electrons and phonons or lattice waves. At low temperatures the electrons are scattered mainly by solute atoms, and at higher temperatures the scattering of electrons by lattice waves becomes significant. The electronic thermal conductivity of an alloy is calculated from the electrical resistivity and thermoelectric power of the alloy and the electrical resistivity and thermal conductivity of the constituent elements.

At the lowest temperatures the lattice thermal conductivity of an alloy is limited by the phonon-electron interaction and phonon scattering by residual dislocations anchored in place by solute atoms; both of these resistive mechanisms result in approximately a  $T^2$  temperature dependence. At somewhat higher temperatures point-defect scattering and scattering by dislocation cores cause the lattice conductivity to depart from its  $T^2$  temperature dependence, and at still higher temperatures the combination of three-phonon anharmonic interactions and point-defect scattering cause the conductivity to decrease approximately as  $T^{-1/2}$ . The lattice thermal conductivity of a solid-solution alloy at temperatures above the region of its maximum can be calculated semi-theoretically based upon the Klemens-Callaway theory. At temperatures in the region of lattice conductivity maximum and below, however, there is no adequate method available for the calculation of the lattice thermal conductivity because the knowledge of both the phonon-electron coupling constant and the residual dislocation densities is lacking, and at present the

lattice thermal conductivity must be derived from experimental data.

In section 3 the procedures for data evaluation, analysis, synthesis, and the generation of recommended values are outlined, including the procedures for data estimation using the methods detailed in section 2. The copper-nickel alloy system is used as an example for illustration.

The values generated for the total thermal conductivity, electronic thermal conductivity, and lattice thermal conductivity of each of the ten selected binary alloy systems and the experimental thermal conductivity data and information are presented in section 4. In the discussion of the thermal conductivity of each alloy system, individual pieces of available data and information are reviewed, details of data analysis and synthesis are given, the considerations involved in arriving at the final assessment and recommendation are discussed, the recommended values and the experimental data are compared, and the uncertainties in the recommended values are stated. For each of the alloy systems except two (aluminum-magnesium and copper-zinc), the values are given for 25 alloy compositions: 0.5, 1, 3, 5, 10(5)95, 97, 99, and 99.5%, which greatly facilitates the interpolation of values for alloys with intermediate compositions. For most of the alloy compositions, the values cover the temperature range from 4 K to the solidus temperature or 1200 K.

At first sight many of the recommendations seem to be merely extensive extrapolations from a few sets of scattered experimental data, but in fact the recommended values for the electronic thermal conductivity are calculated from a large body of electrical resistivity data and those for the lattice thermal conductivity are calculated from well tested semi-theoretical methods.

Conclusions of the present study and recommendations for further experimental and theoretical research are given in section 5. The complete bibliographic citations for the 191 references are given in section 7.

## 2. Theoretical Background

In metals and alloys the principal carriers of thermal energy are electrons and lattice waves, and it is commonly assumed that the total thermal conductivity is

$$k = k_e + k_s, \quad (1)$$

where  $k_e$  is the electronic thermal conductivity and  $k_s$  is the lattice thermal conductivity; these are the thermal conductivity components due to the transport of heat by the electrons and by the lattice waves or phonons, respectively.

In most of the pure non-transition metals, conduction by lattice waves is negligible in comparison with conduction by electrons at all temperatures, but in alloys the lattice component is often comparable to and sometimes even greater than the electronic component at low temperatures and is not negligible even at temperatures well above the Debye temperature in some cases. Hence, in order to estimate the thermal conductivity of an alloy it is necessary to estimate both the electronic and lattice components. Since the principal ther-

mal resistance mechanisms differ in different temperature regions, it is necessary to devise different methods for making predictive estimates in different temperature regions. In the course of developing these methods a number of specific areas in which further experimental and theoretical studies are needed were identified.

### 2.1. Electronic Thermal Conductivity

In the alloys under consideration at temperatures below about 25 K the only significant contribution to the electronic thermal resistivity,  $W_e$ , is the scattering of electrons by solute atoms, so that the electronic thermal conductivity may be calculated from the Wiedemann-Franz-Lorenz relationship,

$$k_e = \frac{1}{W_e} \approx \frac{1}{W_{e0}} = \frac{L_0 T}{\varrho_0}, \quad (2)$$

where  $W_{e0}$  is the residual electronic thermal resistivity due to impurity scattering of electrons,  $\varrho_0$  is the residual electrical resistivity,  $T$  is the temperature, and  $L_0$  is the classical theoretical Lorenz number and has a value of  $2.443 \times 10^{-8} \text{ V}^2 \text{ K}^{-2}$ .

At higher temperatures the scattering of electrons by lattice waves becomes significant. At temperatures between about 25 K and 100 K the electronic thermal resistivity has commonly been estimated from the thermal analog of Matthiessen's rule,

$$W_e = W_{e0} + W_{ei} = \varrho_0 / L_0 T + W_{ei}, \quad (3)$$

where  $W_{ei}$  is the intrinsic electronic thermal resistivity, which is the reciprocal of the intrinsic electronic thermal conductivity,  $k_{ei}$ , of the "parent" element, and Matthiessen's rule states that the electrical resistivity is composed of a residual and an intrinsic component:

$$\varrho = \varrho_0 + \varrho_i. \quad (4)$$

Equation (3) is based on the assumption that the deviations from Matthiessen's rule,  $\Delta\varrho = \varrho - \varrho_0 - \varrho_i$ , and its thermal analog,  $\Delta W = W_e - W_{e0} - W_{ei}$ , can be neglected. This is not the case at higher temperatures;  $\Delta\varrho$  and  $\Delta W$  may be significant even at temperatures below 100 K. These deviations may be taken into account by assuming that they are related by the Wiedemann-Franz-Lorenz law:  $\Delta\varrho / \Delta W = LT$ , where  $L$  is the Lorenz ratio which may or may not be equal to  $L_0$ . This assumption is based on an argument by Klemens [1]<sup>1</sup> which may be summarized as follows.

The intrinsic electrical and thermal resistivities arise from interactions between electrons and phonons which take electrons from regions of momentum space where there are too many into regions where there are too few electrons relative to the equilibrium concentration. Since the phonon energies are relatively small, the electron energies are little changed by these interactions, and their initial and final states must both lie near the Fermi surface.

<sup>1</sup> Numbers in brackets designate references listed in section 7.

In the case of electrical conduction the deviation of the distribution function from the equilibrium distribution due to the electric field is proportional [2] to a function,  $f(\mathbf{k})$ , of the direction of the electron wave vector, the sign of the deviation depending on the direction of the electron wave vector. The intrinsic electrical resistivity,  $\rho_i$ , is the result of the motion of electrons in  $\mathbf{k}$  space through interactions with phonons to distant regions of the Fermi surface, involving substantial changes in the direction of  $\mathbf{k}$ , which is a "horizontal" movement on the Fermi surface.

In the case of thermal conduction, the deviation from the electronic equilibrium distribution due to the temperature gradient is proportional to the same function  $f(\mathbf{k})$  of the direction of the electron wave vector but it is also proportional to the reduced electron energy,  $\eta = (E - \xi)/kT$ ,  $E$  being the electron energy,  $\xi$  the Fermi energy, and  $k$  the Boltzmann constant. Thus the sign of the deviation of the distribution function can be changed not only by "horizontal" movement on the Fermi surface but also by changing the sign of  $\eta$ , which is a "vertical" movement through the Fermi surface. These motions in  $\mathbf{k}$  space contribute approximately additively to the intrinsic electronic thermal resistivity:  $W_e = W_{hi} + W_{vi}$ . Since  $f(\mathbf{k})$  is the same for electrical and thermal conduction, horizontal movement is equally effective in both cases, so that  $\rho_i$  and  $W_{hi}$  are related by the Wiedemann-Franz-Lorenz law. Now  $W_{vi}$  depends on a local property of the Fermi surface and is, therefore, relatively insensitive to changes in the band structure due to alloying. On the other hand  $W_{hi}$ , being due to motion of the electrons over large distances on the Fermi surface, is sensitive to changes in its overall shape, particularly when these changes involve contact with the zone boundary which effectively short circuits the horizontal movement. Hence the change in  $W_{hi}$  on alloying is much larger than the change in  $W_{vi}$  and makes the dominant contribution to the deviations from Matthiessen's rule. Thus, to a good approximation, the deviations from Matthiessen's rule and its thermal analog are related by the Wiedemann-Franz-Lorenz Law,

$$W_e = (\rho - \rho_i)/LT + W_{ei} \quad (5)$$

or

$$k_e = \frac{1}{(\rho - \rho_i)/LT + W_{ei}}. \quad (6)$$

In applying eq (6),  $W_{ei}$  and  $\rho_i$  are taken to be the intrinsic thermal and electrical resistivities of the virtual crystal obtained for alloys containing ordinary metals, by linear interpolation between the values for the elements. For alloys containing transition elements the intrinsic resistivities were interpolated according to Mott's theory [3,4]. In Mott's theory the holes in the  $d$  band of palladium, for example, are filled by the  $s$  electrons of the silver atoms. These  $d$  band holes act as traps into which the conduction electrons are scattered and account for the strong electron-phonon interaction in palladium-rich alloys. These holes are assumed to be filled when the silver concentration reaches 60 atomic percent so that the intrinsic resistivities for the silver-rich alloys

are taken to be those of silver and to increase linearly with palladium content for alloys containing less than 60 atomic percent silver.

For most alloys  $W_{ei}$  is much smaller than the other term in eq (6) so that the error introduced in common practice by taking  $W_{ei}$  of the elements to be the reciprocals of their total thermal conductivities is also small. However, in dilute alloys of elements which do not have electronic thermal conductivities comparable to those of the noble elements this error is significant, and  $W_{ei}$  is therefore calculated in this work from the expression

$$W_{ei} = \frac{1}{k_{ei}} = \frac{1}{k_e} - \frac{\beta}{T} = \frac{1}{k - k_g} - \frac{\beta}{T}, \quad (7)$$

where  $\beta$  is the impurity-imperfection parameter of the element. The values of  $k$  and  $\beta$  of the elements are available from ref. [5]<sup>2</sup> and the values of  $k_g$  of an element at moderate and high temperatures are calculated from eq (36). The values of electrical resistivities of the ten selected binary alloy systems and their nine constituent elements used in eq (6) are available from ref. [7].

From the argument leading to eq (6) it is clear that the value of  $L$  used therein should be that for horizontal motion on the Fermi surface, or for elastic scattering; the values of  $L$  appropriate for use in eq (6) and in the Wiedemann-Franz-Lorenz law, which one might expect to be valid at high temperatures where phonons scatter electrons through large angles, are discussed below.

It should be noted that eq (6) may not be valid in some cases. If the deviations from Matthiessen's rule are due to the fact that two bands of electrons, such as those on the neck and belly regions of the Fermi surface, contribute significantly to the electrical conduction, then, in general, the deviations from Matthiessen's rule and its thermal analog are not related by the Wiedemann-Franz-Lorenz law.

Significant deviations of the Lorenz ratio from its classical value can result from band structure effects and from electron-electron scattering.

The possibility of deviations due to band structure effects and the difficulties they present may be seen from the following. Assuming the existence of a relaxation time, the electronic transport properties can be expressed through integrals over reciprocal space of the form

$$K_n = -\frac{1}{3} \int \int \int v^2(\mathbf{k}) \tau(\mathbf{k})(E_k - \xi)^n \frac{\partial f^0}{\partial E_k} d^3k \quad (8)$$

which for spherical symmetry [182] reduces to

$$K_n = \frac{1}{12\pi^3\hbar} \int \int_{-\infty}^{\infty} v(E) \tau(E)(E - \xi)^n \frac{\partial f^0}{\partial E} dA dE. \quad (9)$$

Here  $\hbar$  is the reduced Planck constant,  $v$  is the electron velocity,  $\tau$  is the relaxation time,  $E$  is the electron energy,  $f^0$  is the Fermi-Dirac distribution function,  $\xi$  is the Fermi energy,

<sup>2</sup> The recommended values for the thermal conductivities of the elements given in ref. [5] in some cases are slightly different from those given in ref. [6], and the values given in ref. [5] are preferred and should be used whenever there is a difference.

and  $dA$  is an element of a constant energy surface in reciprocal space. In particular, the absolute thermoelectric power is given by

$$S = \frac{1}{eT} \frac{K_1}{K_0} \quad (10)$$

and the Lorenz ratio by

$$L = \frac{1}{e^2 T^2} \left[ \frac{K_2}{K_0} - \frac{K_1^2}{K_0^2} \right] = \frac{1}{e^2 T^2} \frac{K_2}{K_0} - S^2. \quad (11)$$

Because of the factor  $\partial f^0 / \partial E$  which is large only near  $\xi$ , the usual procedure is to expand each integrand in a Taylor series about  $\xi$ . Retaining only the leading term of the series leads to the result  $L = L_0 - S^2$ , where  $L_0$  is the classical theoretical Lorenz number. The values of  $L$  obtained from this result are used in eq (6) to give the equation employed in our calculations:

$$k_e = \frac{1}{\frac{e - e_i}{(L_0 - S^2) T} + W_{ei}}. \quad (12)$$

The values of absolute thermoelectric powers of the ten selected binary alloy systems used in eq (12) are available from ref. [40].

There is some question about the choice of  $L_0$  in the case of transition-element alloys. The difficulties occur also in the treatment of the pure transition metals, and will be reviewed briefly in that context.

If, as in the case of some transition metals, a narrow band with a high density of states overlaps the conduction band at the Fermi energy, then at high temperatures it is necessary to include higher order terms in the series and this will cause a deviation of the Lorenz ratio from the classical value. It is possible, at least in principle, to evaluate the second order terms from the thermoelectric power and the series expansion for the electrical conductivity (see Williams and Fulkerson, 1969 [8, pp. 443-7]). However, if the relaxation time is a strong function of energy, as is the case in transition metals on the assumption [9] that it may be written as the reciprocal of the product of the density of states and a scattering probability per unit time, then a Taylor series expansion about  $\xi$  may not be adequate to represent the integrand over the energy range  $xT$  at high temperatures. In such cases the integrals must be evaluated numerically. This has been done for Pd [10] and reasonable agreement between theory and experiment was obtained; the discrepancies were presumably due to electron-electron scattering [11, p. 412] which occurs in both ordinary and transition metals. In ordinary metals, normal electron-electron scattering, in which electron quasi-momentum is conserved, contributes to the thermal resistivity but not to the electrical resistivity and thus causes a negative deviation of the Lorenz ratio. Such a deviation has been observed in Cu [12,13]. In transition metals normal electron-electron interactions between  $s$  and  $d$  band electrons contribute to the electrical resistivity as well as to the thermal resistivity; these processes are very strong [14,15] and are generally thought to be responsible for the  $T^2$  temperature

dependence of the electrical resistivity observed in these metals at low temperatures. The deviation of the Lorenz ratio due to electron-electron scattering may either enhance or partially cancel the effects of band structure. The latter appears to be the case in the group VIII elements [16]. The deviations of the Lorenz ratio of transition metals due to band structure effects are significant and cannot yet be calculated directly; further, in order to calculate correlations between the electrical resistivity and the Lorenz ratio, the density of states function of the material must be known and there are difficulties in including the effects of electron-electron scattering in such an analysis.

The Wiedemann-Franz-Lorenz law is valid in alloys at very low temperatures where one need consider only impurity scattering, and in both metals and alloys at high temperatures where phonons scatter electrons through large angles. Equation (12) was developed in order to calculate the electronic component at intermediate temperatures. However, as is clear from the preceding discussion, in the case of transition-metal alloys there is considerable uncertainty about the values of the Lorenz ratio to be used in the Wiedemann-Franz-Lorenz law at high temperatures. The method tried was to interpolate for the deviation from the classical value on the basis of the questionable assumption that the net deviation resulting from band structure effects and  $s-d$  electron-electron scattering is proportional to the number of holes in the  $d$  band. It was found that in the Cu-Ni system the resulting values of  $k_e$  nowhere differed from those obtained from eq (12) by more than 5 percent and it was decided to use eq (12) over the entire temperature range above 25 K.

In view of the uncertainties associated with eq (12), it is reassuring that the values obtained from it have been found to be in good agreement with the values of the electronic component obtained from experimental values of thermal conductivity considered to be reliable on the basis of the usual criteria.

While a considerable amount of effort has been concentrated on the study of deviations from Matthiessen's rule, far less attention has been given to their relation to the deviations from its thermal analog [1,17,18,185]. Work in this area is hindered by the failure of many authors to include the corresponding electrical resistivity data when reporting thermal conductivity values. Further work in this area would help to determine the limitations of eq (12) and very probably lead to improvements on it.

## 2.2. Lattice Thermal Conductivity

The processes limiting lattice conduction are different in the temperature regions below, about, and above the temperature at which it has its maximum value. At very low temperatures, typically below one twentieth of the Debye temperature,  $\theta$ , these are the ordinary and impurity-induced electron-phonon interactions, and in strained specimens, phonon scattering by dislocations. These processes are also important in the temperature range in which the lattice component has its maximum value, typically between  $\theta/20$  and  $\theta/5$  for alloys of ordinary metals but considerably higher for some transition elements, but in this region point-defect scat-

tering and three-phonon anharmonic interactions also contribute to the thermal resistivity. At temperatures above this region the important resistive processes in alloys of ordinary metals are three-phonon anharmonic interactions and point-defect scattering; in alloys containing transition metals the effect of electron-phonon interactions may also be significant in the lower portion of this temperature range. This third region is the only one in which it is possible to estimate the lattice component on the basis of present theory.

#### a. Low Temperature Region

The problem of calculating the coupling constant for the electron-phonon interaction is a very difficult one even in the simplest cases; in fact, measurements of low temperature alloy thermal conductivity were initially undertaken to obtain information about this interaction. From results reported by Lindenfeld and Pennebaker [19] for Cu alloys it appeared that it might be possible to estimate the lattice component from electrical resistivity data on the basis of present theory. This did not prove to be the case. It was found that values obtained from an expression which follows from the equations in ref. [19] differed from those obtained from measurements by as much as a factor of three. It is almost certain that these discrepancies are largely the result of the use of Pippard's early results [20] which are based on the free electron model; this simple model is inadequate for most metals and alloys.

At temperatures below  $\theta/20$ , the lattice thermal conductivity of a pure ordinary metal may be calculated from an expression derived by Klemens [21]

$$k_l = \frac{313 k_{ei} T^4}{n^{4/3} \theta^4}, \quad (13)$$

where  $n$  is the number of conduction electrons per atom,  $\theta$  is the Debye temperature, and  $k_{ei}$  is the intrinsic electronic thermal conductivity. Since in this region  $k_{ei}$  is inversely proportional to  $T^2$ ,  $k_l$  has a  $T^2$  temperature dependence. Equation (13) is based on the assumption of a reciprocal effect of the electron-phonon interaction on electronic and lattice conduction and therefore does not apply to transition elements in which electron-phonon interactions involving only  $d$  band electrons have little effect on electrical conductivity but may have a significant effect on lattice conduction. It also does not apply to alloys in which the electron mean free path is so short that the usual treatment of the electron-phonon interaction is invalid; typically, these are alloys in which the residual resistivity is  $10 \mu\Omega \text{ cm}$  or greater.

However, if one attempts to estimate the  $k_l$  of an alloy from this expression the value obtained is greater than the experimental value by a factor which increases rapidly with solute concentration up to approximately 10 atomic percent. A possible explanation of this behavior is that it is due to phonon scattering by dislocations which are so strongly anchored by solute atoms that they remain even after prolonged annealing at high temperatures. The experimental support for this idea is some recent measurements on Cu-Al alloys at the University of Connecticut [22] which show that such behavior is not observed at temperatures below about 0.5K, where the domi-

nant phonon wavelengths are larger than the range of the dislocation strain fields so that scattering by dislocations is greatly reduced [23].

Consequently, at present one cannot make reliable estimates of the  $k_l$  of alloys at low temperatures and it must be obtained by subtracting  $k_e$  from the measured total thermal conductivity. Further, one can obtain reliable values of the  $k_l$  from thermal conductivity measurements only in those cases in which the corresponding values of electrical resistivity are given, as there is often a significant variation in the resistivities of specimens having the same nominal composition. It is unfortunate that while there is a sizable body of experimental data showing strong composition dependence of the low-temperature thermal conductivity of alloys, in most cases the corresponding values of the electrical resistivity are not reported, so that it is not possible to relate the changes in the two quantities. Finally, in view of the probability that residual dislocations are responsible for a large portion of the thermal resistivity, one cannot reliably extrapolate curves of the lattice component down to temperatures below about 1.5 K.

In order to make it possible to estimate the lattice component at low temperatures by other than empirical means, it is necessary to develop both a quantitative theory of impurity enhancement of the phonon scattering in alloys of ordinary metals and a theory of low temperature lattice conduction in transition element and high residual resistivity alloys. It seems that progress in these directions will involve the use of Pippard's more general equations [24] which apply to a non-spherical Fermi surface, taking into account changes in its shape with the addition of solutes. However, application of this theory to transition metals presents a difficult problem. Since electrical conduction is mainly by  $s$  band electrons, the residual resistivity is a measure of the mean free path of the  $s$  electrons and provides no information about the mean free path of the  $d$  band holes, which is probably very short.

#### b. Intermediate Temperatures

At temperatures near the maximum of the lattice component the resistive processes which limit lattice conduction at lower and higher temperatures are comparable in magnitude and the problem of estimating the lattice component in this region is a formidable one. It is, first, because of the difficulties associated with the electron-phonon interaction discussed above and, secondly, because the treatment of the resistive three-phonon anharmonic interaction in this region is complicated by the fact that here the strength of these interactions is a rapidly varying function of temperature.

At present there is no method available for the calculation of  $k_l$  in this temperature region. In this work the values of  $k_l$  in this region are derived from experimental data and the calculated values of  $k_e$ .

#### c. High Temperature Region

At temperatures above the region of the maximum of the lattice component, typically  $\theta/5$  for alloys of ordinary metals but considerably higher for some transition-element alloys, it

is possible to estimate the lattice thermal conductivity on the basis of a theory developed by Klemens [25] and Callaway [26] assuming that the effect of the electron-phonon interaction can be neglected; this is not the case for some transition elements in the lower portion of this temperature range.

The reciprocal relaxation time for the thermally resistive three-phonon anharmonic interactions, U-processes, at frequencies not too close to the Debye limit is of the form  $BT\omega^2$  where  $B$  is a constant determined from experiment,  $T$  is the temperature, and  $\omega$  is the frequency of the lattice wave. The reciprocal relaxation time for point-defect scattering is of the form  $(a^3/4\pi v^3) \epsilon \omega^4$  where  $a^3$  is the average volume per atom,  $v$  is the speed of sound, and  $\epsilon$  is a quantity which characterizes the perturbation due to mass defects and distortions of the lattice. In addition, there are three-phonon anharmonic interactions, N-processes, which do not contribute directly to the thermal resistivity but do contribute indirectly by redistributing energy from the low frequency modes to the high frequency modes which are strongly scattered by the point defects. The reciprocal relaxation time for N-processes has the same form as that for the U-processes and, as argued by Klemens et al. [27], appears to have approximately the same magnitude in this temperature region.

Since N-processes do not contribute directly to the thermal resistivity, the effective total reciprocal relaxation time is not simply the sum of the individual reciprocal relaxation times. Callaway devised a formalism in which the N-processes are effectively taken into account for steady state lattice conduction.

Callaway found that the lattice thermal conductivity is given by

$$k_s = \frac{x}{2\pi^2 v} \left( \frac{xT}{\hbar} \right)^3 \left( I_a + \frac{I_b^2}{I_c} \right), \quad (14)$$

where

$$I_a = \int_0^{x/T} \tau_c \frac{x^4 e^x}{(e^x - 1)^2} dx, \quad (15)$$

$$I_b = \int_0^{x/T} \frac{\tau_c}{\tau_N} \frac{x^4 e^x}{(e^x - 1)^2} dx, \quad (16)$$

$$I_c = \int_0^{x/T} \frac{1}{\tau_N} \left( 1 - \frac{\tau_c}{\tau_N} \right) \frac{x^4 e^x}{(e^x - 1)^2} dx, \quad (17)$$

and  $x$  and  $\hbar$  are the Boltzmann constant and the reduced Planck constant,  $v$  is the speed of sound, and  $x = \hbar \omega / xT$  is the reduced phonon frequency. Here  $\tau_c$  is a combined relaxation time, obtained as the reciprocal of the sum of the reciprocal relaxation times for the various interactions,  $\tau_N$  is the relaxation time for N-processes, and the term  $I_b^2/I_c$  occurs because of the difference between  $\tau_c$  and the effective total relaxation time resulting from the fact that N-processes do not contribute directly to the thermal resistivity.

Writing the reciprocal relaxation times for point-defect scattering, U-processes and N-processes as  $\tau_p^{-1} = A\omega^4$ ,  $\tau_U^{-1} = BT\omega^2$ , and  $\tau_N^{-1} = \alpha BT\omega^2$  respectively, where  $\alpha$  is the temperature-independent ratio of reciprocal relaxation times for N- and U-processes, the reciprocal combined relaxation

time when the lattice thermal conductivity is limited by these interactions is

$$\tau_c^{-1} = \omega^2 [A\omega^2 + BT(1+\alpha)], \quad (18)$$

so that

$$\frac{\tau_c}{\tau_N} = \frac{\alpha BT}{A\omega^2 + BT(1+\alpha)} \quad (19)$$

and

$$\begin{aligned} \frac{1}{\tau_N} \left( 1 - \frac{\tau_c}{\tau_N} \right) &= \alpha BT\omega^2 \left( 1 - \frac{\alpha BT}{A\omega^2 + BT(1+\alpha)} \right) \quad (20) \\ &= \frac{\alpha BT\omega^2 (A\omega^2 + BT)}{A\omega^2 + BT(1+\alpha)}. \end{aligned}$$

Upon denoting the frequency at which the reciprocal relaxation times for point-defect scattering and U-processes are equal by  $\omega_0$ , noting that  $\omega_0^2 = BT/A$ , and introducing the reduced frequency  $x = \hbar\omega/xT$ , so that  $x_0 = \hbar\omega_0/xT$ , these relations become:

$$\tau_c^{-1} = BT\omega^2(1+\alpha + \omega^2/\omega_0^2) \quad (21)$$

$$= BT \left( \frac{xT}{\hbar} \right)^2 x^2 (1+\alpha + x^2/x_0^2),$$

$$\frac{\tau_c}{\tau_N} = \frac{\alpha}{1+\alpha + \omega^2/\omega_0^2} = \frac{\alpha}{1+\alpha + x^2/x_0^2}, \quad (22)$$

and

$$\begin{aligned} \frac{1}{\tau_N} \left( 1 - \frac{\tau_c}{\tau_N} \right) &= \frac{\alpha BT\omega^2(1+\omega^2/\omega_0^2)}{1+\alpha + \omega^2/\omega_0^2} \quad (23) \\ &= \alpha BT \left( \frac{xT}{\hbar} \right)^2 x^2 \frac{(1+x^2/x_0^2)}{1+\alpha + x^2/x_0^2}. \end{aligned}$$

Thus, for the present case, eqs (15) to (17) become:

$$\begin{aligned} I_a &= \left( \frac{\hbar}{xT} \right)^2 \frac{1}{BT} \int_0^{x/T} \frac{x^2 e^x dx}{(e^x - 1)^2 (1+\alpha + x^2/x_0^2)} \\ &= \left( \frac{\hbar}{xT} \right)^2 \frac{1}{(1+\alpha)BT} \int_0^{x/T} \frac{x^2 e^x dx}{(e^x - 1)^2 \left[ 1 + \frac{x^2}{x_0^2(1+\alpha)} \right]} \\ &= \left( \frac{\hbar}{xT} \right)^2 \frac{1}{(1+\alpha)BT} I_2(\theta/T) \end{aligned} \quad (24)$$

$$I_b = \alpha \int_0^{x/T} \frac{x^4 e^x dx}{(e^x - 1)^2 (1+\alpha + x^2/x_0^2)} = \frac{\alpha}{(1+\alpha)} I_4(\theta/T) \quad (25)$$

$$\begin{aligned} I_c &= \left( \frac{xT}{\hbar} \right)^2 \alpha BT \int_0^{x/T} \frac{x^6 e^x (1+x^2/x_0^2) dx}{(e^x - 1)^2 (1+\alpha + x^2/x_0^2)} \\ &= \left( \frac{xT}{\hbar} \right)^2 \frac{\alpha BT}{(1+\alpha)} \left[ I_6(\theta/T) + \frac{I_8(\theta/T)}{x_0^2} \right] \end{aligned} \quad (26)$$

Substituting eqs (24) to (26) into eq (14) yields

$$k_g = \frac{\kappa^2}{[2\pi^2 \hbar v (1+\alpha) B]} \times \left[ I_2(\theta/T) + \frac{\alpha I_4^2(\theta/T)}{I_6(\theta/T) + I_8(\theta/T)/x_0^2} \right] \quad (27)$$

where  $I_n(\theta/T)$  is the modified transport integral given by

$$I_n(\theta/T) = \int_0^{\theta/T} \frac{x^n e^x dx}{(e^x - 1)^2 \left[ 1 + \frac{x^2}{x_0^2 (1+\alpha)} \right]} \quad (28)$$

and  $x_0$  is the reduced frequency at which the reciprocal relaxation times for U-processes and point-defect scattering are equal; that is (see eq (32))

$$x_0 = \hbar \omega_0 / \kappa T = \frac{\hbar}{\kappa} \sqrt{\frac{4\pi v^3 B}{a^3 \epsilon T}} \quad (29)$$

Equation (27) is for the lattice thermal conductivity as limited by both point-defect scattering and three-phonon anharmonic interactions. In the limit of vanishing point-defect scattering, when the thermal conductivity is limited by three-phonon anharmonic interactions only (denoted by  $k_u$ ),  $x_0$  becomes infinite so that the modified transport integral  $I_n(\theta/T)$  reduces to the standard transport integral  $J_n(\theta/T)$  and eq (27) reduces to

$$k_u = \frac{\kappa^2}{[2\pi^2 \hbar v (1+\alpha) B]} [J_2(\theta/T) + \alpha J_4^2(\theta/T) / J_6(\theta/T)], \quad (30)$$

where

$$J_n(\theta/T) = \int_0^{\theta/T} x^n e^x dx / (e^x - 1). \quad (31)$$

$k_u$  is the high-temperature lattice thermal conductivity of an isotopically pure element; in the case of an alloy it is the lattice thermal conductivity of an idealized "virtual" crystal in which each atom has the same average mass and volume of the alloy. Point defect scattering is that scattering which results from the fact that the actual atoms do not have these masses and volumes. The tabulated values for  $J_n$  are available from the literature [186].

The quantity  $\epsilon$  in the expression for the reciprocal relaxation time for point-defect scattering,

$$\tau_p^{-1} = \frac{a^3}{4\pi v^3} \epsilon \omega^4 \quad (32)$$

is calculated from the expression

$$\epsilon = y_L \left[ \frac{M_L - M}{M} + \gamma \left( \frac{V_L - V}{V} \right) \right]^2 + y_H \left[ \frac{M_H - M}{M_H} + \gamma \left( \frac{V_H - V}{V} \right) \right]^2, \quad (33)$$

where  $M$  and  $V$  are the average atomic mass and volume,  $y_L$ ,  $M_L$ , and  $V_L$  are the atomic fraction, mass, and volume of the lighter element,  $y_H$ ,  $M_H$ , and  $V_H$  are the corresponding values for the heavier element, and  $\gamma$  is the Grüneisen parameter.  $M$  is calculated in the usual way,  $\gamma$  is obtained by linear interpolation, and  $V$  is estimated from Vegard's law,

$$V^{1/3} = y V_1^{1/3} + (1-y) V_2^{1/3}, \quad (34)$$

where  $y$  is the atomic fraction of the solute and  $V_1$  and  $V_2$  are the atomic volumes of the solute and solvent elements respectively. The mass defect terms are based on the results of Klemens [28] and Tavernier [29] who respectively treated the case of a light atom in a heavy matrix and that of a heavy atom in a light matrix. The difference lies in the response of the atom to the driving frequency of a wave; in the former case the atom can respond rapidly enough that the speed of oscillation may be considered unaffected so that the perturbation is proportional to the deviation from the average mass while in the latter case it is better to consider the momentum as being unaffected so that the perturbation is proportional to the difference of the reciprocals of the average and impurity masses. The distortion terms and the form of  $\epsilon$  are based on the results of Ackerman and Klemens [30] who rediscovered the fact, as Carruthers [31] first noted and contrary to what is often stated, that the displacement field of a spherical impurity in an elastic continuum has a non-vanishing non-uniform dilation and used a treatment that retained the phase relationship between the effects of the dilation and mass defect. Equation (33) does not take into account the difference,  $\Delta f$ , in the force constant due to the mismatch of atomic bonds; however, neutron scattering and Mössbauer experiments [32,33] indicate that  $\Delta f$  is very small.

The coefficient in eq (27) is the same as the coefficient in eq (30) and is estimated from the latter. This is done by estimating  $\theta$  in the manner described below, estimating  $k_u$  of the virtual crystal at some temperature  $T'$  below the Debye temperature, for want of something better, by linear interpolation between the values for the elements, and taking  $\alpha$  equal to unity; it has been found that the values of  $k_g$  are not sensitive to small changes in  $\alpha$ . Then  $k_g$  is estimated from the expression

$$k_g = k_u(T') \times$$

$$\frac{I_2(\theta/T) + I_4^2(\theta/T) / [I_6(\theta/T) + I_8(\theta/T)/x_0^2]}{J_2(\theta/T') + J_4^2(\theta/T') / J_6(\theta/T')}, \quad (35)$$

which, for a pure element, reduces to

$$k_g = k_u(T') \frac{J_2(\theta/T) + J_4^2(\theta/T) / J_6(\theta/T)}{J_2(\theta/T') + J_4^2(\theta/T') / J_6(\theta/T')}. \quad (36)$$

Equations (35) and (36) are the equations used in our calculations for the lattice thermal conductivity of alloys and of pure elements, respectively. It should be noted that eq (35) applies only to disordered solid-solution alloys.

The accuracy of the estimates obtained from eq (35) clearly depends on the accuracy of the values of  $k_u$  for the virtual crystal. Experimental values of  $k_u$  for the elements, which essentially are the values of the lattice component of very dilute alloys, are available for only three of the metals included in this study: Cu, Au, and Ag. However, it was found that the experimental values for these metals each differed from the values obtained from the modified [34] Leibfried-Schlömann [35] equation by approximately the same factor. Accordingly initial estimates of the values of  $k_u$  for the other elements were obtained from this equation multiplied by the reciprocal of that factor, i.e.,

$$k_u T' = 5.7 \times 10^{-8} \frac{M \theta^3 V^{\frac{1}{3}}}{(\gamma + 0.5)^2}, \quad (37)$$

where  $M$ ,  $\theta$ ,  $\gamma$ , and  $V$  have the same meanings as before. It is unfortunate that in this equation the Debye temperature is raised to the third power, as the high temperature values of the Debye temperature obtained from various physical properties differ considerably. The values of the Debye temperatures and other parameters used in eq (37) for the nine elements constituting the ten selected binary alloy systems covered in this work are given in table 1.

TABLE 1. Parameters for the calculation of lattice thermal conductivity of elements using equation (37)<sup>a</sup>

Element	$M$ (g mol <sup>-1</sup> )	$V$ (cm <sup>3</sup> mol <sup>-1</sup> )	$\gamma$	$\theta$ (K)
Aluminum	26.98154	10.00 <sup>b</sup>	2.18	385
Copper	63.54	7.114	1.97	313 <sup>c</sup>
Gold	196.9665	10.22	3.09	160
Iron	55.847	7.094	1.81	373
Magnesium	24.305	14.00 <sup>d</sup>	1.63	363
Nickel	58.71	6.593	2.00	355
Palladium	106.4	8.879	2.18	264
Silver	107.868	10.27	2.46	213 <sup>e</sup>
Zinc	65.38	9.165 <sup>d</sup>	2.05	326

<sup>a</sup> The values of  $\gamma$  and  $\theta$  are selected from ref. [36] with some of the values adjusted in order to be consistent with the experimental thermal conductivity data.

<sup>b</sup> In calculating  $\epsilon$ , the molar volumes used for aluminum were 8.576 and 9.032. The first value corresponds to the size of aluminum atoms in copper as determined from the change in the lattice parameter of copper upon the addition of aluminum [37, Vol. 1]. The second value was obtained from the change in the volume of the primitive cell upon the addition of aluminum to magnesium as calculated from the changes in the lattice parameters of magnesium upon the addition of aluminum [37, Vol. 2].

<sup>c</sup> In calculating  $\epsilon$ , the molar volume used for magnesium was 13.77 corresponding to the size of magnesium atoms in aluminum as determined from the change in the lattice parameter of aluminum upon the addition of magnesium [37, Vol. 2].

<sup>d</sup> In calculating  $\epsilon$ , the molar volume used for zinc was 8.534 corresponding to the size of zinc atoms in copper as determined from the change in the lattice parameter of copper upon the addition of zinc [37, Vol. 2].

<sup>e</sup> This value was not used for the Cu-Ni and Cu-Zn alloy systems (see sections 4.3 and 4.6).

<sup>f</sup> This value was not used for Ag-Pd alloy system (see section 4.10).

While in some cases it was possible to improve on the initial estimates of  $k_u$  for some elements on the basis of experimental data for a range of compositions, in others it was not, and the estimates of the lattice thermal conductivities of alloys containing the latter elements are accordingly less reliable than those containing the former. While measurements of the thermal conductivity of very dilute alloys of additional elements would make possible more reliable estimates of alloy lattice thermal conductivity, in view of the uncertainty of the separation of the electronic and lattice components of very dilute alloys at temperatures above that of the maximum of the lattice component, it would also be useful to have measurements of the thermal conductivity of some more concentrated alloys of pairs of these elements in this temperature range.

The value of the Debye temperature,  $\Theta$ , for the upper limit of the integrals in eq (35) is estimated from the value of  $k_u$  for the virtual crystal by means of the modified Leibfried-Schlömann equation, adjusted to yield values for the lattice component in agreement with those obtained from experimental data on very dilute alloys as described above:

$$\theta = 260 \left[ \frac{(\gamma + 0.5)^2 k_u T}{MV^{\frac{1}{3}}} \right]^{\frac{1}{3}}, \quad (38)$$

where  $\gamma$  is the Grüneisen parameter, and  $M$  and  $V$  are the average molar mass and volume.

Agreement between the values obtained from eq (35) and those obtained from measurements of thermal conductivity for the various alloy systems is discussed in the text; in general, it was better for alloy systems exhibiting complete solid solubility. Another general result is that the values from eq (35) for dilute alloys tended to be too low at the low end of this temperature range. A possible explanation of this discrepancy is that the present treatment does not take into account the "freezing out" of U-processes which occurs when the temperature is reduced to the point at which there are few phonons having wave vectors of sufficient length to participate in such processes. Such a reduction in U-processes could significantly reduce the thermal resistivity of dilute alloys but cause only a small decrease in the thermal resistivity of dense alloys.

The most important deficiency of the present treatment is that the analysis leading to eq (35) does not include the electron-phonon interaction, for which an adequate theory has not yet been developed. It is for this reason that, in the absence of experimental data, the lattice component of the transition-element-rich alloys could be reported only at temperatures above their Debye temperature.

At high temperatures the values obtained from eq. (35) are nearly the same as those from an approximate expression derived independently by Abeles [38] and Parrott [39], but there are significant differences below the Debye temperature, where the high temperature approximation used by these authors,

$$x^2 e^x / (e^x - 1) \approx 1$$

ceases to be valid. However, because of a partial cancellation of errors these differences are much smaller than might be

expected from the use of the high temperature approximation.

The use of eq (35) rather than an approximate expression for the calculation of the lattice thermal conductivity is to some extent a reflection of the present availability of high-speed digital computers. The expression for the quantity  $\epsilon$ , eq (33), which takes into account the point-defect scattering due to both the mass difference and the distortion of the lattice and is first derived and given in the present work, is definitely an improvement of the theory.

### 3. Data Evaluation and Generation of Recommended Values

Due to the difficulties in accurate measurement of the thermal conductivity of solids and in adequate characterization of test specimens, the available experimental data on the thermal conductivity of solids from the world literature are in many cases widely divergent and subject to large uncertainty. It is, therefore, very important to critically evaluate the validity and reliability of the available data and related information, to resolve and reconcile the disagreements in conflicting data, and to generate recommended values. For the thermal conductivity of alloys, furthermore, there are serious gaps in the experimental data for either the temperature dependence or composition dependence or both. Hence, in addition to the critical evaluation and analysis of the existing data, methods for the calculation of the thermal conductivity of alloys were developed, as detailed in section 2, in order to generate estimated or synthesized values for filling the gaps in data and for checking the validity, consistency, and reliability of experimental data. These methods are essentially semi-empirical and require experimental information as input for calculations and adjustments. The reliability of these methods has been extensively tested by using selected key sets of reliable experimental data on alloys in various binary alloy systems.

In the critical evaluation of the validity and reliability of a particular set of thermal conductivity data, the temperature dependence of the data was examined and any unusual dependence or anomaly carefully investigated, the experimental technique was reviewed to see whether the actual boundary conditions in the measurement agreed with those assumed in the theory and whether all the stray heat flows and losses were prevented or minimized and accounted for, the reduction of data was examined to see whether all the necessary corrections had been appropriately applied, and the estimation of uncertainties was checked to ensure that all the possible sources of errors had been considered.

Experimental data could probably be judged to be reliable only if all sources of systematic error had been eliminated or minimized and accounted for. Major sources of systematic error include unsuitable experimental method, poor experimental technique, poor instrumentation and poor sensitivity of measuring devices, sensors, or circuits, specimen and/or thermocouple contamination, unaccounted for stray heat flows, incorrect form factor, and perhaps most important, the mismatch between actual experimental boundary conditions and those assumed in the analytical model used to derive the

values of thermal conductivity. These and other possible sources of errors were carefully considered in critical evaluation of experimental data.

The uncertainty of a set of data depends, however, not only on the estimated error or inaccuracy of the data but also on the inadequacy of characterization of the material for which the data are reported. For instance, suppose a set of thermal conductivity data obtained for a severely cold-worked specimen of brass with a composition of 70.06% Cu, 28.77% Zn, and 1.17% Pb is accurate to within 5% at low temperatures. If the author knew and reported his specimen only as 70:30 brass, the uncertainty of his data for a 70:30 brass would not be just 5% but might exceed 20%. It was found in this and other studies that the chemical composition of a specimen reported by the author is often unreliable. This may be because in many cases the stated composition was the result of ladle analysis which the author obtained from the company who supplied the specimen and it could at best represent only the nominal composition; the actual composition varied from sample to sample. In other cases there was a strong tendency for only certain elements to be detected by a particular chemical analysis which could miss other important constituents. Furthermore, the chemical composition of a specimen might change when it was measured at high temperatures. For binary alloys it was found that in many cases the actual composition of a specimen might better be inferred from its electrical resistivity if reported.

In the process of critical evaluation of experimental data described above, erroneous data were eliminated. The remaining data were then subjected to further analysis and used for data synthesis. For those test specimens for which experimental data on both the thermal conductivity and electrical resistivity were reported, the electrical resistivity data were used for the calculation of electronic thermal conductivity values using eq (12). Lattice thermal conductivity values were derived as the differences of the experimental  $k$  data and the calculated  $k_e$  values. These "experimental"  $k_e$  values derived from different sets of experimental  $k$  data were then intercompared with one another and also compared with the calculated values from eq (35) regarding their temperature dependence and magnitude. During these comparisons, the validity and reliability of the available experimental data could further be judged. The electrical resistivity data reported for the test specimens on which thermal conductivity measurements were made were also evaluated critically in connection with evaluation of all the electrical resistivity data available from the literature for each of the alloy systems, from which the recommended electrical resistivity values were generated.

As detailed in section 2, values of the electronic thermal conductivity of alloys were calculated from eq (12), which is applicable to alloys in both the solid solution region and the mechanical mixture region. In this calculation, the recommended electrical resistivity values for the selected compositions of the present ten alloy systems and their constituent elements are available from ref. [7], the recommended thermoelectric power values are available from ref. [40], the recommended thermal conductivity values and the values of  $\beta$  for the elements are available from ref. [5], and the lattice thermal conductivity values of the elements used as correc-

tions in the calculation of  $W_{ei}$  from eq (7) are calculated from eq (36).

Values of the lattice thermal conductivity of alloys in the region of solid solubility were calculated from eq (35). The values of  $k_u$  of the virtual crystals of alloys used in eq (35) for calculations were obtained by linear interpolation between the values of  $k_u$  of the two constituent elements. In the initial calculations, the  $k_u$  values of elements used for generating the  $k_u$  values of alloys were either the experimental values if available or the calculated values from eq (37). The values of the Debye temperature for the upper limit of the integrals in eq (35) were estimated from eq (38). It is important to note that eq (35) is applicable only to disordered solid-solution alloys and only for moderate and high temperatures. Beyond the solid solution region and at low temperatures, the lattice thermal conductivity was first obtained as the difference of the experimental total thermal conductivity and the calculated electronic thermal conductivity. The "experimental"  $k_e$  values so obtained were then graphically smoothed and synthesized to obtain the  $k_e$  values for alloys of the selected compositions. In the solid-solution region and at moderate and high temperatures, the "experimental"  $k_e$  values were used to check the  $k_e$  values calculated from eq (35). If there were disagreements and the "experimental"  $k_e$  values were considered reliable, the  $k_u$  values of elements would be adjusted so that the calculated  $k_e$  values of alloys were in agreement with the "experimental"  $k_e$  values.

In some instances only the total thermal conductivity, obtained by smoothing experimental data, and the electronic component, obtained from eq (12), are given. In these cases the user is cautioned against obtaining the lattice component by subtraction as this may lead to unphysical values for the lattice component due to the uncertainties in the tabulated values.

For alloys not consisting of a continuous series of solid solutions the values of the thermal conductivity are derived from the experimental data on specimens in which the solid solution phase is presumably frozen in. This may not be the case for all specimens and the results may not be quite reproducible; this is particularly true for the Al-Cu and Al-Mg alloy systems. For this reason, the values in the temperature range in which the phase structure is uncertain are provisional rather than recommended.

In graphical smoothing and synthesis of data, crossplotting from conductivity versus temperature to conductivity versus composition and vice versa was often used. Smooth curves were drawn which approximate the best fit to the conductivity data versus temperature, and points from the smoothed curves were used to construct conductivity versus composition curves for a convenient set of selected temperatures. In the conductivity versus composition graph, the families of isotherms were similar and any required smoothing of the data could be done more easily and with greater confidence than when working directly with the conductivity-temperature curves. The points from the smoothed curves were then used to construct conductivity-temperature curves for the selected compositions, and these curves were further smoothed. In the graphical smoothing process it is extremely important that the alloy phase dia-

grams [104,183,184] be constantly consulted and the phase boundaries between solid solutions and/or mechanical mixtures and the boundaries of magnetic transitions be kept in mind, so as to be aware of any possible discontinuity or sudden change of slope in the thermal conductivity curves.

The total thermal conductivity values were thus obtained as the sum of the  $k_e$  values calculated from eq (12) and the  $k_e$  values derived from the "experimental"  $k_e$  values or calculated from eq (35), which might have been adjusted to fit the "experimental"  $k_e$  values if such values were available and reliable.

The copper-nickel alloy system is here used as an example to show some of the input data used for calculations and to illustrate some of the points discussed above. The recommended electrical resistivity values for the Cu+Ni alloys and for the Ni+Cu alloys are shown separately in figures 1 and 2; these were used in eq (12) for the calculation of the electronic thermal conductivity values. These electrical resistivity values were generated from both the electrical resistivity data reported for the test specimens on which thermal conductivity measurements were made and those extracted from the electrical resistivity literature for all other alloys of the copper-nickel system. As shown in figure 2, the electrical resistivity versus temperature curves for Ni+Cu alloys change slope abruptly at the Curie temperature of the alloys. The Curie temperature decreases as the concentration of copper in the alloy increases. The ferromagnetism disappears and the Curie temperature drops to zero as the concentration of copper reaches 61.88% (60 At.%). The insert in figure 2 shows the Curie temperature as a function of percent copper in nickel, which is a straight line for the atomic percent of copper. Since the behavior of the electrical resistivity of these alloys has a direct bearing on the behavior of the thermal conductivity, the knowledge of the former is important to the understanding of the latter.

The recommended thermoelectric power values for the Cu+Ni alloys and for the Ni+Cu alloys are shown separately in figures 3 and 4; these were likewise used in eq (12) for calculation. Figure 4 shows also the Curie temperature of each alloy as the point at which the slope of the curve changes abruptly.

In order to demonstrate the validity and reliability of the methods developed for the calculation of the thermal conductivity of alloys, a graphical comparison of the calculated values with the experimental data for the thermal conductivity of some of the alloys of the copper-nickel alloy system is given in figure 5. The calculated values for each alloy are shown as a short-dashed curve which is paired with the experimental curve for the same alloy. For each of these alloys both the experimental thermal conductivity and electrical resistivity data are available, and the calculated thermal conductivity values were obtained by using the author's electrical resistivity data directly for the calculation of the electronic component, with the lattice component obtained by quadratic interpolation of the lattice thermal conductivity values given in table 11 for the selected fixed compositions. The measurement information on these alloys can be found in table 12 for the Cu+Ni alloys and table 13 for the Ni+Cu alloys by referring to the corresponding curve numbers indicated in figure 5.

It can be seen from figure 5 that the calculated values agree very well with the data of Smith and Palmer [49] (Cu+Ni curves 6 and 7), of Berman [70] (Cu+Ni curve 21), of Mikryukov [144] (Cu+Ni curve 43), and of Kierspe [83] (Cu+Ni curve 67) to within 1 to 2%, agree with the data of Barratt [127] (Cu+Ni curve 12), of Zimmerman [130] (Cu+Ni curve 17), and of Aoyama and Ito [134] (Cu+Ni curve 36) to within 3 to 5%, and agree with the data of Smith [45] (Ni+Cu curve 3) to within 6%. The calculated values are in agreement to within 4% with the data of Grüneisen and Goens [128] (Cu+Ni curve 13) at 83 K but are 10% above their data at 21 K. Their experimental data at 21 K is believed to be low since this thermal conductivity data is inconsistent with their electrical resistivity data and since their other similar measurements at 21 K on Cu+Au, Au+Cu, Cu+Pd, and Pd+Cu alloys are also low.

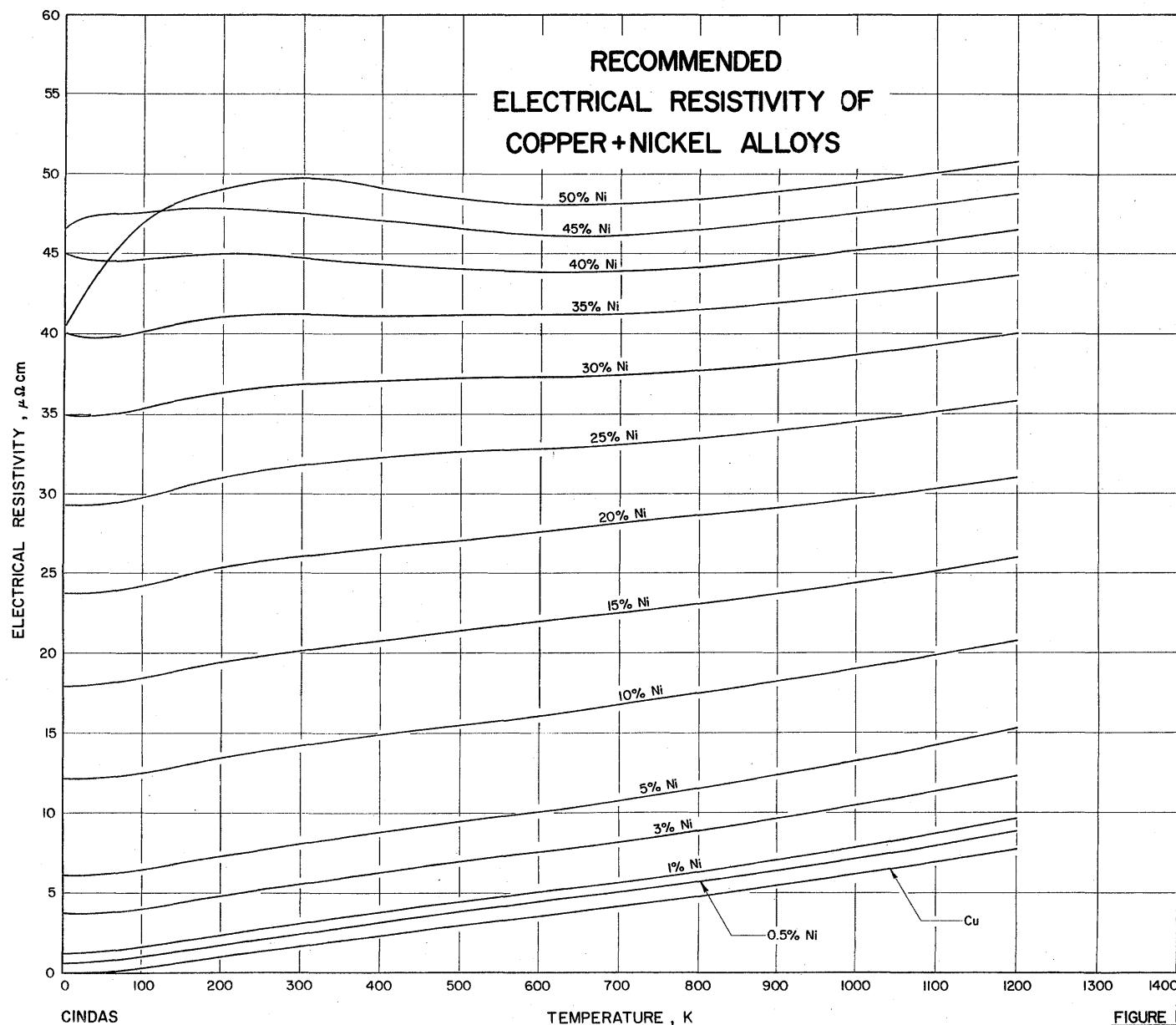
The data of Sager [77] (Cu+Ni curves 10 and 11) are good examples for showing the inconsistency between the thermal conductivity and the electrical resistivity data and for convincing that calculated thermal conductivity values can be much more accurate than the experimental data. At the lower temperature end the differences between Sager's data and the thermal conductivity values calculated from his own electrical resistivity data for the two alloys are only 3% (Cu+Ni curve 10) and 7% (Cu+Ni curve 11). At higher temperatures, however, his data increase very rapidly, and the differences reach 31% and 104% at 990 K. By comparing the slopes of his two experimental curves with those of other curves, it is apparent that his thermal conductivity measurements were much in error, which might very well be due to radiation heat loss in his measurements.

Greig and Harrison [78] did not report electrical resistivity data for their alloys directly and the data used for calculation were derived from reported Lorenz number and thermal conductivity data. This may cause some of the differences between their experimental thermal conductivity data (Ni+Cu curves 11 and 12) and the calculated values, which mostly amount to 5 to 15%. The discontinuity at 15 K in the calculated thermal conductivity values for Ni+Cu curve 11 is due to the discontinuity in the electrical resistivity data used for

calculation, but in reality there should be no such discontinuity at 15 K.

As mentioned earlier, for those alloys for which experimental data on both thermal conductivity and electrical resistivity were reported, the electrical resistivity data were used for the calculation of  $k_e$  values from eq (12), and  $k_e$  values were derived as the differences of the experimental  $k$  data and the calculated  $k_e$  values. Such derived "experimental"  $k_e$  values for the copper-nickel alloy system at 300 K are shown in figure 6 as data points, together with the calculated  $k_e$  values from eq (35) shown as a solid curve. The magnitude of the calculated  $k_e$  values depends on the selected  $k_u$  values for the elements copper and nickel, from which the  $k_u$  values of the virtual crystals of alloys were determined. As stated in section 2.2, experimental data on  $k_u$  are available for copper but not for nickel. White [91] reported an experimental value of  $k_u T$  for copper as  $35.0 \text{ W cm}^{-1}$  at temperatures above 60 K and this value was used in eq (35) for calculation. The value of  $k_u T$  for nickel estimated from the modified Leibfried-Schlömann equation (37) varies considerably depending upon the selected value of the Debye temperature used in the calculation. It can be seen from figure 6 that a higher value of  $k_u$  for nickel, which would make the calculated  $k_e$  values higher especially on the nickel-rich side, would render the calculated curve better fitting to the experimental  $k_e$  values for nickel-rich alloys. However, this would make the calculated  $k_e$  values too high for the copper-rich alloys. The experimental  $k_e$  values for nickel-rich alloys as shown in figure 6 are known to be very uncertain and those for copper-rich alloys are much more reliable. Between the two  $k_u T$  values 52.5 and  $45.0 \text{ W cm}^{-1}$  for copper and nickel, the  $k_u$  values of the virtual crystals of alloys were obtained by linear interpolation and used in eq (35) for the calculation of  $k_e$  values for all the alloys at temperatures above the region of the maximum in  $k_e$ .

Since it is of interest to observe the variation of thermal conductivity with alloy composition at various temperatures, the conductivity-composition isotherms for the copper-nickel alloy system are presented in figure 7 together with some of the experimental data.



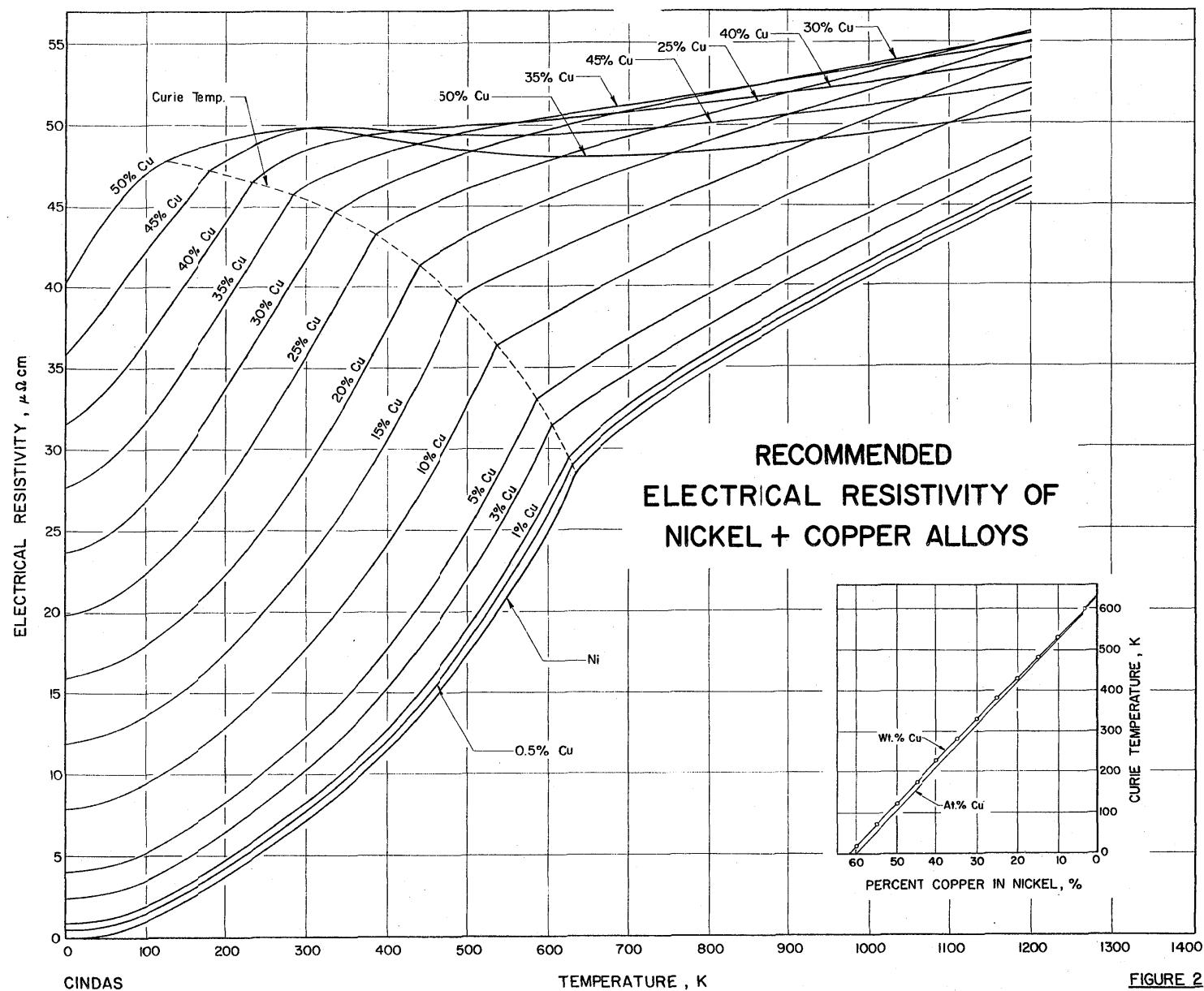
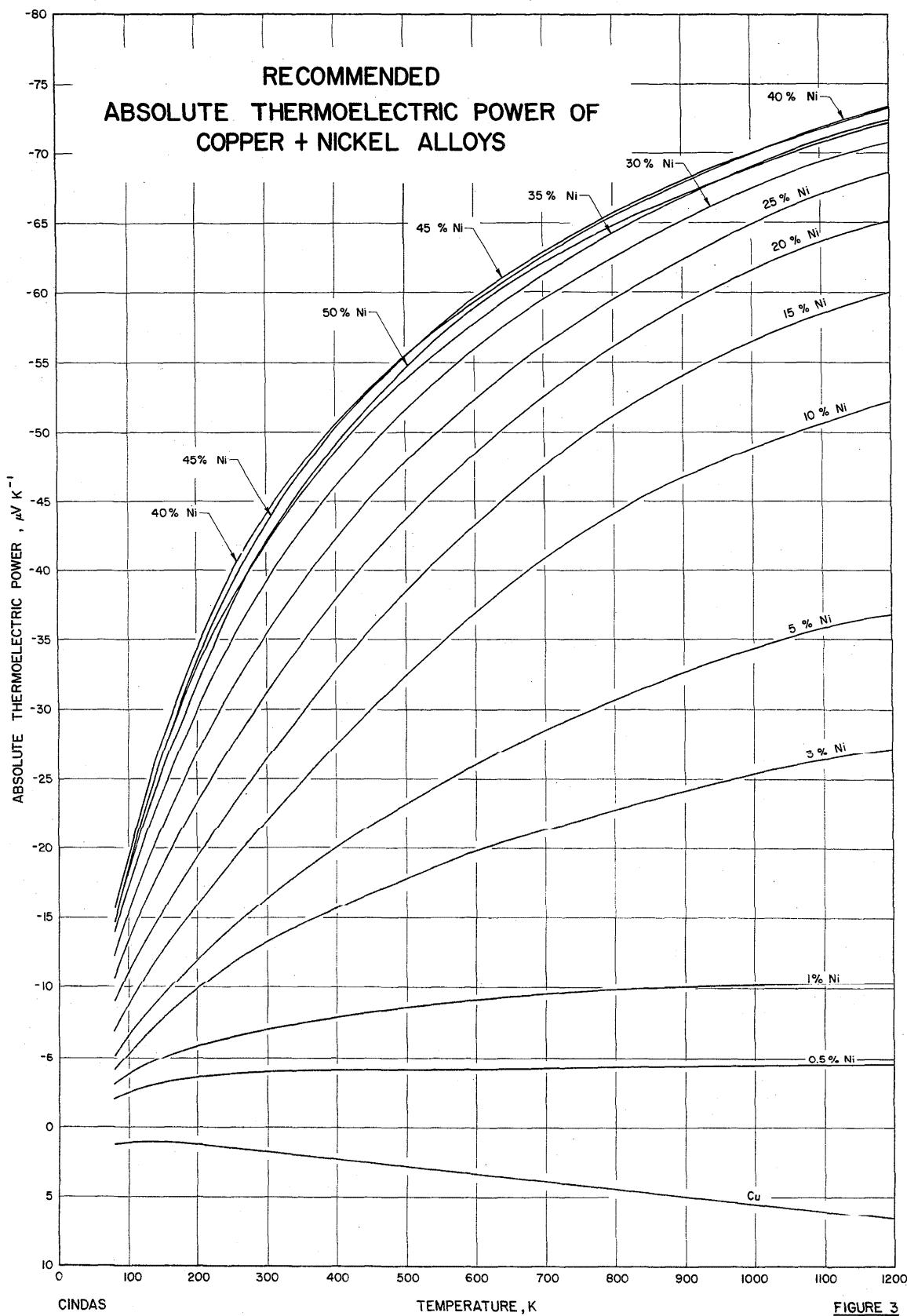
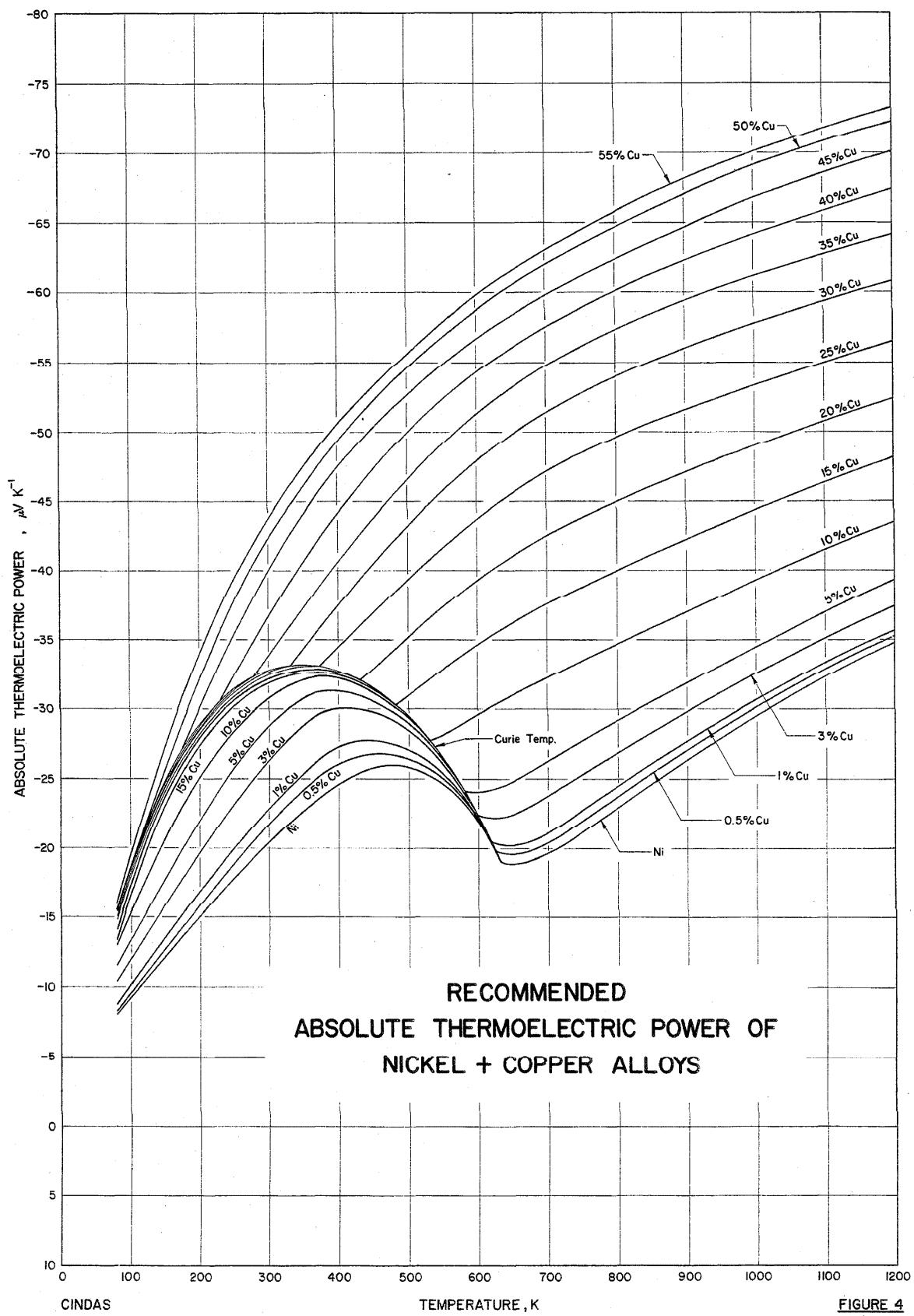
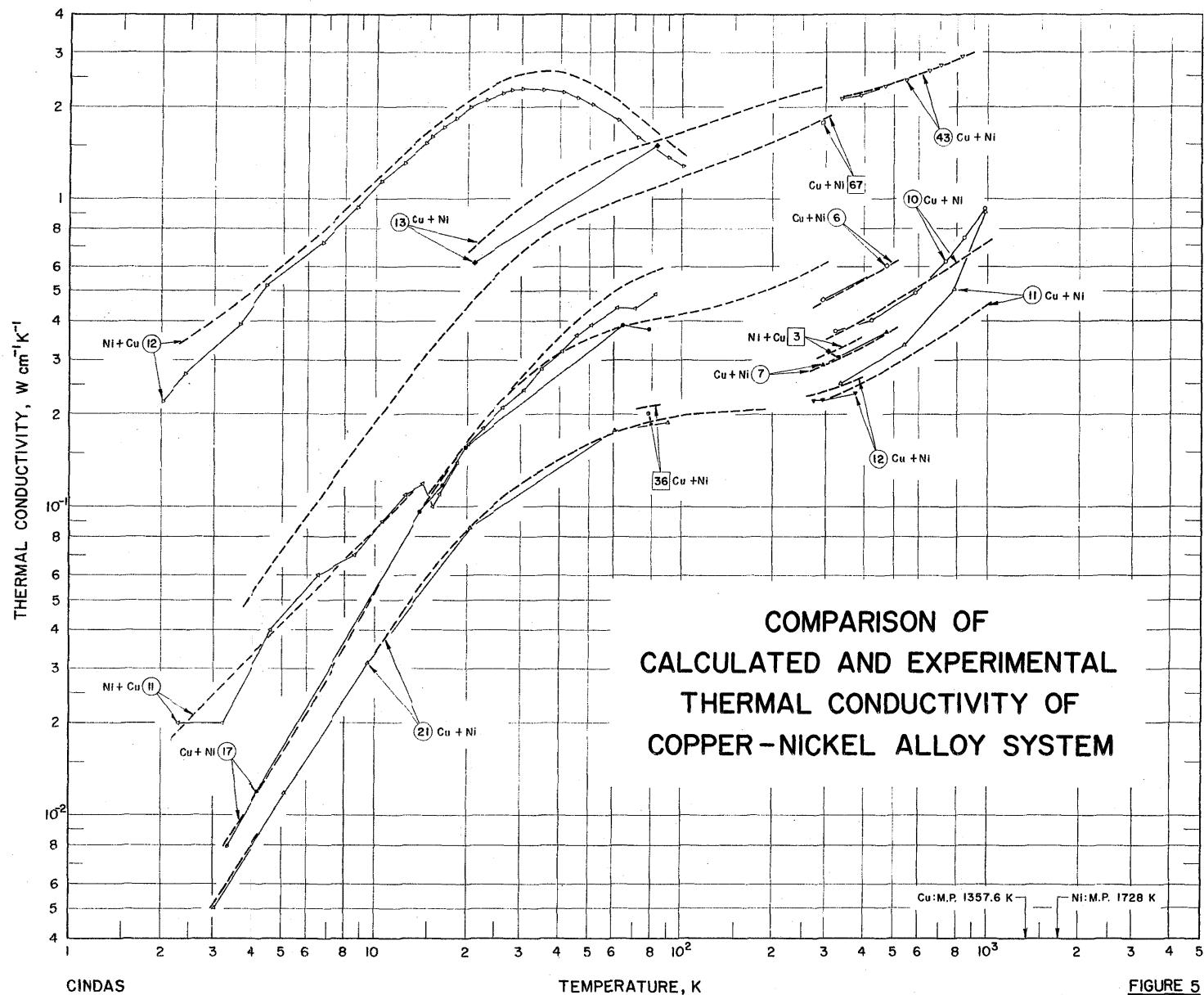
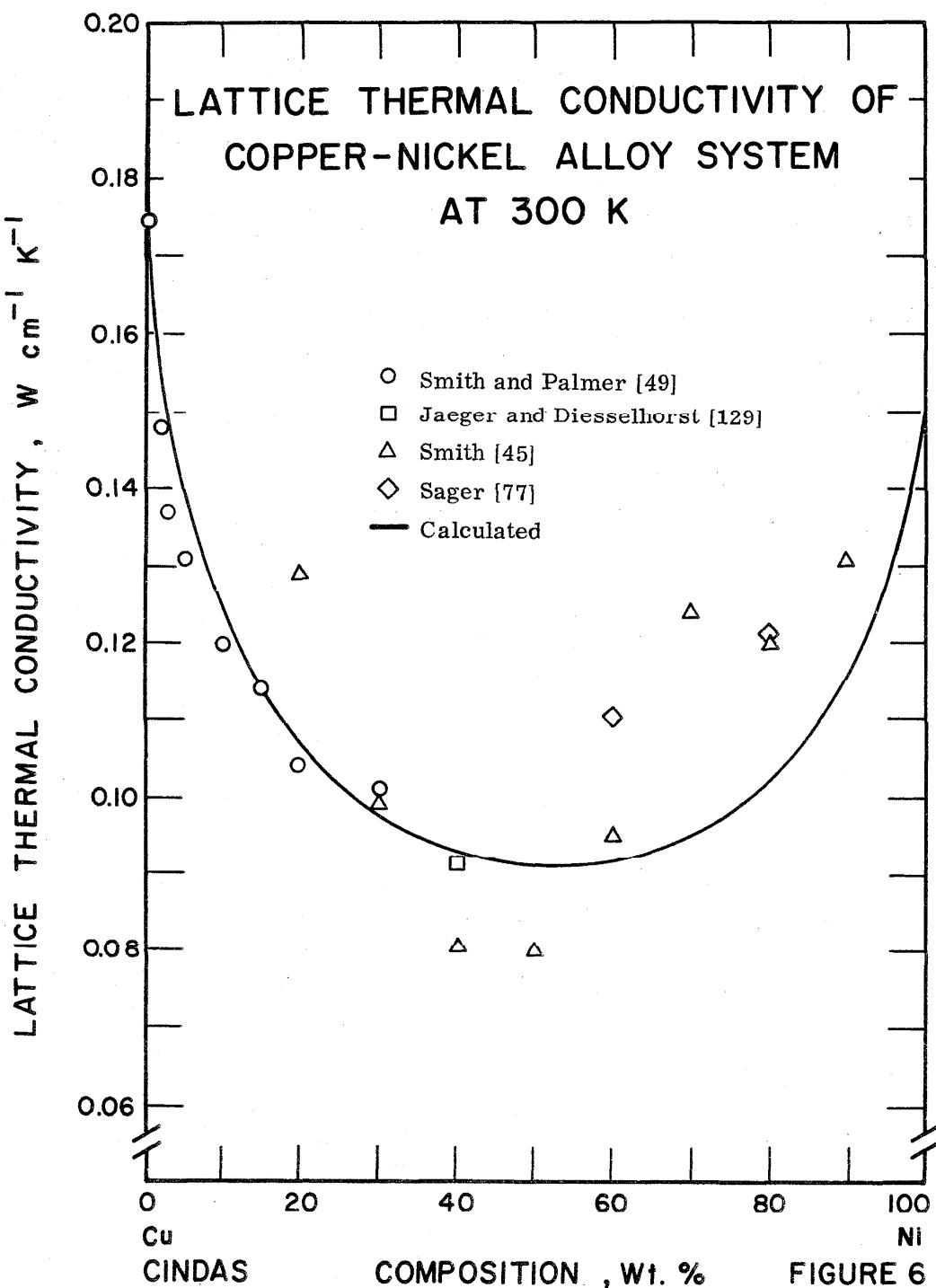


FIGURE 2





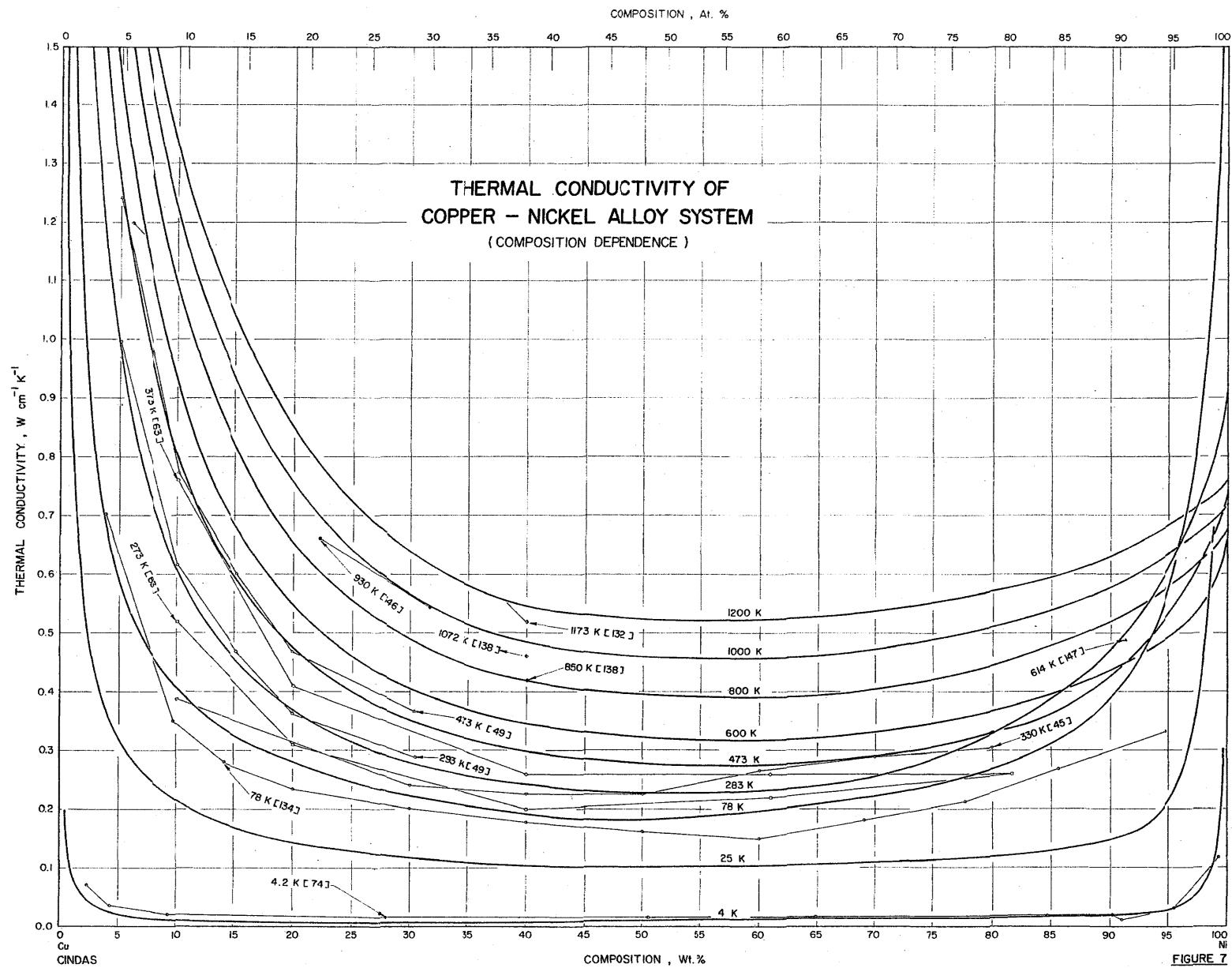




**FIGURE 6**

THERMAL CONDUCTIVITY OF BINARY ALLOY SYSTEMS

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#### 4. Thermal Conductivity of Binary Alloy Systems

In this work, the term "binary alloy system" refers to the full range of composition of two alloying elements and is signified by a hyphen between the two elements, such as aluminum-copper alloy system. The term "binary alloys" refers to a group of binary alloys in which the first alloying element is predominant and is signified by a plus between the two elements, such as aluminum + copper alloys. In specifying the composition of an alloy, weight percent is denoted by % and atomic percent by At.%.

In each of the subsections that follow, the thermal conductivity data and information for each alloy system are presented in the following order: discussion text, figures for comparing recommended curves with experimental data for selected alloys, tables of recommended values, figures presenting recommended curves, figures presenting experimental data, and tables on specimen characterization and measurement information.

In the discussion text on the thermal conductivity of each alloy system, individual pieces of available data and information are reviewed, details of data analysis and synthesis are given, the considerations involved in arriving at the final assessment and recommendation are discussed, the recommended values and the experimental data are compared, and the uncertainties of the recommended values are stated.

In the figures for comparing recommended thermal conductivity values with experimental data for selected alloys mentioned in the discussion text, the recommended thermal conductivity values for the specific alloy compositions shown as smooth solid curves were obtained by quadratic interpolation of the recommended total thermal conductivity values given in the table for the selected fixed alloy compositions.

The values given in the tables of recommended values include those of the total thermal conductivity, electronic thermal conductivity, and lattice thermal conductivity. These values are designated either as recommended or provisional values depending upon the level of confidence placed on the values and, hence, upon the uncertainty assigned. The ranges of uncertainties of recommended and provisional values are less than  $\pm 15\%$  and between  $\pm 15\%$  and  $\pm 30\%$ , respectively. Some of the lattice thermal conductivity values are designated also as typical values, of which the uncertainty is greater than  $\pm 30\%$ . In the tables the third significant figure is given for the thermal conductivity values; this, however, is only for internal comparison and for tabular smoothness and should not be considered indicative of the degree of accuracy or uncertainty. The uncertainty of the values is always explicitly stated. For each of the alloy systems except two, the values are given for 25 alloy compositions: 0.5, 1, 3, 5, 10(5)95, 97, 99, and 99.5%. The corresponding atomic percent of each weight percent composition is also given. For most of the alloy compositions, the values cover the temperature range from 4K to the solidus temperature or 1200 K. The residual electrical resistivity of each alloy composition is also

given in the table, which is for the purpose of helping to characterize and identify the alloy for which the thermal conductivity values are given. The uncertainties of the total thermal conductivity values for each alloy in different temperature ranges are stated in a footnote to the table.

The recommended thermal conductivity values presented in this work are for alloys which are not ordered and have not been cold worked severely. The values would be higher for ordered alloys and lower at low temperatures for cold-worked alloys.

In the figures presenting recommended thermal conductivity curves, continuous (solid) curves represent recommended values and long-dashed curves represent provisional values. The short-dashed portion of any of the above two kinds of curves represents values in the temperature range where no experimental thermal conductivity data are available. In six of the 19 figures presenting the recommended curves, some of the curves belonging to the other alloy group of the same alloy system are also shown in the figure in order to show more clearly the systematic variation of the thermal conductivity with alloy composition and to clarify the confusion in the figure for the other group due to crossover of curves.

In the figures presenting experimental data, a data set consisting of a single point is denoted by a number enclosed by a square, and a curve that connects a set of two or more data points is denoted by a ringed number. These numbers correspond to those given in the accompanying tables on specimen characterization and measurement information. When several sets of data are too close together to be distinguishable, some of the data sets, though listed in the table, are omitted from the figure for the sake of clarity.

The tables on specimen characterization and measurement information give for each set of experimental data the following information: the publication reference number, author's name (or names), year of publication, experimental method used for the measurement, temperature range covered by the data, alloy name and specimen designation, alloy composition, specification and characterization of the specimen and information on measurement conditions, which are contained in the original paper. Whenever available, information on the electrical resistivity has also been included. In these tables the code designations used for the experimental methods for thermal conductivity determinations are as follows:

- C Comparative method
- E Direct electrical heating method
- F Forbes' bar method
- L Longitudinal heat flow method
- P Periodic or transient heat flow method
- R Radial heat flow method
- T Thermoelectrical method

The thermal conductivity data and information for the ten selected binary alloy systems are presented in the following ten subsections.

#### 4.1. Aluminum-Copper Alloy System

The aluminum-copper alloy system does not form a continuous series of solid solutions. The maximum solid solubility of copper in aluminum is 5.70% (2.50 At.%) at 821 K and the solubility decreases to 0.1–0.2% (0.04–0.08 At.%) at 523 K. The maximum solid solubility of aluminum in copper is 9.4% (19.6 At.%) in the range from about 650 to 838 K and the solubility decreases at higher and lower temperatures. Thus the region of solid solution is limited. However, the equation derived for the calculation of the electronic component of thermal conductivity, eq (12), is applicable to all phases, though the equation for the calculation of the lattice component, eq (35), can be used only for solid solutions, as noted before in sections 2 and 3. As noted in section 3 the values for the thermal conductivity of part of this alloy system are derived from experimental data on specimens in which the solid-solution phase was presumably frozen in. Hence, these values may not always be reproducible and are therefore provisional rather than recommended.

There are 188 sets of experimental data available for the thermal conductivity of this alloy system. However, of the 49 data sets for Al + Cu alloys listed in table 3 and shown in figure 12, ten sets are merely single data points around room temperature and 27 sets cover only a narrow temperature range from around room temperature to about 500 K. Of the 139 data sets for Cu + Al alloys listed in table 4 and shown in figure 13, 20 sets are single data points, 15 sets cover the narrow temperature range from around room temperature to about 500 K, and 84 sets are for temperatures below 4.5 K.

For the Al + Cu alloys, all measurements were made between room temperature and 800 K except four (Al + Cu curves 6–8, and 16) which were measured down to about 80 K for specimens containing 4.0, 8.0 and 15.0% Cu [41, 42] and except the two (Al + Cu curves 25 and 26) of Satterthwaite [43] who investigated the thermal conductivity of a specimen containing 0.3% Cu in both the superconducting and normal states between 0.4 and 1.2 K. In the present data analysis and synthesis, a thermal conductivity versus composition curve for 300 K was constructed following mainly the data of Griffiths and Schofield [44] (Al + Cu curves 1–5), of Aliev [116,168] (Al + Cu curves 31–33), and of Smith [45] (Al + Cu curves 12–15). The measurements of Griffiths and Schofield were selected because their specimens were well annealed and their electrical resistivity data are consistent with their thermal conductivity measurements. Smith did not report the heat treatment, but his data are compatible in magnitude to those of Griffiths and Schofield. The other measurements were discounted either because the specimens were unannealed or unspecified, or due to some experimental or theoretical considerations. For instance, Mannchen's data [41] (Al + Cu curves 6–8) were not taken into consideration since his corresponding Lorenz function values were believed to be too low. In the meantime, electronic thermal conductivity values at 300 K for the selected alloys were calculated from eq (12) and these  $k_e$  values were also plotted on the conductivity-composition graph. The difference between the experimental total thermal conductivity  $k$  and the calculated electronic component  $k_e$  is the lattice component  $k_l$ , and the  $k_l$  values at

300 K for the various compositions were thus obtained from the graph. These  $k_l$  values were extrapolated to higher temperatures up to the solidus temperatures according to the temperature dependence of eq (35) and to lower temperatures according to the pattern of  $k_e$  curves of aluminum-copper system derived from the available experimental  $k$  and the calculated  $k_e$  around the region of maximum  $k_e$  and according to  $T^2$  dependence at lower temperatures assuming  $k_e$  to be negligible at 1 K. The values were then adjusted so that the extrapolated  $k_l$  values plus their corresponding  $k_e$  values yield total  $k$  values which fit the experimental data in those regions. The total thermal conductivity values were then obtained by adding the calculated values of  $k_e$  to the adjusted extrapolated values of  $k_l$ .

For the Cu + Al alloys, several measurements were made between 4 K and 80 K [48,50] (Cu + Al curves 111–126) for alloys containing 0.43, 4.07, and 6.97% Al. The conductivity-composition curve at 300 K was constructed, based mainly on the data of Smith and Palmer [49] (Cu + Al curves 2–9), Aliev [116,168] (Cu + Al curves 59–67), and Smith [45] (Cu + Al curves 16 and 17). The specimens of Smith and Palmer were well-annealed and the results from [45] and [116] complement those of Smith and Palmer in forming the conductivity-composition isotherm. The  $k_e$  values were calculated from eq (12) and those at 300 K were plotted on the conductivity-composition graph. The differences  $k_e$  between  $k$  and  $k_e$  were obtained for all compositions. These  $k_e$  values were adjusted so that their extrapolations to lower temperatures, according to the method described above for Al + Cu alloys, fit the  $k_e$  values derived from experimental data of Chu and Lipschultz [48] (Cu + Al curves 111–121) and of Friedman [50] (Cu + Al curves 122–126). Above 300 K the  $k_e$  values were extrapolated to the solidus temperatures. The total thermal conductivity values were then obtained by adding the calculated values of  $k_e$  to the adjusted extrapolated values of  $k_e$ . Because of the lack of experimental electrical resistivity data, no total  $k$  values are given below 200 K for the alloy with 10% Al, below 300 K for the alloy with 15% Al, and at temperatures other than 300 K for the alloy with 20% Al.

A graphical comparison of the recommended total thermal conductivity values with selected experimental data is given in figures 8 and 9. The smooth solid curves in these figures were obtained by interpolating the recommended values of table 2 in order to obtain thermal conductivity values for the desired alloy compositions. For aluminum-rich alloys shown in figure 8, the recommended values above room temperature are in agreement with the data of Griffiths and Schofield [44] (Al + Cu curves 1, 2, 4, and 5), of Smith [45] (Al + Cu curves 12–14), and of Mikryukov and Karagezyan [58] (Al + Cu curves 20 and 21) to within 5%, and with the data of Smith [45] for an alloy containing 50% Cu (Al + Cu curve 15) to within 8%. No appropriate comparison can be made below room temperature. For the copper-rich alloys shown in figure 9, the recommended values at low temperatures are in agreement with the data of Salter and Charsley [51] (Cu + Al curves 20, 22–25), of Chu and Lipschultz [48] (Cu + Al curves 111 and 116), and of Friedman [50] (Cu + Al curve 122) to within 6%, and those at higher temperatures are in agreement with the data of Smith and Palmer [49] (Cu + Al curves 2–9 and

78) and of Aliev [116] (Cu + Al curves 65 and 67) to within 10%.

The resulting recommended values for  $k$ ,  $k_e$ , and  $k_g$  are tabulated in table 2 for 25 alloy compositions. These values are for alloys which have not been severely cold worked or quenched. The values for  $k$  are also presented in figures 10 and 11. The recommended curves for copper-rich alloys containing 25 to 45% Al are also shown in figure 10 in order to show more clearly the systematic variation of the thermal conductivity with alloy composition and to clarify the confusion in figure 11 due to crossover of curves. For most of the alloy compositions, the temperature range covered is from 4 K to

the solidus temperature where melting starts. The values of residual electrical resistivity for the alloys are also given in table 2. The uncertainties of the  $k$  values are stated in a footnote to table 2, while the uncertainties of the  $k_e$  and  $k_g$  values are indicated by their being designated as recommended, provisional or typical values. The ranges of uncertainties of recommended, provisional, and typical values are less than  $\pm 15\%$ , between  $\pm 15$  and  $\pm 30\%$ , and greater than  $\pm 30\%$ , respectively. The  $k_g$  values are very uncertain and are merely to serve as correction terms for the derivation of the total thermal conductivities.

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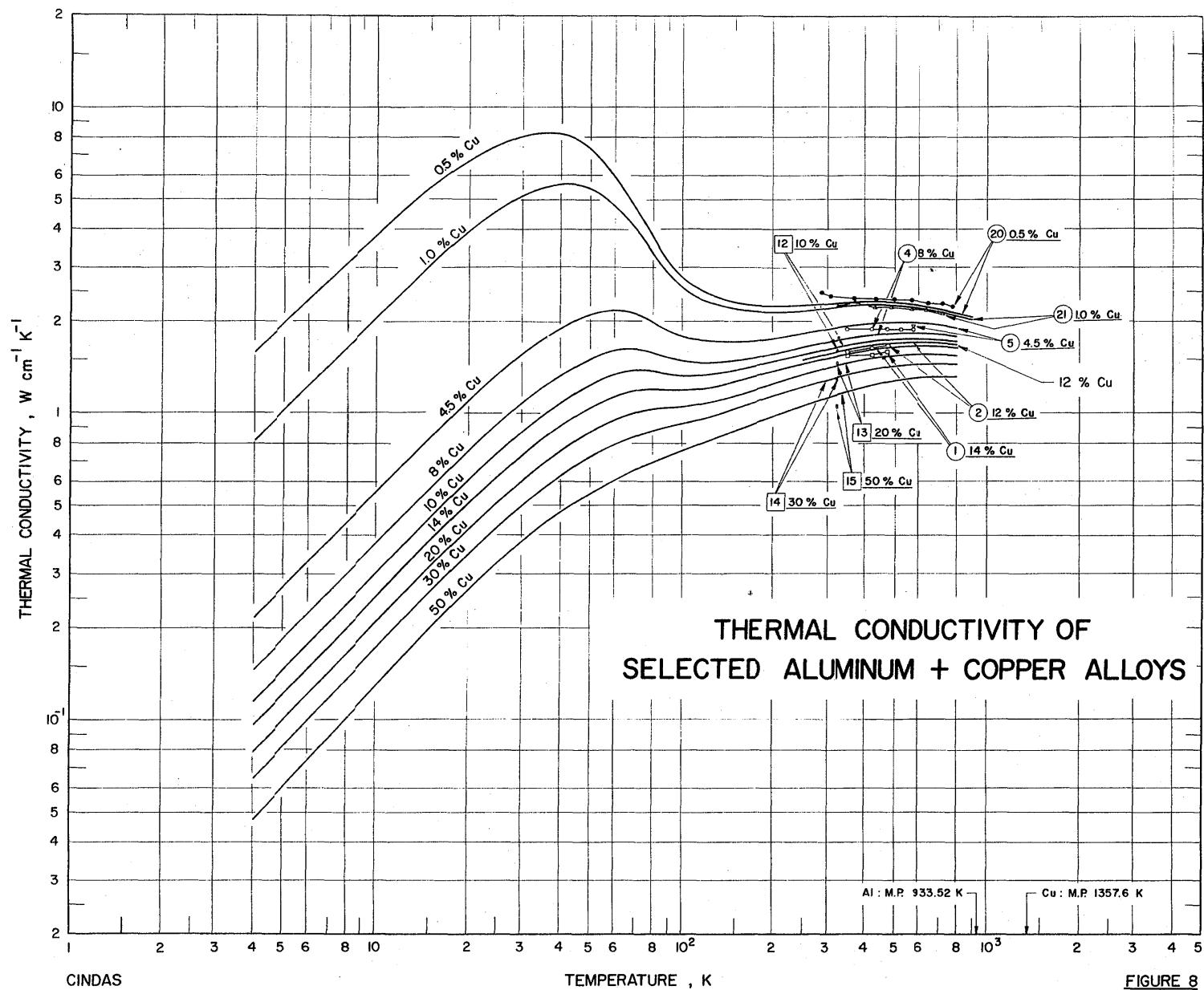


FIGURE 8

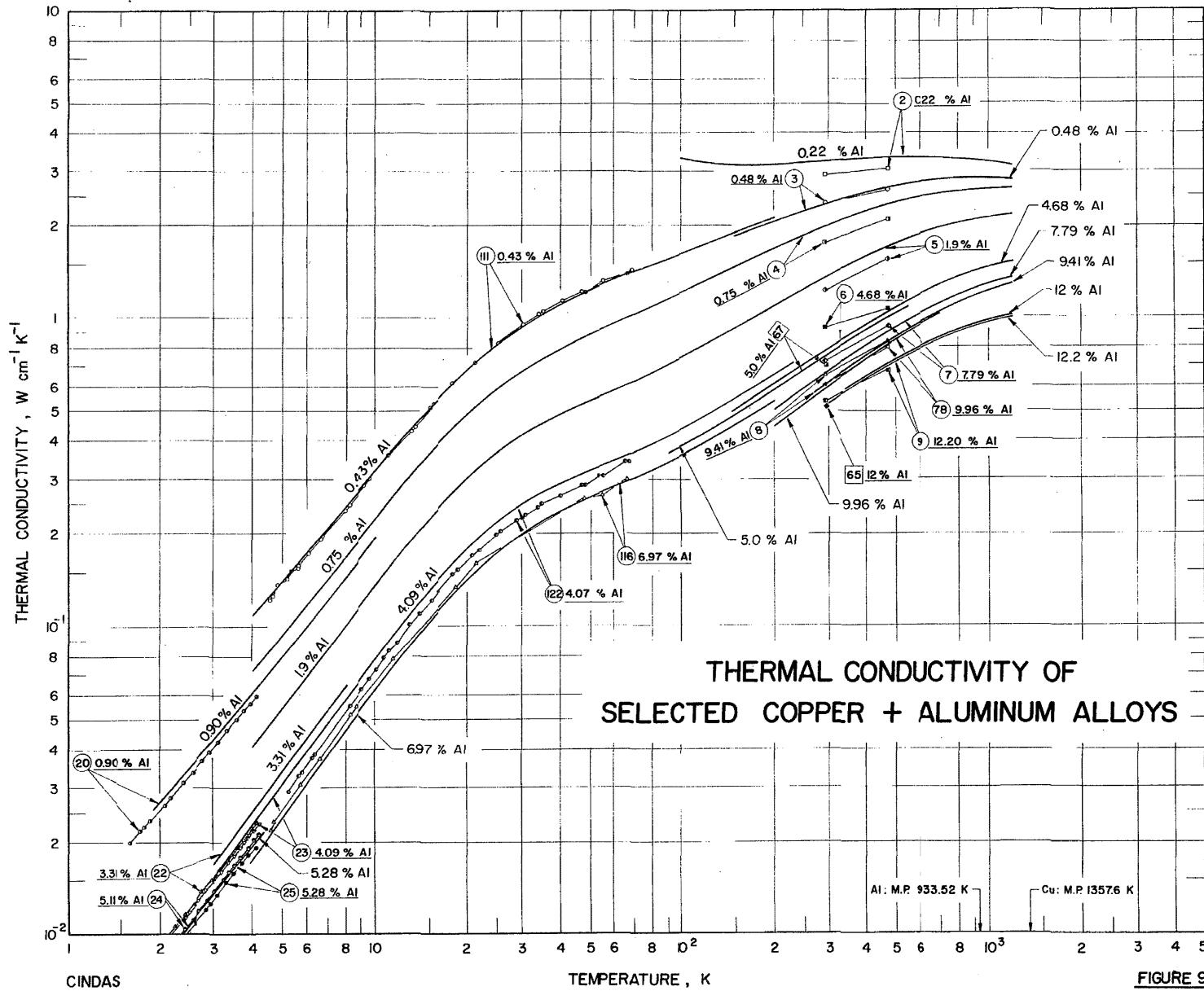


TABLE 2. RECOMMENDED THERMAL CONDUCTIVITY OF ALUMINUM-COPPER ALLOY SYSTEM<sup>†</sup>[Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Al: 99.50% (99.79 At. %) Cu: 0.50% ( 0.21 At. %)				Al: 99.00% (99.57 At. %) Cu: 1.00% ( 0.43 At. %)				Al: 97.00% (98.70 At. %) Cu: 3.00% ( 1.30 At. %)				Al: 95.00% (97.81 At. %) Cu: 5.00% ( 2.19 At. %)			
$\rho_0 = 0.0600 \mu\Omega\text{cm}$				$\rho_0 = 0.1203 \mu\Omega\text{cm}$				$\rho_0 = 0.340 \mu\Omega\text{cm}$				$\rho_0 = 0.532 \mu\Omega\text{cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	1.58*			4	0.814*			4	0.292*			4	0.189*	0.183	0.00578*
6	2.36*			6	1.23*			6	0.442*			6	0.288*	0.275	0.0130*
8	3.11*			8	1.65*			8	0.593*			8	0.388*	0.366	0.0222*
10	3.81*			10	2.05*			10	0.741*			10	0.489*	0.456	0.0330*
15	5.46*			15	3.04*			15	1.10*			15	0.738*	0.677	0.0610*
20	6.73*			20	3.92*			20	1.45*			20	0.977*	0.892	0.0849*
25	7.56*	7.30‡	0.265‡	25	4.64*	4.42‡	0.221‡	25	1.75*	1.61‡	0.139‡	25	1.19*	1.09	0.102‡
30	8.06*	7.78‡	0.285‡	30	5.14*	4.90‡	0.239‡	30	2.02*	1.87‡	0.152‡	30	1.39*	1.28	0.112‡
40	8.22*	7.94‡	0.285‡	40	5.64*	5.40‡	0.239‡	40	2.44*	2.28‡	0.155‡	40	1.71*	1.59	0.117‡
50	7.36*	7.09‡	0.265‡	50	5.45*	5.23‡	0.221‡	50	2.68*	2.53‡	0.147‡	50	1.92*	1.81	0.112‡
60	5.99*	5.75‡	0.241‡	60	4.80*	4.60‡	0.202‡	60	2.70*	2.56‡	0.138‡	60	2.00*	1.89	0.106‡
70	4.74*	4.52‡	0.218‡	70	4.04*	3.85‡	0.185‡	70	2.54*	2.41‡	0.127‡	70	1.98*	1.88	0.0985‡
80	3.77*	3.57‡	0.199‡	80	3.35*	3.18‡	0.170‡	80	2.33*	2.21‡	0.118‡	80	1.89*	1.80	0.0916‡
90	3.11*	2.93‡	0.183‡	90	2.85*	2.69‡	0.157‡	90	2.11*	2.00‡	0.110‡	90	1.79*	1.70	0.0857‡
100	2.78*	2.61‡	0.169‡	100	2.58*	2.43‡	0.145‡	100	1.99*	1.89‡	0.102‡	100	1.72*	1.64	0.0804‡
150	2.30*	2.18‡	0.123‡	150	2.20*	2.09‡	0.107‡	150	1.89*	1.81‡	0.0758‡	150	1.67*	1.61	0.0612‡
200	2.24*	2.14‡	0.0968‡	200	2.15*	2.07‡	0.0847‡	200	1.90*	1.84‡	0.0607‡	200	1.72*	1.67	0.0495‡
250	2.25*	2.17‡	0.0801‡	250	2.17*	2.10‡	0.0704‡	250	1.94*	1.89‡	0.0509‡	250	1.79*	1.75	0.0416‡
273	2.26*	2.19‡	0.0745‡	273	2.18*	2.12‡	0.0652‡	273	1.97*	1.92‡	0.0474‡	273	1.82*	1.78	0.0389‡
300	2.28‡	2.21‡	0.0685‡	300	2.21‡	2.15‡	0.0602‡	300	1.99*	1.95‡	0.0438‡	300	1.85	1.81	0.0360‡
350	2.31‡	2.25‡	0.0596‡	350	2.25‡	2.20‡	0.0525‡	350	2.04‡	2.00‡	0.0386‡	350	1.90	1.87	0.0319‡
400	2.32‡	2.27‡	0.0530‡	400	2.26‡	2.21‡	0.0467‡	400	2.07‡	2.04‡	0.0345‡	400	1.93	1.90	0.0285‡
500	2.29‡	2.25‡	0.0430‡	500	2.24‡	2.20‡	0.0382‡	500	2.07‡	2.04‡	0.0285‡	500	1.95	1.93	0.0237‡
600	2.25‡	2.21‡	0.0362‡	600	2.19‡	2.16‡	0.0322‡	600	2.05‡	2.03‡	0.0243‡	600	1.94	1.92	0.0203‡
700	2.19	2.16	0.0312‡	700	2.15	2.12	0.0279‡	700	2.02	2.00	0.0212‡	700	1.92	1.90	0.0177‡
800	2.13*	2.10	0.0273‡	800	2.08*	2.06	0.0245‡	800	1.97*	1.95	0.0189‡	800	1.89*	1.87	0.0157‡
900	2.06*	2.04	0.0243‡	900	2.02*	2.00	0.0219‡	873	1.94*	1.92	0.0177‡	833	1.88*	1.86	0.0152‡
923	2.05*	2.03	0.0238‡	913	2.01*	1.99	0.0217‡								

† Uncertainties in the total thermal conductivity, k, are as follows:

99.50 Al - 0.50 Cu: ± 15% up to 600 K and ± 6% above 600 K.

99.00 Al - 1.00 Cu: ± 15% up to 600 K and ± 6% above 600 K.

97.00 Al - 3.00 Cu: ± 15% up to 600 K and ± 6% above 600 K.

95.00 Al - 5.00 Cu: ± 8% below 100 K, ± 5% between 100 and 500 K, and ± 6% above 500 K.

‡ Provisional value.

§ Typical value.

\* In temperature range where no experimental thermal conductivity data are available.

TABLE 2. RECOMMENDED THERMAL CONDUCTIVITY OF ALUMINUM-COPPER ALLOY SYSTEM (continued)<sup>†</sup>  
 [Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Al: 90.00% (95.49 At.%) Cu: 10.00% (4.51 At.%)				Al: 85.00% (93.03 At.%) Cu: 15.00% (6.97 At.%)				Al: 80.00% (90.40 At.%) Cu: 20.00% (9.60 At.%)				Al: 75.00% (87.60 At.%) Cu: 25.00% (12.40 At.%)			
$\rho_o = 0.888 \mu\Omega\text{cm}$				$\rho_o = 1.118 \mu\Omega\text{cm}$				$\rho_o = 1.312 \mu\Omega\text{cm}$				$\rho_o = 1.482 \mu\Omega\text{cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.115*	0.110	0.00466‡	4	0.0913*	0.0870	0.00426‡	4	0.0786*	0.0745	0.00406‡	4	0.0699*	0.0659	0.00398‡
6	0.176*	0.165	0.0105‡	6	0.140*	0.130	0.00956‡	6	0.121*	0.112	0.00912‡	6	0.108*	0.0993	0.00894‡
8	0.238*	0.220	0.0179‡	8	0.189*	0.173	0.0163‡	8	0.165*	0.149	0.0156‡	8	0.147*	0.132	0.0153‡
10	0.300*	0.273	0.0266‡	10	0.240*	0.216	0.0249‡	10	0.209*	0.186	0.0232‡	10	0.188*	0.165	0.0227‡
15	0.455*	0.406	0.0491‡	15	0.365*	0.320	0.0449‡	15	0.317*	0.274	0.0428‡	15	0.285*	0.243	0.0420‡
20	0.604*	0.536	0.0684‡	20	0.484*	0.421	0.0625‡	20	0.420*	0.360	0.0597‡	20	0.378*	0.319	0.0585‡
25	0.741*	0.659	0.0823‡	25	0.594*	0.519	0.0752‡	25	0.515*	0.443	0.0718‡	25	0.462*	0.392	0.0704‡
30	0.865*	0.774	0.0905‡	30	0.694*	0.611	0.0827‡	30	0.602*	0.522	0.0789‡	30	0.540*	0.463	0.0774‡
40	1.08*	0.982	0.0942‡	40	0.862*	0.776	0.0861‡	40	0.749*	0.667	0.0822‡	40	0.674*	0.593	0.0806‡
50	1.24*	1.15	0.0905‡	50	0.993*	0.910	0.0827‡	50	0.866*	0.797	0.0789‡	50	0.777*	0.700	0.0774‡
60	1.35*	1.26	0.0853‡	60	1.09*	1.01	0.0779‡	60	0.951*	0.877	0.0744‡	60	0.857*	0.784	0.0729‡
70	1.38*	1.30	0.0794‡	70	1.14*	1.07	0.0725‡	70	1.01*	0.938	0.0692‡	70	0.911*	0.843	0.0679‡
80	1.38*	1.31	0.0738‡	80	1.16*	1.09	0.0674‡	80	1.03*	0.970	0.0644‡	80	0.943*	0.880	0.0631‡
90	1.35	1.28	0.0691‡	90	1.16	1.10	0.0631‡	90	1.04*	0.984	0.0602‡	90	0.960*	0.901	0.0591‡
100	1.33	1.27	0.0647‡	100	1.16	1.10	0.0592‡	100	1.06*	1.00	0.0565‡	100	0.978*	0.923	0.0554‡
150	1.39	1.34	0.0493‡	150	1.26	1.21	0.0451‡	150	1.15*	1.11	0.0430‡	150	1.09*	1.05	0.0422‡
200	1.47	1.43	0.0399‡	200	1.34	1.30	0.0365‡	200	1.25*	1.22	0.0348‡	200	1.18*	1.15	0.0341‡
250	1.55	1.52	0.0335‡	250	1.42	1.39	0.0306‡	250	1.33*	1.30	0.0292‡	250	1.27*	1.24	0.0287‡
273	1.58	1.55	0.0313‡	273	1.45	1.42	0.0286‡	273	1.37*	1.34	0.0273‡	273	1.30*	1.27	0.0268‡
300	1.61	1.58	0.0290‡	300	1.49	1.46	0.0265‡	300	1.40	1.37	0.0253‡	300	1.33*	1.31	0.0248‡
350	1.67	1.64	0.0257‡	350	1.54	1.52	0.0235‡	350	1.46	1.44	0.0224‡	350	1.39*	1.37	0.0219‡
400	1.71	1.69	0.0229‡	400	1.58	1.56	0.0209‡	400	1.50*	1.48	0.0200‡	400	1.43*	1.41	0.0196‡
500	1.74	1.72	0.0191‡	500	1.62	1.60	0.0174‡	500	1.54*	1.52	0.0166‡	500	1.47*	1.45	0.0163‡
600	1.75	1.73	0.0163‡	600	1.64*	1.63	0.0149‡	600	1.56*	1.55	0.0142‡	600	1.50*	1.49	0.0140‡
700	1.74	1.73	0.0142‡	700	1.64*	1.63	0.0130‡	700	1.56*	1.55	0.0124‡	700	1.50*	1.49	0.0122‡
800	1.72	1.71	0.0127‡	800	1.62*	1.61	0.0116‡	800	1.55*	1.54	0.0111‡	800	1.50*	1.49	0.0108‡
821	1.72	1.71	0.0124‡	821	1.62*	1.61	0.0113‡	821	1.55*	1.54	0.0109‡	821	1.50*	1.49	0.0106‡

† Uncertainties in the total thermal conductivity, k, are as follows:

90.00 Al - 10.00 Cu: ±8% below 100 K, ±5% between 100 and 500 K, and ±6% above 500 K.

85.00 Al - 15.00 Cu: ±10% below 100 K, ±5% between 100 and 500 K, and ±6% above 500 K.

80.00 Al - 20.00 Cu: ±10% below 100 K, ±5% between 100 and 500 K, and ±7% above 500 K.

75.00 Al - 25.00 Cu: ±10% below 100 K, ±5% between 100 and 500 K, and ±7% above 500 K.

‡ Typical value.

\* In temperature range where no experimental thermal conductivity data are available.

TABLE 2. RECOMMENDED THERMAL CONDUCTIVITY OF ALUMINUM-COPPER ALLOY SYSTEM (continued)<sup>†</sup>[Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Al: 70.00% (84.60 At.%) Cu: 30.00% (15.40 At.%)				Al: 65.00% (81.39 At.%) Cu: 35.00% (18.61 At.%)				Al: 60.00% (77.94 At.%) Cu: 40.00% (22.06 At.%)				Al: 55.00% (74.22 At.%) Cu: 45.00% (25.78 At.%)			
$\rho_0 = 1.623 \mu\Omega\text{cm}$				$\rho_0 = 1.754 \mu\Omega\text{cm}$				$\rho_0 = 1.883 \mu\Omega\text{cm}$				$\rho_0 = 2.02 \mu\Omega\text{cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.0641*	0.0602	0.00392‡	4	0.0596*	0.0557	0.00392‡	4	0.0558*	0.0519	0.00394‡	4	0.0524*	0.0484	0.00395‡
6	0.0993*	0.0905	0.00880‡	6	0.0924*	0.0836	0.00880‡	6	0.0866*	0.0778	0.00884‡	6	0.0812*	0.0723	0.00887‡
8	0.135§	0.120	0.0150‡	8	0.127*	0.112	0.0150‡	8	0.118*	0.103	0.0151‡	8	0.111*	0.0955	0.0152‡
10	0.172*	0.150	0.0223‡	10	0.160*	0.138	0.0223‡	10	0.150*	0.128	0.0224‡	10	0.142*	0.119	0.0225‡
15	0.262*	0.221	0.0413‡	15	0.244*	0.203	0.0413‡	15	0.228*	0.187	0.0415‡	15	0.217*	0.175	0.0417‡
20	0.348*	0.290	0.0575‡	20	0.324*	0.267	0.0575‡	20	0.306*	0.248	0.0578‡	20	0.290*	0.232	0.0580‡
25	0.425*	0.356	0.0693‡	25	0.399*	0.330	0.0693‡	25	0.377*	0.307	0.0696‡	25	0.357*	0.287	0.0795‡
30	0.497*	0.421	0.0761‡	30	0.466*	0.390	0.0761‡	30	0.439*	0.363	0.0764‡	30	0.416*	0.339	0.0768‡
40	0.618*	0.539	0.0793‡	40	0.579*	0.500	0.0793‡	40	0.546*	0.466	0.0796‡	40	0.517*	0.437	0.0799‡
50	0.724*	0.638	0.0861‡	50	0.669*	0.593	0.0761‡	50	0.631*	0.555	0.0764‡	50	0.597*	0.520	0.0768‡
60	0.787*	0.715	0.0718‡	60	0.740*	0.668	0.0718‡	60	0.700*	0.628	0.0721‡	60	0.662*	0.590	0.0724‡
70	0.841*	0.774	0.0668‡	70	0.793*	0.726	0.0668‡	70	0.751*	0.684	0.0670‡	70	0.711*	0.644	0.0673‡
80	0.877*	0.815	0.0621‡	80	0.830*	0.768	0.0621‡	80	0.787*	0.725	0.0623‡	80	0.748*	0.685	0.0626‡
90	0.900*	0.842	0.0581‡	90	0.856*	0.798	0.0581‡	90	0.813*	0.755	0.0583‡	90	0.778*	0.719	0.0586‡
100	0.924*	0.869	0.0545‡	100	0.880*	0.825	0.0545‡	100	0.850*	0.785	0.0547‡	100	0.805*	0.750	0.0549‡
150	1.04*	0.998	0.0415‡	150	0.998*	0.957	0.0415‡	150	0.963*	0.921	0.0417‡	150	0.929*	0.887	0.0418‡
200	1.14*	1.11	0.0336‡	200	1.10*	1.07	0.0336‡	200	1.06*	1.03	0.0337‡	200	1.03*	0.993	0.0338‡
250	1.22*	1.19	0.0282‡	250	1.17*	1.14	0.0282‡	250	1.14*	1.11	0.0283‡	250	1.10*	1.07	0.0284‡
273	1.25*	1.22	0.0263‡	273	1.21*	1.18	0.0263‡	273	1.17*	1.14	0.0264‡	273	1.13*	1.10	0.0266‡
300	1.28	1.26	0.0244‡	300	1.24*	1.22	0.0244‡	300	1.20	1.18	0.0245‡	300	1.17	1.15	0.0246‡
350	1.34	1.32	0.0216‡	350	1.29*	1.27	0.0216‡	350	1.25	1.23	0.0217‡	350	1.22	1.20	0.0218‡
400	1.38*	1.36	0.0193‡	400	1.33*	1.31	0.0193‡	400	1.29*	1.27	0.0194‡	400	1.26*	1.24	0.0194‡
500	1.42*	1.40	0.0160‡	500	1.38*	1.36	0.0160‡	500	1.34*	1.32	0.0161‡	500	1.32*	1.30	0.0162‡
600	1.45*	1.44	0.0137‡	600	1.40*	1.39	0.0137‡	600	1.37*	1.36	0.0138‡	600	1.34*	1.33	0.0138‡
700	1.46*	1.45	0.0120‡	700	1.42*	1.41	0.0120‡	700	1.38*	1.37	0.0120‡	700	1.35*	1.34	0.0121‡
800	1.45*	1.44	0.0107‡	800	1.41*	1.40	0.0107‡	800	1.38*	1.37	0.0107‡	800	1.35*	1.34	0.0108‡
821	1.45*	1.44	0.0105‡	821	1.41*	1.40	0.0105‡	821	1.38*	1.37	0.0105‡	821	1.35*	1.34	0.0106‡

† Uncertainties in the total thermal conductivity, k, are as follows:

70.00 Al - 30.00 Cu: ±10% below 100 K, ±5% between 100 and 500 K, and ±7% above 500 K.

65.00 Al - 35.00 Cu: ±12% below 100 K, ±5% between 100 and 500 K, and ±7% above 500 K.

60.00 Al - 40.00 Cu: ±12% below 100 K, ±5% between 100 and 500 K, and ±7% above 500 K.

55.00 Al - 45.00 Cu: ±12% below 80 K, ±5% between 80 and 500 K, and ±7% above 500 K.

‡ Typical value.

\* In temperature range where no experimental thermal conductivity data are available.

TABLE 2. RECOMMENDED THERMAL CONDUCTIVITY OF ALUMINUM-COPPER ALLOY SYSTEM (continued)<sup>†</sup>

[Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Al: 50.00% (70.20 At.%) Cu: 50.00% (29.80 At.%)				Al: 45.00% (65.83 At.%) Cu: 55.00% (34.17 At.%)				Al: 40.00% (61.09 At.%) Cu: 60.00% (38.91 At.%)				Al: 35.00% (55.91 At.%) Cu: 65.00% (44.09 At.%)			
$\rho_o = 2.25 \mu\Omega \text{cm}$				$\rho_o = 2.59 \mu\Omega \text{cm}$				$\rho_o = 3.25 \mu\Omega \text{cm}$				$\rho_o = 4.42 \mu\Omega \text{cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.0474*	0.0434	0.00398‡	4	0.0420**‡	0.0380	0.00400‡	4	0.0342**‡	0.0302	0.00402‡	4	0.0269**‡	0.0228	0.00409‡
6	0.0736*	0.0647	0.00894‡	6	0.0659**‡	0.0569	0.00900‡	6	0.0541**‡	0.0450	0.00909‡	6	0.0430**‡	0.0338	0.00922‡
8	0.101*	0.0857	0.0153‡	8	0.0909**‡	0.0755	0.0154‡	8	0.0753**‡	0.0597	0.0156‡	8	0.0605**‡	0.0447	0.0158‡
10	0.130*	0.107	0.0227‡	10	0.117**‡	0.0942	0.0229‡	10	0.0974**‡	0.0744	0.0230‡	10	0.0786**‡	0.0552	0.0234‡
15	0.200*	0.158	0.0420‡	15	0.181**‡	0.139	0.0422‡	15	0.154**‡	0.111	0.0426‡	15	0.125**‡	0.0816	0.0434‡
20	0.266*	0.208	0.0585‡	20	0.242**‡	0.183	0.0590‡	20	0.206**‡	0.146	0.0595‡	20	0.168**‡	0.108	0.0603‡
25	0.328*	0.258	0.0704‡	25	0.296**‡	0.225	0.0708‡	25	0.252**‡	0.181	0.0714‡	25	0.206**‡	0.133	0.0726‡
30	0.383*	0.306	0.0774‡	30	0.344**‡	0.267	0.0775‡	30	0.293**‡	0.215	0.0782‡	30	0.237**‡	0.158	0.0793‡
40	0.475*	0.394	0.0806‡	40	0.426**‡	0.345	0.0810‡	40	0.361**‡	0.279	0.0817‡	40	0.290**‡	0.207	0.0830‡
50	0.548*	0.471	0.0774‡	50	0.494**‡	0.416	0.0779‡	50	0.415**‡	0.337	0.0784‡	50	0.332**‡	0.252	0.0797‡
60	0.609*	0.536	0.0729‡	60	0.550**‡	0.477	0.0730‡	60	0.463**‡	0.389	0.0737‡	60	0.368**‡	0.293	0.0748‡
70	0.658*	0.590	0.0679‡	70	0.596**‡	0.528	0.0680‡	70	0.499**‡	0.430	0.0686‡	70	0.400**‡	0.330	0.0697‡
80	0.695*	0.632	0.0631‡	80	0.631*	0.568	0.0634‡	80	0.535*	0.471	0.0640‡	80	0.431*	0.366	0.0650‡
90	0.726*	0.667	0.0591‡	90	0.661*	0.602	0.0594‡	90	0.565*	0.505	0.0599‡	90	0.457*	0.396	0.0610‡
100	0.753*	0.698	0.0554‡	100	0.689*	0.633	0.0558‡	100	0.594*	0.538	0.0562‡	100	0.483*	0.426	0.0571‡
150	0.880*	0.838	0.0422‡	150	0.814*	0.772	0.0425‡	150	0.722*	0.679	0.0429‡	150	0.598*	0.555	0.0435‡
200	0.979*	0.945	0.0341‡	200	0.915*	0.881	0.0343‡	200	0.820*	0.785	0.0345‡	200	0.691*	0.656	0.0350‡
250	1.06*	1.03	0.0287‡	250	0.996*	0.967	0.0289‡	250	0.902*	0.873	0.0291‡	250	0.772*	0.742	0.0296‡
273	1.09*	1.06	0.0268‡	273	1.03*	1.00	0.0270‡	273	0.933*	0.906	0.0271‡	273	0.804*	0.776	0.0276‡
300	1.12	1.10	0.0248‡	300	1.06	1.04	0.0250‡	300	0.968	0.943	0.0252‡	300	0.840	0.814	0.0256‡
350	1.18	1.16	0.0219‡	350	1.12*	1.10	0.0220‡	350	1.02*	1.00	0.0223‡	350	0.897*	0.874	0.0226‡
400	1.22*	1.20	0.0196‡	400	1.16*	1.14	0.0197‡	400	1.07*	1.05	0.0199‡	400	0.943*	0.923	0.0202‡
500	1.28*	1.26	0.0163‡	500	1.22*	1.20	0.0164‡	500	1.14*	1.12	0.0165‡	500	1.01*	0.997	0.0168‡
600	1.30*	1.29	0.0140‡	600	1.25*	1.24	0.0140‡	600	1.17*	1.16	0.0141‡	600	1.06*	1.05	0.0144‡
700	1.32*	1.31	0.0122‡	700	1.27*	1.26	0.0122‡	700	1.20*	1.19	0.0123‡	700	1.10*	1.09	0.0126‡
800	1.32*	1.31	0.0108‡	800	1.28*	1.27	0.0109‡	800	1.22*	1.21	0.0109‡	800	1.12*	1.11	0.0111‡
821	1.32*	1.31	0.0106‡	864	1.29*	1.28	0.0101‡	864	1.23*	1.22	0.0102‡	864	1.14*	1.13	0.0104‡

† Uncertainties in the total thermal conductivity, k, are as follows:

50.00 Al - 50.00 Cu: ±12% below 80 K, ±5% between 80 and 500 K, and ±7% above 500 K.

45.00 Al - 55.00 Cu: ±15% below 80 K, ±10% between 80 and 200 K, and ±7% above 200 K.

40.00 Al - 60.00 Cu: ±15% below 80 K, ±10% between 80 and 200 K, and ±8% above 200 K.

35.00 Al - 65.00 Cu: ±20% below 80 K, ±10% between 80 and 200 K, and ±8% above 200 K.

\* Provisional value.

‡ Typical value.

\* In temperature range where no experimental thermal conductivity data are available.

TABLE 2. RECOMMENDED THERMAL CONDUCTIVITY OF ALUMINUM-COPPER ALLOY SYSTEM (continued)<sup>†</sup>  
 [Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Al: 30.00% (50.23 At.%) Cu: 70.00% (49.77 At.%)				Al: 25.00% (43.98 At.%) Cu: 75.00% (56.02 At.%)				Al: 20.00% (37.06 At.%) Cu: 80.00% (62.94 At.%)				Al: 15.00% (29.36 At.%) Cu: 85.00% (70.64 At.%)			
$\rho_0 = 6.61 \mu\Omega \text{cm}$				$\rho_0 = 12.4 \mu\Omega \text{cm}$											
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.0191‡	0.0149	0.00416‡	4	0.0121**‡	0.00788	0.00424‡	4		0.00440‡		4		0.00471‡	
6	0.0318‡	0.0224	0.00938‡	6	0.0214**‡	0.0118	0.00955‡	6		0.00991‡		6		0.0107‡	
8	0.0457‡	0.0297	0.0160‡	8	0.0321**‡	0.0158	0.0163‡	8		0.0169‡		8		0.0182‡	
10	0.0608‡	0.0370	0.0238‡	10	0.0439**‡	0.0197	0.0242‡	10		0.0251‡		10		0.0269‡	
15	0.0987‡	0.0547	0.0440‡	15	0.0743**‡	0.0294	0.0449‡	15		0.0464‡		15		0.0498‡	
20	0.134‡	0.0723	0.0614‡	20	0.102**‡	0.0391	0.0627‡	20		0.0650‡		20		0.0696‡	
25	0.163‡	0.0896	0.0737‡	25	0.124**‡	0.0485	0.0750‡	25		0.0709‡		25		0.0834‡	
30	0.188‡	0.107	0.0806‡	30	0.140**‡	0.0580	0.0822‡	30		0.0851‡		30		0.0913‡	
40	0.224‡	0.140	0.0842‡	40	0.163**‡	0.0766	0.0860‡	40		0.0891‡		40		0.0954‡	
50	0.259‡	0.172	0.0810‡	50	0.177**‡	0.0947	0.0825‡	50		0.0852‡		50		0.0917‡	
60	0.277‡	0.201	0.0760‡	60	0.190**‡	0.112	0.0775‡	60		0.0801‡		60		0.0860‡	
70	0.299‡	0.228	0.0710‡	70	0.201**‡	0.129	0.0722‡	70		0.0748‡		70		0.0801‡	
80	0.322‡	0.256	0.0662‡	80	0.213‡	0.145	0.0676‡	80		0.0699‡		80		0.0749‡	
90	0.343‡	0.281	0.0620‡	90	0.224‡	0.161	0.0631‡	90		0.0653‡		90		0.0700‡	
100	0.363‡	0.305	0.0580‡	100	0.235‡	0.176	0.0592‡	100		0.0613‡		100		0.0658‡	
150	0.455‡	0.411	0.0442‡	150	0.293‡	0.248	0.0451‡	150		0.0467‡		150		0.0501‡	
200	0.534‡	0.499	0.0357‡	200	0.347‡	0.311	0.0364‡	200		0.0377‡		200		0.0404‡	
250	0.606‡	0.576	0.0300‡	250	0.399‡	0.368	0.0306‡	250		0.0317‡		250		0.0340‡	
273	0.635‡	0.607	0.0280‡	273	0.422‡	0.393	0.0286‡	273		0.0296‡		273		0.0318‡	
300	0.668	0.642	0.0260‡	300	0.446	0.420	0.0265‡	300	0.278**‡	0.250‡	0.0275‡	300	0.442‡	0.412	0.0295‡
350	0.722‡	0.699	0.0230‡	350	0.489‡	0.466	0.0234‡	350		0.0243‡		350	0.477‡	0.451	0.0260‡
400	0.768‡	0.748	0.0205‡	400	0.529‡	0.508	0.0209‡	400		0.0217‡		400	0.507‡	0.484	0.0233‡
500	0.842‡	0.825	0.0170‡	500	0.596‡	0.579	0.0174‡	500		0.0180‡		500	0.556‡	0.537	0.0193‡
600	0.898‡	0.883	0.0146‡	600	0.652‡	0.637	0.0148‡	600		0.0154‡		600	0.593‡	0.576	0.0166‡
700	0.941‡	0.928	0.0127‡	700	0.698‡	0.685	0.0130‡	700		0.0135‡		700	0.620‡	0.606	0.0144‡
800	0.971‡	0.960	0.0113‡	800	0.735‡	0.723	0.0116‡	800		0.0120‡		800	0.642‡	0.629	0.0128‡
864	0.983‡	0.972	0.0106‡	900	0.763‡	0.753	0.0104‡	900		0.0108‡		900	0.659‡	0.647	0.0116‡
				939	0.773‡	0.763	0.0101‡	1000		0.00980‡		1000	0.671‡	0.660	0.0106‡
								1100		0.00902‡		1200	0.686‡	0.677	0.00896‡
								1232		0.00821‡		1310	0.691‡	0.683	0.00832‡

† Uncertainties in the total thermal conductivity, k, are as follows:

30.00 Al - 70.00 Cu: ±25% below 80 K, ±10% between 80 and 200 K, and ±8% above 200 K.

25.00 Al - 75.00 Cu: ±30% below 80 K, ±10% between 80 and 200 K, and ±8% above 200 K.

20.00 Al - 80.00 Cu: ±20% at 300 K.

15.00 Al - 85.00 Cu: ±20% above 300 K.

‡ Provisional value.

§ Typical value.

\* In temperature range where no experimental thermal conductivity data are available.

TABLE 2. RECOMMENDED THERMAL CONDUCTIVITY OF ALUMINUM-COPPER ALLOY SYSTEM (continued)<sup>†</sup>  
 [Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Al: 10.00% (20.74 At.%) Cu: 90.00% (79.26 At.%)				Al: 5.00% (11.03 At.%) Cu: 95.00% (88.97 At.%)				Al: 3.00% (6.79 At.%) Cu: 97.00% (93.21 At.%)				Al: 1.00% (2.32 At.%) Cu: 99.00% (97.68 At.%)			
				$\rho_o = 7.23 \mu\Omega\text{cm}$				$\rho_o = 5.53 \mu\Omega\text{cm}$				$\rho_o = 2.36 \mu\Omega\text{cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4		0.00522 <sup>‡</sup>		4	0.0197	0.0134	0.00628 <sup>‡</sup>	4	0.0259	0.0177	0.00816 <sup>‡</sup>	4	0.0531	0.0412	0.0119 <sup>‡</sup>
6		0.0118 <sup>‡</sup>		6	0.0345	0.0204	0.0141 <sup>‡</sup>	6	0.0450	0.0265	0.0185 <sup>‡</sup>	6	0.0885	0.0618	0.0267 <sup>‡</sup>
8		0.0201 <sup>‡</sup>		8	0.0509	0.0268	0.0241 <sup>‡</sup>	8	0.0669	0.0352	0.0317 <sup>‡</sup>	88	0.129	0.0824	0.0468 <sup>‡</sup>
10		0.0299 <sup>‡</sup>		10	0.0694	0.0336	0.0358 <sup>‡</sup>	10	0.0896	0.0441	0.0455 <sup>‡</sup>	10	0.173	0.103	0.0700 <sup>‡</sup>
15		0.0551 <sup>‡</sup>		15	0.116	0.0495	0.0662 <sup>‡</sup>	15	0.151	0.0654	0.0856 <sup>‡</sup>	15	0.284	0.153	0.131 <sup>‡</sup>
20		0.0772 <sup>‡</sup>		20	0.159	0.0665	0.0922 <sup>‡</sup>	20	0.207	0.0867	0.120 <sup>‡</sup>	20	0.382	0.201	0.181 <sup>‡</sup>
25		0.0924 <sup>‡</sup>		25	0.193	0.0824	0.111 <sup>‡</sup>	25	0.249	0.106	0.143 <sup>‡</sup>	25	0.463	0.250	0.213 <sup>‡</sup>
30		0.101 <sup>‡</sup>		30	0.220	0.0984	0.122 <sup>‡</sup>	30	0.282	0.128	0.157 <sup>‡</sup>	30	0.528	0.298	0.230 <sup>‡</sup>
40		0.106 <sup>‡</sup>		40	0.257	0.130	0.127 <sup>‡</sup>	40	0.329	0.169	0.160 <sup>‡</sup>	40	0.619	0.389	0.230 <sup>‡</sup>
50		0.102 <sup>‡</sup>		50	0.283	0.161	0.122 <sup>‡</sup>	50	0.361	0.209	0.152 <sup>‡</sup>	50	0.687	0.474	0.213 <sup>‡</sup>
60		0.0952 <sup>‡</sup>		60	0.304	0.189	0.115 <sup>‡</sup>	60	0.388	0.246	0.142 <sup>‡</sup>	60	0.746	0.551	0.195 <sup>‡</sup>
70		0.0890 <sup>‡</sup>		70	0.324	0.217	0.107 <sup>‡</sup>	70	0.414	0.283	0.131 <sup>‡</sup>	70	0.800	0.622	0.178 <sup>‡</sup>
80		0.0831 <sup>‡</sup>		80	0.344*	0.244	0.0995 <sup>‡</sup>	80	0.440*	0.318	0.122 <sup>‡</sup>	80	0.852*	0.688	0.164 <sup>‡</sup>
90		0.0778 <sup>‡</sup>		90	0.364*	0.271	0.0931 <sup>‡</sup>	90	0.465*	0.352	0.113 <sup>‡</sup>	90	0.903*	0.752	0.151 <sup>‡</sup>
100		0.0730 <sup>‡</sup>		100	0.385*	0.298	0.0873 <sup>‡</sup>	100	0.491*	0.386	0.105 <sup>‡</sup>	100	0.953*	0.813	0.140 <sup>‡</sup>
150		0.0555 <sup>‡</sup>		150	0.486*	0.420	0.0665 <sup>‡</sup>	150	0.618*	0.540	0.0782 <sup>‡</sup>	150	1.18*	1.08	0.103 <sup>‡</sup>
200	0.442*	0.397	0.0448 <sup>‡</sup>	200	0.581*	0.527	0.0538 <sup>‡</sup>	200	0.740*	0.677	0.0626 <sup>‡</sup>	200	1.38*	1.30	0.0816 <sup>‡</sup>
250	0.522*	0.484	0.0377 <sup>‡</sup>	250	0.673*	0.628	0.0452 <sup>‡</sup>	250	0.854*	0.802	0.0523 <sup>‡</sup>	250	1.55*	1.48	0.0678 <sup>‡</sup>
273	0.555*	0.520	0.0352 <sup>‡</sup>	273	0.713*	0.671	0.0422 <sup>‡</sup>	273	0.903*	0.854	0.0489 <sup>‡</sup>	273	1.63*	1.57	0.0628 <sup>‡</sup>
300	0.596	0.563	0.0327 <sup>‡</sup>	300	0.757	0.718	0.0391 <sup>‡</sup>	300	0.960	0.915	0.0452 <sup>‡</sup>	300	1.71	1.65	0.0580 <sup>‡</sup>
350	0.665	0.636	0.0288 <sup>‡</sup>	350	0.835	0.800	0.0346 <sup>‡</sup>	350	1.06	1.02	0.0398 <sup>‡</sup>	350	1.83	1.78	0.0506 <sup>‡</sup>
400	0.730	0.704	0.0258 <sup>‡</sup>	400	0.905	0.874	0.0309 <sup>‡</sup>	400	1.15	1.11	0.0356 <sup>‡</sup>	400	1.94	1.89	0.0450 <sup>‡</sup>
500	0.843	0.822	0.0214 <sup>‡</sup>	500	1.03	1.00	0.0257 <sup>‡</sup>	500	1.30	1.27	0.0294 <sup>‡</sup>	500	2.10	2.06	0.0368 <sup>‡</sup>
600	0.941	0.923	0.0183 <sup>‡</sup>	600	1.13	1.11	0.0220 <sup>‡</sup>	600	1.43*	1.40	0.0251 <sup>‡</sup>	600	2.22*	2.19	0.0310 <sup>‡</sup>
700	1.03	1.01	0.0160 <sup>‡</sup>	700	1.22	1.20	0.0192 <sup>‡</sup>	700	1.51*	1.49	0.0219 <sup>‡</sup>	700	2.31*	2.28	0.0269 <sup>‡</sup>
800	1.09	1.08	0.0143 <sup>‡</sup>	800	1.30	1.28	0.0171 <sup>‡</sup>	800	1.59*	1.57	0.0195 <sup>‡</sup>	800	2.37*	2.35	0.0236 <sup>‡</sup>
900	1.14	1.13	0.0123 <sup>‡</sup>	900	1.36	1.34	0.0154 <sup>‡</sup>	900	1.66*	1.64	0.0175 <sup>‡</sup>	900	2.41*	2.39	0.0211 <sup>‡</sup>
1000	1.18	1.17	0.0117 <sup>‡</sup>	1000	1.39	1.38	0.0140 <sup>‡</sup>	1000	1.70*	1.68	0.0158 <sup>‡</sup>	1000	2.44*	2.42	0.0190 <sup>‡</sup>
1200	1.25	1.24	0.00991 <sup>‡</sup>	1200	1.47*	1.46	0.0119 <sup>‡</sup>	1200	1.77*	1.76	0.0135 <sup>‡</sup>	1200	2.48*	2.46	0.0159 <sup>‡</sup>
1313	1.27	1.26	0.00918 <sup>‡</sup>	1331	1.50*	1.49	0.0108 <sup>‡</sup>	1343	1.80*	1.79	0.0123 <sup>‡</sup>	1352	2.49*	2.48	0.0142 <sup>‡</sup>

<sup>†</sup> Uncertainties in the total thermal conductivity, k, are as follows:

10.00 Al - 90.00 Cu:  $\pm 10\%$  above 200 K.

5.00 Al - 95.00 Cu:  $\pm 8\%$  below 80 K,  $\pm 6\%$  between 80 and 500 K, and  $\pm 8\%$  above 500 K.

3.00 Al - 97.00 Cu:  $\pm 8\%$  below 80 K,  $\pm 5\%$  between 80 and 500 K, and  $\pm 7\%$  above 500 K.

1.00 Al - 99.00 Cu:  $\pm 8\%$  below 80 K,  $\pm 5\%$  between 80 and 500 K, and  $\pm 6\%$  above 500 K.

<sup>‡</sup> Provisional value.

<sup>\*</sup> Typical value.

<sup>\*</sup> In temperature range where no experimental thermal conductivity data are available.

TABLE 2. RECOMMENDED THERMAL CONDUCTIVITY OF ALUMINUM-COPPER ALLOY SYSTEM (continued)<sup>†</sup>

[Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

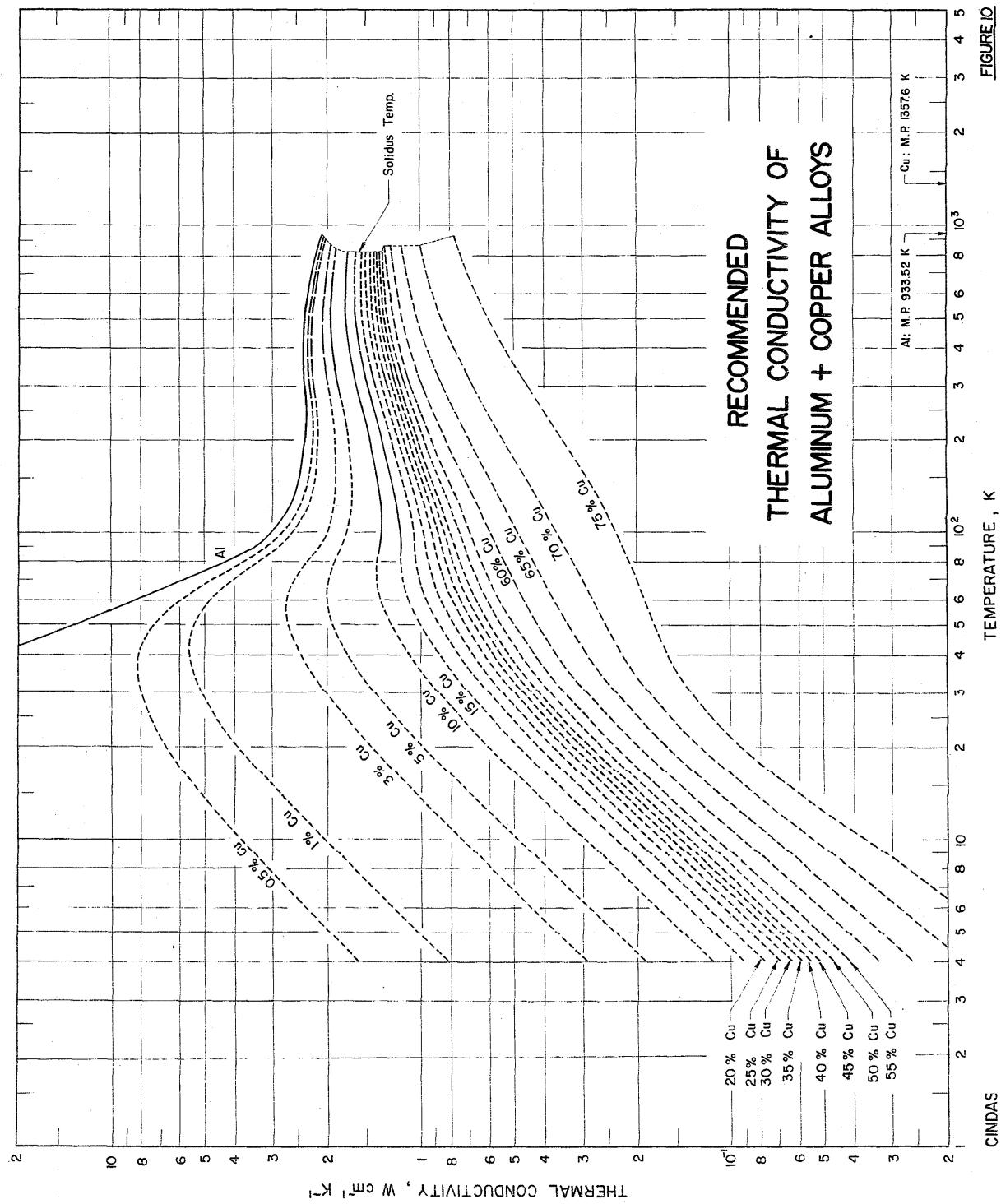
Al: 0.50% (1.17 At. %) Cu: 99.50% (98.83 At. %)			
$\rho_0 = 1.270 \mu\Omega\text{cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.0911	0.0771	0.0140
6	0.146	0.115	0.0314
8	0.209	0.154	0.0552
10	0.277	0.192	0.0854
15	0.445	0.282	0.163
20	0.591	0.369	0.222
25	0.715	0.455	0.260
30	0.819	0.539	0.280
40	0.975	0.695	0.280
50	1.09	0.832	0.260
60	1.18	0.948	0.236
70	1.26	1.05	0.214
80	1.34 <sup>‡</sup>	1.15	0.195
90	1.41 <sup>‡</sup>	1.22	0.180
100	1.47 <sup>‡</sup>	1.30	0.166
150	1.74 <sup>‡</sup>	1.62	0.121 <sup>‡</sup>
200	1.96 <sup>‡</sup>	1.87	0.0950 <sup>‡</sup>
250	2.14 <sup>‡</sup>	2.06	0.0786 <sup>‡</sup>
273	2.21 <sup>‡</sup>	2.14	0.0731 <sup>‡</sup>
300	2.28	2.21	0.0672 <sup>‡</sup>
350	2.39	2.33	0.0585 <sup>‡</sup>
400	2.49	2.44	0.0520 <sup>‡</sup>
500	2.63 <sup>‡</sup>	2.59	0.0422 <sup>‡</sup>
600	2.73 <sup>‡</sup>	2.69	0.0355 <sup>‡</sup>
700	2.76 <sup>‡</sup>	2.73	0.0306 <sup>‡</sup>
800	2.79 <sup>‡</sup>	2.76	0.0268 <sup>‡</sup>
900	2.80 <sup>‡</sup>	2.78	0.0238 <sup>‡</sup>
1000	2.80 <sup>‡</sup>	2.78	0.0215 <sup>‡</sup>
1200	2.79 <sup>‡</sup>	2.77	0.0180 <sup>‡</sup>
1354	2.76 <sup>‡</sup>	2.74	0.0160 <sup>‡</sup>

<sup>†</sup> Uncertainties in the total thermal conductivity, k, are as follows:

0.50 Al - 99.50 Cu:  $\pm 6\%$  below 80 K,  $\pm 5\%$  between 30 and 500 K, and  $\pm 6\%$  above 500 K.

<sup>‡</sup> Typical value.

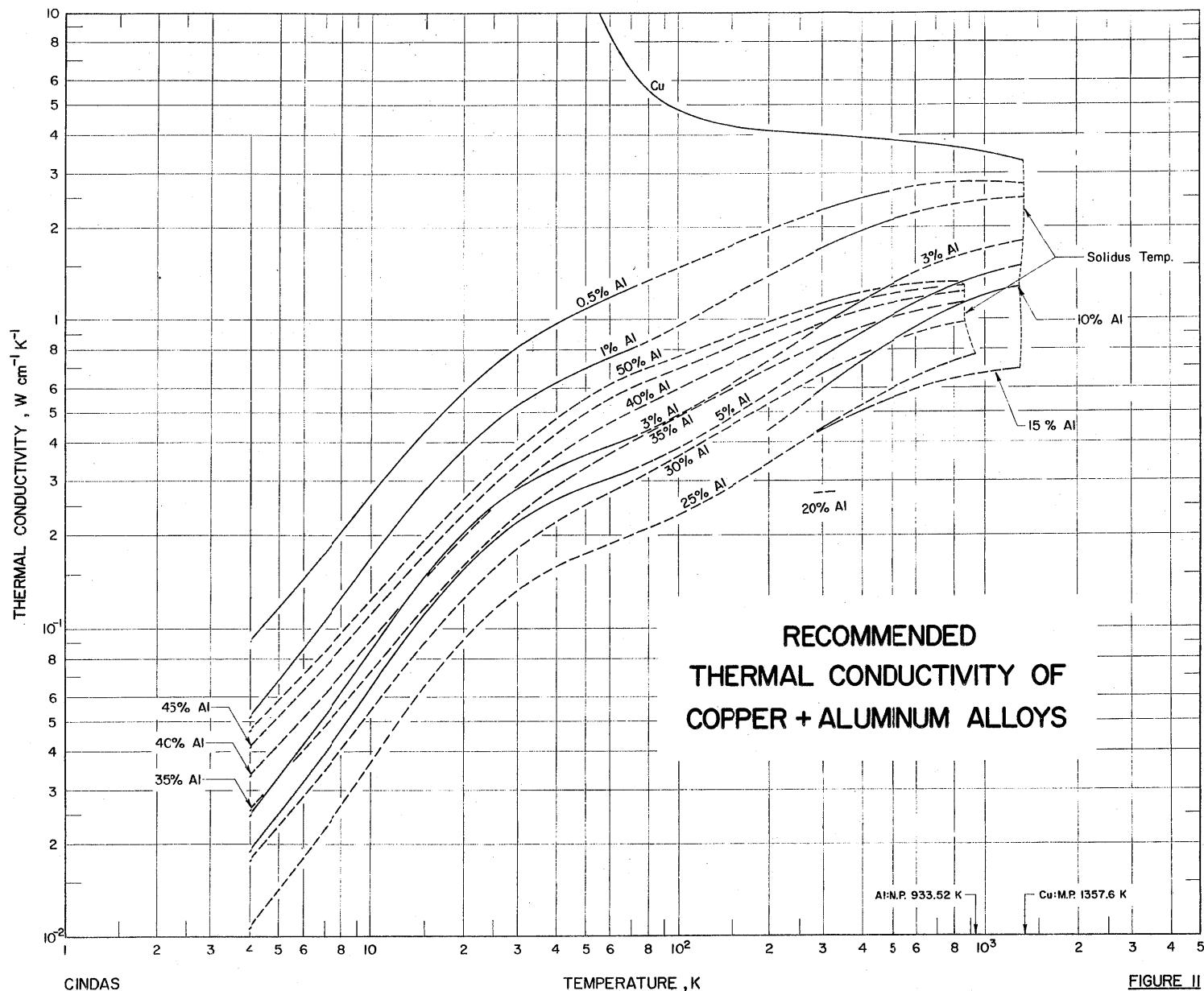
\* In temperature range where no experimental thermal conductivity data are available.



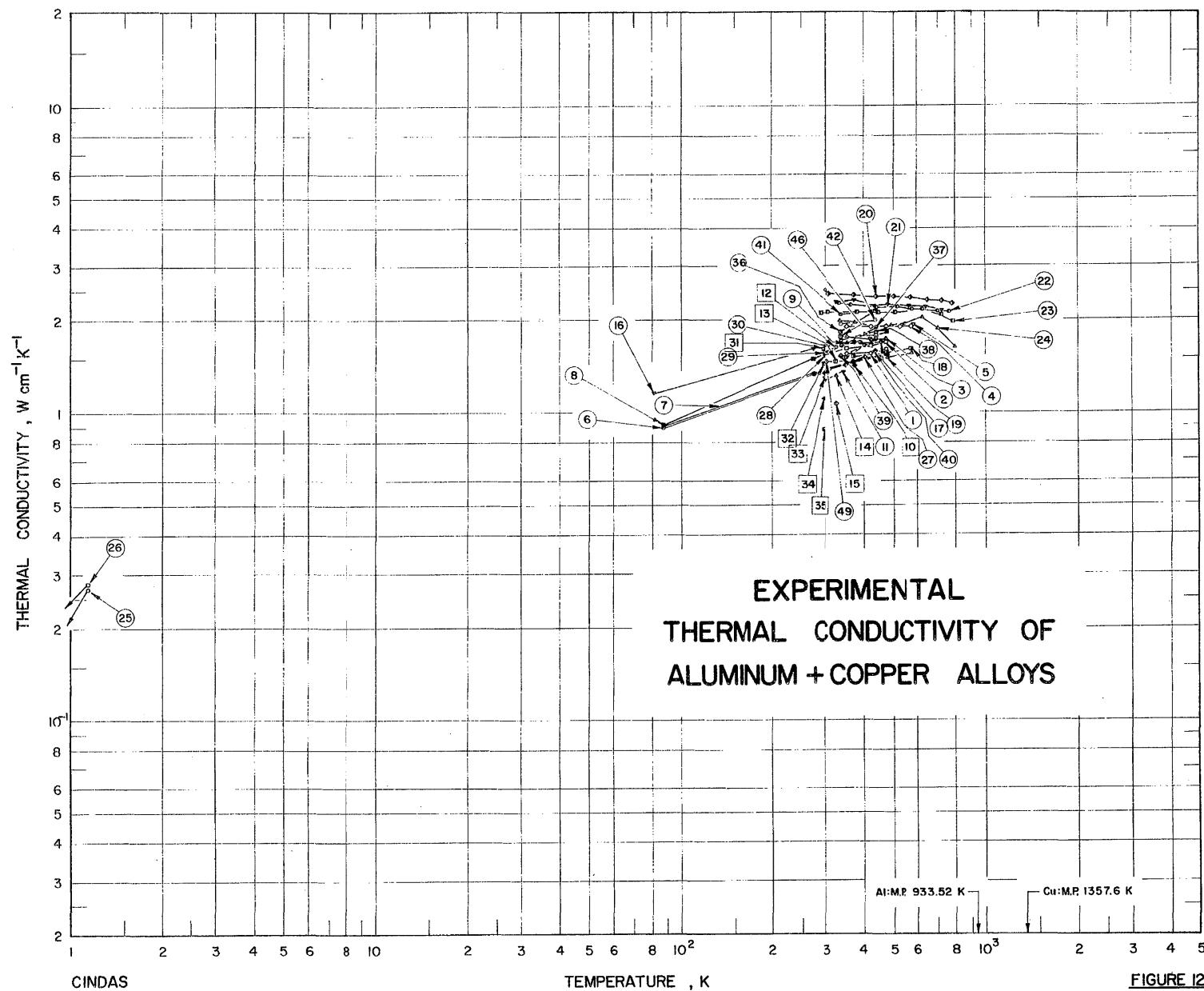
CINDAS

TEMPERATURE, K

FIGURE 10



**FIGURE II**

FIGURE I2

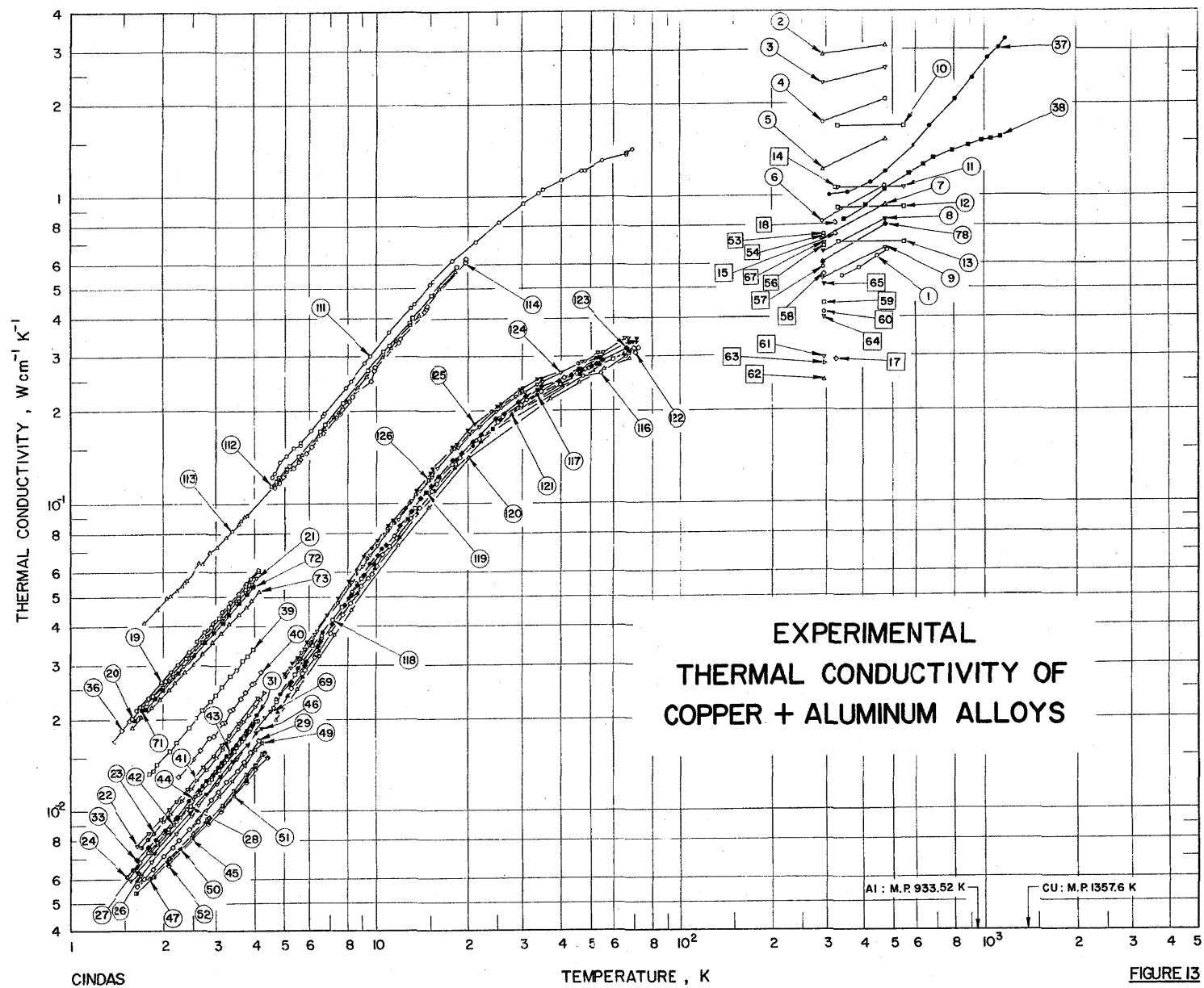


TABLE 3. THERMAL CONDUCTIVITY OF ALUMINUM + COPPER ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent)		Composition (continued), Specifications, and Remarks
							Al	Cu	
1	44	Griffiths, E. and Schofield, F. H.	1928	L	353-473	No. 655	86.0	14.0	1.125 in. diameter and 15.5 in. long; 2 specimens chill-cast and 2 specimens sand-cast; one of each annealed at 450°C for 1 hr; electrical resistivity reported as 5.24, 6.25, 6.97, 7.69, 8.40, and 9.14 $\mu\Omega$ cm at 353, 423, 473, 523, 573, and 623 K, respectively; smoothed values reported.
2	44	Griffiths, E. and Schofield, F. H.	1928	L	353-473	No. 671	88.0	12.0	Similar to above except electrical resistivity reported as 5.20, 5.96, 6.51, 7.03, 7.57, and 8.11 $\mu\Omega$ cm at 353, 423, 473, 523, 573, and 623 K, respectively.
3	44	Griffiths, E. and Schofield, F. H.	1928	L	353-473	No. 921	~88.0	~12.0	Trace Fe; 1.125 in. diameter and 15.5 in. long; 2 specimens chill-cast; one of which annealed at 450°C for 1 hr; electrical resistivity reported as 4.64, 5.61, 6.34, 7.12, 7.95, and 8.82 $\mu\Omega$ cm at 353, 423, 473, 523, 573, and 623 K, respectively; smoothed values reported.
4	44	Griffiths, E. and Schofield, F. H.	1928	L	353-573	No. 2313	92.0	8.0	Similar to above except electrical resistivity reported as 4.06, 4.77, 5.40, 6.16, 7.03, and 8.08 $\mu\Omega$ cm at 353, 423, 473, 523, 573, and 623 K, respectively.
5	44	Griffiths, E. and Schofield, F. H.	1928	L	353-573	No. 2312	95.5	4.5	Similar to above except electrical resistivity reported as 4.04, 4.96, 5.61, 6.26, 6.92, and 7.58 $\mu\Omega$ cm at 353, 423, 473, 523, 573, and 623 K, respectively.
6	41	Mannchen, W.	1931	L	87-476		92.0	8.0	Cast; electrical conductivity reported as 65.1, 29.3, 20.2, and $14.6 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 87, 273, 373, and 476 K, respectively; Lorenz function 1.549, 1.650, 1.891, and $2.18 \times 10^{-8} \text{V}^2 \text{K}^{-2}$ at the above temperatures, respectively.
7	41	Mannchen, W.	1931	L	87-476				The above specimen; Lorenz function 1.58, 1.64, 1.94, and $2.20 \times 10^{-8} \text{V}^2 \text{K}^{-2}$ at the above temperatures, respectively.
8	41	Mannchen, W.	1931	L	87-476		85.0	15.0	Cast; electrical conductivity reported as 59.6, 22.3, 16.0, and $14.2 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 87, 273, 373, and 476 K, respectively; Lorenz function 1.74, 2.43, 2.79, and $2.67 \times 10^{-8} \text{V}^2 \text{K}^{-2}$ at the above temperatures, respectively.
9	113	Grard, C. and Villey, J.	1927	E	353-423		96.0	4.0	Approximate composition; cast.
10	113	Grard, C. and Villey, J.	1927	E	373.2		88.0	12.0	Cast; density $2.95 \text{ g cm}^{-3}$ ; electrical conductivity $0.16 \times 10^6 \Omega^{-1} \text{cm}^{-1}$ at 100°C.
11	114	Czochralski, J.	1921		301-346		92.0	~8.0	Trace Si; density 2.85 to $2.9 \text{ g cm}^{-3}$ .
12	45	Smith, A. W.	1925	L	326.2		90.0	10.0	1.9 cm in diameter and 10 cm long; prepared by fusing 99.97% pure aluminum and copper supplied by Baker; electrical conductivity $26.0 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 23°C.
13	45	Smith, A. W.	1925	L	326.2		80.0	20.0	Similar to above except electrical conductivity $20.9 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 23°C.
14	45	Smith, A. W.	1925	L	326.2		70.0	30.0	Similar to above except electrical conductivity $18.5 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 23°C.
15	45	Smith, A. W.	1925	L	326.2		50.0	50.0	Similar to above except electrical conductivity $15.3 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 23°C.
16	42	Eucker, A. and Warrentrup, H.	1935	R	81,273		96.0	4.0	Cast sheet; annealed at 510°C for 45 min and quenched in ice water; electrical resistivity 1.409 and $3.600 \mu\Omega$ cm at -192 and 0°C, respectively.

\* Not shown in figure.

TABLE 3. THERMAL CONDUCTIVITY OF ALUMINUM + COPPER ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION (continued)

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent) Al Cu	Composition (continued), Specifications, and Remarks
17	46	Griffiths, E. and Shakespear, G.A.	1922	L	353-453	V 671 A	88.0 12.0	15 in. long and 1 in. in diameter; supplied by Metallurgical Dept. of National Physical Laboratory (England); chill-cast.
18	46	Griffiths, E. and Shakespear, G.A.	1922	L	373-573	V 671 D	88.0 12.0	Prepared from commercially pure aluminum; 15 in. long and 1 in. in diameter; supplied by Metallurgical Dept. of National Physical Lab.; annealed at 450 C.
19	46	Griffiths, E. and Shakespear, G.A.	1922	L	373-573	V 671 C	88.0 12.0	Similar to above specimen except sand-cast.
20	58	Mikryukov, V.E. and Karagezyan, A.G.	1961	E	288-777		99.5 0.5	3 mm diameter and 300 mm long; prepared from 99.9 pure Al.
21	58	Mikryukov, V.E. and Karagezyan, A.G.	1961	E	328-723		99.0 1.0	Similar to above.
22	58	Mikryukov, V.E. and Karagezyan, A.G.	1961	E	333-762		96.0 4.0	Similar to above.
23	58	Mikryukov, V.E. and Karagezyan, A.G.	1961	E	288-781		93.0 7.0	Similar to above.
24	58	Mikryukov, V.E. and Karagezyan, A.G.	1961	E	334-792		90.0 10.0	Similar to above.
25	43	Satterthwaite, C.B.	1962	L	0.4-1.2	Al-26	0.3	Bar specimen with end sections machined to 0.5 in. diameter and 0.375 in. long, and with center portion 3.2 cm long milled to 0.5 mm thick and 2 mm wide; electrical resistivity ratio $\rho(273K)/\rho(1.2K) = 26$ ; transition temperature (s.c.) $T_c = 1.149$ K; in superconducting state.
26	43	Satterthwaite, C.B.	1962	L	0.4-1.2	Al-26		The above specimen measured in normal state; reported values calculated from the given formula $k = 0.242 T$ ( $W \text{ cm}^{-1} \text{ K}^{-1}$ ) in the same temperature range as above.
27	115	Elflein, M.	1937	L	298-393	1,1	5	Cylindrical specimen 1.5 cm in diameter and 3.0 cm in length; cast from 98 to 99 pure Al bar (contamination: <1.0 Fe, <0.9 Si, and <0.1 Cu + Zn) and key alloy (50 Al and 50 Cu) at 750 C, and then cooled in air; electrical resistivity reported as $5.00 \mu\Omega \text{ cm}$ at 20 C.
28	115	Elflein, M.	1937	L	298-393	1,5	5	Similar to the above specimen except 99.5 pure Al notch bar (contamination: 0.28 Fe and 0.22 Si) used for the melting; electrical resistivity reported as $4.56 \mu\Omega \text{ cm}$ at 20 C.
29	115	Elflein, M.	1937	L	298-393	1,5A	5	Similar to the above specimen except electrical resistivity reported as $4.66 \mu\Omega \text{ cm}$ at 20 C.
30	115	Elflein, M.	1937	L	298-393	1,5B	5	Similar to the above specimen except electrical resistivity reported as $4.42 \mu\Omega \text{ cm}$ at 20 C.
31	116, 168	Aliev, N.A.	1953	L	295.2	1	10.24	$1.25 \text{ cm}^2$ in cross-section and 0.64 cm thick; electrical conductivity $21.18 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ ; total Lorenz function $2.564 \times 10^{-8} \text{ V}^2 \text{ K}^{-2}$ .
32	116, 168	Aliev, N.A.	1953	L	295.2	2	20.78	$1.25 \text{ cm}^2$ in cross-section and 0.79 cm thick; electrical conductivity $18.79 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ ; total Lorenz function $2.594 \times 10^{-8} \text{ V}^2 \text{ K}^{-2}$ .
33	116, 168	Aliev, N.A.	1953	L	295.2	3	30.32	$1.25 \text{ cm}^2$ in cross-section and 0.90 cm thick; electrical conductivity $16.72 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ ; total Lorenz function $2.652 \times 10^{-8} \text{ V}^2 \text{ K}^{-2}$ .

TABLE 3. THERMAL CONDUCTIVITY OF ALUMINUM + COPPER ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION (continued)

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent) Al Cu	Composition (continued), Specifications, and Remarks
34	116, 168	Aliev, N. A.	1953	L	295.2	4	40.82	1.25 cm <sup>2</sup> in cross-section and 0.68 cm thick; electrical conductivity $15.26 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ ; total Lorenz function $2.455 \times 10^{-8} \text{V}^2 \text{K}^{-2}$ .
35	116, 168	Aliev, N. A.	1953	L	295.2	5	48.00	1.25 cm <sup>2</sup> in cross-section and 0.70 cm thick; electrical conductivity $12.41 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ ; total Lorenz function $2.378 \times 10^{-8} \text{V}^2 \text{K}^{-2}$ .
36	47	Hanson, D. and Rodgers, C. E.	1932	L	338, 438	3	98.47	1.01
37	47	Hanson, D. and Rodgers, C. E.	1932	L	338, 438	5	94.47	5.06
38	47	Hanson, D. and Rodgers, C. E.	1932	L	338, 438	6	92.34	7.20
39	47	Hanson, D. and Rodgers, C. E.	1932	L	338, 438	8	88.05	11.51
40	47	Hanson, D. and Rodgers, C. E.	1932	L	338, 438	9	79.52	15.46
41	47	Hanson, D. and Rodgers, C. E.	1932	L	338, 438	3A	98.49	1.01
42	47	Hanson, D. and Rodgers, C. E.	1932	L	338, 438	5A	94.47	5.06
43*	47	Hanson, D. and Rodgers, C. E.	1932	L	338, 438	6A	92.34	7.20
44*	47	Hanson, D. and Rodgers, C. E.	1932	L	338, 438	8A	88.05	11.51
45*	47	Hanson, D. and Rodgers, C. E.	1932	L	338, 438	9A	84.12	15.46
46	47	Hanson, D. and Rodgers, C. E.	1932	L	338, 438	10A	79.52	20.08
47*	47	Hanson, D. and Rodgers, C. E.	1932	L	338, 438	11A	74.03	25.60
48*	47	Hanson, D. and Rodgers, C. E.	1932	L	338, 438	12A	69.17	30.46
49	47	Hanson, D. and Rodgers, C. E.	1932	L	303, 373	10	79.52	20.08

\* Not shown in figure.

TABLE 4. THERMAL CONDUCTIVITY OF COPPER + ALUMINUM ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent)		Composition (continued), Specifications, and Remarks
							Cu	Al	
1	44	Griffiths, E. and Schofield, F. H.	1928	L	343-480	Aluminum bronze; 6	90.0	10.0	2.53 cm in diameter and 38 cm long; chill-cast and annealed; electrical resistivity reported as 14.7, 15.6, 16.0, 16.7, 17.5, and 18.3 $\mu\Omega$ cm at 293, 348, 373, 423, 473, and 523 K, respectively.
2	49	Smith, C. S. and Palmer, E. W.	1935	L	293, 473	100	99.77	0.22	0.01 Fe; 0.75 in. in diameter and 8 in. long; rolled, annealed, and cold-drawn; heat-treated at 750 C for 2 hr; electrical conductivity reported as 41.91 and $27.59 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 20 and 200 C, respectively.
3	49	Smith, C. S. and Palmer, E. W.	1935	L	293, 473	101	99.47	0.47	0.02 Fe; similar to the above specimen except electrical conductivity reported as 32.10 and $22.91 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 20 and 200 C, respectively.
4	49	Smith, C. S. and Palmer, E. W.	1935	L	293, 473	76	99.20	0.71	0.09 Fe; similar to the above specimen except heat-treated at 700 C; electrical conductivity reported as 23.40 and $17.95 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 20 and 200 C, respectively.
5	49	Smith, C. S. and Palmer, E. W.	1935	L	293, 473	77	98.08	1.89	0.03 Fe; similar to the above specimen except electrical conductivity reported as 15.91 and $13.00 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 20 and 200 C, respectively.
6	49	Smith, C. S. and Palmer, E. W.	1935	L	293, 473	45	95.25	4.61	0.14 Fe; similar to the above specimen except electrical conductivity reported as 10.26 and $8.824 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 20 and 200 C, respectively.
7	49	Smith, C. S. and Palmer, E. W.	1935	L	293, 473	46	92.15	7.72	0.13 Fe; 0.75 in. in diameter and 8 in. long; rolled, annealed, and cold-drawn; heat-treated at 750 C for 3.5 hr; slowly cooled in furnace; electrical conductivity reported as 8.834 and $7.65 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 20 and 200 C, respectively.
8	49	Smith, C. S. and Palmer, E. W.	1935	L	293, 473	102	90.56	9.37	0.07 Fe; similar to the above specimen except heat-treated at 750 C for 2 hr, then very slowly cooled in furnace to 550 C, held for 4 hr, again furnace-cooled to 450 C, held for 16 hr, cooled to room temperature; electrical conductivity reported as 8.24 and $7.056 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 20 and 200 C, respectively.
9	49	Smith, C. S. and Palmer, E. W.	1935	L	293, 473	130	87.76	12.15	0.09 Fe; similar to the above specimen except electrical conductivity reported as 6.925 and $5.738 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 20 and 200 C, respectively.
10	47	Hanson, D. and Rodgers, C. E.	1932	L	333, 543	30a	98.25	1.75	Prepared from Al (containing 0.21 Fe, 0.29 Si) and high grade Cu; 0.5 in. diameter and 6.5 in. long; cast in iron mould 7 in. long and 9/16 in. in diameter, machined to size; annealed at 500 C.
11	47	Hanson, D. and Rodgers, C. E.	1932	L	333, 543	28	94.90	5.10	Similar to the above specimen.
12	47	Hanson, D. and Rodgers, C. E.	1932	L	333, 543	27a	91.55	8.45	Similar to the above specimen.
13	47	Hanson, D. and Rodgers, C. E.	1932	L	333, 543	25	87.22	12.78	Similar to the above specimen.
14	45	Smith, A. W.	1925	L	326.2		50.0	50.0	1.9 cm in diameter and 10 cm long; prepared by double-fusing the Baker's analyzed copper and aluminum; electrical conductivity $15.3 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 23 C.
15	45	Smith, A. W.	1925	L	326.2		60.0	40.0	Similar to the above specimen except electrical conductivity $10.6 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 23 C.
16*	45	Smith, A. W.	1925	L	326.2		70.0	30.0	Similar to the above specimen except electrical conductivity $9.76 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 23 C.

\* Not shown in figure.

TABLE 4. THERMAL CONDUCTIVITY OF COPPER + ALUMINUM ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION (continued)

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent) Cu      Al	Composition (continued), Specifications, and Remarks
17	45	Smith, A.W.	1925	L	326.2		80.0    20.0	Similar to the above specimen except electrical conductivity $3.60 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 23 C.
18	45	Smith, A.W.	1925	L	326.2		90.0    10.0	Similar to the above specimen except electrical conductivity $9.98 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 23 C.
19	51	Salter, J.A.M. and Charsley, P.	1967	L	1.7-4.2	2S	99.17    0.83	Calculated composition; single crystal; grown in a sealed graphite mould using the Bridgman technique; annealed in vacuo at 750 C for 14 hr; residual electrical resistivity $2.07 \mu\Omega \text{ cm}$ .
20	51	Salter, J.A.M. and Charsley, P.	1967	L	1.6-4.2	2	99.10    0.90	Calculated composition; polycrystalline; rod specimen 3 mm in diameter; annealed in vacuo at 750 C for 14 hr; residual electrical resistivity $2.12 \mu\Omega \text{ cm}$ ; grain size 0.008 cm.
21	51	Salter, J.A.M. and Charsley, P.	1967	L	1.8-4.1	2AR	99.17    0.83	Calculated composition; polycrystalline; rod specimen 3 mm in diameter; residual electrical resistivity $2.10 \mu\Omega \text{ cm}$ ; grain size 0.0015 cm.
22	51	Salter, J.A.M. and Charsley, P.	1967	L	1.7-4.2	8S	96.69    3.31	Calculated composition; single crystal; grown in a sealed graphite mould using the Bridgman technique; annealed in vacuo at 750 C for 14 hr; residual electrical resistivity $6.50 \mu\Omega \text{ cm}$ .
23	51	Salter, J.A.M. and Charsley, P.	1967	L	1.7-4.2	8	95.91    4.09	Calculated composition; polycrystalline; rod specimen 3 mm in diameter; annealed in vacuo at 750 C for 14 hr; grain size 0.0063 cm; residual electrical resistivity $6.63 \mu\Omega \text{ cm}$ .
24	51	Salter, J.A.M. and Charsley, P.	1967	L	1.5-4.2	12	94.89    5.11	Calculated composition; similar to the above specimen except residual electrical resistivity $7.21 \mu\Omega \text{ cm}$ and grain size 0.011 cm.
25*	51	Salter, J.A.M. and Charsley, P.	1967	L	1.9-4.1	12(550)	94.72    5.28	Calculated composition; polycrystalline; rod specimen 3 mm in diameter; annealed in vacuo at 550 C for 14 hr; grain size 0.0025 cm; residual electrical resistivity $7.41 \mu\Omega \text{ cm}$ .
26	51	Salter, J.A.M. and Charsley, P.	1967	L	1.7-4.0	12(450)	94.72    5.28	Calculated composition; polycrystalline; rod specimen 3 mm in diameter; annealed in vacuo at 450 C for 14 hr; residual electrical resistivity $7.57 \mu\Omega \text{ cm}$ ; grain size 0.0009 cm.
27	117	Charsley, P., Leaver, A.D.W. and Salter, J.A.M.	1968	L	1.7-4.1		94.87    5.13	Single crystal; $0.2 \times 10 \times 2.5 \text{ cm}$ ; prepared by International Research and Development Co.; grown in graphite mould using Bridgman technique; measured in jig in the relaxed condition.
28	117	Charsley, P., et al.	1968	L	1.8-4.1		94.87    5.13	The above specimen; measured in jig under a stress of $7 \text{ kg mm}^{-2}$ .
29	117	Charsley, P., et al.	1968	L	1.7-4.2		94.87    5.13	Polycrystalline; prepared by International Research and Development Co.; measured in jig in the relaxed condition.
30*	117	Charsley, P., et al.	1968	L	1.7-4.1		94.87    5.13	The above specimen; annealed at 750 C for 15 hr and measured in jig under a stress of $7 \text{ kg mm}^{-2}$ .
31	117	Charsley, P., et al.	1968	L	1.9-4.1	A <sub>1</sub> A <sub>2</sub> ; cross 1	94.87    5.13	Single crystal; grown in graphite mould using Bridgman technique; prepared by International Research and Development Co.; cross shape specimen obtained by cutting perpendicular to the large face of the crystal ( $0.2 \times 10 \times 2.5 \text{ cm}$ ); the orientation of the cross was chosen such that the primary edge dislocations made equal angles with both arms A <sub>1</sub> A <sub>2</sub> and B <sub>1</sub> B <sub>2</sub> , the angle between the screw dislocations and these two directions however differed; heat flow in the arm A <sub>1</sub> A <sub>2</sub> direction (angle to edges 55°, and angle to screws 35°).

\* Not shown in figure.

TABLE 4. THERMAL CONDUCTIVITY OF COPPER + ALUMINUM ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION (continued)

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent) Cu      Al	Composition (continued), Specifications, and Remarks
32*	117	Charsley, P., Leaver, A.D.W. and Salter, J.A.M.	1968	L	2.0-4.2	A <sub>1</sub> A <sub>2</sub> ; cross 1	94.87    5.13	The above specimen measured in different cryostats.
33	117	Charsley, P., et al.	1968	L	1.7-4.1	B <sub>1</sub> B <sub>2</sub> ; cross 1		The above specimen; heat flow in the arm B <sub>1</sub> B <sub>2</sub> direction (angle to edges 63°, and angle to screws 73°).
34*	117	Charsley, P., et al.	1968	L	1.7-4.2	A <sub>1</sub> A <sub>2</sub> ; cross 2	94.87    5.13	Similar to the above specimen except the orientation of the cross was chosen such that the primary edge dislocations made different angles with both arms A <sub>1</sub> A <sub>2</sub> and B <sub>1</sub> B <sub>2</sub> , the angle between the screw dislocations and these two directions however equal; heat flow in the arm A <sub>1</sub> A <sub>2</sub> direction (angle to edges 80°, and angle to screws 52°).
35*	117	Charsley, P., et al.	1968	L	1.8-3.4	B <sub>1</sub> B <sub>2</sub> ; cross 2		The above specimen; heat flow in the arm B <sub>1</sub> B <sub>2</sub> direction (angle to edges 46°, and angle to screws 52°).
36	19	Lindenfeld, P. and Pennebaker, W.B.	1962	L	1.4-4.2		0.617	Calculated composition; 3 x 0.125 x 0.031 in.; prepared from 99.999 pure Cu and 99.99% pure Al; materials melted, outgassed in vacuum, stirred for 0.5 hr, then cast; annealed at 700 C for 22 hr; residual electrical resistivity 2.10 $\mu\Omega$ cm.
37	55	Inouye, H.	1957	C	309-1171		94    6	Iron and alumina used as comparative materials; data taken from smoothed curve.
38	55	Inouye, H.	1957	C	348-1125		92    8	Similar to the above specimen.
39	118	Charsley, P. and Salter, J.A.M.	1965	L	1.8-4.0	4	1.84	Calculated composition; polycrystalline; 3 mm diameter and 12 cm long; prepared by International Research and Development Co., Ltd.; materials melted in pure argon, cast, machined, swaged, and drawn; annealed in vacuo at 750 C for 14 hr; residual electrical resistivity 3.88 $\mu\Omega$ cm.
40	118	Charsley, P. and Salter, J.A.M.	1965	L	2.3-4.2	6	2.68	Similar to the above specimen except residual electrical resistivity 5.20 $\mu\Omega$ cm.
41	118	Charsley, P. and Salter, J.A.M.	1965	L	2.0-4.4	10	4.22	Similar to the above specimen except residual electrical resistivity 6.62 $\mu\Omega$ cm.
42	118	Charsley, P. and Salter, J.A.M.	1965	L	1.8-3.1	12S	5.11	Calculated composition; single crystal; 3 mm diameter and 12 cm long; grown by the Bridgman technique; grain size 0.1 ~ 0.3 mm; residual electrical resistivity 7.49 $\mu\Omega$ cm.
43	118	Charsley, P. and Salter, J.A.M.	1965	L	2.2-4.2	12S		The above specimen; 2nd run.
44	118	Charsley, P. and Salter, J.A.M.	1965	L	2.5-4.0	12S		Similar to the above specimen.
45	53	Kusunoki, M. and Suzuki, H.	1939	L	1.7-4.3	Specimen No. 5	93.03    6.97	Calculated composition; single crystal; cross-sectional area 2.546 mm <sup>2</sup> ; prepared from 99.999 pure Cu (Mitsubishi-Kinzoku Co. Ltd.) and 99.99 pure Al (Sumitomo-Kinzoku Co. Ltd.) by melting in a high purity graphite crucible by induction heating; grown in a splitting graphite mould by the Bridgman method using a seed crystal; annealed at 1000 C for 48 hr in a vacuum better than 10 <sup>-5</sup> mm Hg; electrolytically polished in phosphoric acid-ethyl alcohol; dislocation density 5.8 x 10 <sup>10</sup> cm <sup>-2</sup> ; residual electrical resistivity 7.617 $\mu\Omega$ cm.

TABLE 4. THERMAL CONDUCTIVITY OF COPPER + ALUMINUM ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION (continued)

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent) Cu      Al	Composition (continued), Specifications, and Remarks
46	53	Kusunoki, M. and Suzuki, H.	1969	L	1.7-4.3	Specimen No. 9	93.03    6.97	Similar to the above specimen except specimen cross-sectional area $2.924 \text{ mm}^2$ , dislocation density $1.0 \times 10^{10} \text{ cm}^{-2}$ , and residual electrical resistivity $7.108 \mu\Omega \text{ cm}$ .
47	53	Kusunoki, M. and Suzuki, H.	1969	L	1.8-4.3	Specimen No. 11		Similar to the above specimen except specimen cross-sectional area $1.535 \text{ mm}^2$ , dislocation density $6.6 \times 10^{10} \text{ cm}^{-2}$ , and residual electrical resistivity $7.568 \mu\Omega \text{ cm}$ .
48*	53	Kusunoki, M. and Suzuki, H.	1969	L	1.7-4.3	Specimen No. 12(1)		Similar to the above specimen except specimen cross-sectional area $1.915 \text{ mm}^2$ , dislocation density $2.0 \times 10^{10} \text{ cm}^{-2}$ , and residual electrical resistivity $7.562 \mu\Omega \text{ cm}$ .
49	53	Kusunoki, M. and Suzuki, H.	1969	L	1.7-4.3	Specimen No. 13(1)		Similar to the above specimen except specimen cross-sectional area $2.318 \text{ mm}^2$ , dislocation density $3.6 \times 10^{10} \text{ cm}^{-2}$ , and residual electrical resistivity $7.571 \mu\Omega \text{ cm}$ .
50	53	Kusunoki, M. and Suzuki, H.	1969	L	1.6-4.3	Specimen No. 13(2)		Similar to the above specimen except specimen cross-sectional area $2.055 \text{ mm}^2$ , dislocation density $4.4 \times 10^{10} \text{ cm}^{-2}$ , and residual electrical resistivity $7.605 \mu\Omega \text{ cm}$ .
51	53	Kusunoki, M. and Suzuki, H.	1969	L	1.8-4.3	Specimen No. 14		Similar to the above specimen except specimen cross-sectional area $1.569 \text{ mm}^2$ , dislocation density $8.4 \times 10^{10} \text{ cm}^{-2}$ , and residual electrical resistivity $7.641 \mu\Omega \text{ cm}$ .
52	53	Kusunoki, M. and Suzuki, H.	1969	L	1.7-4.4	Specimen No. 12(2)		Same fabrication method and heat-treatment as the above specimen except no other details reported.
53	116, 168	Aliev, N.A.	1953	L	295.2	6	50.45	$1.25 \text{ cm}^2$ in cross-section and $0.50 \text{ cm}$ thick; electrical conductivity $10.68 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ ; total Lorenz function $2.345 \times 10^{-8} \text{ V}^2 \text{K}^{-2}$ .
54	116, 168	Aliev, N.A.	1953	L	295.2	7	53.00	$1.25 \text{ cm}^2$ in cross-section and $0.96 \text{ cm}$ thick; electrical conductivity $10.74 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ ; total Lorenz function $2.334 \times 10^{-8} \text{ V}^2 \text{K}^{-2}$ .
55*	116, 168	Aliev, N.A.	1953	L	295.2	8	55.00	$1.25 \text{ cm}^2$ in cross-section and $0.52 \text{ cm}$ thick; electrical conductivity $10.82 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ ; total Lorenz function $2.348 \times 10^{-8} \text{ V}^2 \text{K}^{-2}$ .
56	116, 168	Aliev, N.A.	1953	L	295.2	9	59.62	$1.25 \text{ cm}^2$ in cross-section and $0.52 \text{ cm}$ thick; electrical conductivity $9.98 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ ; total Lorenz function $2.994 \times 10^{-8} \text{ V}^2 \text{K}^{-2}$ .
57	116, 168	Aliev, N.A.	1953	L	295.2	10	69.99	$1.25 \text{ cm}^2$ in cross-section and $1.18 \text{ cm}$ thick; electrical conductivity $8.85 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ ; total Lorenz function $2.233 \times 10^{-8} \text{ V}^2 \text{K}^{-2}$ .
58	116, 168	Aliev, N.A.	1953	L	295.2	11	71.00	$1.25 \text{ cm}^2$ in cross-section and $0.96 \text{ cm}$ thick; electrical conductivity $7.75 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ ; total Lorenz function $2.438 \times 10^{-8} \text{ V}^2 \text{K}^{-2}$ .
59	116, 168	Aliev, N.A.	1953	L	295.2	12	73.00	$1.25 \text{ cm}^2$ in cross-section and $1.49 \text{ cm}$ thick; electrical conductivity $6.71 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ ; total Lorenz function $2.247 \times 10^{-8} \text{ V}^2 \text{K}^{-2}$ .
60	116, 168	Aliev, N.A.	1953	L	295.2	13	76.00	$1.25 \text{ cm}^2$ in cross-section and $0.80 \text{ cm}$ thick; electrical conductivity $6.02 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ ; total Lorenz function $2.438 \times 10^{-8} \text{ V}^2 \text{K}^{-2}$ .
61	116, 168	Aliev, N.A.	1953	L	295.2	14	77.00	$1.25 \text{ cm}^2$ in cross-section and $0.74 \text{ cm}$ thick; electrical conductivity $4.25 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ ; total Lorenz function $2.438 \times 10^{-8} \text{ V}^2 \text{K}^{-2}$ .
62	116, 168	Aliev, N.A.	1953	L	295.2	15	78.00	$1.25 \text{ cm}^2$ in cross-section and $0.80 \text{ cm}$ thick; electrical conductivity $3.54 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ ; total Lorenz function $2.392 \times 10^{-8} \text{ V}^2 \text{K}^{-2}$ .

\* Not shown in figure.

TABLE 4. THERMAL CONDUCTIVITY OF COPPER + ALUMINUM ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION (continued)

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent)		Composition (continued), Specifications, and Remarks
							Cu	Al	
63	116, 168	Aliev, N.A.	1953	L	295.2	16	79.58		1.25 cm <sup>2</sup> in cross-section and 0.98 cm thick; electrical conductivity $4.16 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ ; total Lorenz function $2.360 \times 10^{-8} \text{V}^2\text{K}^{-2}$ .
64	116, 168	Aliev, N.A.	1953	L	295.2	17	83.00		1.25 cm <sup>2</sup> in cross-section and 1.16 cm thick; electrical conductivity $5.95 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ ; total Lorenz function $2.277 \times 10^{-8} \text{V}^2\text{K}^{-2}$ .
65	116, 168	Aliev, N.A.	1953	L	295.2	18	88.00		1.25 cm <sup>2</sup> in cross-section and 1.35 cm thick; electrical conductivity $7.40 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ ; total Lorenz function $2.348 \times 10^{-8} \text{V}^2\text{K}^{-2}$ .
66*	116, 168	Aliev, N.A.	1953	L	295.2	19	89.22		1.25 cm <sup>2</sup> in cross-section and 0.60 cm thick; electrical conductivity $10.04 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ ; total Lorenz function $2.304 \times 10^{-8} \text{V}^2\text{K}^{-2}$ .
67	116, 168	Aliev, N.A.	1953	L	295.2	20	95.00		1.25 cm <sup>2</sup> in cross-section and 0.51 cm thick; electrical conductivity $10.50 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ ; total Lorenz function $2.258 \times 10^{-8} \text{V}^2\text{K}^{-2}$ .
68*	169	Charsley, P. and Salter, J.A.M.	1965	L	1.6-4.1		5.47		Polycrystalline specimen; annealed.
69	169	Charsley, P. and Salter, J.A.M.	1965	L	1.6-4.5		5.47		Polycrystalline specimen; plastically deformed (6%).
70*	169	Charsley, P. and Salter, J.A.M.	1965	L	2.4-4.2		5.47		Polycrystalline specimen; plastically deformed (12%).
71	52	Charsley, P., Salter, J.A.M. and Leaver, A.D.W.	1968	L	1.6-4.2	2	0.90		Polycrystalline; 3 mm in diameter and 10 cm long; prepared by International Research and Development Co., Ltd.; annealed at 750 C for 15 hr in graphite tubes in vacuo and furnace cooled.
72	52	Charsley, P., et al.	1968	L	1.6-4.0	2 (2.9%)	0.90		Similar to the above specimen except 2.9% deformed.
73	52	Charsley, P., et al.	1968	L	1.6-4.2	2 (10%)	0.83		Similar to the above specimen except 10% deformed.
74*	52	Charsley, P., et al.	1968	L	1.7-4.2	8 (6%)	4.09		Similar to the above specimen except 6% deformed.
75*	52	Charsley, P., et al.	1968	L	1.6-4.4	12 (6.2%)	5.11		Similar to the above specimen except 6.2% deformed.
76*	52	Charsley, P., et al.	1968	L	2.4-4.2	12 (12.8%)	5.28		Similar to the above specimen except 12.8% deformed.
77*	49	Smith, C.S. and Palmer, E.W.	1935	L	293,473	Bar 50	89.88	9.90	0.22 Fe; 0.75 in. diameter and 8 in. long; rolled to 1.25 in. in diameter, annealed at 700-750 C, cold-drawn to size; heat-treated at 750 C for 3.5 hr, slowly air-cooled; electrical conductivity 7.923 and $6.724 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 20 and 200 C, respectively.
78	49	Smith, C.S. and Palmer, E.W.	1935	L	293,473	Bar 49	89.38	9.41	0.52 Fe, 0.38 Sn, 0.31 Ni, and trace Zn; 0.75 in. diameter and 8 in. long; same fabrication method as the above specimen; heat-treated at 750 C for 3.5 hr, very slowly cooled; electrical conductivity 7.314 and $6.364 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 20 and 200 C, respectively.
79*	119, 169	Friedman, A.J., Chu, T.K., Klemens, P.G., and Reynolds, C.A.	1972	L	1.7-4.0	A	4.07		Polycrystalline; form factor $37.50 \text{cm}^{-1}$ ; prepared from 99.999 pure copper supplied by Johnsons and Matthey and from 99.99 pure aluminum supplied by Jarrell Ash Co. by melting in an evacuated quartz beat, casting into a quartz capillary and quenching in an ice bath; annealed in vacuo at 1273 K for 18 hr; average grain size 1 mm; residual electrical resistivity $7.51 \mu\Omega\text{cm}$ .

\* Not shown in figure.

TABLE 4. THERMAL CONDUCTIVITY OF COPPER + ALUMINUM ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION (continued)

Cur. Ref. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent) Cu      Al	Composition (continued), Specifications, and Remarks
80*	119, 169	Friedman, A.J., Chu, T.K., Klemens, P.G., and Reynolds, C.A.	1972	L	1.5-3.8	A		The above specimen irradiated for 6 hr at 25 to 60 °C at the Brookhaven National Laboratory BNRR facility for a total fast neutron ( $>1$ MeV) dosage of $4 \times 10^{17}$ n cm $^{-2}$ and a total thermal dosage of $1 \times 10^{15}$ n cm $^{-2}$ ; form factor 37.57 cm $^{-1}$ ; residual electrical resistivity 7.46 $\mu\Omega$ cm.
81*	119, 169, 170	Friedman, A.J., et al.	1972	L	1.7-3.8	B	4.07	Some fabrication method as the above specimen A; form factor 35.67 cm $^{-1}$ ; residual electrical resistivity 7.60 $\mu\Omega$ cm.
82*	119, 169, 170	Friedman, A.J., et al.	1972	L	1.3-3.7	B		The above specimen deformed in tension, 6.1%, at room temperature; form factor 47.4 cm $^{-1}$ ; residual electrical resistivity 7.89 $\mu\Omega$ cm.
83*	119, 169	Friedman, A.J., et al.	1972	L	1.3-3.8	B		The above specimen annealed in vacuo at 573 K for 24 hr; form factor 47.0 cm $^{-1}$ ; residual electrical resistivity 7.90 $\mu\Omega$ cm.
84*	119, 169	Friedman, A.J., et al.	1972	L	1.4-3.9	B		The above specimen irradiation treated same as the above specimen A for curve No. 73; form factor 46.9 cm $^{-1}$ ; residual electrical resistivity 7.83 $\mu\Omega$ cm.
85*	119, 169	Friedman, A.J., et al.	1972	L	1.6-3.8	B		The above specimen annealed in vacuo at 573 K for 24 hr; form factor 46.6 cm $^{-1}$ ; residual electrical resistivity 7.95 $\mu\Omega$ cm.
86*	54	Mitchell, M.A., Klemens, P.G., and Reynolds, C.A.	1971	L	1.3-4.1	A	4.5	Obtained from Materials Research Corp., Orangeburg, N.Y.; prepared from 99.99% pure Al and Cu by vacuum induction melting, then machining and swaging to 0.125 in. in diameter; cold-worked in liquid nitrogen, then kept at 293 K for 3 hr; residual electrical resistivity 7.995 $\mu\Omega$ cm.
87*	54	Mitchell, M.A., et al.	1971	L	1.4-4.1	B		Similar to the above specimen A but annealed at 1193 K for 48 hr after cold-work; residual electrical resistivity 7.461 $\mu\Omega$ cm.
88*	54	Mitchell, M.A., et al.	1971	L	1.3-4.2	C1		Similar to the above specimen A but annealed at 1123 K for 28 hr after cold-work, then given 9.5% torsional strain at 293 K, re-annealed at 300 K for 12 hr; residual electrical resistivity 7.468 $\mu\Omega$ cm.
89*	54	Mitchell, M.A., et al.	1971	L	1.4-4.1	C2		The above specimen re-annealed at 373 K for 48 hr; residual electrical resistivity 7.450 $\mu\Omega$ cm.
90*	54	Mitchell, M.A., et al.	1971	L	1.4-4.0	C3		The above specimen re-annealed at 693 K for 20 hr; residual electrical resistivity 7.463 $\mu\Omega$ cm.
91*	54	Mitchell, M.A., et al.	1971	L	1.3-4.1	C4		The above specimen re-annealed at 713 K for 48 hr; residual electrical resistivity 7.494 $\mu\Omega$ cm.
92*	54	Mitchell, M.A., et al.	1971	L	1.2-4.1	D		Same composition, supplier, and fabrication method as the above specimen A but swaged to 3/16 in. in diameter; annealed at 1205 K for 48 hr; residual electrical resistivity 7.350 $\mu\Omega$ cm.
93*	54	Mitchell, M.A., et al.	1971	L	1.5-4.1	E1		Similar to the above specimen D but given, after annealing, 9.33% tensile strain at 77 K with maximum stress 28.5 kg mm $^{-2}$ and strain rate 0.0093 s $^{-1}$ ; then re-annealed at 300 K for 12 hr; residual electrical resistivity 7.586 $\mu\Omega$ cm.
94*	54	Mitchell, M.A., et al.	1971	L	1.3-4.1	E2		The above specimen re-annealed at 422 K for 48 hr; residual electrical resistivity 7.475 $\mu\Omega$ cm.
95*	54	Mitchell, M.A., et al.	1971	L	1.4-4.1	E3		The above specimen re-annealed at 552 K for 48 hr; residual electrical resistivity 7.498 $\mu\Omega$ cm.

\* Not shown in figure.

TABLE 4. THERMAL CONDUCTIVITY OF COPPER + ALUMINUM ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION (continued)

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent) Cu      Al	Composition (continued), Specifications, and Remarks
96*	54	Mitchell, M.A., Klemens, P.G., and Reynolds, C.A.	1971	L	1.2-4.1	E4	4.5	The above specimen re-annealed at 673 K for 48 hr; residual electrical resistivity 7.542 $\mu\Omega$ cm.
97*	54	Mitchell, M.A., et al.	1971	L	1.2-4.2	E5		The above specimen re-annealed at 797 K for 48 hr; residual electrical resistivity 7.456 $\mu\Omega$ cm.
98*	54	Mitchell, M.A., et al.	1971	L	1.2-4.2	E6		The above specimen re-annealed at 920 K for 48 hr; residual electrical resistivity 7.453 $\mu\Omega$ cm.
99*	54	Mitchell, M.A., et al.	1971	L	1.4-4.1	E7		The above specimen re-annealed at 1202 K for 48 hr; residual electrical resistivity 7.441 $\mu\Omega$ cm.
100*	54	Mitchell, M.A., et al.	1971	L	1.3-4.2	F1		Similar to the above specimen E1 but annealed at 1202 K for 48 hr, then given 8.13% tensile strain at 77 K with maximum stress 29 kg mm <sup>-2</sup> and strain rate 0.0081 s <sup>-1</sup> , re-annealed at 360 K for 48 hr; residual electrical resistivity 7.567 $\mu\Omega$ cm.
101*	54	Mitchell, M.A., et al.	1971	L	1.4-4.2	F2		The above specimen re-annealed at 564 K for 0.5 hr; residual electrical resistivity 7.536 $\mu\Omega$ cm.
102*	54	Mitchell, M.A., et al.	1971	L	1.2-4.2	F3		The above specimen re-annealed at 565 K for 1.5 hr; residual electrical resistivity 7.536 $\mu\Omega$ cm.
103*	54	Mitchell, M.A., et al.	1971	L	1.5-4.2	F4		The above specimen re-annealed at 567 K for 48 hr; residual electrical resistivity 7.498 $\mu\Omega$ cm.
104*	54	Mitchell, M.A., et al.	1971	L	1.5-4.2	F5		The above specimen re-annealed at 570 K for 97 hr; residual electrical resistivity 7.498 $\mu\Omega$ cm.
105*	54	Mitchell, M.A., et al.	1971	L	1.3-4.2	G1		Similar to the above specimen F1 but given, after annealing, 9.26% tensile strain at 77 K with maximum stress 25.1 kg mm <sup>-2</sup> and strain rate 0.004 s <sup>-1</sup> , re-annealed at 344 K for 48 hr; residual electrical resistivity 7.644 $\mu\Omega$ cm.
106*	54	Mitchell, M.A., et al.	1971	L	1.2-4.2	G2		The above specimen re-annealed at 670 K for 0.5 hr; residual electrical resistivity 7.625 $\mu\Omega$ cm.
107*	54	Mitchell, M.A., et al.	1971	L	1.2-4.2	G3		The above specimen re-annealed at 661 K for 1.5 hr; residual electrical resistivity 7.612 $\mu\Omega$ cm.
108*	54	Mitchell, M.A., et al.	1971	L	1.2-4.1	G4		The above specimen re-annealed at 660 K for 48 hr; residual electrical resistivity 7.601 $\mu\Omega$ cm.
109*	54	Mitchell, M.A., et al.	1971	L	1.2-4.2	G5		The above specimen re-annealed at 732 K for 48 hr; residual electrical resistivity 7.553 $\mu\Omega$ cm.
110*	54	Mitchell, M.A., et al.	1971	L	1.2-4.1	G6		The above specimen re-annealed at 1308 K for 48 hr; residual electrical resistivity 7.576 $\mu\Omega$ cm.
111	48, 171	Chu, T.K. and Lipschultz, F.P.	1972	L	4.6-69	C1	0.43	Supplied by American Anacoda Brass Co.; 0.5 in. diameter x 8 in. long with central 5 in. machined to 0.25 in. in diameter; annealed at 1273 K for 48 hr; electrical resistivity 1.066, 1.066, 1.302, and 2.670 $\mu\Omega$ cm at 1.1, 4.2, 77, and 273 K, respectively.
112	48, 171	Chu, T.K. and Lipschultz, F.P.	1972	L	4.5-55	C2		The above specimen fatigued for 500 cycles with maximum load 6.4 kg mm <sup>-2</sup> ; electrical resistivity 1.071, 1.067, 1.301, and 2.664 $\mu\Omega$ cm at 1.1, 4.2, 77, and 273 K, respectively.

\* Not shown in figure.

TABLE 4. THERMAL CONDUCTIVITY OF COPPER + ALUMINUM ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION (continued)

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent) Cu      Al	Composition (continued), Specifications, and Remarks
113	48, 171	Chu, T.K. and Lipschultz, F.P.	1972	L	1.7-72	C3	0.43	The above specimen fatigued for $10^4$ cycles with maximum load $6.4 \text{ kg mm}^{-2}$ ; electrical resistivity 1.069, 1.069, 1.304, and $2.663 \mu\Omega \text{ cm}$ at 1.1, 4.2, 77, and 273 K, respectively.
114	48, 171	Chu, T.K. and Lipschultz, F.P.	1972	L	4.6-69	C5		Similar to the above specimen C1 but given a 5% plastic deform under uniaxial stress; electrical resistivity 1.066, 1.066, 1.294, and $2.660 \mu\Omega \text{ cm}$ at 1.1, 4.2, 77, and 273 K, respectively.
115*	48, 171	Chu, T.K. and Lipschultz, F.P.	1972	L	4.6-66	C6		The above specimen fatigued for $10^5$ cycles with maximum load $6.4 \text{ kg mm}^{-2}$ ; electrical resistivity 1.064, 1.306, and $2.665 \mu\Omega \text{ cm}$ at 4.2, 77, and 273 K, respectively.
116	48, 171	Chu, T.K. and Lipschultz, F.P.	1972	L	4.6-66	B1	6.97	Same supplier and dimensions as the above specimen C1; annealed at 1237 K for 48 hr; electrical resistivity 7.868, 7.867, 8.253, and $10.19 \mu\Omega \text{ cm}$ at 1.1, 4.2, 77, and 273 K, respectively.
117	48, 171	Chu, T.K. and Lipschultz, F.P.	1972	L	4.9-68	B2		The above specimen fatigued for 500 cycles with maximum load $8.3 \text{ kg mm}^{-2}$ ; electrical resistivity 7.850, 7.853, 8.250, and $10.16 \mu\Omega \text{ cm}$ at 1.1, 4.2, 77, and 273 K, respectively.
118	48, 171	Chu, T.K. and Lipschultz, F.P.	1972	L	4.7-68	B3		The above specimen fatigued for $10^4$ cycles; electrical resistivity 7.806, 7.806, 8.204, and $10.10 \mu\Omega \text{ cm}$ at 1.1, 4.2, 77, and 273 K, respectively.
119	48, 171	Chu, T.K. and Lipschultz, F.P.	1972	L	5.4-68	B4		The above specimen fatigued for $10^5$ cycles; electrical resistivity 7.813, 7.813, 8.217, and $10.14 \mu\Omega \text{ cm}$ at 1.1, 4.2, 77, and 273 K, respectively.
120	48, 171	Chu, T.K. and Lipschultz, F.P.	1972	L	4.7-68	B5	6.97	Similar to the above specimen B1 but given a 5% plastic deform under uniaxial stress; electrical resistivity 7.889, 7.889, 8.288, and $10.16 \mu\Omega \text{ cm}$ at 1.1, 4.2, 77, and 273 K, respectively.
121	48, 171	Chu, T.K. and Lipschultz, F.P.	1972	L	4.8-65	B6		The above specimen fatigued for $2 \times 10^5$ cycles with maximum load $8.3 \text{ kg mm}^{-2}$ ; electrical resistivity 7.891, 8.273, and $10.21 \mu\Omega \text{ cm}$ at 4.2, 77, and 273 K, respectively.
122	50	Friedman, A.J.	1974	L	5.3-73	5	4.07	The same irradiated specimen B for curve No. 82; electrical resistivity 7.832, 7.832, 8.204, and $10.033 \mu\Omega \text{ cm}$ at 1.2, 4.2, 77, and 273 K, respectively.
123	50	Friedman, A.J.	1974	L	5.3-70	5		The above specimen re-annealed at 573 K for 24 hr; electrical resistivity 7.949, 7.949, 8.314, and $10.150 \mu\Omega \text{ cm}$ at 1.2, 4.2, 77, and 273 K, respectively.
124	50	Friedman, A.J.	1974	L	5.3-68	6	4.07	Form factor $37.497 \text{ cm}^{-1}$ ; annealed in vacuum at 1273 K for 18 hr; electrical resistivity 7.518, 7.513, 7.867, and $9.630 \mu\Omega \text{ cm}$ at 1.2, 4.2, 77, and 273 K, respectively.
125	50	Friedman, A.J.	1974	L	5.0-72	6		The above specimen.
126	50	Friedman, A.J.	1974	L	5.0-67	6		The above specimen given the same irradiation treatment as the specimen B for curve No. 82; form factor $37.569 \text{ cm}^{-1}$ ; electrical resistivity 7.461, 7.461, 7.812, and $9.564 \mu\Omega \text{ cm}$ at 1.2, 4.2, 77, and 273 K, respectively.
127*	120	Leaver, A.D.W. and Charsley, P.	1971	L	1.9-4.0	2 Al	0.83	Similar to the specimen for curve No. 73; annealed; residual electrical resistivity $2.080 \mu\Omega \text{ cm}$ .
128*	120	Leaver, A.D.W. and Charsley, P.	1971	L	1.8-4.1	2 Al		The above specimen tensile strained 8.2% under a stress of $16.93 \text{ kg mm}^{-2}$ ; residual electrical resistivity $2.109 \mu\Omega \text{ cm}$ .
129*	120	Leaver, A.D.W. and Charsley, P.	1971	L	2.0-4.0	12 Al	5.56	Polycrystalline; obtained from International Research and Development Co., Ltd.; residual electrical resistivity $7.61 \mu\Omega \text{ cm}$ .

\* Not shown in figure.

TABLE 4. THERMAL CONDUCTIVITY OF COPPER + ALUMINUM ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION (continued)

Cur. Ref. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent) Cu      Al	Composition (continued), Specifications, and Remarks
130*	120	Leaver, A.D.W. and Charsley, P.	1971	L	1.8-4.0	12 Al		The above specimen tensile strained 1.8% under a stress of 16.38 kg mm <sup>-2</sup> ; residual electrical resistivity 7.62 $\mu\Omega$ cm.
131*	120	Leaver, A.D.W. and Charsley, P.	1971	L	2.0-4.2	12 Al	5.56	Single crystal; grown in a graphite mold by the Bridgman technique; annealed.
132*	120	Leaver, A.D.W. and Charsley, P.	1971	L	2.2-4.1	12 Al		The above specimen tensile strained 7.3% under a stress of 3.03 kg mm <sup>-2</sup> .
133*	120	Leaver, A.D.W. and Charsley, P.	1971	L	1.9-4.0	12 Al		The above specimen tensile strained 17.0% under a stress of 4.48 kg mm <sup>-2</sup> .
134*	120	Leaver, A.D.W. and Charsley, P.	1971	L	2.0-4.1	12 Al		The above specimen tensile strained 22.5% under a stress of 6.73 kg mm <sup>-2</sup> .
135*	121	Kogure, Y. and Hiki, Y.	1973	L	1.6-6.6		97.8    2.2	Calculated composition (5 a/o Al); 2.5 mm dia x 70 mm long; prepared from 99.99 <sup>+</sup> Cu and Al by vacuum melting and casting; annealed in vacuum at 850 C for 15 hrs.
136*	172	Kapoor, A., Rowlands, J.A., and Woods, S.B.	1974	L	0.48-3.9		95.5    4.5	Calculated composition (10 a/o Al); cylindrical specimen 3.6 mm in diameter; prepared by melting the pure materials in a quartz container in vacuum, resulted ingot swaged to size; cold-worked; residual electrical resistivity 7.54 $\mu\Omega$ cm.
137*	172	Kapoor, A., et al.	1974	L	0.52-4.0			The above specimen annealed in vacuum at 600 K for 12 hr; residual electrical resistivity 6.79 $\mu\Omega$ cm.
138*	172	Kapoor, A., et al.	1974	L	0.48-3.7			The above specimen reannealed in vacuum at 675 K for 12 hr; residual electrical resistivity 6.88 $\mu\Omega$ cm.
139*	172	Kapoor, A., et al.	1974	L	0.65-4.0			The above specimen reannealed in vacuum at 1000 K for 12 hr; residual electrical resistivity 6.69 $\mu\Omega$ cm.

\* Not shown in figure.

#### 4.2. Aluminum-Magnesium Alloy System

The aluminum-magnesium alloy system does not form a continuous series of solid solutions. The maximum solid solubility of magnesium in aluminum is 17.4% (18.9 At.%) at 723 K and the solubility decreases at higher and lower temperatures, being only 1.9% (2.1 At.%) at 373 K. The maximum solid solubility of aluminum in magnesium is 12.7% (11.6 At.%) at 710 K and likewise it decreases at higher and lower temperatures, being only about 1.5% (1.3 At.%) at 373 K. Thus the region of solid solution of this alloy system is even more limited than that of the aluminum-copper alloy system. As noted in section 3, the values for the thermal conductivity of much of this system are derived from experimental data on specimens in which the solid-solution phase was presumably frozen in. Hence, these values may not always be reproducible and are therefore provisional rather than recommended.

There are 50 sets of experimental thermal conductivity data available for this system. Of the 32 data sets for Al + Mg alloys listed in table 6 and shown in figure 18, seven sets are merely single data points. Of the data sets for Mg + Al alloys listed in table 7 and shown in figure 19, ten sets are single data points.

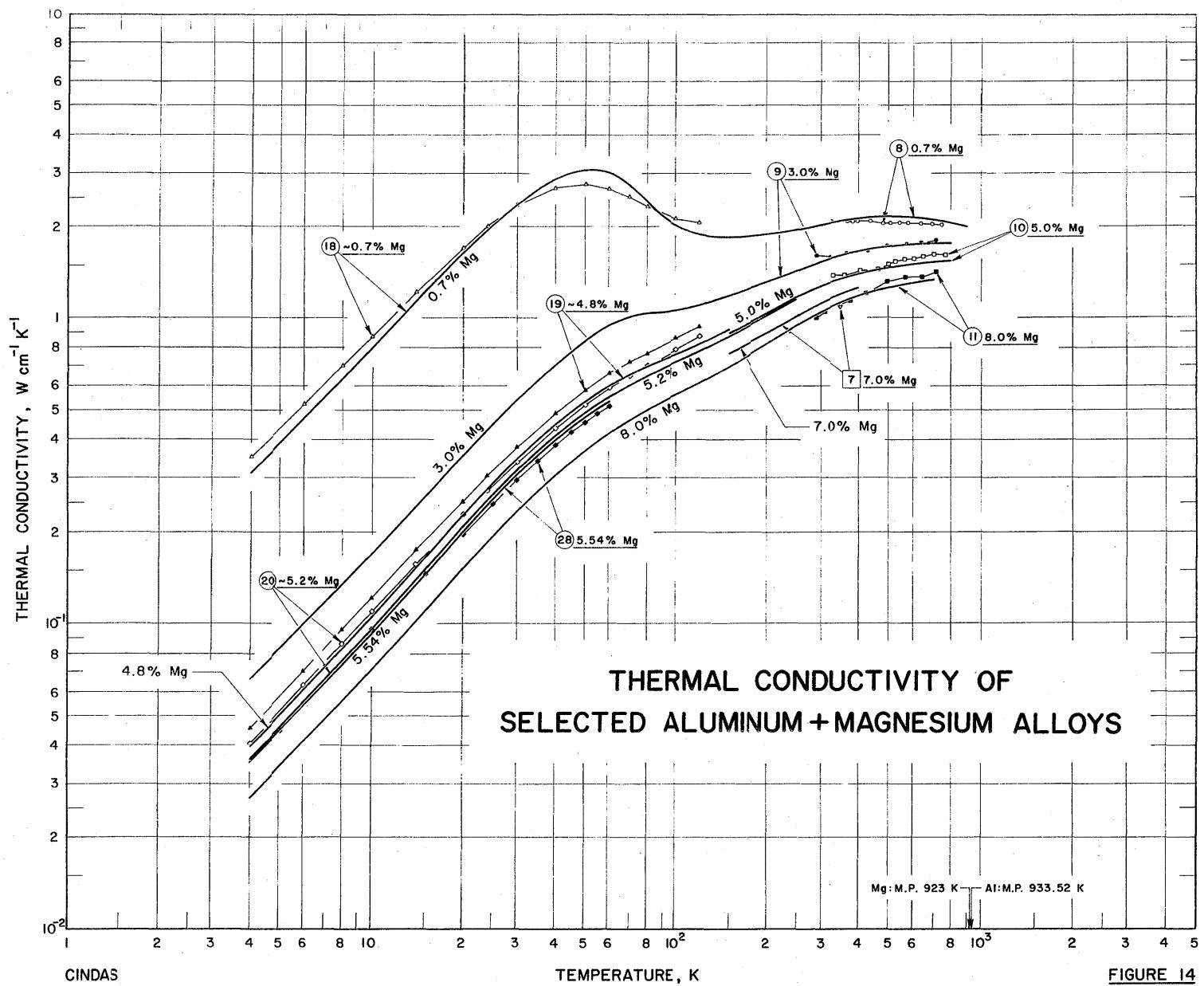
For the Al + Mg alloys, measurements were limited to specimens containing no more than 15% Mg. Recommended curves are, therefore, given for 0.5 to 10% Mg alloys only. They follow the slopes of the data of Johnson [56] (Al + Mg curves 5 and 6) and of Powell et al. [57] (Al + Mg curves 18-22) at low temperatures, and in this region the data of Mohan et al. [190] on a binary Al + Mg alloy (Al + Mg curve 28) are within 10% of the interpolated values from the recommended curves. At higher temperatures the recommended curves follow the trend of the high-temperature data of Mikryukov and Karagezyan [58] (Al + Mg curves 8-11). The alloys measured by Powell et al. are age hardened and since most of the impurities are heavier than Mg, there are fewer impurities per atom than indicated and the error incurred is in the effective Mg content scale. In addition, most of the weight of the analysis was given to the higher Mg content alloys. In a conductivity versus composition plot for 300 K, all the available data are shown to be congruous and complementary except those of Johnson [56] (Al + Mg curves 5 and 6) for specimens of uncertain composition and those from Materials Design Engineering [123] (Al + Mg curves 16 and 17) for as-cast specimens. A conductivity-composition curve at 300 K for 0 to 10% Mg is thus constructed based on those data which are in agreement with one another. The  $k_e$  values at 300 K were calculated from eq (12), and the  $k_e$  values at 300 K were derived as the differences between  $k$  and  $k_e$  values. These  $k_e$  values were extrapolated to higher temperatures up to the solidus temperatures according to the temperature dependence of eq (35) and to lower temperatures according to the pattern of  $k_e$  curves derived from the available experimental  $k$  and the calculated  $k_e$  around the region of maximum  $k_e$  and according to  $T^2$  dependence at lower temperatures assuming  $k_e$  to be negligible at 1 K. The total thermal conductivity values were then obtained by adding the extrapolated  $k_e$  and the calculated  $k_e$ .

For the Mg+Al alloys, no measurements were made below 85 K and none for alloys containing more than 14% Al. The

data of Smith [45] (Mg+Al curves 1 and 2) and of Kikuchi [59] (Mg+Al curves 8-13) were favored in constructing the conductivity-composition curve for 300 K. The data of Staebler and Mannchen [41,124] (Mg+Al curves 3-5) were rejected because the values of the total Lorenz function calculated from their thermal conductivity and electrical resistivity results are obviously too large ( $3.25$  to  $3.65 \times 10^{-8} V^2 K^{-2}$  at 73 K), which leads to the conclusion that their thermal conductivity data are too high. Maybrey [60] did not measure electrical resistivity, but his thermal conductivity data are in the same neighborhood of magnitude as those of Staebler and Mannchen, and are hence taken out of consideration. The remaining measurements other than those of Smith and of Kikuchi were made on specimens of nonspecific composition, and, therefore, would be given less weight in constructing the conductivity-composition isotherm. It, then, left the data of Smith and of Kikuchi as the basis for the construction. The  $k_e$  values were calculated from eq (12) and those at 300 K were plotted on the conductivity-composition graph. The  $k_e$  values at 300 K were taken as the differences between  $k$  and  $k_e$  values. These  $k_e$  values were similarly extrapolated to lower and higher temperatures according to the appropriate temperature dependences. The total thermal conductivity values were obtained by adding these  $k_e$  to the calculated  $k_e$ . Since there is no information regarding where the maxima of the  $k_e$  curves occur, no  $k_e$  values are given below 100 K and hence no total  $k$  values are reported at low temperatures for the dilute alloys, even though the  $k_e$  values are known. The  $k$  values of the 5 and 10% Al alloys are given only in the range between 250 and 350 K, since electrical resistivity values are available only in this range.

A graphical comparison of the recommended total thermal conductivity values with selected experimental data is given in figures 14 and 15. The smooth solid curves in these figures were obtained by interpolating the recommended values of table 5 in order to obtain thermal conductivity values for the desired alloy compositions. For aluminum-rich alloys shown in figure 14, the recommended values are in agreement with the data of Powell et al. [57] (Al+Mg curves 18-20) at low temperatures to within 10% and with the data of Meyer-Rassler [122] (Al+Mg curve 7) and of Mikryukov and Karagezyan [58] (Al+Mg curves 8-11) at higher temperatures to within 8%. For magnesium-rich alloys shown in figure 15, the recommended values are in agreement with the data of Kikuchi [59] (Mg+Al curves 8-13), of Smith [45] (Mg+Al curves 1 and 2), and of Giuliani [135] (Mg+Al curve 14) to within 6%.

The resulting recommended values for  $k$ ,  $k_e$ , and  $k_g$  are tabulated in table 5 for 10 alloy compositions. These values are for alloys which have not been severely cold worked or quenched. The  $k$  values are also presented in figures 16 and 17. The values of residual electrical resistivity for eight of the 10 alloys are also given in table 5. The uncertainties of the  $k$  values are stated in a footnote to table 5, while the uncertainties of the  $k_e$  and  $k_g$  values are indicated by their being designated as recommended, provisional, or typical values. The ranges of uncertainties of recommended, provisional, and typical values are less than  $\pm 15\%$ , between  $\pm 15$  and  $\pm 30\%$ , and greater than  $\pm 30\%$ , respectively. The  $k_e$  values are very uncertain and are merely to serve as correction terms for the derivation of the total thermal conductivities.



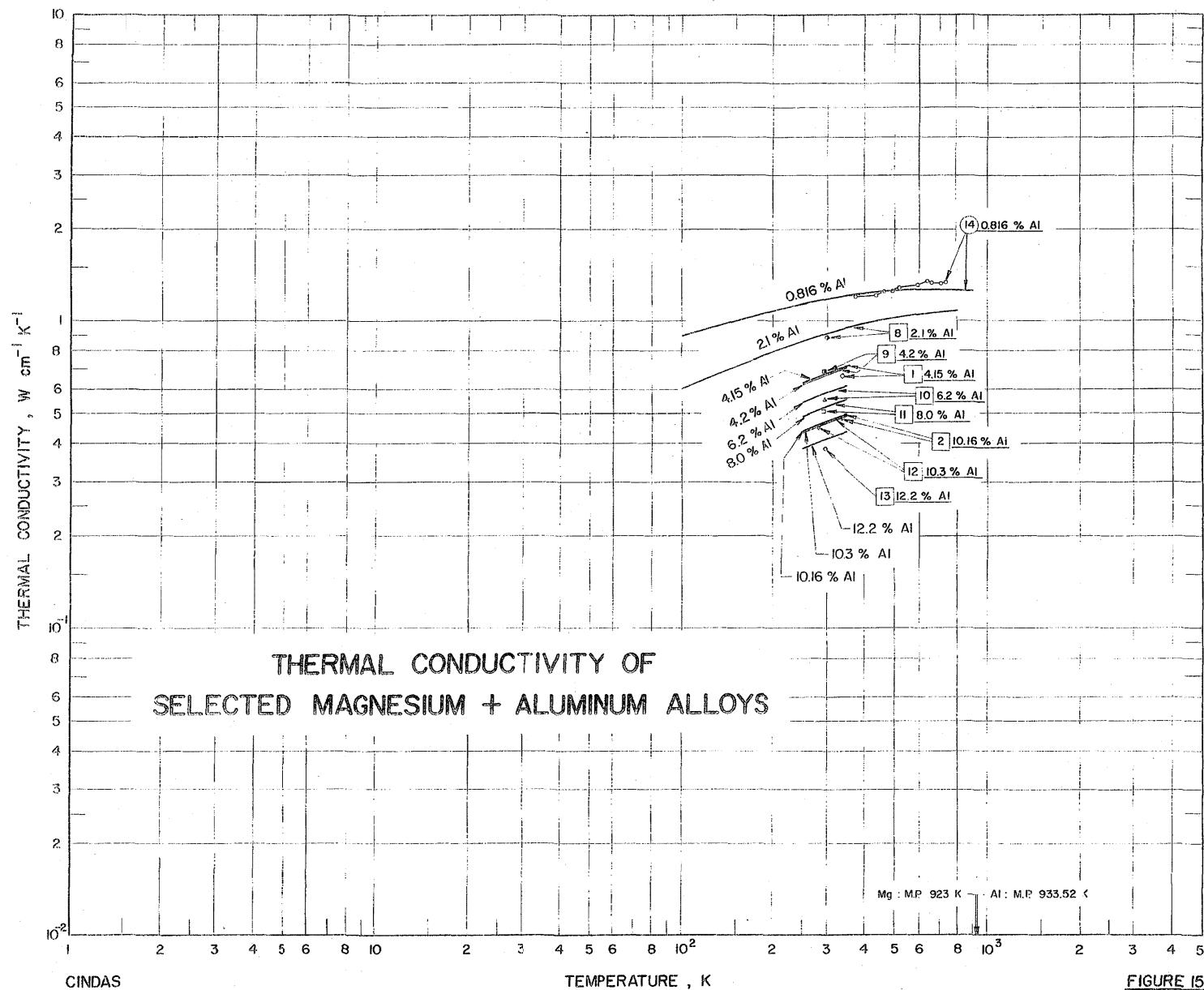


TABLE 5. RECOMMENDED THERMAL CONDUCTIVITY OF ALUMINUM-MAGNESIUM ALLOY SYSTEM<sup>†</sup>

[Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Al: 99.50% (99.45 At.%) Mg: 0.50% (0.55 At.%)				Al: 99.00% (98.89 At.%) Mg: 1.00% (1.11 At.%)				Al: 97.00% (96.68 At.%) Mg: 3.00% (3.32 At.%)				Al: 95.00% (94.48 At.%) Mg: 5.00% (5.52 At.%)			
$\rho_o = 0.253 \mu\Omega \text{ cm}$				$\rho_o = 0.511 \mu\Omega \text{ cm}$				$\rho_o = 1.53 \mu\Omega \text{ cm}$				$\rho_o = 2.54 \mu\Omega \text{ cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.391			4	0.195			4	0.066 <sup>‡</sup>			4	0.037 <sup>‡</sup>		
6	0.591			6	0.295			6	0.100 <sup>‡</sup>			6	0.056 <sup>‡</sup>		
8	0.796			8	0.397			8	0.135 <sup>‡</sup>			8	0.077 <sup>‡</sup>		
10	1.00			10	0.501			10	0.170 <sup>‡</sup>			10	0.098 <sup>‡</sup>		
15	1.54			15	0.767			15	0.264 <sup>‡</sup>			15	0.154 <sup>‡</sup>		
20	2.01			20	1.03			20	0.358 <sup>‡</sup>			20	0.211 <sup>‡</sup>		
25	2.46			25	1.28			25	0.451 <sup>‡</sup>			25	0.268 <sup>‡</sup>		
30	2.89			30	1.51			30	0.539 <sup>‡</sup>			30	0.320 <sup>‡</sup>		
40	3.50			40	1.89			40	0.699 <sup>‡</sup>			40	0.417 <sup>‡</sup>		
50	3.67			50	2.14			50	0.834 <sup>‡</sup>			50	0.497 <sup>‡</sup>		
60	3.52			60	2.23			60	0.937 <sup>‡</sup>			60	0.560 <sup>‡</sup>		
70	3.13			70	2.18			70	1.002 <sup>‡</sup>			70	0.618 <sup>‡</sup>		
80	2.71			80	2.02			80	1.032 <sup>‡</sup>			80	0.660 <sup>‡</sup>		
90	2.34			90	1.86			90	1.039 <sup>‡</sup>			90	0.691 <sup>‡</sup>		
100	2.16	2.05	0.107 <sup>‡</sup>	100	1.78	1.69	0.086 <sup>‡</sup>	100	1.06 <sup>‡</sup>	0.990	0.065 <sup>‡</sup>	100	0.723 <sup>‡</sup>	0.669	0.054 <sup>‡</sup>
150	1.96*	1.87	0.089 <sup>‡</sup>	150	1.72*	1.65	0.074 <sup>‡</sup>	150	1.19* <sup>‡</sup>	1.13	0.055 <sup>‡</sup>	150	0.906 <sup>‡</sup>	0.859	0.047 <sup>‡</sup>
200	1.97*	1.90	0.074 <sup>‡</sup>	200	1.79*	1.73	0.063 <sup>‡</sup>	200	1.32* <sup>‡</sup>	1.27	0.048 <sup>‡</sup>	200	1.04 <sup>‡</sup>	1.00	0.041 <sup>‡</sup>
250	2.01*	1.95	0.064 <sup>‡</sup>	250	1.86*	1.80	0.055 <sup>‡</sup>	250	1.42* <sup>‡</sup>	1.38	0.043 <sup>‡</sup>	250	1.16 <sup>‡</sup>	1.12	0.036 <sup>‡</sup>
273	2.05*	1.99	0.060 <sup>‡</sup>	273	1.90*	1.85	0.052 <sup>‡</sup>	273	1.48* <sup>‡</sup>	1.44	0.040 <sup>‡</sup>	273	1.21 <sup>‡</sup>	1.18	0.034 <sup>‡</sup>
300	2.08	2.02	0.056 <sup>‡</sup>	300	1.94	1.89	0.049 <sup>‡</sup>	300	1.53 <sup>‡</sup>	1.49	0.038 <sup>‡</sup>	300	1.27 <sup>‡</sup>	1.24	0.033 <sup>‡</sup>
350	2.11	2.06	0.050 <sup>‡</sup>	350	1.99	1.95	0.043 <sup>‡</sup>	350	1.61 <sup>‡</sup>	1.58	0.034 <sup>‡</sup>	350	1.35 <sup>‡</sup>	1.32	0.030 <sup>‡</sup>
400	2.17	2.12	0.045 <sup>‡</sup>	400	2.06	2.02	0.040 <sup>‡</sup>	400	1.67 <sup>‡</sup>	1.64	0.031 <sup>‡</sup>	400	1.41 <sup>‡</sup>	1.38	0.027 <sup>‡</sup>
500	2.18	2.14	0.037 <sup>‡</sup>	500	2.08	2.05	0.033 <sup>‡</sup>	500	1.72 <sup>‡</sup>	1.69	0.027 <sup>‡</sup>	500	1.46 <sup>‡</sup>	1.44	0.024 <sup>‡</sup>
600	2.16	2.13	0.032 <sup>‡</sup>	600	2.08	2.05	0.029 <sup>‡</sup>	600	1.74	1.72	0.024 <sup>‡</sup>	600	1.50 <sup>‡</sup>	1.48	0.021 <sup>‡</sup>
700	2.12	2.09	0.028 <sup>‡</sup>	700	2.06	2.03	0.025 <sup>‡</sup>	700	1.76	1.74	0.021 <sup>‡</sup>	700	1.53	1.51	0.019 <sup>‡</sup>
800	2.07*	2.04	0.025 <sup>‡</sup>	800	2.01*	1.99	0.023 <sup>‡</sup>	800	1.76*	1.74	0.020 <sup>‡</sup>	800	1.56*	1.54	0.017 <sup>‡</sup>
900	2.00*	1.98	0.022 <sup>‡</sup>	900	1.96*	1.94	0.021 <sup>‡</sup>	881	1.76*	1.74	0.018 <sup>‡</sup>	849	1.55*	1.53	0.016 <sup>‡</sup>
922	1.99*	1.97	0.021 <sup>‡</sup>	913	1.95*	1.93	0.021 <sup>‡</sup>								

<sup>†</sup> Uncertainties in the total thermal conductivity, k, are as follows:

99.50 Al - 0.50 Mg:  $\pm 10\%$  up to 200 K and  $\pm 6\%$  above 200 K.

99.00 Al - 1.00 Mg:  $\pm 10\%$  up to 200 K and  $\pm 6\%$  above 200 K.

97.00 Al - 3.00 Mg:  $\pm 15\%$  up to 500 K and  $\pm 8\%$  above 500 K.

95.00 Al - 5.00 Mg:  $\pm 15\%$  up to 600 K and  $\pm 8\%$  above 600 K.

<sup>‡</sup> Provisional value.

<sup>\*</sup> Typical value.

<sup>\*</sup> In temperature range where no experimental thermal conductivity data are available.

TABLE 5. RECOMMENDED THERMAL CONDUCTIVITY OF ALUMINUM-MAGNESIUM ALLOY SYSTEM (continued)<sup>†</sup>  
 [Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Al: 90.00% (89.02 At.%) Mg: 10.00% (10.98 At.%)				Al: 10.00% (9.10 At.%) Mg: 90.00% (90.90 At.%)				Al: 5.00% (4.53 At.%) Mg: 95.00% (95.47 At.%)				Al: 3.00% (2.71 At.%) Mg: 97.00% (97.29 At.%)			
$\rho_o = 4.98 \mu\Omega \text{ cm}$												$\rho_o = 4.78 \mu\Omega \text{ cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.020‡											4	0.0204‡		
6	0.031‡											6	0.0307‡		
8	0.041‡											8	0.0409‡		
10	0.052‡											10	0.0508‡		
15	0.081‡											15	0.0752‡		
20	0.113‡											20	0.0998‡		
25	0.143‡											25	0.124‡		
30	0.173‡											30	0.148‡		
40	0.230‡											40	0.192‡		
50	0.281‡											50	0.232‡		
60	0.326‡											60	0.266‡		
70	0.364‡											70	0.295‡		
80	0.395‡											80	0.318‡		
90	0.423‡											90	0.339‡		
100	0.447‡	0.404‡	0.043‡	100		0.0564‡		100		0.0723‡		100	0.453**‡	0.362‡	0.0911‡
150	0.576‡	0.538‡	0.038‡	150		0.0477‡		150		0.0613‡		150	0.553**‡	0.476‡	0.0771‡
200	0.690‡	0.657‡	0.033‡	200		0.0409‡		200		0.0527‡		200	0.634**‡	0.568‡	0.0658‡
250	0.795‡	0.765‡	0.030‡	250	0.444‡	0.408‡	0.0358‡	250	0.576‡	0.530‡	0.0460‡	250	0.699**‡	0.642‡	0.0572‡
273	0.840‡	0.812‡	0.028‡	273	0.461‡	0.427‡	0.0338‡	273	0.598‡	0.554‡	0.0435‡	273	0.728**‡	0.674‡	0.0540‡
300	0.891‡	0.864‡	0.027‡	300	0.477‡	0.445‡	0.0317‡	300	0.619‡	0.578‡	0.0407‡	300	0.756‡	0.705‡	0.0505‡
350	0.976‡	0.952‡	0.024‡	350	0.504‡	0.475‡	0.0285‡	350	0.653‡	0.616‡	0.0367‡	350	0.799**‡	0.754‡	0.0452‡
400	1.03‡	1.01‡	0.023‡	400		0.0259‡		400		0.0334‡		400	0.835**‡	0.794‡	0.0408‡
500	1.12‡	1.10‡	0.020‡	500		0.0220‡		500		0.0283‡		500	0.888**‡	0.854‡	0.0343‡
600	1.17‡	1.15‡	0.017‡	600		0.0191‡		600		0.0247‡		600	0.924*	0.894	0.0295‡
700	1.20	1.18	0.016‡	700		0.0170‡		700		0.0218‡		700	0.946*	0.920	0.0260‡
788	1.22	1.21	0.014‡	756		0.0159‡		800		0.0196‡		800	0.964*	0.941	0.0232‡
								839		0.0189‡		872	0.975*	0.953	0.0216‡

† Uncertainties in the total thermal conductivity, k, are as follows:

90.00 Al - 10.00 Mg:  $\pm 15\%$  up to 600 K and  $\pm 8\%$  above 600 K.  
 10.00 Al - 90.00 Mg:  $\pm 15\%$  between 250 and 350 K.  
 5.00 Al - 95.00 Mg:  $\pm 15\%$  between 250 and 350 K.  
 3.00 Al - 97.00 Mg:  $\pm 15\%$  up to 500 K and  $\pm 8\%$  above 500 K.

‡ Provisional value.

\* Typical value.

\* In temperature range where no experimental thermal conductivity data are available.

TABLE 5. RECOMMENDED THERMAL CONDUCTIVITY OF ALUMINUM-MAGNESIUM ALLOY SYSTEM (continued)†  
 [Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Al: 1.00% (0.90 At. %) Mg: 99.00% (99.10 At. %)				Al: 0.50% (0.45 At. %) Mg: 99.50% (99.55 At. %)							
$\rho_0 = 1.960 \mu\Omega \text{ cm}$				$\rho_0 = 0.980 \mu\Omega \text{ cm}$							
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.0500			4	0.0996						
6	0.0750			6	0.150						
8	0.100			8	0.200						
10	0.125			10	0.249						
15	0.186			15	0.369						
20	0.245			20	0.481						
25	0.301			25	0.586						
30	0.355			30	0.683						
40	0.451			40	0.838						
50	0.525			50	0.920						
60	0.573			60	0.950						
70	0.602			70	0.962						
80	0.619			80	0.971						
90	0.634			90	0.978						
100	0.793	0.660	0.133‡	100	1.07*	0.982	0.152‡				
150	0.904	0.792	0.112‡	150	1.18*	1.05	0.127‡				
200	0.989	0.896	0.0932‡	200	1.23*	1.13	0.104‡				
250	1.05	0.972	0.0797‡	250	1.27*	1.18	0.0874‡				
273	1.08	1.01	0.0746‡	273	1.29*	1.21	0.0816‡				
300	1.10	1.03	0.0692‡	300	1.30*	1.23	0.0756‡				
350	1.14	1.08	0.0613‡	350	1.32*	1.25	0.0661‡				
400	1.17	1.12	0.0546‡	400	1.33	1.27	0.0589‡				
500	1.19	1.15	0.0449‡	500	1.34	1.29	0.0481‡				
600	1.21	1.17	0.0382‡	600	1.34	1.30	0.0406‡				
700	1.22	1.19	0.0331‡	700	1.33	1.30	0.0350‡				
800	1.22	1.19	0.0292‡	800	1.33*	1.30	0.0308‡				
900	1.22	1.19	0.0262‡	900	1.32*	1.30	0.0274‡				
906	1.22	1.19	0.0260‡	914	1.32*	1.30	0.0270‡				

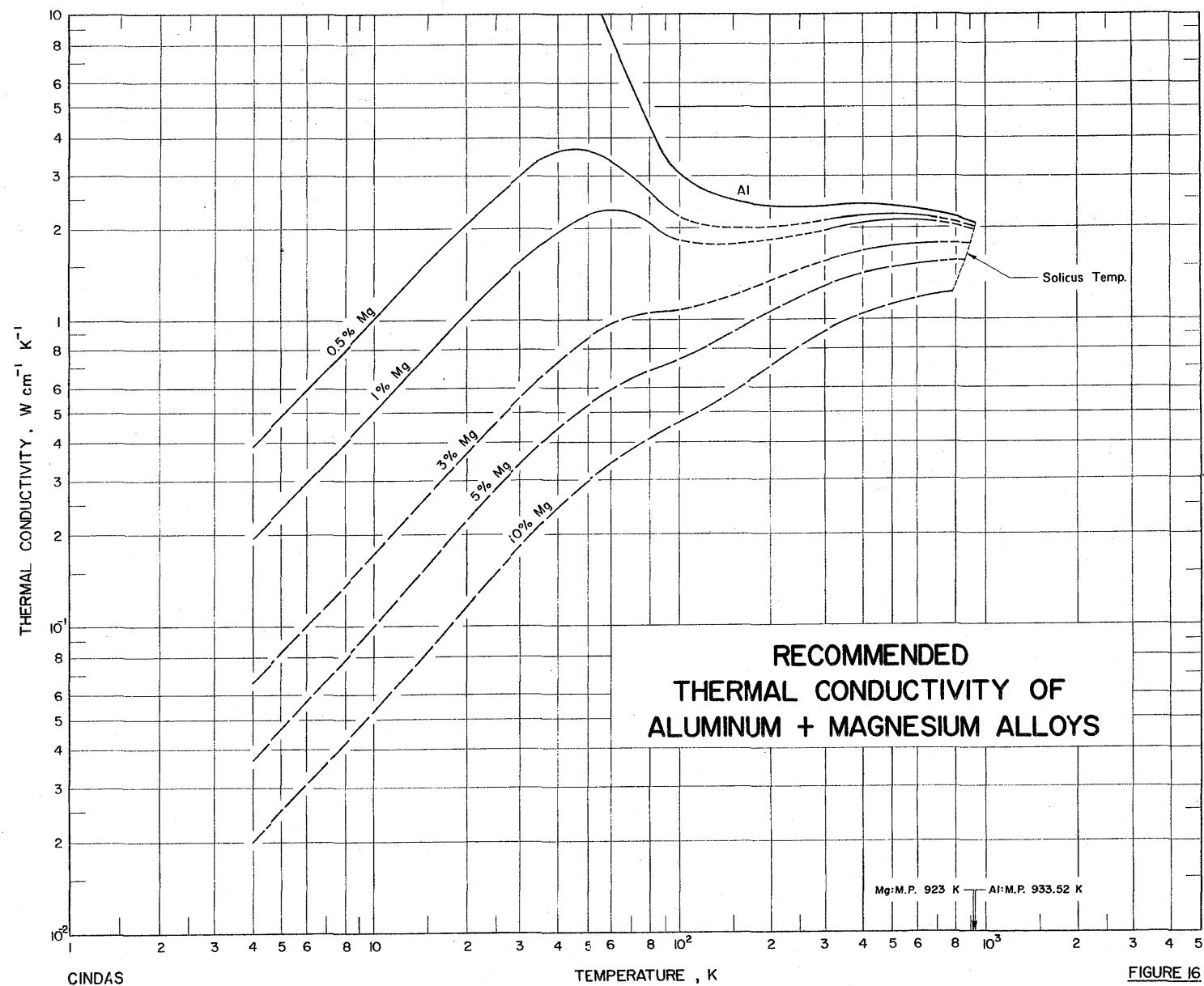
† Uncertainties in the total thermal conductivity, k, are as follows:

1.00 Al - 99.00 Mg: ±12% below 200 K, ±6% between 200 and 500 K, and ±8% above 500 K.

0.50 Al - 99.50 Mg: ±12% below 200 K, ±6% between 200 and 500 K, and ±8% above 500 K.

‡ Typical value.

\* In temperature range where no experimental thermal conductivity data are available.

**FIGURE 16**

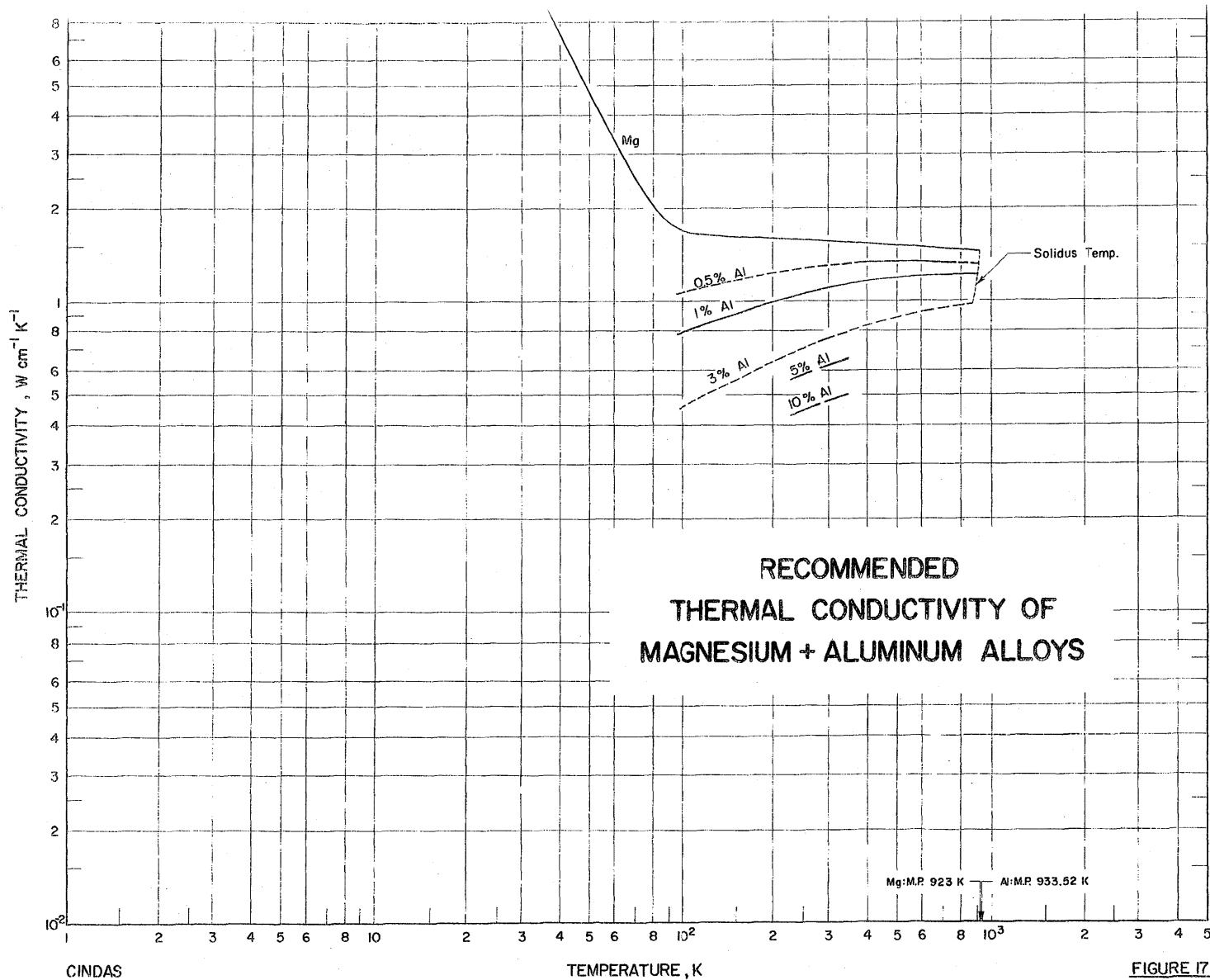
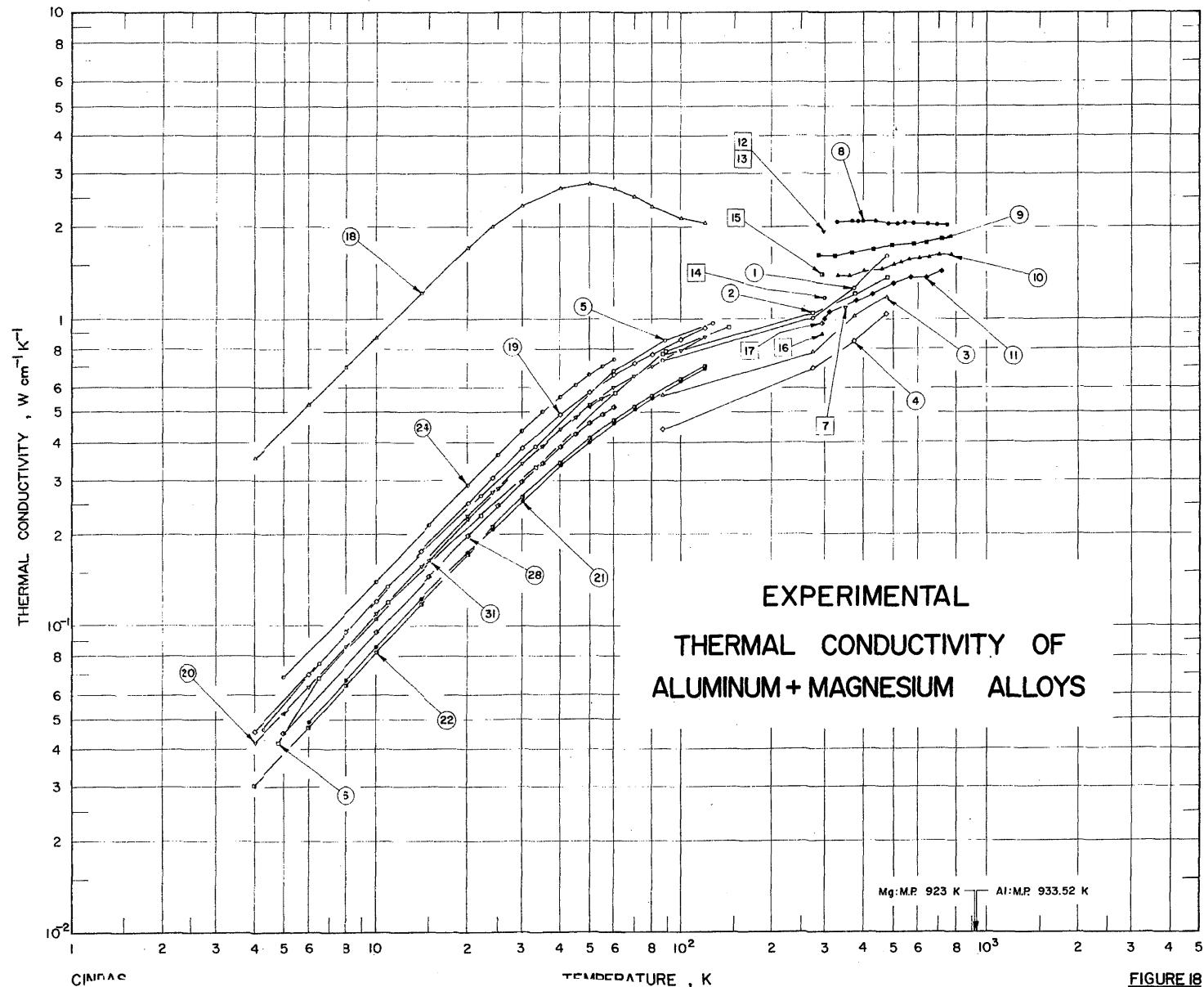


FIGURE 17



**FIGURE 18**

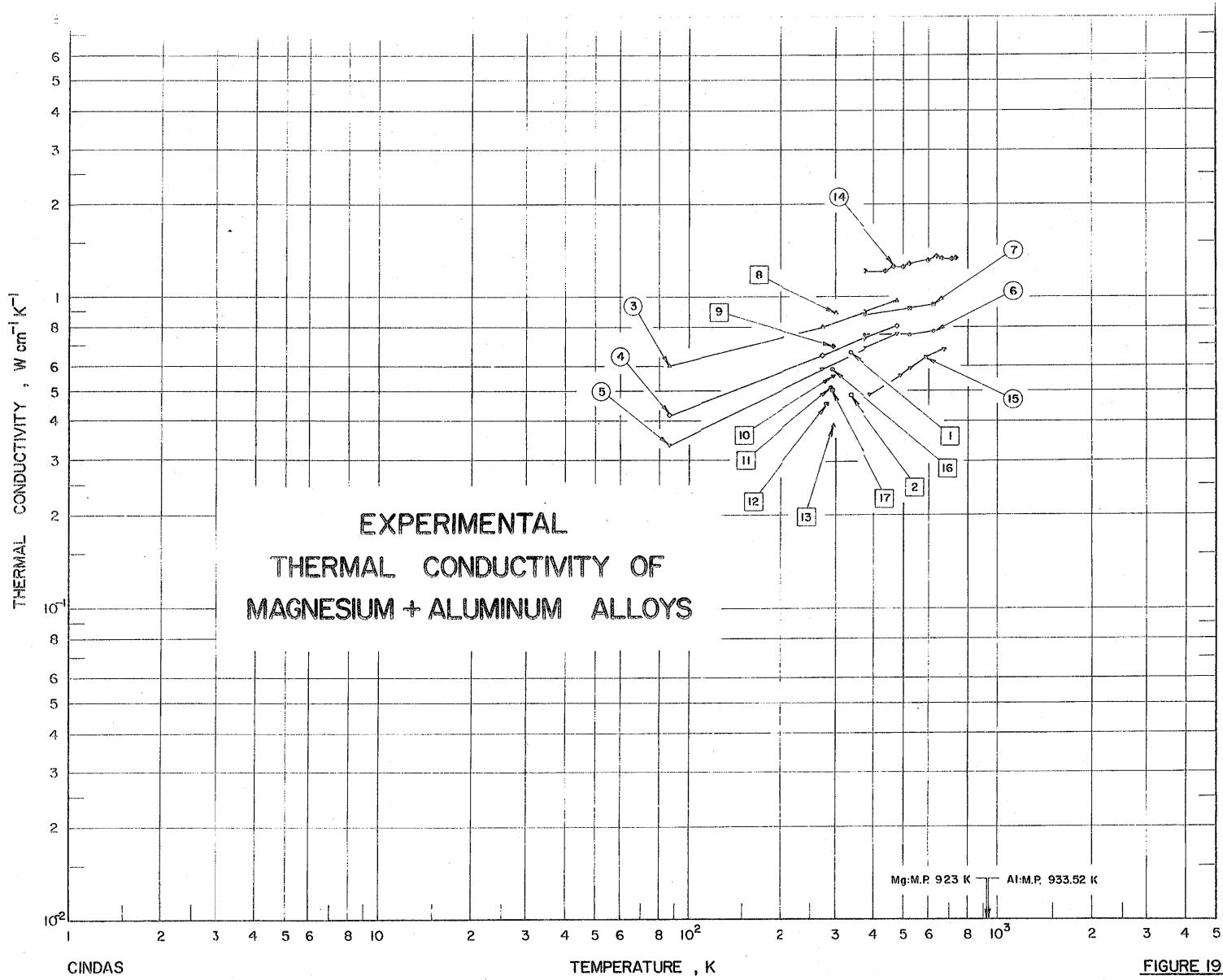


FIGURE 19

TABLE 6. THERMAL CONDUCTIVITY OF ALUMINUM + MAGNESIUM ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent)		Composition (continued), Specifications, and Remarks
							Al	Mg	
1	41	Mannchen, W.	1931	L	87-476		92.0	8.0	Cast; electrical conductivity reported as 20.02, 13.21, 10.5, and $8.8 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 87, 273, 373, and 476 K, respectively.
2	41	Mannchen, W.	1931	L	87-476		92.0	8.0	Annealed; electrical conductivity reported as 24.5, 15.05, 12.25, and $10.25 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 87, 273, 373, and 476 K, respectively.
3	41	Mannchen, W.	1931	L	87-476		88.0	12.0	Cast; electrical conductivity reported as 19.6, 11.95, 9.4, and $7.85 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 87, 273, 373, and 476 K, respectively.
4	41	Mannchen, W.	1931	L	87-476		86.0	14.0	Annealed; electrical conductivity reported as 12.7, 8.96, 8.05, and $7.6 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 87, 273, 373, and 476 K, respectively.
5	56	Johnson, E.W.	1960		4.3-128	5052	97.7- 97.1	2.2- 2.8	0.10 Mn; annealed.
6	56	Johnson, E.W.	1960		4.8-144	5154	96.8- 96.0	3.1- 3.9	0.10 Mn; annealed.
7	122	Meyer-Rassler, E.	1940		348.2	Magnalium	93.0	7.0	15 mm in diameter and 72 mm long; density $2.63 \text{ g cm}^{-3}$ .
8	58	Mikryukov, V.E. and Karagezyan, A.G.	1961	E	327-746		99.3	0.7	3 mm diameter and 300 mm long; prepared from 99.9 pure Al.
9	58	Mikryukov, V.E. and Karagezyan, A.G.	1961	E	285-716		97.0	3.0	Similar to the above specimen.
10	58	Mikryukov, V.E. and Karagezyan, A.G.	1961	E	330-766		95.0	5.0	Similar to the above specimen.
11	58	Mikryukov, V.E. and Karagezyan, A.G.	1961	E	289-717		92.0	8.0	Similar to the above specimen.
12	123	Materials in Design Engineering	1959		298.2	5005	Bal.	0.8	Nominal composition; annealed at 617 K; density $2.68 \text{ g cm}^{-3}$ ; electrical resistivity $3.4 \mu\Omega \text{ cm}$ at 20 C.
13	123	Materials in Design Engineering	1959		298.2	5050	Bal.	1.0~ 1.8	Nominal composition; annealed at 617 K; density $2.68 \text{ g cm}^{-3}$ .
14	123	Materials in Design Engineering	1959		298.2	5056	Bal.	4.7~ 5.6	0.05~0.20 Cr and 0.05~0.20 Mn (nominal composition); annealed at 617 K; density $2.63 \text{ g cm}^{-3}$ ; electrical resistivity $5.94 \mu\Omega \text{ cm}$ at 20 C.
15	123	Materials in Design Engineering	1959		293.2	G4A	96.0	4.0	Nominal composition; as cast; density $2.63 \text{ g cm}^{-3}$ .
16	123	Materials in Design Engineering	1959		293.2	G10A	96.0	4.0	Nominal composition; as cast; density $2.57 \text{ g cm}^{-3}$ .
17	123	Materials in Design Engineering	1959		293.2	G8A	92.0	8.0	Nominal composition; as cast; density $2.57 \text{ g cm}^{-3}$ .
18	57	Powell, R.L., Hall, W.J. and Roder, H.M.	1960	L	4-120	6063-T5	Bal.	0.65	0.38 Si, 0.1 each Fe, Ga, Mn, 0.01 each Cr, Cu, Ti, V, Zn, 0.001 Ca, and 0.001 Pb; 3.66 mm diameter rod specimen; grain size $0.052 \text{ mm} \times 0.048 \text{ mm}$ (longitudinal) and $0.052 \text{ mm}$ (transverse); precipitation heat-treated; electrical resistivity 0.28, 0.28, 0.31, 0.43, 0.6, 2.3, and $3.5 \mu\Omega \text{ cm}$ at 4, 10, 40, 60, 100, 200, and 300 K, respectively; smoothed values reported.

TABLE 6. THERMAL CONDUCTIVITY OF ALUMINUM + MAGNESIUM ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION (continued)

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent) Al      Mg	Composition (continued), Specifications, and Remarks
19	57	Powell, R. L., Hall, W. J., and Roder, H. M.	1960	L	4-120	5052-O	Bal.      2.46	0.22 Cr, 0.1 each Cu, Fe, Si, Ga, Mn, Zn, 0.01 Ti, 0.01 V, 0.001 Ca, and 0.001 Zr; grain size 0.056 mm x 0.032 mm (longitudinal) and 0.040 mm (transverse); annealed in vacuum for 1 hr at 350 C; electrical resistivity 2.0, 2.1, 2.2, 2.7, 4.4, and 5.0 $\mu\Omega$ cm at 4, 20, 60, 100, 200, and 300 K, respectively; smoothed values reported.
20	57	Powell, R. L., et al.	1960	L	4-120	5154-O	Bal.      3.32	0.21 Cr, 0.1 each Cu, Fe, Si, Mn, 0.01 each Ti, V, Zn, 0.001 Ca, and 0.001 Pb; grain size 0.036 mm x 0.028 mm (longitudinal) and 0.032 mm (transverse); annealed in vacuum for 1 hr at 350 C; electrical resistivity 2.2, 2.3, 2.4, and 2.5 $\mu\Omega$ cm at 4, 10, 30, and 60 K, respectively; smoothed values reported.
21	57	Powell, R. L., et al.	1960	L	6-120	5083-O	Bal.      4.44	0.7 Mn, 0.1 each Cr, Fe, Si, 0.04 Cu; supplied by R. D. Ollerman, Kaiser Aluminum and Chemical Co.; average crystal grain size 0.74 mm x 0.21 mm (longitudinal) and 0.54 mm x 0.14 mm (transverse); annealed in vacuum for 1 hr at 350 C.
22	57	Powell, R. L., et al.	1960	L	4-120	5086-F	Bal.      4.10	0.51 Mn, 0.28 Fe, 0.1 each Cr, Si, Zn, 0.07 Cu, and 0.02 Ti; average crystal grain size 0.061 mm x 0.022 mm (longitudinal) and 0.086 mm x 0.020 mm (transverse); as fabricated; electrical resistivity 3.0, 3.0, 3.1, 3.6, 5.0, and 5.7 $\mu\Omega$ cm at 4, 40, 60, 100, 200, and 300 K, respectively; smoothed values reported.
23 <sup>a</sup>	190	Mohan, N. S., Klaffky, R. W., Harrington, L. C., and Damon, D. H.			5-60	2a	→      →	Starting composition 95.47 Al and 4.53 Mg; composition as determined from residual resistivity was 96.38 Al and 3.62 Mg; specimen made in the laboratory of the Institute of Materials Science at Storrs, Connecticut; annealed at 473 K for 96 h, at 623 K for 72 h, and further annealed at 733 K for 8.5 h; specimen swaged from 1/4 in to 1/8 in at room temperature; also quenched in water at room temperature after annealing; solute loss on heat treatment about 0.2%; residual resistivity $\rho_0 = 1.842 \times 10^{-8} \Omega\text{m}$ , measured at 4.2 K; no resistivity minimum found between 1.5 and 4.2 K; composition of alloy was calculated from residual resistivity using Fickett's recommended value of $4.6 \times 10^{-9} \Omega\text{m}$ per atomic percent of Mg; original data reported tabularly; obtained after smoothing the measured values using a standard least squares fit of the type $\lambda = X_1 T^{-2} + X_2 T^{-1} + X_3 T + X_4 T^2 + X_5 T^3 + X_6 T^4$ ; experimental accuracy about 3% for $T \lesssim 30$ K, and about 5% for $T \gtrsim 30$ K.
24	190	Mohan, N. S., et al.			5-60	2b	→      →	Similar to the above specimen except for the following: starting composition 95.47 Al and 4.53 Mg; composition as determined from residual resistivity was 96.41 Al and 3.59 Mg; specimen further annealed at 773 K for 20 h and slow-cooled in furnace to 293 K at a rate of 50 deg/h; solute loss on heat treatment about 0.75%; residual resistivity $\rho_0 = 1.828 \times 10^{-8} \Omega\text{m}$ .
25 <sup>a</sup>	190	Mohan, N. S., et al.			5-60	3	→      →	Similar to the above specimen except for the following: starting composition 95.47 Al and 4.53 Mg; composition as determined from residual resistivity was 95.97 Al and 4.03 Mg; no heat treatment and solute loss reported; residual resistivity $\rho_0 = 2.045 \times 10^{-8} \Omega\text{m}$ .

<sup>a</sup> Not shown in figure.

TABLE 6. THERMAL CONDUCTIVITY OF ALUMINUM + MAGNESIUM ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION (continued)

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent) Al      Mg	Composition (continued), Specifications, and Remarks
26*	190	Mohan, N.S., Klaffky, R.W., Harrington, L.C., and Damon, D.H.			5-60	3a	→      →	Similar to the above specimen except for the following: starting composition 95.47 Al and 4.53 Mg; composition as determined from residual resistivity was 96.33 Al and 3.67 Mg; specimen annealed at 843 K for 16 h and kept at 673 K for 24 h; solute loss on heat treatment about 0.2%; residual resistivity $\rho_0 = 1.869 \times 10^{-8} \Omega\text{m}$ .
27	190	Mohan, N.S., et al.			5-60	3b	→      →	Similar to the above specimen except for the following: starting composition 95.47 Al and 4.53 Mg; composition as determined from residual resistivity was 96.34 Al and 3.66 Mg; specimen annealed at 843 K for 16 h, kept at 673 K for 24 h, further annealed at 876 K for 17 h and slow-cooled in furnace to 543 K at a rate of 1 deg/min; solute loss on heat treatment about 0.02%; residual resistivity $\rho_0 = 1.862 \times 10^{-8} \Omega\text{m}$ .
28	190	Mohan, N.S., et al.			5-60	4	→      →	Similar to the above specimen except for the following: starting composition 93.65 Al and 6.35 Mg; composition as determined from residual resistivity was 94.65 Al and 5.54 Mg; specimen annealed at 876 K for 16 h and slow cooled in furnace to 708 K at a rate of 1 deg/min; solute loss on heat treatment about 0.2%; residual resistivity $\rho_0 = 2.812 \times 10^{-8} \Omega\text{m}$ .
29*	190	Mohan, N.S., et al.			5-60	5	→      →	Similar to the above specimen except for the following: starting composition 93.65 Al and 6.35 Mg; composition as determined from residual resistivity was 94.59 Al and 5.41 Mg; specimen swaged from 3/8 in to 1/8 in; no heat treatment and solute loss reported; residual resistivity $\rho_0 = 2.744 \times 10^{-8} \Omega\text{m}$ .
30*	190	Mohan, N.S., et al.			5-60	6	→      →	Similar to the above specimen except for the following: starting composition 93.65 Al and 6.35 Mg; composition as determined from residual resistivity was 95.14 Al and 4.96 Mg; specimen swaged from 3/16 in to 1/8 in; no heat treatment and solute loss reported; residual resistivity $\rho_0 = 2.521 \times 10^{-8} \Omega\text{m}$ .
31	190	Mohan, N.S., et al.			5-60	6a	→      →	Similar to the above specimen except for the following: starting composition 93.65 Al and 6.35 Mg; composition as determined from residual resistivity was 95.23 Al and 4.77 Mg; specimen swaged from 3/16 in to 1/8 in; annealed at 673 K for 25 h and air quenched; no solute loss on heat treatment reported; residual resistivity $2.424 \times 10^{-8} \Omega\text{m}$ .
32	190	Mohan, N.S., et al.			5-60	7	→      →	Similar to the above specimen except for the following: starting composition 93.65 Al and 6.35 Mg; composition as determined from residual resistivity was 95.35 Al and 4.65 Mg; specimen swaged from 3/8 in to 1/8 in; annealed at 473 K for 96 h, further at 623 K for 72 h; further at 738 K for 85 h, further at 848 K for 10 h and kept at 273 K for 15 h; solute loss on heat treatment about 1.9%; residual resistivity $2.359 \times 10^{-8} \Omega\text{m}$ .

\* Not shown in figure.

TABLE 7. THERMAL CONDUCTIVITY OF MAGNESIUM + ALUMINUM ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION

Cur. Ref. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent) Mg      Al	Composition (continued), Specifications, and Remarks	
1	45	Smith, A. W.	1925	L	336.2		95.82      4.12	0.028 Fe and 0.019 Si; ~5 cm long and 0.3 cm <sup>2</sup> in cross-section; supplied by Aluminum Co. of America; electrical conductivity $9.06 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 63 C.	
2	45	Smith, A. W.	1925	L	336.2		89.82      10.12	0.023 Si and 0.028 Fe; similar to the above specimen except electrical conductivity $6.00 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 63 C.	
3	124, 41	Staebler, J.; Mannchen, W.	1929 1931	L	87-476		94.0      6.0	1.23 cm <sup>2</sup> in cross-section and 3 cm long; cast; electrical conductivity 14.7, 8.04, 6.47, and $5.99 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 87, 273, 373, and 476 K, respectively.	
4	124, 41	Staebler, J.; Mannchen, W.	1929 1931	L	87-476		92.0      8.0	1.23 cm <sup>2</sup> in cross-section and 3 cm long; electrical conductivity 13.32, 7.31, 5.95, and $5.55 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 87, 273, 373, and 476 K, respectively.	
5	124, 41	Staebler, J.; Mannchen, W.	1929 1931	L	87-476		88      12	1.23 cm <sup>2</sup> in cross-section and 3 cm long; electrical conductivity 9.65, 5.99, 5.27, and $4.90 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 87, 273, 373, and 476 K, respectively.	
6	60	Maybrey, H.J.	1928	L	373-623		94      6	12 in. long and 1 in. in diameter; annealed at 300 C for 3 hr.	
7	60	Maybrey, H.J.	1928	L	373-623		89      11	Similar to the above specimen.	
8	59	Kikuchi, R.	1932	E	300.2		97.9      2.1	3 mm diameter and 200 mm long; electrical conductivity $11.9 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 27 C.	
9	59	Kikuchi, R.	1932	E	295.5		95.8      4.2	3 mm diameter and 200 mm long; electrical conductivity $8.9 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 22.3 C.	
10	59	Kikuchi, R.	1932	E	295.1		93.8      6.2	3 mm diameter and 200 mm long; electrical conductivity $6.9 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 21.9 C.	
11	59	Kikuchi, R.	1932	E	291.5		91.8      8.2	3 mm diameter and 200 mm long; electrical conductivity $5.9 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 18.3 C.	
12	59	Kikuchi, R.	1932	E	281.5		89.7      10.3	3 mm diameter and 200 mm long; electrical conductivity $5.5 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 19.3 C.	
13	59	Kikuchi, R.	1932	E	296.5		87.8      12.2	3 mm diameter and 200 mm long; electrical conductivity $5.1 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 23.1 C.	
14	125	Giuliani, S.	1967	C	375-736	Magnox; Al 80	0.80	0.0050 Be, 0.0020 Mn, and 0.0004 Cu; 1.2 to 1.3 cm in diameter and 1.8 to 2.5 cm long; Armco iron used as comparative material.	
15	125	Giuliani, S.	1967	C	387-674	Magnox; Atesia T	8-9	0.5-1 Zn and 0.2 Mn; 1.2 to 1.3 cm in diameter and 1.8 to 2.5 cm long; Armco iron used as comparative material.	
16	123	Materials in Design Engineering	1959		293.2	AZ6aA-F	5.8- 7.2	0.4-1.5 Zn and >0.15 Mn (nominal composition); density $1.80 \text{ g cm}^{-3}$ ; electrical resistivity $12.5 \mu\Omega \text{ cm}$ at 20 C.	
17	123	Materials in Design Engineering	1959		293.2	AZ80A-T	7.8- 9.2	0.2-0.8 Zn and >0.12 Mn (nominal composition); density $1.83 \text{ g cm}^{-3}$ ; electrical resistivity $14.5 \mu\Omega \text{ cm}$ at 20 C.	
18* 173	Powell, R.W., Hickman, M.J., and Tye, R. P.		1964	C	323-773	Magnox B	1.0	0.002-0.003 Be; 2.5 cm diameter $\times 20^+$ cm long; electrical resistivity 6.05, 6.5, 7.3, 8.9, 10.6, 12.3, and $14.15 \mu\Omega \text{ cm}$ at 20, 50, 100, 200, 300, 400, and 500 C, respectively.	

\* Not shown in figure.

#### 4.3. Copper-Gold Alloy System

The copper-gold alloy system forms a continuous series of solid solutions over the entire range of compositions. Ordered structures are formed at temperatures below about 663 K for compositions ranging from about 40 to 63% Au (17.7 to 35.5 At.% Au) and at temperatures below about 683 K for compositions ranging from about 63 to 94% Au (35.5 to 83.5 At.% Au). These ordered structures are due to the formation of the intermetallic compounds  $\text{Cu}_3\text{Au}$  (50.85% Au),  $\text{CuAu}$  (75.63% Au), and  $\text{CuAu}_3$  (90.30% Au). In this work only the thermal conductivity data of disordered alloys are treated.

There are 75 sets of experimental data available for the thermal conductivity of this alloy system. Of the 17 data sets for  $\text{Cu}+\text{Au}$  alloys listed in table 9 and shown in figure 24, nine sets are merely single data points around room temperature. Of the 58 curves for  $\text{Au}+\text{Cu}$  alloys listed in table 10 and shown in figure 25, 35 sets are single data points.

For the  $\text{Cu}+\text{Au}$  alloys, the data can be separated into three groups: the low temperature data of Grüneisen and Reddemann [61] ( $\text{Cu}+\text{Au}$  curves 1 and 2) and of Kemp et al. [62] ( $\text{Cu}+\text{Au}$  curves 8 and 9), the data of Sedström [63] ( $\text{Cu}+\text{Au}$  curves 10-15) at the ice point, and the five points around 440 K measured by Zolotukhin [65] ( $\text{Cu}+\text{Au}$  curves 3-7) for a partially ordered 5% Au. No data are available above 470 K. Hence the experimental data are very limited. To derive recommended values, the electronic component  $k_e$  was calculated from eq (12) and the lattice component  $k_g$  was calculated from eq (35). The total  $k$  was obtained by adding  $k_g$  to  $k_e$ . The recommended curves were extended to the solidus points at high temperatures. The curves for alloys containing 10% Au or less were not extended to temperatures below 40 K because of the large uncertainties of the calculated  $k_g$  values at low temperatures. For denser alloys, however, the curves were extended to 4 K using  $k_e$  values derived from the data of Kemp et al. [62]. The  $k_g$  values for dilute alloys are extremely uncertain at low temperatures and are not reported below 60 K.

A graphical comparison of the recommended total thermal conductivities with some of the experimental data for  $\text{Cu}+\text{Au}$  alloys is given in figure 20. The smooth solid curves in the figure were obtained by interpolating the recommended values of table 8 in order to obtain thermal conductivities for the desired alloy compositions. The recommended values are in agreement with the data of Kemp et al. [62] ( $\text{Cu}+\text{Au}$  curves 8 and 9), of Leaver and Charsley [120] ( $\text{Cu}+\text{Au}$  curve 16), and of Grüneisen and Reddemann [61] ( $\text{Cu}+\text{Au}$  curve 2) to within 8%. Measurements of Sedström [63] ( $\text{Cu}+\text{Au}$  curves 12-15) at the ice point for a wide range of compositions differ from the recommendations by no more than 10%.

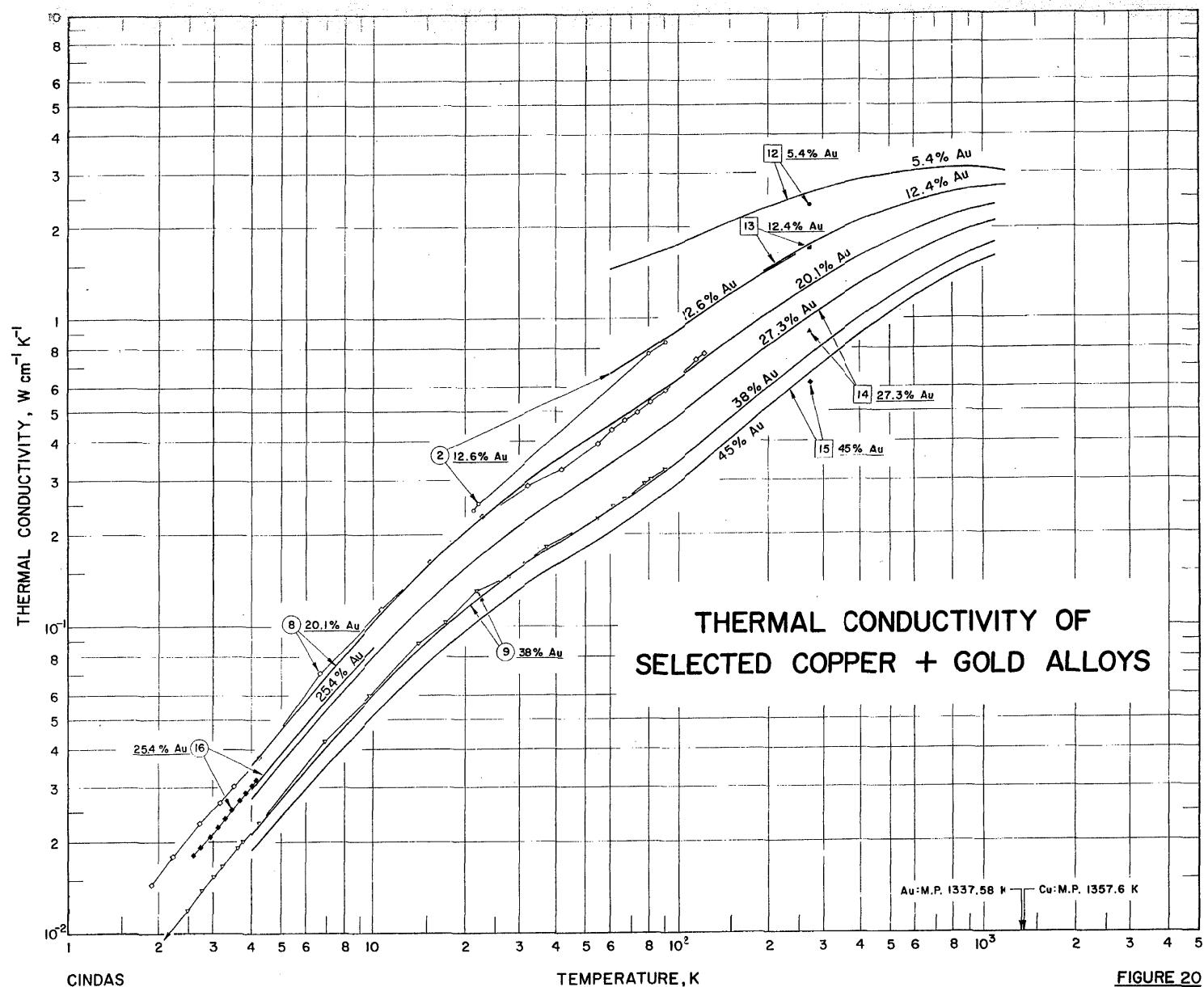
The data for Sedström's 44.76% Au specimen ( $\text{Cu}+\text{Au}$  curve 10) show poor agreement, especially at 373 K, with the recommendations and are not shown in figure 20. However, the temperature dependence of both the thermal and electrical conductivities of this specimen is at odds with all other experimental data and may be safely discounted as erroneous. Similarly, the measurements of Grüneisen and

Reddemann [61] ( $\text{Cu}+\text{Au}$  curve 1) for a 24.8% Au specimen are 10-20% higher than the recommendation and are not shown in the figure. Since the recommended values are for disordered alloys only, there can be no valid comparison with the data of Zolotukhin [65] ( $\text{Cu}+\text{Au}$  curves 3-7) for a partially ordered alloy.

For the  $\text{Au}+\text{Cu}$  alloys, the experimental data were mostly obtained below the order-disorder transition temperature on specimens in the ordering range, except for two measurements made by Grüneisen and Reddemann [61] ( $\text{Au}+\text{Cu}$  curves 40 and 41) on specimens containing 1.57 and 3.10% Cu at low temperatures and one made by Goff et al. [66] ( $\text{Au}+\text{Cu}$  curve 56) on a disordered  $\text{Cu}_3\text{Au}$  specimen. The recommended values for disordered alloys were derived from  $k_e$  calculated from eq (35) and  $k_g$  calculated from eq (12) using electrical resistivity data for disordered alloys. The recommended curves were extended to the solidus points at the high temperature end, but not below 40 K at the low temperature end owing to the large uncertainties of the calculated  $k_g$  values at very low temperatures, except for the curves for alloys with 45 and 50% Cu, which were extended to 4 K using the  $k_g$  values derived from the data of Kemp et al. [62]. The  $k_g$  values for alloys containing 40% Cu or less are very uncertain at low temperatures and are not reported below 60 K.

The recommended total thermal conductivities for the  $\text{Au}+\text{Cu}$  alloys are compared with some of the experimental data in figure 21. Not all of the experimental data shown are for fully disordered specimens. Due to poor experimental data and a lack of data for disordered specimens, a detailed quantitative comparison of the calculated values is not practical. However, the recommended values are within 5% of the low temperature data of Grüneisen and Reddemann [61] ( $\text{Au}+\text{Cu}$  curves 38-41, 45, 46, and 48) for disordered specimens or specimens quenched from above the ordering transition temperature. Some of the data of Sedström [64] ( $\text{Au}+\text{Cu}$  curves 21, 23, 27, and 29) are within 5% of the recommendations. The agreement with the low-temperature results of Goff et al. [66] ( $\text{Au}+\text{Cu}$  curves 56 and 58) is poor, but from 60-300 K their measurements fall within 10% of the recommendations.

The resulting recommended values for  $k$ ,  $k_e$ , and  $k_g$  are tabulated in table 8 for 25 alloy compositions. These values are for disordered alloys which have not been severely cold worked or quenched. The values for  $k$  are also presented in figures 22 and 23. In order to clearly show the trend of the dependence of the thermal conductivity on solute concentration and to clarify the confusion in figure 23 due to crossover of curves, recommendations for alloys with 55-75% Au are also displayed in figure 22 along with recommendations for the  $\text{Cu}+\text{Au}$  alloys. The values of residual electrical resistivity for the alloys are also given in table 8. The uncertainties of the  $k$  values are stated in a footnote to table 8, while the uncertainties of the  $k_e$  and  $k_g$  values are indicated by their being designated as recommended or provisional values. The ranges of uncertainties of recommended and provisional values are less than  $\pm 15\%$  and between  $\pm 15$  and  $\pm 30\%$ , respectively.



**FIGURE 20**

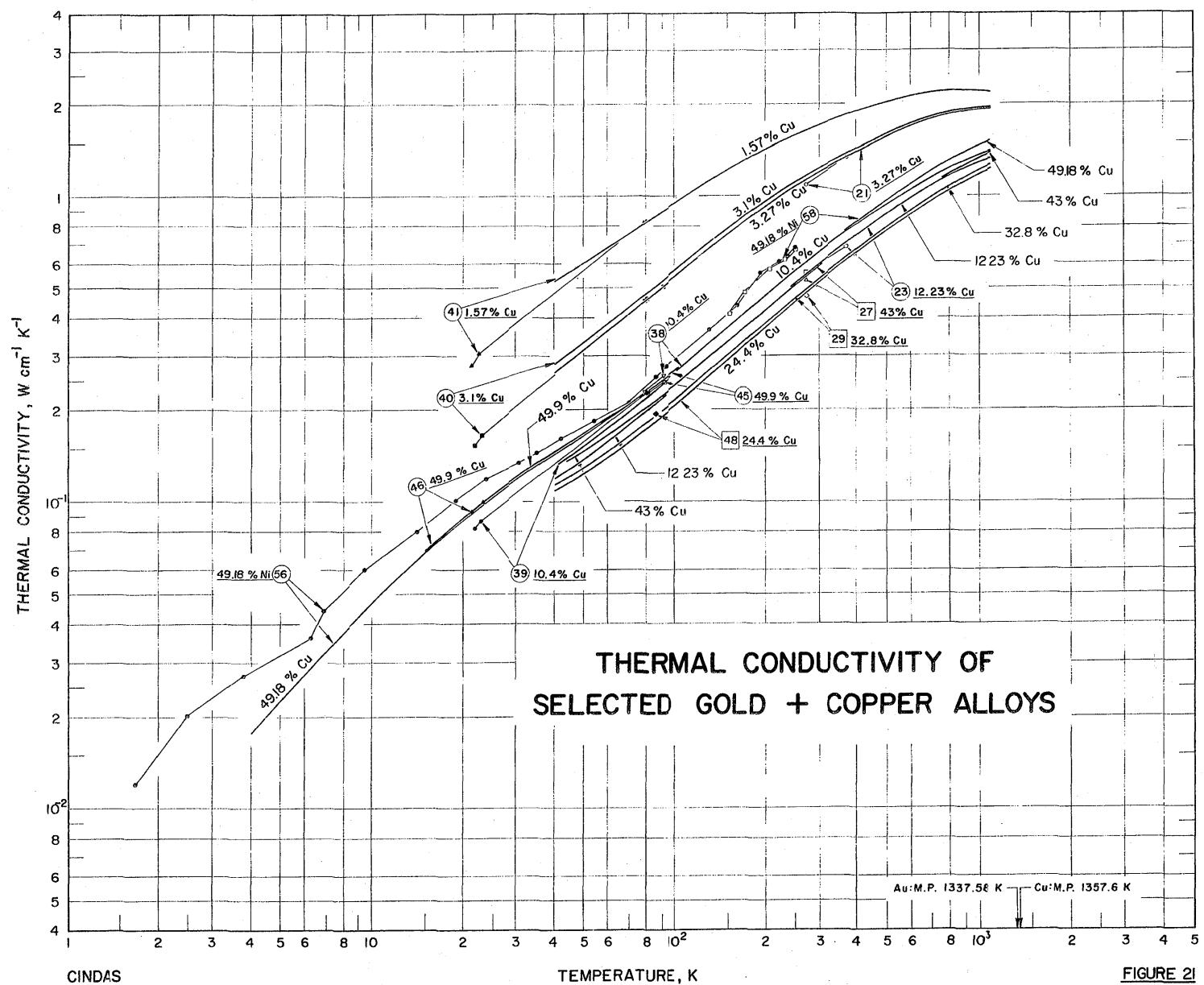


FIGURE 2I

8 10<sup>2</sup> 2 3 4 5 6 8

TURE, K

TABLE 8. RECOMMENDED THERMAL CONDUCTIVITY OF COPPER-GOLD ALLOY SYSTEM<sup>†</sup>[Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Cu: 99.50% (99.84 At.%) Au: 0.50% ( 0.16 At.%)				Cu: 99.00% (99.68 At.%) Au: 1.00% ( 0.32 At.%)				Cu: 97.00% (98.01 At.%) Au: 3.00% ( 0.99 At.%)				Cu: 95.00% (98.33 At.%) Au: 5.00% ( 1.67 At.%)			
$\rho_o = 0.10 \mu\Omega \text{ cm}$				$\rho_o = 0.20 \mu\Omega \text{ cm}$				$\rho_o = 0.530 \mu\Omega \text{ cm}$				$\rho_o = 0.870 \mu\Omega \text{ cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.977			4	0.489			4	0.184			4	0.112		
6	1.47			6	0.733			6	0.276			6	0.168		
8	1.95			8	0.977			8	0.339			8	0.225		
10	2.44			10	1.22			10	0.451			10	0.281		
15	3.66			15	1.83			15	0.691			15	0.421		
20	4.89			20	2.44			20	0.922			20	0.562		
25	5.76			25	2.96			25	1.14			25	0.697		
30	6.11			30	3.49			30	1.36			30	0.832		
40	6.76			40	4.17			40	1.73			40	1.08		
50	6.30			50	4.46			50	1.99			50	1.28		
60	5.57*	5.26		60	4.34*	4.09		60	2.29*	2.12		60	1.55*	1.41	
70	4.80*	4.50		70	3.99*	3.74		70	2.34*	2.18		70	1.63*	1.50	
80	4.37*	4.09		80	3.75*	3.52		80	2.36*	2.21		80	1.70*	1.58	
90	4.12*	3.85		90	3.60*	3.38		90	2.39*	2.24		90	1.76*	1.64	
100	4.01*	3.75		100	3.55*	3.34		100	2.44*	2.30		100	1.83*	1.72	
150	3.92*	3.71	0.205 <sup>‡</sup>	150	3.60*	3.44	0.165 <sup>‡</sup>	150	2.74*	2.63	0.112 <sup>‡</sup>	150	2.17*	2.08	0.0906 <sup>‡</sup>
200	3.88*	3.71	0.170 <sup>‡</sup>	200	3.65*	3.51	0.141 <sup>‡</sup>	200	2.92*	2.82	0.0958 <sup>‡</sup>	200	2.42*	2.34	0.0778 <sup>‡</sup>
250	3.86*	3.71	0.147 <sup>‡</sup>	250	3.68*	3.56	0.123 <sup>‡</sup>	250	3.05*	2.97	0.0843 <sup>‡</sup>	250	2.60*	2.53	0.0686 <sup>‡</sup>
273	3.85*	3.71	0.138 <sup>‡</sup>	273	3.70*	3.58	0.116 <sup>‡</sup>	273	3.10*	3.02	0.0801 <sup>‡</sup>	273	2.67	2.60	0.0652 <sup>‡</sup>
300	3.85*	3.72	0.129 <sup>‡</sup>	300	3.71*	3.60	0.109 <sup>‡</sup>	300	3.15*	3.07	0.0757 <sup>‡</sup>	300	2.74*	2.68	0.0618 <sup>‡</sup>
350	3.85*	3.74	0.114 <sup>‡</sup>	350	3.73*	3.63	0.0979 <sup>‡</sup>	350	3.21*	3.14	0.0688 <sup>‡</sup>	350	2.85*	2.79	0.0564 <sup>‡</sup>
400	3.83*	3.73	0.103 <sup>‡</sup>	400	3.72*	3.63	0.0890 <sup>‡</sup>	400	3.26*	3.20	0.0633 <sup>‡</sup>	400	2.92*	2.87	0.0520 <sup>‡</sup>
500	3.77*	3.68	0.0861 <sup>‡</sup>	500	3.69*	3.61	0.0755 <sup>‡</sup>	500	3.32*	3.26	0.0548 <sup>‡</sup>	500	3.03*	2.98	0.0453 <sup>‡</sup>
600	3.71*	3.64	0.0738 <sup>‡</sup>	600	3.65*	3.58	0.0656 <sup>‡</sup>	600	3.34*	3.29	0.0486 <sup>‡</sup>	600	3.08*	3.04	0.0403 <sup>‡</sup>
700	3.65*	3.59	0.0647 <sup>‡</sup>	700	3.60*	3.54	0.0581 <sup>‡</sup>	700	3.35*	3.31	0.0437 <sup>‡</sup>	700	3.12*	3.08	0.0365 <sup>‡</sup>
800	3.60*	3.54	0.0575 <sup>‡</sup>	800	3.55*	3.50	0.0521 <sup>‡</sup>	800	3.34*	3.30	0.0398 <sup>‡</sup>	800	3.14*	3.11	0.0335 <sup>‡</sup>
900	3.55*	3.50	0.0518 <sup>‡</sup>	900	3.50*	3.45	0.0473 <sup>‡</sup>	900	3.31*	3.27	0.0366 <sup>‡</sup>	900	3.14*	3.11	0.0309 <sup>‡</sup>
1000	3.49*	3.44	0.0471 <sup>‡</sup>	1000	3.45*	3.41	0.0433 <sup>‡</sup>	1000	3.28*	3.25	0.0340 <sup>‡</sup>	1000	3.13*	3.10	0.0288 <sup>‡</sup>
1200	3.36*	3.32	0.0399 <sup>‡</sup>	1200	3.33*	3.29	0.0370 <sup>‡</sup>	1200	3.20*	3.17	0.0297 <sup>‡</sup>	1200	3.09*	3.06	0.0254 <sup>‡</sup>
1355	3.26*			1353	3.24*			1346	3.13*			1339	3.04*		

<sup>†</sup> Uncertainties in the total thermal conductivity, k, are as follows:99.50 Cu - 0.50 Au:  $\pm 14\%$  below 100 K,  $\pm 10\%$  between 100 and 300 K, and  $\pm 8\%$  above 300 K.99.00 Cu - 1.00 Au:  $\pm 14\%$  below 100 K,  $\pm 10\%$  between 100 and 300 K, and  $\pm 8\%$  above 300 K.97.00 Cu - 3.00 Au:  $\pm 14\%$  below 200 K and  $\pm 10\%$  above 200 K.95.00 Cu - 5.00 Au:  $\pm 14\%$  below 200 K and  $\pm 10\%$  above 200 K.<sup>‡</sup> Provisional value.<sup>\*</sup> In temperature range where no experimental thermal conductivity data are available.

TABLE 8. RECOMMENDED THERMAL CONDUCTIVITY OF COPPER-GOLD ALLOY SYSTEM (continued)<sup>†</sup>[Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Cu: 90.00% (96.54 At.%) Au: 10.00% ( 3.46 At.%)				Cu: 85.00% (94.61 At.%) Au: 15.00% ( 5.39 At.%)				Cu: 80.00% (92.54 At.%) Au: 20.00% ( 7.46 At.%)				Cu: 75.00% (90.29 At.%) Au: 25.00% ( 9.71 At.%)			
$\rho_o = 1.72 \mu\Omega \text{ cm}$				$\rho_o = 2.58 \mu\Omega \text{ cm}$				$\rho_o = 3.52 \mu\Omega \text{ cm}$				$\rho_o = 4.45 \mu\Omega \text{ cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.0568			4	0.0462	0.0379	0.00829	4	0.0358	0.0278	0.00805	4	0.0299	0.0220	0.00788
6	0.0852			6	0.746	0.0568	0.0178	6	0.0580	0.0416	0.0164	6	0.0482	0.0329	0.0153
8	0.117			8	0.104	0.0758	0.0287	8	0.0811	0.0555	0.0256	8	0.0675	0.0439	0.0236
10	0.142			10	0.134	0.0947	0.0397	10	0.104	0.0694	0.0350	10	0.0867	0.0549	0.0318
15	0.213			15	0.205	0.142	0.0631	15	0.158	0.104	0.0542	15	0.131	0.0823	0.0486
20	0.284			20	0.269	0.189	0.0799	20	0.206	0.139	0.0674	20	0.170	0.110	0.0598
25	0.353			25	0.324	0.234	0.0901	25	0.248	0.173	0.0755	25	0.204	0.137	0.0665
30	0.421			30	0.375	0.280	0.0950	30	0.286	0.206	0.0795	30	0.233	0.163	0.0697
40	0.553			40	0.462	0.368	0.0942	40	0.351	0.272	0.0789	40	0.284	0.216	0.0684
50	0.666			50	0.534	0.446	0.0879	50	0.407	0.333	0.0743	50	0.332	0.267	0.0647
60	0.856	0.756		60	0.600	0.518	0.0816 <sup>‡</sup>	60	0.458	0.389	0.0694 <sup>‡</sup>	60	0.373	0.312	0.0606 <sup>‡</sup>
70	0.932	0.838		70	0.658	0.582	0.0763 <sup>‡</sup>	70	0.506	0.441	0.0649 <sup>‡</sup>	70	0.414	0.358	0.0565 <sup>‡</sup>
80	1.00	0.916		80	0.714	0.642	0.0719 <sup>‡</sup>	80	0.552	0.491	0.0610 <sup>‡</sup>	80	0.453	0.400	0.0532 <sup>‡</sup>
90	1.07	0.982		90	0.769	0.701	0.0682 <sup>‡</sup>	90	0.597	0.539	0.0578 <sup>‡</sup>	90	0.491	0.441	0.0503 <sup>‡</sup>
100	1.13*	1.05		100	0.824*	0.759	0.0649 <sup>‡</sup>	100	0.643	0.588	0.0550 <sup>‡</sup>	100	0.530	0.482	0.0478 <sup>‡</sup>
150	1.44*	1.37	0.0657 <sup>‡</sup>	150	1.08*	1.03	0.0532 <sup>‡</sup>	150	0.861*	0.816	0.0450 <sup>‡</sup>	150	0.717*	0.678	0.0391 <sup>‡</sup>
200	1.70*	1.64	0.0565 <sup>‡</sup>	200	1.31*	1.26	0.0457 <sup>‡</sup>	200	1.06*	1.02	0.0388 <sup>‡</sup>	200	0.882*	0.848	0.0337 <sup>‡</sup>
250	1.90*	1.85	0.0500 <sup>‡</sup>	250	1.50*	1.46	0.0406 <sup>‡</sup>	250	1.22*	1.18	0.0344 <sup>‡</sup>	250	1.03*	1.00	0.0299 <sup>‡</sup>
273	1.98	1.93	0.0476 <sup>‡</sup>	273	1.58	1.54	0.0386 <sup>‡</sup>	273	1.29*	1.26	0.0328 <sup>‡</sup>	273	1.09	1.06	0.0285 <sup>‡</sup>
300	2.08*	2.03	0.0452 <sup>‡</sup>	300	1.66*	1.62	0.0367 <sup>‡</sup>	300	1.37*	1.34	0.0311 <sup>‡</sup>	300	1.17	1.14	0.0271 <sup>‡</sup>
350	2.22*	2.18	0.0414 <sup>‡</sup>	350	1.80*	1.77	0.0336 <sup>‡</sup>	350	1.50*	1.47	0.0286 <sup>‡</sup>	350	1.29	1.26	0.0249 <sup>‡</sup>
400	2.33*	2.29	0.0383 <sup>‡</sup>	400	1.91*	1.88	0.0312 <sup>‡</sup>	400	1.62*	1.59	0.0265 <sup>‡</sup>	400	1.40*	1.38	0.0231 <sup>‡</sup>
500	2.50*	2.47	0.0335 <sup>‡</sup>	500	2.11*	2.08	0.0274 <sup>‡</sup>	500	1.81*	1.79	0.0234 <sup>‡</sup>	500	1.59*	1.57	0.0204 <sup>‡</sup>
600	2.61*	2.58	0.0300 <sup>‡</sup>	600	2.25*	2.23	0.0246 <sup>‡</sup>	600	1.97*	1.95	0.0210 <sup>‡</sup>	600	1.74*	1.72	0.0184 <sup>‡</sup>
700	2.70*	2.67	0.0274 <sup>‡</sup>	700	2.37*	2.35	0.0224 <sup>‡</sup>	700	2.09*	2.07	0.0192 <sup>‡</sup>	700	1.87*	1.85	0.0168 <sup>‡</sup>
800	2.76*	2.73	0.0252 <sup>‡</sup>	800	2.46*	2.44	0.0207 <sup>‡</sup>	800	2.19*	2.17	0.0178 <sup>‡</sup>	800	1.97*	1.95	0.0156 <sup>‡</sup>
900	2.80*	2.78	0.0234 <sup>‡</sup>	900	2.51*	2.49	0.0193 <sup>‡</sup>	900	2.26*	2.24	0.0166 <sup>‡</sup>	900	2.05*	2.04	0.0145 <sup>‡</sup>
1000	2.82*	2.80	0.0219 <sup>‡</sup>	1000	2.56*	2.54	0.0181 <sup>‡</sup>	1000	2.33*	2.31	0.0155 <sup>‡</sup>	1000	2.12*	2.11	0.0136 <sup>‡</sup>
1200	2.84*	2.82	0.0195 <sup>‡</sup>	1100	2.59*	2.57	0.0171 <sup>‡</sup>	1100	2.39*	2.37	0.0147 <sup>‡</sup>	1100	2.18*	2.17	0.0129 <sup>‡</sup>
1320	2.83*			1303	2.63*			1289	2.47*			1277	2.27*		

<sup>†</sup> Uncertainties in the total thermal conductivity, k, are as follows:90.00 Cu - 10.00 Au:  $\pm 12\%$  below 100 K,  $\pm 8\%$  between 100 and 400 K, and  $\pm 10\%$  above 400 K.85.00 Cu - 15.00 Au:  $\pm 12\%$  below 100 K,  $\pm 8\%$  between 100 and 400 K, and  $\pm 10\%$  above 400 K.80.00 Cu - 20.00 Au:  $\pm 10\%$  below 200 K,  $\pm 8\%$  between 200 and 500 K, and  $\pm 10\%$  above 500 K.75.00 Cu - 25.00 Au:  $\pm 10\%$  below 200 K,  $\pm 8\%$  between 200 and 500 K, and  $\pm 10\%$  above 500 K.<sup>\*</sup> Provisional value.<sup>\*</sup> In temperature range where no experimental thermal conductivity data are available.

TABLE 8. RECOMMENDED THERMAL CONDUCTIVITY OF COPPER-GOLD ALLOY SYSTEM (continued)<sup>†</sup>[Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Cu: 70.00% (87.85 At.%) Au: 30.00% (12.15 At.%)				Cu: 65.00% (85.20 At.%) Au: 35.00% (14.80 At.%)				Cu: 60.00% (82.30 At.%) Au: 40.00% (17.70 At.%)				Cu: 55.00% (79.12 At.%) Au: 45.00% (20.88 At.%)			
$\rho_o = 5.47 \mu\Omega \text{ cm}$				$\rho_o = 6.52 \mu\Omega \text{ cm}$				$\rho_o = 7.52 \mu\Omega \text{ cm}$				$\rho_o = 8.48 \mu\Omega \text{ cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.0256	0.0179	0.00772	4	0.0226	0.0150	0.00758	4	0.0205	0.0130	0.00746	4	0.0188	0.0115	0.00735
6	0.0413	0.0268	0.0145	6	0.0364	0.0225	0.0139	6	0.0327	0.0195	0.0132	6	0.0298	0.0173	0.0125
8	0.0575	0.0357	0.0218	8	0.0505	0.0300	0.0205	8	0.0452	0.0260	0.0192	8	0.0409	0.0230	0.0179
10	0.0739	0.0447	0.0292	10	0.0645	0.0375	0.0270	10	0.0575	0.0325	0.0250	10	0.0518	0.0288	0.0230
15	0.111	0.0670	0.0441	15	0.0962	0.0562	0.0400	15	0.0853	0.0487	0.0366	15	0.0765	0.0432	0.0333
20	0.143	0.0893	0.0539	20	0.124	0.0749	0.0488	20	0.109	0.0650	0.0444	20	0.0978	0.0576	0.0402
25	0.171	0.111	0.0596	25	0.147	0.0930	0.0540	25	0.130	0.0807	0.0491	25	0.116	0.0717	0.0445
30	0.195	0.133	0.0623	30	0.168	0.111	0.0566	30	0.148	0.0964	0.0515	30	0.132	0.0856	0.0468
40	0.236	0.175	0.0615	40	0.203	0.147	0.0559	40	0.178	0.127	0.0509	40	0.160	0.113	0.0467
50	0.275	0.217	0.0576	50	0.233	0.181	0.0522	50	0.204	0.157	0.0472	50	0.183	0.140	0.0430
60	0.309*	0.255	0.0537 <sup>‡</sup>	60	0.262*	0.214	0.0482 <sup>‡</sup>	60	0.230	0.186	0.0436 <sup>‡</sup>	60	0.204*	0.164	0.0396 <sup>‡</sup>
70	0.343*	0.293	0.0501 <sup>‡</sup>	70	0.291*	0.246	0.0449 <sup>‡</sup>	70	0.254	0.214	0.0405 <sup>‡</sup>	70	0.228*	0.191	0.0369 <sup>‡</sup>
80	0.376*	0.329	0.0470 <sup>‡</sup>	80	0.319*	0.277	0.0421 <sup>‡</sup>	80	0.279	0.241	0.0381 <sup>‡</sup>	80	0.251*	0.216	0.0346 <sup>‡</sup>
90	0.409*	0.364	0.0445 <sup>‡</sup>	90	0.348*	0.308	0.0398 <sup>‡</sup>	90	0.305	0.269	0.0360 <sup>‡</sup>	90	0.274*	0.241	0.0327 <sup>‡</sup>
100	0.442*	0.400	0.0423 <sup>‡</sup>	100	0.377*	0.339	0.0379 <sup>‡</sup>	100	0.331*	0.297	0.0342 <sup>‡</sup>	100	0.296*	0.265	0.0311 <sup>‡</sup>
150	0.603*	0.568	0.0346 <sup>‡</sup>	150	0.518*	0.487	0.0309 <sup>‡</sup>	150	0.456*	0.428	0.0279 <sup>‡</sup>	150	0.410*	0.385	0.0254 <sup>‡</sup>
200	0.750*	0.720	0.0298 <sup>‡</sup>	200	0.651*	0.624	0.0267 <sup>‡</sup>	200	0.576*	0.552	0.0241 <sup>‡</sup>	200	0.520*	0.498	0.0219 <sup>‡</sup>
250	0.886*	0.859	0.0265 <sup>‡</sup>	250	0.773*	0.749	0.0237 <sup>‡</sup>	250	0.687*	0.666	0.0214 <sup>‡</sup>	250	0.622*	0.603	0.0194 <sup>‡</sup>
273	0.942	0.917	0.0253 <sup>‡</sup>	273	0.825*	0.802	0.0226 <sup>‡</sup>	273	0.736	0.716	0.0204 <sup>‡</sup>	273	0.666	0.647	0.0186 <sup>‡</sup>
300	1.01	0.986	0.0240 <sup>‡</sup>	300	0.886*	0.865	0.0215 <sup>‡</sup>	300	0.791	0.772	0.0194 <sup>‡</sup>	300	0.717	0.699	0.0176 <sup>‡</sup>
350	1.12	1.10	0.0221 <sup>‡</sup>	350	0.988*	0.968	0.0198 <sup>‡</sup>	350	0.887	0.869	0.0179 <sup>‡</sup>	350	0.807	0.791	0.0162 <sup>‡</sup>
400	1.22*	1.20	0.0205 <sup>‡</sup>	400	1.08*	1.06	0.0184 <sup>‡</sup>	400	0.976	0.959	0.0166 <sup>‡</sup>	400	0.890	0.875	0.0151 <sup>‡</sup>
500	1.40*	1.38	0.0181 <sup>‡</sup>	500	1.25*	1.23	0.0162 <sup>‡</sup>	500	1.14*	1.13	0.0147 <sup>‡</sup>	500	1.04*	1.03	0.0134 <sup>‡</sup>
600	1.55*	1.53	0.0163 <sup>‡</sup>	600	1.40*	1.39	0.0147 <sup>‡</sup>	600	1.27*	1.26	0.0133 <sup>‡</sup>	600	1.18*	1.17	0.0121 <sup>‡</sup>
700	1.68*	1.67	0.0150 <sup>‡</sup>	700	1.53*	1.52	0.0134 <sup>‡</sup>	700	1.40*	1.39	0.0122 <sup>‡</sup>	700	1.29*	1.28	0.0111 <sup>‡</sup>
800	1.79*	1.78	0.0138 <sup>‡</sup>	800	1.63*	1.62	0.0124 <sup>‡</sup>	800	1.50*	1.49	0.0113 <sup>‡</sup>	800	1.39*	1.38	0.0103 <sup>‡</sup>
900	1.88*	1.87	0.0129 <sup>‡</sup>	900	1.72*	1.71	0.0116 <sup>‡</sup>	900	1.59*	1.58	0.0106 <sup>‡</sup>	900	1.48*	1.47	0.00962 <sup>‡</sup>
1000	1.96*	1.95	0.0122 <sup>‡</sup>	1000	1.80*	1.79	0.0109 <sup>‡</sup>	1000	1.67*	1.66	0.00993 <sup>‡</sup>	1000	1.56*	1.55	0.00906 <sup>‡</sup>
1100	2.03*	2.02	0.0115 <sup>‡</sup>	1100	1.88*	1.87	0.0104 <sup>‡</sup>	1100	1.74*	1.73	0.00939 <sup>‡</sup>	1100	1.63*	1.62	0.00858 <sup>‡</sup>
1265	2.12*			1255	1.97*			1245	1.82*			1236	1.71*		

<sup>†</sup> Uncertainties in the total thermal conductivity, k, are as follows:70.00 Cu - 30.00 Au:  $\pm 10\%$  below 200 K,  $\pm 8\%$  between 200 and 500 K, and  $\pm 10\%$  above 500 K.65.00 Cu - 35.00 Au:  $\pm 10\%$  below 200 K,  $\pm 7\%$  between 200 and 500 K, and  $\pm 10\%$  above 500 K.60.00 Cu - 40.00 Au:  $\pm 10\%$  below 200 K,  $\pm 7\%$  between 200 and 500 K, and  $\pm 10\%$  above 500 K.55.00 Cu - 45.00 Au:  $\pm 10\%$  below 200 K,  $\pm 7\%$  between 200 and 500 K, and  $\pm 10\%$  above 500 K.<sup>‡</sup> Provisional value.<sup>\*</sup> In temperature range where no experimental thermal conductivity data are available.

TABLE 8. RECOMMENDED THERMAL CONDUCTIVITY OF COPPER-GOLD ALLOY SYSTEM (continued)<sup>†</sup>  
 [Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Cu: 50.00% (75.61 At.%) Au: 50.00% (24.39 At.%)				Cu: 45.00% (71.72 At.%) Au: 55.00% (28.28 At.%)				Cu: 40.00% (37.39 At.%) Au: 60.00% (32.61 At.%)				Cu: 35.00% (62.54 At.%) Au: 65.00% (37.46 At.%)			
$\rho_o = 9.34 \mu\Omega \text{ cm}$				$\rho_o = 10.1 \mu\Omega \text{ cm}$				$\rho_o = 10.9 \mu\Omega \text{ cm}$				$\rho_o = 11.4 \mu\Omega \text{ cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.0178	0.0105	0.00725	4	0.0168	0.00964	0.00717	4	0.00898			4	0.00855		
5	0.0277	0.0157	0.0120	6	0.0259	0.0144	0.0115	6	0.0135			6	0.0128		
8	0.0376	0.0209	0.0167	8	0.0350	0.0193	0.0157	8	0.0180			8	0.0171		
10	0.0474	0.0262	0.0212	10	0.0437	0.0241	0.0196	10	0.0224			10	0.0214		
15	0.0694	0.0392	0.0302	15	0.0636	0.0361	0.0275	15	0.0337			15	0.0321		
20	0.0887	0.0523	0.0364	20	0.0811	0.0482	0.0329	20	0.0449			20	0.0427		
25	0.105	0.0649	0.0402	25	0.0961	0.0599	0.0362	25	0.0557			25	0.0532		
30	0.120	0.0777	0.0422	30	0.110	0.0716	0.0379	30	0.0669			30	0.0636		
40	0.145	0.108	0.0421 <sup>‡</sup>	40	0.133	0.0947	0.0380 <sup>‡</sup>	40	0.126*	0.0885		40	0.118*	0.0842	
50	0.166	0.127	0.0394 <sup>‡</sup>	50	0.153	0.117	0.0360 <sup>‡</sup>	50	0.143*	0.110		50	0.135*	0.104	
60	0.187	0.151	0.0362 <sup>‡</sup>	60	0.172	0.139	0.0333 <sup>‡</sup>	60	0.161*	0.130		60	0.152*	0.124	
70	0.207	0.173	0.0337 <sup>‡</sup>	70	0.192	0.161	0.0309 <sup>‡</sup>	70	0.179*	0.150		70	0.169*	0.143	
80	0.228	0.196	0.0316 <sup>‡</sup>	80	0.211	0.182	0.0290 <sup>‡</sup>	80	0.197*	0.170		80	0.187*	0.162	
90	0.250	0.220	0.0299 <sup>‡</sup>	90	0.231	0.204	0.0274 <sup>‡</sup>	90	0.216*	0.191		90	0.204*	0.181	
100	0.271	0.243	0.0284 <sup>‡</sup>	100	0.250	0.224	0.0260 <sup>‡</sup>	100	0.234*	0.210	0.0240 <sup>‡</sup>	100	0.222*	0.200	0.0221 <sup>‡</sup>
150	0.376	0.353	0.0232 <sup>‡</sup>	150	0.348	0.327	0.0212 <sup>‡</sup>	150	0.326*	0.306	0.0196 <sup>‡</sup>	150	0.310*	0.292	0.0180 <sup>‡</sup>
200	0.476	0.456	0.0200 <sup>‡</sup>	200	0.441	0.423	0.0183 <sup>‡</sup>	200	0.413*	0.396	0.0168 <sup>‡</sup>	200	0.394*	0.378	0.0156 <sup>‡</sup>
250	0.570	0.552	0.0178 <sup>‡</sup>	250	0.530	0.514	0.0163 <sup>‡</sup>	250	0.496*	0.481	0.0150 <sup>‡</sup>	250	0.473*	0.459	0.0138 <sup>‡</sup>
273	0.612	0.595	0.0170 <sup>‡</sup>	273	0.569	0.553	0.0156 <sup>‡</sup>	273	0.534	0.520	0.0143 <sup>‡</sup>	273	0.509	0.496	0.0132 <sup>‡</sup>
300	0.660*	0.644	0.0161 <sup>‡</sup>	300	0.614	0.599	0.0148 <sup>‡</sup>	300	0.575	0.561	0.0136 <sup>‡</sup>	300	0.549	0.536	0.0126 <sup>‡</sup>
350	0.743*	0.728	0.0149 <sup>‡</sup>	350	0.692	0.678	0.0136 <sup>‡</sup>	350	0.651	0.638	0.0125 <sup>‡</sup>	350	0.621	0.609	0.0116 <sup>‡</sup>
400	0.823	0.809	0.0138 <sup>‡</sup>	400	0.768	0.755	0.0127 <sup>‡</sup>	400	0.721	0.709	0.0117 <sup>‡</sup>	400	0.688	0.677	0.0108 <sup>‡</sup>
500	0.967	0.955	0.0122 <sup>‡</sup>	500	0.904	0.893	0.0112 <sup>‡</sup>	500	0.850*	0.840	0.0103 <sup>‡</sup>	500	0.812*	0.802	0.00954 <sup>‡</sup>
600	1.09	1.08	0.0110 <sup>‡</sup>	600	1.02	1.01	0.0102 <sup>‡</sup>	600	0.966*	0.957	0.00935 <sup>‡</sup>	600	0.922*	0.913	0.00864 <sup>‡</sup>
700	1.20*	1.20	0.0101 <sup>‡</sup>	700	1.13*	1.12	0.00932 <sup>‡</sup>	700	1.07*	1.06	0.00859 <sup>‡</sup>	700	1.02*	1.01	0.00793 <sup>‡</sup>
800	1.30*	1.29	0.00942 <sup>‡</sup>	800	1.22*	1.21	0.00865 <sup>‡</sup>	800	1.16*	1.15	0.00797 <sup>‡</sup>	800	1.11*	1.10	0.00736 <sup>‡</sup>
900	1.39*	1.38	0.00881 <sup>‡</sup>	900	1.30*	1.29	0.00810 <sup>‡</sup>	900	1.23*	1.22	0.00746 <sup>‡</sup>	900	1.18*	1.17	0.00689 <sup>‡</sup>
1000	1.46*	1.45	0.00829 <sup>‡</sup>	1000	1.38	1.37	0.00763 <sup>‡</sup>	1000	1.30*	1.29	0.00703 <sup>‡</sup>	1000	1.25*	1.24	0.00649 <sup>‡</sup>
1100	1.53*	1.52	0.00786 <sup>‡</sup>	1100	1.44*	1.43	0.00722 <sup>‡</sup>	1100	1.37*	1.36	0.00666 <sup>‡</sup>	1100	1.31*	1.30	0.00615 <sup>‡</sup>
1226	1.62*			1216	1.51*			1206	1.43*	1.42	0.00632 <sup>‡</sup>	1196	1.37*	1.36	0.00587 <sup>‡</sup>

<sup>†</sup> Uncertainties in the total thermal conductivity, k, are as follows:

50.00 Cu - 50.00 Au:  $\pm 10\%$  below 200 K,  $\pm 7\%$  between 200 and 500 K, and  $\pm 10\%$  above 500 K.

45.00 Cu - 55.00 Au:  $\pm 10\%$  below 200 K,  $\pm 8\%$  between 200 and 500 K, and  $\pm 10\%$  above 500 K.

40.00 Cu - 60.00 Au:  $\pm 10\%$  below 200 K,  $\pm 8\%$  between 200 and 500 K, and  $\pm 10\%$  above 500 K.

35.00 Cu - 65.00 Au:  $\pm 10\%$  below 200 K,  $\pm 8\%$  between 200 and 500 K, and  $\pm 10\%$  above 500 K.

<sup>‡</sup> Provisional value.

\* In temperature range where no experimental thermal conductivity data are available.

TABLE 8. RECOMMENDED THERMAL CONDUCTIVITY OF COPPER-GOLD ALLOY SYSTEM (continued)<sup>†</sup>[Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Cu: 30.00% (57.05 At.%) Au: 70.00% (42.95 At.%)				Cu: 25.00% (50.82 At.%) Au: 75.00% (49.18 At.%)				Cu: 20.00% (43.66 At.%) Au: 80.00% (56.34 At.%)				Cu: 15.00% (35.36 At.%) Au: 85.00% (64.63 At.%)			
$\rho_o = 11.8 \mu\Omega \text{ cm}$				$\rho_o = 12.0 \mu\Omega \text{ cm}$				$\rho_o = 11.7 \mu\Omega \text{ cm}$				$\rho_o = 10.8 \mu\Omega \text{ cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.00827			4	0.00818			4	0.00834			4	0.00909		
6	0.0124			6	0.0123			6	0.0125			6	0.0136		
8	0.0165			8	0.0164			8	0.0167			8	0.0182		
10	0.0207			10	0.0204			10	0.0208			10	0.0227		
15	0.0310			15	0.0307			15	0.0313			15	0.0341		
20	0.0413			20	0.0409			20	0.0417			20	0.0454		
25	0.0514			25	0.0508			25	0.0518			25	0.0565		
30	0.0615			30	0.0607			30	0.0620			30	0.0675		
40	0.113*	0.0814		40	0.110	0.0803		40	0.110	0.0820		40	0.115	0.0892	
50	0.129*	0.100		50	0.127	0.0998		50	0.127	0.102		50	0.134	0.110	
60	0.146*	0.120		60	0.143	0.118		60	0.144	0.121		60	0.153	0.131	
70	0.163*	0.139		70	0.159	0.136		70	0.161	0.140		70	0.172	0.152	
80	0.180*	0.157		80	0.176	0.155		80	0.178	0.158		80	0.191	0.172	
90	0.197*	0.175		90	0.193*	0.173		90	0.196*	0.177		90	0.209	0.191	
100	0.214*	0.194	0.0205 <sup>‡</sup>	100	0.209*	0.190	0.0191 <sup>‡</sup>	100	0.213*	0.195	0.0178 <sup>‡</sup>	100	0.228*	0.211	0.0169 <sup>‡</sup>
150	0.299*	0.282	0.0167 <sup>‡</sup>	150	0.294*	0.279	0.0155 <sup>‡</sup>	150	0.299*	0.284	0.0145 <sup>‡</sup>	150	0.321*	0.307	0.0137 <sup>‡</sup>
200	0.381*	0.367	0.0144 <sup>‡</sup>	200	0.375*	0.362	0.0134 <sup>‡</sup>	200	0.381*	0.369	0.0125 <sup>‡</sup>	200	0.409*	0.397	0.0118 <sup>‡</sup>
250	0.458*	0.445	0.0128 <sup>‡</sup>	250	0.452*	0.440	0.0119 <sup>‡</sup>	250	0.459*	0.448	0.0111 <sup>‡</sup>	250	0.492*	0.481	0.0105 <sup>‡</sup>
273	0.492	0.480	0.0122 <sup>‡</sup>	273	0.486	0.475	0.0114 <sup>‡</sup>	273	0.493	0.482	0.0106 <sup>‡</sup>	273	0.529	0.519	0.0100 <sup>‡</sup>
300	0.531*	0.519	0.0116 <sup>‡</sup>	300	0.525*	0.514	0.0108 <sup>‡</sup>	300	0.532*	0.522	0.0101 <sup>‡</sup>	300	0.570	0.560	0.00951 <sup>‡</sup>
350	0.600*	0.589	0.0107 <sup>‡</sup>	350	0.593*	0.583	0.00996 <sup>‡</sup>	350	0.601*	0.582	0.00929 <sup>‡</sup>	350	0.643	0.634	0.00875 <sup>‡</sup>
400	0.666*	0.656	0.00997 <sup>‡</sup>	400	0.658	0.649	0.00926 <sup>‡</sup>	400	0.667	0.658	0.00864 <sup>‡</sup>	400	0.712*	0.704	0.00814 <sup>‡</sup>
500	0.786*	0.777	0.00884 <sup>‡</sup>	500	0.775*	0.767	0.00820 <sup>‡</sup>	500	0.785*	0.777	0.00765 <sup>‡</sup>	500	0.836	0.829	0.00720 <sup>‡</sup>
600	0.893*	0.885	0.00799 <sup>‡</sup>	600	0.881*	0.874	0.00742 <sup>‡</sup>	600	0.892*	0.885	0.00692 <sup>‡</sup>	600	0.947*	0.940	0.00650 <sup>‡</sup>
700	0.990*	0.983	0.00734 <sup>‡</sup>	700	0.975*	0.968	0.00681 <sup>‡</sup>	700	0.988*	0.982	0.00635 <sup>‡</sup>	700	1.04*	1.03	0.00596 <sup>‡</sup>
800	1.08*	1.07	0.00682 <sup>‡</sup>	800	1.06*	1.05	0.00632 <sup>‡</sup>	800	1.07*	1.06	0.00589 <sup>‡</sup>	800	1.13*	1.12	0.00553 <sup>‡</sup>
900	1.15*	1.14	0.00638 <sup>‡</sup>	900	1.13*	1.12	0.00592 <sup>‡</sup>	900	1.14*	1.13	0.00551 <sup>‡</sup>	900	1.20*	1.20	0.00517 <sup>‡</sup>
1000	1.21*	1.20	0.00601 <sup>‡</sup>	1000	1.19*	1.18	0.00558 <sup>‡</sup>	1000	1.21*	1.20	0.00520 <sup>‡</sup>	1000	1.26*	1.26	0.00487 <sup>‡</sup>
1100	1.27*	1.26	0.00570 <sup>‡</sup>	1100	1.25*	1.24	0.00528 <sup>‡</sup>	1100	1.26*	1.25	0.00492 <sup>‡</sup>	1100	1.31*	1.31	0.00461 <sup>‡</sup>
1188	1.32*	1.31	0.00547 <sup>‡</sup>	1184	1.29*	1.28	0.00507 <sup>‡</sup>	1182	1.30*	1.30	0.00473 <sup>‡</sup>	1185	1.35*	1.35	0.00442 <sup>‡</sup>

<sup>†</sup> Uncertainties in the total thermal conductivity, k, are as follows:

30.00 Cu - 70.00 Au: ±10% below 200 K, ±8% between 200 and 500 K, and ±10% above 500 K.

25.00 Cu - 75.00 Au: ±10% below 200 K, ±8% between 200 and 500 K, and ±10% above 500 K.

20.00 Cu - 80.00 Au: ±10% below 200 K, ±8% between 200 and 500 K, and ±10% above 500 K.

15.00 Cu - 85.00 Au: ±10% below 200 K, ±8% between 200 and 500 K, and ±10% above 500 K.

<sup>‡</sup> Provisional value.<sup>\*</sup> In temperature range where no experimental thermal conductivity data are available.

TABLE 8. RECOMMENDED THERMAL CONDUCTIVITY OF COPPER-GOLD ALLOY SYSTEM (continued)<sup>†</sup>[Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Cu: 10.00% (25.62 At.%) Au: 90.00% (74.38 At.%)				Cu: 5.00% (14.03 At.%) Au: 95.00% (85.97 At.%)				Cu: 3.00% (8.75 At.%) Au: 97.00% (91.25 At.%)				Cu: 1.00% (3.04 At.%) Au: 99.00% (96.96 At.%)			
$\rho_o = 8.72 \mu\Omega \text{ cm}$				$\rho_o = 5.27 \mu\Omega \text{ cm}$				$\rho_o = 3.44 \mu\Omega \text{ cm}$				$\rho_o = 1.40 \mu\Omega \text{ cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.0112			4	0.0185			4	0.0284			4	0.0698		
6	0.0168			6	0.0278			6	0.0426			6	0.105		
8	0.0224			8	0.0371			8	0.0568			8	0.140		
10	0.0280			10	0.0464			10	0.0701			10	0.174		
15	0.0420			15	0.0695			15	0.106			15	0.262		
20	0.0560			20	0.0927			20	0.142			20	0.349		
25	0.0696			25	0.114			25	0.174			25	0.420		
30	0.0832			30	0.136			30	0.206			30	0.492		
40	0.135	0.110		40	0.204	0.178		40	0.297	0.267		40	0.663	0.622	
50	0.158	0.135		50	0.242	0.218		50	0.351	0.324		50	0.758	0.721	
60	0.181	0.160		60	0.278	0.256		60	0.403	0.378		60	0.848	0.814	
70	0.205	0.185		70	0.314	0.294		70	0.453	0.430		70	0.932	0.901	
80	0.228	0.210		80	0.350	0.331		80	0.502	0.480		80	1.01	0.981	
90	0.251	0.234		90	0.385	0.367		90	0.549	0.529		90	1.09	1.06	
100	0.274*	0.258	0.0163 <sup>‡</sup>	100	0.420*	0.403	0.0171 <sup>‡</sup>	100	0.597*	0.578	0.0190 <sup>‡</sup>	100	1.17*	1.14	0.0256 <sup>‡</sup>
150	0.385*	0.372	0.0133 <sup>‡</sup>	150	0.584*	0.570	0.0138 <sup>‡</sup>	150	0.812*	0.797	0.0150 <sup>‡</sup>	150	1.47*	1.45	0.0203 <sup>‡</sup>
200	0.489*	0.478	0.0114 <sup>‡</sup>	200	0.731*	0.719	0.0118 <sup>‡</sup>	200	0.993*	0.980	0.0129 <sup>‡</sup>	200	1.69*	1.68	0.0172 <sup>‡</sup>
250	0.585*	0.575	0.0101 <sup>‡</sup>	250	0.862*	0.852	0.0104 <sup>‡</sup>	250	1.15*	1.14	0.0114 <sup>‡</sup>	250	1.86*	1.84	0.0150 <sup>‡</sup>
273	0.627	0.617	0.00964 <sup>‡</sup>	273	0.918	0.908	0.00995 <sup>‡</sup>	273	1.21	1.20	0.0108 <sup>‡</sup>	273	1.92*	1.91	0.0142 <sup>‡</sup>
300	0.675	0.666	0.00915 <sup>‡</sup>	300	0.979	0.970	0.00943 <sup>‡</sup>	300	1.28	1.27	0.0102 <sup>‡</sup>	300	1.98*	1.97	0.0134 <sup>‡</sup>
350	0.757	0.749	0.00841 <sup>‡</sup>	350	1.08	1.07	0.00865 <sup>‡</sup>	350	1.39	1.38	0.00935 <sup>‡</sup>	350	2.08*	2.07	0.0122 <sup>‡</sup>
400	0.834*	0.826	0.00781 <sup>‡</sup>	400	1.17*	1.16	0.00801 <sup>‡</sup>	400	1.49*	1.48	0.00865 <sup>‡</sup>	400	2.16*	2.15	0.0112 <sup>‡</sup>
500	0.967	0.960	0.00690 <sup>‡</sup>	500	1.33*	1.32	0.00704 <sup>‡</sup>	500	1.64*	1.63	0.00758 <sup>‡</sup>	500	2.27*	2.26	0.00974 <sup>‡</sup>
600	1.08*	1.07	0.00622 <sup>‡</sup>	600	1.45*	1.44	0.00633 <sup>‡</sup>	600	1.76*	1.75	0.00679 <sup>‡</sup>	600	2.34*	2.33	0.00864 <sup>‡</sup>
700	1.18*	1.17	0.00570 <sup>‡</sup>	700	1.55*	1.54	0.00578 <sup>‡</sup>	700	1.86*	1.85	0.00618 <sup>‡</sup>	700	2.37*	2.36	0.00780 <sup>‡</sup>
800	1.27*	1.26	0.00528 <sup>‡</sup>	800	1.62*	1.61	0.00534 <sup>‡</sup>	800	1.92*	1.91	0.00569 <sup>‡</sup>	800	2.38*	2.37	0.00712 <sup>‡</sup>
900	1.34*	1.34	0.00493 <sup>‡</sup>	900	1.68*	1.68	0.00498 <sup>‡</sup>	900	1.96*	1.95	0.00529 <sup>‡</sup>	900	2.37*	2.36	0.00657 <sup>‡</sup>
1000	1.39*	1.39	0.00464 <sup>‡</sup>	1000	1.73*	1.73	0.00467 <sup>‡</sup>	1000	1.98*	1.98	0.00495 <sup>‡</sup>	1000	2.34*	2.33	0.00610 <sup>‡</sup>
1100	1.44*	1.44	0.00439 <sup>‡</sup>	1100	1.77*	1.77	0.00441 <sup>‡</sup>	1100	1.99*	1.99	0.00466 <sup>‡</sup>	1100	2.31*	2.30	0.00571 <sup>‡</sup>
1199	1.48*	1.48	0.00417 <sup>‡</sup>	1241	1.81*			1270	1.98*			1296	2.22*		

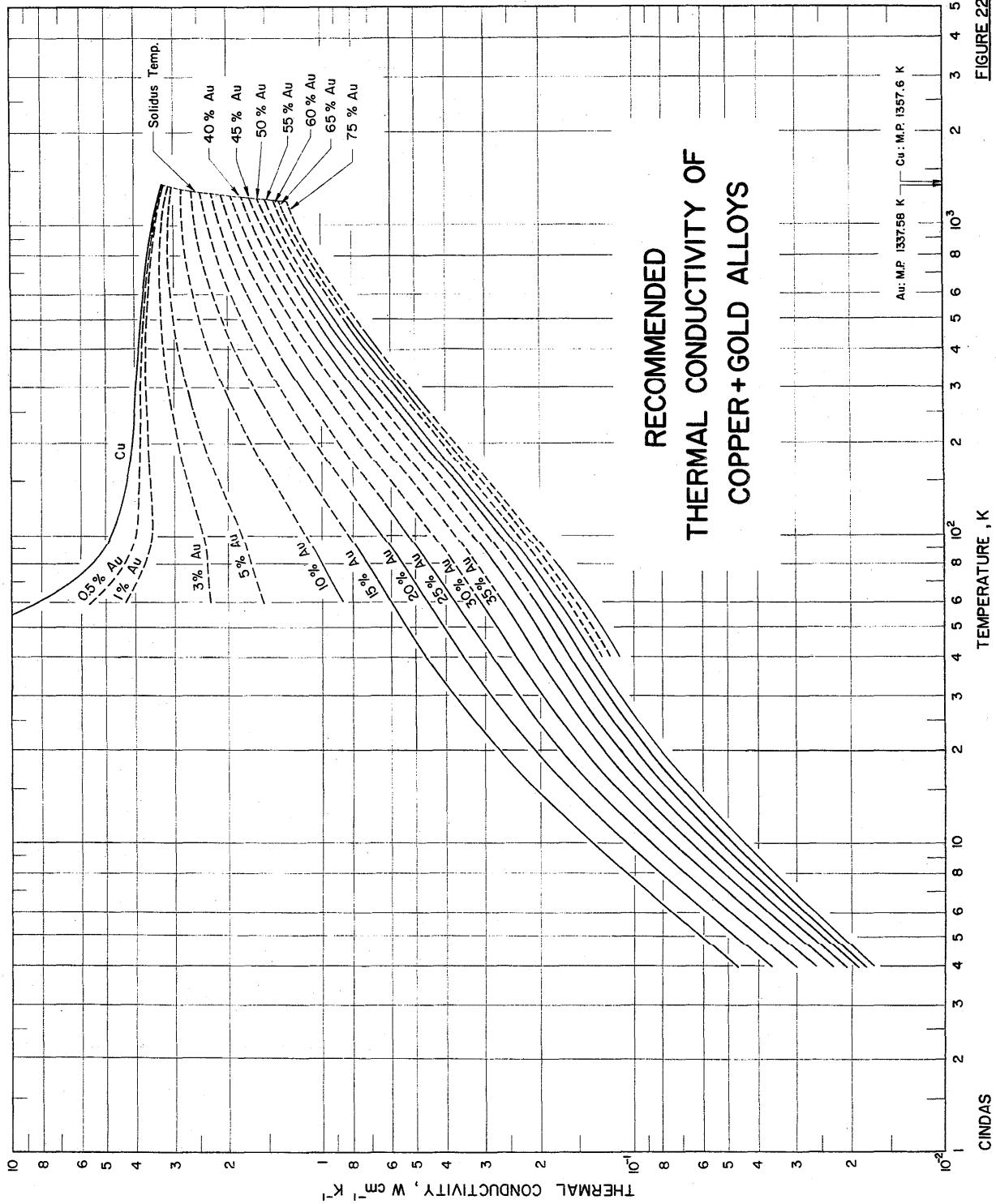
<sup>†</sup> Uncertainties in the total thermal conductivity, k, are as follows:10.00 Cu - 90.00 Au:  $\pm 10\%$  below 200 K,  $\pm 8\%$  between 200 and 500 K, and  $\pm 10\%$  above 500 K.5.00 Cu - 95.00 Au:  $\pm 12\%$  below 200 K,  $\pm 8\%$  between 200 and 500 K, and  $\pm 10\%$  above 500 K.3.00 Cu - 97.00 Au:  $\pm 12\%$  below 200 K,  $\pm 8\%$  between 200 and 500 K, and  $\pm 10\%$  above 500 K.1.00 Cu - 99.00 Au:  $\pm 14\%$  below 200 K and  $\pm 10\%$  above 200 K.<sup>‡</sup> Provisional value.<sup>\*</sup> In temperature range where no experimental thermal conductivity data are available.

TABLE 8. RECOMMENDED THERMAL CONDUCTIVITY OF COPPER-GOLD ALLOY SYSTEM (continued)<sup>†</sup>[Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

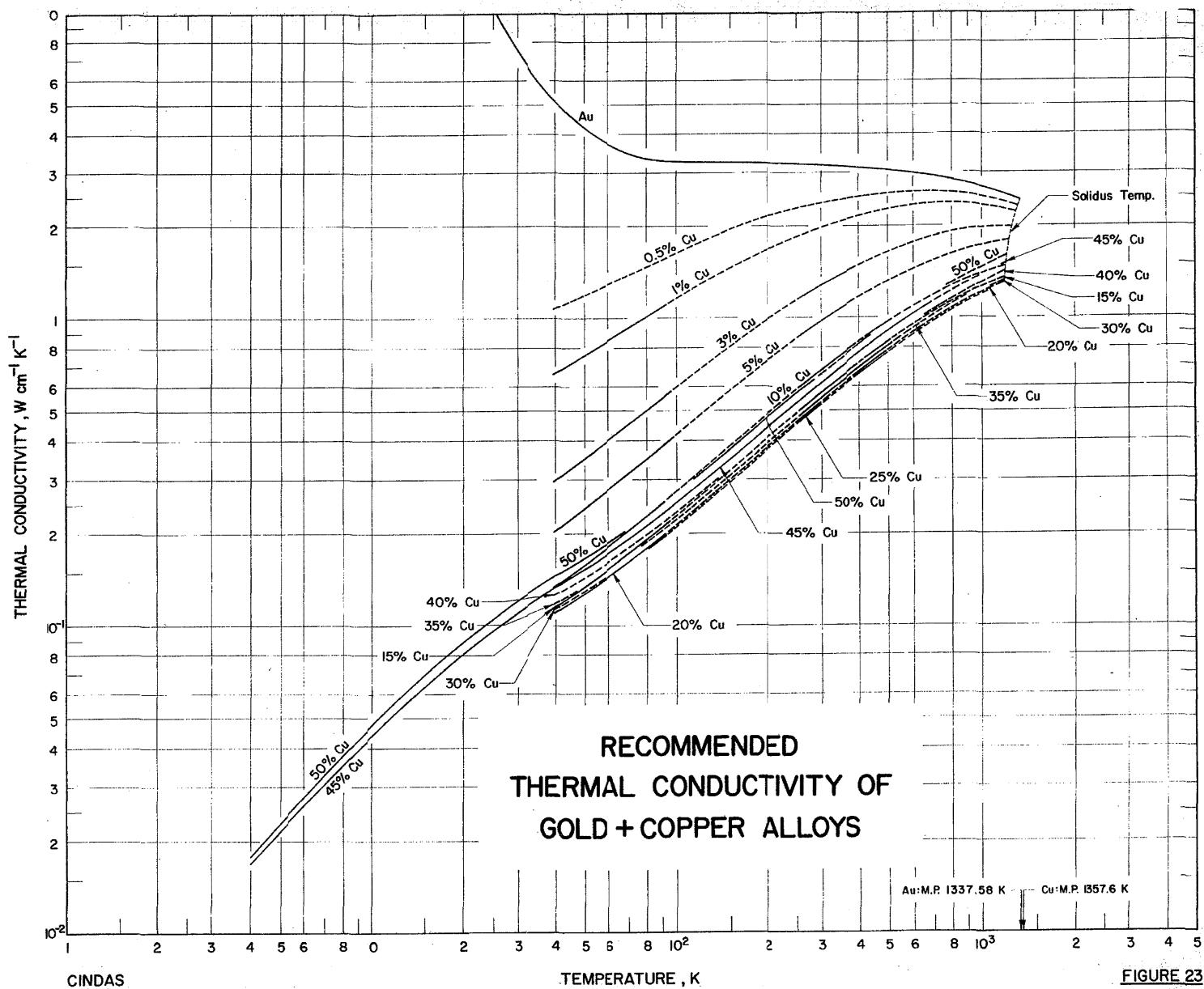
Cu: 0.50% ( 1.53 At.%) Au: 99.50% (98.47 At.%)			
$\rho_0 = 0.770 \mu\Omega \text{ cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>
4		0.127	
6		0.190	
8		0.254	
10		0.317	
15		0.476	
20		0.634	
25		0.740	
30		0.843	
40	1.08*	1.03	
50	1.20*	1.15	
60	1.30*	1.26	
70	1.39*	1.35	
80	1.48*	1.44	
90	1.56*	1.52	
100	1.64*	1.61	0.0329‡
150	1.96*	1.93	0.0257‡
200	2.16*	2.14	0.0213‡
250	2.30*	2.28	0.0185‡
273	2.34*	2.32	0.0175‡
300	2.39*	2.37	0.0164‡
350	2.45*	2.43	0.0148‡
400	2.50*	2.49	0.0136‡
500	2.56*	2.55	0.0116‡
600	2.59*	2.58	0.0102‡
700	2.59*	2.58	0.00914‡
800	2.58*	2.57	0.00828‡
900	2.54*	2.53	0.00757‡
1000	2.50*	2.49	0.00698‡
1200	2.40*	2.39	0.00605‡
1323	2.32*		

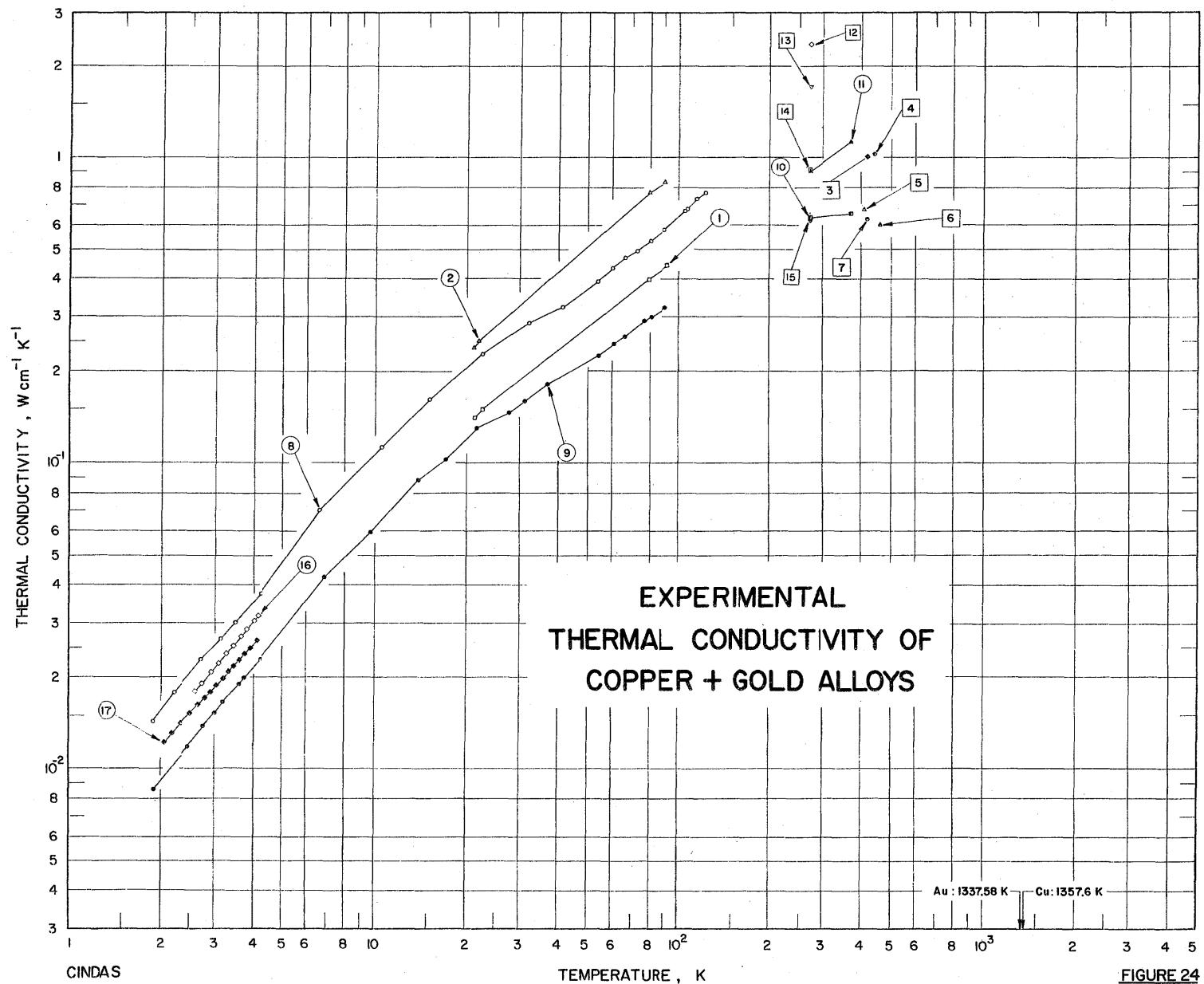
<sup>†</sup> Uncertainties in the total thermal conductivity, k, are as follows:0.50 Cu - 99.50 Au:  $\pm 14\%$  below 200 K and  $\pm 10\%$  above 200 K.<sup>‡</sup> Provisional value.

\* In temperature range where no experimental thermal conductivity data are available.



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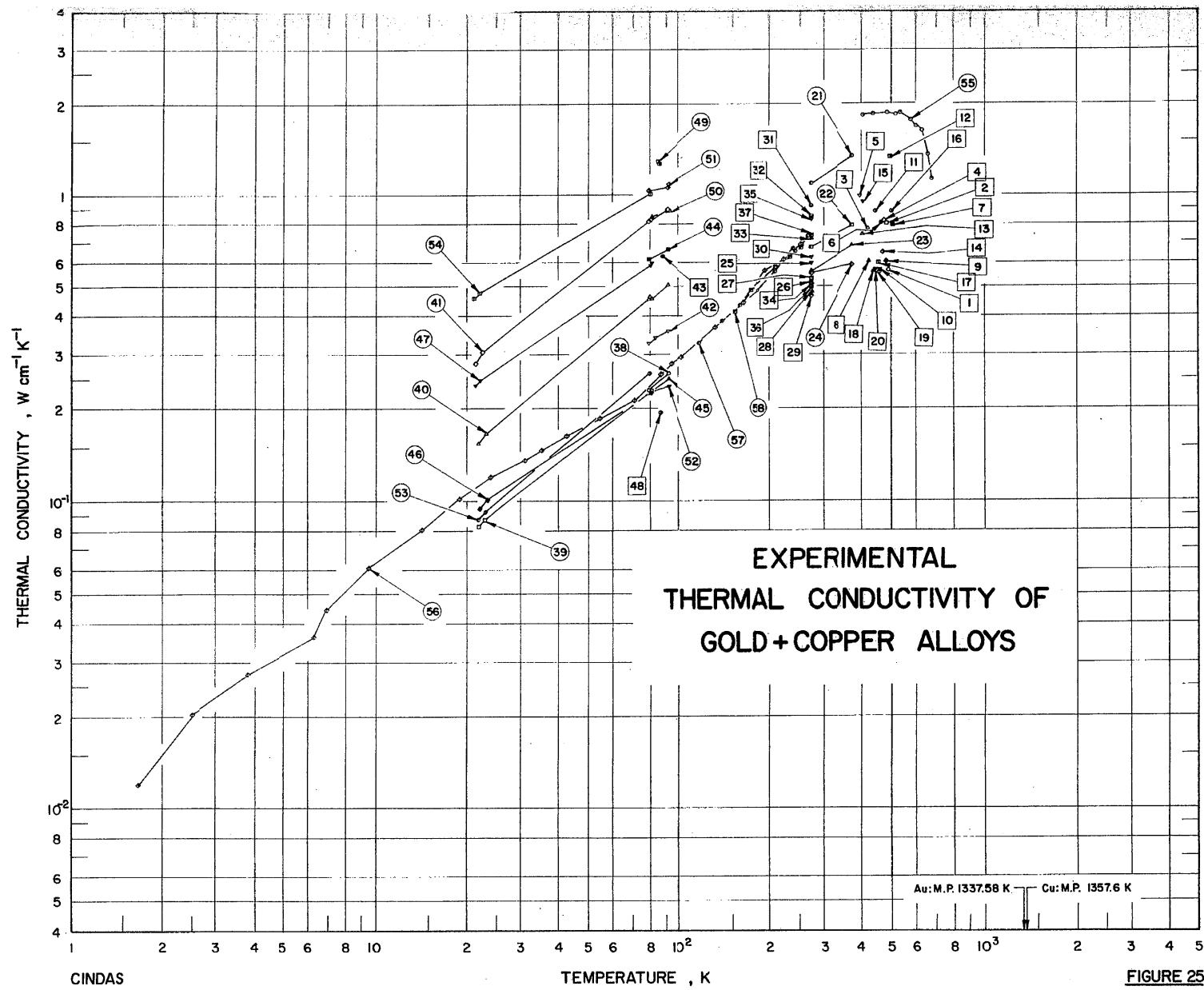


FIGURE 25

TABLE 9. THERMAL CONDUCTIVITY OF COPPER + GOLD ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent) Cu      Au	Composition (continued), Specifications, and Remarks
1	61	Grüneisen, E. and Reddemann, H.	1934	L	21-93	10	75.2      24.8	Calculated composition; polycrystalline; form factor $1.53 \times 10^3$ ; residual electrical resistivity $6.54 \mu\Omega \text{ cm}$ ; electrical resistivity 5.09 and $4.71 \mu\Omega \text{ cm}$ at -190 and -251 C, respectively.
2	61	Grüneisen, E. and Reddemann, H.	1934	L	21-91	9	87.4      12.6	Calculated composition; polycrystalline; form factor $2.61 \times 10^3$ ; residual electrical resistivity $3.83 \mu\Omega \text{ cm}$ ; electrical resistivity 2.487 and $2.172 \mu\Omega \text{ cm}$ at -190 and -251 C, respectively.
3	65	Zolotukhin, G. E.	1957	L	422.7		56.33      43.67	Calculated composition; cylindrical specimen 1.43 cm long and $0.63 \text{ cm}^2$ in cross-section; cast; density $14.30 \text{ g cm}^{-3}$ .
4	65	Zolotukhin, G. E.	1957	L	448.2			The above specimen; annealed for 10 hr.
5	65	Zolotukhin, G. E.	1957	L	411.2			The above specimen; annealed for 20 hr.
6	65	Zolotukhin, G. E.	1957	L	467.2			The above specimen; annealed for 30 hr.
7	65	Zolotukhin, G. E.	1957	L	422.2			The above specimen; annealed for 40 hr.
8	62	Kemp, W.R.G., Klemens, P.G., and Tainsh, R.J.	1957	L	1.9-124		20.09	8 cm long and 0.5 cm in diameter; annealed at 750 C for 1 hr; electrical resistivity reported as 3.53, 3.91, and $5.37 \mu\Omega \text{ cm}$ at 0, 90, and 293 K, respectively.
9	62	Kemp, W.R.G., et al.	1957	L	1.9-91		37.99	Similar to the above specimen except electrical resistivity reported as 7.04, 7.38, and $8.89 \mu\Omega \text{ cm}$ at 0, 90, and 293 K, respectively.
10	63	Sedström, E.	1919	T	273, 373		55.24      44.76	Calculated composition; specimen rolled and drawn to wire 1 mm diameter; heated to near melting point for 0.5 hr; electrical conductivity $5.7 \times 10^4$ and $5.5 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 0 and 100 C, respectively.
11	63	Sedström, E.	1919	T	273, 373		73.52      26.48	Similar to the above specimen except electrical conductivity $10.7 \times 10^4$ and $9.1 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 0 and 100 C, respectively.
12	63	Sedström, E.	1924	T	273.2		94.6      5.4	Calculated composition; specimen rolled and drawn to a wire of 3 cm in length and $1 \text{ mm}^2$ in cross-section, then heated to the melting point; electrical resistivity $8.2 \mu\Omega \text{ cm}$ at 0 C.
13	63	Sedström, E.	1924	T	273.2		87.6      12.4	Similar to the above specimen except electrical resistivity $4.7 \mu\Omega \text{ cm}$ at 0 C.
14	63	Sedström, E.	1924	T	273.2		72.7      27.3	Similar to the above specimen except electrical resistivity $7.3 \mu\Omega \text{ cm}$ at 0 C.
15	63	Sedström, E.	1924	T	273.2		55.0      45.0	Similar to the above specimen except electrical resistivity $10.4 \mu\Omega \text{ cm}$ at 0 C.
16	120	Leaver, A.D.W. and Charsley, P.	1971	L	2.6-4.2	10 Au	25.4	Polycrystalline; obtained from the International Research and Development Co., Ltd.; annealed; residual electrical resistivity $4.386 \mu\Omega \text{ cm}$ .
17	120	Leaver, A.D.W. and Charsley, P.	1971	L	2.1-4.1	10 Au		The above specimen tensile strained 13.4% under a stress of $36.68 \text{ kg mm}^{-2}$ ; residual electrical resistivity $4.444 \mu\Omega \text{ cm}$ .

TABLE 10. THERMAL CONDUCTIVITY OF GOLD + COPPER ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent) Au Cu	Composition (continued), Specifications, and Remarks
1	65	Zolotukhin, G. E.	1957	L	488.7	IV	75.61 24.39	Calculated composition; cast; 1.30 cm long and 0.63 cm <sup>2</sup> in cross-section; density 18.34 g cm <sup>-3</sup> .
2	65	Zolotukhin, G. E.	1957	L	483.2	IV		The above specimen annealed 10 hr at 200 C.
3	65	Zolotukhin, G. E.	1957	L	420.7	IV		The above specimen annealed 20 hr at 200 C.
4	65	Zolotukhin, G. E.	1957	L	473.7	IV		The above specimen annealed 30 hr at 200 C.
5	65	Zolotukhin, G. E.	1957	L	395.2	IV		The above specimen annealed 40 hr at 200 C.
6	65	Zolotukhin, G. E.	1957	L	466.2	V	85.20 14.80	Calculated composition; cast; 1.30 cm long and 0.63 cm <sup>2</sup> in cross-section; density 19.40 g cm <sup>-3</sup> .
7	65	Zolotukhin, G. E.	1957	L	504.7	V		The above specimen annealed 10 hr at 200 C.
8	65	Zolotukhin, G. E.	1957	L	426.2	V		The above specimen annealed 20 hr at 200 C.
9	65	Zolotukhin, G. E.	1957	L	481.7	V		The above specimen annealed 30 hr at 200 C.
10	65	Zolotukhin, G. E.	1957	L	460.7	V		The above specimen annealed 40 hr at 200 C.
11	65	Zolotukhin, G. E.	1957	L	445.7	II	50.82 49.18	Calculated composition; cast; 1.49 cm long and 0.63 cm <sup>2</sup> in cross-section; density 15.05 g cm <sup>-3</sup> .
12	65	Zolotukhin, G. E.	1957	L	493.2	II		The above specimen annealed 10 hr at 200 C.
13	65	Zolotukhin, G. E.	1957	L	401.7	II		The above specimen annealed 20 hr at 200 C.
14	65	Zolotukhin, G. E.	1957	L	470.2	II		The above specimen annealed 30 hr at 200 C.
15	65	Zolotukhin, G. E.	1957	L	403.7	II		The above specimen annealed 40 hr at 200 C.
16	65	Zolotukhin, G. E.	1957	L	497.7	III	62.54 37.46	Calculated composition; cast; 1.45 cm long and 0.63 cm <sup>2</sup> in cross-section; density 16.70 g cm <sup>-3</sup> .
17	65	Zolotukhin, G. E.	1957	L	455.7	III		The above specimen annealed 10 hr at 200 C.
18	65	Zolotukhin, G. E.	1957	L	437.7	III		The above specimen annealed 20 hr at 200 C.
19	65	Zolotukhin, G. E.	1957	L	457.7	III		The above specimen annealed 30 hr at 200 C.
20	65	Zolotukhin, G. E.	1957	L	444.7	III		The above specimen annealed 40 hr at 200 C.
21	63	Sedström, E.	1919	T	273, 373		96.73 3.27	Calculated composition; rolled and drawn to 1 mm diameter wire; annealed close to melting point for 0.5 hr; electrical conductivity 14.3 and 13.4 x 10 <sup>4</sup> Ω <sup>-1</sup> cm <sup>-1</sup> at 0 and 100 C, respectively.
22	63	Sedström, E.	1919	T	273, 373		92.55 7.45	Similar to the above specimen except electrical conductivity 8.5 and 8.2 x 10 <sup>4</sup> Ω <sup>-1</sup> cm <sup>-1</sup> at 0 and 100 C, respectively.
23	63	Sedström, E.	1919	T	273, 373		87.77 12.23	Similar to the above specimen except electrical conductivity 6.3 and 5.9 x 10 <sup>4</sup> Ω <sup>-1</sup> cm <sup>-1</sup> at 0 and 100 C, respectively.
24	63	Sedström, E.	1919	T	273, 373		59.25 40.75	Similar to the above specimen except electrical conductivity 5.0 and 4.6 x 10 <sup>4</sup> Ω <sup>-1</sup> cm <sup>-1</sup> at 0 and 100 C, respectively.
25	64	Sedström, E.	1924	T	273.2		50.8 49.2	Rolled and drawn to 1 mm <sup>2</sup> in cross-sectional area and 3 cm long; annealed close to melting point for 0.5 hr; electrical resistivity 10.8 μΩ cm at 273 K.
26	64	Sedström, E.	1924	T	273.2		54.0 46.0	Similar to the above specimen except electrical resistivity 11.4 μΩ cm at 273 K.

TABLE 10. THERMAL CONDUCTIVITY OF GOLD + COPPER ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION (continued)

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent)		Composition (continued), Specifications, and Remarks
							Au	Cu	
27	64	Sedström, E.	1924	T	273.2		57.0	43.0	Similar to the above specimen except electrical resistivity $11.8 \mu\Omega$ cm at 273 K.
28	64	Sedström, E.	1924	T	273.2		62.6	37.4	Similar to the above specimen except electrical resistivity $13.0 \mu\Omega$ cm at 273 K.
29	64	Sedström, E.	1924	T	273.2		67.2	32.8	Similar to the above specimen except electrical resistivity $13.6 \mu\Omega$ cm at 273 K.
30	64	Sedström, E.	1924	T	273.2		71.9	28.1	Similar to the above specimen except electrical resistivity $10.5 \mu\Omega$ cm at 273 K.
31	64	Sedström, E.	1924	T	273.2		78.1	21.9	Similar to the above specimen except electrical resistivity $7.6 \mu\Omega$ cm at 273 K.
32	64	Sedström, E.	1924	T	273.2		78.2	21.8	Similar to the above specimen except electrical resistivity $7.6 \mu\Omega$ cm at 273 K.
33	64	Sedström, E.	1924	T	273.2		78.9	21.1	Similar to the above specimen except electrical resistivity $8.4 \mu\Omega$ cm at 273 K.
34	64	Sedström, E.	1924	T	273.2		82.1	17.9	Similar to the above specimen except electrical resistivity $11.6 \mu\Omega$ cm at 273 K.
35	64	Sedström, E.	1924	T	273.2		82.4	17.6	Similar to the above specimen except electrical resistivity $11.6 \mu\Omega$ cm at 273 K.
36	64	Sedström, E.	1924	T	273.2		87.5	12.5	Similar to the above specimen except electrical resistivity $11.6 \mu\Omega$ cm at 273 K.
37	64	Sedström, E.	1924	T	273.2		94.1	5.9	Similar to the above specimen except electrical resistivity $8.0 \mu\Omega$ cm at 273 K.
38	61	Grüneisen, E. and Reddemann, H.	1934	L	80, 92	11	89.6	10.4	Calculated composition; polycrystalline; cast; electrical resistivity $9.27 \mu\Omega$ cm at 83 K.
39	61	Grüneisen, E. and Reddemann, H.	1934	L	22-80	11a			The above specimen annealed in vacuo for 40 hr at 365 C; electrical resistivity $10.88 \mu\Omega$ cm at 273 K.
40	61	Grüneisen, E. and Reddemann, H.	1934	L	22-91	12	96.9	3.10	Calculated composition; polycrystalline; cast; electrical resistivity 3.828, 4.345, and $5.94 \mu\Omega$ cm at 22, 83, and 273 K, respectively.
41	61	Grüneisen, E. and Reddemann, H.	1934	L	21-91	13	98.43	1.57	Calculated composition; polycrystalline; cast; electrical resistivity 1.841, 2.353, and $3.93 \mu\Omega$ cm at 22, 83, and 273 K, respectively.
42	61	Grüneisen, E. and Reddemann, H.	1934	L	79-91	14a	50.1	49.9	Calculated composition; polycrystalline; cast; quenched from 800 C; electrical resistivity $6.64 \mu\Omega$ cm at 83 K.
43	61	Grüneisen, E. and Reddemann, H.	1934	L	87.4	14b			The above specimen annealed at $\sim 400$ C for 20 hr; electrical resistivity 3.23 and $5.80 \mu\Omega$ cm at 83 and 273 K, respectively.
44	61	Grüneisen, E. and Reddemann, H.	1934	L	79, 92	14c			The above specimen annealed at $\sim 360$ C for 32 hr; electrical resistivity 3.126 and $5.42 \mu\Omega$ cm at 83 and 273 K, respectively.
45	61	Grüneisen, E. and Reddemann, H.	1934	L	80, 92	14d			The above specimen annealed at $\sim 820$ C for 2 hr and then quenched; electrical resistivity $11.49 \mu\Omega$ cm at 273 K.
46	61	Grüneisen, E. and Reddemann, H.	1934	L	22-80	14e			The above specimen measured after 5 months; electrical resistivity 9.88 and $11.48 \mu\Omega$ cm at 83 and 273 K, respectively.

TABLE 10. THERMAL CONDUCTIVITY OF GOLD + COPPER ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION (continued)

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent) Au Cu	Composition (continued), Specifications, and Remarks
47	61	Grüneisen, E. and Reddemann, H.	1934	L	21-81	14f		The above specimen annealed at ~325 C for 30 hr; electrical resistivity 2.70 and 3.41 $\mu\Omega$ cm at 22 and 83 K, respectively.
48	61	Grüneisen, E. and Reddemann, H.	1934	L	86.9	15a	75.6 24.4	Calculated composition; polycrystalline; cast; quenched from 800 C; electrical resistivity 11.57, 13.2, and 13.41 $\mu\Omega$ cm at 83, 273, and 292 K, respectively.
49	61	Grüneisen, E. and Reddemann, H.	1934	L	85, 85	15b		The above specimen annealed at 360 C for 22 hr; electrical resistivity 1.753, 3.974, and 4.82 $\mu\Omega$ cm at 83, 273, and 293 K, respectively.
50	61	Grüneisen, E. and Reddemann, H.	1934	L	81, 92	15c		The above specimen annealed at 345 C for 30 hr; electrical resistivity 2.228 and 4.48 $\mu\Omega$ cm at 83 and 273 K, respectively.
51	61	Grüneisen, E. and Reddemann, H.	1934	L	79-91	15d		The above specimen annealed at 325 C for 30 hr; electrical resistivity 1.797 and 4.07 $\mu\Omega$ cm at 83 and 273 K, respectively.
52	61	Grüneisen, E. and Reddemann, H.	1934	L	79, 91	15e		The above specimen annealed at 800 C for 2 hr and then quenched; electrica resistivity 9.17 $\mu\Omega$ cm at 83 K.
53	61	Grüneisen, E. and Reddemann, H.	1934	L	22-79	15f		The above specimen measured after 4 months; electrical resistivity 7.90 $\mu\Omega$ cm at 83 K.
54	61	Grüneisen, E. and Reddemann, H.	1934	L	21-80	15g		The above specimen annealed at ~325 C for 30 hr; electrical resistivity 1.826 and 4.09 $\mu\Omega$ cm at 83 and 273 K, respectively.
55	126, 174, 175	Lindenbaum, S. D. and Quimby, S. L.	1962	L	407-680	Cu <sub>3</sub> Au	49.18	Intermetallic compound; 0.1858 in. diameter and 2.41 in. long; success- ively annealed at 360 C for 90 hr, 240 C for 110 hr, and 220 C for 600 hr; critical temperature lies between 387.5 and 358.2 C; electrical resistivity reported as 4.2582, 4.3864, 4.8367, 5.2834, 5.6889, 6.2509, 6.6710, 7.2382, 8.2142, 9.3038, 10.6252, 10.8993, 11.3171, 12.1981, 13.6671, 14.0257, 14.0355, 14.0752, 14.1084, and 14.2959 $\mu\Omega$ cm at 33.30, 43.74, 83.38, 124.04, 160.92, 211.71, 248.80, 278.71, 311.98, 345.78, 373.61, 377.93, 382.60, 385.60, 387.54, 388.19, 390.97, 395.25, 404.20, and 419.77 C, respectively (selected from 76 points reported by the authors).
56	66	Goff, J. F., Verhalis, A. C., Rhyne, J. J., and Klemens, P. G.	1968	L	1.7-275	Cu <sub>3</sub> Au	49.18	0.1 Fe; intermetallic compound; specimen 60 mm x 3.2 mm x 3.2 mm; prepared from ASARCO five-9 Cu and Au material; the melt was first homogenized by rocking for about 10 min then cast in a constricted end of the same tube; annealed for 2 hr at 850 C and quenched from 700 C by breaking the capsule in water (all melting and annealing the specimen and specimen materials were done in quartz tubes had been evacuated to less than $10^{-6}$ torr at close-off); residual electrical resistiv- ity 0.092 $\mu\Omega$ cm; electrical resistivity ratio $\rho(300K)/\rho(4.2K) = 1.23$ ; electrical resistivity reported as 9.1, 9.1, 9.2, 9.3, 9.3, 9.2, 9.4, 9.4, 9.5, 9.7, 9.8, 9.9, 10.2, 10.5, 10.8, 11.0, 10.9, and 11.3 $\mu\Omega$ cm at 1.8, 5.6, 13.0, 16.4, 19.6, 30.0, 41.3, 63.2, 86.6, 101, 114, 131, 163, 191, 227, 254, 261, and 299 K respectively.

TABLE 10. THERMAL CONDUCTIVITY OF GOLD + COPPER ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION (continued)

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent) Au Cu	Composition (continued), Specifications, and Remarks
57	66	Goff, J. F., Verbalis, A. C., Rhyne, J. J., and Klemens, P. G.	1968	L	117-269	Cu <sub>3</sub> Au	49.18	Intermetallic compound; similar to the above except electrical resistivity reported as 9.7, 9.9, 10.1, 10.3, 10.4, 10.6, 10.8, 10.7, 10.9, and 11.3 $\mu\Omega$ cm at 88, 115, 148, 159, 180, 194, 224, 232, 247, and 293 K, respectively; measurement was made with an insulating packing inside the radiation shield.
58	66	Goff, J. F., et al.	1968	L	154-276	Cu <sub>3</sub> Au	49.18	Similar to the above except electrical resistivity reported as 9.1, 9.9, 9.8, 9.9, 10.1, 10.5, 11.0, 10.7, 10.9, 11.0, and 11.4 $\mu\Omega$ cm at 9.0, 112, 129, 143, 171, 211, 235, 240, 260, 265, and 287 K, respectively; measurement was made in the original condition but with a measured radiation loss correction.

#### 4.4. Copper-Nickel Alloy System

The copper-nickel alloy system forms a continuous series of solid solutions and is free of all transformations except that of ferromagnetism. As shown in figure 2, the electrical resistivity versus temperature curves for Ni+Cu alloys change slope abruptly at the Curie temperature of the alloys. The Curie temperature decreases as the concentration of copper in the alloys increases. The ferromagnetism disappears and the Curie temperature drops to zero as the concentration of copper reaches 61.88% (60 At. %).

Mott [3] has given an explanation of the ferromagnetic behavior of these alloys based on the filling of holes in the *d* and of nickel by the *s* electrons of copper. The *d*-shell in a copper atom is completely occupied and there is a single *s* electron outside, whereas the  $3d^{\frac{1}{2}}$  band of a nickel atom is full but there are 0.54 holes in the  $3d^{\frac{1}{2}}$  band; these *d*-band holes are the elementary magnets in nickel. The Curie temperature is proportional to the number of elementary magnets per unit volume, which in nickel is thus 0.54 times the number of atoms per unit volume. The density of states in the *d* band of the nickel atom at the Fermi surface is approximately ten times greater than the density of states in the *s* band, so that as copper is added to nickel about 96 percent of the extra *s* electrons go to fill up the *d* band, and thus decrease the number of elementary magnets per unit volume, until at 60

% Cu the *d* band of nickel is full, at which point the ferromagnetism disappears and the Curie temperature drops to 0 K. The insert in figure 2 shows the Curie temperature as a function of percent copper in nickel, which is linear for the atomic percent of copper. This straight-line relationship was determined from the electrical resistivity data shown in figure 2. The behavior of the electrical resistivity of these alloys has a direct bearing on the behavior of the thermal conductivity (see figure 29), and therefore the knowledge of the former is prerequisite to the understanding of the latter.

There are 153 sets of experimental data available for the thermal conductivity of this alloy system. However, of the 104 data sets available for Cu+Al alloys listed in table 12 and shown in figure 30, 27 sets are merely single data points and 5 sets cover only a narrow temperature range from around room temperature to about 500 K. Of the 49 data sets for Ni+Cu alloys listed in table 13 and shown in figure 31, 23 sets are single data points. Furthermore, many sets of data show large discrepancies.

For the Cu+Ni alloys, the most reliable measurements at room temperature were made by Smith and Palmer [49] (Cu+Ni curves 1-7), surprisingly in 1935, for a set of well-annealed alloys. Electrical resistivity data were also reported for the same specimens used for the thermal conductivity measurements. These provided the basis for the easy separation of the lattice component from the measured thermal conductivity.

Hulm [69] measured the thermal conductivity of an alloy with 20% Ni below 25 K (Cu+Ni curve 15). Berman [70] measured thermal conductivity of a sample of Constantan (40% Ni) below 100 K (Cu+Ni curve 21). Wilkinson and Wilks [71] measured the thermal conductivity of an alloy with 30% Ni below 20 K (Cu+Ni curve 14). These three sets of low-

temperature data appear to be reliable and consistent in view of the cold-work condition of the 30% Ni specimen of Wilkinson and Wilks (curve 14).

In the temperature range below 70 K, Erdmann and Jahoda have measured the thermal conductivity of the Cu-Ni alloy system several times [72-74] (Cu+Ni curves 52-55, 62-66, 68, and 84; Ni+Cu curves 13-19 and 21-23). One set of their measurements [74] (Cu+Ni curves 52-55 and Ni+Cu curves 13-19) is the only one that covers a wide range of composition at low temperature. However, it was very difficult to evaluate the reliability of their results. For copper-rich alloys, the lattice thermal conductivities derived from their measured total thermal conductivities are about 40% higher than those derived from other authors' results. Since their samples seemed to be the best annealed (at 930° C) among the alloy samples, it had been thought that the lattice thermal conductivities of their samples might be higher than those of the others because annealing could eliminate dislocations. However, after the effect of annealing on the electrical resistivity and lattice thermal conductivity of binary alloys had been reviewed carefully, it was concluded that the differences are too large to be accounted for by annealing. Furthermore, around liquid helium temperature, the difference between the lattice thermal conductivities of their own dilute and concentrated alloys are too large compared with those of other measurements. If their measured total thermal conductivities are connected to the total thermal conductivities above 300 K measured by other authors, the slopes of the conductivity-temperature curves become negative between 100 and 300 K for concentrated alloys. This seems unlikely for it does not occur in the conductivity-temperature curves of the analogous silver-palladium alloys. Recent private communication from Klemens [76] provided useful thermal conductivity data for a copper alloy with 4 At.% Ni at temperatures below 40 K (Cu+Ni curve 103). The sample was annealed at 1075° C for 72 hours and slowly cooled. The results also indicate that the lattice thermal conductivities of Erdmann and Jahoda are too high at temperatures above that of the maximum of the lattice component although they are in agreement with the results of others at lower temperatures. Consequently, the results of Erdmann and Jahoda were not used in the present data synthesis at temperatures above that of the lattice component maximum.

For Ni+Cu alloys, Sager [77] (Ni+Cu curves 1 and 2), Smith [45] (Ni+Cu curves 3-6), and Sedström [63] (Ni+Cu curves 7 and 8) have measured the thermal conductivity around room temperature. There is some doubt about the reported compositions of their specimens as the electrical resistivity data reported for the same specimens differ from those obtained by other authors for alloys with the same nominal compositions.

Greig and Harrison [78] measured the thermal conductivities of nickel alloys with 0.32, 0.6, 1.5, and 4.2 At.% Cu below 100 K (Ni+Cu curves 9-12). More recently Farrell and Greig [79] studied the electrical resistivity and thermal conductivity of a nickel alloy with 0.31 At.% Cu below 100 K (Ni+Cu curve 34). They concluded that the lattice thermal conductivity of pure nickel is quite high and close to those of dilute copper alloys.

Chari [80] has suggested a method to separate the lattice thermal conductivity from total thermal conductivity of pure nickel and dilute nickel-rhenium alloys above 400 K. There is, however, doubt concerning his method of graphical separation of electrical resistivity into the intrinsic and magnetic components, because the anomaly of the temperature dependence of the electrical resistivity of the ferromagnetic metals can be explained by the ferromagnetic ordering of metals below the Curie point. Many authors have tried to express the resistivities of the ferromagnetic alloys in the form of  $\rho = \rho^* (1 + \mu)$ , where  $\mu$ , the ferromagnetic ordering parameter, is negative and vanishes above the Curie point [167], and  $\rho^*$  represents the resistivity of ferromagnetic metal in the absence of ferromagnetic ordering. In other words,  $\rho^*$  represents the resistivity of the "normal" non-ferromagnetic metal. Farrell and Greig [81] indicated that deviations from Matthiessen's rule due to spin mixing must be taken into account when analyzing the electronic transport properties of nickel alloys.

In the present data synthesis, the electronic thermal conductivities of the alloys were calculated directly from eq (12) using the recommended electrical resistivity values from ref. [7] and the recommended thermoelectric power values from ref. [40]. This analysis does not include spin-disorder scattering in agreement with the treatment by Coles [189]. For those alloys for which both the thermal conductivity and electrical resistivity had been measured the electronic thermal conductivities were also calculated from eq (12) in order to separate the lattice component from the measured total thermal conductivity. The resulting "experimental" lattice thermal conductivity data at low temperatures were used directly to generate the low-temperature lattice conductivity values, and those at moderate and high temperatures were used for the adjustment of the lattice thermal conductivities of the virtual crystals so that the calculated lattice conductivities are in agreement with the experimental data.

At moderate and high temperatures, lattice conductivities were calculated from eq (35). As stated previously in section 2.2, experimental data for  $k_u$ , which are necessary as input for eq (35), are available for copper but not for nickel. For copper, White [91] reported an experimental value for  $k_u T$  at temperatures above 60 K as  $35.0 \text{ W cm}^{-1}$  and this value was used in eq (35) for the calculations. The value of  $k_u T$  for nickel estimated from the modified Leibfried-Schlömann equation (37) varies considerably depending upon the selected value of the Debye temperature used in the calculation, and the initial estimates of the value of  $k_u T$  range from 21 to  $31 \text{ W cm}^{-1}$ . A final value of  $30.8 \text{ W cm}^{-1}$  was determined by using the various values for the calculations of the lattice conductivities and comparing the calculated values with the experi-

mental data as shown in figure 6 and discussed previously in section 3. From the two  $k_u T$  values for copper and nickel the  $k_u$  values of the virtual crystals were estimated and used in eq (35) to generate lattice conductivities for all the alloys at temperatures above the region of the maximum in  $k_g$ .

A graphical comparison of the recommended total thermal conductivity values with selected experimental data is given in figures 26 and 27. The smooth solid curves in these figures were obtained by interpolating the recommended values of table 11 in order to obtain thermal conductivities for the desired alloy compositions. For copper-rich alloys shown in figure 26, the recommended values are in agreement with the data of Smith and Palmer [49] (Cu+Ni curves 1-7), of Bouley et al. [76] (Cu+Ni curve 103), of Zimmerman [130] (Cu+Ni curves 17 and 20), and of Willett [146] (Cu+Ni curve 99) to within 5%, and with the data of Kierspe [83] (Cu+Ni curve 67), of Berman [70] (Cu+Ni curve 21), and with some of the data of Mikryukov [144] (Cu+Ni curves 44 and 72) to within 12%. For nickel-rich alloys shown in figure 27, at high temperatures the recommended values agree with the data of Smith [45] (Ni+Cu curves 3-6) and of Jackson and Saunders [147] (Ni+Cu curve 20) to within 12%. At low temperatures there is conflict between different sets of experimental data and the agreement of the recommendations with the data is less satisfactory. The large difference between the data of Erdmann and Jahoda [74] (Ni+Cu curve 19) and those of Greig and Harrison [78] (Ni+Cu curve 9) for an alloy of the same composition, for example, illustrates the large discrepancies in the results of different investigators. For alloys with about 4% copper, the data of Erdmann and Jahoda [74] (Ni+Cu curve 18) and of Greig and Harrison [78] (Ni+Cu curve 11) both agree with the recommendations to within 10%, but at other solute concentrations, the recommendations receive little direct experimental support. The thermal conductivity values in this range are consequently provisional.

The resulting recommended values for  $k$ ,  $k_e$ , and  $k_g$  are tabulated in table 11 for 25 alloy compositions covering the temperatures from 4 to 1200 K. These values are for alloys which have not been severely cold worked or quenched. The values for  $k$  are also presented in figures 28 and 29. The values of residual electrical resistivity for the alloys are also given in table 11. The uncertainties of the thermal conductivity values are stated in a footnote to table 11, while the uncertainties of the  $k_e$  and  $k_g$  values are indicated by their being designated as recommended, provisional, or typical values. The ranges of uncertainties of recommended, provisional, and typical values are less than  $\pm 15\%$ , between  $\pm 15$  and  $\pm 30\%$ , and greater than  $\pm 30\%$ , respectively.

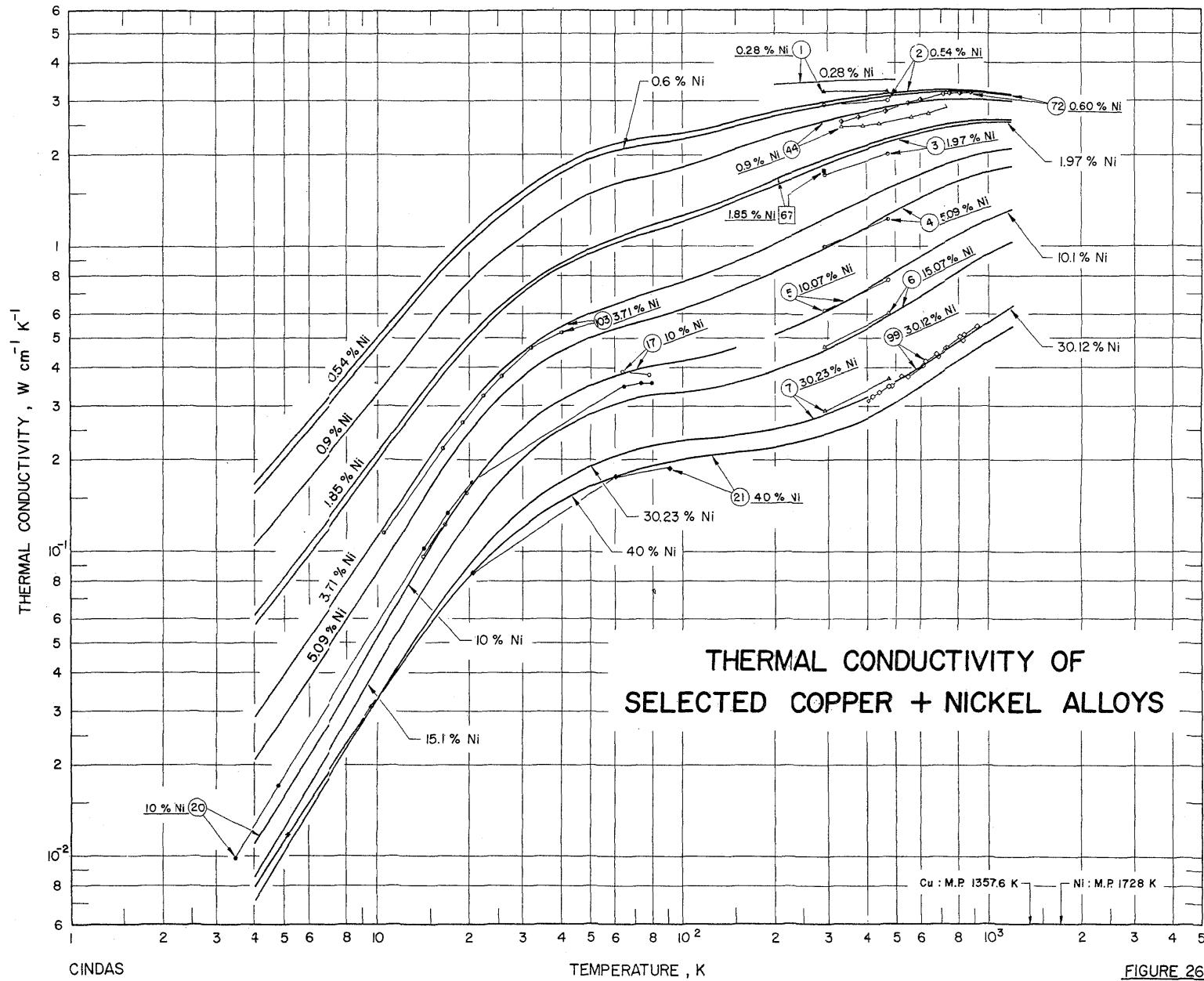


FIGURE 26

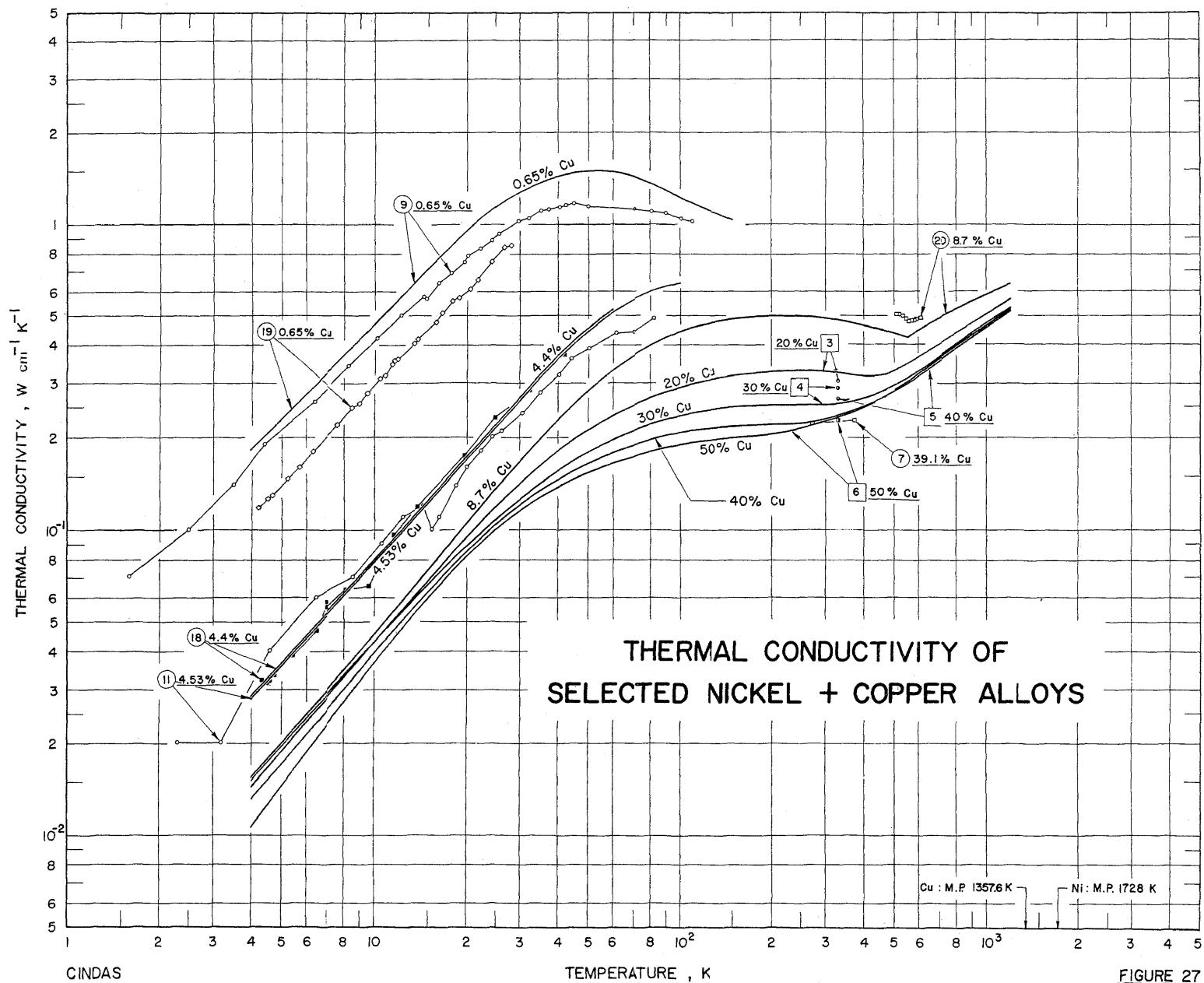


TABLE 11. RECOMMENDED THERMAL CONDUCTIVITY OF COPPER-NICKEL ALLOY SYSTEM<sup>†</sup>[Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Cu: 99.50% (99.46 At.%) Ni: 0.50% ( 0.54 At.%)				Cu: 99.00% (98.92 At.%) Ni: 1.00% ( 1.08 At.%)				Cu: 97.00% (96.76 At.%) Ni: 3.00% ( 3.24 At.%)				Cu: 95.00% (94.61 At.%) Ni: 5.00% ( 5.39 At.%)			
$\rho_o = 0.620 \mu\Omega \text{cm}$				$\rho_o = 1.25 \mu\Omega \text{cm}$				$\rho_o = 3.70 \mu\Omega \text{cm}$				$\rho_o = 6.10 \mu\Omega \text{cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.176*	0.158	0.0185‡	4	0.0917	0.0782	0.0135‡	4	0.0347	0.0264	0.00830	4	0.0215	0.0160	0.00550
6	0.281*	0.236	0.0450‡	6	0.150	0.117	0.0335‡	6	0.0611	0.0396	0.0215	6	0.0391	0.0240	0.0151
8	0.399*	0.315	0.0840‡	8	0.218	0.156	0.0625‡	8	0.0936	0.0528	0.0408	8	0.0616	0.0320	0.0296
10	0.525*	0.394	0.131‡	10	0.295	0.195	0.100‡	10	0.132	0.0660	0.0655	10	0.0890	0.0400	0.0490
15	0.846*	0.591	0.255‡	15	0.496	0.293	0.203‡	15	0.234	0.0990	0.135	15	0.166	0.0601	0.106
20	1.14*	0.788	0.355‡	20	0.684	0.391	0.293‡	20	0.340	0.132	0.208	20	0.250	0.0801	0.170
25	1.38*	0.945	0.430‡	25	0.840	0.482	0.358‡	25	0.428	0.164	0.264	25	0.321	0.0999	0.221
30	1.59*	1.11	0.480‡	30	0.978	0.573	0.405‡	30	0.498	0.196	0.302	30	0.379	0.120	0.259
40	1.92*	1.39	0.535‡	40	1.20	0.743	0.460‡	40	0.599	0.258	0.341	40	0.458	0.158	0.300
50	2.14*	1.60	0.545‡	50	1.36	0.889	0.470‡	50	0.666	0.315	0.351	50	0.509	0.195	0.314
60	2.26*	1.73	0.535‡	60	1.46	1.00	0.465‡	60	0.715	0.366	0.349	60	0.544	0.231	0.313
70	2.32*	1.82	0.500‡	70	1.54	1.10	0.445‡	70	0.755	0.414	0.341	70	0.571	0.264	0.307
80	2.36*	1.89	0.465	80	1.61	1.19	0.420	80	0.790	0.459	0.331	80	0.593	0.296	0.297
90	2.39*	1.96	0.430	90	1.66*	1.27	0.395	90	0.823*	0.504	0.319	90	0.615*	0.328	0.287
100	2.43*	2.03	0.400	100	1.72*	1.35	0.370	100	0.854*	0.548	0.306	100	0.634*	0.358	0.276
150	2.64*	2.35	0.293	150	1.98*	1.70	0.281	150	1.01*	0.759	0.248	150	0.731*	0.505	0.226
200	2.82*	2.58	0.234	200	2.20*	1.97	0.227	200	1.15*	0.947	0.204	200	0.828*	0.640	0.188
250	2.93*	2.74	0.194	250	2.36*	2.17	0.189	250	1.29*	1.11	0.172	250	0.922*	0.761	0.160
273	2.97	2.79	0.179	273	2.41*	2.24	0.175	273	1.34*	1.18	0.161	273	0.963*	0.813	0.150
300	3.04	2.87	0.164	300	2.49	2.32	0.161	300	1.41	1.26	0.149	300	1.01	0.872	0.140
350	3.10	2.96	0.143	350	2.59	2.45	0.140	350	1.51	1.38	0.131	350	1.09	0.972	0.123
400	3.16	3.04	0.126	400	2.68	2.56	0.124	400	1.61	1.49	0.116	400	1.17	1.06	0.110
500	3.24*	3.13	0.102	500	2.80	2.70	0.100	500	1.77*	1.67	0.0953	500	1.32	1.23	0.0911
600	3.26*	3.18	0.0853	600	2.90	2.81	0.0843	600	1.90*	1.82	0.0807	600	1.45	1.37	0.0776
700	3.29*	3.21	0.0734	700	2.96	2.89	0.0727	700	2.01*	1.94	0.0699	700	1.56	1.49	0.0675
800	3.27*	3.21	0.0644	800	2.98	2.92	0.0638	800	2.08*	2.02	0.0617	800	1.65	1.59	0.0598
900	3.26*	3.20	0.0574	900	2.98	2.92	0.0569	900	2.14*	2.09	0.0552	900	1.72	1.66	0.0536
1000	3.22*	3.17	0.0517	1000	2.96	2.91	0.0513	1000	2.18*	2.13	0.0499	1000	1.77	1.72	0.0486
1100	3.20*	3.16	0.0471	1100	2.96*	2.91	0.0468	1100	2.22*	2.17	0.0455	1100	1.82	1.78	0.0445
1200	3.16*	3.12	0.0432	1200	2.94*	2.89	0.0429	1200	2.23*	2.19	0.0419	1200	1.86	1.82	0.0410

† Uncertainties in the total thermal conductivity, k, are as follows:

99.50 Cu - 0.50 Ni:  $\pm 10\%$  below 200 K and  $\pm 5\%$  above 200 K.99.00 Cu - 1.00 Ni:  $\pm 10\%$  below 200 K and  $\pm 5\%$  above 200 K.97.00 Cu - 3.00 Ni:  $\pm 5\%$ .95.00 Cu - 5.00 Ni:  $\pm 5\%$ .

\* Provisional value.

‡ Typical value.

\* In temperature range where no experimental thermal conductivity data are available.

TABLE 11. RECOMMENDED THERMAL CONDUCTIVITY OF COPPER-NICKEL ALLOY SYSTEM (continued)<sup>†</sup>  
 [Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Cu: 90.00% (89.27 At.%) Ni: 10.00% (10.73 At.%)				Cu: 85.00% (83.96 At.%) Ni: 15.00% (16.04 At.%)				Cu: 80.00% (78.71 At.%) Ni: 20.00% (21.29 At.%)				Cu: 75.00% (73.49 At.%) Ni: 25.00% (26.51 At.%)			
$\rho_o = 12.15 \mu\Omega \text{ cm}$				$\rho_o = 17.95 \mu\Omega \text{ cm}$				$\rho_o = 23.70 \mu\Omega \text{ cm}$				$\rho_o = 29.30 \mu\Omega \text{ cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.0112	0.00804	0.00315	4	0.00869*	0.00544	0.00325 <sup>‡</sup>	4	0.00762 <sup>‡</sup>	0.00412	0.00350 <sup>‡</sup>	4	0.00724 <sup>‡</sup>	0.00334	0.00390 <sup>‡</sup>
6	0.0216	0.0121	0.00950	6	0.0170** <sup>‡</sup>	0.00817	0.00890 <sup>‡</sup>	6	0.0153 <sup>‡</sup>	0.00619	0.00910 <sup>‡</sup>	6	0.0143 <sup>‡</sup>	0.00500	0.00930 <sup>‡</sup>
8	0.0358	0.0161	0.0197	8	0.0283** <sup>‡</sup>	0.0109	0.0175 <sup>‡</sup>	8	0.0253 <sup>‡</sup>	0.00825	0.0170 <sup>‡</sup>	8	0.0234 <sup>‡</sup>	0.00667	0.0167 <sup>‡</sup>
10	0.0536	0.0201	0.0335	10	0.0426** <sup>‡</sup>	0.0136	0.0290 <sup>‡</sup>	10	0.0373 <sup>‡</sup>	0.0103	0.0270 <sup>‡</sup>	10	0.0343 <sup>‡</sup>	0.00834	0.0260 <sup>‡</sup>
15	0.106	0.0302	0.0760	15	0.0839** <sup>‡</sup>	0.0204	0.0635 <sup>‡</sup>	15	0.0725 <sup>‡</sup>	0.0155	0.0570 <sup>‡</sup>	15	0.0660** <sup>‡</sup>	0.0125	0.0535 <sup>‡</sup>
20	0.164	0.0402	0.124	20	0.128** <sup>‡</sup>	0.0272	0.101 <sup>‡</sup>	20	0.111 <sup>‡</sup>	0.0206	0.0900 <sup>‡</sup>	20	0.100** <sup>‡</sup>	0.0167	0.0835 <sup>‡</sup>
25	0.215	0.0502	0.165	25	0.169** <sup>‡</sup>	0.0339	0.135 <sup>‡</sup>	25	0.144 <sup>‡</sup>	0.0257	0.118 <sup>‡</sup>	25	0.125** <sup>‡</sup>	0.0209	0.108 <sup>‡</sup>
30	0.256	0.0601	0.196	30	0.202** <sup>‡</sup>	0.0407	0.161 <sup>‡</sup>	30	0.172 <sup>‡</sup>	0.0309	0.141 <sup>‡</sup>	30	0.152** <sup>‡</sup>	0.0251	0.127 <sup>‡</sup>
40	0.316	0.0799	0.236	40	0.252** <sup>‡</sup>	0.0541	0.198 <sup>‡</sup>	40	0.215 <sup>‡</sup>	0.0411	0.174 <sup>‡</sup>	40	0.188** <sup>‡</sup>	0.0334	0.155 <sup>‡</sup>
50	0.355	0.0996	0.255	50	0.284** <sup>‡</sup>	0.0673	0.217 <sup>‡</sup>	50	0.245 <sup>‡</sup>	0.0512	0.192 <sup>‡</sup>	50	0.212** <sup>‡</sup>	0.0416	0.170 <sup>‡</sup>
60	0.378	0.118	0.260	60	0.305** <sup>‡</sup>	0.0802	0.225 <sup>‡</sup>	60	0.261 <sup>‡</sup>	0.0611	0.200 <sup>‡</sup>	60	0.230** <sup>‡</sup>	0.0498	0.180 <sup>‡</sup>
70	0.395	0.137	0.258	70	0.317** <sup>‡</sup>	0.0931	0.224 <sup>‡</sup>	70	0.278 <sup>‡</sup>	0.0711	0.202 <sup>‡</sup>	70	0.241** <sup>‡</sup>	0.0579	0.183 <sup>‡</sup>
80	0.407	0.155	0.252	80	0.327	0.106	0.221	80	0.281	0.0808	0.200 <sup>‡</sup>	80	0.245*	0.0658	0.182 <sup>‡</sup>
90	0.416*	0.174	0.242	90	0.333*	0.118	0.215	90	0.286*	0.0904	0.196	90	0.255*	0.0738	0.179
100	0.423*	0.190	0.233	100	0.339*	0.130	0.209	100	0.290*	0.0994	0.191	100	0.257*	0.0808	0.176
150	0.468**	0.275	0.193	150	0.363*	0.189	0.174	150	0.306*	0.144	0.162	150	0.276*	0.117	0.153
200	0.516*	0.353	0.163	200	0.392*	0.244	0.148	200	0.324*	0.187	0.138	200	0.285*	0.152	0.131
250	0.563*	0.428	0.141	250	0.427*	0.299	0.128	250	0.348*	0.228	0.120	250	0.300*	0.186	0.114
273	0.592	0.460	0.132	273	0.444*	0.323	0.121	273	0.361	0.247	0.113	273	0.309*	0.201	0.108
300	0.621	0.498	0.124	300	0.464	0.350	0.113	300	0.375	0.269	0.106	300	0.326*	0.218	0.101
350	0.676	0.566	0.110	350	0.502	0.400	0.102	350	0.403	0.308	0.0957	350	0.341*	0.249	0.0913
400	0.727	0.627	0.0995	400	0.540	0.448	0.0922	400	0.432	0.345	0.0870	400	0.364*	0.281	0.0832
500	0.831	0.747	0.0833	500	0.615*	0.537	0.0778	500	0.491	0.417	0.0738	500	0.412*	0.341	0.0708
600	0.930	0.859	0.0716	600	0.684*	0.617	0.0673	600	0.548	0.483	0.0641	600	0.462*	0.400	0.0617
700	1.01	0.949	0.0628	700	0.753*	0.694	0.0594	700	0.601	0.544	0.0568	700	0.511*	0.456	0.0548
800	1.09	1.03	0.0560	800	0.820*	0.767	0.0531	800	0.654	0.603	0.0509	800	0.557*	0.508	0.0493
900	1.16	1.11	0.0505	900	0.879*	0.830	0.0481	900	0.708	0.662	0.0462	900	0.601*	0.556	0.0448
1000	1.22	1.18	0.0460	1000	0.937*	0.894	0.0439	1000	0.756	0.714	0.0423	1000	0.642*	0.601	0.0411
1100	1.28*	1.24	0.0422	1100	0.988*	0.948	0.0404	1100	0.804*	0.765	0.0390	1100	0.685*	0.645	0.0379
1200	1.33*	1.29	0.0390	1200	1.04*	1.00	0.0375	1200	0.851*	0.814	0.0362	1200	0.725*	0.688	0.0352

<sup>†</sup> Uncertainties in the total thermal conductivity, k, are as follows:

90.00 Cu - 10.00 Ni:  $\pm 5\%$ .

85.00 Cu - 15.00 Ni:  $\pm 15\%$  below 80 K,  $\pm 10\%$  between 80 and 200 K, and  $\pm 5\%$  above 200 K.

80.00 Cu - 20.00 Ni:  $\pm 15\%$  below 80 K,  $\pm 10\%$  between 80 and 200 K, and  $\pm 5\%$  above 200 K.

75.00 Cu - 25.00 Ni:  $\pm 15\%$  below 80 K,  $\pm 10\%$  between 80 and 200 K, and  $\pm 5\%$  above 200 K.

<sup>‡</sup> Provisional value.

\* In temperature range where no experimental thermal conductivity data are available.

TABLE 11. RECOMMENDED THERMAL CONDUCTIVITY OF COPPER-NICKEL ALLOY SYSTEM (continued)<sup>†</sup>[Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Cu: 70.00% (68.31 At.%) Ni: 30.00% (31.69 At.%)				Cu: 65.00% (63.18 At.%) Ni: 35.00% (36.82 At.%)				Cu: 60.00% (58.09 At.%) Ni: 40.00% (41.91 At.%)				Cu: 55.00% (53.04 At.%) Ni: 45.00% (46.96 At.%)			
$\rho_o = 34.90 \mu\Omega \text{ cm}$				$\rho_o = 40.05 \mu\Omega \text{ cm}$				$\rho_o = 45.00 \mu\Omega \text{ cm}$				$\rho_o = 46.60 \mu\Omega \text{ cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.00720 <sup>‡</sup>	0.00280	0.00440 <sup>‡</sup>	4	0.00749* <sup>‡</sup>	0.00244	0.00505 <sup>‡</sup>	4	0.00797 <sup>‡</sup>	0.00217	0.00580 <sup>‡</sup>	4	0.00900** <sup>‡</sup>	0.00210	0.00690 <sup>‡</sup>
6	0.0142 <sup>‡</sup>	0.00420	0.0100 <sup>‡</sup>	6	0.0145* <sup>‡</sup>	0.00366	0.0108 <sup>‡</sup>	6	0.0152 <sup>‡</sup>	0.00326	0.0119 <sup>‡</sup>	6	0.0166* <sup>‡</sup>	0.00315	0.0134 <sup>‡</sup>
8	0.0231 <sup>‡</sup>	0.00560	0.0175 <sup>‡</sup>	8	0.0232* <sup>‡</sup>	0.00488	0.0183 <sup>‡</sup>	8	0.0238 <sup>‡</sup>	0.00434	0.0195 <sup>‡</sup>	8	0.0253* <sup>‡</sup>	0.00419	0.0211 <sup>‡</sup>
10	0.0335 <sup>‡</sup>	0.00700	0.0265 <sup>‡</sup>	10	0.0331* <sup>‡</sup>	0.00610	0.0270 <sup>‡</sup>	10	0.0334* <sup>‡</sup>	0.00543	0.0280 <sup>‡</sup>	10	0.0347* <sup>‡</sup>	0.00524	0.0295 <sup>‡</sup>
15	0.0620 <sup>‡</sup>	0.0105	0.0515 <sup>‡</sup>	15	0.0622* <sup>‡</sup>	0.00915	0.0510 <sup>‡</sup>	15	0.0536 <sup>‡</sup>	0.00814	0.0505 <sup>‡</sup>	15	0.0589* <sup>‡</sup>	0.00786	0.0510 <sup>‡</sup>
20	0.0930 <sup>‡</sup>	0.0140	0.0790 <sup>‡</sup>	20	0.0877* <sup>‡</sup>	0.0122	0.0755 <sup>‡</sup>	20	0.0839 <sup>‡</sup>	0.0109	0.0730 <sup>‡</sup>	20	0.0820* <sup>‡</sup>	0.0105	0.0715 <sup>‡</sup>
25	0.118 <sup>‡</sup>	0.0175	0.100 <sup>‡</sup>	25	0.110* <sup>‡</sup>	0.0154	0.0850 <sup>‡</sup>	25	0.104 <sup>‡</sup>	0.0137	0.0900 <sup>‡</sup>	25	0.101 <sup>‡</sup>	0.0129 <sup>‡</sup>	0.0885 <sup>‡</sup>
30	0.139 <sup>‡</sup>	0.0210	0.118 <sup>‡</sup>	30	0.128* <sup>‡</sup>	0.0185	0.110 <sup>‡</sup>	30	0.121 <sup>‡</sup>	0.0164	0.105 <sup>‡</sup>	30	0.118 <sup>‡</sup>	0.0155 <sup>‡</sup>	0.102 <sup>‡</sup>
40	0.170 <sup>‡</sup>	0.0280	0.142 <sup>‡</sup>	40	0.157* <sup>‡</sup>	0.0246	0.132 <sup>‡</sup>	40	0.147 <sup>‡</sup>	0.0219	0.125 <sup>‡</sup>	40	0.142 <sup>‡</sup>	0.0206 <sup>‡</sup>	0.121 <sup>‡</sup>
50	0.192 <sup>‡</sup>	0.0349	0.157 <sup>‡</sup>	50	0.177* <sup>‡</sup>	0.0307	0.146 <sup>‡</sup>	50	0.164 <sup>‡</sup>	0.0274	0.137 <sup>‡</sup>	50	0.159 <sup>‡</sup>	0.0257 <sup>‡</sup>	0.133 <sup>‡</sup>
60	0.207 <sup>‡</sup>	0.0418	0.165 <sup>‡</sup>	60	0.191* <sup>‡</sup>	0.0367	0.154 <sup>‡</sup>	60	0.173 <sup>‡</sup>	0.0329	0.145 <sup>‡</sup>	60	0.170 <sup>‡</sup>	0.0308 <sup>‡</sup>	0.139 <sup>‡</sup>
70	0.217 <sup>‡</sup>	0.0486	0.168 <sup>‡</sup>	70	0.195* <sup>‡</sup>	0.0428	0.156 <sup>‡</sup>	70	0.185 <sup>‡</sup>	0.0383	0.147 <sup>‡</sup>	70	0.178 <sup>‡</sup>	0.0359 <sup>‡</sup>	0.142 <sup>‡</sup>
80	0.223	0.0554	0.168 <sup>‡</sup>	80	0.206*	0.0488	0.157 <sup>‡</sup>	80	0.192 <sup>‡</sup>	0.0437	0.148 <sup>‡</sup>	80	0.184	0.0409	0.143
90	0.228*	0.0621	0.166	90	0.211*	0.0547	0.156	90	0.196	0.0491	0.147 <sup>‡</sup>	90	0.189	0.0459	0.143
100	0.232*	0.0679	0.164	100	0.214*	0.0598	0.154	100	0.200*	0.0536	0.146	100	0.192	0.0502	0.142
150	0.243*	0.0991	0.144	150	0.225*	0.0871	0.138	150	0.212*	0.0786	0.133	150	0.204	0.0738	0.130
200	0.255*	0.129	0.125	200	0.235*	0.113	0.122	200	0.221*	0.103	0.118	200	0.213	0.0968	0.116
250	0.268*	0.158	0.110	250	0.246*	0.139	0.107	250	0.231*	0.127	0.104	250	0.222	0.119	0.103
273	0.275*	0.171	0.104	273	0.252*	0.151	0.101	273	0.237*	0.138	0.0989	273	0.227	0.129	0.0976
300	0.284	0.186	0.0977	300	0.260*	0.165	0.0950	300	0.244	0.151	0.0931	300	0.233	0.141	0.0919
350	0.302	0.214	0.0881	350	0.276*	0.190	0.0858	350	0.253	0.174	0.0842	350	0.246	0.163	0.0831
400	0.322	0.241	0.0804	400	0.293*	0.215	0.0783	400	0.274	0.198	0.0769	400	0.261*	0.185	0.0759
500	0.363	0.294	0.0686	500	0.330*	0.263	0.0669	500	0.309	0.244	0.0657	500	0.295*	0.230	0.0649
600	0.407	0.347	0.0599	600	0.368*	0.310	0.0585	600	0.347	0.289	0.0575	600	0.332*	0.275	0.0569
700	0.450	0.397	0.0532	700	0.408*	0.356	0.0521	700	0.384	0.333	0.0512	700	0.370*	0.319	0.0507
800	0.491	0.443	0.0480	800	0.446*	0.399	0.0470	800	0.419	0.373	0.0462	800	0.404*	0.358	0.0457
900	0.531	0.488	0.0437	900	0.480*	0.438	0.0428	900	0.453	0.411	0.0421	900	0.437*	0.395	0.0417
1000	0.568	0.528	0.0401	1000	0.515*	0.475	0.0393	1000	0.485	0.447	0.0387	1000	0.469*	0.431	0.0383
1100	0.604*	0.566	0.0371	1100	0.548*	0.512	0.0364	1100	0.517	0.481	0.0359	1100	0.501*	0.466	0.0355
1200	0.640*	0.605	0.0345	1200	0.581*	0.548	0.0339	1200	0.547	0.514	0.0334	1200	0.533*	0.500	0.0331

<sup>†</sup> Uncertainties in the total thermal conductivity, k, are as follows:70.00 Cu - 30.00 Ni:  $\pm 15\%$  below 80 K,  $\pm 10\%$  between 80 and 200 K, and  $\pm 5\%$  above 200 K.65.00 Cu - 35.00 Ni:  $\pm 15\%$  below 80 K,  $\pm 10\%$  between 80 and 200 K, and  $\pm 5\%$  above 200 K.60.00 Cu - 40.00 Ni:  $\pm 15\%$  below 90 K,  $\pm 10\%$  between 90 and 200 K, and  $\pm 5\%$  above 200 K.55.00 Cu - 45.00 Ni:  $\pm 15\%$  below 80 K,  $\pm 10\%$  between 80 and 200 K, and  $\pm 5\%$  above 200 K.<sup>‡</sup> Provisional value.<sup>\*</sup> In temperature range where no experimental thermal conductivity data are available.

TABLE 11. RECOMMENDED THERMAL CONDUCTIVITY OF COPPER-NICKEL ALLOY SYSTEM (continued)<sup>†</sup>[Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Cu: 50.00% (48.02 At.%) Ni: 50.00% (51.98 At.%)				Cu: 45.00% (43.05 At.%) Ni: 55.00% (56.95 At.%)				Cu: 40.00% (39.12 At.%) Ni: 60.00% (61.88 At.%)				Cu: 35.00% (33.22 At.%) Ni: 65.00% (66.78 At.%)			
$\rho_o = 40.30 \mu\Omega\text{cm}$				$\rho_o = 35.85 \mu\Omega\text{cm}$				$\rho_o = 31.60 \mu\Omega\text{cm}$				$\rho_o = 27.65 \mu\Omega\text{cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.0107 <sup>‡</sup>	0.00243	0.00825 <sup>‡</sup>	4	0.0120* <sup>‡</sup>	0.00273	0.00930 <sup>‡</sup>	4	0.0131* <sup>‡</sup>	0.00309	0.0100 <sup>‡</sup>	4	0.0138	0.00353	0.0103
6	0.0186 <sup>‡</sup>	0.00364	0.0150 <sup>‡</sup>	6	0.0202** <sup>‡</sup>	0.00409	0.0161 <sup>‡</sup>	6	0.0216* <sup>‡</sup>	0.00464	0.0170 <sup>‡</sup>	6	0.0228	0.00530	0.0175
8	0.0274 <sup>‡</sup>	0.00485	0.0226 <sup>‡</sup>	8	0.0292* <sup>‡</sup>	0.00545	0.0237 <sup>‡</sup>	8	0.0307* <sup>‡</sup>	0.00619	0.0245 <sup>‡</sup>	8	0.0321	0.00707	0.0251
10	0.0371 <sup>‡</sup>	0.00606	0.0310 <sup>‡</sup>	10	0.0385* <sup>‡</sup>	0.00682	0.0317 <sup>‡</sup>	10	0.0402* <sup>‡</sup>	0.00773	0.0325 <sup>‡</sup>	10	0.0418	0.00884	0.0330
15	0.0606 <sup>‡</sup>	0.00909	0.0515 <sup>‡</sup>	15	0.0617* <sup>‡</sup>	0.0102	0.0515 <sup>‡</sup>	15	0.0631* <sup>‡</sup>	0.0116	0.0515 <sup>‡</sup>	15	0.0658	0.0133	0.0525
20	0.0831 <sup>‡</sup>	0.0121	0.0710 <sup>‡</sup>	20	0.0842* <sup>‡</sup>	0.0137	0.0705 <sup>‡</sup>	20	0.0860* <sup>‡</sup>	0.0155	0.0705 <sup>‡</sup>	20	0.0882	0.0177	0.0705
25	0.101 <sup>‡</sup>	0.0144 <sup>‡</sup>	0.0870 <sup>‡</sup>	25	0.102* <sup>‡</sup>	0.0163 <sup>‡</sup>	0.0860 <sup>‡</sup>	25	0.105* <sup>‡</sup>	0.0188 <sup>‡</sup>	0.0860 <sup>‡</sup>	25	0.108 <sup>‡</sup>	0.0216 <sup>‡</sup>	0.0865
30	0.117 <sup>‡</sup>	0.0171 <sup>‡</sup>	0.0995 <sup>‡</sup>	30	0.118* <sup>‡</sup>	0.0194 <sup>‡</sup>	0.0990 <sup>‡</sup>	30	0.121* <sup>‡</sup>	0.0224 <sup>‡</sup>	0.0990 <sup>‡</sup>	30	0.126 <sup>‡</sup>	0.0257 <sup>‡</sup>	0.100
40	0.139 <sup>‡</sup>	0.0223 <sup>‡</sup>	0.117 <sup>‡</sup>	40	0.143* <sup>‡</sup>	0.0255 <sup>‡</sup>	0.117 <sup>‡</sup>	40	0.147* <sup>‡</sup>	0.0294 <sup>‡</sup>	0.118 <sup>‡</sup>	40	0.154 <sup>‡</sup>	0.0339 <sup>‡</sup>	0.120
50	0.156 <sup>‡</sup>	0.0275 <sup>‡</sup>	0.128 <sup>‡</sup>	50	0.159* <sup>‡</sup>	0.0312 <sup>‡</sup>	0.128 <sup>‡</sup>	50	0.166* <sup>‡</sup>	0.0361 <sup>‡</sup>	0.130 <sup>‡</sup>	50	0.174 <sup>‡</sup>	0.0417 <sup>‡</sup>	0.132
60	0.167 <sup>‡</sup>	0.0324 <sup>‡</sup>	0.135 <sup>‡</sup>	60	0.172* <sup>‡</sup>	0.0368 <sup>‡</sup>	0.135 <sup>‡</sup>	60	0.180* <sup>‡</sup>	0.0425 <sup>‡</sup>	0.137 <sup>‡</sup>	60	0.189 <sup>‡</sup>	0.0491 <sup>‡</sup>	0.140
70	0.175 <sup>‡</sup>	0.0373 <sup>‡</sup>	0.138 <sup>‡</sup>	70	0.181* <sup>‡</sup>	0.0421 <sup>‡</sup>	0.139 <sup>‡</sup>	70	0.190* <sup>‡</sup>	0.0487 <sup>‡</sup>	0.141 <sup>‡</sup>	70	0.201* <sup>‡</sup>	0.0562 <sup>‡</sup>	0.145
80	0.182	0.0421 <sup>‡</sup>	0.140	80	0.188* <sup>‡</sup>	0.0469 <sup>‡</sup>	0.141 <sup>‡</sup>	80	0.198	0.0545 <sup>‡</sup>	0.143 <sup>‡</sup>	80	0.210* <sup>‡</sup>	0.0630 <sup>‡</sup>	0.147
90	0.187 <sup>‡</sup>	0.0468 <sup>‡</sup>	0.140	90	0.194* <sup>‡</sup>	0.0522 <sup>‡</sup>	0.142 <sup>‡</sup>	90	0.204* <sup>‡</sup>	0.0600 <sup>‡</sup>	0.144 <sup>‡</sup>	90	0.217* <sup>‡</sup>	0.0694 <sup>‡</sup>	0.148
100	0.190 <sup>‡</sup>	0.0507 <sup>‡</sup>	0.139	100	0.197* <sup>‡</sup>	0.0562 <sup>‡</sup>	0.141 <sup>‡</sup>	100	0.208* <sup>‡</sup>	0.0645 <sup>‡</sup>	0.143 <sup>‡</sup>	100	0.222* <sup>‡</sup>	0.0745 <sup>‡</sup>	0.147
150	0.201*	0.0729	0.128	150	0.209* <sup>‡</sup>	0.0775 <sup>‡</sup>	0.131 <sup>‡</sup>	150	0.219* <sup>‡</sup>	0.0866 <sup>‡</sup>	0.132 <sup>‡</sup>	150	0.235* <sup>‡</sup>	0.0986 <sup>‡</sup>	0.136
200	0.208*	0.0944	0.114	200	0.214*	0.0969	0.117	200	0.223* <sup>‡</sup>	0.105 <sup>‡</sup>	0.118	200	0.237* <sup>‡</sup>	0.117 <sup>‡</sup>	0.120
250	0.217*	0.115	0.102	250	0.219*	0.116	0.102	250	0.224*	0.121	0.103	250	0.237* <sup>‡</sup>	0.132 <sup>‡</sup>	0.105
273	0.221*	0.124	0.0970	273	0.222*	0.125	0.0970	273	0.228	0.130	0.0976	273	0.237*	0.138	0.0989
300	0.227	0.135	0.0913	300	0.227*	0.136	0.0913	300	0.232	0.140	0.0919	300	0.240*	0.147	0.0930
350	0.239	0.156	0.0826	350	0.239*	0.156	0.0825	350	0.243	0.160	0.0830	350	0.250*	0.166	0.0840
400	0.254*	0.178	0.0754	400	0.252*	0.177	0.0754	400	0.255	0.179	0.0758	400	0.261*	0.185	0.0766
500	0.287*	0.222	0.0645	500	0.284*	0.220	0.0644	500	0.284	0.219	0.0647	500	0.289*	0.223	0.0654
600	0.323*	0.266	0.0565	600	0.319*	0.263	0.0564	600	0.318	0.262	0.0566	600	0.322*	0.265	0.0571
700	0.361*	0.311	0.0503	700	0.357*	0.307	0.0502	700	0.356	0.306	0.0504	700	0.360*	0.309	0.0508
800	0.396*	0.350	0.0454	800	0.392*	0.347	0.0453	800	0.391	0.345	0.0454	800	0.394*	0.349	0.0457
900	0.429*	0.388	0.414	900	0.426*	0.385	0.0413	900	0.424	0.383	0.0414	900	0.428*	0.386	0.0416
1000	0.462*	0.424	0.0381	1000	0.459*	0.421	0.0380	1000	0.458	0.420	0.0380	1000	0.461*	0.423	0.0382
1100	0.493*	0.458	0.0353	1100	0.491*	0.456	0.0352	1100	0.491*	0.456	0.0352	1100	0.495*	0.460	0.0354
1200	0.525*	0.492	0.0328	1200	0.522*	0.489	0.0327	1200	0.525*	0.493	0.0328	1200	0.528*	0.495	0.0329

<sup>†</sup> Uncertainties in the total thermal conductivity, k, are as follows:50.00 Cu - 50.00 Ni:  $\pm 15\%$  below 20 K,  $\pm 20\%$  between 20 and 100 K,  $\pm 10\%$  between 100 and 200 K, and  $\pm 5\%$  above 200 K.45.00 Cu - 55.00 Ni:  $\pm 15\%$  below 20 K,  $\pm 20\%$  between 20 and 150 K, and  $\pm 10\%$  above 150 K.40.00 Cu - 60.00 Ni:  $\pm 15\%$  below 20 K,  $\pm 20\%$  between 20 and 200 K, and  $\pm 10\%$  above 200 K.35.00 Cu - 65.00 Ni:  $\pm 10\%$  below 20 K,  $\pm 20\%$  between 20 and 250 K, and  $\pm 10\%$  above 250 K.<sup>‡</sup> Provisional value.<sup>\*</sup> In temperature range where no experimental thermal conductivity data are available.

TABLE 11. RECOMMENDED THERMAL CONDUCTIVITY OF COPPER-NICKEL ALLOY SYSTEM (continued)<sup>†</sup>[Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Cu: 30.00% (28.37 At.%) Ni: 70.00% (71.63 At.%)				Cu: 25.00% (23.55 At.%) Ni: 75.00% (76.45 At.%)				Cu: 20.00% (18.76 At.%) Ni: 80.00% (81.24 At.%)				Cu: 15.00% (14.02 At.%) Ni: 85.00% (85.98 At.%)			
$\rho_o = 23.70 \mu\Omega \text{ cm}$				$\rho_o = 19.80 \mu\Omega \text{ cm}$				$\rho_o = 16.00 \mu\Omega \text{ cm}$				$\rho_o = 11.90 \mu\Omega \text{ cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.0144** <sup>#</sup>	0.00412	0.0103 <sup>#</sup>	4	0.0148** <sup>#</sup>	0.00494	0.00985 <sup>#</sup>	4	0.0159** <sup>#</sup>	0.00611	0.0092 <sup>#</sup>	4	0.0162 <sup>#</sup>	0.00822	0.00800 <sup>#</sup>
6	0.0237** <sup>#</sup>	0.00619	0.0175 <sup>#</sup>	6	0.0238** <sup>#</sup>	0.00740	0.0164 <sup>#</sup>	6	0.0244** <sup>#</sup>	0.00916	0.0152 <sup>#</sup>	6	0.0258 <sup>#</sup>	0.0123	0.0135 <sup>#</sup>
8	0.0334** <sup>#</sup>	0.00825	0.0251 <sup>#</sup>	8	0.0335** <sup>#</sup>	0.00987	0.0236 <sup>#</sup>	8	0.0339** <sup>#</sup>	0.0122	0.0217 <sup>#</sup>	8	0.0359 <sup>#</sup>	0.0164	0.0195 <sup>#</sup>
10	0.0433** <sup>#</sup>	0.0103	0.0330 <sup>#</sup>	10	0.0433** <sup>#</sup>	0.0123	0.0310 <sup>#</sup>	10	0.0436** <sup>#</sup>	0.0153	0.0285 <sup>#</sup>	10	0.0465 <sup>#</sup>	0.0205	0.0260 <sup>#</sup>
15	0.0670** <sup>#</sup>	0.0155	0.0515 <sup>#</sup>	15	0.0675** <sup>#</sup>	0.0185	0.0490 <sup>#</sup>	15	0.0689** <sup>#</sup>	0.0229	0.0460 <sup>#</sup>	15	0.0738 <sup>#</sup>	0.0308	0.0430 <sup>#</sup>
20	0.0896** <sup>#</sup>	0.0206	0.0690 <sup>#</sup>	20	0.0917** <sup>#</sup>	0.0247	0.0670 <sup>#</sup>	20	0.0955** <sup>#</sup>	0.0305	0.0650 <sup>#</sup>	20	0.103 <sup>#</sup>	0.0411	0.0615 <sup>#</sup>
25	0.110** <sup>#</sup>	0.0254 <sup>#</sup>	0.0845 <sup>#</sup>	25	0.114** <sup>#</sup>	0.0303 <sup>#</sup>	0.0835 <sup>#</sup>	25	0.120** <sup>#</sup>	0.0375 <sup>#</sup>	0.0820 <sup>#</sup>	25	0.130 <sup>#</sup>	0.0502 <sup>#</sup>	0.0800 <sup>#</sup>
30	0.128** <sup>#</sup>	0.0303 <sup>#</sup>	0.0980 <sup>#</sup>	30	0.135** <sup>#</sup>	0.0362 <sup>#</sup>	0.0985 <sup>#</sup>	30	0.144** <sup>#</sup>	0.0449 <sup>#</sup>	0.0990 <sup>#</sup>	30	0.157 <sup>#</sup>	0.0597 <sup>#</sup>	0.0970 <sup>#</sup>
40	0.159** <sup>#</sup>	0.0400 <sup>#</sup>	0.119 <sup>#</sup>	40	0.169** <sup>#</sup>	0.0477 <sup>#</sup>	0.121 <sup>#</sup>	40	0.182** <sup>#</sup>	0.0590 <sup>#</sup>	0.123 <sup>#</sup>	40	0.203 <sup>#</sup>	0.0783 <sup>#</sup>	0.125 <sup>#</sup>
50	0.180** <sup>#</sup>	0.0492 <sup>#</sup>	0.131 <sup>#</sup>	50	0.195** <sup>#</sup>	0.0586 <sup>#</sup>	0.136 <sup>#</sup>	50	0.212** <sup>#</sup>	0.0725 <sup>#</sup>	0.139 <sup>#</sup>	50	0.239 <sup>#</sup>	0.0958 <sup>#</sup>	0.143 <sup>#</sup>
60	0.198** <sup>#</sup>	0.0580 <sup>#</sup>	0.140 <sup>#</sup>	60	0.214** <sup>#</sup>	0.0691 <sup>#</sup>	0.145 <sup>#</sup>	60	0.236** <sup>#</sup>	0.0855 <sup>#</sup>	0.150 <sup>#</sup>	60	0.268** <sup>#</sup>	0.113 <sup>#</sup>	0.155 <sup>#</sup>
70	0.213** <sup>#</sup>	0.0665 <sup>#</sup>	0.146 <sup>#</sup>	70	0.230** <sup>#</sup>	0.0792 <sup>#</sup>	0.151 <sup>#</sup>	70	0.255** <sup>#</sup>	0.0977 <sup>#</sup>	0.157 <sup>#</sup>	70	0.292** <sup>#</sup>	0.128 <sup>#</sup>	0.164 <sup>#</sup>
80	0.223** <sup>#</sup>	0.0744 <sup>#</sup>	0.149 <sup>#</sup>	80	0.242** <sup>#</sup>	0.0884 <sup>#</sup>	0.154 <sup>#</sup>	80	0.270 <sup>#</sup>	0.109 <sup>#</sup>	0.161 <sup>#</sup>	80	0.312 <sup>#</sup>	0.142 <sup>#</sup>	0.170 <sup>#</sup>
90	0.232** <sup>#</sup>	0.0818 <sup>#</sup>	0.150 <sup>#</sup>	90	0.252** <sup>#</sup>	0.0972 <sup>#</sup>	0.155 <sup>#</sup>	90	0.284** <sup>#</sup>	0.120 <sup>#</sup>	0.164 <sup>#</sup>	90	0.328** <sup>#</sup>	0.156 <sup>#</sup>	0.172 <sup>#</sup>
100	0.237** <sup>#</sup>	0.0877 <sup>#</sup>	0.149 <sup>#</sup>	100	0.258** <sup>#</sup>	0.104 <sup>#</sup>	0.154 <sup>#</sup>	100	0.293** <sup>#</sup>	0.129 <sup>#</sup>	0.164 <sup>#</sup>	100	0.340** <sup>#</sup>	0.167 <sup>#</sup>	0.173 <sup>#</sup>
150	0.253** <sup>#</sup>	0.116 <sup>#</sup>	0.137 <sup>#</sup>	150	0.281** <sup>#</sup>	0.138 <sup>#</sup>	0.143 <sup>#</sup>	150	0.320** <sup>#</sup>	0.169 <sup>#</sup>	0.151 <sup>#</sup>	150	0.373** <sup>#</sup>	0.214 <sup>#</sup>	0.159 <sup>#</sup>
200	0.256** <sup>#</sup>	0.134 <sup>#</sup>	0.122 <sup>#</sup>	200	0.287** <sup>#</sup>	0.161 <sup>#</sup>	0.126 <sup>#</sup>	200	0.330** <sup>#</sup>	0.198 <sup>#</sup>	0.132 <sup>#</sup>	200	0.387** <sup>#</sup>	0.247 <sup>#</sup>	0.140 <sup>#</sup>
250	0.257** <sup>#</sup>	0.150 <sup>#</sup>	0.107 <sup>#</sup>	250	0.286** <sup>#</sup>	0.176 <sup>#</sup>	0.110 <sup>#</sup>	250	0.332** <sup>#</sup>	0.217 <sup>#</sup>	0.115 <sup>#</sup>	250	0.388** <sup>#</sup>	0.267 <sup>#</sup>	0.122 <sup>#</sup>
273	0.257** <sup>#</sup>	0.156 <sup>#</sup>	0.101 <sup>#</sup>	273	0.285** <sup>#</sup>	0.181 <sup>#</sup>	0.104 <sup>#</sup>	273	0.331 <sup>#</sup>	0.223 <sup>#</sup>	0.108 <sup>#</sup>	273	0.388 <sup>#</sup>	0.273 <sup>#</sup>	0.114 <sup>#</sup>
300	0.257 <sup>#</sup>	0.162 <sup>#</sup>	0.0949 <sup>#</sup>	300	0.285 <sup>#</sup>	0.187 <sup>#</sup>	0.0977 <sup>#</sup>	300	0.330 <sup>#</sup>	0.223 <sup>#</sup>	0.102 <sup>#</sup>	300	0.388 <sup>#</sup>	0.280 <sup>#</sup>	0.107 <sup>#</sup>
350	0.261	0.175	0.0856 <sup>#</sup>	350	0.283 <sup>#</sup>	0.195 <sup>#</sup>	0.0880 <sup>#</sup>	350	0.325 <sup>#</sup>	0.234 <sup>#</sup>	0.0913 <sup>#</sup>	350	0.381 <sup>#</sup>	0.285 <sup>#</sup>	0.0959 <sup>#</sup>
400	0.272	0.194	0.0780 <sup>#</sup>	400	0.286*	0.206	0.0800 <sup>#</sup>	400	0.320*	0.237 <sup>#</sup>	0.0829 <sup>#</sup>	400	0.373** <sup>#</sup>	0.287 <sup>#</sup>	0.0868 <sup>#</sup>
500	0.298	0.232	0.0664 <sup>#</sup>	500	0.313 <sup>#</sup>	0.245	0.0679 <sup>#</sup>	500	0.333	0.263	0.0701 <sup>#</sup>	500	0.359*	0.286	0.0730 <sup>#</sup>
600	0.331	0.273	0.0579 <sup>#</sup>	600	0.347*	0.288	0.0591 <sup>#</sup>	600	0.367	0.306	0.0608 <sup>#</sup>	600	0.397*	0.334	0.0630 <sup>#</sup>
700	0.369	0.318	0.0514 <sup>#</sup>	700	0.388*	0.335	0.0524 <sup>#</sup>	700	0.411	0.357	0.0537 <sup>#</sup>	700	0.445*	0.389	0.0555 <sup>#</sup>
800	0.404*	0.357	0.0463 <sup>#</sup>	800	0.422*	0.375	0.0471 <sup>#</sup>	800	0.445	0.397	0.0481 <sup>#</sup>	800	0.479*	0.429	0.0495 <sup>#</sup>
900	0.438*	0.396	0.0421 <sup>#</sup>	900	0.456*	0.413	0.0427 <sup>#</sup>	900	0.478	0.435	0.0436 <sup>#</sup>	900	0.510*	0.465	0.0448 <sup>#</sup>
1000	0.472*	0.433	0.0386 <sup>#</sup>	1000	0.489*	0.450	0.0391 <sup>#</sup>	1000	0.511*	0.471	0.0399 <sup>#</sup>	1000	0.539*	0.498	0.0408 <sup>#</sup>
1100	0.506*	0.470	0.0357 <sup>#</sup>	1100	0.521*	0.485	0.0361 <sup>#</sup>	1100	0.542*	0.505	0.0367 <sup>#</sup>	1100	0.567*	0.529	0.0376 <sup>#</sup>
1200	0.538*	0.505	0.0331 <sup>#</sup>	1200	0.552*	0.518	0.0335 <sup>#</sup>	1200	0.572*	0.538	0.0341 <sup>#</sup>	1200	0.595*	0.560	0.0348 <sup>#</sup>

<sup>†</sup> Uncertainties in the total thermal conductivity, k, are as follows:30.00 Cu - 70.00 Ni:  $\pm 15\%$  below 20 K,  $\pm 20\%$  between 20 and 300 K, and  $\pm 10\%$  above 300 K.25.00 Cu - 75.00 Ni:  $\pm 15\%$  below 20 K,  $\pm 20\%$  between 20 and 350 K, and  $\pm 14\%$  above 350 K.20.00 Cu - 80.00 Ni:  $\pm 15\%$  below 20 K,  $\pm 20\%$  between 20 and 400 K, and  $\pm 14\%$  above 400 K.15.00 Cu - 85.00 Ni:  $\pm 15\%$  below 20 K,  $\pm 20\%$  between 20 and 400 K, and  $\pm 14\%$  above 400 K.<sup>#</sup> Provisional value.<sup>\*</sup> Typical value.<sup>\*</sup> In temperature range where no experimental thermal conductivity data are available.

TABLE 11. RECOMMENDED THERMAL CONDUCTIVITY OF COPPER-NICKEL ALLOY SYSTEM (continued)<sup>†</sup>  
 [Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Cu: 10.00% ( 9.31 At.%) Ni: 90.00% (90.69 At.%)				Cu: 5.00% ( 4.64 At.%) Ni: 95.00% (95.36 At.%)				Cu: 3.00% ( 2.78 At.%) Ni: 97.00% (97.22 At.%)				Cu: 1.00% ( 0.92 At.%) Ni: 99.00% (99.08 At.%)			
$\rho_0 = 8.00 \mu\Omega \text{ cm}$				$\rho_0 = 4.100 \mu\Omega \text{ cm}$				$\rho_0 = 2.400 \mu\Omega \text{ cm}$				$\rho_0 = 0.900 \mu\Omega \text{ cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.0188 <sup>‡</sup>	0.0122	0.00660 <sup>#</sup>	4	0.0279 <sup>‡</sup>	0.0238	0.00410 <sup>#</sup>	4	0.0481* <sup>#</sup>	0.0407	0.00740 <sup>#</sup>	4	0.123 <sup>‡</sup>	0.109	0.0140 <sup>#</sup>
6	0.0309 <sup>‡</sup>	0.0183	0.0116 <sup>#</sup>	6	0.0438 <sup>‡</sup>	0.0358	0.00800 <sup>#</sup>	6	0.0741* <sup>#</sup>	0.0611	0.0130 <sup>#</sup>	6	0.186 <sup>‡</sup>	0.163	0.0233 <sup>#</sup>
8	0.0415 <sup>‡</sup>	0.0244	0.0171 <sup>#</sup>	8	0.0604 <sup>‡</sup>	0.0477	0.0127 <sup>#</sup>	8	0.101* <sup>#</sup>	0.0814	0.0192 <sup>#</sup>	8	0.256 <sup>‡</sup>	0.217	0.0330 <sup>#</sup>
10	0.0536 <sup>‡</sup>	0.0305	0.0231 <sup>#</sup>	10	0.0778 <sup>‡</sup>	0.0596	0.0182 <sup>#</sup>	10	0.128* <sup>#</sup>	0.102	0.0260 <sup>#</sup>	10	0.314 <sup>‡</sup>	0.271	0.0433 <sup>#</sup>
15	0.0851 <sup>‡</sup>	0.0458	0.0393 <sup>#</sup>	15	0.123 <sup>‡</sup>	0.0894	0.0337 <sup>#</sup>	15	0.198* <sup>#</sup>	0.153	0.0445 <sup>#</sup>	15	0.477 <sup>‡</sup>	0.407	0.0695 <sup>#</sup>
20	0.118 <sup>‡</sup>	0.0611 <sup>‡</sup>	0.0570 <sup>#</sup>	20	0.171 <sup>‡</sup>	0.119	0.0515 <sup>#</sup>	20	0.269* <sup>#</sup>	0.204	0.0650 <sup>#</sup>	20	0.639 <sup>‡</sup>	0.543	0.0960 <sup>#</sup>
25	0.150 <sup>‡</sup>	0.0752 <sup>‡</sup>	0.0750 <sup>#</sup>	25	0.217 <sup>‡</sup>	0.146 <sup>‡</sup>	0.0705 <sup>#</sup>	25	0.329* <sup>#</sup>	0.242 <sup>‡</sup>	0.0870 <sup>#</sup>	25	0.771 <sup>‡</sup>	0.649 <sup>‡</sup>	0.122 <sup>#</sup>
30	0.183 <sup>‡</sup>	0.0896 <sup>‡</sup>	0.0930 <sup>#</sup>	30	0.264 <sup>‡</sup>	0.173 <sup>‡</sup>	0.0910 <sup>#</sup>	30	0.397* <sup>#</sup>	0.287 <sup>‡</sup>	0.110 <sup>#</sup>	30	0.890 <sup>‡</sup>	0.742 <sup>‡</sup>	0.148 <sup>#</sup>
40	0.242 <sup>‡</sup>	0.117 <sup>‡</sup>	0.125 <sup>#</sup>	40	0.354 <sup>‡</sup>	0.224 <sup>‡</sup>	0.130 <sup>#</sup>	40	0.516* <sup>#</sup>	0.363 <sup>‡</sup>	0.153 <sup>#</sup>	40	1.07 <sup>‡</sup>	0.875 <sup>‡</sup>	0.195 <sup>#</sup>
50	0.293 <sup>‡</sup>	0.143 <sup>‡</sup>	0.150 <sup>#</sup>	50	0.433 <sup>‡</sup>	0.268 <sup>‡</sup>	0.165 <sup>#</sup>	50	0.613* <sup>#</sup>	0.424 <sup>‡</sup>	0.189 <sup>#</sup>	50	1.19 <sup>‡</sup>	0.952 <sup>‡</sup>	0.235 <sup>#</sup>
60	0.331* <sup>#</sup>	0.165 <sup>‡</sup>	0.166 <sup>#</sup>	60	0.497 <sup>‡</sup>	0.306 <sup>‡</sup>	0.191 <sup>#</sup>	60	0.688* <sup>#</sup>	0.473 <sup>‡</sup>	0.215 <sup>#</sup>	60	1.21 <sup>‡</sup>	0.949 <sup>‡</sup>	0.265 <sup>#</sup>
70	0.365* <sup>#</sup>	0.187 <sup>‡</sup>	0.178 <sup>#</sup>	70	0.543 <sup>‡</sup>	0.337 <sup>‡</sup>	0.206 <sup>#</sup>	70	0.734* <sup>#</sup>	0.504 <sup>‡</sup>	0.230 <sup>#</sup>	70	1.21 <sup>‡</sup>	0.924 <sup>‡</sup>	0.283 <sup>#</sup>
80	0.390 <sup>‡</sup>	0.204 <sup>‡</sup>	0.186 <sup>#</sup>	80	0.578 <sup>‡</sup>	0.362 <sup>‡</sup>	0.216 <sup>#</sup>	80	0.765* <sup>#</sup>	0.524 <sup>‡</sup>	0.241 <sup>#</sup>	80	1.19 <sup>‡</sup>	0.899 <sup>‡</sup>	0.293 <sup>#</sup>
90	0.411* <sup>#</sup>	0.221 <sup>‡</sup>	0.190 <sup>#</sup>	90	0.599* <sup>#</sup>	0.378 <sup>‡</sup>	0.221 <sup>#</sup>	90	0.784* <sup>#</sup>	0.537 <sup>‡</sup>	0.247 <sup>#</sup>	90	1.16 <sup>‡</sup>	0.866 <sup>‡</sup>	0.295 <sup>#</sup>
100	0.426* <sup>#</sup>	0.234 <sup>‡</sup>	0.192 <sup>#</sup>	100	0.614* <sup>#</sup>	0.391 <sup>‡</sup>	0.223 <sup>#</sup>	100	0.786* <sup>#</sup>	0.536 <sup>‡</sup>	0.250 <sup>#</sup>	100	1.11 <sup>‡</sup>	0.823 <sup>‡</sup>	0.290 <sup>#</sup>
150	0.465* <sup>#</sup>	0.287 <sup>‡</sup>	0.178 <sup>#</sup>	150	0.642* <sup>#</sup>	0.436 <sup>‡</sup>	0.206 <sup>#</sup>	150	0.779* <sup>#</sup>	0.554 <sup>‡</sup>	0.225 <sup>#</sup>	150	0.993* <sup>#</sup>	0.741 <sup>‡</sup>	0.252 <sup>#</sup>
200	0.474* <sup>#</sup>	0.322 <sup>‡</sup>	0.152 <sup>#</sup>	200	0.637* <sup>#</sup>	0.463 <sup>‡</sup>	0.174 <sup>#</sup>	200	0.743* <sup>#</sup>	0.557 <sup>‡</sup>	0.186 <sup>#</sup>	200	0.900* <sup>#</sup>	0.698 <sup>‡</sup>	0.202 <sup>#</sup>
250	0.473* <sup>#</sup>	0.342 <sup>‡</sup>	0.131 <sup>#</sup>	250	0.623* <sup>#</sup>	0.476 <sup>‡</sup>	0.147 <sup>#</sup>	250	0.717* <sup>#</sup>	0.561 <sup>‡</sup>	0.156 <sup>#</sup>	250	0.836* <sup>#</sup>	0.670 <sup>‡</sup>	0.163 <sup>#</sup>
273	0.472* <sup>#</sup>	0.343 <sup>‡</sup>	0.123 <sup>#</sup>	273	0.616* <sup>#</sup>	0.478 <sup>‡</sup>	0.137 <sup>#</sup>	273	0.704* <sup>#</sup>	0.559 <sup>‡</sup>	0.145 <sup>#</sup>	273	0.819* <sup>#</sup>	0.663 <sup>‡</sup>	0.155 <sup>#</sup>
300	0.471 <sup>‡</sup>	0.356 <sup>‡</sup>	0.115 <sup>#</sup>	300	0.608 <sup>‡</sup>	0.481 <sup>‡</sup>	0.127 <sup>#</sup>	300	0.692* <sup>#</sup>	0.558 <sup>‡</sup>	0.134 <sup>#</sup>	300	0.801* <sup>#</sup>	0.658 <sup>‡</sup>	0.143 <sup>#</sup>
350	0.459 <sup>‡</sup>	0.356 <sup>‡</sup>	0.103 <sup>#</sup>	350	0.591 <sup>‡</sup>	0.479 <sup>‡</sup>	0.112 <sup>#</sup>	350	0.665* <sup>#</sup>	0.547 <sup>‡</sup>	0.118 <sup>#</sup>	350	0.764* <sup>#</sup>	0.640 <sup>‡</sup>	0.124 <sup>#</sup>
400	0.447* <sup>#</sup>	0.355 <sup>‡</sup>	0.0923 <sup>#</sup>	400	0.566* <sup>#</sup>	0.466 <sup>‡</sup>	0.100 <sup>#</sup>	400	0.635* <sup>#</sup>	0.530 <sup>‡</sup>	0.105 <sup>#</sup>	400	0.724* <sup>#</sup>	0.615 <sup>‡</sup>	0.110 <sup>#</sup>
500	0.419 <sup>‡</sup>	0.342 <sup>‡</sup>	0.0770 <sup>#</sup>	500	0.523 <sup>‡</sup>	0.441 <sup>‡</sup>	0.0826 <sup>#</sup>	500	0.581* <sup>#</sup>	0.495 <sup>‡</sup>	0.0855 <sup>#</sup>	500	0.655* <sup>#</sup>	0.566 <sup>‡</sup>	0.0890 <sup>#</sup>
600	0.437	0.371	0.0660 <sup>#</sup>	600	0.494	0.424	0.0702 <sup>#</sup>	600	0.527* <sup>#</sup>	0.455 <sup>‡</sup>	0.0723 <sup>#</sup>	600	0.598* <sup>#</sup>	0.523 <sup>‡</sup>	0.0747 <sup>#</sup>
700	0.486*	0.423	0.0578 <sup>#</sup>	700	0.547*	0.486	0.0610 <sup>#</sup>	700	0.581*	0.518	0.0626 <sup>#</sup>	700	0.615*	0.555	0.0643 <sup>#</sup>
800	0.520*	0.469	0.0514 <sup>#</sup>	800	0.579*	0.525	0.0539 <sup>#</sup>	800	0.611*	0.556	0.0551 <sup>#</sup>	800	0.643*	0.587	0.0565 <sup>#</sup>
900	0.550*	0.503	0.0463 <sup>#</sup>	900	0.607*	0.559	0.0483 <sup>#</sup>	900	0.638*	0.588	0.0493 <sup>#</sup>	900	0.669*	0.618	0.0503 <sup>#</sup>
1000	0.578*	0.536	0.0421 <sup>#</sup>	1000	0.635*	0.591	0.0437 <sup>#</sup>	1000	0.662*	0.618	0.0445 <sup>#</sup>	1000	0.692*	0.646	0.0454 <sup>#</sup>
1100	0.606*	0.563	0.0386 <sup>#</sup>	1100	0.661*	0.621	0.0400 <sup>#</sup>	1100	0.687*	0.646	0.0406 <sup>#</sup>	1100	0.715*	0.673	0.0413 <sup>#</sup>
1200	0.622*	0.596	0.0357 <sup>#</sup>	1200	0.686*	0.649	0.0368 <sup>#</sup>	1200	0.710*	0.672	0.0373 <sup>#</sup>	1200	0.736*	0.698	0.0379 <sup>#</sup>

<sup>†</sup> Uncertainties in the total thermal conductivity, k, are as follows:

10.00 Cu - 90.00 Ni:  $\pm 20\%$  below 20 K,  $\pm 25\%$  between 20 and 500 K, and  $\pm 15\%$  above 500 K.

5.00 Cu - 95.00 Ni:  $\pm 20\%$  below 20 K,  $\pm 25\%$  between 20 and 500 K, and  $\pm 15\%$  above 500 K.

3.00 Cu - 97.00 Ni:  $\pm 20\%$  below 20 K,  $\pm 25\%$  between 20 and 600 K, and  $\pm 15\%$  above 600 K.

1.00 Cu - 99.00 Ni:  $\pm 20\%$  below 20 K,  $\pm 25\%$  between 20 and 600 K, and  $\pm 15\%$  above 600 K.

<sup>‡</sup> Provisional value.

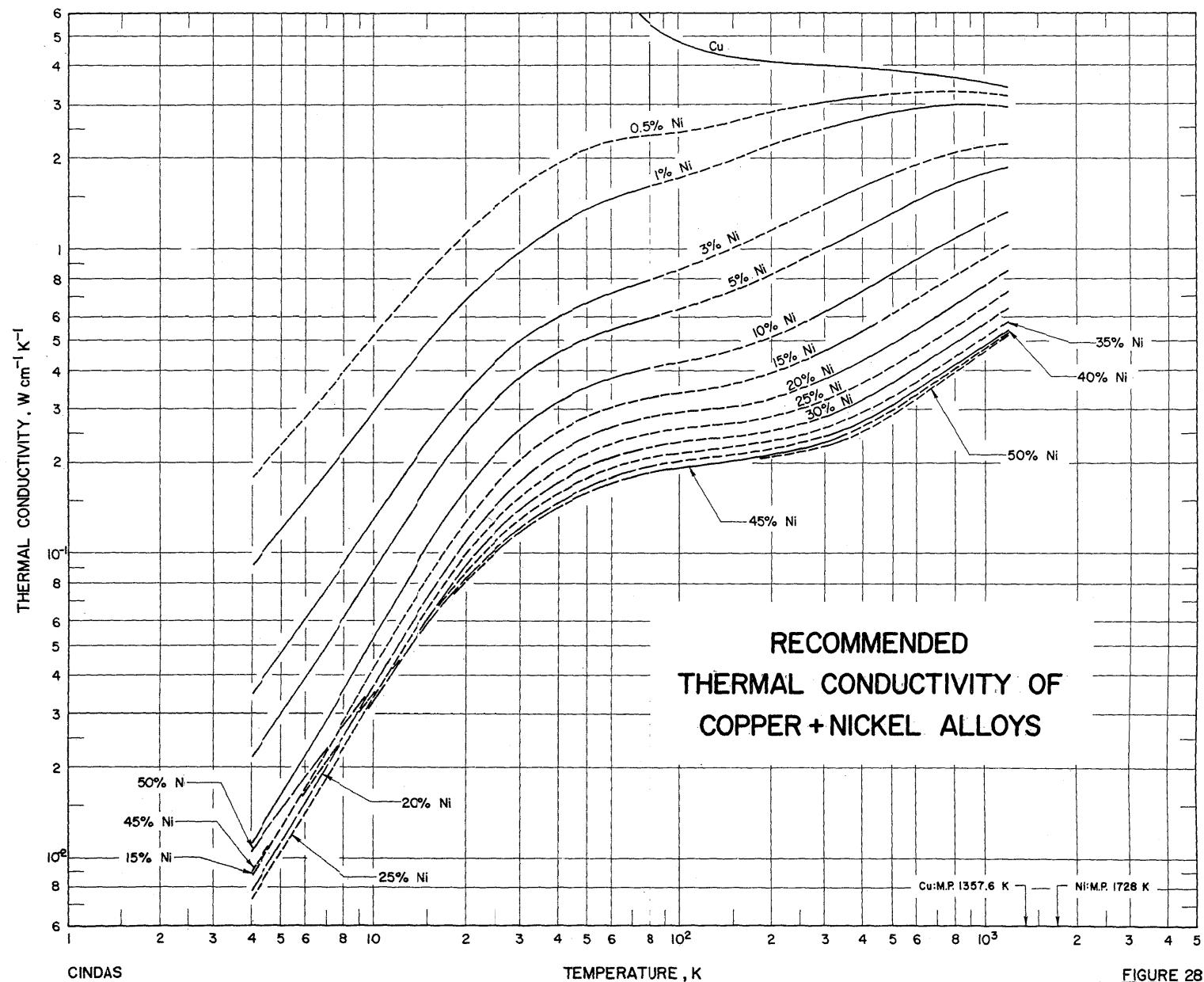
<sup>#</sup> Typical value.

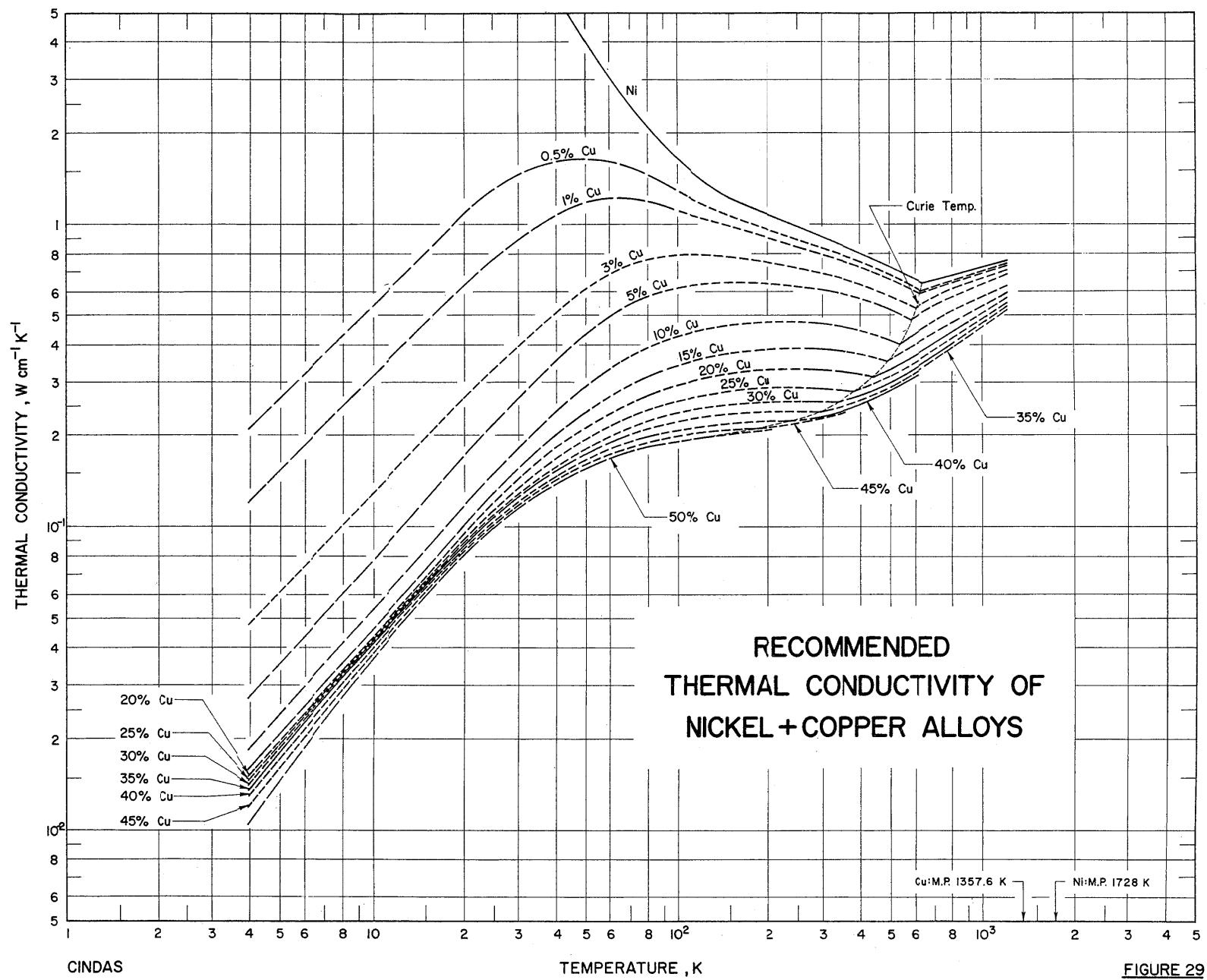
<sup>\*</sup> In temperature range where no experimental thermal conductivity data are available.

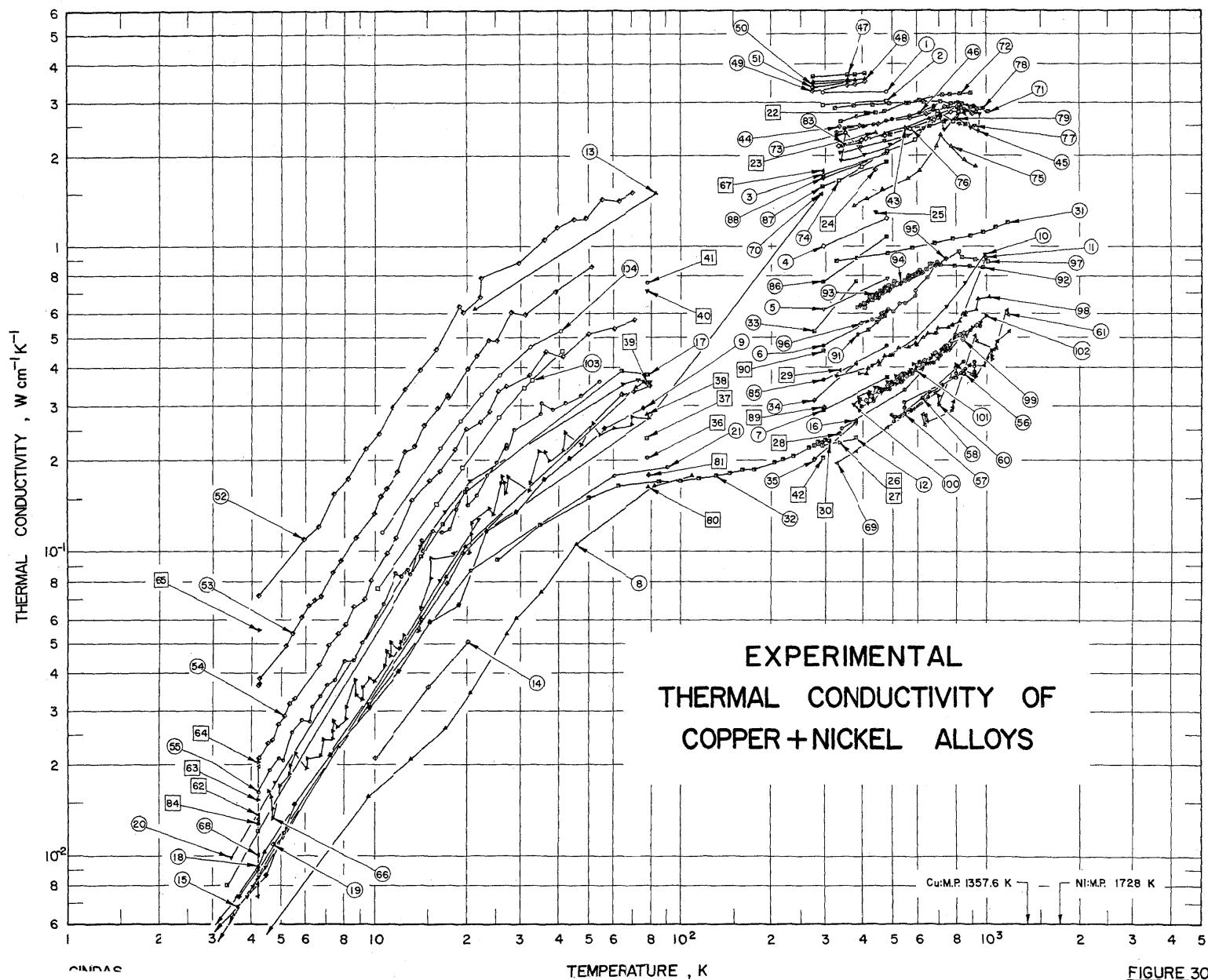
TABLE 11. RECOMMENDED THERMAL CONDUCTIVITY OF COPPER-NICKEL ALLOY SYSTEM (continued)<sup>†</sup>[Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Cu: 0.50% (0.46 At.%) Ni: 99.50% (99.54 At.%)			
$\rho_0 = 0.500 \mu\Omega \text{cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.212 <sup>#</sup>	0.195	0.0170 <sup>#</sup>
6	0.321 <sup>#</sup>	0.293	0.0278 <sup>#</sup>
8	0.430 <sup>#</sup>	0.391	0.0390 <sup>#</sup>
10	0.540 <sup>#</sup>	0.489	0.0510 <sup>#</sup>
15	0.813 <sup>#</sup>	0.733	0.0800 <sup>#</sup>
20	1.09 <sup>#</sup>	0.977	0.110 <sup>#</sup>
25	1.31 <sup>#</sup>	1.17 <sup>#</sup>	0.140 <sup>#</sup>
30	1.46 <sup>#</sup>	1.29 <sup>#</sup>	0.170 <sup>#</sup>
40	1.62 <sup>#</sup>	1.40 <sup>#</sup>	0.220 <sup>#</sup>
50	1.64 <sup>#</sup>	1.38 <sup>#</sup>	0.260 <sup>#</sup>
60	1.62 <sup>#</sup>	1.33 <sup>#</sup>	0.290 <sup>#</sup>
70	1.56 <sup>#</sup>	1.25 <sup>#</sup>	0.308 <sup>#</sup>
80	1.45 <sup>#</sup>	1.13 <sup>#</sup>	0.318 <sup>#</sup>
90	1.36 <sup>#</sup>	1.04 <sup>#</sup>	0.320 <sup>#</sup>
100	1.29 <sup>#</sup>	0.969 <sup>#</sup>	0.318 <sup>#</sup>
150	1.06** <sup>#</sup>	0.796 <sup>#</sup>	0.263 <sup>#</sup>
200	0.954** <sup>#</sup>	0.745 <sup>#</sup>	0.209 <sup>#</sup>
250	0.888** <sup>#</sup>	0.717 <sup>#</sup>	0.171 <sup>#</sup>
273	0.860** <sup>#</sup>	0.701 <sup>#</sup>	0.158 <sup>#</sup>
300	0.837** <sup>#</sup>	0.692 <sup>#</sup>	0.145 <sup>#</sup>
350	0.793** <sup>#</sup>	0.667 <sup>#</sup>	0.126 <sup>#</sup>
400	0.752** <sup>#</sup>	0.641 <sup>#</sup>	0.111 <sup>#</sup>
500	0.679** <sup>#</sup>	0.589 <sup>#</sup>	0.0899 <sup>#</sup>
600	0.618** <sup>#</sup>	0.543 <sup>#</sup>	0.0753 <sup>#</sup>
700	0.629*	0.564	0.0648 <sup>#</sup>
800	0.653*	0.596	0.0569 <sup>#</sup>
900	0.678*	0.627	0.0506 <sup>#</sup>
1000	0.700*	0.654	0.0456 <sup>#</sup>
1100	0.724*	0.682	0.0415 <sup>#</sup>
1200	0.747*	0.709	0.0381 <sup>#</sup>

<sup>†</sup> Uncertainties in the total thermal conductivity, k, are as follows:0.50 Cu - 99.50 Ni:  $\pm 20\%$  below 20 K,  $\pm 25\%$  between 20 and 600 K, and  $\pm 15\%$  above 600 K.<sup>#</sup> Provisional value.<sup>\*</sup> Typical value.<sup>\*</sup> In temperature range where no experimental thermal conductivity data are available.

**FIGURE 28**

**FIGURE 29**

**FIGURE 30**

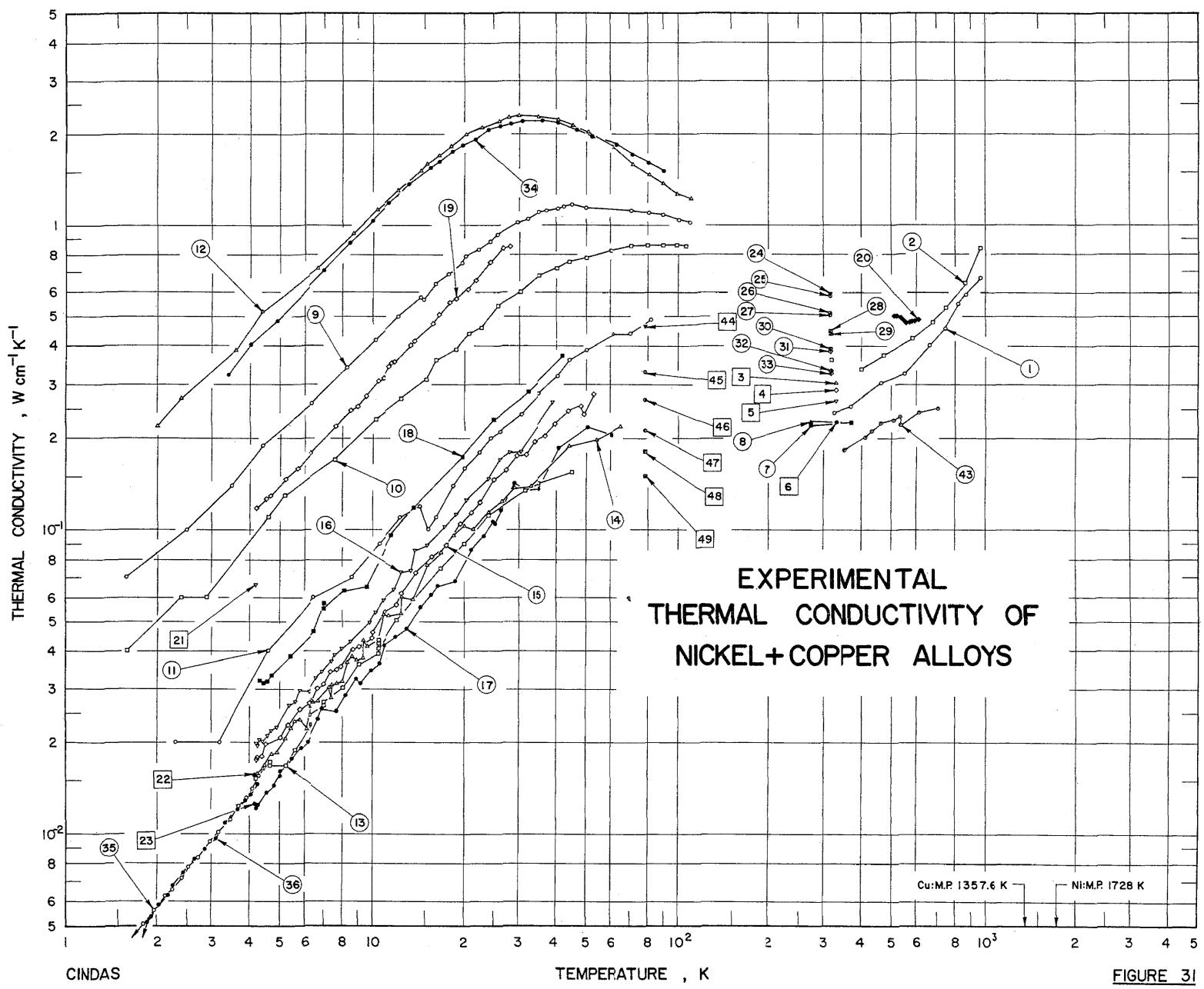


FIGURE 31

TABLE 12. THERMAL CONDUCTIVITY OF COPPER + NICKEL ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent)		Composition (continued), Specifications, and Remarks
							Cu	Ni	
1	49	Smith, C.S. and Palmer, E.W.	1935	L	293,473	Bar 107	99.73	0.28	0.03 Mg and 0.01 Fe; specimen 0.75 in. in diameter and 8 in. long; supplied by American Brass Co.; cold-rolled, annealed, and cold-drawn; annealed at 800 C for 2 hr; electrical conductivity 45.70 and $29.11 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 20 and 200 C, respectively.
2	49	Smith, C.S. and Palmer, E.W.	1935	L	293,473	Bar 108	99.47	0.54	0.04 Mg and 0.02 Fe; similar to the above specimen except electrical conductivity 39.94 and $26.86 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 20 and 200 C, respectively.
3	49	Smith, C.S. and Palmer, E.W.	1935	L	293,473	Bar 109	97.94	1.97	0.04 Mg and 0.02 Fe; similar to the above specimen except annealed at 800 C for 4 hr; electrical conductivity 22.71 and $17.58 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 20 and 200 C, respectively.
4	49	Smith, C.S. and Palmer, E.W.	1935	L	293,473	Bar 110	94.92	5.09	0.03 Mg and 0.01 Fe; similar to the above specimen except electrical conductivity 12.39 and $10.64 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 20 and 200 C, respectively.
5	49	Smith, C.S. and Palmer, E.W.	1935	L	293,473	Bar 111	89.90	10.07	0.03 Mg, 0.024 C, and 0.02 Fe; similar to the above specimen except electrical conductivity 7.07 and $6.46 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 20 and 200 C, respectively.
6	49	Smith, C.S. and Palmer, E.W.	1935	L	293,473	Bar 125	84.85	15.07	0.05 Fe, 0.03 Mn, and 0.01 Mg; similar to the above specimen except electrical conductivity 5.094 and $4.795 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 20 and 200 C, respectively.
7	49	Smith, C.S. and Palmer, E.W.	1935	L	293,473	Bar 124	69.54	30.23	0.13 Mn, 0.05 Fe, and 0.05 Mg; similar to the above specimen except electrical conductivity 2.754 and $2.730 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 20 and 200 C, respectively.
8	68	Zavaritskii, N.V. and Zeldovich, A.G.	1956	L	2.3-108	Russian cupro nickel NM-81; 7	81.0	19.0	Specimen in strip form cut from a 6 x 5 mm tube; measured in helium.
9	68	Zavaritskii, N.V. and Zeldovich, A.G.	1956	L	2.5-76	Russian cupro nickel NM-81; 6	81.0	19.0	The above specimen; annealed at 800 C; measured in helium.
10	77	Sager, G.F.	1930	P	321-984		≈79.8	20.0	0.2 Mn and trace Mg; ~0.25 cm in diameter and ~3.5 cm long; chill cast, hot rolled and cold drawn; annealed at 700 C for 12 hr; electrical conductivity 3.54, 3.46, 3.35, 3.21, 3.12, and $3.02 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 48, 150, 315, 462, 575, and 711 C, respectively.
11	77	Sager, G.F.	1930	P	335-991		≈59.8	40.0	Similar to the above specimen except electrical conductivity 1.99, 1.99, 1.96, and $1.92 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 62, 266, 510, and 717 C, respectively.
12	127	Barratt, T.	1914	F	273-373	Eureka	60.0	40.0	0.0995 cm diameter and 40.0 cm long; electrical resistivity 45.90 and $45.87 \mu\Omega \text{cm}$ at 0 and 100 C, respectively.
13	128	Grüneisen, E. and Goens, E.	1927	L	21,83	Cu 11	99.0	1.0	7 cm long and 0.1 to 0.3 cm wide; drawn; electrical resistivity 2.97, 1.60, and $1.295 \mu\Omega \text{cm}$ at 0, -190, and -252 C, respectively.
14	71	Wilkinson, K.R. and Wilks, J.	1949	L	10-20	Cupro-nickel	70	30	4.1 mm in O.D., 2.5 mm in I.D., and 21 mm long; supplied by Yorkshire Copper Works Ltd.; cold-worked.
15	69	Hulm, J.K.	1951	L	1.9-22		80	20	Average grain size 0.011 mm.
16	129	Jaeger, W. and Diesselhorst, H.	1900	E	291,375	Constantan	60	40	1.996 cm diameter and 27 cm long; density $8.92 \text{ g cm}^{-3}$ at 18 C; electrical conductivity 2.04 and $2.037 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 18 and 100 C, respectively.

TABLE 12. THERMAL CONDUCTIVITY OF COPPER + NICKEL ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION (continued)

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent)		Composition (continued), Specifications, and Remarks
							Cu	Ni	
17	130, 176	Zimmerman, J. E.	1951	L	3.3-78	CN 1	90	10	Cylindrical specimen 0.125 in. in diameter; machined from a forged bar; electrical resistivity 12.50, 12.72, and 14.68 $\mu\Omega$ cm at 19.7, 78.9, and 296 K, respectively.
18	130, 176	Zimmerman, J. E.	1951	L	3.0-77	CN 2	90	10	Cylindrical specimen 0.125 in. in diameter; cold-worked by rolling from 0.25 in. thick to 0.14 in. before being machined to size; electrical resistivity 12.65 and 14.69 $\mu\Omega$ cm at 76.2 and 296 K, respectively.
19	130, 176	Zimmerman, J. E.	1951	L	3.6-79	CN 3	90	10	Cylindrical specimen 0.125 in. in diameter; severely cold-worked; rolled from 0.5 in. <sup>2</sup> cross section to 0.22 x 0.24 in. before machining; electrical resistivity 12.63 and 14.65 $\mu\Omega$ cm at 78.7 and 298 K, respectively.
20	130, 176	Zimmerman, J. E.	1951	L	3.4-79	CN 4	90	10	Single crystal; cylindrical specimen 0.125 in. in diameter; electrical resistivity 13.0, 13.10, and 15.04 $\mu\Omega$ cm at 20.5, 79.3, and 298 K, respectively.
21	70	Berman, R.	1951	L	3.0-91	Constantan	60	40	317 36 gauge wires bound and soldered together at ends; electrical resistivity 44.3, 45.3, and 52.7 $\mu\Omega$ cm at 20, 90, and 290 K, respectively.
22	47	Hanson, D. and Rodgers, C.E.	1932	L	438.2		Bal.	0.78	Prepared from high grade electrolytic Cu with traces of impurities; 6.5 in. long and 0.5 in. in diameter; annealed at 900 C.
23	47	Hanson, D. and Rodgers, C.E.	1932	L	438.2		Bal.	1.57	Similar to the above specimen.
24	47	Hanson, D. and Rodgers, C.E.	1932	L	438.2		Bal.	2.76	Similar to the above specimen.
25	47	Hanson, D. and Rodgers, C.E.	1932	L	438.2		Bal.	4.9	Similar to the above specimen.
26	45	Smith, A.W.	1925	L	330.2		50	50	$\sim$ 5 cm long with cross section 0.3 cm <sup>2</sup> ; made from Cu (< 0.03 of total impurity) supplied by Baker by fusing with Ni (99.75 to 99.85 pure including cobalt) supplied by International Nickel Co. of America; electrical conductivity $1.98 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 25 C.
27	45	Smith, A.W.	1925	L	330.2		60	40	Similar to the above specimen except electrical conductivity $2.04 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 25 C.
28	45	Smith, A.W.	1925	L	330.2		70	30	Similar to the above specimen except electrical conductivity $2.48 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 25 C.
29	45	Smith, A.W.	1925	L	330.2		90	10	Similar to the above specimen except electrical conductivity $3.49 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 25 C.
30	131	Ellis, W.C., Morgan, F.L. and Sager, F.G.	1928	P	305.2	Advance	55	45	0.25 cm diameter and 35 cm long; density $8.78 \text{ g cm}^{-3}$ ; electrical conductivity $2.023 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 32 C; thermal conductivity value calculated from measured thermal diffusivity, specific heat capacity, and density.
31	132	Silverman, L.	1953	C	323-1174	Lohm	93.4	6.05	0.01 Mn and 0.01 Si; annealed at 900 C; advance used as comparative material.
32	133	Powers, R.W., Ziegler, J.B. and Johnston, H. L.	1951	L	26-295	Constantan	55	45	No details given.

TABLE 12. THERMAL CONDUCTIVITY OF COPPER + NICKEL ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION (continued)

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent)		Composition (continued), Specifications, and Remarks
							Cu	Ni	
33	63	Sedström, E.	1919	T	273, 373		89.94	10.06	Calculated composition; rolled and drawn to 1 mm thick; heated 0.5 hr close to melting point; electrical conductivity 6.2 and $6.1 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 0 and 100 C, respectively.
34	63	Sedström, E.	1919	T	273, 373		79.90	20.10	Similar to the above specimen except electrical conductivity 3.5 and $3.3 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 0 and 100 C, respectively.
35	63	Sedström, E.	1919	T	273, 373		60.02	39.98	Similar to the above specimen except electrical conductivity 2.0 and $2.0 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 0 and 100 C, respectively.
36	134	Aoyama, S. and Ito, T.	1940	L	78.2	8	29.89		0.03 Mn, 0.03 Fe, and traces of other impurities; prepared from electrolytic Ni (containing 0.53 Co, 0.05 Fe, and 0.02 Al) and electrolytic Cu (containing 0.015 Sb, 0.01 Fe, 0.007 S, and trace of P) by fusing; 4.00 mm in diameter and 60.0 mm long; electrical resistivity $40.3 \mu\Omega$ cm at -195 C.
37	134	Aoyama, S. and Ito, T.	1940	L	78.2	9	19.83		0.04 Mn, 0.02 Fe, and traces of other impurities; the same original materials and dimensions as the above specimen; electrical resistivity $27.1 \mu\Omega$ cm at -195 C.
38	134	Aoyama, S. and Ito, T.	1940	L	78.2	10	13.84		0.11 Fe and trace Mn; the same original materials and dimensions as the above specimen; electrical resistivity $17.6 \mu\Omega$ cm at -195 C.
39	134	Aoyama, S. and Ito, T.	1940	L	78.2	11	9.47		0.14 Fe, traces of Mn and other impurities; the same original materials and dimensions as the above specimen; electrical resistivity $11.9 \mu\Omega$ cm at -195 C.
40	134	Aoyama, S. and Ito, T.	1940	L	78.2	12	3.67		0.09 Fe and traces of other impurities; the same original materials and dimensions as the above specimen; electrical resistivity $3.43 \mu\Omega$ cm at -195 C.
41	134	Aoyama, S. and Ito, T.	1940	L	78.2	13	98.94	1.03	0.03 Fe and traces of other impurities; the same original materials and dimensions as the above specimen; electrical resistivity $1.039 \mu\Omega$ cm at -195 C.
42	135	Grüneisen, E.	1900	L	291.2		54	46	Density $8.89 \text{ g cm}^{-3}$ ; electrical conductivity $1.99 \times 10^5 \Omega^{-1} \text{ cm}^{-1}$ at 18 C.
43	144	Mikryukov, V.E.	1957		336-825		99.05	0.70	0.1 Be and 0.15 Cc; electrical conductivity 25.8, 23.1, 20.4, 18.25, 16.5, 15.67, and $14.33 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 63.0, 114.6, 195, 273, 375.8, 433.5, and 551.3 C, respectively.
44	136	Mikryukov, V.E.	1957		333-900	Bal.	0.90		0.10 Be and 0.10 Zr; electrical resistivity 3.34, 3.85, 4.33, 5.21, 5.78, 6.38, 7.05, and $8.14 \mu\Omega$ cm at 59.4, 115.6, 171.5, 291.6, 365.6, 457, 534.5, and 626.5 C, respectively.
45	136	Mikryukov, V.E.	1957		336-947	Bal.	0.80		0.20 Ti; electrical resistivity 4.25, 4.83, 5.56, 6.01, 6.46, 6.57, 7.18, 7.28, 7.66, 8.93, and $9.78 \mu\Omega$ cm at 62.8, 130.9, 217.5, 290.6, 462.5, 440.3, 580.3, 538.3, 674.3, 618.0, and 673.6 C, respectively.
46	136	Mikryukov, V.E.	1957		345-923	Bal.	0.55		0.17 Zr; electrical resistivity 3.45, 4.13, 4.43, 5.10, 5.32, 5.78, 6.20, 6.83, 7.20, and $8.07 \mu\Omega$ cm at 71.8, 158.7, 201.0, 291.0, 331.0, 401.4, 473.6, 534.5, 575.0, and 649.5 C, respectively.
47	137	Chubb, W.F.	1938	L	273-403	Bal.	0.204		$\approx 0.079 \Omega$ ; specimen 50.6 cm long.
48	137	Chubb, W.F.	1938	L	273-403	Bal.	0.303		$\approx 0.079 \Omega$ ; specimen 50.6 cm long.
49	137	Chubb, W.F.	1938	L	273-403	Bal.	0.508		$\approx 0.079 \Omega$ ; specimen 50.6 cm long.

TABLE 12. THERMAL CONDUCTIVITY OF COPPER + NICKEL ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION (continued)

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent)		Composition (continued), Specifications, and Remarks
							Cu	Ni	
50	137	Chubb, W. F.	1938	L	273-403		Bal.	0.303	0.0042 Fe, 0.0014 Pb, trace Sn and Zn; specimen 50.6 cm long.
51	137	Chubb, W. F.	1938	L	273-403		Bal.	0.508	≈0.022 O; specimen 50.6 cm long.
52	74	Erdmann, J. C. and Jahoda, J. A.	1968	L	4.2-70	Cu 98		2.29	Single crystal; 6.0-7.5 mm diameter and 12 cm long; prepared by electron beam float zoning; supplied by Materials Research Corp.; residual electrical resistivity 2.17 $\mu\Omega\text{cm}$ ; measured in a vacuum of $10^{-6}$ mm Hg.
53	74	Erdmann, J. C. and Jahoda, J. A.	1968	L	4.2-51	Cu 96		4.05	Similar to the above specimen except residual electrical resistivity 4.95 $\mu\Omega\text{cm}$ .
54	74	Erdmann, J. C. and Jahoda, J. A.	1968	L	4.2-71	Cu 91		9.30	0.025 Al; polycrystalline; 5.0 mm in diameter and 10 cm long; vacuum cast ingot hammer forged, hot rolled to 18 mm diameter and rough turned, the rough swaged to 10 mm in diameter, then machined to size; annealed at 930°C for 24 hr in the argon furnace and allowed to cool slowly; residual electrical resistivity 11.22 $\mu\Omega\text{cm}$ ; measured in a vacuum of $10^{-6}$ mm Hg.
55	74	Erdmann, J. C. and Jahoda, J. A.	1968	L	4.2-54	Cu 72		27.96	0.023 Al; similar to the above specimen except residual electrical resistivity 33.38 $\mu\Omega\text{cm}$ .
56	138	Kummer, D. L., Rosenthal, J. J. and Lütt, D. W.	1965	C	498-849	Constantan, No. 103	~60	~40	Thermocouple grade; 1 in. diameter and 1 in. thick; Armco iron used as comparative material.
57	138	Kummer, D. L., et al.	1965	C	539-906	Constantan, No. 103	~60	~40	2.5 in. O.D., 0.75 in. I.D., and 3 in. long.
58	139	Carroll, J. M.	1964	C	492-850	Constantan; Specimen No. 1	~60	~40	Thermocouple grade; 1 in. in diameter and 1 in. long; Armco iron used as comparative material.
59*	139	Carroll, J. M.	1964	C	499-850	Constantan; Specimen No. 2	~60	~40	Similar to the above specimen.
60	139	Carroll, J. M.	1964	R	693-1044	Constantan; Specimen No. 1	~60	~40	Thermocouple grade; 0.25 in. I.D., 1 in. O.D., and 1 in. long.
61	139	Carroll, J. M.	1964	R	622-1175	Constantan; Specimen No. 3	~60	~40	Similar to the above specimen.
62	73	Erdmann, J. C. and Jahoda, J. A.	1964	L	4.2	Ko	Bal.	~40	Polycrystalline; wire specimen 1.35 to 1.45 mm in diameter and 125 mm long; obtained from International Nickel Co.; vacuum cast ingot hammer forged; hot rolled to 18.5 mm diameter, rough turned, cold rolled to 6 mm diameter and drawn to 1.5 mm diameter, cut; annealed at 1000°C for 24 hr, slowly cooled in the furnace over a period of 6 hr, electro-polished; electrical resistivity 42.3 $\mu\Omega\text{cm}$ at 4.2 K.
63	73	Erdmann, J. C. and Jahoda, J. A.	1964	L	4.2	666	Bal.	9.3	0.025 Al; polycrystalline; same dimensions, supplier, and fabrication method as the above specimen; electrical resistivity 10.94 $\mu\Omega\text{cm}$ at 4.2 K.
64	73	Erdmann, J. C. and Jahoda, J. A.	1964	L	4.2	664	Bal.	4.74	<0.1 each of Fe, Mg, and Mn, and 0.043 Al; polycrystalline; same dimensions, supplier, and fabrication method as the above specimen; electrical resistivity 7.04 $\mu\Omega\text{cm}$ at 4.2 K.
65	73	Erdmann, J. C. and Jahoda, J. A.	1964	L	4.2	868	Bal.	1.96	Polycrystalline; same dimensions, supplier, and fabrication method as the above specimen; electrical resistivity 2.17 $\mu\Omega\text{cm}$ at 4.2 K.

\* Not shown in figure.

TABLE 12. THERMAL CONDUCTIVITY OF COPPER + NICKEL ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION (continued)

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent)		Composition (continued), Specifications, and Remarks
							Cu	Ni	
66	140	Erimann, J. C. and Jahoda, J. A.	1968	L	4.6-78	Cu 72 Ni 28	72	28	Poly-crystalline; 1.35 to 1.45 mm in diameter and 130 mm long; obtained from International Nickel Co., Inc.; vacuum cast ingot hammer forged, hot-rolled to 18.5 mm diameter, rough turned, cold-rolled to 6 mm diameter and drawn to 1.5 mm diameter, cut, annealed in argon atmosphere at 1000°C for 24 hr, slowly cooled in the furnace over a period of 6 hr, electropolished; grain size 50 to 200 μ.
67	83	Kierspe, W.	1967	L	293.2			1.85	Cylindrical specimen; electrical resistivity 2.246, 2.2492, 2.2521, 2.2662, 2.2993, 2.3492, 2.4812, 2.5802, 2.7301, 2.8818, 3.0326, 3.1811, 3.3266, 3.4710, 3.6146, 3.7563, 3.8972, and 3.9674 μΩ cm at 4.2, 10, 20, 30, 40, 50, 70, 83, 103, 128, 143, 163, 183, 203, 223, 243, 263, and 273 K, respectively.
68	72, 141	Erimann, J. C. and Jahoda, J. A.	1962	E	4.2	Constantan	60	40	Commercial alloy; about 1 to 3 mm in diameter and about 100 mm long; annealed; measured in different strain conditions.
69	132	Silverman, L.	1953	C	323-1173	Advance	54.79	44.04	1.20 Mn, 0.035 C, and 0.003 Si; cylindrical bar specimen; annealed at 900°C; lead used as comparative material; smoothed values reported.
70	142	Zlunitsyn, S. and Savel'ev, I.V.	1939	L	18-290	Cupronickel	77.44	20.48	1.99 Zn; 4.97 mm O.D., 4.16 mm I.D., and 87 mm long.
71	144, 145	Mikryukov, V.E.	1957	E	321-1002		99.03	0.60	0.27 Zr and 0.1 P; electrical conductivity 36.70, 32.15, 27.61, 24.70, 21.70, 19.34, 17.54, 15.80, 14.56, 13.36, 12.64, and $11.38 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 47.3, 94.0, 155.5, 211.0, 283.5, 354.3, 432.1, 493.8, 560.5, 616.3, 655.1, and 729.0°C, respectively.
72	144, 145	Mikryukov, V.E.	1957	E	334-884		98.99	0.60	0.26 Zr and 0.15 Sn; electrical conductivity 32.00, 28.95, 24.82, 22.12, 20.71, 18.47, 17.43, 16.23, and $15.00 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 61.0, 106.5, 193.0, 281.5, 331.3, 442.0, 482.0, 544.0, and 611.0°C, respectively.
73	136	Mikryukov, V.E.	1957	E	336-948		99.0	0.80	0.20 Ti; electrical conductivity 23.50, 20.50, 17.97, 16.65, 15.48, 15.20, 14.91, 13.72, 11.20, and $10.22 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 62.8, 130.9, 217.5, 290.6, 362.5, 440.3, 538.3, 580.3, 618.0, and 673.6°C, respectively.
74	136	Mikryukov, V.E.	1957	E	329-774		98.35	0.40	0.25 P; electrical conductivity 19.96, 18.60, 17.35, 15.44, 16.22, and $13.40 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 56.0, 118.8, 201.0, 316.0, 422.0, and 500.5°C, respectively.
75	136	Mikryukov, V.E.	1957	E	370-920		98.50	1.20	0.30 Si; electrical conductivity 15.02, 14.20, 13.87, 12.25, 11.86, 12.65, 13.13, 11.35, 9.11, and $8.06 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 96.6, 135.6, 184.8, 279.0, 333.1, 413.0, 429.0, 493.3, 570.0, and 646.6°C, respectively.
76	136	Mikryukov, V.E.	1957	E	331-815		98.73	0.80	0.33 Zr and 0.14 Be; electrical conductivity 25.70, 23.10, 22.00, 19.85, 17.30, 15.60, 14.60, and $13.65 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 58.0, 123.0, 136.0, 195.8, 290.3, 405.6, 493.0, and 542.0°C, respectively.
77	136	Mikryukov, V.E.	1957	E	333-910		98.53	1.0	0.33 Zr and 0.14 Be; electrical conductivity 24.65, 22.00, 19.35, 17.13, 16.20, 15.32, 12.75, and $11.35 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 60.0, 117.0, 195.8, 282.0, 354.3, 442.0, 544.8, and 637.0°C, respectively.
78	136	Mikryukov, V.E.	1957	E	326-974		99.13	0.62	0.25 Zr; electrical conductivity 29.3, 24.7, 21.1, 18.4, 17.2, 16.8, 14.8, 12.9, and $11.7 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 52.6, 131.5, 225.4, 325.3, 403.8, 435.9, 533.9, 635.7, and 701.1°C, respectively.

TABLE 12. THERMAL CONDUCTIVITY OF COPPER + NICKEL ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION (continued)

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent)		Composition (continued), Specifications, and Remarks
							Cu	Ni	
79	136	Mikryukov, V.E.	1957	E	333-855		49.3	0.28	0.24 Zr and 0.18 Be; electrical conductivity 26.10, 22.90, 19.50, 17.46, 15.30, 14.34, 13.40, and $12.12 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 59.8, 119.5, 216.8, 302.6, 383.0, 455.1, 522.0, and 581.6 C, respectively.
80	134	Aoyama, S. and Ito, T.	1940	L	78.2	6	Bal.	49.45	0.26 Co, 0.06 Fe, 0.05 Mn, 0.01 Al, 0.008 Sb, 0.004 S, and trace Pb (calculated composition); electrical resistivity $54.9 \mu\Omega \text{cm}$ .
81	134	Aoyama, S. and Ito, T.	1940	L	78.2	7	Bal.	39.6	0.21 Co, 0.07 Fe, 0.02 Mn, 0.009 Sb, 0.008 Al, 0.004 S, and trace Pb (calculated composition); electrical resistivity $51.4 \mu\Omega \text{cm}$ .
82*	143	Fairbank, H.A. and Lee, D.M.	1960	L	0.28-4.0	Cupronickel	69.60	30.0	0.40 Fe; nominal composition; supplied by Anaconda; drawn into 0.0622 in. O.D. and 0.0567 in. I.D.
83	143	Mikryukov, V.Ye.	1958	E	340-827		Bal.	0.7	0.15 Co, 0.15 Fe, 0.1 Be, and 0.1 C; electrical resistivity 3.99, 4.29, 5.01, 5.60, 5.98, 6.37, 3.93, 7.55, and $9.32 \mu\Omega \text{cm}$ at 65, 115, 196, 275, 380, 440, 511, 589, and 700 C, respectively.
84	73	Erdmann, J.C. and Jahoda, J.A.	1964	L	4.2	667	Bal.	27.96	<1.0 each Mn, Mg, Fe, and 0.023 Al; polycrystalline; wire specimen 1.35 to 1.45 mm in diameter and 125 mm long; obtained from International Nickel Co.; vacuum cast ingot hammer forged, hot rolled to 18.5 mm diameter, rough turned, cold rolled to 6 mm diameter and drawn to 1.5 mm diameter, cut; annealed at 1000 C for 24 hr, cooled slowly in the furnace over a period of 6 hr, electropolished; electrical resistivity $32.3 \mu\Omega \text{cm}$ at 4.2 K.
85	49	Smith, C.S. and Palmer, E.W.	1935	L	293,473	Bar 39	79.68	19.79	0.30 Mn and 0.23 Fe; 0.75 in. diameter and 8 in. long; cold-rolled to 1.25 in. in diameter, annealed, cold-drawn to size; heat-treated at 800 C; electrical conductivity 3.755 and $3.600 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 20 and 200 C, respectively.
86	49	Smith, C.S. and Palmer, E.W.	1935	L	293,473	Bar 66	96.05	3.01	0.88 Si and 0.04 Fe; 0.75 in. diameter and 8 in. long; cold-rolled to 1.25 in. in diameter, annealed, cold-drawn to size; heat-treated at 870 C for 3 hr, quenched; electrical conductivity 9.775 and $9.140 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 20 and 200 C, respectively.
87	49	Smith, C.S. and Palmer, E.W.	1935	L	293,473	Bar 66A			Similar to the above specimen except reheated after quenching at 500 C for 2 hr; electrical conductivity 20.69 and $16.38 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 20 and 200 C, respectively.
88	49	Smith, C.S. and Palmer, E.W.	1935	L	293,473	Bar 66B			Similar to the above specimen bar 66 (Curve No. 86) except cooled slowly after heat-treatment at 870 C; electrical conductivity 22.60 and $17.34 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 20 and 200 C, respectively.
89	123	Materials in Design Engineering	1959		292.2	Cupro-nickel	68.9	30	0.6 Mn and 0.5 Fe; nominal composition; density $8.94 \text{ g cm}^{-3}$ ; electrical resistivity $37 \mu\Omega \text{cm}$ at 20 C.
90	123	Materials in Design Engineering	1959		292.2	Cupro-nickel	88.35	10	1.25 Fe and 0.4 Mn; nominal composition; density $8.94 \text{ g cm}^{-3}$ ; electrical resistivity $15 \mu\Omega \text{cm}$ at 20 C.
91	146	Willett, R.E.	1968	C	378-463	Copper-Nickel (706) alloy	88.08	10.07	1.18 Fe, 0.67 Mn, <0.10 Zn, and <0.02 Pb; annealed at 750 C and cooled by waterfall spray at the exit end of the furnace; Armco iron used as comparative material; equilibrium 1.
92	146	Willett, R.E.	1968	C	701-969	Copper-Nickel (706) alloy			The above specimen; equilibrium 2.
93	146	Willett, R.E.	1968	C	388-466	Copper-Nickel (706) alloy			The above specimen; equilibrium 3.

\* Not shown in figure.

TABLE 12. THERMAL CONDUCTIVITY OF COPPER + NICKEL ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION (continued)

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent) Cu      Ni	Composition (continued), Specifications, and Remarks
94	146	Willett, R. E.	1968	C	447-558	Copper-Nickel (706) alloy	88.08 10.07	1.18 Fe, 0.67 Mn, < 0.10 Zn, and < 0.02 Pb; the above specimen; equilibrium 4.
95	146	Willett, R. E.	1968	C	557-738	Copper-Nickel (706) alloy		The above specimen; equilibrium 5.
96	146	Willett, R. E.	1968	C	391-686	Copper-Nickel (706) alloy		Similar to the above specimen except annealed at 750 C for 1 hr and water quenched.
97	146	Willett, R. E.	1968	C	377-1017	Copper-Nickel (706) alloy		Similar to the above specimen except annealed at 750 C for 1 hr and furnace cooled.
98	146	Willett, R. E.	1968	C	382-1020	Copper-Nickel (710) alloy	77.75 20.67	0.81 Fe, 0.55 Mn, 0.20 Zn, 0.01 Pb, and 0.017 C; annealed at 750 C and cooled by waterfall spray at the exit end of the furnace; Armco iron used as comparative material.
99	146	Willett, R. E.	1968	C	406-927	Copper-Nickel (715) alloy; 1	68.33 30.72	0.53 Fe, 0.41 Mn, < 0.10 Zn, 0.026 C, and < 0.005 Pb; annealed at 650 C and cooled by waterfall spray at the exit end of the furnace; Armco iron used as comparative material.
100	146	Willett, R. E.	1968	C	365-949	Copper-Nickel (715) alloy; 2	68.29 30.57	0.59 Mn, 0.51 Fe, 0.36 C, < 0.10 Zn, and 0.005 Pb; similar to the above specimen except annealed at 750 C.
101	146	Willett, R. E.	1968	C	385-948	Copper-Nickel (715) alloy	68.40 29.94	0.62 Fe, 0.50 Zn, 0.46 Mn, 0.063 C, and 0.010 Pb; similar to the above specimen.
102	146	Willett, R. E.	1968	C	380-991	Copper-Nickel (715) alloy	68.60 29.94	0.61 Fe, 0.48 Mn, 0.30 Zn, 0.059 C, and 0.007 Pb; similar to the above specimen except annealed at 1000 C and water quenched.
103	76	Bouley, A., Linz, R., 1974 Kluffky, R., Damon, D.H., and Mohan, N.S.			11-40		3.71	Calculated composition from atomic percent; annealed at $1075 \pm 5$ C for 72 hrs and slowly cooled afterwards in 18 hrs; residual electrical resistivity reported as $4.92 \mu\Omega \text{cm}$ .
104	76	Bouley, A., et al.	1974		10-41		3.71	Calculated composition from atomic percent; heavily swaged; residual electrical resistivity reported as $4.54 \mu\Omega \text{cm}$ .

TABLE 13. THERMAL CONDUCTIVITY OF NICKEL + COPPER ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent) Ni Cu	Composition (continued), Specifications, and Remarks
1	77	Sager, G. F.	1930	P	325-970		60 40	0.2 Mn and 0.17 Mg; 2 mm diameter and 35 cm long; prepared from Mond nickel by fusing, chill-casting, hot-rolling, and cold-drawing; annealed at 700 C for 12 hr; density 8.81 g cm <sup>-3</sup> ; electrical conductivity 1.88, 1.86, 1.85, 1.82, 1.81, 1.78, 1.76, 1.75, and 1.72 x 10 <sup>4</sup> Ω <sup>-1</sup> cm <sup>-1</sup> at 26, 133, 204, 386, 467, 580, 642, 690, and 756 C, respectively; thermal conductivity values calculated from measured thermal diffusivity, specific heat capacity, and density.
2	77	Sager, G. F.	1930	P	317-966		80 20	Similar to above except density 8.82 g cm <sup>-3</sup> and electrical conductivity 3.60, 3.06, 2.90, 2.72, 2.67, 2.48, 2.40, 2.33, 2.27, 2.22, 2.17, 2.12, 2.04, 1.97, and 1.92 x 10 <sup>4</sup> Ω <sup>-1</sup> cm <sup>-1</sup> at 26, 76, 91, 126, 131, 164, 184, 231, 291, 331, 396, 451, 546, 668, and 744 C, respectively.
3	45	Smith, A. W.	1925	L	330		80 20	Prepared by fusing Ni (99.75 to 99.85 pure); supplied by International Nickel Co., and 99.97 <sup>+</sup> pure Cu, supplied by Baker; ~5.5 cm long and 0.3 cm <sup>2</sup> in cross-sectional area; electrical conductivity 3.00 x 10 <sup>4</sup> Ω <sup>-1</sup> cm <sup>-1</sup> at 25 C.
4	45	Smith, A. W.	1925	L	330		70 30	Similar to the above specimen except electrical conductivity 2.17 x 10 <sup>4</sup> Ω <sup>-1</sup> cm <sup>-1</sup> at 25 C.
5	45	Smith, A. W.	1925	L	330		60 40	Similar to the above specimen except electrical conductivity 2.02 x 10 <sup>4</sup> Ω <sup>-1</sup> cm <sup>-1</sup> at 25 C.
6	45	Smith, A. W.	1925	L	330		50 50	Similar to the above specimen except electrical conductivity 1.98 x 10 <sup>4</sup> Ω <sup>-1</sup> cm <sup>-1</sup> at 25 C.
7	63	Sedström, E.	1919	T	273, 373		60.93 39.07	Rolled and drawn; annealed at close to melting point for 0.5 hr.
8	63	Sedström, E.	1919	T	273, 373		81.63 18.37	Similar to the above specimen.
9	78	Greig, D. and Harrison, J. P.	1965	E	1.6-111	C	0.65	Cylindrical specimen, 4 mm in diameter; calculated composition from atomic composition; supplied by Johnson Matthey and Co.; chill cast from J.M. 890 Ni and J.M. 30 Cu; annealed at 850 C for 12 hr; small grains; very fine grain boundaries; electrical resistivities are estimated from reported Lorenz number L and thermal conductivity k as 0.504, 0.594, 0.582, 0.625, 0.622, 0.636, 0.638, 0.684, 0.664, 0.679, 0.685, 0.669, 0.688, 0.707, 0.694, 0.709, 0.736, 0.738, 0.764, 0.793, 0.809, and 0.830 μΩ cm at 1.6, 2.5, 4.4, 6.4, 8.3, 10.3, 12.3, 14.9, 16.3, 17.9, 19.7, 20.3, 22.2, 24.4, 25.6, 29.8, 32.2, 35.1, 37.4, 40.6, 42.5, and 45.3 K, respectively.
10	78	Greig, D. and Harrison, J. P.	1965	E	1.6-107	D	1.62	Similar to the above specimen; long grains running in one direction, very thick (~0.05 mm) grain boundaries; electrical resistivities are estimated from reported Lorenz number L and thermal conductivity k as 0.963, 1.006, 1.115, 1.299, 1.299, 1.356, 1.441, 1.327, 1.445, 1.425, 1.468, 1.407, 1.471, 1.447, 1.513, 1.551, 1.626, 1.813, 2.097, 2.297, and 2.623 μΩ cm at 1.6, 2.4, 5.2, 7.6, 10.2, 12.5, 15.1, 16.2, 18.9, 20.7, 22.8, 25.7, 30.5, 35.3, 40.2, 45.4, 50.4, 60.3, 80.4, 90.2, and 101.7 K, respectively.

TABLE 13. THERMAL CONDUCTIVITY OF NICKEL + COPPER ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION (continued)

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent) Ni Cu	Composition (continued), Specifications, and Remarks
11	78	Greig, D. and Harrison, J.P.	1965	E	2.3-82.1	E	4.53	Similar to the above specimen; various sizes of grain; various thickness of grain boundaries; electrical resistivities are estimated from reported Lorenz number L and thermal conductivity k as 2.997, 4.318, 3.344, 3.337, 3.804, 3.757, 3.703, 3.912, 5.096, 4.963, 4.422, 4.276, 4.261, 4.166, 4.268, 4.366, 4.211, 4.190, 4.096, 4.129, 4.288, 4.808, 4.929 $\mu\Omega$ cm at 2.3, 3.2, 4.6, 6.5, 8.6, 10.6, 12.5, 14.4, 15.4, 16.3, 18.5, 20.1, 22.4, 24.4, 26.1, 30.6, 35.0, 40.4, 45.2, 50.2, 61.7, 70.1, and 82.1 K, respectively.
12	78	Greig, D. and Harrison, J.P.	1965	E	2.0-111	F	0.35	Similar to the above specimen; mostly small grains, but few long grains running from center; electrical resistivities are estimated from reported Lorenz number L and thermal conductivity k as 0.219, 0.199, 0.225, 0.224, 0.220, 0.225, 0.230, 0.227, 0.228, 0.244, 0.244, 0.250, 0.255, 0.264, 0.289, 0.328, 0.361, 0.414, 0.541, 0.712, 0.873, 1.084, and 1.323 $\mu\Omega$ cm at 2.6, 4.4, 6.7, 8.7, 10.4, 12.3, 14.6, 16.7, 18.2, 20.3, 23.3, 25.8, 28.0, 25.8, 28.0, 30.1, 35.2, 40.9, 45.5, 51.0, 62.1, 71.8, 81.3, 90.3, and 100.8 K, respectively.
13	74	Erdmann, J.C. and Jahoda, J.A.	1968	→	4.2-45	Cu 49	50.50 49.47	0.030 Al; polycrystalline; 5.0 mm diameter and 10 cm long; supplied by International Nickel Co., Inc; vacuum cast ingot hammer forged, hot-cast rolled to 18 mm diameter and rough turned; swaged to 10 mm diameter, and machined to size; annealed at 930 C for 24 hr in argon furnace and cooled slowly; residual electrical resistivity 46.10 $\mu\Omega$ cm; measured in a vacuum of $10^{-6}$ mm Hg.
14	74	Erdmann, J.C. and Jahoda, J.A.	1968	→	4.2-65	Ni 65	64.87 Bal.	0.051 Al; similar to above except residual electrical resistivity 27.62 $\mu\Omega$ cm.
15	74	Erdmann, J.C. and Jahoda, J.A.	1968	→	4.2-53	Ni 85	84.70 Bal.	0.054 Al; similar to above except residual electrical resistivity 11.14 $\mu\Omega$ cm.
16	74	Erdmann, J.C. and Jahoda, J.A.	1968	→	4.2-39	Ni 90	90.24 Bal.	0.060 Al; similar to above except residual electrical resistivity 8.24 $\mu\Omega$ cm.
17	74	Erdmann, J.C. and Jahoda, J.A.	1968	→	4.2-61	Ni 91	91.05 Bal.	0.046 Al; similar to above except residual electrical resistivity 15.88 $\mu\Omega$ cm.
18	74	Erdmann, J.C. and Jahoda, J.A.	1968	→	4.3-42	Ni 96	95.60 Bal.	Similar to above except residual electrical resistivity 3.91 $\mu\Omega$ cm.
19	74	Erdmann, J.C. and Jahoda, J.A.	1968	→	4.2-28	Ni 98	99.35 Bal.	Single crystal; 6.0-7.5 mm in diameter and 12 cm long; supplied by Materials Research Corp; prepared by electron beam float zoning; residual electrical resistivity 0.907 $\mu\Omega$ cm; measured in a vacuum of $10^{-6}$ mm Hg.
20	147	Jackson, P.J. and Saunders, N.H.	1968		514-614		Bal. 8.7	Polycrystalline; prepared from 4 N purity Ni and Cu; annealed; Curie point 278 C.
21	73	Erdmann, J.C. and Jahoda, J.A.	1964	L	4.2	131	Bal. 2.03	Polycrystalline; wire specimen 1.35 to 1.45 mm in diameter and 125 mm long; obtained from International Nickel Co.; vacuum cast ingot hammer forged, hot-rolled to 18.5 mm in diameter, rough turned, cold rolled to 6 mm diameter and drawn to 1.5 mm diameter, cut; annealed at 1000 C for 24 hr, slowly cooled in the furnace for a period of 6 hr, electro-polished; grain size 50 to 250 $\mu$ ; electrical resistivity 1.65 $\mu\Omega$ cm at 4.2 K.

TABLE 13. THERMAL CONDUCTIVITY OF NICKEL + COPPER ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION (continued)

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent)		Composition (continued), Specifications, and Remarks
							Ni	Cu	
22	73	Erdmann, J. C. and Jahoda, J. A.	1964	L	4.2	670	84.7	Bal.	<0.1 each of Fe and Mn, 0.054 Al, and 0.02 C; polycrystalline; same supplier and fabrication method as the above specimen; electrical resistivity 10.64 $\mu\Omega$ cm at 4.2 K.
23	73	Erdmann, J. C. and Jahoda, J. A.	1964	L	4.2	669	64.87	Bal.	0.051 Al, 0.013 C, and <0.01 Fe; polycrystalline; same supplier and fabrication method as the above specimen; electrical resistivity 27.8 $\mu\Omega$ cm at 4.2 K.
24	148	Burger, R., Dittrich, H., and Koch, K.M.	1968	E	316.2		95	5	Prepared from 99.98 pure nickel; measured in transverse magnetic fields ranging from 0.48 to 10.63 kOe; reported data taken from smooth curve.
25	148	Burger, R., et al.	1968	E	316.2				The above specimen measured in longitudinal magnetic fields ranging from 0.16 to 10.59 kOe; smoothed values reported.
26	148	Burger, R., et al.	1968	E	316.2		90	10	Prepared from 99.98 pure nickel; measured in transverse magnetic fields ranging from 0.49 to 10.48 kOe; smoothed values reported.
27	148	Burger, R., et al.	1968	E	316.2				The above specimen measured in longitudinal magnetic fields ranging from 0.17 to 10.48 kOe; smoothed values reported.
28	148	Burger, R., et al.	1968	E	316.2		85	15	Prepared from 99.98 pure nickel; measured in transverse magnetic fields ranging from 0.47 to 10.50 kOe; smoothed values reported.
29	148	Burger, R., et al.	1968	E	316.2				The above specimen measured in longitudinal magnetic fields ranging from 0.19 to 10.47 kOe; smoothed values reported.
30	148	Burger, R., et al.	1968	E	316.2		80	20	Prepared from 99.98 pure nickel; measured in transverse magnetic fields ranging from 0.45 to 10.39 kOe; smoothed values reported.
31	148	Burger, R., et al.	1968	E	316.2				The above specimen measured in longitudinal magnetic fields ranging from 0.29 to 10.42 kOe; smoothed values reported.
32	148	Burger, R., et al.	1968	E	316.2		75	25	Prepared from 99.98 pure nickel; measured in transverse magnetic fields ranging from 0.48 to 10.34 kOe; smoothed values reported.
33	148	Burger, R., et al.	1968	E	316.2				The above specimen measured in longitudinal magnetic fields ranging from 0.33 to 10.46 kOe; smoothed values reported.
34	81	Farrell, T. and Greig, D.	1969	L	3.4-90		0.34		~3 mm diameter and 9 cm long; supplied by Metals Research Ltd.; annealed at 850 C for 15 hr; residual electrical resistivity 0.247 $\mu\Omega$ cm; electrical resistivity 6.67 $\mu\Omega$ cm at 0 C.
35	149	Berger, L.	1969	L	1.7-4.3		Bal.	35	Polycrystalline from Johnson Matthey Ni and Cu, vacuum melted, swaged, homogenized for 48 hr at 1200 C in purified helium, and furnace cooled.
36	149	Berger, L.	1969	L	1.5-4.3				The above specimen measured in a constant longitudinal field of 58.9 kG.
37*	106, 177	Yelon, W. B. and Berger, L.	1970	L	1.6-4.3		33.4		Prepared by melting high-purity Johnson Matthey metal in a vacuum of $6 \times 10^{-6}$ torr, after cooling, machining to round rod, homogenizing at 1300 C for 2400 hr, in helium, annealing in a vacuum of $10^{-5}$ torr at 1100 C for 0.5 hr, swaging to 0.797 cm in diameter, again annealing in a vacuum of $6 \times 10^{-6}$ torr at 750 C for 1 hr; grain size C. 1~0.5 mm; electrical resistivity 23.4 $\mu\Omega$ cm at 4.2 K; run 7.
38*	106, 177	Yelon, W. G. and Berger, L.	1970	L	1.7-4.3				The above specimen; run 8.

\* Not shown in figure.

TABLE 13. THERMAL CONDUCTIVITY OF NICKEL + COPPER ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION (continued)

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent) Ni Cu	Composition (continued), Specifications, and Remarks
39*	106, 177	Yelon, W. B. and Berger, L.	1970	L	2.3-21			The above specimen measured in a parallel magnetic field of 58.96 kG; run 10.
40*	106, 177	Yelon, W. B. and Berger, L.	1970	L	1.4-2.1			The above specimen measured without the magnetic field; run 11.
41*	106, 177	Yelon, W. B. and Berger, L.	1970	L	1.4-4.3			The above specimen; run 9.
42*	106, 177	Yelon, W. B. and Berger, L.	1970	L	2.1-21			The above specimen; run 12.
43	150	Donaldson, J. W.	1939	L	353-701	"K" Monel	66.73 29.76	2.50 Al, 0.35 Fe, 0.25 Si, 0.20 C, and 0.21 Mn; rolled and annealed.
44	134	Aoyama, S. and Ito, T.	1940	L	78	No. 0	94.77 4.36	0.51 Co, 0.26 Mn, 0.08 Fe, 0.02 Al, 0.001 Sb, 0.0004 S, and trace Pb (calculated composition); 4.00 mm diameter and 60.0 mm long; cast, hot-rolled, then machined to size; electrical resistivity 5.00 $\mu\Omega$ cm at 78 K.
45	134	Aoyama, S. and Ito, T.	1940	L	78	No. 1	90.43 8.85	0.48 Co, 0.13 Mn, 0.09 Fe, 0.02 Al, 0.001 Sb, 0.0007 S, and trace Pb (calculated composition); 4.00 mm diameter and 60.0 mm long; cast, hot-rolled, machined to size; electrical resistivity 8.50 $\mu\Omega$ cm at 78 K.
46	134	Aoyama, S. and Ito, T.	1940	L	78	No. 2	85.62 13.71	0.46 Co, 0.10 Mn, 0.094 Fe, 0.017 Al, 0.002 Sb, 0.001 S, and trace Pb (calculated composition); 4.00 mm diameter and 60.0 mm long; cast, hot-rolled, machined to size; electrical resistivity 12.2 $\mu\Omega$ cm at 78 K.
47	134	Aoyama, S. and Ito, T.	1940	L	78	No. 3	77.73 21.69	0.414 Co, 0.091 Fe, 0.05 Mn, 0.015 Al, 0.003 Sb, 0.0015 S, and trace Pb (calculated composition); 4.00 mm diameter and 60.0 mm long; cast, hot-rolled, machined to size; electrical resistivity 18.1 $\mu\Omega$ cm at 78 K.
48	134	Aoyama, S. and Ito, T.	1940	L	78	No. 4	69.14 30.35	0.37 Co, 0.05 Si, 0.068 Fe, 0.014 Al, 0.005 Sb, 0.0021 S, and trace Pb (calculated composition); 4.00 mm diameter and 60.0 mm long; cast, hot-rolled, machined to size; electrical resistivity 28.0 $\mu\Omega$ cm at 78 K.
49	134	Aoyama, S. and Ito, T.	1940	L	78	No. 5	58.98 40.53	0.314 Co, 0.104 Fe, 0.012 Al, 0.04 Mn, 0.006 Sb, 0.0028 S, and trace Pb (calculated composition); 4.00 mm diameter and 60.0 mm long; cast, hot-rolled, machined to size; electrical resistivity 47.7 $\mu\Omega$ cm at 78 K.

\* Not shown in figure.

#### 4.5. Copper-Palladium Alloy System

The copper-palladium system forms a continuous series of solid solutions over the entire range of compositions. Ordered structures are formed at temperatures below about 775 K for compositions ranging from slightly below 10 to somewhat above 25 At. % (16 to 36%) palladium and at temperatures below about 975 K for compositions ranging from slightly below 30 to somewhat above 50 At. % (42 to 63%) palladium. The maxima of the temperatures of transformation suggest that these ordered structures are based on  $PdCu_5$  and  $Pd_3Cu_5$ , respectively. In this connection, it should be noted that curves 2 and 3 of the Cu+Pd alloys and curves 3, 5, 6, 12, 13, 14, 15, 22, 23, 24, and 25 of the Pd+Cu alloys are results obtained from specimens which were in a partially ordered state.

There are 49 sets of experimental data available for the thermal conductivity of this alloy system. However, of the 19 data sets available for Cu+Pd alloys listed in table 15 and shown in figure 36, 14 sets are merely single data points around room temperature, and of the 30 data sets for Pd+Cu alloys listed in table 16 and shown in figure 37, 19 sets are single data points around room temperature.

The thermal conductivity of these alloys was first investigated by Sedström [178,179] who measured the thermal conductivity at 273 K of 14 specimens ranging from 3.5 to 93% Pd and the thermal conductivity at 323 K of 17 specimens ranging from 8.41 to 93.19% Pd. Later Grüneisen and Reddemann [61] measured the low temperature thermal conductivity of specimens containing 10.3, 57.8, 62.7, and 90.8% Pd (Cu+Pd curve 1 and Pd+Cu curves 1-5) and it was found that prolonged annealing just below the order-disorder transition temperature produced a 6-fold increase in the thermal conductivity at 80 K of the specimen containing 57.8% Pd. More recently, Pott [82] measured the thermal conductivity of specimens containing 24.18, 35.82, 52.75, 57.81, and 70.67% Pd at temperatures ranging from 293 to 1073 K. The first four specimens were measured both in the disordered state and after prolonged annealing just below the transition temperature (Cu+Pd curves 2-5 and Pd+Cu curves 6, 7, 9, and 10); the specimen containing 70.67% Pd was measured following two different heat treatments (Pd+Cu curves 8 and 10). The most recent measurement on alloys of this system was made in 1967 by Kierspe [83] (Cu+Pd curve 6) for a specimen containing 4.92% Pd at room temperature.

The low-temperature experimental thermal conductivity data for disordered specimens are in satisfactory agreement with the values calculated from eqs (12) and (35) for those compositions for which the  $k_e$  maximum occurs below 80 K. The investigation by Fletcher and Greig [84] of the lattice thermal conductivity of palladium-silver alloys showed that the strong electron-phonon interaction in the palladium-rich alloys reduces the low temperature lattice thermal conductivity, causing its maximum to occur at much higher temperatures than in the silver-rich alloys. A similar elevation of the temperature of the maximum of the lattice component is believed to occur in this alloy system. The discrepancy between the experimental and calculated values of the thermal conductivity at 80 K ranged from 2 to 12%, the calculated values

being higher; the 12% discrepancy was with the specimen containing 57.8% Pd and the electrical resistivities reported for this specimen are 8% greater than those reported by other authors for this composition.

At ordinary temperatures Sedström's data for his disordered specimens tend to be lower than the calculated values, particularly for the more dilute alloys; this is not surprising in view of the fact that the electrical resistivities of the specimens are higher than those reported by other authors for the same nominal compositions. In this same temperature range the calculated values are within 3% of Kierspe's data for a specimen containing 4.9% Pd and Pott's data for a specimen containing 57.8% Pd. On the other hand, the calculated values were 16% below Pott's data for a specimen containing 24.18% Pd and 28% below his data for a specimen containing 70.67% Pd. After correcting for the lattice component, corresponding Lorenz ratios for these specimens are respectively 22 and 36% greater than the classical value; it is unlikely that band structure effects could cause such large deviations from the classical value for these alloys at 300 K.

At higher temperatures there are four large discrepancies between the calculated and experimental data, ranging from 30 to 40%. Three of these are with the 70.67% Pd specimen mentioned above and are associated with Lorenz ratios 33 to 38% greater than the classical value; the other discrepancy is with Pott's specimen containing 57.8% Pd and the corresponding Lorenz ratio is 36% greater than the classical value. While heavy alloying with a noble element would presumably reduce band structure effects, these Lorenz ratios are larger than those obtained by Laubitz and Matsumura [10] for pure palladium. Also, they are very much larger than those obtained by Laubitz and van der Meer [85] for a gold alloy with 34.95% Pd in which comparable band structure effects might be expected. Further experimental work on the palladium-rich alloys of this system is clearly in order. Until there is additional experimental evidence or some theoretical support for these very large Lorenz ratios it seems safer to use evidence from similar systems rather than the thermal conductivities associated with these Lorenz ratios as a guide in recommending values.

A graphical comparison of the recommended total thermal conductivity values with some of the experimental data is given in figures 32 and 33. The smooth solid curves in these figures were obtained by interpolating the recommended values of table 14 in order to obtain thermal conductivity values for the desired alloy compositions. For the copper-rich alloys shown in figure 32, the recommended values are in agreement with the higher temperature portion of the data of Grüneisen and Reddemann [61] (Cu+Pd curve 1) to within 6%, with the data of Pott [82] (Cu+Pd curve 5) to within 5%, and with the data of Kierspe [83] (Cu+Pd curve 6) and of Holgersson and Sedström [178] (Cu+Pd curves 12 and 13) to within 3%. The agreement with the data of Holgersson and Sedström for their 8.41% and 16.57% Pd alloys (Cu+Pd curves 7 and 8) is not as good, being within 12% and 8%, respectively. For palladium-rich alloys shown in figure 33, the recommended values agree with the data of Pott [82] (Pd+Cu curve 9) and of Holgersson and Sedström [178] (Pd+Cu curve 18 and 20) to within 3 to 5%.

The recommended values for  $k$ ,  $k_e$ , and  $k_g$  are tabulated in table 14 for 25 alloy compositions. These values are for disordered alloys which have not been severely cold worked or quenched. The values for  $k$  are also presented in figures 34 and 35. In order to show more clearly the systematic variation of the thermal conductivity with alloy composition and to clarify the confusion in figure 35 due to crossover of curves, the recommended curves for palladium-rich alloys with 55 to

70% Pd are also displayed in figure 34. The  $k_e$  values cover the full temperature range from 4 to 1200 K, but  $k$  and  $k_g$  values are not given at very low temperatures. The values of residual electrical resistivity for the alloys are also given in table 14. The uncertainties of the  $k$  values are stated in a footnote to table 14, and those of the  $k_e$  and  $k_g$  values are of the order of  $\pm 10$  to  $\pm 14\%$ .

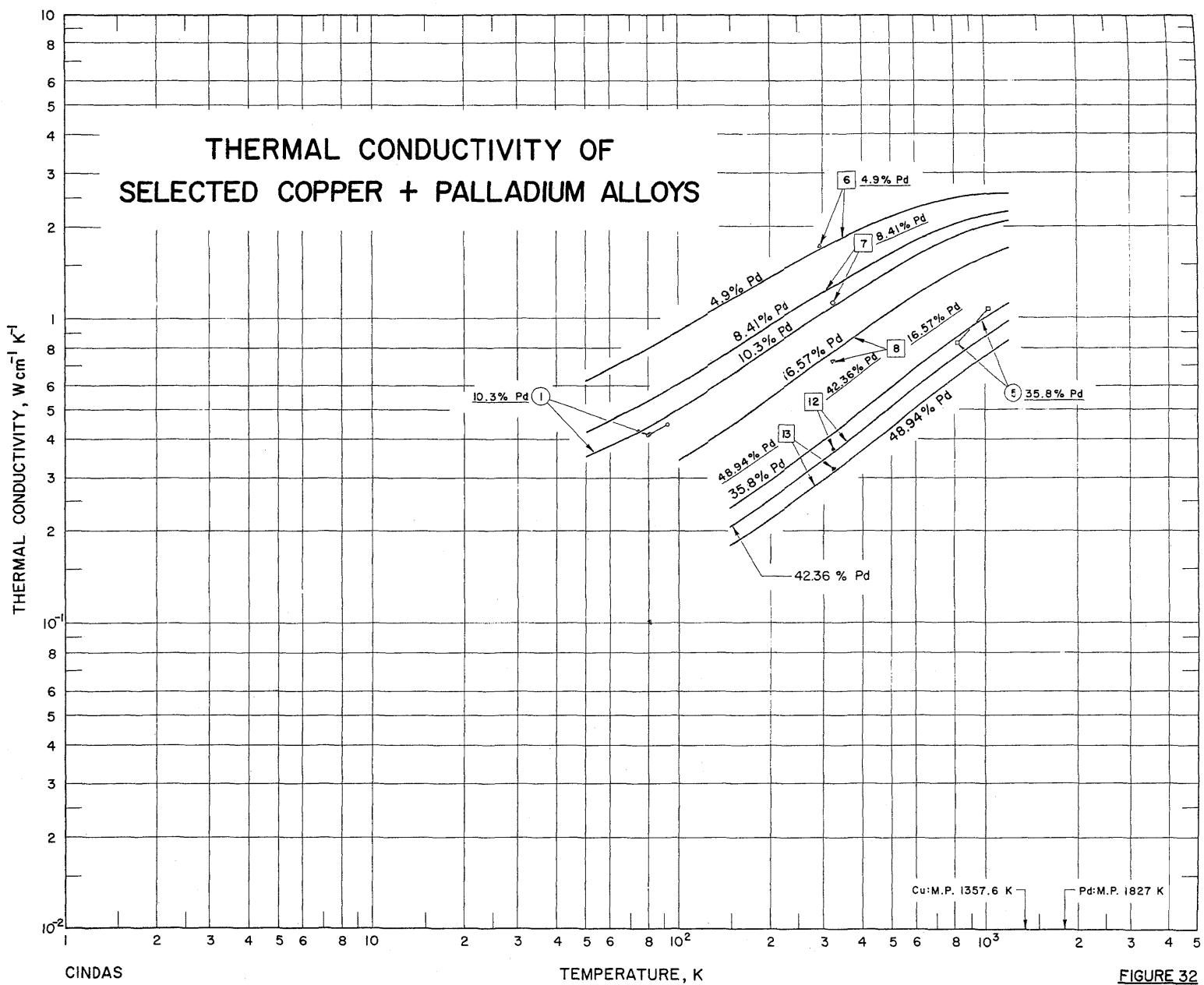


FIGURE 32

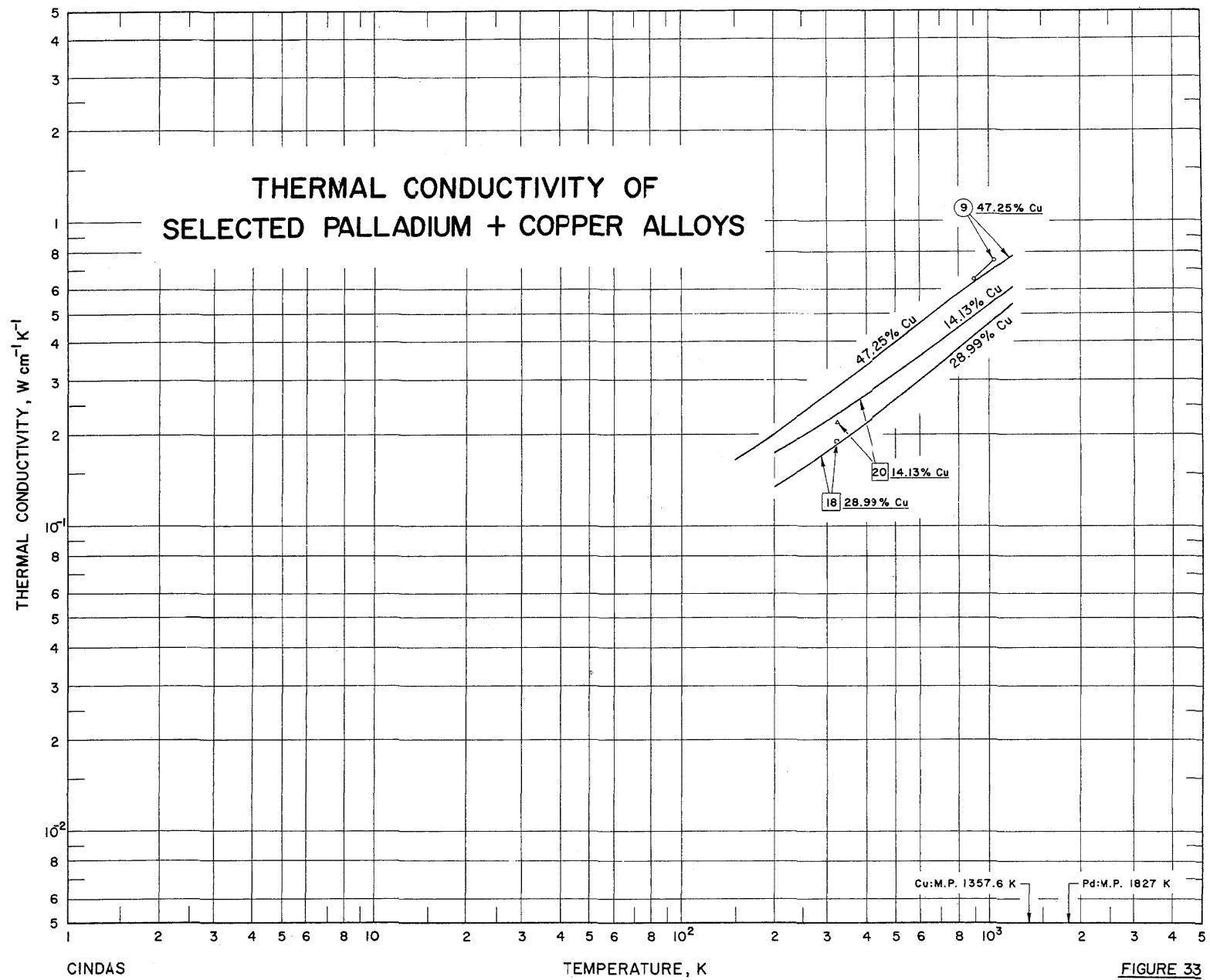


FIGURE 33

TABLE 14. RECOMMENDED THERMAL CONDUCTIVITY OF COPPER-PALLADIUM ALLOY SYSTEM<sup>†</sup>[Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Cu: 99.50% (99.70 At.%) Pd: 0.50% ( 0.30 At.%)				Cu: 99.00% (99.40 At.%) Pd: 1.00% ( 0.60 At.%)				Cu: 97.00% (98.19 At.%) Pd: 3.00% ( 1.81 At.%)				Cu: 95.00% (96.95 At.%) Pd: 5.00% ( 3.05 At.%)			
$\rho_o = 0.2800 \mu\Omega\text{cm}$				$\rho_o = 0.580 \mu\Omega\text{cm}$				$\rho_o = 1.620 \mu\Omega\text{cm}$				$\rho_o = 2.700 \mu\Omega\text{cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.349			4	0.168			4	0.0603			4	0.0362		
5	0.524			6	0.253			6	0.0905			6	0.0543		
8	0.698			8	0.337			8	0.121			8	0.0724		
10	0.873			10	0.421			10	0.151			10	0.0905		
15	1.31			15	0.632			15	0.226			15	0.136		
20	1.75			20	0.842			20	0.302			20	0.181		
25	2.06			25	1.04			25	0.376			25	0.226		
30	2.44			30	1.24			30	0.450			30	0.270		
40	3.11			40	1.59			40	0.591			40	0.359		
50	3.68*	0.336	0.324	50	2.15*	1.87	0.277	50	0.917*	0.713	0.204	50	0.615*	0.442	0.173
60	3.58*	0.327	0.316	60	2.25*	1.98	0.267	60	1.01*	0.820	0.194	60	0.680*	0.516	0.163
70	3.45*	0.314	0.307	70	2.29*	2.04	0.258	70	1.09*	0.905	0.184	70	0.736*	0.582	0.155
80	3.31*	0.301	0.297	80	2.29*	2.05	0.248	80	1.15*	0.975	0.176	80	0.791*	0.644	0.147
90	3.26*	0.297	0.286	90	2.35*	2.11	0.239	90	1.22*	1.05	0.168	90	0.845*	0.705	0.140
100	3.25*	0.298	0.275	100	2.41*	2.18	0.229	100	1.28*	1.12	0.161	100	0.895*	0.761	0.134
150	3.31*	0.309	0.226	150	2.72*	2.53	0.190	150	1.58*	1.44	0.133	150	1.15*	1.04	0.110
200	3.49*	0.327	0.188	200	2.90*	2.74	0.161	200	1.83*	1.71	0.114	200	1.35*	1.26	0.0947
250	3.48*	0.332	0.160	250	3.05*	2.91	0.139	250	2.03*	1.93	0.100	250	1.53*	1.45	0.0834
273	3.51*	0.336	0.150	273	3.08*	2.95	0.131	273	2.11*	2.02	0.0949	273	1.61	1.53	0.0792
300	3.54*	0.340	0.140	300	3.16*	3.04	0.122	300	2.19*	2.10	0.0895	300	1.69	1.61	0.0748
350	3.56*	0.344	0.123	350	3.22*	3.12	0.109	350	2.31*	2.23	0.0811	350	1.82	1.75	0.0681
400	3.56*	0.345	0.110	400	3.30*	3.20	0.0987	400	2.42*	2.35	0.0743	400	1.93*	1.86	0.0626
500	3.64*	0.355	0.0913	500	3.36*	3.27	0.0828	500	2.60*	2.54	0.0638	500	2.15*	2.09	0.0542
600	3.58*	0.350	0.0778	600	3.37*	3.29	0.0713	600	2.73*	2.68	0.0561	600	2.28*	2.23	0.0481
700	3.58*	0.351	0.0677	700	3.37*	3.31	0.0627	700	2.81*	2.76	0.0502	700	2.40*	2.35	0.0433
800	3.50*	0.344	0.0599	800	3.36*	3.30	0.0559	800	2.84*	2.80	0.0455	800	2.48*	2.44	0.0395
900	3.47*	0.341	0.0538	900	3.31*	3.26	0.0505	900	2.88*	2.84	0.0416	900	2.53*	2.49	0.0363
1000	3.42*	0.337	0.0488	1000	3.29*	3.24	0.0460	1000	2.88*	2.84	0.0383	1000	2.56*	2.52	0.0337
1100	3.36*	0.332	0.0446	1100	3.26*	3.22	0.0422	1100	2.88*	2.85	0.0356	1100	2.58*	2.55	0.0314
1200	3.31*	0.327	0.0411	1200	3.21*	3.17	0.0391	1200	2.87*	2.84	0.0332	1200	2.59*	2.56	0.0294

<sup>†</sup> Uncertainties in the total thermal conductivity, k, are as follows:99.50 Cu - 0.50 Pd:  $\pm 10\%$ .99.00 Cu - 1.00 Pd:  $\pm 10\%$ .97.00 Cu - 3.00 Pd:  $\pm 10\%$ .95.00 Cu - 5.00 Pd:  $\pm 10\%$ .

\* In temperature range where no experimental thermal conductivity data are available.

TABLE 14. RECOMMENDED THERMAL CONDUCTIVITY OF COPPER-PALLADIUM ALLOY SYSTEM (continued)<sup>†</sup>[Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Cu: 90.00% (93.78 At.%) Pd: 10.00% ( 6.22 At.%)				Cu: 85.00% (90.47 At.%) Pd: 15.00% ( 9.53 At.%)				Cu: 80.00% (87.01 At.%) Pd: 20.00% (12.99 At.%)				Cu: 75.00% (83.40 At.%) Pd: 25.00% (16.60 At.%)			
$\rho_o = 5.32 \mu\Omega\text{cm}$				$\rho_o = 7.91 \mu\Omega\text{cm}$				$\rho_o = 10.43 \mu\Omega\text{cm}$				$\rho_o = 12.90 \mu\Omega\text{cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.0184			4	0.0124			4	0.00937			4	0.00758		
6	0.0276			6	0.0185			6	0.0141			6	0.0114		
8	0.0367			8	0.0247			8	0.0187			8	0.0152		
10	0.0459			10	0.0309			10	0.0234			10	0.0189		
15	0.0689			15	0.0463			15	0.0351			15	0.0284		
20	0.0918			20	0.0618			20	0.0468			20	0.0379		
25	0.114			25	0.0771			25	0.0585			25	0.0473		
30	0.137			30	0.0924			30	0.0702			30	0.0567		
40	0.181			40	0.123			40	0.0934			40	0.0755		
50	0.360	0.225	0.135	50	0.267*	0.152	0.115	50	0.218*	0.116	0.102	50	0.186*	0.0939	0.0925
60	0.393	0.267	0.126	60	0.288*	0.181	0.107	60	0.233*	0.138	0.0945	60	0.198*	0.112	0.0857
70	0.424	0.305	0.119	70	0.308*	0.208	0.100	70	0.249*	0.160	0.0886	70	0.210*	0.130	0.0802
80	0.455	0.343	0.112	80	0.329*	0.234	0.0947	80	0.265*	0.181	0.0835	80	0.223*	0.147	0.0756
90	0.486	0.379	0.107	90	0.351*	0.261	0.0899	90	0.281*	0.202	0.0792	90	0.236*	0.164	0.0717
100	0.516*	0.414	0.102	100	0.373*	0.287	0.0857	100	0.299*	0.223	0.0755	100	0.249*	0.181	0.0682
150	0.668*	0.585	0.0837	150	0.484*	0.414	0.0703	150	0.386*	0.324	0.0618	150	0.321*	0.265	0.0558
200	0.815*	0.743	0.0719	200	0.593*	0.533	0.0604	200	0.472*	0.419	0.0532	200	0.393*	0.345	0.0480
250	0.950*	0.887	0.0635	250	0.698*	0.644	0.0534	250	0.557*	0.510	0.0471	250	0.465*	0.422	0.0425
273	1.01	0.945	0.0604	273	0.742	0.691	0.0509	273	0.594	0.549	0.0448	273	0.496	0.456	0.0405
300	1.07	1.01	0.0572	300	0.796	0.748	0.0482	300	0.638	0.596	0.0425	300	0.533	0.494	0.0384
350	1.18	1.13	0.0522	350	0.886	0.842	0.0441	350	0.715	0.676	0.0389	350	0.599	0.564	0.0352
400	1.29*	1.24	0.0482	400	0.971*	0.930	0.0408	400	0.787*	0.751	0.0360	400	0.662	0.629	0.0326
500	1.47*	1.43	0.0421	500	1.13*	1.10	0.0357	500	0.924*	0.893	0.0316	500	0.782	0.753	0.0287
600	1.63*	1.59	0.0375	600	1.27*	1.24	0.0319	600	1.05*	1.02	0.0283	600	0.895	0.869	0.0257
700	1.77*	1.73	0.0340	700	1.40*	1.37	0.0290	700	1.17*	1.14	0.0258	700	1.00	0.979	0.0235
800	1.88*	1.85	0.0312	800	1.51*	1.48	0.0267	800	1.27*	1.25	0.0238	800	1.10	1.08	0.0216
900	1.97*	1.94	0.0289	900	1.61*	1.58	0.0248	900	1.36*	1.34	0.0221	900	1.19	1.17	0.0201
1000	2.04*	2.01	0.0270	1000	1.68*	1.66	0.0232	1000	1.45*	1.43	0.0207	1000	1.27	1.25	0.0189
1100	2.09*	2.07	0.0253	1100	1.75*	1.73	0.0218	1100	1.52*	1.50	0.0195	1100	1.35*	1.33	0.0178
1200	2.14*	2.11	0.0238	1200	1.80*	1.78	0.0206	1200	1.58*	1.56	0.0184	1200	1.42*	1.40	0.0168

† Uncertainties in the total thermal conductivity, k, are as follows:

90.00 Cu - 10.00 Pd: ±10%.

85.00 Cu - 15.00 Pd: ±10%.

80.00 Cu - 20.00 Pd: ±10%.

75.00 Cu - 25.00 Pd: ±10%.

\* In temperature range where no experimental thermal conductivity data are available.

TABLE 14. RECOMMENDED THERMAL CONDUCTIVITY OF COPPER-PALLADIUM ALLOY SYSTEM (continued)<sup>†</sup>  
 [Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Cu: 70.00% (79.62 At.%) Pd: 30.00% (20.38 At.%)				Cu: 65.00% (75.67 At.%) Pd: 35.00% (24.33 At.%)				Cu: 60.00% (71.52 At.%) Pd: 40.00% (23.48 At.%)				Cu: 55.00% (67.18 At.%) Pd: 45.00% (22.82 At.%)			
$\rho_o = 15.30 \mu\Omega\text{cm}$				$\rho_o = 17.68 \mu\Omega\text{cm}$				$\rho_o = 20.01 \mu\Omega\text{cm}$				$\rho_o = 22.60 \mu\Omega\text{cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.00639			4	0.00553			4	0.00488			4	0.00432		
6	0.00958			6	0.00829			6	0.00733			6	0.00649		
8	0.0128			8	0.0111			8	0.00977			8	0.00865		
10	0.0160			10	0.0138			10	0.0122			10	0.0108		
15	0.0240			15	0.0207			15	0.0183			15	0.0162		
20	0.0319			20	0.0276			20	0.0244			20	0.0216		
25	0.0399			25	0.0345			25	0.0305			25	0.0270		
30	0.0478			30	0.0414			30	0.0366			30	0.0324		
40	0.0636			40	0.0551			40	0.0487			40	0.0431		
50	0.165*	0.0791	0.0855	50	0.149*	0.0688	0.0799	50	0.136*	0.0606	0.0756	50	0.126*	0.0537	0.0721
60	0.174*	0.0945	0.0791	60	0.156*	0.0822	0.0739	60	0.142*	0.0724	0.0698	60	0.131*	0.0642	0.0665
70	0.183*	0.109	0.0739	70	0.164*	0.0953	0.0691	70	0.149*	0.0840	0.0652	70	0.137*	0.0745	0.0621
80	0.194*	0.125	0.0696	80	0.173*	0.108	0.0650	80	0.157*	0.0955	0.0613	80	0.143*	0.0847	0.0584
90	0.205*	0.139	0.0660	90	0.183*	0.121	0.0615	90	0.165*	0.107	0.0580	90	0.150*	0.0948	0.0553
100	0.217*	0.154	0.0628	100	0.193*	0.134	0.0585	100	0.173*	0.118	0.0552	100	0.158*	0.105	0.0526
150	0.278*	0.226	0.0514	150	0.246*	0.198	0.0479	150	0.219*	0.174	0.0451	150	0.198*	0.155	0.0429
200	0.339*	0.295	0.0442	200	0.300*	0.259	0.0412	200	0.267*	0.229	0.0388	200	0.240*	0.203	0.0369
250	0.401*	0.362	0.0392	250	0.354*	0.317	0.0365	250	0.316*	0.281	0.0344	250	0.283*	0.250	0.0328
273	0.428*	0.391	0.0373	273	0.378	0.344	0.0348	273	0.338	0.305	0.0328	273	0.302	0.271	0.0312
300	0.462*	0.426	0.0354	300	0.407	0.374	0.0330	300	0.363	0.332	0.0311	300	0.325	0.295	0.0297
350	0.520*	0.487	0.0325	350	0.459	0.428	0.0303	350	0.410	0.381	0.0286	350	0.367	0.340	0.0272
400	0.575*	0.545	0.0301	400	0.509	0.481	0.0281	400	0.454*	0.428	0.0265	400	0.407*	0.382	0.0252
500	0.683*	0.657	0.0264	500	0.508	0.583	0.0247	500	0.542*	0.519	0.0233	500	0.485*	0.463	0.0222
600	0.826*	0.802	0.0238	600	0.701	0.678	0.0222	600	0.327*	0.606	0.0210	600	0.561*	0.541	0.0200
700	0.882*	0.860	0.0217	700	0.790*	0.770	0.0203	700	0.707*	0.688	0.0192	700	0.633*	0.615	0.0183
800	0.972*	0.952	0.0200	800	0.873	0.854	0.0187	800	0.782*	0.764	0.0177	800	0.701*	0.685	0.0169
900	1.05*	1.04	0.0186	900	0.948	0.931	0.0175	900	0.853*	0.837	0.0165	900	0.765*	0.749	0.0157
1000	1.13*	1.11	0.0175	1000	1.02	1.00	0.0164	1000	0.920*	0.904	0.0155	1000	0.825*	0.810	0.0148
1100	1.20*	1.18	0.0165	1100	1.09	1.07	0.0154	1100	0.982*	0.967	0.0146	1100	0.881*	0.867	0.0140
1200	1.26*	1.25	0.0156	1200	1.15*	1.14	0.0146	1200	1.04*	1.03	0.0139	1200	0.933*	0.920	0.0132

† Uncertainties in the total thermal conductivity, k, are as follows:

70.00 Cu - 30.00 Pd: ±10%.

65.00 Cu - 35.00 Pd: ±10%.

60.00 Cu - 40.00 Pd: ±10%.

55.00 Cu - 45.00 Pd: ±10%.

\* In temperature range where no experimental thermal conductivity data are available.

TABLE 14. RECOMMENDED THERMAL CONDUCTIVITY OF COPPER-PALLADIUM ALLOY SYSTEM (continued)<sup>†</sup>  
 [Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Cu: 50.00% (62.61 At.%) Pd: 50.00% (37.39 At.%)				Cu: 45.00% (57.81 At.%) Pd: 55.00% (42.19 At.%)				Cu: 40.00% (52.75 At.%) Pd: 60.00% (47.25 At.%)				Cu: 35.00% (47.41 At.%) Pd: 65.00% (52.59 At.%)			
$\rho_0 = 25.53 \mu\Omega\text{cm}$				$\rho_0 = 29.00 \mu\Omega\text{cm}$				$\rho_0 = 32.63 \mu\Omega\text{cm}$				$\rho_0 = 40.00 \mu\Omega\text{cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.00383			4	0.00337			4	0.00300			4	0.00244		
6	0.00574			6	0.00505			6	0.00449			6	0.00366		
8	0.00766			8	0.00674			8	0.00599			8	0.00489		
10	0.00957			10	0.00842			10	0.00749			10	0.00611		
15	0.0144			15	0.0126			15	0.0112			15	0.00916		
20	0.0191			20	0.0168			20	0.0150			20	0.0122		
25	0.0239			25	0.0210			25	0.0186			25	0.0152		
30	0.0287			30	0.0252			30	0.0223			30	0.0182		
40	0.0381			40	0.0336			40	0.0296			40	0.0242		
50	0.117*	0.0476	0.0693	50	0.0419			50	0.0369			50	0.0301		
60	0.121*	0.0568	0.0640	60	0.112*	0.0500	0.0620	60	0.0440			60	0.0360		
70	0.126*	0.0659	0.0597	70	0.116*	0.0580	0.0578	70	0.108	0.0511	0.0565	70	0.0419		
80	0.131*	0.0750	0.0561	80	0.120	0.0660	0.0544	80	0.111	0.0582	0.0531	80	0.100	0.0477	0.0525
90	0.137*	0.0840	0.0531	90	0.125	0.0740	0.0514	90	0.115	0.0652	0.0503	90	0.103	0.0535	0.0496
100	0.143*	0.0929	0.0595	100	0.131*	0.0819	0.0489	100	0.120*	0.0722	0.0478	100	0.106*	0.0581	0.0471
150	0.178*	0.137	0.0412	150	0.161*	0.121	0.0399	150	0.145*	0.106	0.0390	150	0.126*	0.0872	0.0385
200	0.215*	0.180	0.0355	200	0.192*	0.158	0.0343	200	0.172*	0.139	0.0335	200	0.148*	0.114	0.0331
250	0.253*	0.222	0.0315	250	0.224*	0.194	0.0305	250	0.200*	0.170	0.0297	250	0.170*	0.141	0.0293
273	0.269	0.239	0.0300	273	0.239	0.210	0.0290	273	0.212	0.184	0.0283	273	0.181	0.153	0.0279
300	0.289	0.260	0.0285	300	0.257	0.230	0.0276	300	0.227	0.200	0.0269	300	0.193	0.167	0.0265
350	0.325	0.299	0.0261	350	0.289	0.263	0.0253	350	0.254	0.230	0.0247	350	0.216	0.192	0.0243
400	0.361	0.337	0.0242	400	0.320	0.296	0.0235	400	0.281	0.258	0.0229	400	0.239*	0.216	0.0226
500	0.430	0.409	0.0213	500	0.379	0.359	0.0207	500	0.333	0.312	0.0202	500	0.289*	0.263	0.0199
600	0.497	0.477	0.0192	600	0.437	0.418	0.0186	600	0.382	0.363	0.0182	600	0.325*	0.307	0.0179
700	0.561	0.543	0.0176	700	0.492	0.475	0.0170	700	0.429	0.413	0.0166	700	0.366*	0.350	0.0164
800	0.622	0.605	0.0162	800	0.545	0.529	0.0157	800	0.475	0.460	0.0154	800	0.407*	0.392	0.0151
900	0.680	0.665	0.0151	900	0.596	0.581	0.0147	900	0.520	0.506	0.0143	900	0.448*	0.433	0.0141
1000	0.734	0.720	0.0142	1000	0.645	0.631	0.0138	1000	0.563	0.549	0.0134	1000	0.488*	0.474	0.0132
1100	0.786	0.773	0.0134	1100	0.691	0.678	0.0130	1100	0.604	0.591	0.0127	1100	0.529*	0.516	0.0125
1200	0.835*	0.822	0.0127	1200	0.734*	0.722	0.0123	1200	0.643*	0.631	0.0120	1200	0.570*	0.558	0.0119

<sup>†</sup> Uncertainties in the total thermal conductivity, k, are as follows:

50.00 Cu - 50.00 Pd:  $\pm 10\%$ .

45.00 Cu - 55.00 Pd:  $\pm 10\%$ .

40.00 Cu - 60.00 Pd:  $\pm 10\%$ .

35.00 Cu - 65.00 Pd:  $\pm 10\%$ .

\* In temperature range where no experimental thermal conductivity data are available.

TABLE 14. RECOMMENDED THERMAL CONDUCTIVITY OF COPPER-PALLADIUM ALLOY SYSTEM (continued)<sup>†</sup>[Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Cu: 30.00% (41.78 At.%) Pd: 70.00% (58.22 At.%)				Cu: 25.00% (35.82 At.%) Pd: 75.00% (64.18 At.%)				Cu: 20.00% (29.51 At.%) Pd: 80.00% (70.49 At.%)				Cu: 15.00% (22.81 At.%) Pd: 85.00% (77.19 At.%)			
$\rho_0 = 44.19 \mu\Omega \text{cm}$				$\rho_0 = 42.40 \mu\Omega \text{cm}$				$\rho_0 = 36.26 \mu\Omega \text{cm}$				$\rho_0 = 28.68 \mu\Omega \text{cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.00221			4	0.00231			4	0.00270			4	0.00341		
6	0.00332			6	0.00346			6	0.00404			6	0.00511		
8	0.00442			8	0.00461			8	0.00539			8	0.00682		
10	0.00553			10	0.00576			10	0.00674			10	0.00852		
15	0.00829			15	0.00864			15	0.0101			15	0.0128		
20	0.0111			20	0.0115			20	0.0135			20	0.0170		
25	0.0137			25	0.0142			25	0.0165			25	0.0207		
30	0.0165			30	0.0170			30	0.0198			30	0.0247		
40	0.0219			40	0.0226			40	0.0261			40	0.0325		
50	0.0273			50	0.0281			50	0.0323			50	0.0400		
60	0.0326			60	0.0335			60	0.0384			60	0.0473		
70	0.0379			70	0.0388			70	0.0444			70	0.0545		
80	0.0432			80	0.0441			80	0.0503			80	0.0615		
90	0.0485			90	0.0494			90	0.0561			90	0.0684		
100	0.0535			100	0.0547			100	0.0619			100	0.0752		
150	0.117*	0.0790	0.0384	150	0.119*	0.0801	0.0388	150	0.0893			150	0.107		
200	0.137*	0.104	0.0330	200	0.138*	0.105	0.0334	200	0.150*	0.115	0.0344	200	0.172*	0.136	0.0365
250	0.157*	0.128	0.0292	250	0.158*	0.129	0.0296	250	0.171*	0.140	0.0305	250	0.195*	0.163	0.0323
273	0.167	0.139	0.0279	273	0.168	0.139	0.0282	273	0.180	0.151	0.0290	273	0.206	0.175	0.0308
300	0.178	0.152	0.0264	300	0.179	0.152	0.0267	300	0.192	0.164	0.0275	300	0.218	0.189	0.0292
350	0.199	0.175	0.0243	350	0.200	0.176	0.0245	350	0.214	0.189	0.0252	350	0.242	0.215	0.0267
400	0.220	0.198	0.0225	400	0.222	0.199	0.0227	400	0.236*	0.213	0.0234	400	0.265*	0.240	0.0247
500	0.262	0.242	0.0198	500	0.264	0.244	0.0200	500	0.280*	0.259	0.0206	500	0.311*	0.289	0.0217
600	0.303	0.285	0.0178	600	0.306	0.288	0.0180	600	0.323*	0.304	0.0185	600	0.356*	0.336	0.0195
700	0.343*	0.327	0.0163	700	0.347*	0.331	0.0164	700	0.366*	0.349	0.0169	700	0.400*	0.383	0.0178
800	0.383	0.368	0.0151	800	0.388	0.373	0.0152	800	0.408*	0.393	0.0156	800	0.443*	0.427	0.0164
900	0.422	0.408	0.0140	900	0.430	0.415	0.0142	900	0.450*	0.436	0.0145	900	0.485*	0.470	0.0153
1000	0.461	0.448	0.0132	1000	0.470	0.457	0.0133	1000	0.492*	0.478	0.0136	1000	0.526*	0.511	0.0143
1100	0.502	0.489	0.0124	1100	0.513	0.500	0.0125	1100	0.534*	0.521	0.0128	1100	0.566*	0.553	0.0135
1200	0.543*	0.531	0.0118	1200	0.556*	0.544	0.0119	1200	0.578*	0.566	0.0122	1200	0.607*	0.594	0.0128

† Uncertainties in the total thermal conductivity, k, are as follows:

30.00 Cu - 70.00 Pd: ± 14%.

25.00 Cu - 75.00 Pd: ± 14%.

20.00 Cu - 80.00 Pd: ± 14%.

15.00 Cu - 85.00 Pd: ± 14%.

\* In temperature range where no experimental thermal conductivity data are available.

TABLE 14. RECOMMENDED THERMAL CONDUCTIVITY OF COPPER-PALLADIUM ALLOY SYSTEM (continued)<sup>†</sup>  
 [Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Cu: 10.00% (15.69 At.%) Pd: 90.00% (84.31 At.%)				Cu: 5.00% (8.10 At.%) Pd: 95.00% (91.90 At.%)				Cu: 3.00% (4.92 At.%) Pd: 97.00% (95.08 At.%)				Cu: 1.00% (1.66 At.%) Pd: 99.00% (98.34 At.%)			
$\rho_o = 20.10 \mu\Omega\text{cm}$				$\rho_o = 10.31 \mu\Omega\text{cm}$				$\rho_o = 6.20 \mu\Omega\text{cm}$				$\rho_o = 2.100 \mu\Omega\text{cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.00485			4	0.00948			4	0.0158			4	0.0465		
6	0.00729			6	0.0142			6	0.0236			6	0.0698		
8	0.00972			8	0.0190			8	0.0315			8	0.0931		
10	0.0122			10	0.0237			10	0.0394			10	0.116		
15	0.0182			15	0.0355			15	0.0591			15	0.175		
20	0.0243			20	0.0474			20	0.0788			20	0.233		
25	0.0294			25	0.0572			25	0.0959			25	0.276		
30	0.0350			30	0.0676			30	0.113			30	0.315		
40	0.0459			40	0.0871			40	0.143			40	0.364		
50	0.0562			50	0.105			50	0.167			50	0.382		
60	0.0660			60	0.120			60	0.214			60	0.389		
70	0.0756			70	0.135			70	0.230			70	0.397		
80	0.0849			80	0.149			80	0.246			80	0.407		
90	0.0940			90	0.162			90	0.261			90	0.417		
100	0.103			100	0.175			100	0.273			100	0.422		
150	0.141			150	0.223			150	0.294			150	0.441		
200	0.216*	0.175	0.0407	200	0.312*	0.261	0.0509	200	0.329			200	0.454		
250	0.241*	0.205	0.0360	250	0.337*	0.293	0.0448	250	0.411*	0.358	0.0533	250	0.547*	0.471	0.0762
273	0.252	0.218	0.0342	273	0.348	0.305	0.0426	273	0.421*	0.371	0.0505	273	0.553*	0.481	0.0719
300	0.266	0.234	0.0324	300	0.362	0.322	0.0403	300	0.435*	0.387	0.0477	300	0.562*	0.494	0.0676
350	0.292	0.262	0.0297	350	0.389	0.352	0.0367	350	0.462*	0.419	0.0434	350	0.583*	0.522	0.0608
400	0.317*	0.290	0.0274	400	0.415*	0.381	0.0339	400	0.486*	0.446	0.0399	400	0.604*	0.548	0.0554
500	0.366*	0.342	0.0240	500	0.465*	0.436	0.0295	500	0.533*	0.499	0.0346	500	0.646*	0.599	0.0471
600	0.412*	0.391	0.0215	600	0.515*	0.489	0.0263	600	0.579*	0.548	0.0307	600	0.690*	0.649	0.0411
700	0.456*	0.436	0.0196	700	0.559*	0.535	0.0239	700	0.623*	0.595	0.0277	700	0.731*	0.694	0.0365
800	0.499*	0.481	0.0180	800	0.661*	0.639	0.0219	800	0.665*	0.640	0.0253	800	0.770*	0.737	0.0329
900	0.541*	0.525	0.0168	900	0.641*	0.621	0.0202	900	0.706*	0.682	0.0233	900	0.808*	0.778	0.0299
1000	0.581*	0.565	0.0157	1000	0.676*	0.657	0.0189	1000	0.743*	0.722	0.0216	1000	0.847*	0.819	0.0275
1100	0.621*	0.606	0.0148	1100	0.711*	0.693	0.0177	1100	0.775*	0.755	0.0202	1100	0.886*	0.861	0.0254
1200	0.660*	0.646	0.0140	1200	0.745*	0.728	0.0167	1200	0.810*	0.791	0.0190	1200	0.926*	0.903	0.0236

<sup>†</sup> Uncertainties in the total thermal conductivity, k, are as follows:

10.00 Cu - 90.00 Pd:  $\pm 14\%$ .  
 5.00 Cu - 95.00 Pd:  $\pm 14\%$ .  
 3.00 Cu - 97.00 Pd:  $\pm 14\%$ .  
 1.00 Cu - 99.00 Pd:  $\pm 14\%$ .

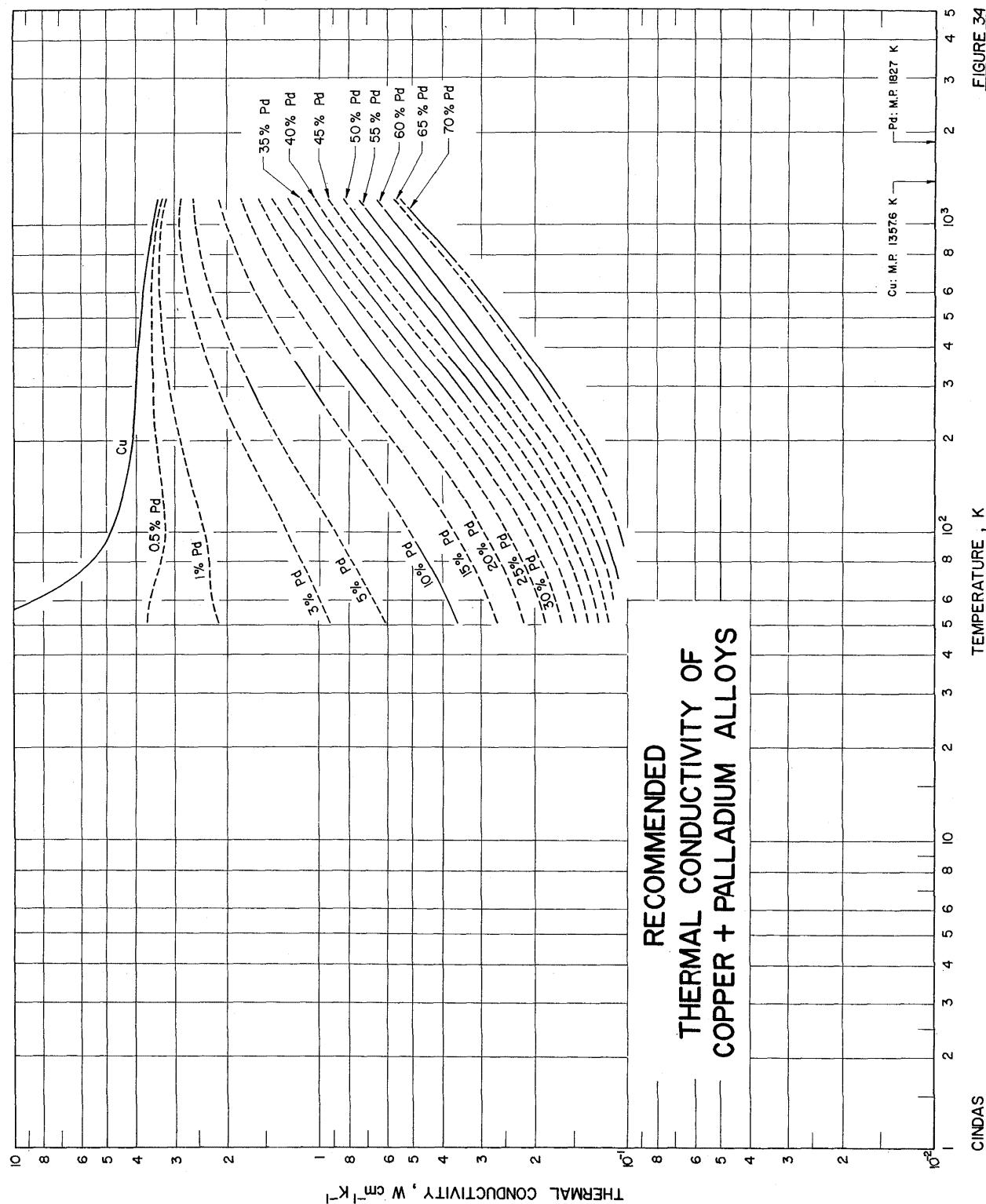
\* In temperature range where no experimental thermal conductivity data are available.

TABLE 14. RECOMMENDED THERMAL CONDUCTIVITY OF COPPER-PALLADIUM ALLOY SYSTEM (continued)<sup>†</sup>[Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

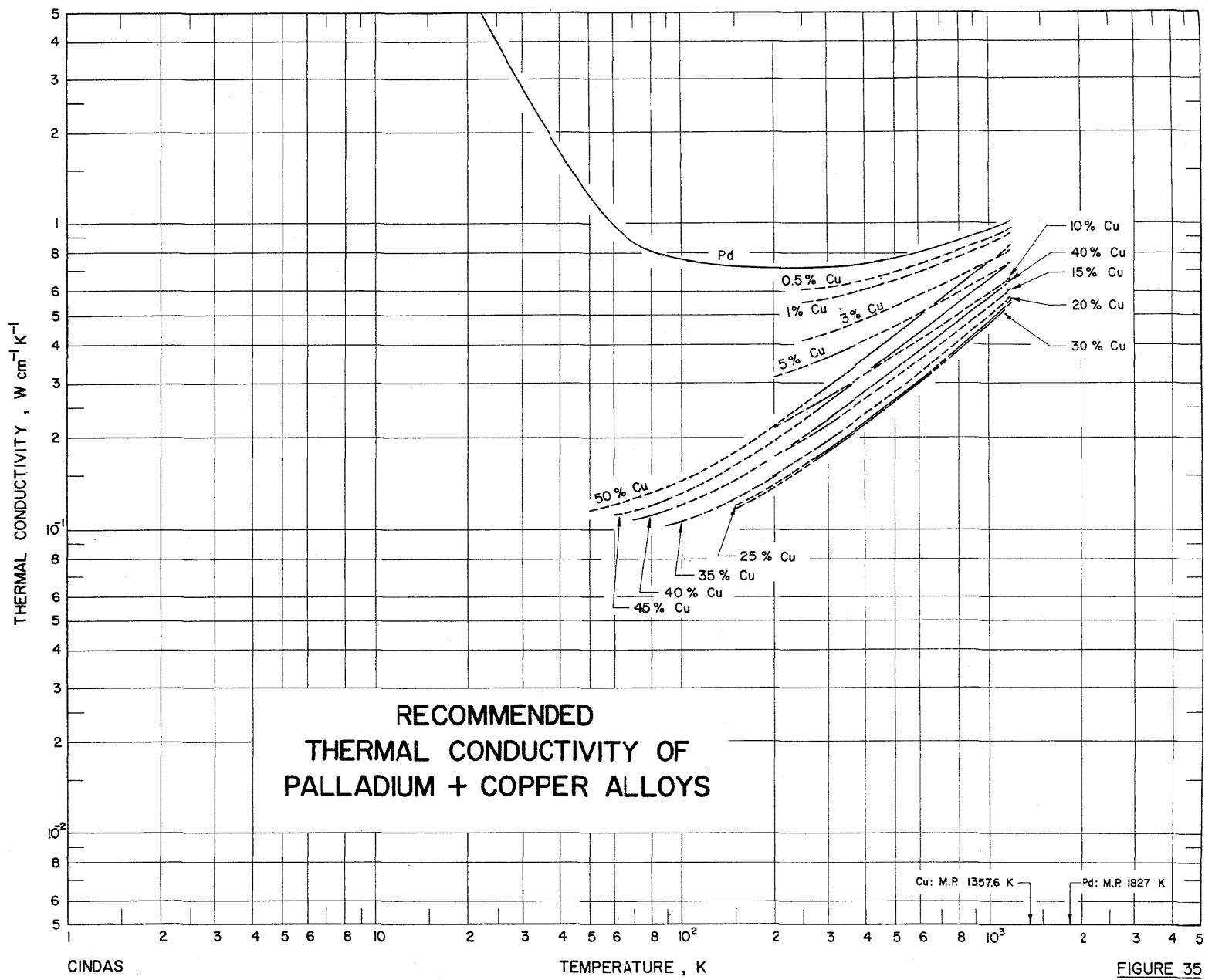
Cu: 0.50% ( 0.83 At. %) Pd: 99.50% (99.17 At. %)				
$\rho_0 = 1.100 \mu\Omega\text{cm}$				
T	k	k <sub>e</sub>	k <sub>g</sub>	
4	0.0888			
6	0.133			
8	0.178			
10	0.222			
15	0.333			
20	0.444			
25	0.516			
30	0.557			
40	0.596			
50	0.582			
60	0.557			
70	0.539			
80	0.529			
90	0.530			
100	0.520			
150	0.504			
200	0.504			
250	0.606*	0.514	0.0922	
273	0.608*	0.521	0.0866	
300	0.615*	0.534	0.0809	
350	0.634*	0.562	0.0721	
400	0.652*	0.587	0.0650	
500	0.689*	0.634	0.0545	
600	0.730*	0.683	0.0469	
700	0.772*	0.731	0.0412	
800	0.810*	0.773	0.0367	
900	0.849*	0.816	0.0332	
1000	0.887*	0.857	0.0302	
1100	0.927*	0.899	0.0278	
1200	0.966*	0.940	0.0257	

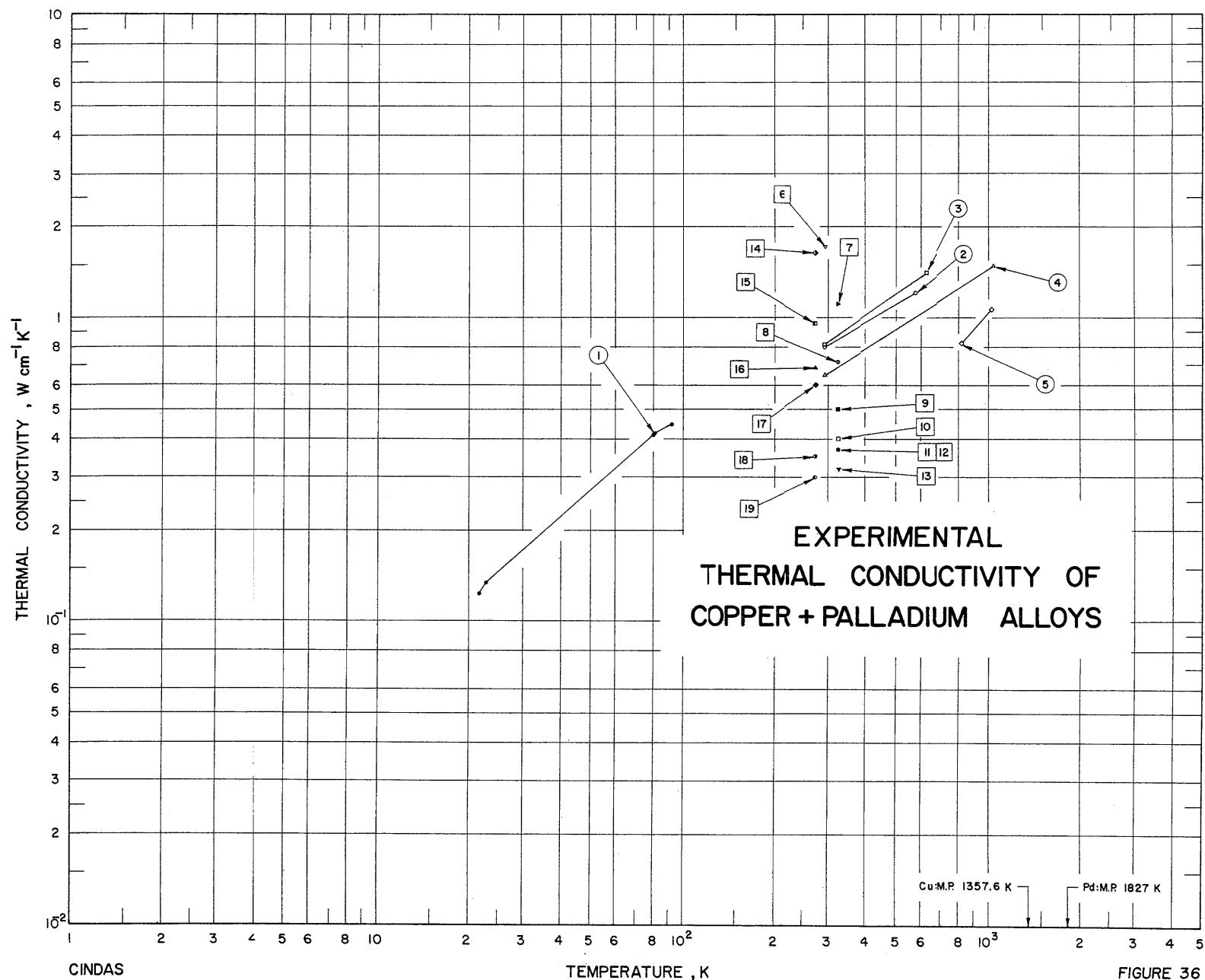
<sup>†</sup> Uncertainties in the total thermal conductivity, k, are as follows:  
0.50 Cu - 99.50 Pd:  $\pm 14\%$ .

\* In temperature range where no experimental thermal conductivity data are available.



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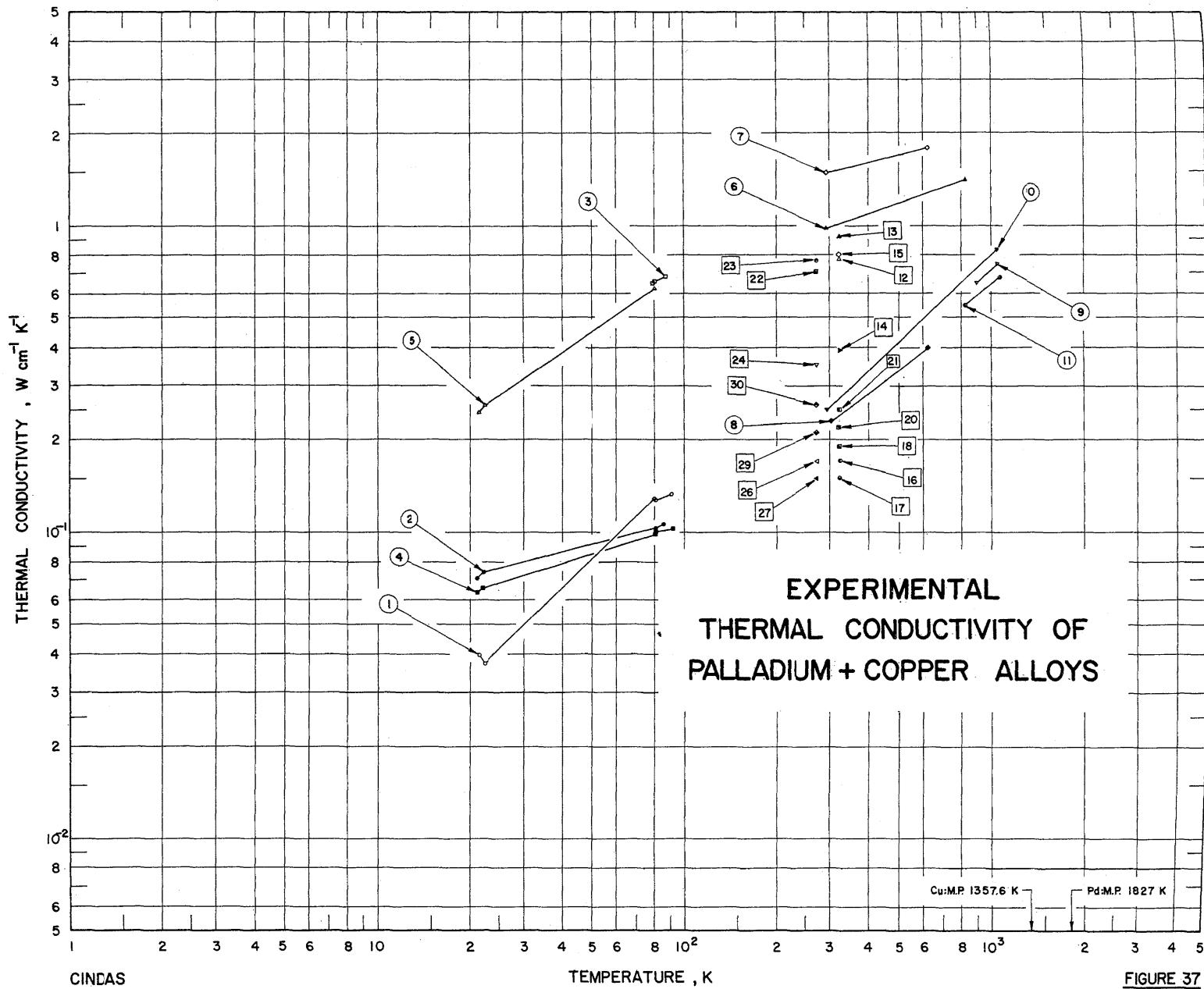


TABLE 15. THERMAL CONDUCTIVITY OF COPPER + PALLADIUM ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent) Cu      Pd	Composition (continued), Specifications, and Remarks
1	61	Grüneisen, E. and Reddemann, H.	1934	L	22-91	20	89.7      10.3	Calculated composition; polycrystalline; electrical resistivity 6.82, 5.508, and 5.184 $\mu\Omega$ cm at 0, -190, and -251 C, respectively.
2	82	Pott, F.P.	1958	L	293,573		24.18	Calculated composition; annealed at 600 to 700 C for 2 hr; ordered; electrical resistivity 9.7, 12.4, and 13.9 $\mu\Omega$ cm at 36, 300, and 480 C, respectively.
3	82	Pott, F.P.	1958	L	293,623		35.82	Similar to the above specimen except electrical resistivity 10.5, 12.9, and 15.2 $\mu\Omega$ cm at 34, 251, and 449 C, respectively.
4	82	Pott, F.P.	1958	L	293,1048		24.18	Similar to the above specimen except disordered with electrical resistivity 14.2, 17.1, and 19.3 $\mu\Omega$ cm at 19, 441, and 779 C, respectively.
5	82	Pott, F.P.	1958	L	818,1028		35.82	Similar to the above specimen except electrical resistivity 19.7, 22.4, and 25.6 $\mu\Omega$ cm at 25, 400, and 800 C, respectively.
6	83	Kierspe, W.	1967	L	293.2		4.9	Cylindrical specimen; electrical resistivity 2.5862, 2.5865, 2.5901, 2.6052, 2.6378, 2.6848, 2.8092, 2.9047, 3.0440, 3.1847, 3.3258, 3.4636, 3.6005, 3.7351, 3.8703, 4.0055, 4.1351, and 4.2018 $\mu\Omega$ cm at 4.2, 10, 20, 30, 40, 50, 70, 85, 103, 123, 143, 163, 183, 203, 223, 243, 263, and 273 K, respectively.
7	178	Holgersson, S. and Sedström, E.	1924		323.2		8.41	Calculated composition (5.2 a/o Pd); electrical resistivity 6.8 $\mu\Omega$ cm at 50 C.
8	178	Holgersson, S. and Sedström, E.	1924		323.2		16.57	Calculated composition (10.6 a/o Pd); electrical resistivity 11.9 $\mu\Omega$ cm at 50 C.
9	178	Holgersson, S. and Sedström, E.	1924		323.2		22.40	Calculated composition (14.7 a/o Pd); electrical resistivity 15.4 $\mu\Omega$ cm at 50 C.
10	178	Holgersson, S. and Sedström, E.	1924		323.2		28.73	Calculated composition (19.4 a/o Pd); density 9.78 g $\text{cm}^{-3}$ ; electrical resistivity 18.8 $\mu\Omega$ cm at 50 C.
11	178	Holgersson, S. and Sedström, E.	1924		323.2		35.45	Calculated composition (24.7 a/o Pd); electrical resistivity 22.0 $\mu\Omega$ cm at 50 C.
12	178	Holgersson, S. and Sedström, E.	1924		323.2		42.36	Calculated composition (30.5 a/o Pd); electrical resistivity 27.0 $\mu\Omega$ cm at 50 C.
13	178	Holgersson, S. and Sedström, E.	1924		323.2		48.94	Calculated composition (36.4 a/o Pd); density 10.12 g $\text{cm}^{-3}$ ; electrical resistivity 29.8 $\mu\Omega$ cm at 50 C.
14	179	Sedström, E.	1924		273.2		3.5	Thermal conductivity value extracted from Schulze, A. ( <i>Z. Anorg. Chem.</i> , <u>159</u> , 325-42, 1927).
15	179	Sedström, E.	1924		273.2		8.7	Same as above; electrical resistivity 6.90 $\mu\Omega$ cm at 0 C.
16	179	Sedström, E.	1924		273.2		11.1	Same data source as above.
17	179	Sedström, E.	1924		273.2		17.3	Same as above; electrical resistivity 11.79 $\mu\Omega$ cm at 0 C.
18	179	Sedström, E.	1924		273.2		42.8	Same as above; electrical resistivity 25.38 $\mu\Omega$ cm at 0 C.
19	179	Sedström, E.	1924		273.2		49.0	Same as above; electrical resistivity 29.67 $\mu\Omega$ cm at 0 C.

TABLE 16. THERMAL CONDUCTIVITY OF PALLADIUM + COPPER ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION

Cur. Ref. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent) Pd Cu	Composition (continued), Specifications, and Remarks
1	61	Grüneisen, E. and Reedemann, H.	1934	L	21-91	18	90.8 9.2	Calculated composition; polycrystalline; electrical resistivity 20.59, 22.18, and 28.05 $\mu\Omega$ cm at 22, 83, and 273 K, respectively.
2	61	Grüneisen, E. and Reedemann, H.	1934	L	21-85	19	62.7 37.3	Calculated composition; electrical resistivity 32.49, 33.68, 36.8, and 37.15 $\mu\Omega$ cm at 22, 83, 273, and 291.60 K, respectively.
3	61	Grüneisen, E. and Reedemann, H.	1934	L	78-87	21a	57.8 42.2	Calculated composition: electrical resistivity 3.168, 5.1, and 5.32 $\mu\Omega$ cm at 83, 273, and 292.6 K, respectively.
4	61	Grüneisen, E. and Reedemann, H.	1934	L	21-92	21b		The above specimen annealed in vacuo for 2 hr at $\sim$ 850 C; electrical resistivity 33.47, 34.01, 36.4, and 36.6 $\mu\Omega$ cm at 22, 83, 273, and 291.60 K, respectively.
5	61	Grüneisen, E. and Reedemann, H.	1934	L	21-80	21c		The above specimen annealed at $\sim$ 325 C for 30 hr; electrical resistivity 2.812, 3.286, and 5.25 $\mu\Omega$ cm at 22, 83, and 273 K, respectively.
6	82	Pott, F.P.	1958	L	298, 823		52.75 47.25	Calculated composition; specimen cut from a 0.2 mm thick sheet; cold-rolled, annealed for 2 hr at $\sim$ 650 C; ordered atomic arrangement; electrical resistivity 7.8, 10.8, and 14.0 $\mu\Omega$ cm at 35, 300, and 590 C, respectively.
7	82	Pott, F.P.	1958	L	298, 623		57.81 42.19	Similar to the above specimen except electrical resistivity 4.3, 7.7, and 11.0 $\mu\Omega$ cm at 0, 291, and 560 C, respectively.
8	82	Pott, F.P.	1958	L	308, 623		70.67 29.33	Similar to the above specimen except electrical resistivity 49.3, 50.6, and 51.4 $\mu\Omega$ cm at 0, 314, and 580 C, respectively.
9	82	Pott, F.P.	1958	L	898, 1048		52.75 47.25	Similar to the above specimen except disordered atomic arrangement and electrical resistivity 28.4, 31.4, and 35.9 $\mu\Omega$ cm at 25, 400, and 792 C, respectively.
10	82	Pott, F.P.	1958	L	298, 1048		57.81 42.19	Similar to the above specimen except electrical resistivity 34.2, 37.4, and 41.4 $\mu\Omega$ cm at 36, 400, and 800 C, respectively.
11	82	Pott, F.P.	1958	L	821, 1073		70.67 29.33	Similar to the above specimen except electrical resistivity 47.6, 49.7, and 51.7 $\mu\Omega$ cm at 32, 400, and 800 C, respectively.
12	178	Holgersson, S. and Sedström, E.	1924		323.2		48.40	Calculated composition (61.1 a/o Cu); electrical resistivity 11.9 $\mu\Omega$ cm at 50 C.
13	178	Holgersson, S. and Sedström, E.	1924		323.2		47.56	Calculated composition (60.3 a/o Cu); electrical resistivity 10.3 $\mu\Omega$ cm at 50 C.
14	178	Holgersson, S. and Sedström, E.	1924		323.2		41.70	Calculated composition (54.5 a/o Cu); density 10.35 g cm <sup>-3</sup> ; electrical resistivity 19.1 $\mu\Omega$ cm at 50 C.
15	178	Holgersson, S. and Sedström, E.	1924		323.2		37.58	Calculated composition (49.8 a/o Cu); electrical resistivity 10.0 $\mu\Omega$ cm at 50 C.
16	178	Holgersson, S. and Sedström, E.	1924		323.2		35.63	Calculated composition (48.1 a/o Cu); density 10.50 g cm <sup>-3</sup> ; electrical resistivity 48.1 $\mu\Omega$ cm at 50 C.
17	178	Holgersson, S. and Sedström, E.	1924		323.2		33.36	Calculated composition (45.6 a/o Cu); density 10.96 g cm <sup>-3</sup> ; electrical resistivity 50.1 $\mu\Omega$ cm at 50 C.
18	178	Holgersson, S. and Sedström, E.	1924		323.2		28.99	Calculated composition (40.6 a/o Cu); electrical resistivity 55.4 $\mu\Omega$ cm at 50 C.

TABLE 16. THERMAL CONDUCTIVITY OF PALLADIUM + COPPER ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION (continued)

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent) Pd Cu	Composition (continued), Specifications, and Remarks
19*	178	Holgersson, S. and Sedström, E.	1924		323.2		20.22	Calculated composition (29.8 a/o Cu); density 11.26 g cm <sup>-3</sup> ; electrical resistivity 51.4 $\mu\Omega$ cm at 50 C.
20	178	Holgersson, S. and Sedström, E.	1924		323.2		14.13	Calculated composition (21.6 a/o Cu); electrical resistivity 41.1 $\mu\Omega$ cm at 50 C.
21	178	Holgersson, S. and Sedström, E.	1924		323.2		6.81	Calculated composition (10.9 a/o Cu); electrical resistivity 29.7 $\mu\Omega$ cm at 50 C.
22	179	Sedström, E.	1924		273.2		51.6	Thermal conductivity value extracted from Schulze, A. (Z. Anorg. Chem., 159, 325-42, 1927); electrical resistivity 11.10 $\mu\Omega$ cm at 0 C.
23	179	Sedström, E.	1924		273.2		52.5	Same as above but electrical resistivity 8.77 $\mu\Omega$ cm at 0 C.
24	179	Sedström, E.	1924		273.2		58.4	Same as above but electrical resistivity 18.28 $\mu\Omega$ cm at 0 C.
25*	179	Sedström, E.	1924		273.2		62.4	Same as above but electrical resistivity 8.26 $\mu\Omega$ cm at 0 C.
26	179	Sedström, E.	1924		273.2		64.4	Same as above but electrical resistivity 47.39 $\mu\Omega$ cm at 0 C.
27	179	Sedström, E.	1924		273.2		66.7	Same data source as above.
28*	179	Sedström, E.	1924		273.2		79.8	Same as above; electrical resistivity 50.76 $\mu\Omega$ cm at 0 C.
29	179	Sedström, E.	1924		273.2		85.9	Same as above but electrical resistivity 40.16 $\mu\Omega$ cm at 0 C.
30	179	Sedström, E.	1924		273.2		93.0	Same as above but electrical resistivity 27.32 $\mu\Omega$ cm at 0 C.

\* Not shown in figure.

#### 4.6. Copper-Zinc Alloy System

The copper-zinc alloy system does not constitute a continuous series of solid solutions. The maximum solid solubility of zinc in copper is 38.3% (39.0 At.%) at 727 K and the solubility decreases at higher and lower temperatures. At lower temperatures, the attainment of equilibrium becomes very slow and the solubility data are uncertain. Massalski and Kittl [86] analyzed the existing data and concluded that the boundary lies at about 35% Zn at 473 K and it may lie at less than 30% Zn at room temperature. Shinoda and Amano [87] reported a much greater reduction in solubility at room temperature.

There are 91 sets of experimental data available for the thermal conductivity of Cu+Zn alloys as listed in table 18 and shown in figure 40. Of these, seven sets are merely single data points, 24 sets cover a narrow temperature range from around room temperature to about 500 K, and 17 sets are for temperatures below 4.5 K. Most of the measurements were on alloys in the solid solution region. Surprisingly there are no data available in the literature for the Zn+Cu alloys. Consequently, only Cu+Zn alloys are treated in the present work.

In order to ascertain the reliability of experimental data and to fill gaps in data, the lattice and electronic components of the thermal conductivity of the Cu+Zn alloys were calculated. The electronic component was calculated from eq (12). However, these calculations were limited to temperatures below 400 K, since no reliable electrical resistivity data were available at higher temperatures. Where values of the electronic components are reported at higher temperatures in table 17, these were obtained by graphical smoothing of the differences between the experimental thermal conductivity data and the calculated values of the lattice thermal conductivity. Estimates of the lattice thermal conductivity in the low temperature region were based on experimental data and values in the high temperature region were calculated from eq (35). In the intermediate range, near the maximum, graphical techniques were used to smoothly join the high and low temperature values (following a crude separation of  $k_e$  as a guide). The high temperature calculations of the lattice component were limited to alloys with Zn not exceeding 30%.

The low-temperature lattice thermal conductivity of solid-solution Cu+Zn alloys in both strained and annealed states has been extensively investigated by Kemp et al. [62,88,89] (curves 17-24 and 27-33). Their results show that the lattice and total thermal conductivities of the alloys increase markedly as the annealing temperature is increased, due to the removal of both point defects and dislocations. This increase is illustrated by curves 30-33 in figure 40 for an alloy with 32% Zn. Apparently the dislocations are locked in by the impurity atoms and cannot be removed by normal annealing just above the recrystallization temperature. Even annealing the alloys at temperatures near the melting point was found to remove only a fraction of the dislocations. In recommending low-temperature lattice thermal conductivities, only the data for alloys annealed at high temperatures were used. The values given in table 17 were based primarily on the data of Kemp et al. [62] for alloys with 5.14 and 10.26% Zn (curves 28 and 29), which were annealed at 1123 K. Because the low-

temperature lattice thermal conductivities of solid-solution Cu+Zn alloys do not vary greatly with composition in the 10-30% Zn range, it was possible to estimate the lattice components of alloys in this range by graphically extending the conductivity-composition curves formed by the 5.14 and 10.26% Zn alloys to higher Zn concentrations, using data of Kemp et al. [88] for alloys annealed at a lower temperature (773 K) (curves 18, 20, and 24) as a guide. Although this procedure should not introduce unacceptable uncertainties, the lattice components reported for the 10-30% Zn alloys should be accepted with more caution than those for which direct, supporting experimental data are available.

Problems were encountered in attempts to develop reliable estimates of the lattice thermal conductivities of the alloys at high temperatures. Initially, the lattice components for the alloys were calculated by using White and Woods' [90,91] value of  $35.0 \text{ W cm}^{-1}$  for the value of  $k_e T$  of pure copper to determine  $k_a(T)$  in eq (35). However, calculations of the lattice components from higher temperature measurements by Kemp et al. [62, 88, 89] (curves 17-24 and 27-33) and Smith [92] (curves 1-13) of the total thermal conductivity and the electrical resistivity for the same alloy samples were as much as 50% higher than the values calculated using eq (35) with White and Woods' values for the lattice component of copper. It was found that this discrepancy could be reduced by increasing the values for the lattice component of pure copper by 50% at high temperatures. This resulted in a much better agreement between experimental and calculated values of the lattice component over the entire range of compositions. However, because of this conflict between White and Woods' value for the lattice component of copper and the available experimental data for copper-zinc alloys, the lattice components of the dilute copper-zinc alloys are not reported at high temperatures.

A graphical comparison of the recommended total thermal conductivity values with selected experimental data is given in figure 38. The smooth solid curves in the figure were obtained by interpolating the recommended values of table 17 in order to obtain thermal conductivity values for the desired alloy compositions. As shown in figure 38, the recommended values are in agreement with the data of Smith [92] (curves 2-8, and 11), of Bailey [151] (curve 15), of Kemp et al. [88] (curves 18, and 20-22), of Kierspe [83] (curve 67), and of Lomer [161] (curves 82 and 84-86) to within 14%. There is a difference of 21% at 20 K between experimental curve 80 and the recommended curve for 1% Zn, but curve 80 is not well documented because we did not have access to the primary data and it is not consistent with curve 81 from the same reference. On the other hand, taking account of the differences in composition, curve 18 for 1.63% Zn supports the recommended curve for 1% Zn. Also, the recommended curves for 0.5 and 1% Zn show local minima not exhibited by the experimental curves; however, in principle there is no reason why these minima should not occur if the lattice component is large enough and there is evidence that the lattice component is significant in this alloy system.

The recommended values for  $k$ ,  $k_e$ , and  $k_a$  are tabulated in table 17 for nine alloy compositions ranging from 0.50 to 30% Zn. These values are for alloys which have not been

severely cold worked or quenched. The values for  $k$  are also presented in figure 39, covering the temperature range from 4 to 700 K. The values of residual electrical resistivity for the alloys are also given in table 17. The uncertainties of the  $k$  values are stated in a footnote to table 17, while the uncer-

tainties of the  $k_e$  and  $k_g$  values are indicated by their being designated as recommended or provisional values. The ranges of uncertainties of recommended and provisional values are less than  $\pm 15\%$  and between  $\pm 15\%$  and  $\pm 30\%$ , respectively.

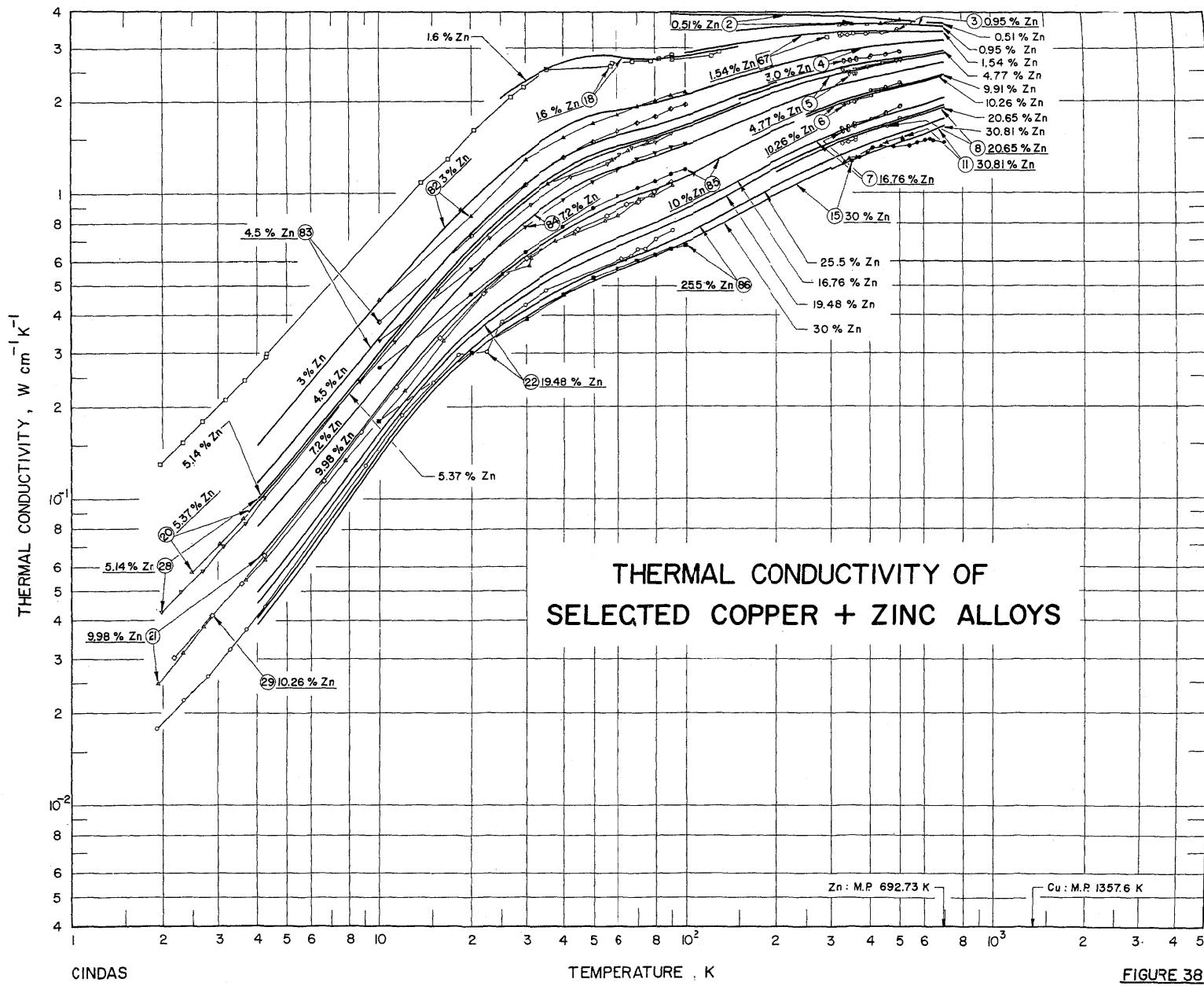


TABLE 17. RECOMMENDED THERMAL CONDUCTIVITY OF COPPER-ZINC ALLOY SYSTEM†  
 [Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Cu: 99.50% (99.51 At.%) Zn: 0.50% ( 0.49 At.%)				Cu: 99.00% (99.03 At.%) Zn: 1.00% ( 0.97 At.%)				Cu: 97.00% (97.08 At.%) Zn: 3.00% ( 2.92 At.%)				Cu: 95.00% (95.13 At.%) Zn: 5.00% ( 4.87 At.%)			
$\rho_0 = 0.1500 \mu\Omega\text{cm}$				$\rho_0 = 0.2650 \mu\Omega\text{cm}$				$\rho_0 = 0.705 \mu\Omega\text{cm}$				$\rho_0 = 1.090 \mu\Omega\text{cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.675*	0.651	0.0235‡	4	0.389	0.369	0.0196‡	4	0.152	0.139	0.0129	4	0.101	0.0897	0.0114
6	1.03*	0.977	0.0565‡	6	0.603	0.553	0.0498‡	6	0.242	0.203	0.0341	6	0.162	0.134	0.0280
8	1.40*	1.30	0.104‡	8	0.834	0.738	0.0960‡	8	0.345	0.277	0.0677	8	0.232	0.179	0.0530
10	1.79*	1.63	0.160‡	10	1.07	0.922	0.148‡	10	0.453	0.347	0.106	10	0.309	0.224	0.0850
15	2.73*	2.44	0.290‡	15	1.64	1.38	0.264‡	15	0.705	0.520	0.185	15	0.496	0.336	0.160
20	3.65*	3.26	0.385‡	20	2.13	1.78	0.346‡	20	0.945	0.693	0.252	20	0.667	0.448	0.219
25	4.13*	3.68	0.447‡	25	2.46	2.06	0.399‡	25	1.15	0.853	0.298‡	25	0.808	0.547	0.261‡
30	4.56*	4.07	0.489‡	30	2.80	2.36	0.434‡	30	1.33	1.00	0.33‡	30	0.935	0.645	0.290‡
40	4.70*	4.16	0.533‡	40	3.14	2.68	0.468‡	40	1.64	1.27	0.366‡	40	1.14	0.823	0.320‡
50	4.69*			50	3.29			50	1.82			50	1.30	0.968	0.327‡
60	4.30*			60	3.23			60	1.89			60	1.39	1.07	0.320‡
70	4.08*			70	3.16			70	1.95			70	1.46	1.15	0.308‡
80	3.90*			80	3.13			80	1.99			80	1.51	1.22	0.295‡
90	3.87*			90	3.13			90	2.05			90	1.58	1.29	0.284‡
100	3.88*			100	3.18			100	2.11			100	1.64	1.37	0.274‡
150	3.81*			150	3.34			150	2.42			150	1.95	1.72	0.230‡
200	3.79*			200	3.47*			200	2.65			200	2.18	1.98	0.198‡
250	3.77*			250	3.50*			250	2.80			250	2.36		
273	3.76*			273	3.52			273	2.85			273	2.41		
300	3.76			300	3.54			300	2.90			300	2.49		
350	3.75			350	3.56			350	2.97			350	2.58		
400	3.74			400	3.57			400	3.03			400	2.65		
500	3.70			500	3.57			500	3.11			500	2.77		
600	3.67*			600	3.57*			600	3.18*			600	2.89*		
700	3.65*			700	3.57*			700	3.26*			700	2.99*		

† Uncertainties in the total thermal conductivity, k, are as follows:

99.50 Cu - 0.50 Zn: ± 14%.

99.00 Cu - 1.00 Zn: ± 14%.

97.00 Cu - 3.00 Zn: ± 14%.

95.00 Cu - 5.00 Zn: ± 10% below 300 K and ± 5% above 300 K.

\* Provisional value.

\*\* In temperature range where no experimental thermal conductivity data are available.

TABLE 17. RECOMMENDED THERMAL CONDUCTIVITY OF COPPER-ZINC ALLOY SYSTEM (continued)†

[Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Cu: 90.00% (90.25 At.%) Zn: 10.00% (9.75 At.%)				Cu: 85.00% (85.36 At.%) Zn: 15.00% (14.64 At.%)				Cu: 80.00% (80.45 At.%) Zn: 20.00% (19.55 At.%)				Cu: 75.00% (75.53 At.%) Zn: 25.00% (24.47 At.%)			
$\rho_0 = 1.840 \mu\Omega\text{cm}$				$\rho_0 = 2.380 \mu\Omega\text{cm}$				$\rho_0 = 2.840 \mu\Omega\text{cm}$				$\rho_0 = 3.200 \mu\Omega\text{cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.0640	0.0581	0.0109	4	0.0519	0.0411	0.0108‡	4	0.0448	0.0344	0.0104‡	4	0.0408	0.0305	0.0103‡
6	0.105	0.0797	0.0254	6	0.0865*	0.0616	0.0249‡	6	0.0759	0.0516	0.0243‡	6	0.0646	0.0458	0.0238‡
8	0.152	0.106	0.0461	8	0.127*	0.0821	0.0448‡	8	0.113	0.0688	0.0441‡	8	0.104	0.0611	0.0433‡
10	0.204	0.133	0.0708	10	0.172*	0.103	0.0694‡	10	0.154	0.0860	0.0680‡	10	0.144	0.0763	0.0672‡
15	0.332	0.199	0.133	15	0.281*	0.154	0.127‡	15	0.254	0.129	0.125‡	15	0.237	0.115	0.122‡
20	0.450	0.266	0.184	20	0.378*	0.205	0.173‡	20	0.338	0.172	0.166‡	20	0.313	0.153	0.160‡
25	0.545	0.325	0.220	25	0.455*	0.252	0.203‡	25	0.402	0.212	0.190‡	25	0.373	0.189	0.184‡
30	0.631	0.388	0.243	30	0.520*	0.299	0.221‡	30	0.459	0.253	0.206‡	30	0.422	0.225	0.197‡
40	0.762	0.503	0.259‡	40	0.623*	0.389	0.234‡	40	0.546	0.329	0.217‡	40	0.497	0.292	0.205‡
50	0.861	0.601	0.260‡	50	0.699*	0.466	0.233‡	50	0.611	0.396	0.215‡	50	0.556	0.353	0.203‡
60	0.938	0.682	0.256‡	60	0.761*	0.534	0.227‡	60	0.660	0.452	0.208‡	60	0.601	0.405	0.196‡
70	0.996	0.748	0.248‡	70	0.811*	0.592	0.219‡	70	0.703	0.503	0.200‡	70	0.638	0.450	0.188‡
80	1.05	0.810	0.238‡	80	0.854	0.644	0.210‡	80	0.742	0.550	0.192‡	80	0.673	0.493	0.180‡
90	1.10	0.869	0.228‡	90	0.898	0.697	0.201‡	90	0.780	0.596	0.184‡	90	0.707	0.535	0.172‡
100	1.15	0.934	0.219‡	100	0.943	0.751	0.192‡	100	0.818	0.643	0.176‡	100	0.742	0.578	0.164‡
150	1.41	1.23	0.183‡	150	1.16	1.00	0.160‡	150	1.01	0.867	0.146‡	150	0.918	0.782	0.136‡
200	1.62	1.47	0.158‡	200	1.35	1.21	0.138‡	200	1.18	1.05	0.126‡	200	1.07	0.951	0.118‡
250	1.79	1.65	0.140‡	250	1.50	1.38	0.122‡	250	1.32	1.20	0.111‡	250	1.20	1.09	0.104‡
273	1.86	1.72	0.139‡	273	1.56	1.44	0.116‡	273	1.37	1.26	0.106‡	273	1.24	1.15	0.0992‡
300	1.93	1.80	0.126‡	300	1.62	1.51	0.110‡	300	1.43	1.33	0.100‡	300	1.30	1.20	0.0940‡
350	2.03	1.92	0.114‡	350	1.73	1.63	0.100‡	350	1.52	1.43	0.0918‡	350	1.39	1.30	0.0859‡
400	2.12	2.02	0.105‡	400	1.81	1.72	0.0925‡	400	1.60	1.51	0.0847‡	400	1.46	1.38	0.0793‡
500	2.29	2.20	0.0910‡	500	1.96	1.88	0.0805‡	500	1.73	1.66	0.0738‡	500	1.59	1.52	0.0692‡
600	2.41‡	2.33	0.0806‡	600	2.09*	2.02	0.0716‡	600	1.86*	1.79	0.0657‡	600	1.70	1.64	0.0617‡
700	2.51‡	2.44	0.0725‡	700	2.20*	2.14	0.0646‡	700	1.96*	1.90	0.0595‡	700	1.78	1.72	0.0559‡

† Uncertainties in the total thermal conductivity, k, are as follows:

90.00 Cu - 10.00 Zn: ±10% below 300 K and ±5% above 300 K.

85.00 Cu - 15.00 Zn: ±10% below 300 K and ±5% above 300 K.

80.00 Cu - 20.00 Zn: ±14% below 70 K and ±10% above 70 K.

75.00 Cu - 25.00 Zn: ±14% below 70 K and ±10% above 70 K.

‡ Provisional value.

\* In temperature range where no experimental thermal conductivity data are available.

TABLE 17. RECOMMENDED THERMAL CONDUCTIVITY OF COPPER-ZINC ALLOY SYSTEM (continued)†

[Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Cu: 70.00% (70.59 At.%) Zn: 30.00% (29.41 At.%)						
$\rho_0 = 3.390 \mu\Omega \text{cm}$						
T	k	k <sub>e</sub>	k <sub>g</sub>			
4	0.0389	0.0288	0.0101‡			
6	0.0667	0.0432	0.0235‡			
8	0.0998	0.0577	0.0421‡			
10	0.138	0.0721	0.0755‡			
15	0.227	0.108	0.119‡			
20	0.300	0.144	0.156‡			
25	0.356	0.178	0.178‡			
30	0.400	0.211	0.189‡			
40	0.472	0.275	0.197‡			
50	0.526	0.331	0.195‡			
60	0.566	0.378	0.188‡			
70	0.601	0.421	0.180‡			
80	0.633	0.462	0.172‡			
90	0.664	0.500	0.164‡			
100	0.697	0.541	0.156‡			
150	0.862	0.732	0.130‡			
200	1.00	0.892	0.112‡			
250	1.12	1.02	0.0991‡			
273	1.17	1.08	0.0943‡			
300	1.22	1.13	0.0894‡			
350	1.30	1.22	0.0817‡			
400	1.37	1.29	0.0755‡			
500	1.49	1.42	0.0659‡			
600	1.59	1.53	0.0588‡			
700	1.66	1.61	0.0534‡			

† Uncertainties in the total thermal conductivity, k, are as follows:  
70.00 Cu - 30.00 Zn:  $\pm 14\%$  below 70 K and  $\pm 10\%$  above 70 K.

‡ Provisional value.

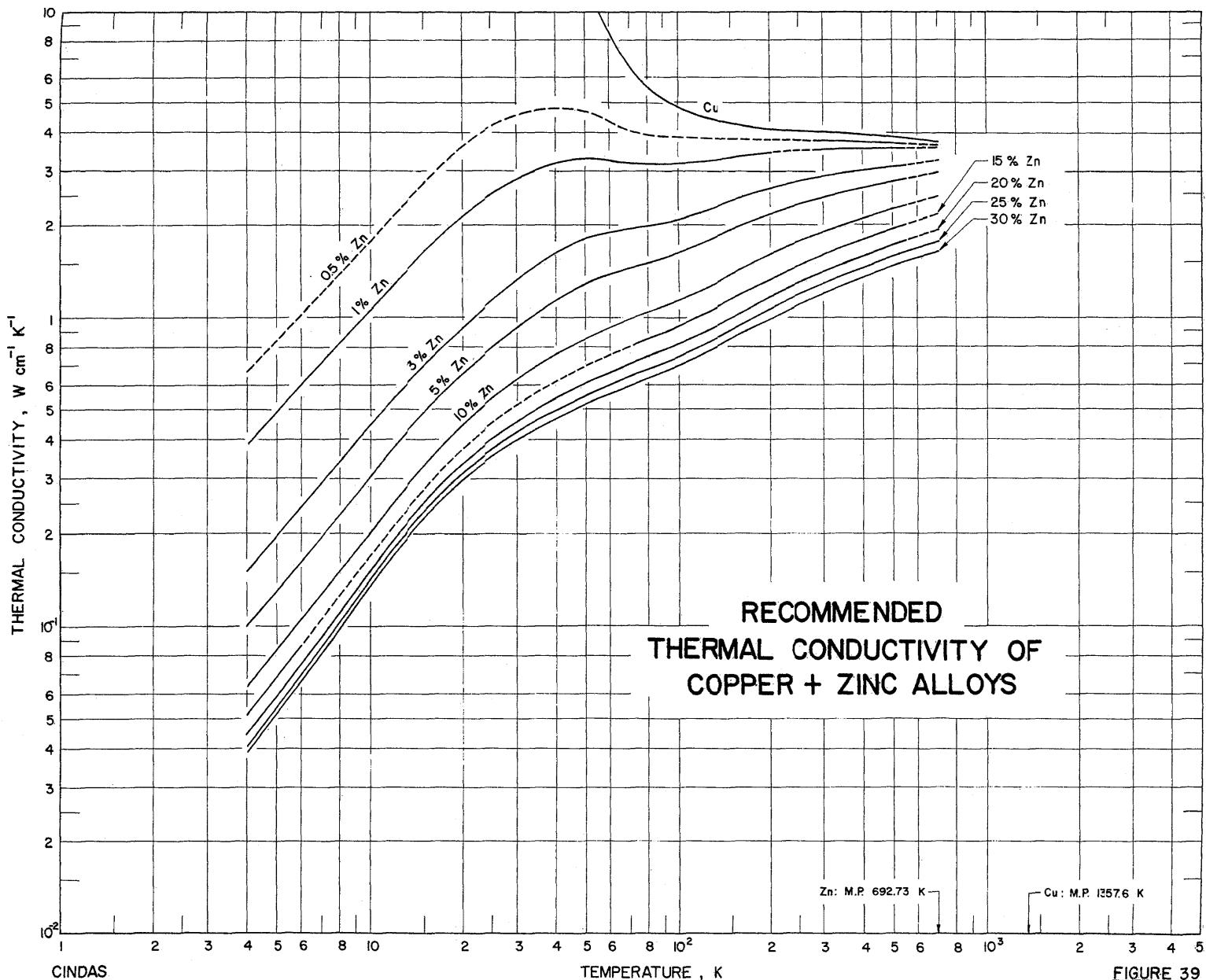


FIGURE 39

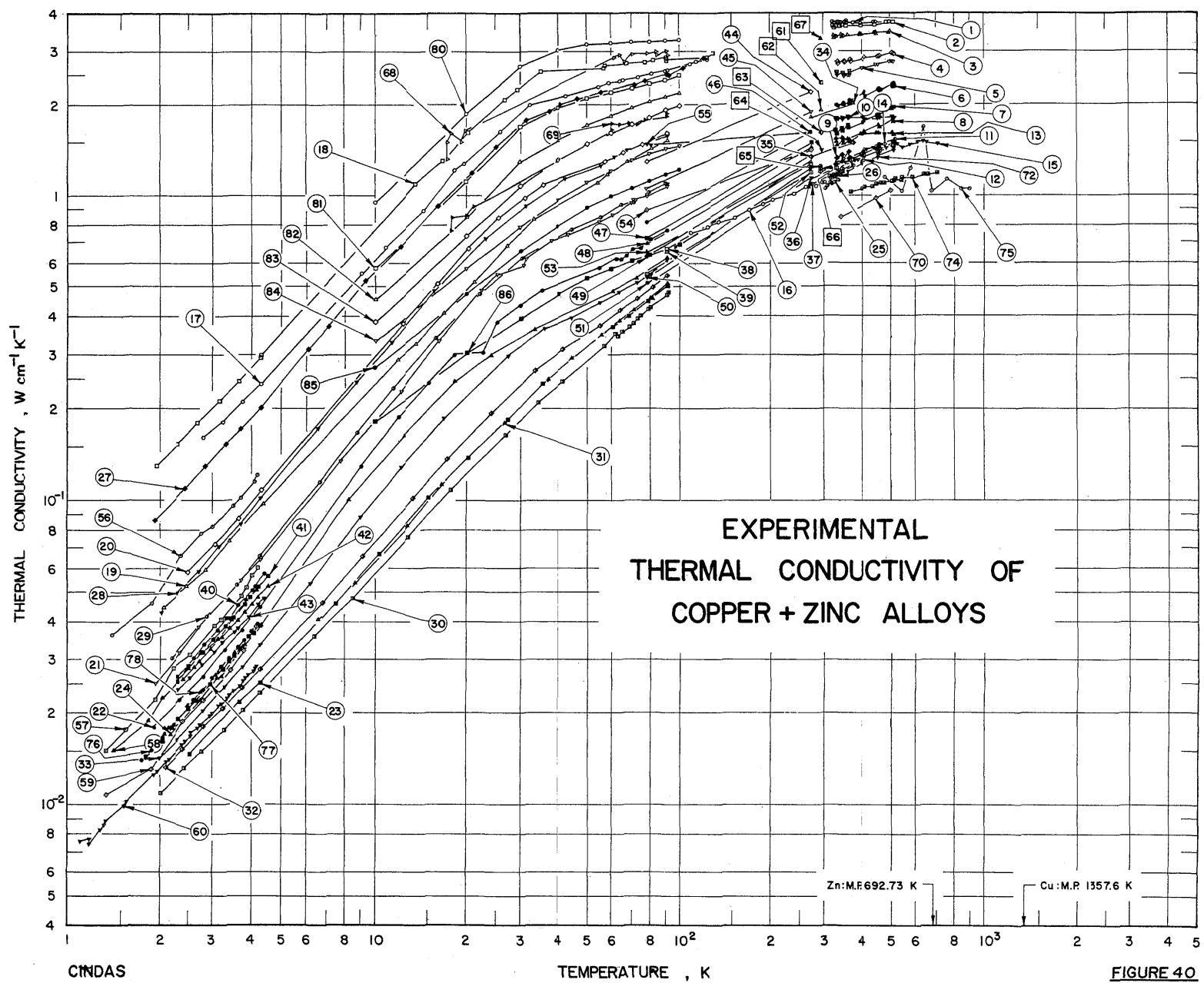


TABLE 18. THERMAL CONDUCTIVITY OF COPPER + ZINC ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent) Cu      Zn	Composition (continued), Specifications, and Remarks
1	92	Smith, C.S.	1930	L	319-494	90	99.64      0.35	0.02 Fe and 0.01 Pb; polycrystalline; cylindrical specimen 13.25 in. long and 0.750 in. diameter; grain size 0.070 mm; annealed at 650 C for 1 hr, cooled in air; electrical conductivity $55.264 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 20 C.
2	92	Smith, C.S.	1930	L	323-501	89	99.45      0.51	0.01 Fe and 0.01 Pb; similar to the above specimen except grain size 0.110 mm and electrical conductivity $53.325 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 20 C.
3	92	Smith, C.S.	1930	L	324-494	73	98.93      0.95	0.02 Fe; similar to the above specimen except annealing temperature 700 C and grain size 0.120 mm; electrical conductivity $47.685 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 20 C.
4	49, 92	Smith, C.S.	1930	L	332-506	12	96.94      3.04	0.02 Fe; similar to the above specimen except annealing time 0.75 hr, grain size 0.100 mm, and electrical conductivity 36.607 and $25.21 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 20 and 200 C, respectively.
5	49, 92	Smith, C.S.	1930	L	328-507	13	95.21      4.77	Similar to the above specimen except grain size 0.085 mm and electrical conductivity 33.062 and $23.31 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 20 and 200 C, respectively.
6	92	Smith, C.S.	1930	L	328-510	14	90.07      9.91	0.01 Fe and 0.01 Pb; similar to the above specimen but grain size 1 mm and electrical conductivity $25.293 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 20 C.
7	92	Smith, C.S.	1930	L	326-504	15	83.20      16.76	0.03 Fe and 0.01 Pb; similar to the above specimen except grain size 0.125 mm and electrical conductivity $20.108 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 20 C.
8	92	Smith, C.S.	1930	L	327-510	16	79.62      20.35	0.01 Fe and 0.02 Pb; similar to the above specimen except grain size 0.190 mm and electrical conductivity $18.459 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 20 C.
9	92	Smith, C.S.	1930	L	325-512	22	59.20      40.75	0.02 Fe and 0.03 Pb; same structure and dimensions as the above specimen; grain size 0.070 mm; annealed at 650 C for 3 hr; cooled in furnace; electrical conductivity $16.700 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 20 C.
10	92	Smith, C.S.	1930	L	328-508	85	50.30      49.49	0.01 Fe and 0.04 Pb; similar to the above specimen but annealing time 2 hr, grain size 16 mm, and electrical conductivity $23.812 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 20 C.
11	92	Smith, C.S.	1930	L	329-512	18	69.14      30.81	0.03 Fe and 0.02 Pb; same structure and dimensions as the above specimen; annealed at 650 C for 0.75 hr, cooled in air; electrical conductivity $15.857 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 20 C.
12	92	Smith, C.S.	1930	L	329-511	21	65.43      34.53	0.01 Fe and 0.03 Pb; similar to the above specimen except grain size 0.080 mm and electrical conductivity $15.325 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 20 C.
13	92	Smith, C.S.	1930	L	326-505	88	54.96      45.02	0.01 Fe; similar to the above specimen except annealing time 2 hr, grain size 0.040 mm, and electrical conductivity $20.466 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 20 C.
14	49	Smith, C.S. and Palmer, E.W.	1935	L	293, 473	19	66.24      33.72	0.03 Pb and 0.01 Fe; annealed at 650 C for 0.75 hr; electrical conductivity 15.63 and $12.24 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 20 and 200 C, respectively.
15	151	Bailey, L.C.	1931	L	351-703	Brass 70/30	70      30	7 to 8 cm long and 0.585 cm in diameter; density $8.44 \text{ g cm}^{-3}$ at 22 C.
16	152	Lees, C.H.	1908	L	108-299	Brass 70/30	70      30	7 to 8 cm long and 0.585 cm in diameter; density $8.44 \text{ g cm}^{-3}$ at 22 C.
17	88	Kemp, W.R.G., Klemens, P.G., Tainsh, R.J., and White, G.K.	1957	L	2.8-123	2S	1.63	~8 cm long and 0.5 cm in diameter; supplied by Johnson Matthey and Co., Ltd.; as drawn; residual electrical resistivity $0.425 \mu\Omega \text{ cm}$ .

TABLE 18. THERMAL CONDUCTIVITY OF COPPER + ZINC ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent) Cu      Zn	Composition (continued), Specifications, and Remarks
18	88	Kemp, W.R.G., Klemens, P.G., Tainsh, R.J., and White, G.K.	1957	L	2.0-130	2		The above specimen annealed at 500 C for 4 hr in helium atmosphere; residual electrical resistivity 0.38 $\mu\Omega$ cm.
19	88	Kemp, W.R.G., et al.	1957	L	2.1-91	5S	5.37	Same dimensions and supplier as the above specimen; as drawn; residual electrical resistivity 1.22 $\mu\Omega$ cm.
20	88	Kemp, W.R.G., et al.	1957	L	2.5-91	5		The above specimen annealed at 500 C for 4 hr in a helium atmosphere; residual electrical resistivity 1.12 $\mu\Omega$ cm.
21	88	Kemp, W.R.G., et al.	1957	L	1.9-91	10	9.98	Similar to the above specimen except residual electrical resistivity 1.88 $\mu\Omega$ cm.
22	88	Kemp, W.R.G., et al.	1957	L	1.9-91	20	19.48	Similar to the above specimen except residual electrical resistivity 2.97 $\mu\Omega$ cm.
23	88	Kemp, W.R.G., et al.	1957	L	2.5-91	30S	31.87	Same dimensions and supplier as the above specimen; as drawn; residual electrical resistivity 4.31 $\mu\Omega$ cm.
24	88	Kemp, W.R.G., et al.	1957	L	2.2-91	30		The above specimen annealed in a helium atmosphere at 500 C for 4 hr; residual electrical resistivity 3.60 $\mu\Omega$ cm.
25	153	Raeth, C.H.	1944	L	302-335	Brass		Cylindrical specimen 2.565 cm long and 5.017 cm <sup>2</sup> in cross-sectional area.
26	153	Raeth, C.H.	1944	L	314-344	Brass		Cylindrical specimen 2.570 cm long and 3.447 cm <sup>2</sup> in cross-sectional area.
27	62	Kemp, W.R.G., Klemens, P.G., and Tainsh, R.J.	1957	L	1.9-121		2.06	8 cm long and 0.5 cm in diameter; drawn; annealed at 850 C for 4 hr; electrical resistivity reported as 0.563, 0.873, and 2.273 $\mu\Omega$ cm at 0, 90, and 293 K, respectively.
28	62	Kemp, W.R.G., et al.	1957	L	2.0-91		5.14	Similar to the above specimen except electrical resistivity reported as 1.20, 1.53, and 3.00 $\mu\Omega$ cm at 0, 90, and 293 K, respectively.
29	62	Kemp, W.R.G., et al.	1957	L	2.2-91		10.26	Similar to the above specimen except electrical resistivity reported as 1.94, 2.31, and 3.89 $\mu\Omega$ cm at 0, 90, and 293 K, respectively.
30	89	Kemp, W.R.G., et al.	1959	L	2.0-91	1	32	$\alpha$ -brass; machined from an annealed and torsionally deformed bar; elec- trical resistivity 4.59, 5.11, and 7.27 $\mu\Omega$ cm at 4.2, 90, and 293 K, respectively.
31	89	Kemp, W.R.G., et al.	1959	L	6.5-91	2		Similar to the above specimen except annealed (after machining) up to 250 C at a rate of 6 C min <sup>-1</sup> ; electrical resistivity 4.20, 4.84, and 6.88 $\mu\Omega$ cm at 4.2, 90, and 293 K, respectively.
32	89	Kemp, W.R.G., et al.	1959	L	2.1-91	3		Similar to the above specimen except annealed (after machining) up to 290 C at a rate of 6 C min <sup>-1</sup> ; electrical resistivity 3.90, 4.49, and 6.58 $\mu\Omega$ cm at 4.2, 90, and 293 K, respectively.
33	89	Kemp, W.R.G., et al.	1959	K	2.0-91	4		Similar to the above specimen except annealed after machining up to 400 C at a rate of 6 C min <sup>-1</sup> ; electrical resistivity 3.66, 4.27, and 6.31 $\mu\Omega$ cm at 4.2, 90, and 293 K, respectively.
34	63	Sedström, E.	1919	T	273, 373		92.65      7.35	Rolled and drawn; annealed close to the melting point for 0.5 hr.
35	63	Sedström, E.	1919	T	273, 373		85.65      14.35	Similar to the above specimen.
36	63	Sedström, E.	1919	T	273, 373		72.11      27.89	Similar to the above specimen.
37	63	Sedström, E.	1919	T	273, 373		66.97      33.03	Similar to the above specimen.

TABLE 18. THERMAL CONDUCTIVITY OF COPPER + ZINC ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent)		Composition (continued), Specifications, and Remarks
							Cu	Zn	
38	154	Eucken, A. and Neumann, O.	1924	L	90, 273	Red brass	82	18	Polycrystalline; grain size $0.006 \text{ cm}^2$ ; electrical conductivity 26.95 and $17.50 \times 10^5 \Omega^{-1} \text{ cm}^{-1}$ at 90 and 273 K, respectively.
39	154	Eucken, A. and Neumann, O.	1924	L	90, 273	Red brass	82	18	Polycrystalline; grain size $0.11 \text{ cm}^2$ ; electrical conductivity 27.36 and $17.75 \times 10^5 \Omega^{-1} \text{ cm}^{-1}$ at 90 and 273 K, respectively.
40	155	Lomer, J.N. and Rosenberg, E.M.	1959	L	2.3-4.4	Brass	85	15	$\alpha$ -brass; 2.5 mm diameter and 4 cm long; prepared from Johnson Matthey spectrographically standardized metals by melting in vacuo, cooling, and swaging; annealed just below melting point for 40 hr.
41	155	Lomer, J.N. and Rosenberg, E.M.	1959	L	2.3-4.5	Brass			The above specimen drawn to produce 4.6% strain.
42	155	Lomer, J.N. and Rosenberg, E.M.	1959	L	2.4-4.5	Brass			The above specimen drawn to produce 10.4% strain.
43	155	Lomer, J.N. and Rosenberg, E.M.	1959	L	2.3-4.4	Brass			The above specimen drawn to produce 19.8% strain.
44	156	Aoyama, S. and Ito, T.	1940	L,R	78, 273	1	95.46	4.54	Prepared from electrolytic copper containing impurities: 0.015 Sb, 0.010 Fe, 0.007 S, 0.0008 As, and 0.0008 Pb; $\alpha$ -brass; annealed in $\text{N}_2$ for 20 hr at 380-400 C; electrical conductivity 6.00 and $3.25 \times 10^5 \Omega^{-1} \text{ cm}^{-1}$ at 78 and 273 K, respectively.
45	156	Aoyama, S. and Ito, T.	1940	L,R	78, 273	2	92.82	7.18	Similar to the above specimen except electrical conductivity 4.59 and $2.71 \times 10^5 \Omega^{-1} \text{ cm}^{-1}$ at 78 and 273 K, respectively.
46	156	Aoyama, S. and Ito, T.	1940	L,R	78, 273	3	86.87	13.13	Similar to the above specimen except electrical conductivity 3.56 and $2.29 \times 10^5 \Omega^{-1} \text{ cm}^{-1}$ at 78 and 273 K, respectively.
47	156	Aoyama, S. and Ito, T.	1940	L,R	78, 273	4	82.55	17.42	Similar to the above specimen except electrical conductivity 3.08 and $2.03 \times 10^5 \Omega^{-1} \text{ cm}^{-1}$ at 78 and 273 K, respectively.
48	156	Aoyama, S. and Ito, T.	1940	L,R	78, 273	5	79.73	20.27	Similar to the above specimen except electrical conductivity 3.04 and $1.99 \times 10^5 \Omega^{-1} \text{ cm}^{-1}$ at 78 and 273 K, respectively.
49	156	Aoyama, S. and Ito, T.	1940	L,R	78, 273	6	75.44	24.56	Similar to the above specimen except electrical conductivity 2.83 and $1.87 \times 10^5 \Omega^{-1} \text{ cm}^{-1}$ at 78 and 273 K, respectively.
50	156	Aoyama, S. and Ito, T.	1940	L,R	73, 273	7	70	30	Similar to the above specimen except electrical conductivity 2.46 and $1.64 \times 10^5 \Omega^{-1} \text{ cm}^{-1}$ at 78 and 273 K, respectively.
51	156	Aoyama, S. and Ito, T.	1940	L,R	73, 273	8	64.05	35.95	Similar to the above specimen except electrical conductivity 2.39 and $1.57 \times 10^5 \Omega^{-1} \text{ cm}^{-1}$ at 78 and 273 K, respectively.
52	156	Aoyama, S. and Ito, T.	1940	L,R	73, 273	9	62.30	37.70	Prepared from the same original materials by the same fabrication method; $\alpha+\beta$ -brass; electrical conductivity 2.63 and $1.61 \times 10^5 \Omega^{-1} \text{ cm}^{-1}$ at 78 and 273 K, respectively.
53	156	Aoyama, S. and Ito, T.	1940	L,R	73, 273	10	59.93	40.07	Similar to the above specimen except electrical conductivity 3.28 and $1.76 \times 10^5 \Omega^{-1} \text{ cm}^{-1}$ at 78 and 273 K, respectively.
54	156	Aoyama, S. and Ito, T.	1940	L,R	73, 273	11	55.62	44.38	Similar to the above specimen except electrical conductivity 4.73 and $2.05 \times 10^5 \Omega^{-1} \text{ cm}^{-1}$ at 78 and 273 K, respectively.
55	156	Aoyama, S. and Ito, T.	1940	L,R	73, 273	12	51.09	48.91	$\beta$ -brass; prepared from the same original materials by the same fabrication method; electrical conductivity 8.25 and $2.50 \times 10^5 \Omega^{-1} \text{ cm}^{-1}$ at 78 and 273 K, respectively.

TABLE 18. THERMAL CONDUCTIVITY OF COPPER + ZINC ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION (continued)

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent) Cu      Zn	Composition (continued), Specifications, and Remarks
56	157	Olsen, T.	1960	L	1.3-4.2	Z4	95.4      4.59	0.01 Pb; cylindrical specimen 10 cm long; machined; annealed for 21 hr at 540 C; electrical resistivity 1.13 and 1.08 $\mu\Omega$ cm at 1.05 and 4.2 K, respectively.
57	157	Olsen, T.	1960	L	1.3-4.2	Z15	84.53      15.43	0.02 Fe and 0.02 Pb; cylindrical specimen 10 cm long; machined; annealed for 21 hr at 540 C; electrical resistivity 2.55 and 2.36 $\mu\Omega$ cm at 1.05 and 4.2 K, respectively.
58	157	Olsen, T.	1960	L	1.4-4.2	Z20	86.56      13.43	0.01 Fe; cylindrical specimen 10 cm long; cold-worked and machined; annealed at 500 C for 17 hr; electrical resistivity 2.73 and 2.58 $\mu\Omega$ cm at 1.05 and 4.2 K, respectively.
59	157	Olsen, T.	1960	L	1.3-4.1	Z30	69.95      30.02	0.02 Fe and 0.01 Pb; cylindrical specimen 10 cm long; machined; annealed for 21 hr at 540 C; electrical resistivity 4.22 and 4.10 $\mu\Omega$ cm at 1.05 and 4.2 K, respectively.
60	158	Gordon, J. E. and Amstutz, L.I.	1965		1.1-4.1	CDA alloy; No. 260	69.3± 0.5      30.7± 0.5	0.07 Si, 0.025 Pb, <0.01 each of Fe, Co, and Ni; strip specimen 0.0150 cm in cross-section and 3.46 cm long; supplied by Chase Brass and Copper Co.; cold-rolled cartridge brass of nominal grain size 0.025-0.050 mm; electrical resistivity 3.78 and 6.65 $\mu\Omega$ cm at 4.2 K and room temperature, respectively.
61	123	Materials in Design Engineering	1959		293.2	Gliding	94.0- 96.0      Bal.	Nominal composition; density 8.86 g cm <sup>-3</sup> .
62	123	Materials in Design Engineering	1959		293.2	Commercial bronze	89.0- 91.0      Bal.	Nominal composition; density 8.80 g cm <sup>-3</sup> .
63	123	Materials in Design Engineering	1959		293.2	Red brass	84.0- 86.0      Bal.	Nominal composition; density 8.75 g cm <sup>-3</sup> .
64	123	Materials in Design Engineering	1959		293.2	Low brass	78.5- 81.5      Bal.	Nominal composition; density 8.66 g cm <sup>-3</sup> .
65	123	Materials in Design Engineering	1959		293.2	Cartridge brass	68.5- 71.5      Bal.	Nominal composition; density 8.53 g cm <sup>-3</sup> .
66	123	Materials in Design Engineering	1959		293.2	Muntz metal	59.0- 63.0      Bal.	Nominal composition; density 8.39 g cm <sup>-3</sup> .
67	83	Kierspe, W.	1967	L	293.2		1.54	Cylindrical specimen.
68	159	Srivastava, B.N., Chatterjee, S., and Sen, S.K.	1969	L	17-92		1.96	Prepared from spectrographically pure rods of copper and zinc, supplied by Johnson Matthey and Co., Ltd, by sealing the metals in appropriate portion in an evacuated quartz tube, heating to 1100 C, shaking thoroughly, cooling to 900 C and maintaining for 5 days, rolled, annealed at 500 C for 6 hr; residual electrical resistivity 0.549 $\mu\Omega$ cm.
69	159	Srivastava, B.N., et al.	1969	L	18-91		4.76	Same fabrication method as the above specimen; residual electrical resistivity 1.043 $\mu\Omega$ cm.
70	44	Griffiths, E. and Schofield, F.H.	1928	L	337-498	Bar 4	60.7      38.5	0.5 Sn and 0.30 Mn; 1 in. diameter and 15 in. long; electrical resistivity 9.3, 9.8, 10.0, 10.4, 10.9, and 11.3 $\mu\Omega$ cm at 20, 75, 100, 150, 200, and 250 C, respectively.
71*	92	Smith, C.S.	1930	L	405-515	Bar 55	81.18      18.63	0.20 Sn, 0.02 Fe, and trace Pb; 0.750 in. diameter and 13.25 in. long; annealed at 700 C for 2 hr; electrical conductivity $18.674 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 20 C.

\* Not shown in figure.

TABLE 18. THERMAL CONDUCTIVITY OF COPPER + ZINC ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION (continued)

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent)		Composition (continued), Specifications, and Remarks
							Cu	Zn	
72	92	Smith, C.S.	1930	L	321-508	Bar '56	71.09	27.77	1.02 Sn, 0.02 Fe, and trace Pb; 0.750 in. diameter and 13.25 in. long; annealed at 700 C for 45 min; electrical conductivity $14.298 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 20 C.
73*	92	Smith, C.S.	1930	L	320-517	Bar 57	59.85	39.36	0.70 Sn, 0.07 Pb, and 0.02 Fe; 0.750 in. diameter and 13.25 in. long; annealed at 650 C for 3 hr; electrical conductivity $15.146 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 20 C.
74	150	Donaldson, J.W.	1925	L	363-702	70:30 brass	70.29	28.71	0.35 Sn, 0.34 Pb, and 0.31 Fe; 0.75 in. diameter and 15.5 in. long; machined from a dry sand-cast bar.
75	160	Tadokoro, Y.	1936	P	479-888	Brass	71.00	28.43	0.25 Pb, 0.24 Fe, and trace Ni and Si; 110 x 110 x 70 mm; annealed at 650 C for 1.5 hr; density $8.062 \text{ g cm}^{-3}$ ; thermal conductivity values calculated from measured thermal diffusivity, specific heat capacity, and density data.
76	52	Charsley, P., Salter, J.A.M., and Leaver, A.D.W.	1968	L	1.8-4.2	$\alpha$ -brass		27.8	Polycrystalline; supplied by the International Research and Development Co., Ltd.; prepared by induction melting; annealed in vacuum at 750 C for 15 hrs, furnace cooled.
77	52	Charsley, P., et al.	1968	L	1.7-4.2	$\alpha$ -brass			The above specimen deformed by tensile strain of 4.4%.
78	120	Leaver, A.D.W. and Charsley, P.	1971	L	2.1-4.1	30 Zn			Similar to the specimen for curve No. 76; deformed by tensile strain of 3.2%.
79*	161	Lomer, J.N.	1958		10-100	0.1 Zn	99.9	0.1	Data taken from smooth curve presented by H. M. Rosenberg [180].
80	161	Lomer, J.N.	1958		10-100	1.0 Zn	99.0	1.0	Similar to above.
81	161	Lomer, J.N.	1958		10-100	2.0 Zn	98.0	2.0	Similar to above.
82	161	Lomer, J.N.	1958		10-100	3.0 Zn	97.0	3.0	Similar to above.
83	161	Lomer, J.N.	1958		10-100	4.5 Zn	95.5	4.5	Similar to above.
84	161	Lomer, J.N.	1958		10-100	7.2 Zn	92.8	7.2	Similar to above.
85	161	Lomer, J.N.	1958		10-100	10.0 Zn	90.0	10.0	Similar to above.
86	161	Lomer, J.N.	1958		10-100	25.5 Zn	74.5	25.5	Similar to above.
87*	172	Kapoor, A., Rowlands, J.A., and Woods, S.B.	1974	L	0.57-4.0	$\alpha$ -Brass	69.4	30.6	Calculated composition (30 a/o Zn); 4 mm diameter x 12 cm long; cast in air, swaged to 0.25 in. diameter, and machined to size; cold worked; residual electrical resistivity $4.59 \mu\Omega \text{ cm}$ .
88*	172	Kapoor, A., et al.	1974	L	0.52-3.9	$\alpha$ -Brass			The above specimen annealed in argon at 600 K for 12 hr; residual electrical resistivity $3.82 \mu\Omega \text{ cm}$ .
89*	172	Kapoor, A., et al.	1974	L	0.71-4.0	$\alpha$ -Brass			The above specimen reannealed in argon at 700 K for 12 hr; residual electrical resistivity $3.77 \mu\Omega \text{ cm}$ .
90*	172	Kapoor, A., et al.	1974	L	0.73-4.0	$\alpha$ -Brass			The above specimen reannealed in argon at 1000 K for 12 hr; residual electrical resistivity $3.86 \mu\Omega \text{ cm}$ .
91*	172	Kapoor, A., et al.	1974	L	0.68-4.0	Brass			Single crystal; 3 mm diameter x 15 cm long; obtained from Windsor Metal Crystals Inc., Md.; residual electrical resistivity $3.53 \mu\Omega \text{ cm}$ .

\* Not shown in figure.

#### 4.7. Gold-Palladium Alloy System

The gold-palladium alloy system forms a continuous series of solid solutions over the entire range of compositions and is free from the complicating effects of any kind of transformations.

There are 14 sets of experimental data available for the thermal conductivity of this alloy system. However, of the nine data sets available for Au + Pd alloys listed in table 20 and shown in figure 45, five sets are merely single data points at room temperature, and all the five data sets available for Pd + Au alloys are single data points at room temperature, as listed in table 21 and shown in figure 46.

The thermal conductivity of these alloys was first investigated by Schulze [93] (Au + Pd curves 1-5 and Pd + Au curves 1-5) who measured the room-temperature thermal conductivity of these alloys at intervals of 10%. These data, which include the only experimental data for this system for palladium concentrations greater than 40%, are thought to be more than 20% too high in some cases. This judgment is based primarily on the fact that interpolation between the values for 30 and 40% Pd yields a value 27% greater than that obtained by Laubitz and van der Meer [85] (Au + Pd curve 8) on a specimen containing 34.95% Pd and is supported by the fact that, after correcting for the lattice component, the Lorenz ratio for the specimen containing 40% Pd (55.24 At. % Pd) is 30% greater than the classical value. It is unlikely that band structure effects could cause such a large deviation from the classical value for this composition at 298 K.

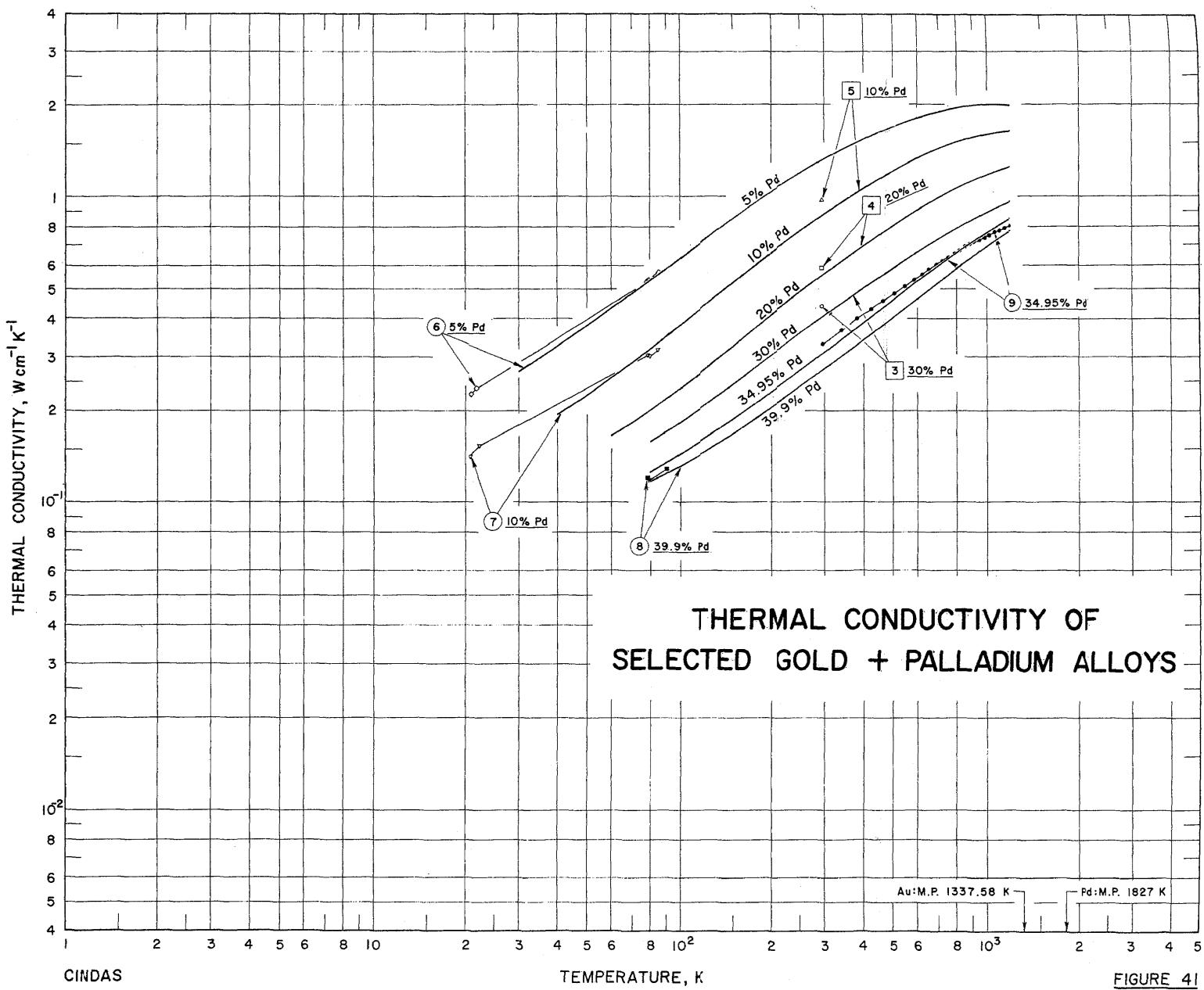
In contrast to this, the early measurements by Grüneisen and Reddemann [61] of the thermal conductivity at liquid hydrogen and liquid nitrogen temperatures of specimens containing 5, 10, and 39.9% Pd (Au + Pd curves 6-8) are thought to be close to the true values. The values calculated from eqs (12) and (35) are in good agreement with these measurements at those temperatures for which it was possible to calculate the lattice component. The investigation by Fletcher and Greig [84] of the thermal conductivity of palladium-silver alloys revealed that the strong electron-phonon interaction in palladium-rich alloys suppresses the low temperature lattice thermal conductivity, causing its maximum to occur at much higher temperatures than in

silver-rich alloys. This elevation of the temperature of the maximum of the lattice component is believed to occur also in this alloy system. The evidence for this is that while the calculated and experimental data for the 5, 10, and 39.9% Pd (8.88, 17.06, and 55.24 At. % Pd) alloys differ by less than 5% at 80 K and while the measured values at liquid hydrogen temperatures of the 5 and 10% Pd specimens are consistent with the calculated values at 30 K, the measured value for the 39.9% Pd specimen is far below the calculated value for 30 K.

At high temperatures the only measurements are those of Laubitz and van der Meer [85], but these range from 300 to 1200 K and provide a test of the temperature dependence of the calculated values of the thermal conductivity of these alloys in this region. While the slope of the calculated curve is slightly steeper than that of the experimental curve, the largest discrepancy between the calculated and experimental values is less than 7%; in view of the 3.5% experimental error estimated for these measurements this is considered satisfactory agreement.

A graphical comparison of the recommended total thermal conductivity values with some of experimental data is given in figures 41 and 42. For gold-rich alloys shown in figure 41, the recommended values are in agreement with the higher temperature portion of the data of Grüneisen and Reddemann [61] (Au + Pd curves 6-8) to within 5%, with the data of Laubitz and Van der Meer [85] (Au + Pd curve 9) to within 7%, and with the data of Schulze [93] (Au + Pd curves 3-5) to within 6 to 10%. For palladium-rich alloys shown in figure 42, the recommended values agree with the data of Schulze [93] to within 3%.

The recommended values for  $k$ ,  $k_e$ , and  $k_s$  are tabulated in table 19 for 25 alloy compositions. These values are for alloys which have not been severely cold worked or quenched. The  $k_e$  values cover the full range of temperature from 4 to 1200 K, whereas the  $k$  and  $k_s$  values are not given for low temperatures. The values for  $k$  are also presented in figures 43 and 44 and their uncertainties are stated in a footnote to table 19, in which the values of residual electrical resistivity for the alloys are also given. The uncertainties of the  $k_e$  and  $k_s$  values are indicated by their being designated as recommended or provisional values. The ranges of uncertainties of recommended and provisional values are less than  $\pm 15\%$  and between  $\pm 15$  and  $\pm 30\%$  respectively.



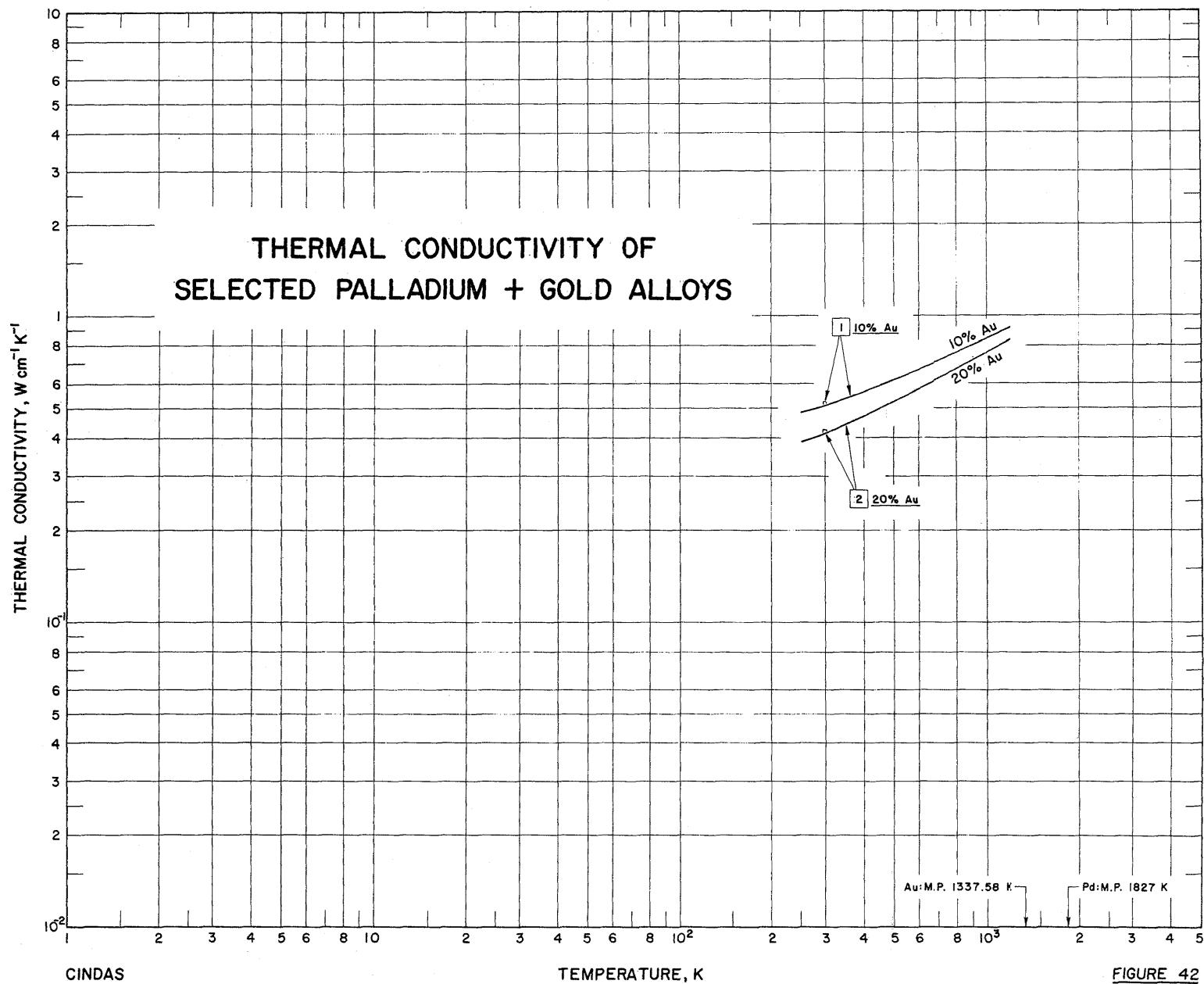


FIGURE 42

TABLE 19. RECOMMENDED THERMAL CONDUCTIVITY OF GOLD-PALLADIUM ALLOY SYSTEM<sup>†</sup>[Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Au: 99.50% (99.08 At.%) Pd: 0.50% (0.92 At.%)				Au: 99.00% (98.16 At.%) Pd: 1.00% (1.84 At.%)				Au: 97.00% (94.58 At.%) Pd: 3.00% (5.42 At.%)				Au: 95.00% (91.12 At.%) Pd: 5.00% (8.88 At.%)			
$\rho_o = 0.3500 \mu\Omega\text{cm}$				$\rho_o = 0.680 \mu\Omega\text{cm}$				$\rho_o = 2.010 \mu\Omega\text{cm}$				$\rho_o = 3.270 \mu\Omega\text{cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.279			4	0.144			4	0.0486			4	0.0299		
6	0.419			6	0.216			6	0.0729			6	0.0448		
8	0.558			8	0.287			8	0.0972			8	0.0598		
10	0.698			10	0.359			10	0.122			10	0.0747		
15	1.05			15	0.539			15	0.182			15	0.112		
20	1.40			20	0.719			20	0.243			20	0.149		
25	1.39			25	0.784			25	0.292			25	0.182		
30	1.57*	1.48	0.0917	30	0.955*	0.878	0.0774	30	0.401*	0.342	0.0593	30	0.269	0.216	0.0535
40	1.68*	1.60	0.0854	40	1.11*	1.04	0.0771	40	0.489*	0.436	0.0534	40	0.328	0.280	0.0479
50	1.75*	1.71	0.0793	50	1.23*	1.17	0.0656	50	0.567*	0.518	0.0488	50	0.382	0.339	0.0436
60	1.88*	1.81	0.0736	60	1.34*	1.28	0.0608	60	0.643*	0.598	0.0451	60	0.436	0.396	0.0402
70	1.96*	1.90	0.0684	70	1.43*	1.38	0.0566	70	0.715*	0.673	0.0419	70	0.488	0.451	0.0374
80	2.02*	1.95	0.0638	80	1.51*	1.46	0.0529	80	0.779*	0.740	0.0392	80	0.537	0.502	0.0350
90	2.10*	2.04	0.0597	90	1.60*	1.55	0.0497	90	0.846*	0.809	0.0369	90	0.587	0.554	0.0329
100	2.18*	2.10	0.0561	100	1.68*	1.64	0.0468	100	0.910*	0.875	0.0349	100	0.635*	0.604	0.0312
150	2.42*	2.37	0.0429	150	2.00*	1.97	0.0366	150	1.19*	1.16	0.0278	150	0.857*	0.832	0.0249
200	2.55*	2.52	0.0348	200	2.18*	2.15	0.0302	200	1.40*	1.38	0.0234	200	1.04*	1.02	0.0211
250	2.64*	2.61	0.0292	250	2.30*	2.28	0.0258	250	1.57*	1.55	0.0203	250	1.20*	1.18	0.0184
273	2.66*	2.63	0.0272	273	2.35*	2.33	0.0242	273	1.63*	1.61	0.0192	273	1.27*	1.25	0.0175
300	2.68*	2.66	0.0252	300	2.40*	2.37	0.0226	300	1.70*	1.69	0.0181	300	1.33*	1.32	0.0165
350	2.72*	2.69	0.0222	350	2.45*	2.43	0.0201	350	1.81*	1.79	0.0163	350	1.45*	1.43	0.0150
400	2.75*	2.73	0.0198	400	2.51*	2.49	0.0181	400	1.91*	1.89	0.0149	400	1.55*	1.54	0.0137
500	2.80*	2.78	0.0163	500	2.57*	2.55	0.0152	500	2.04*	2.03	0.0128	500	1.70*	1.69	0.0119
600	2.75*	2.77	0.0139	600	2.62*	2.61	0.0130	600	2.14*	2.13	0.0113	600	1.82*	1.81	0.0105
700	2.75*	2.74	0.0121	700	2.62*	2.61	0.0115	700	2.20*	2.19	0.0101	700	1.90*	1.89	0.00949
800	2.71*	2.70	0.0107	800	2.59*	2.58	0.0102	800	2.22*	2.21	0.00914	800	1.95*	1.94	0.00866
900	2.65*	2.64	0.00959	900	2.54*	2.54	0.00923	900	2.23*	2.22	0.00837	900	1.99*	1.98	0.00797
1000	2.60*	2.59	0.00870	1000	2.52*	2.51	0.00841	1000	2.23*	2.22	0.00772	1000	2.01*	2.00	0.00740
1100	2.53*	2.52	0.00796	1100	2.46*	2.45	0.00773	1100	2.21*	2.21	0.00717	1100	2.01*	2.01	0.00691
1200	2.47*	2.46	0.00733	1200	2.41*	2.40	0.00715	1200	2.19*	2.18	0.00670	1200	2.00*	2.00	0.00649

<sup>†</sup> Uncertainties in the total thermal conductivity, k, are as follows:99.50 Au - 0.50 Pd:  $\pm 14\%$  below 60 K and  $\pm 10\%$  above 60 K.99.00 Au - 1.00 Pd:  $\pm 14\%$  below 60 K and  $\pm 10\%$  above 60 K.97.00 Au - 3.00 Pd:  $\pm 14\%$  below 60 K and  $\pm 10\%$  above 60 K.95.00 Au - 5.00 Pd:  $\pm 14\%$  below 60 K and  $\pm 10\%$  above 60 K.

\* In temperature range where no experimental thermal conductivity data are available.

TABLE 19. RECOMMENDED THERMAL CONDUCTIVITY OF GOLD-PALLADIUM ALLOY SYSTEM (continued)<sup>a</sup>[Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Au: 90.00% (82.94 At. %) Pd: 10.00% (17.06 At. %)				Au: 85.00% (75.38 At. %) Pd: 15.00% (24.62 At. %)				Au: 80.00% (68.36 At. %) Pd: 20.00% (31.64 At. %)				Au: 75.00% (61.84 At. %) Pd: 25.00% (38.16 At. %)			
$\rho_0 = 6.160 \mu\Omega\text{cm}$				$\rho_0 = 8.65 \mu\Omega\text{cm}$				$\rho_0 = 10.85 \mu\Omega\text{cm}$				$\rho_0 = 12.74 \mu\Omega\text{cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.0159			4	0.0113			4	0.00901			4	0.00767		
6	0.0238			6	0.0169			6	0.0135			6	0.0115		
8	0.0317			8	0.0226			8	0.0180			8	0.0153		
10	0.0397			10	0.0282			10	0.0225			10	0.0192		
15	0.0595			15	0.0424			15	0.0338			15	0.0288		
20	0.0793			20	0.0565			20	0.0450			20	0.0384		
25	0.0965			25	0.0694			25	0.0554			25	0.0474		
30	0.1164	0.115	0.0489	30	0.0829			30	0.0663			30	0.0566		
40	0.195	0.151	0.0435	40	0.152*	0.109	0.0429	40	0.0876			40	0.0749		
50	0.226	0.187	0.0395	50	0.174*	0.135	0.0389	50	0.148*	0.109	0.0396	50	0.0929		
60	0.258	0.222	0.0363	60	0.197*	0.161	0.0358	60	0.166*	0.129	0.0364	60	0.148*	0.111	0.0376
70	0.290	0.256	0.0338	70	0.220*	0.186	0.0333	70	0.184*	0.150	0.0339	70	0.163*	0.128	0.0350
80	0.320	0.289	0.0316	80	0.242*	0.211	0.0312	80	0.202*	0.170	0.0317	80	0.178*	0.146	0.0328
90	0.351	0.322	0.0298	90	0.265*	0.235	0.0294	90	0.220*	0.190	0.0299	90	0.194*	0.163	0.0310
100	0.383*	0.354	0.0282	100	0.287*	0.259	0.0279	100	0.238*	0.209	0.0284	100	0.209*	0.180	0.0294
150	0.529*	0.506	0.0227	150	0.397*	0.375	0.0225	150	0.327*	0.304	0.0230	150	0.285*	0.261	0.0238
200	0.660*	0.640	0.0193	200	0.500*	0.481	0.0192	200	0.412*	0.392	0.0196	200	0.357*	0.337	0.0204
250	0.778*	0.761	0.0170	250	0.594*	0.577	0.0169	250	0.491*	0.473	0.0173	250	0.423*	0.405	0.0180
273	0.829*	0.813	0.0161	273	0.635*	0.169	0.0161	273	0.528*	0.512	0.0165	273	0.452*	0.435	0.0171
300	0.886	0.871	0.0153	300	0.682*	0.666	0.0152	300	0.565	0.549	0.0156	300	0.486*	0.470	0.0162
350	0.983*	0.969	0.0139	350	0.762*	0.748	0.0139	350	0.631*	0.617	0.0143	350	0.544*	0.529	0.0149
400	1.07*	1.06	0.0128	400	0.838*	0.826	0.0129	400	0.695*	0.682	0.0132	400	0.599*	0.586	0.0138
500	1.22*	1.21	0.0112	500	0.966*	0.955	0.0113	500	0.806*	0.795	0.0116	500	0.698*	0.686	0.0121
600	1.34*	1.33	0.00999	600	1.08*	1.07	0.0101	600	0.909*	0.899	0.0104	600	0.785*	0.774	0.0108
700	1.44*	1.43	0.00907	700	1.17*	1.16	0.00917	700	0.996*	0.986	0.00947	700	0.861*	0.851	0.00989
800	1.51*	1.50	0.00832	800	1.25*	1.24	0.00844	800	1.07*	1.06	0.00873	800	0.927*	0.918	0.00912
900	1.57*	1.56	0.00771	900	1.31*	1.30	0.00784	900	1.13*	1.12	0.00812	900	0.981*	0.973	0.00849
1000	1.61*	1.61	0.00720	1000	1.37*	1.36	0.00733	1000	1.19*	1.18	0.00760	1000	1.03*	1.02	0.00796
1100	1.64*	1.64	0.00676	1100	1.41*	1.40	0.00690	1100	1.23*	1.22	0.00716	1100	1.06*	1.05	0.00750
1200	1.66*	1.66	0.00637	1200	1.43*	1.43	0.00652	1200	1.26*	1.25	0.00678	1200	1.09*	1.09	0.00711

<sup>a</sup> Uncertainties in the total thermal conductivity, k, are as follows:

90.00 Au - 10.00 Pd:  $\pm 14\%$  below 150 K and  $\pm 10\%$  above 150 K.  
 85.00 Au - 15.00 Pd:  $\pm 14\%$  below 150 K and  $\pm 10\%$  above 150 K.  
 80.00 Au - 20.00 Pd:  $\pm 14\%$  below 150 K and  $\pm 10\%$  above 150 K.  
 75.00 Au - 25.00 Pd:  $\pm 14\%$  below 150 K and  $\pm 10\%$  above 150 K.

\* In temperature range where no experimental thermal conductivity data are available.

TABLE 19. RECOMMENDED THERMAL CONDUCTIVITY OF GOLD-PALLADIUM ALLOY SYSTEM (continued)<sup>†</sup>  
 [Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Au: 70.00% (55.76 At.%) Pd: 30.00% (44.24 At.%)				Au: 65.00% (50.08 At.%) Pd: 35.00% (49.92 At.%)				Au: 60.00% (44.76 At.%) Pd: 40.00% (55.24 At.%)				Au: 55.00% (39.77 At.%) Pd: 45.00% (60.23 At.%)			
$\rho_0 = 15.00 \mu\Omega\text{cm}$				$\rho_0 = 20.57 \mu\Omega\text{cm}$				$\rho_0 = 23.55 \mu\Omega\text{cm}$				$\rho_0 = 23.19 \mu\Omega\text{cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.00652			4	0.00475			4	0.00415			4	0.00421		
6	0.00977			6	0.00713			6	0.00622			6	0.00632		
8	0.0130			8	0.00950			8	0.00830			8	0.00843		
10	0.0163			10	0.0119			10	0.0104			10	0.0105		
15	0.0244			15	0.0178			15	0.0156			15	0.0158		
20	0.0326			20	0.0238			20	0.0207			20	0.0211		
25	0.0402			25	0.0294			25	0.0257			25	0.0261		
30	0.0451			30	0.0352			30	0.0308			30	0.0312		
40	0.0637			40	0.0466			40	0.0408			40	0.0413		
50	0.0790			50	0.0579			50	0.0507			50	0.0512		
60	0.133*	0.0942	0.0393	60	0.0688			60	0.0605			60	0.0608		
70	0.146*	0.109	0.0365	70	0.0797			70	0.0701			70	0.0703		
80	0.158*	0.124	0.0343	80	0.127*	0.0905	0.0360	80	0.117 <sup>‡</sup>	0.0793	0.0381	80	0.0796		
90	0.171*	0.138	0.0323	90	0.135*	0.101	0.0340	90	0.125 <sup>‡</sup>	0.0887	0.0360	90	0.0889		
100	0.184*	0.153	0.0307	100	0.144*	0.112	0.0323	100	0.132** <sup>‡</sup>	0.0980 <sup>‡</sup>	0.0341 <sup>‡</sup>	100	0.0976		
150	0.246*	0.221	0.0249	150	0.188*	0.162	0.0262	150	0.169** <sup>‡</sup>	0.142 <sup>‡</sup>	0.0277 <sup>‡</sup>	150	0.169** <sup>‡</sup>	0.140 <sup>‡</sup>	0.0295 <sup>‡</sup>
200	0.306*	0.285	0.0213	200	0.231*	0.209	0.0224	200	0.206** <sup>‡</sup>	0.182 <sup>‡</sup>	0.0238 <sup>‡</sup>	200	0.204** <sup>‡</sup>	0.178 <sup>‡</sup>	0.0253 <sup>‡</sup>
250	0.361*	0.342	0.0188	250	0.272*	0.252	0.0199	250	0.240** <sup>‡</sup>	0.219 <sup>‡</sup>	0.0210 <sup>‡</sup>	250	0.236** <sup>‡</sup>	0.213 <sup>‡</sup>	0.0224 <sup>‡</sup>
273	0.385*	0.367	0.0179	273	0.290*	0.27 <sup>‡</sup>	0.0189	273	0.256** <sup>‡</sup>	0.236 <sup>‡</sup>	0.0200 <sup>‡</sup>	273	0.250** <sup>‡</sup>	0.229 <sup>‡</sup>	0.0213 <sup>‡</sup>
300	0.412*	0.396	0.0170	300	0.311	0.293	0.0179	300	0.274 <sup>‡</sup>	0.255 <sup>‡</sup>	0.0190 <sup>‡</sup>	300	0.267 <sup>‡</sup>	0.247 <sup>‡</sup>	0.0202 <sup>‡</sup>
350	0.461*	0.445	0.0156	350	0.349	0.333	0.0164	350	0.303** <sup>‡</sup>	0.291 <sup>‡</sup>	0.0174 <sup>‡</sup>	350	0.293** <sup>‡</sup>	0.280 <sup>‡</sup>	0.0185 <sup>‡</sup>
400	0.507*	0.492	0.0144	400	0.387	0.37 <sup>‡</sup>	0.0152	400	0.341** <sup>‡</sup>	0.325 <sup>‡</sup>	0.0161 <sup>‡</sup>	400	0.323** <sup>‡</sup>	0.311 <sup>‡</sup>	0.0172 <sup>‡</sup>
500	0.589*	0.577	0.0127	500	0.460	0.44 <sup>‡</sup>	0.0134	500	0.405** <sup>‡</sup>	0.39 <sup>‡</sup>	0.0142 <sup>‡</sup>	500	0.385** <sup>‡</sup>	0.370 <sup>‡</sup>	0.0151 <sup>‡</sup>
600	0.662*	0.651	0.0114	600	0.531	0.519	0.0120	600	0.467** <sup>‡</sup>	0.455 <sup>‡</sup>	0.0128 <sup>‡</sup>	600	0.441** <sup>‡</sup>	0.427 <sup>‡</sup>	0.0136 <sup>‡</sup>
700	0.729*	0.718	0.0104	700	0.599	0.588	0.0110	700	0.523** <sup>‡</sup>	0.51 <sup>‡</sup>	0.0116 <sup>‡</sup>	700	0.495** <sup>‡</sup>	0.483 <sup>‡</sup>	0.0124 <sup>‡</sup>
800	0.789*	0.775	0.00959	800	0.660	0.650	0.0101	800	0.587** <sup>‡</sup>	0.576 <sup>‡</sup>	0.0107 <sup>‡</sup>	800	0.546** <sup>‡</sup>	0.535 <sup>‡</sup>	0.0114 <sup>‡</sup>
900	0.842*	0.833	0.00893	900	0.715	0.706	0.00944	900	0.640** <sup>‡</sup>	0.630 <sup>‡</sup>	0.0100 <sup>‡</sup>	900	0.593** <sup>‡</sup>	0.582 <sup>‡</sup>	0.0107 <sup>‡</sup>
1000	0.888*	0.880	0.00838	1000	0.767	0.758	0.00885	1000	0.683** <sup>‡</sup>	0.679 <sup>‡</sup>	0.00939 <sup>‡</sup>	1000	0.634** <sup>‡</sup>	0.624 <sup>‡</sup>	0.0100 <sup>‡</sup>
1100	0.930*	0.922	0.00790	1100	0.815	0.807	0.00835	1100	0.734** <sup>‡</sup>	0.725 <sup>‡</sup>	0.00886 <sup>‡</sup>	1100	0.680** <sup>‡</sup>	0.671 <sup>‡</sup>	0.00943 <sup>‡</sup>
1200	0.972*	0.965	0.00749	1200	0.864	0.856	0.00792	1200	0.782** <sup>‡</sup>	0.773 <sup>‡</sup>	0.00840 <sup>‡</sup>	1200	0.724** <sup>‡</sup>	0.715 <sup>‡</sup>	0.00894 <sup>‡</sup>

† Uncertainties in the total thermal conductivity, k, are as follows:

70.00 Au - 30.00 Pd:  $\pm 14\%$  below 150 K and  $\pm 10\%$  above 150 K.

65.00 Au - 35.00 Pd:  $\pm 14\%$  below 150 K and  $\pm 10\%$  above 150 K.

60.00 Au - 40.00 Pd:  $\pm 20\%$  below 150 K and  $\pm 15\%$  above 150 K.

55.00 Au - 45.00 Pd:  $\pm 15\%$ .

‡ Provisional value.

\* In temperature range where no experimental thermal conductivity data are available.

TABLE 19. RECOMMENDED THERMAL CONDUCTIVITY OF GOLD-PALLADIUM ALLOY SYSTEM (continued)†  
 [Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Au: 50.00% (35.07 At.%) Pd: 50.00% (64.93 At.%)				Au: 45.00% (30.65 At.%) Pd: 55.00% (69.35 At.%)				Au: 40.00% (26.48 At.%) Pd: 60.00% (73.52 At.%)				Au: 35.00% (22.53 At.%) Pd: 65.00% (77.47 At.%)			
$\rho_0 = 21.54 \mu\Omega\text{cm}$				$\rho_0 = 19.33 \mu\Omega\text{cm}$				$\rho_0 = 17.00 \mu\Omega\text{cm}$				$\rho_0 = 14.70 \mu\Omega\text{cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.00454			4	0.00505			4	0.00575			4	0.00665		
6	0.00681			6	0.00758			6	0.00862			6	0.00997		
8	0.00907			8	0.0101			8	0.0115			8	0.0133		
10	0.0113			10	0.0126			10	0.0144			10	0.0166		
15	0.0170			15	0.0190			15	0.0216			15	0.0249		
20	0.0227			20	0.0253			20	0.0287			20	0.0332		
25	0.0281			25	0.0313			25	0.0353			25	0.0408		
30	0.0336			30	0.0373			30	0.0421			30	0.0486		
40	0.0444			40	0.0492			40	0.0553			40	0.0635		
50	0.0548			50	0.0605			50	0.0678			50	0.0776		
60	0.0649			60	0.0714			60	0.0798			60	0.0908		
70	0.0748			70	0.0820			70	0.0914			70	0.103		
80	0.0845			80	0.0923			80	0.103			80	0.116		
90	0.0941			90	0.102			90	0.114			90	0.127		
100	0.103			100	0.112			100	0.124			100	0.139		
150	0.178*‡	0.146‡	0.0315‡	150	0.156			150	0.170			150	0.187		
200	0.211*‡	0.184‡	0.0270‡	200	0.223*‡	0.194‡	0.0290‡	200	0.241*‡	0.209‡	0.0314‡	200	0.261*‡	0.227‡	0.0342‡
250	0.242*‡	0.218‡	0.0239‡	250	0.254*‡	0.228‡	0.0257‡	250	0.271*‡	0.243‡	0.0278‡	250	0.291*‡	0.261‡	0.0302‡
273	0.255*‡	0.232‡	0.0228‡	273	0.269*‡	0.244‡	0.0245‡	273	0.284*‡	0.258‡	0.0265‡	273	0.304*‡	0.275‡	0.0288‡
300	0.271‡	0.249‡	0.0216‡	300	0.283*‡	0.260‡	0.0232‡	300	0.300‡	0.274‡	0.0251‡	300	0.319*‡	0.292‡	0.0273‡
350	0.301*‡	0.281‡	0.0198‡	350	0.312*‡	0.291‡	0.0213‡	350	0.329*‡	0.306‡	0.0230‡	350	0.349*‡	0.324‡	0.0250‡
400	0.329*‡	0.311‡	0.0184‡	400	0.340*‡	0.320‡	0.0197‡	400	0.357*‡	0.335‡	0.0213‡	400	0.374*‡	0.351‡	0.0231‡
500	0.383*‡	0.367‡	0.0161‡	500	0.392*‡	0.375‡	0.0173‡	500	0.409*‡	0.391‡	0.0187‡	500	0.432*‡	0.412‡	0.0203‡
600	0.435*‡	0.420‡	0.0145‡	600	0.442*‡	0.426‡	0.0156‡	600	0.459*‡	0.443‡	0.0168‡	600	0.482*‡	0.464‡	0.0183‡
700	0.483*‡	0.470‡	0.0132‡	700	0.488*‡	0.474‡	0.0142‡	700	0.506*‡	0.490‡	0.0153‡	700	0.528*‡	0.512‡	0.0166‡
800	0.529*‡	0.517‡	0.0122‡	800	0.531*‡	0.518‡	0.0131‡	800	0.549*‡	0.535‡	0.0141‡	800	0.570*‡	0.554‡	0.0153‡
900	0.572*‡	0.561‡	0.0114‡	900	0.571*‡	0.559‡	0.0122‡	900	0.588*‡	0.575‡	0.0132‡	900	0.609*‡	0.594‡	0.0143‡
1000	0.615*‡	0.604‡	0.0107‡	1000	0.609*‡	0.598‡	0.0115‡	1000	0.626*‡	0.614‡	0.0123‡	1000	0.646*‡	0.633‡	0.0134‡
1100	0.657*‡	0.647‡	0.0101‡	1100	0.639*‡	0.628‡	0.0108‡	1100	0.663*‡	0.652‡	0.0116‡	1100	0.683*‡	0.671‡	0.0126‡
1200	0.701*‡	0.692‡	0.00955‡	1200	0.686*‡	0.676‡	0.0102‡	1200	0.700*‡	0.689‡	0.0110‡	1200	0.719*‡	0.707‡	0.0120‡

† Uncertainties in the total thermal conductivity, k, are as follows:

50.00 Au - 50.00 Pd: ±15%.  
 45.00 Au - 55.00 Pd: ±15%.  
 40.00 Au - 60.00 Pd: ±15%.  
 35.00 Au - 65.00 Pd: ±15%.

‡ Provisional value.

\* In temperature range where no experimental thermal conductivity data are available.

TABLE 19. RECOMMENDED THERMAL CONDUCTIVITY OF GOLD-PALLADIUM ALLOY SYSTEM (continued)†

[Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Au: 30.00% (18.80 At.%) Pd: 70.00% (81.20 At.%)				Au: 25.00% (15.26 At.%) Pd: 75.00% (84.74 At.%)				Au: 20.00% (11.90 At.%) Pd: 80.00% (88.10 At.%)				Au: 15.00% (8.70 At.%) Pd: 85.00% (91.30 At.%)			
$\rho_0 = 13.00 \mu\Omega\text{cm}$				$\rho_0 = 10.19 \mu\Omega\text{cm}$				$\rho_0 = 8.00 \mu\Omega\text{cm}$				$\rho_0 = 5.850 \mu\Omega\text{cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.00752			4	0.00959			4	0.0122			4	0.0167		
6	0.0113			6	0.0144			6	0.0183			6	0.0251		
8	0.0150			8	0.0192			8	0.0244			8	0.0334		
10	0.0188			10	0.0240			10	0.0305			10	0.0417		
15	0.0282			15	0.0360			15	0.0458			15	0.0626		
20	0.0376			20	0.0479			20	0.0611			20	0.0835		
25	0.0459			25	0.0584			25	0.0741			25	0.0993		
30	0.0545			30	0.0692			30	0.0875			30	0.116		
40	0.0710			40	0.0897			40	0.112			40	0.147		
50	0.0864			50	0.108			50	0.134			50	0.173		
60	0.101			60	0.125			60	0.153			60	0.194		
70	0.114			70	0.140			70	0.170			70	0.214		
80	0.128			80	0.155			80	0.187			80	0.232		
90	0.140			90	0.170			90	0.202			90	0.250		
100	0.152			100	0.183			100	0.216			100	0.264		
150	0.202			150	0.236			150	0.271			150	0.317		
200	0.280**‡	0.243‡	0.0376‡	200	0.319**‡	0.278‡	0.0418‡	200	0.330**‡	0.313‡	0.0472‡	200	0.355		
250	0.311**‡	0.277‡	0.0332‡	250	0.349**‡	0.312‡	0.0369‡	250	0.337**‡	0.345‡	0.0417‡	250	0.433**‡	0.384‡	0.0482‡
273	0.324**‡	0.292‡	0.0318‡	273	0.361**‡	0.326‡	0.0351‡	273	0.399**‡	0.359‡	0.0396‡	273	0.443**‡	0.397‡	0.0458‡
300	0.341‡	0.311‡	0.0300‡	300	0.377**‡	0.344‡	0.0333‡	300	0.413‡	0.376‡	0.0375‡	300	0.457**‡	0.414‡	0.0434‡
350	0.372**‡	0.344‡	0.0274‡	350	0.408**‡	0.378‡	0.0304‡	350	0.444‡	0.410‡	0.0343‡	350	0.487**‡	0.447‡	0.0396‡
400	0.402**‡	0.377‡	0.0254‡	400	0.438**‡	0.409‡	0.0282‡	400	0.474‡	0.442‡	0.0317‡	400	0.516**‡	0.479‡	0.0366‡
500	0.459**‡	0.437‡	0.0223‡	500	0.492**‡	0.467‡	0.0247‡	500	0.528‡	0.500‡	0.0277‡	500	0.570**‡	0.539‡	0.0319‡
600	0.511**‡	0.491‡	0.0200‡	600	0.542**‡	0.520‡	0.0221‡	600	0.578‡	0.553‡	0.0248‡	600	0.619**‡	0.591‡	0.0285‡
700	0.557**‡	0.539‡	0.0182‡	700	0.588**‡	0.568‡	0.0201‡	700	0.626‡	0.604‡	0.0226‡	700	0.666**‡	0.640‡	0.0259‡
800	0.602**‡	0.585‡	0.0168‡	800	0.633**‡	0.615‡	0.0185‡	800	0.672‡	0.652‡	0.0208‡	800	0.709**‡	0.685‡	0.0237‡
900	0.645**‡	0.629‡	0.0156‡	900	0.677‡	0.660‡	0.0172‡	900	0.717‡	0.698‡	0.0193‡	900	0.757**‡	0.735‡	0.0220‡
1000	0.681**‡	0.667‡	0.0146‡	1000	0.716**‡	0.700‡	0.0161‡	1000	0.756‡	0.738‡	0.0180‡	1000	0.797**‡	0.776‡	0.0205‡
1100	0.718**‡	0.704‡	0.0138‡	1100	0.754**‡	0.739‡	0.0152‡	1100	0.795‡	0.778‡	0.0169‡	1100	0.836**‡	0.817‡	0.0193‡
1200	0.753**‡	0.740‡	0.0130‡	1200	0.791**‡	0.776‡	0.0144‡	1200	0.832‡	0.816‡	0.0160‡	1200	0.871**‡	0.853‡	0.0182‡

† Uncertainties in the total thermal conductivity, k, are as follows:

30.00 Au - 70.00 Pd: ±15%.

25.00 Au - 75.00 Pd: ±15%.

20.00 Au - 80.00 Pd: ±15%.

15.00 Au - 85.00 Pd: ±15%.

‡ Provisional value.

\* In temperature range where no experimental thermal conductivity data are available.

TABLE 19. RECOMMENDED THERMAL CONDUCTIVITY OF GOLD-PALLADIUM ALLOY SYSTEM (continued)†  
 [Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Au: 10.00% ( 5.66 At.%) Pd: 90.00% (94.34 At.%)				Au: 5.00% ( 2.76 At.%) Pd: 95.00% (97.24 At.%)				Au: 3.00% ( 1.64 At.%) Pd: 97.00% (98.36 At.%)				Au: 1.00% ( 0.54 At.%) Pd: 99.00% (99.46 At.%)			
$\rho_o = 3.850 \mu\Omega \text{ cm}$				$\rho_o = 1.900 \mu\Omega \text{ cm}$				$\rho_o = 1.100 \mu\Omega \text{ cm}$				$\rho_o = 0.3800 \mu\Omega \text{ cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.0254			4	0.0514			4	0.0888			4	0.257		
6	0.0381			6	0.0771			6	0.133			6	0.386		
8	0.0508			8	0.103			8	0.178			8	0.514		
10	0.0635			10	0.129			10	0.222			10	0.643		
15	0.0952			15	0.193			15	0.333			15	0.964		
20	0.127			20	0.257			20	0.444			20	1.29		
25	0.151			25	0.296			25	0.483			25	1.16		
30	0.175			30	0.337			30	0.533			30	1.15		
40	0.227			40	0.393			40	0.576			40	1.03		
50	0.247			50	0.418			50	0.569			50	0.871		
60	0.269			60	0.423			60	0.550			60	0.762		
70	0.288			70	0.430			70	0.537			70	0.699		
80	0.305			80	0.435			80	0.527			80	0.663		
90	0.322			90	0.444			90	0.520			90	0.637		
100	0.333			100	0.447			100	0.515			100	0.615		
150	0.377			150	0.462			150	0.505			150	0.559		
200	0.407			200	0.475			200	0.508			200	0.545		
250	0.489**‡	0.431‡	0.0582‡	250	0.566**‡	0.489‡	0.0775‡	250	0.610**‡	0.517‡	0.0930‡	250	0.548		
273	0.497**‡	0.442‡	0.0553‡	273	0.571**‡	0.497‡	0.0734‡	273	0.612**‡	0.524‡	0.0879‡	273	0.671**‡	0.553‡	0.118‡
300	0.509‡	0.457‡	0.0523‡	300	0.580**‡	0.510‡	0.0692‡	300	0.616**‡	0.534‡	0.0826‡	300	0.675**‡	0.565‡	0.110‡
350	0.538**‡	0.490‡	0.0476‡	350	0.606**‡	0.544‡	0.0627‡	350	0.640**‡	0.566‡	0.0745‡	350	0.691**‡	0.593‡	0.0977‡
400	0.566**‡	0.522‡	0.0439‡	400	0.629**‡	0.572‡	0.0575‡	400	0.662**‡	0.594‡	0.0679‡	400	0.706**‡	0.618‡	0.0875‡
500	0.617**‡	0.578‡	0.0382‡	500	0.677**‡	0.627‡	0.0495‡	500	0.704**‡	0.646‡	0.0579‡	500	0.739**‡	0.666‡	0.079‡
600	0.665**‡	0.631‡	0.0339‡	600	0.720**‡	0.677‡	0.0437‡	600	0.746**‡	0.695‡	0.0506‡	600	0.778**‡	0.715‡	0.0625‡
700	0.711**‡	0.681‡	0.0307‡	700	0.761**‡	0.722‡	0.0392‡	700	0.786**‡	0.741‡	0.0451‡	700	0.816**‡	0.761‡	0.0546‡
800	0.754**‡	0.726‡	0.0281‡	800	0.806**‡	0.770‡	0.0356‡	800	0.829**‡	0.788‡	0.0406‡	800	0.856**‡	0.807‡	0.0485‡
900	0.800**‡	0.774‡	0.0259‡	900	0.850**‡	0.817‡	0.0326‡	900	0.872**‡	0.835‡	0.0370‡	900	0.898**‡	0.855‡	0.0437‡
1000	0.841**‡	0.817‡	0.0241‡	1000	0.887**‡	0.857‡	0.0301‡	1000	0.909**‡	0.875‡	0.0340‡	1000	0.933**‡	0.893‡	0.0397‡
1100	0.880**‡	0.857‡	0.0226‡	1100	0.925**‡	0.897‡	0.0280‡	1100	0.949**‡	0.917‡	0.0314‡	1100	0.972**‡	0.935‡	0.0364‡
1200	0.918**‡	0.897‡	0.0213‡	1200	0.958**‡	0.932‡	0.0262‡	1200	0.984**‡	0.955‡	0.0293‡	1200	1.01**‡	0.980‡	0.0336‡

† Uncertainties in the total thermal conductivity, k, are as follows:

10.00 Au - 90.00 Pd: ±15%.  
 5.00 Au - 95.00 Pd: ±15%.  
 3.00 Au - 97.00 Pd: ±15%.  
 1.00 Au - 99.00 Pd: ±15%.

‡ Provisional value.

\* In temperature range where no experimental thermal conductivity data are available.

TABLE 19. RECOMMENDED THERMAL CONDUCTIVITY OF GOLD-PALLADIUM ALLOY SYSTEM (continued)†

[Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Au: 0.50% ( 0.27 At.%) Pd: 99.50% (99.73 At.%)			
$\rho_0 = 0.2600 \mu\Omega \text{ cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.376		
6	0.564		
8	0.752		
10	0.940		
15	1.41		
20	1.88		
25	1.51		
30	1.42		
40	1.16		
50	0.944		
60	0.803		
70	0.728		
80	0.688		
90	0.667		
100	0.641		
150	0.568		
200	0.553		
250	0.553		
273	0.691*‡	0.558*‡	0.133*‡
300	0.693*‡	0.569*‡	0.123*‡
350	0.705*‡	0.597*‡	0.108*‡
400	0.719*‡	0.622*‡	0.0964*‡
500	0.751*‡	0.672*‡	0.0791*‡
600	0.788*‡	0.721*‡	0.0671*‡
700	0.823*‡	0.765*‡	0.0581*‡
800	0.863*‡	0.811*‡	0.0513*‡
900	0.903*‡	0.857*‡	0.0460*‡
1000	0.939*‡	0.898*‡	0.0416*‡
1100	0.978*‡	0.940*‡	0.0380*‡
1200	1.02*‡	0.983*‡	0.0350*‡

† Uncertainties in the total thermal conductivity, k, are as follows:

0.50 Au - 99.50 Pd: ±15%.

‡ Provisional value.

\* In temperature range where no experimental thermal conductivity data are available.

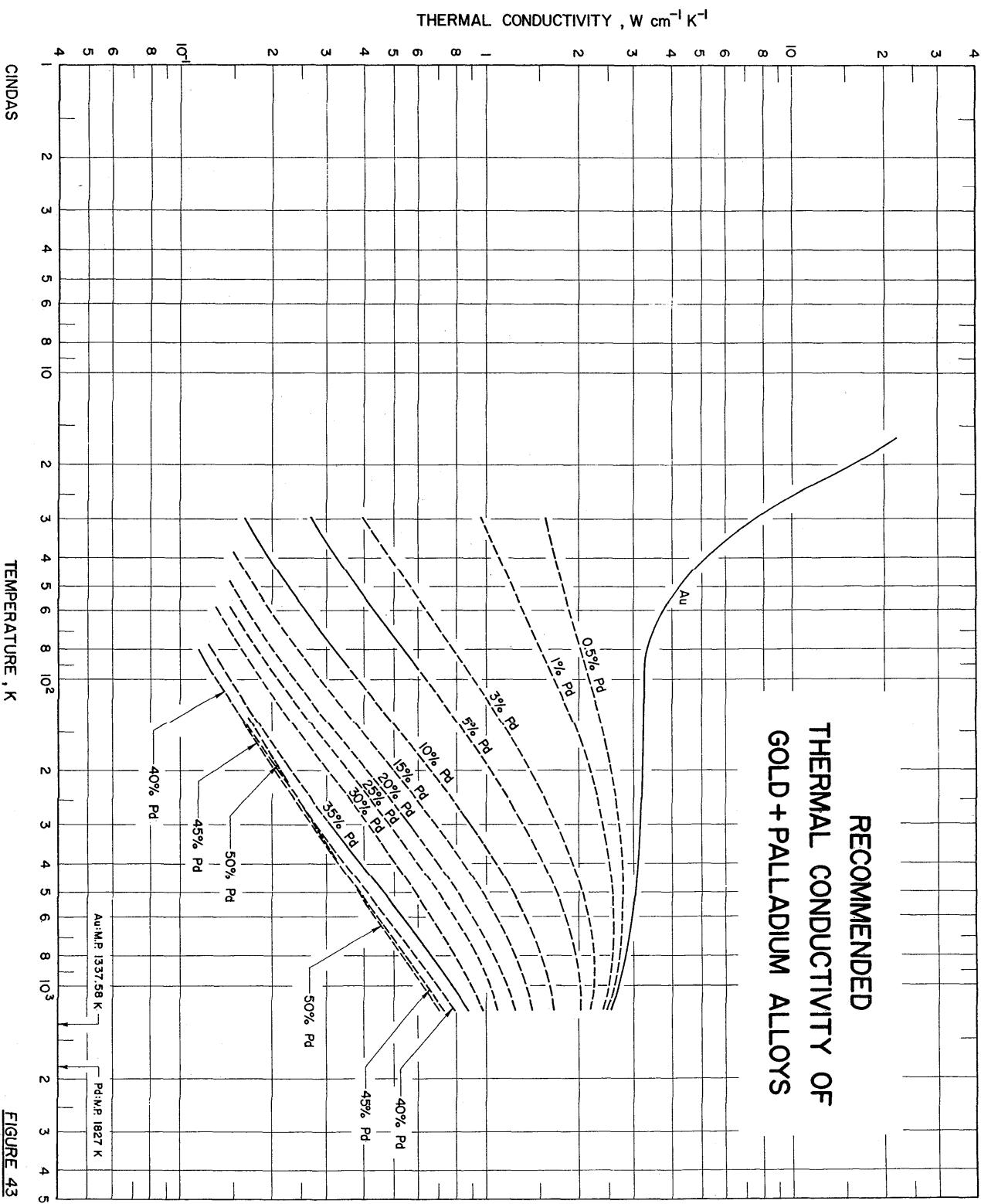


FIGURE 43

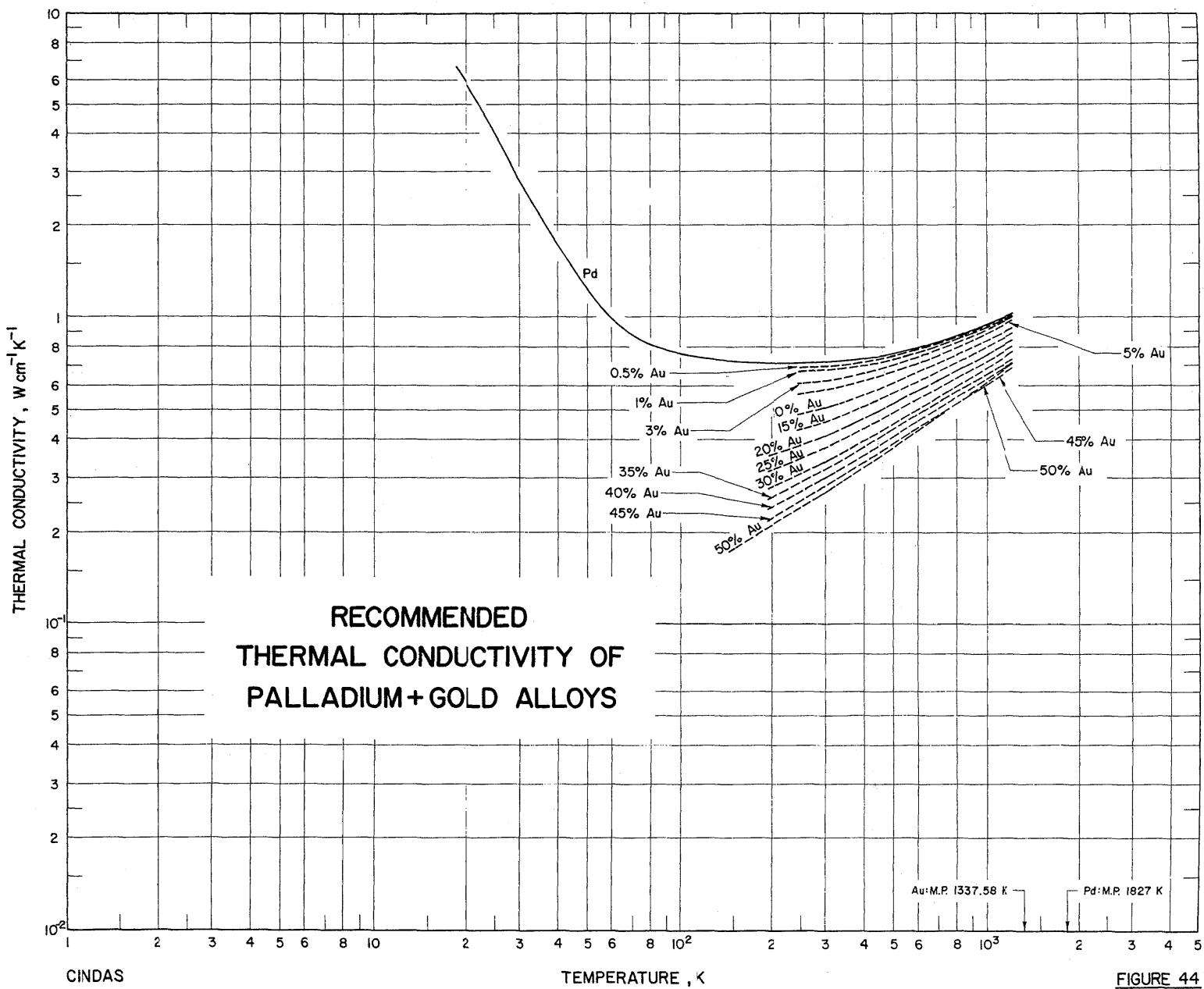


FIGURE 44

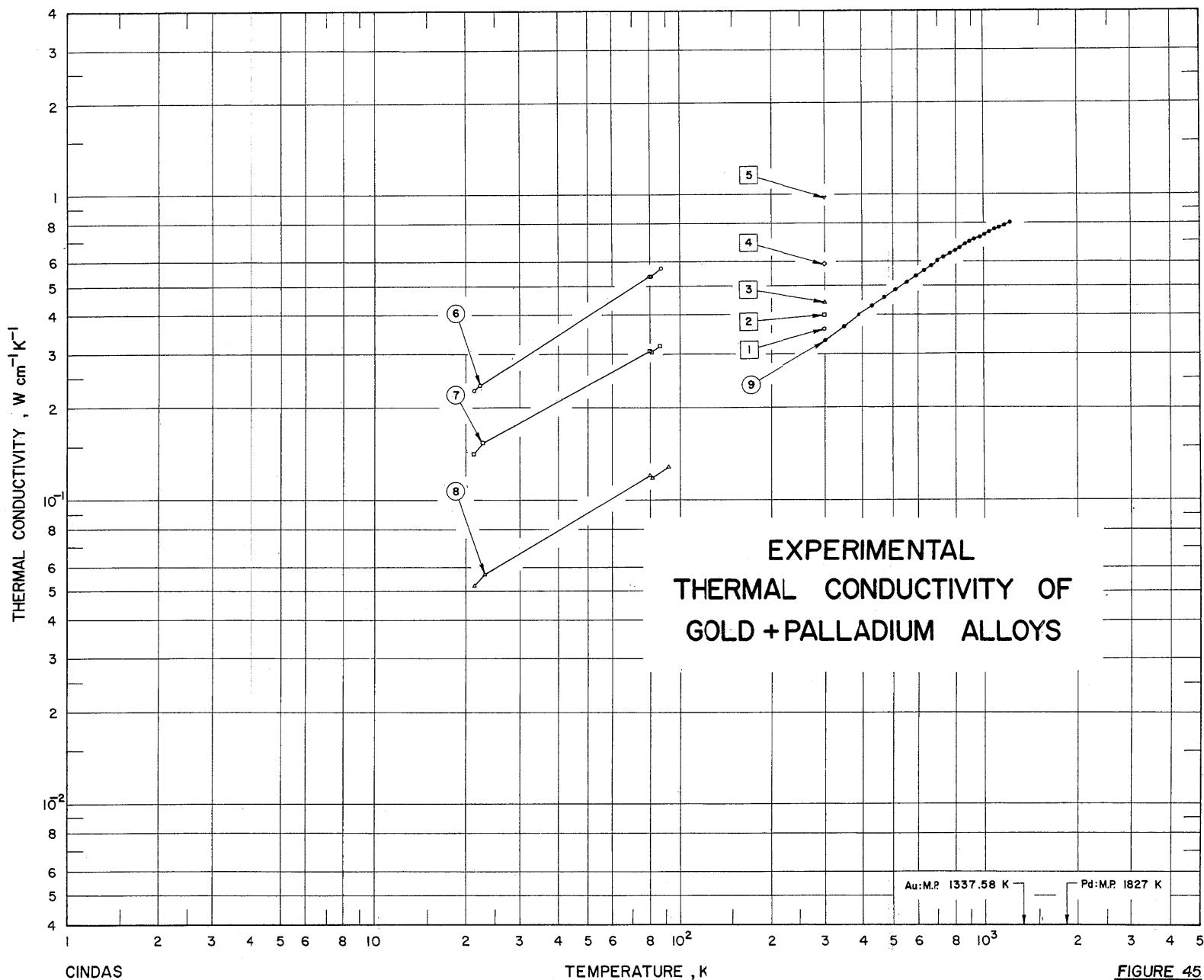


FIGURE 45

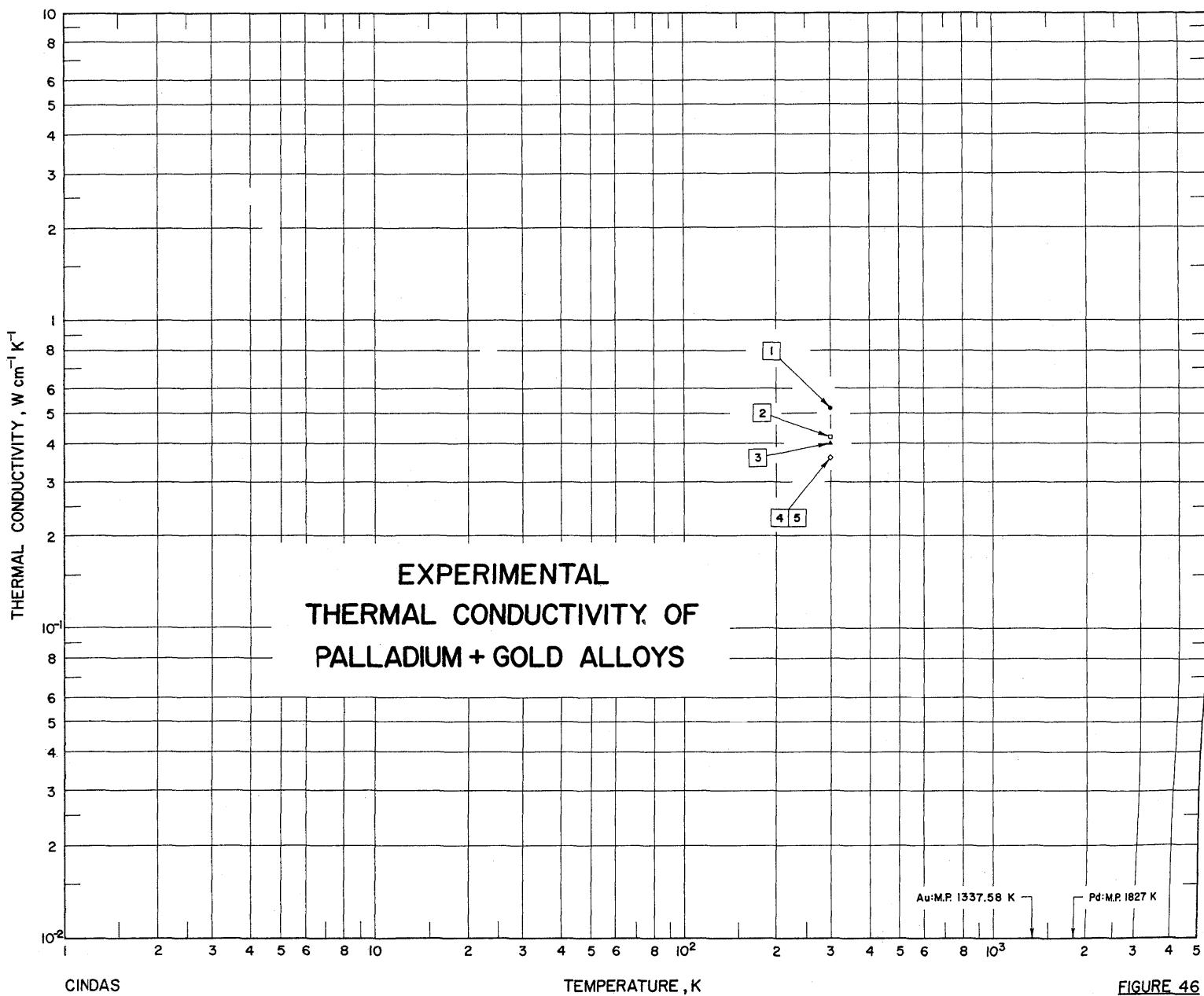


TABLE 20. THERMAL CONDUCTIVITY OF GOLD + PALLADIUM ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent) Au      Pd	Composition (continued), Specifications, and Remarks
1	93	Schulze, F.A.	1911	E	298.2		50      50	Electrical conductivity $3.74 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 25 C.
2	93	Schulze, F.A.	1911	E	298.2		60      40	Electrical conductivity $4.02 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 25 C.
3	93	Schulze, F.A.	1911	E	298.2		70      30	Electrical conductivity $5.45 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 25 C.
4	93	Schulze, F.A.	1911	E	298.2		80      20	Electrical conductivity $7.82 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 25 C.
5	93	Schulze, F.A.	1911	E	298.2		90      10	Electrical conductivity $13.27 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 25 C.
6	61	Grüneisen, E. and Reddemann, H.	1934	L	21-87	22	95      5	Calculated composition; heated at 800 C for 2 hr; electrical resistivity 3.479, 3.939, and $5.44 \mu\Omega \text{ cm}$ at 22, 83, and 273 K, respectively.
7	61	Grüneisen, E. and Reddemann, H.	1934	L	21-86	23	90      10	Calculated composition; heated at 800 C for 2 hr; electrical resistivity 7.175, 7.605, and $9.10 \mu\Omega \text{ cm}$ at 22, 83, and 273 K, respectively.
8	61	Grüneisen, E. and Reddemann, H.	1934	L	21-92	24	60.1      39.9	Calculated composition; heated at 800 C for 2 hr; electrical resistivity 23.66, 24.48, and $27.1 \mu\Omega \text{ cm}$ at 22, 83, and 273, K, respectively.
9	85	Laubitz, M.J. and Van der Meer, M.P.	1968	L	300-1203	Platinel 1503	65.05      34.95	$\sim 1.2 \text{ cm}$ in diameter and 10 cm long; supplied by Engelhard Ind.; annealed at 800 to 900 K for 60 hr; electrical resistivity ratio $\rho(273\text{K})/\rho(4\text{K}) =$ 1.133; electrical resistivity reported as 24.3, 25.1, 25.5, 25.9, 26.4, 26.9, 27.5, 28.2, 28.9, 29.5, 30.1, 30.8, 31.5, 31.9, 33.0 $\mu\Omega \text{ cm}$ at 310, 420, 485, 551, 614, 688, 755, 821, 890, 953, 1012, 1072, 1140, 1198, and 1304 K, respectively; data extracted from smooth curve.

TABLE 21. THERMAL CONDUCTIVITY OF PALLADIUM + GOLD ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent)		Composition (continued), Specifications, and Remarks
							Pd	Au	
1	93	Schulze, F.A.	1911	E	298.2		90	10	1 mm thick wire specimen obtained from Heraeus Co.; electrical conductivity $6.65 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 25 C.
2	93	Schulze, F.A.	1911	E	298.2		80	20	1 mm thick wire specimen obtained from Heraeus Co.; electrical conductivity $5.33 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 25 C.
3	93	Schulze, F.A.	1911	E	298.2		70	30	1 mm thick wire specimen obtained from Heraeus Co.; electrical conductivity $4.72 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 25 C.
4	93	Schulze, F.A.	1911	E	298.2		60	40	1 mm thick wire specimen obtained from Heraeus Co.; electrical conductivity $3.89 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 25 C.
5*	93	Schulze, F.A.	1911	E	298.2		50	50	1 mm thick wire specimen obtained from Heraeus Co.; electrical conductivity $3.74 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 25 C.

\* Not shown in figure.

#### 4.8. Gold-Silver Alloy System

The gold-silver alloy system forms a continuous series of solid solutions over the entire range of compositions [104]. Possible existence of ordered structures due to the formation of  $\text{AgAu}$ ,  $\text{Ag}_3\text{Au}$ ,  $\text{Ag}_3\text{Au}_2$  and  $\text{AgAu}_3$  intermetallic compounds has been reported [183].

There are 39 sets of experimental data available for the thermal conductivity of this alloy system. Of the 22 data sets available for  $\text{Au} + \text{Ag}$  alloys listed in table 23 and shown in figure 51, nine sets cover only a narrow temperature range from 273 to 373 K, which is the highest temperature at which data exist. Of the 17 data sets for  $\text{Ag} + \text{Au}$  alloys listed in table 24 and shown in figure 52, four sets likewise cover only the narrow temperature range from 273 to 373 K, which is also the highest temperature at which data exist. This alloy system is one of those in which at first sight the recommendations seem to be merely extensive extrapolations from a few scattered experimental curves, but in fact the recommended values for the electronic component are calculated from an extensive body of electrical resistivity data and those for the lattice component are calculated from well tested semi-theoretical methods.

Thermal conductivities of this alloy system have been reported in five papers [61, 63, 94, 95, and 172]. The measurements by Grüneisen and Reddemann [61] ( $\text{Au} + \text{Ag}$  curves 1 and 2 and  $\text{Ag} + \text{Au}$  curves 1 and 2) appear to be the most reliable, though there is some uncertainty in the compositions of their gold-rich specimens. For most of their specimens, separation of the electronic component from the measured total thermal conductivities gives reasonable values for the lattice component, without much scatter when these  $k_g$  values are plotted against the composition. However, the data for their 0.7% Au specimen ( $\text{Ag} + \text{Au}$  curve 1) are questionable. The resistivities reported by Grüneisen and Reddemann for this specimen are as much as 15% higher than expected, while separation of the lattice component gives negative values in some cases. The lattice component for the 15.5% Ag specimen is 25% higher than the calculation from eq (35) at 83 K, but the reported resistivity of this specimen is about 5% higher than expected for an alloy of this composition; an error in the resistivity measurement of this magnitude would account for the disagreement with the result from eq (35). The separated lattice components for the 62.2 and 35.4% Ag specimens ( $\text{Ag} + \text{Au}$  curve 2 and  $\text{Au} + \text{Ag}$  curve 1) show good agreement with the  $k_g$  values obtained from eq (35) at 83 K.

The most recent measurements, by Crisp and Rungis [94] ( $\text{Au} + \text{Ag}$  curves 12–20 and  $\text{Ag} + \text{Au}$  curves 8–17), cover a wide range of composition below 300 K. Unfortunately, however, their measurements seem not to be accurate enough to give reasonable lattice thermal conductivities. Lattice conductivities of low accuracy were reported from 4 to 30 K for several alloys in the 0.5–5.0 atomic percent solute range. But separation of the electronic component from their measured total thermal conductivities results in negative values for the lattice component for most of their specimens at 83 and 273 K. In their paper it was mentioned that the separation failed for the most dilute and the most concentrated alloys; in the

former case because the lattice component is only a very small portion of the total, and because the conductivity measurements were not sufficiently precise in the very concentrated alloys.

Early measurements by Sedström [63] ( $\text{Au} + \text{Ag}$  curves 3–11 and  $\text{Ag} + \text{Au}$  curves 3–7) in 1919 yield positive lattice thermal conductivities at 273 K, but the  $k_g$  values scatter and seem to be high.

Van Baarle et al. [95] have measured the thermal conductivities of 1.26 At.% and 2.92 At.% Au alloys between 2 and 30 K, but they have reported only the lattice thermal conductivity values. Because only lattice components were reported, the original measurements of Van Baarle et al. are not included in table 24 and figure 52. Below 10 K their lattice conductivities for the 1.26 At.% Au alloy conflict with the lattice conductivities reported by White et al. [188] for  $\text{Ag}-\text{Sn}$  alloys with 0.14 and 0.3 At.% Sn. The data reported by Van Baarle et al. in this range are as much as 15% higher than the lattice components of White et al., which in this report were assumed to be the values of the lattice component for "pure" Ag. In their separation of the lattice component, Van Baarle et al. did not consider deviations from Matthiessen's rule and its thermal analog. As a result, their reported lattice conductivities are too low at the higher temperatures. At the present time, it is difficult to judge the reliability of their results because total conductivities are not reported and because the low-temperature results of Crisp and Rungis [94] which might have been compared are highly uncertain.

Since the  $\text{Au}-\text{Ag}$  system is a non-transition solid-solution alloy system, for which the calculations from eqs (12) and (35) should be more reliable, and since the calculated results show reasonable agreement with the reliable experimental data of Grüneisen and Reddemann [61], the recommendations were almost entirely based on the calculated values. Recommended values for the electrical resistivity of  $\text{Au}-\text{Ag}$  alloys were obtained from ref. [7]. The experimental values of  $k_e$  for Au and Ag used in eq (35) were obtained from White et al. [188]. For the dilute alloys (0.5–5.0% solute) at temperatures between 40 and 100 K, the calculations were not followed exactly because calculations of the lattice component of the thermal conductivity in this range are expected to fall below the actual values. In this composition and temperature range, the  $k_g$  values were adjusted upward in such a way as to be consistent with the experimental data for the "pure" element, the experimental data of Van Baarle et al., and the calculations for the more concentrated alloys. The only other place in which calculations were not used directly was at low temperatures where the lattice conductivity data of Van Baarle et al. [95] made it possible to give provisional values for the 3.00 and 5.00% Au alloys. Although Van Baarle et al. reported data down to 4 K, the provisional values given in table 22 for the 3.00% Au alloy have not been extended below 20 K because of conflicts with the data for "pure" Ag from White et al. [188].

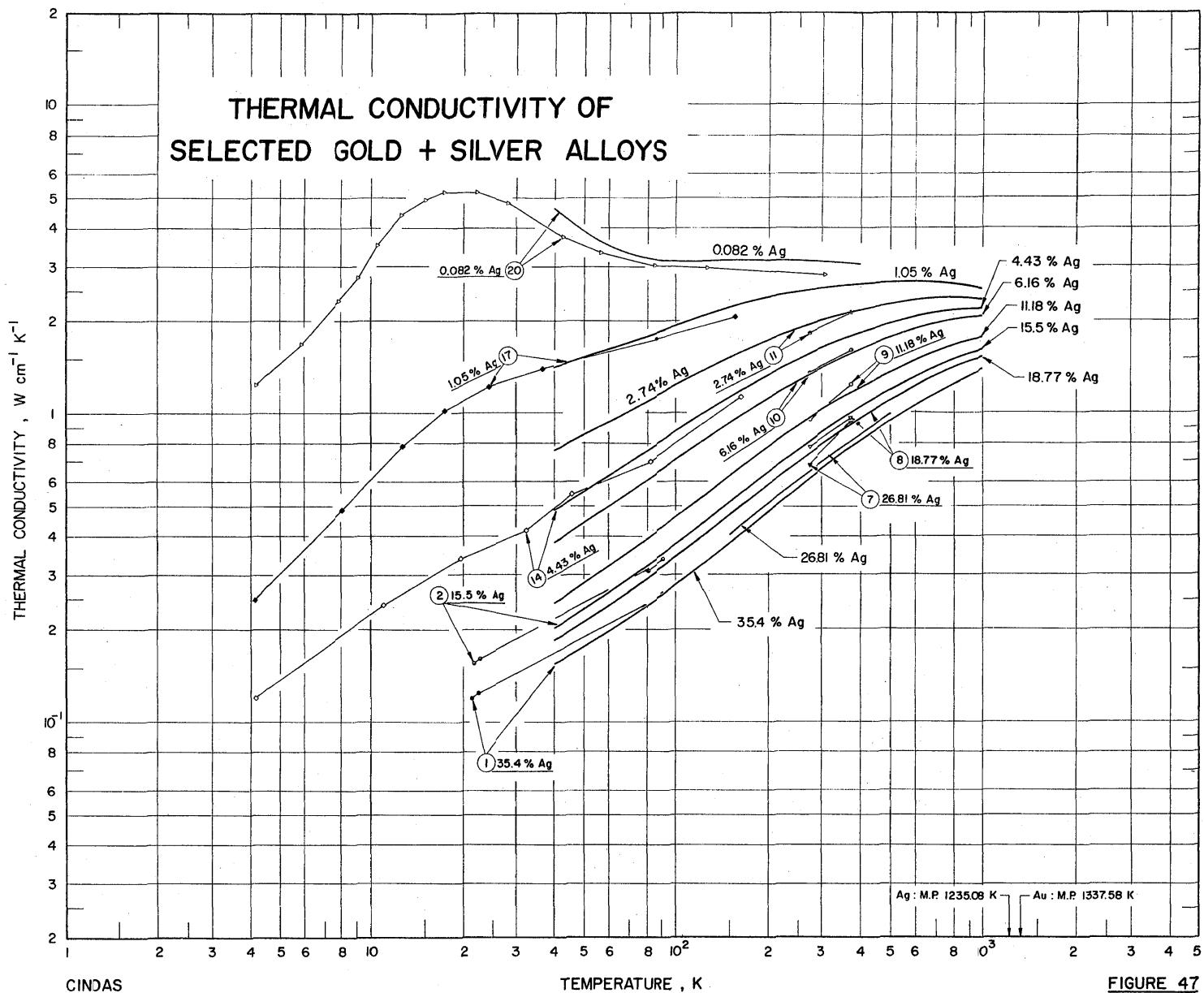
A graphical comparison of the recommended total thermal conductivities with some of the experimental data is given in figures 47 and 48. The smooth solid curves in these figures were obtained by interpolating the recommended values of table 22 in order to obtain thermal conductivities for the

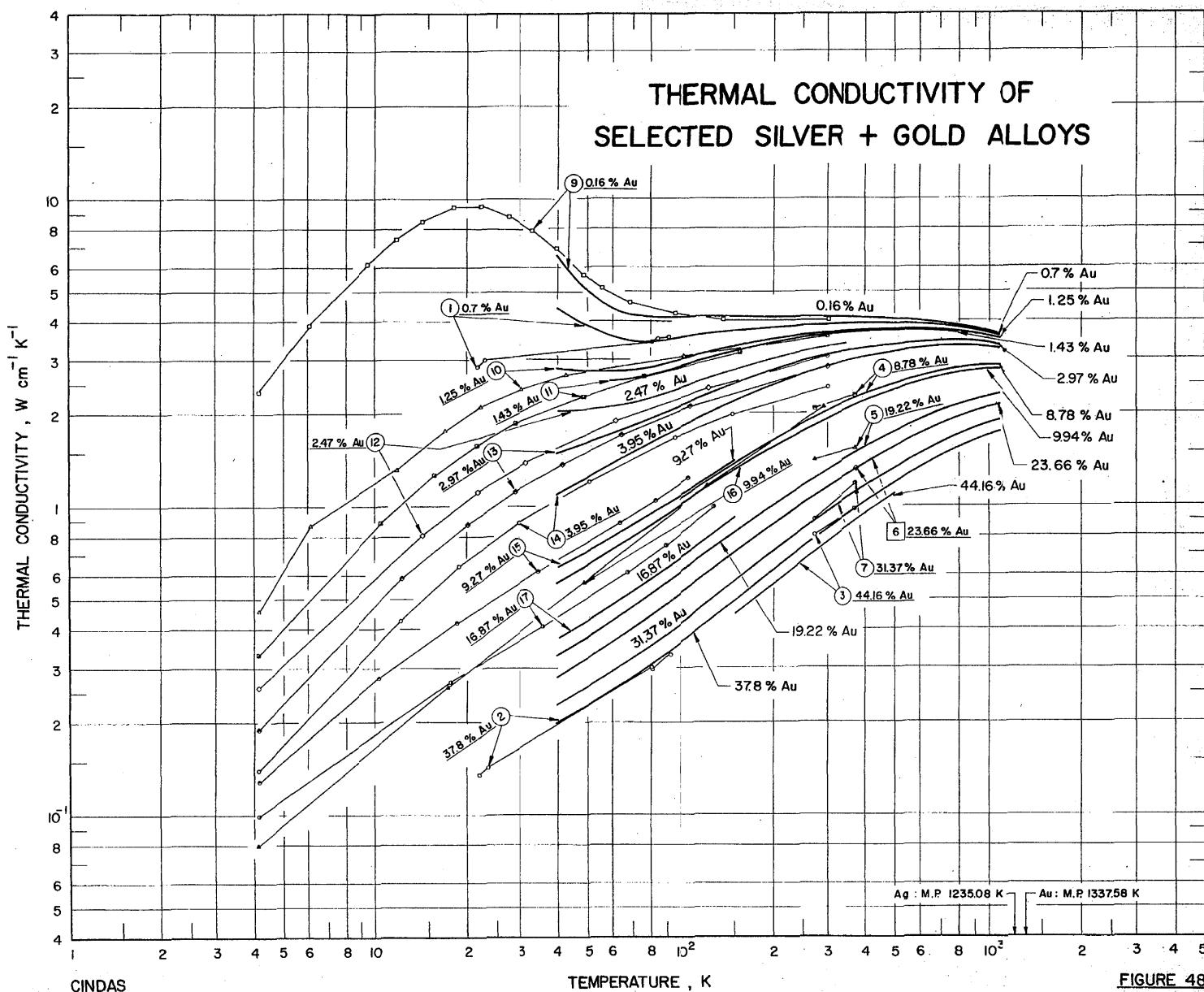
desired alloy compositions. The recommended thermal conductivities show excellent agreement (within 3%) with the data of Grüneisen and Reddemann [61] for concentrated alloys (Au + Ag curves 1 and 2 and Ag + Au curve 2). For the dilute alloy of Grüneisen and Reddemann (Ag + Au curve 1) the agreement is good at 80 K but at lower temperatures the recommendations show an upward trend and pass above the experimental data by up to 25%. In this region, the electronic component constitutes 95% of the total, and it would require unreasonably large uncertainties in the electrical resistivity of the dilute alloys to account for a reduction in the total conductivity by 25%. Considering the difficulties with this specimen discussed earlier, it was concluded that the data were unreliable and no attempts were made to bring the recommendations into better agreement with the questionable experimental results.

The agreement of the recommended thermal conductivities with the work of other investigators is in general poor. As discussed above, the data of Crisp and Rungis [94] are unreliable. They routinely differ from the recommendations by 20% and in some cases differ from the recommendations and the data of Grüneisen and Reddemann by much more. For example, a comparison of the corresponding data of Grüneisen and Reddemann (Au + Ag curve 1 and Ag + Au curve 2) and of Crisp and Rungis (Au + Ag curve 12 and Ag + Au curve 8) for specimens of similar compositions show disagreements of up to 25 and 60%, respectively. Nevertheless, some of the data of Crisp and Rungis [94] (Au + Ag curves 14, 17, and 20 and Ag + Au curves 9-17) agree with the

recommendations to within 15% or better and are shown in figures 47 and 48 for comparison. Similarly, the early measurements of Sedström [63] often differ from the recommendations by 15-20%, but some of the data (Au + Ag curves 7-11 and Ag + Au curves 3-7) show better agreement and appear in the comparison figures. Sedström's measurements often exhibit a more rapid increase with temperature than the recommendations.

The recommended values for  $k$ ,  $k_e$ , and  $k_g$  are tabulated in table 22 for 25 alloy compositions mostly covering the temperature range from 40 K to the solidus temperatures. These values are for disordered alloys which have not been severely cold worked or quenched. For two alloys, with 3% and 5% Au, the tabulated values cover the range down to 20 K and 4 K, respectively. The  $k_e$  values are given from 4 K to the solidus temperatures for all 25 alloy compositions. The values for  $k$  are also presented in figures 49 and 50 except for those for 40% and 45% Ag alloys which are not shown in figure 49 for the sake of clarity. The recommended curve for 65% Au alloy is also shown in figure 50 in order to show more clearly the systematic variation of the thermal conductivity with alloy composition. The uncertainties of the  $k$  values are stated in a footnote to table 22, in which the values of residual electrical resistivity for the alloys are also given. The uncertainties of the  $k_e$  and  $k_g$  values are indicated by their being designated as recommended, provisional, or typical values. The ranges of uncertainties of recommended, provisional, and typical values are less than  $\pm 15\%$ , between  $\pm 15$  and  $\pm 30\%$ , and greater than  $\pm 30\%$ , respectively.





## THERMAL CONDUCTIVITY OF BINARY ALLOY SYSTEMS

TABLE 22. RECOMMENDED THERMAL CONDUCTIVITY OF GOLD-SILVER ALLOY SYSTEM<sup>†</sup>  
 [Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Au: 99.50% (99.09 At.%) Ag: 0.50% (0.91 At.%)				Au: 99.00% (98.19 At.%) Ag: 1.00% (1.81 At.%)				Au: 97.00% (94.66 At.%) Ag: 3.00% (5.34 At.%)				Au: 95.00% (91.23 At.%) Ag: 5.00% (8.77 At.%)			
$\rho_o = 0.28 \mu\Omega\text{cm}$				$\rho_o = 0.530 \mu\Omega\text{cm}$				$\rho_o = 1.52 \mu\Omega\text{cm}$				$\rho_o = 2.470 \mu\Omega\text{cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.349			4	0.184			4	0.0643			4	0.0396		
6	0.524			6	0.277			6	0.0964			6	0.0593		
8	0.698			8	0.369			8	0.129			8	0.0791		
10	0.873			10	0.461			10	0.161			10	0.0989		
15	1.31			15	0.691			15	0.241			15	0.148		
20	1.75			20	0.922			20	0.321			20	0.198		
25	1.86			25	1.06			25	0.390			25	0.241		
30	2.01			30	1.19			30	0.454			30	0.284		
40	2.21	2.07	0.142‡	40	1.49	1.37	0.120‡	40	0.656	0.571	0.0850‡	40	0.436	0.363	0.0727‡
50	2.24	2.12	0.124‡	50	1.61	1.50	0.106‡	50	0.745	0.669	0.0763‡	50	0.502	0.437	0.0653‡
60	2.29	2.18	0.109‡	60	1.68	1.59	0.0945‡	60	0.836	0.767	0.0690‡	60	0.567	0.507	0.0596‡
70	2.34	2.24	0.0970‡	70	1.77	1.69	0.0848‡	70	0.917	0.853	0.0637‡	70	0.628	0.573	0.0550‡
80	2.36	2.27	0.0878‡	80	1.84	1.76	0.0770‡	80	0.989	0.930	0.0587‡	80	0.685	0.634	0.0512‡
90	2.42	2.34	0.0800‡	90	1.92	1.85	0.0710‡	90	1.06	1.01	0.0546‡	90	0.742	0.694	0.0479‡
100	2.48	2.41	0.0729‡	100	2.00	1.93	0.0657‡	100	1.13	1.08	0.0515‡	100	0.798	0.753	0.0450‡
150	2.70	2.65	0.0528‡	150	2.29	2.24	0.0489‡	150	1.43	1.39	0.0398‡	150	1.05*	1.01	0.0352‡
200	2.80	2.76	0.0412‡	200	2.44	2.41	0.0388‡	200	1.64*	1.61	0.0326‡	200	1.25*	1.22	0.0292‡
250	2.83	2.80	0.0337‡	250	2.53	2.50	0.0320‡	250	1.80*	1.77	0.0276‡	250	1.41*	1.38	0.0250‡
273	2.85	2.82	0.0311‡	273	2.56	2.53	0.0297‡	273	1.88*	1.83	0.0258‡	273	1.47	1.45	0.0235‡
300	2.86	2.83	0.0285‡	300	2.59	2.56	0.0273‡	300	1.92*	1.90	0.0240‡	300	1.54	1.52	0.0219‡
350	2.86‡	2.84	0.0247‡	350	2.64*	2.61	0.0238‡	350	2.02*	2.00	0.0212‡	350	1.65	1.63	0.0196‡
400	2.88‡	2.86	0.0218‡	400	2.67*	2.65	0.0211‡	400	2.10*	2.09	0.0190‡	400	1.75*	1.73	0.0177‡
500	2.85‡	2.83	0.0176‡	500	2.70*	2.68	0.0171‡	500	2.22*	2.21	0.0158‡	500	1.90*	1.88	0.0149‡
600	2.83‡	2.82	0.0147‡	600	2.70*	2.68	0.0145‡	600	2.30*	2.28	0.0135‡	600	2.00*	1.99	0.0128‡
700	2.80‡	2.78	0.0127‡	700	2.69*	2.68	0.0125‡	700	2.34*	2.33	0.0118‡	700	2.07*	2.06	0.0133‡
800	2.75‡	2.74	0.0111‡	800	2.66*	2.65	0.0110‡	800	2.36*	2.35	0.0105‡	800	2.12*	2.11	0.0101‡
900	2.69‡	2.68	0.00994‡	900	2.61*	2.60	0.00982‡	900	2.35*	2.34	0.00944‡	900	2.15*	2.14	0.00913‡
1000	2.63‡	2.62	0.00896‡	1000	2.56*	2.55	0.00888‡	1000	2.33*	2.32	0.00858‡	1000	2.15*	2.14	0.00834‡
1200	2.49‡	2.49	0.00749‡	1200	2.44*	2.43	0.00744‡	1200	2.27*	2.27	0.00725‡	1200	2.14*	2.13	0.00710‡
1337	2.41*	2.40	0.00670‡	1337	2.37*	2.36	0.00668‡	1336	2.22*	2.21	0.00655‡	1335	2.12*	2.11	0.00645‡

<sup>†</sup> Uncertainties in the total thermal conductivity, k, are as follows:

99.50 Au - 0.50 Ag: ±10%.

99.00 Au - 1.00 Ag: ±10% below 273 K, ±7% between 273 and 500 K, and ±10% above 500 K.

97.00 Au - 3.00 Ag: ±10% below 273 K, ±7% between 273 and 500 K, and ±10% above 500 K.

95.00 Au - 5.00 Ag: ±10% below 273 K, ±7% between 273 and 500 K, and ±10% above 500 K.

\* Provisional value.

# In temperature range where no experimental thermal conductivity data are available.

TABLE 22. RECOMMENDED THERMAL CONDUCTIVITY OF GOLD-SILVER ALLOY SYSTEM (continued)<sup>†</sup>[Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Au: 90.00% (83.13 At.%) Ag: 10.00% (16.87 At.%)				Au: 85.00% (75.63 At.%) Ag: 15.00% (24.37 At.%)				Au: 80.00% (68.66 At.%) Ag: 20.00% (31.34 At.%)				Au: 75.00% (62.16 At.%) Ag: 25.00% (37.84 At.%)			
$\rho_o = 4.53 \mu\Omega \text{cm}$				$\rho_o = 6.12 \mu\Omega \text{cm}$				$\rho_o = 7.36 \mu\Omega \text{cm}$				$\rho_o = 8.24 \mu\Omega \text{cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.0216			4	0.0160			4	0.0133			4	0.0119		
6	0.0324			6	0.0240			6	0.0199			6	0.0178		
8	0.0431			8	0.0319			8	0.0266			8	0.0237		
10	0.0539			10	0.0399			10	0.0332			10	0.0296		
15	0.0809			15	0.0599			15	0.0498			15	0.0445		
20	0.108			20	0.0798			20	0.0664			20	0.0593		
25	0.132			25	0.0989			25	0.0823			25	0.0735		
30	0.157			30	0.118			30	0.0980			30	0.0877		
40	0.262	0.205	0.0576 <sup>‡</sup>	40	0.208	0.155	0.0531 <sup>‡</sup>	40	0.180*	0.129	0.0509 <sup>‡</sup>	40	0.165*	0.116	0.0499 <sup>‡</sup>
50	0.303	0.250	0.0527 <sup>‡</sup>	50	0.238	0.190	0.0484 <sup>‡</sup>	50	0.205*	0.159	0.0464 <sup>‡</sup>	50	0.188*	0.143	0.0455 <sup>‡</sup>
60	0.344	0.295	0.0487 <sup>‡</sup>	60	0.269	0.224	0.0447 <sup>‡</sup>	60	0.231*	0.188	0.0427 <sup>‡</sup>	60	0.211*	0.169	0.0419 <sup>‡</sup>
70	0.383	0.338	0.0453 <sup>‡</sup>	70	0.300	0.258	0.0416 <sup>‡</sup>	70	0.257*	0.217	0.0397 <sup>‡</sup>	70	0.234*	0.195	0.0389 <sup>‡</sup>
80	0.421	0.379	0.0424 <sup>‡</sup>	80	0.330	0.291	0.0389 <sup>‡</sup>	80	0.282*	0.245	0.0372 <sup>‡</sup>	80	0.257*	0.220	0.0365 <sup>‡</sup>
90	0.459	0.420	0.0399 <sup>‡</sup>	90	0.360	0.323	0.0366 <sup>‡</sup>	90	0.308*	0.273	0.0350 <sup>‡</sup>	90	0.280*	0.246	0.0343 <sup>‡</sup>
100	0.497	0.460	0.0377 <sup>‡</sup>	100	0.390*	0.355	0.0346 <sup>‡</sup>	100	0.334*	0.301	0.0331 <sup>‡</sup>	100	0.304*	0.271	0.0325 <sup>‡</sup>
150	0.676	0.646	0.0299 <sup>‡</sup>	150	0.534*	0.506	0.0275 <sup>‡</sup>	150	0.457*	0.431	0.0264 <sup>‡</sup>	150	0.416*	0.390	0.0259 <sup>‡</sup>
200	0.833 <sup>*</sup>	0.808	0.0250 <sup>‡</sup>	200	0.665*	0.641	0.0232 <sup>‡</sup>	200	0.573*	0.550	0.0223 <sup>‡</sup>	200	0.522*	0.501	0.0219 <sup>‡</sup>
250	0.971 <sup>*</sup>	0.949	0.0217 <sup>‡</sup>	250	0.782*	0.762	0.0202 <sup>‡</sup>	250	0.678*	0.658	0.0194 <sup>‡</sup>	250	0.621*	0.602	0.0192 <sup>‡</sup>
273	1.03	1.01	0.0205 <sup>‡</sup>	273	0.833	0.814	0.0191 <sup>‡</sup>	273	0.723	0.704	0.0184 <sup>‡</sup>	273	0.664	0.646	0.0181 <sup>‡</sup>
300	1.09	1.07	0.0192 <sup>‡</sup>	300	0.889	0.872	0.0180 <sup>‡</sup>	300	0.775	0.757	0.0173 <sup>‡</sup>	300	0.712	0.695	0.0171 <sup>‡</sup>
350	1.20	1.18	0.0173 <sup>‡</sup>	350	0.986	0.970	0.0162 <sup>‡</sup>	350	0.864	0.848	0.0157 <sup>‡</sup>	350	0.797	0.781	0.0155 <sup>‡</sup>
400	1.29*	1.28	0.0158 <sup>‡</sup>	400	1.07*	1.06	0.0149 <sup>‡</sup>	400	0.947*	0.932	0.0144 <sup>‡</sup>	400	0.874*	0.860	0.0143 <sup>‡</sup>
500	1.44*	1.43	0.0135 <sup>‡</sup>	500	1.22*	1.21	0.0128 <sup>‡</sup>	500	1.09*	1.08	0.0124 <sup>‡</sup>	500	1.01*	1.00	0.0123 <sup>‡</sup>
600	1.57*	1.56	0.0118 <sup>‡</sup>	600	1.34*	1.33	0.0112 <sup>‡</sup>	600	1.21*	1.20	0.0110 <sup>‡</sup>	600	1.13*	1.12	0.0109 <sup>‡</sup>
700	1.66*	1.65	0.0105 <sup>‡</sup>	700	1.44*	1.43	0.0101 <sup>‡</sup>	700	1.32*	1.31	0.00987 <sup>‡</sup>	700	1.24*	1.23	0.00988 <sup>‡</sup>
800	1.74*	1.73	0.00946 <sup>‡</sup>	800	1.53*	1.52	0.00913 <sup>‡</sup>	800	1.40*	1.39	0.00898 <sup>‡</sup>	800	1.33*	1.32	0.00895 <sup>‡</sup>
900	1.79*	1.79	0.00863 <sup>‡</sup>	900	1.59*	1.58	0.00836 <sup>‡</sup>	900	1.47*	1.46	0.00825 <sup>‡</sup>	900	1.40*	1.39	0.00823 <sup>‡</sup>
1000	1.83*	1.82	0.00794 <sup>‡</sup>	1000	1.64*	1.63	0.00772 <sup>‡</sup>	1000	1.52*	1.52	0.00763 <sup>‡</sup>	1000	1.45*	1.45	0.00763 <sup>‡</sup>
1200	1.89*	1.88	0.00684 <sup>‡</sup>	1200	1.72*	1.71	0.00671 <sup>‡</sup>	1200	1.61*	1.61	0.00666 <sup>‡</sup>	1200	1.55*	1.54	0.00668 <sup>‡</sup>
1331	1.92*	1.91	0.00630 <sup>‡</sup>	1327	1.77*	1.76	0.00620 <sup>‡</sup>	1322	1.67*	1.66	0.00615 <sup>‡</sup>	1317	1.59*	1.58	0.00620 <sup>‡</sup>

<sup>†</sup> Uncertainties in the total thermal conductivity, k, are as follows:90.00 Au - 10.00 Ag:  $\pm 10\%$  below 273 K,  $\pm 7\%$  between 273 and 500 K, and  $\pm 10\%$  above 500 K.85.00 Au - 15.00 Ag:  $\pm 10\%$  below 273 K,  $\pm 7\%$  between 273 and 500 K, and  $\pm 10\%$  above 500 K.80.00 Au - 20.00 Ag:  $\pm 10\%$  below 273 K,  $\pm 7\%$  between 273 and 500 K, and  $\pm 10\%$  above 500 K.75.00 Au - 25.00 Ag:  $\pm 10\%$  below 273 K,  $\pm 7\%$  between 273 and 500 K, and  $\pm 10\%$  above 500 K.<sup>‡</sup> Provisional value.<sup>\*</sup> In temperature range where no experimental thermal conductivity data are available.

TABLE 22. RECOMMENDED THERMAL CONDUCTIVITY OF GOLD-SILVER ALLOY SYSTEM (continued)<sup>†</sup>[Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Au: 70.00% (56.10 At.%) Ag: 30.00% (43.90 At.%)				Au: 65.00% (50.42 At.%) Ag: 35.00% (49.58 At.%)				Au: 60.00% (45.10 At.%) Ag: 40.00% (54.90 At.%)				Au: 55.00% (40.10 At.%) Ag: 45.00% (59.90 At.%)			
$\rho_o = 8.77 \mu\Omega\text{A}$				$\rho_o = 9.0 \mu\Omega\text{cm}$				$\rho_o = 8.93 \mu\Omega\text{cm}$				$\rho_o = 8.66 \mu\Omega\text{cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.0111			4	0.0109			4	0.0109			4	0.0113		
6	0.0167			6	0.0163			6	0.0164			6	0.0169		
8	0.0223			8	0.0217			8	0.0219			8	0.0226		
10	0.0279			10	0.0271			10	0.0274			10	0.0282		
15	0.0418			15	0.0407			15	0.0410			15	0.0423		
20	0.0557			20	0.0543			20	0.0547			20	0.0564		
25	0.0691			25	0.0673			25	0.0679			25	0.0701		
30	0.0825			30	0.0803			30	0.0811			30	0.0836		
40	0.159*	0.109	0.0497 <sup>‡</sup>	40	0.156	0.106	0.0502 <sup>‡</sup>	40	0.158*	0.107	0.0511 <sup>‡</sup>	40	0.163*	0.110	0.0526 <sup>‡</sup>
50	0.180*	0.134	0.0453 <sup>‡</sup>	50	0.177	0.131	0.0457 <sup>‡</sup>	50	0.179*	0.132	0.0466 <sup>‡</sup>	50	0.184*	0.136	0.0479 <sup>‡</sup>
60	0.20*	0.159	0.0417 <sup>‡</sup>	60	0.197	0.155	0.0421 <sup>‡</sup>	60	0.200*	0.157	0.0429 <sup>‡</sup>	60	0.205*	0.161	0.0441 <sup>‡</sup>
70	0.223*	0.184	0.0388 <sup>‡</sup>	70	0.218	0.179	0.0392 <sup>‡</sup>	70	0.221*	0.181	0.0399 <sup>‡</sup>	70	0.227*	0.186	0.0410 <sup>‡</sup>
80	0.244*	0.208	0.0363 <sup>‡</sup>	80	0.240	0.203	0.0367 <sup>‡</sup>	80	0.242*	0.205	0.0374 <sup>‡</sup>	80	0.249*	0.211	0.0384 <sup>‡</sup>
90	0.267*	0.232	0.0342 <sup>‡</sup>	90	0.261	0.227	0.0345 <sup>‡</sup>	90	0.264*	0.229	0.0352 <sup>‡</sup>	90	0.271*	0.235	0.0362 <sup>‡</sup>
100	0.288*	0.256	0.0324 <sup>‡</sup>	100	0.282	0.250	0.0327 <sup>‡</sup>	100	0.285*	0.252	0.0333 <sup>‡</sup>	100	0.294*	0.259	0.0343 <sup>‡</sup>
150	0.395*	0.370	0.0259 <sup>‡</sup>	150	0.387	0.361	0.0262 <sup>‡</sup>	150	0.391*	0.364	0.0267 <sup>‡</sup>	150	0.402*	0.375	0.0275 <sup>‡</sup>
200	0.497*	0.475	0.0219 <sup>‡</sup>	200	0.486	0.464	0.0221 <sup>‡</sup>	200	0.490*	0.468	0.0226 <sup>‡</sup>	200	0.505*	0.481	0.0232 <sup>‡</sup>
250	0.59*	0.571	0.0192 <sup>‡</sup>	250	0.579	0.560	0.0194 <sup>‡</sup>	250	0.584*	0.564	0.0198 <sup>‡</sup>	250	0.601*	0.581	0.0203 <sup>‡</sup>
273	0.632	0.614	0.0181 <sup>‡</sup>	273	0.620	0.601	0.0184 <sup>‡</sup>	273	0.624	0.606	0.0187 <sup>‡</sup>	273	0.642	0.623	0.0193 <sup>‡</sup>
300	0.679	0.661	0.0171 <sup>‡</sup>	300	0.666	0.649	0.0173 <sup>‡</sup>	300	0.671	0.653	0.0177 <sup>‡</sup>	300	0.689	0.671	0.0182 <sup>‡</sup>
350	0.760	0.744	0.0155 <sup>‡</sup>	350	0.746	0.731	0.0157 <sup>‡</sup>	350	0.752	0.736	0.0161 <sup>‡</sup>	350	0.773	0.756	0.0165 <sup>‡</sup>
400	0.838*	0.822	0.0143 <sup>‡</sup>	400	0.822*	0.808	0.0145 <sup>‡</sup>	400	0.828	0.813	0.0148 <sup>‡</sup>	400	0.852	0.837	0.0152 <sup>‡</sup>
500	0.969*	0.957	0.0124 <sup>‡</sup>	500	0.956*	0.943	0.0125 <sup>‡</sup>	500	0.964*	0.951	0.0128 <sup>‡</sup>	500	0.992*	0.978	0.0132 <sup>‡</sup>
600	1.09*	1.08	0.0110 <sup>‡</sup>	600	1.07*	1.06	0.0111 <sup>‡</sup>	600	1.08*	1.07	0.0114 <sup>‡</sup>	600	1.12*	1.10	0.0117 <sup>‡</sup>
700	1.19*	1.18	0.00988 <sup>‡</sup>	700	1.18*	1.17	0.0100 <sup>‡</sup>	700	1.19*	1.18	0.0102 <sup>‡</sup>	700	1.22*	1.21	0.0105 <sup>‡</sup>
800	1.28*	1.27	0.00901 <sup>‡</sup>	800	1.26*	1.26	0.00915 <sup>‡</sup>	800	1.28*	1.27	0.00936 <sup>‡</sup>	800	1.31*	1.30	0.00963 <sup>‡</sup>
900	1.35*	1.35	0.00830 <sup>‡</sup>	900	1.34*	1.33	0.00843 <sup>‡</sup>	900	1.35*	1.34	0.00863 <sup>‡</sup>	900	1.39*	1.38	0.00888 <sup>‡</sup>
1000	1.41*	1.41	0.00770 <sup>‡</sup>	1000	1.40*	1.39	0.00783 <sup>‡</sup>	1000	1.42*	1.41	0.00801 <sup>‡</sup>	1000	1.45*	1.44	0.00825 <sup>‡</sup>
1200	1.51*	1.50	0.00676 <sup>‡</sup>	1200	1.50*	1.49	0.00687 <sup>‡</sup>	1200	1.52*	1.51	0.00704 <sup>‡</sup>	1100	1.51*	1.50	0.00771 <sup>‡</sup>
1311	1.55*	1.54	0.00630 <sup>‡</sup>	1306	1.54*	1.53	0.00650 <sup>‡</sup>	1300	1.55*	1.54	0.00660 <sup>‡</sup>	1295	1.59*	1.58	0.00685 <sup>‡</sup>

<sup>†</sup> Uncertainties in the total thermal conductivity, k, are as follows:

70.00 Au - 30.00 Ag:  $\pm 10\%$  below 273 K,  $\pm 7\%$  between 273 and 500 K, and  $\pm 10\%$  above 500 K.  
 65.00 Au - 35.00 Ag:  $\pm 10\%$  below 273 K,  $\pm 7\%$  between 273 and 500 K, and  $\pm 10\%$  above 500 K.  
 60.00 Au - 40.00 Ag:  $\pm 10\%$  below 273 K,  $\pm 7\%$  between 273 and 500 K, and  $\pm 10\%$  above 500 K.  
 55.00 Au - 45.00 Ag:  $\pm 10\%$  below 273 K,  $\pm 7\%$  between 273 and 500 K, and  $\pm 10\%$  above 500 K.

<sup>‡</sup> Provisional value.<sup>\*</sup> In temperature range where no experimental thermal conductivity data are available.

TABLE 22. RECOMMENDED THERMAL CONDUCTIVITY OF GOLD-SILVER ALLOY SYSTEM (continued)<sup>†</sup>  
 [Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Au: 50.00% (35.39 At.%) Ag: 50.00% (64.61 At.%)				Au: 45.00% (30.94 At.%) Ag: 55.00% (69.06 At.%)				Au: 40.00% (26.75 At.%) Ag: 60.00% (73.25 At.%)				Au: 35.00% (22.77 At.%) Ag: 65.00% (77.23 At.%)			
$\rho_0 = 8.30 \mu\Omega \text{cm}$				$\rho_0 = 7.79 \mu\Omega \text{cm}$				$\rho_0 = 7.15 \mu\Omega \text{cm}$				$\rho_0 = 6.42 \mu\Omega \text{cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4		0.0118		4		0.0125		4		0.0136		4		0.0152	
6		0.0177		6		0.0188		6		0.0205		6		0.0228	
8		0.0235		8		0.0251		8		0.0273		8		0.0304	
10		0.0294		10		0.0314		10		0.0341		10		0.0381	
15		0.0442		15		0.0470		15		0.0512		15		0.0571	
20		0.0589		20		0.0627		20		0.0682		20		0.0761	
25		0.0732		25		0.0778		25		0.0849		25		0.0945	
30		0.0874		30		0.0929		30		0.101		30		0.113	
40	0.170*	0.115	0.0544‡	40	0.179*	0.122	0.0568‡	40	0.193	0.133	0.0598‡	40	0.212	0.148	0.0634‡
50	0.192*	0.142	0.0496‡	50	0.203*	0.151	0.0518‡	50	0.219	0.164	0.0545‡	50	0.240	0.182	0.0579‡
60	0.214*	0.169	0.0458‡	60	0.227*	0.179	0.0478‡	60	0.245	0.194	0.0503‡	60	0.269	0.216	0.0535‡
70	0.237*	0.194	0.0426‡	70	0.251*	0.206	0.0445‡	70	0.271	0.224	0.0469‡	70	0.298	0.248	0.0498‡
80	0.260*	0.220	0.0399‡	80	0.275*	0.234	0.0417‡	80	0.297	0.254	0.0439‡	80	0.327	0.280	0.0467‡
90	0.283*	0.246	0.0376‡	90	0.300*	0.261	0.0393‡	90	0.324	0.283	0.0414‡	90	0.356	0.313	0.0440‡
100	0.306*	0.271	0.0356‡	100	0.324*	0.287	0.0372‡	100	0.350*	0.311	0.0392‡	100	0.385*	0.344	0.0416‡
150	0.419*	0.391	0.0285‡	150	0.444*	0.414	0.0298‡	150	0.479*	0.448	0.0313‡	150	0.527*	0.493	0.0333‡
200	0.526*	0.502	0.0241‡	200	0.557*	0.532	0.0252‡	200	0.600*	0.573	0.0265‡	200	0.658*	0.630	0.0282‡
250	0.626*	0.605	0.0211‡	250	0.662*	0.640	0.0220‡	250	0.712*	0.689	0.0232‡	250	0.780*	0.756	0.0246‡
273	0.670	0.650	0.0200‡	273	0.708	0.687	0.0209‡	273	0.760*	0.738	0.0220‡	273	0.833*	0.810	0.0233‡
300	0.719	0.701	0.0189‡	300	0.760	0.740	0.0197‡	300	0.816*	0.795	0.0207‡	300	0.892*	0.870	0.0220‡
350	0.806	0.789	0.0171‡	350	0.851	0.833	0.0179‡	350	0.913*	0.894	0.0188‡	350	0.996*	0.976	0.0200‡
400	0.888*	0.872	0.0158‡	400	0.936*	0.920	0.0164‡	400	1.00*	0.987	0.0173‡	400	1.09*	1.07	0.0183‡
500	1.03*	1.02	0.0136‡	500	1.09*	1.07	0.0142‡	500	1.16*	1.15	0.0149‡	500	1.26*	1.24	0.0158‡
600	1.16*	1.15	0.0121‡	600	1.22*	1.21	0.0126‡	600	1.30*	1.29	0.0132‡	600	1.40*	1.39	0.0140‡
700	1.27*	1.26	0.0109‡	700	1.34*	1.32	0.0114‡	700	1.42*	1.41	0.0119‡	700	1.52*	1.51	0.0126‡
800	1.36*	1.35	0.00996‡	800	1.43*	1.42	0.0104‡	800	1.52*	1.51	0.0109‡	800	1.62*	1.61	0.0114‡
900	1.44*	1.43	0.00918‡	900	1.51*	1.50	0.00955‡	900	1.60*	1.59	0.00995‡	900	1.71*	1.70	0.0105‡
1000	1.51*	1.50	0.00853‡	1000	1.58*	1.57	0.00887‡	1000	1.67*	1.66	0.00927‡	1000	1.78*	1.77	0.00974‡
1100	1.56*	1.55	0.00797‡	1100	1.63*	1.62	0.00828‡	1100	1.73*	1.72	0.00865‡	1100	1.84*	1.83	0.00908‡
1289	1.65*	1.64	0.00710‡	1284	1.72*	1.71	0.00740‡	1278	1.82*	1.81	0.00775‡	1273	1.93*	1.92	0.00820‡

<sup>†</sup> Uncertainties in the total thermal conductivity, k, are as follows:

50.00 Au - 50.00 Ag:  $\pm 10\%$  below 273 K,  $\pm 7\%$  between 273 and 500 K, and  $\pm 10\%$  above 500 K.

45.00 Au - 55.00 Ag:  $\pm 10\%$  below 273 K,  $\pm 7\%$  between 273 and 500 K, and  $\pm 10\%$  above 500 K.

40.00 Au - 60.00 Ag:  $\pm 10\%$  below 273 K,  $\pm 7\%$  between 273 and 500 K, and  $\pm 10\%$  above 500 K.

35.00 Au - 65.00 Ag:  $\pm 10\%$  below 273 K,  $\pm 7\%$  between 273 and 500 K, and  $\pm 10\%$  above 500 K.

<sup>‡</sup> Provisional value.

\* In temperature range where no experimental thermal conductivity data are available.

TABLE 22. RECOMMENDED THERMAL CONDUCTIVITY OF GOLD-SILVER ALLOY SYSTEM (continued)<sup>†</sup>  
 [Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Au: 30.00% (19.01 At.%) Ag: 70.00% (80.99 At.%)				Au: 25.00% (15.44 At.%) Ag: 75.00% (84.56 At.%)				Au: 20.00% (12.04 At.%) Ag: 80.00% (87.96 At.%)				Au: 15.00% (8.81 At.%) Ag: 85.00% (91.19 At.%)			
$\rho_o = 5.60 \mu\Omega \text{cm}$				$\rho_o = 4.75 \mu\Omega \text{cm}$				$\rho_o = 3.86 \mu\Omega \text{cm}$				$\rho_o = 2.94 \mu\Omega \text{cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.0175			4	0.0206			4	0.0253			4	0.0332		
6	0.0262			6	0.0309			6	0.0380			6	0.0499		
8	0.0349			8	0.0411			8	0.0506			8	0.0665		
10	0.0436			10	0.0514			10	0.0633			10	0.0831		
15	0.0654			15	0.0771			15	0.0949			15	0.125		
20	0.0873			20	0.103			20	0.127			20	0.166		
25	0.108			25	0.127			25	0.157			25	0.206		
30	0.129			30	0.152			30	0.187			30	0.244		
40	0.237*	0.169	0.0679 <sup>‡</sup>	40	0.272*	0.198	0.0736 <sup>‡</sup>	40	0.326	0.245	0.0809 <sup>‡</sup>	40	0.408	0.317	0.0909 <sup>‡</sup>
50	0.270*	0.208	0.0621 <sup>‡</sup>	50	0.311*	0.244	0.0674 <sup>‡</sup>	50	0.373	0.299	0.0744 <sup>‡</sup>	50	0.469	0.385	0.0839 <sup>‡</sup>
60	0.305*	0.245	0.0574 <sup>‡</sup>	60	0.348*	0.286	0.0624 <sup>‡</sup>	60	0.418	0.349	0.0689 <sup>‡</sup>	60	0.524	0.446	0.0779 <sup>‡</sup>
70	0.335*	0.282	0.0535 <sup>‡</sup>	70	0.387*	0.328	0.0582 <sup>‡</sup>	70	0.464	0.400	0.0643 <sup>‡</sup>	70	0.580	0.508	0.0728 <sup>‡</sup>
80	0.365*	0.318	0.0502 <sup>‡</sup>	80	0.424*	0.370	0.0546 <sup>‡</sup>	80	0.509	0.448	0.0603 <sup>‡</sup>	80	0.635	0.567	0.0683 <sup>‡</sup>
90	0.401*	0.354	0.0473 <sup>‡</sup>	90	0.462*	0.411	0.0514 <sup>‡</sup>	90	0.553	0.496	0.0569 <sup>‡</sup>	90	0.691	0.626	0.0644 <sup>‡</sup>
100	0.434*	0.389	0.0447 <sup>‡</sup>	100	0.500*	0.451	0.0487 <sup>‡</sup>	100	0.597	0.543	0.0538 <sup>‡</sup>	100	0.744	0.683	0.0609 <sup>‡</sup>
150	0.592*	0.556	0.0358 <sup>‡</sup>	150	0.678*	0.640	0.0389 <sup>‡</sup>	150	0.805	0.762	0.0429 <sup>‡</sup>	150	0.990	0.942	0.0484 <sup>‡</sup>
200	0.737*	0.707	0.0302 <sup>‡</sup>	200	0.841*	0.808	0.0328 <sup>‡</sup>	200	0.987*	0.951	0.0361 <sup>‡</sup>	200	1.20*	1.16	0.0406 <sup>‡</sup>
250	0.871*	0.844	0.0263 <sup>‡</sup>	250	0.988*	0.960	0.0285 <sup>‡</sup>	250	1.15*	1.12	0.0313 <sup>‡</sup>	250	1.38*	1.35	0.0351 <sup>‡</sup>
273	0.925	0.903	0.0249 <sup>‡</sup>	273	1.05*	1.02	0.0270 <sup>‡</sup>	273	1.22	1.19	0.0296 <sup>‡</sup>	273	1.46*	1.43	0.0331 <sup>‡</sup>
300	0.995	0.969	0.0235 <sup>‡</sup>	300	1.12*	1.09	0.0254 <sup>‡</sup>	300	1.29	1.26	0.0278 <sup>‡</sup>	300	1.54*	1.51	0.0311 <sup>‡</sup>
350	1.10	1.08	0.0213 <sup>‡</sup>	350	1.24	1.21	0.0230 <sup>‡</sup>	350	1.42	1.39	0.0251 <sup>‡</sup>	350	1.68*	1.65	0.0279 <sup>‡</sup>
400	1.20*	1.18	0.0195 <sup>‡</sup>	400	1.35*	1.33	0.0210 <sup>‡</sup>	400	1.54*	1.51	0.0229 <sup>‡</sup>	400	1.80*	1.78	0.0254 <sup>‡</sup>
500	1.38*	1.36	0.0168 <sup>‡</sup>	500	1.53*	1.51	0.0181 <sup>‡</sup>	500	1.73*	1.71	0.0196 <sup>‡</sup>	500	2.01*	1.99	0.0216 <sup>‡</sup>
600	1.53*	1.51	0.0148 <sup>‡</sup>	600	1.68*	1.67	0.0159 <sup>‡</sup>	600	1.89*	1.87	0.0172 <sup>‡</sup>	600	2.17*	2.15	0.0188 <sup>‡</sup>
700	1.65*	1.64	0.0133 <sup>‡</sup>	700	1.81*	1.80	0.0142 <sup>‡</sup>	700	2.02*	2.00	0.0154 <sup>‡</sup>	700	2.29*	2.27	0.0167 <sup>‡</sup>
800	1.76*	1.74	0.0121 <sup>‡</sup>	800	1.91*	1.90	0.0129 <sup>‡</sup>	800	2.12*	2.10	0.0139 <sup>‡</sup>	800	2.38*	2.36	0.0151 <sup>‡</sup>
900	1.83*	1.82	0.0111 <sup>‡</sup>	900	1.99*	1.98	0.0118 <sup>‡</sup>	900	2.19*	2.18	0.0127 <sup>‡</sup>	900	2.45*	2.44	0.0137 <sup>‡</sup>
1000	1.91*	1.90	0.0103 <sup>‡</sup>	1000	2.06*	2.05	0.0109 <sup>‡</sup>	1000	2.26*	2.24	0.0117 <sup>‡</sup>	1000	2.50*	2.49	0.0126 <sup>‡</sup>
1100	1.97*	1.96	0.0958 <sup>‡</sup>	1100	2.12*	2.11	0.0101 <sup>‡</sup>	1100	2.31*	2.30	0.0108 <sup>‡</sup>	1100	2.54*	2.53	0.0116 <sup>‡</sup>
1267	2.06*	2.05	0.0860 <sup>‡</sup>	1261	2.20*	2.19	0.00920 <sup>‡</sup>	1256	2.38*	2.37	0.00980 <sup>‡</sup>	1251	2.59*	2.58	0.0105 <sup>‡</sup>

<sup>†</sup> Uncertainties in the total thermal conductivity, k, are as follows:

30.00 Au - 70.00 Ag:  $\pm 10\%$  below 273 K,  $\pm 7\%$  between 273 and 500 K, and  $\pm 10\%$  above 500 K.  
 25.00 Au - 75.00 Ag:  $\pm 10\%$  below 273 K,  $\pm 7\%$  between 273 and 500 K, and  $\pm 10\%$  above 500 K.  
 20.00 Au - 80.00 Ag:  $\pm 10\%$  below 273 K,  $\pm 7\%$  between 273 and 500 K, and  $\pm 10\%$  above 500 K.  
 15.00 Au - 85.00 Ag:  $\pm 10\%$  below 273 K,  $\pm 7\%$  between 273 and 500 K, and  $\pm 10\%$  above 500 K.

<sup>‡</sup> Provisional value.

\* In temperature range where no experimental thermal conductivity data are available.

TABLE 22. RECOMMENDED THERMAL CONDUCTIVITY OF GOLD-SILVER ALLOY SYSTEM (continued)<sup>†</sup>[Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Au: 10.00% ( 5.74 At.%) Ag: 90.00% (94.26 At.%)				Au: 5.00% ( 2.80 At.%) Ag: 95.00% (97.20 At.%)				Au: 3.00% ( 1.67 At.%) Ag: 97.00% (98.33 At.%)				Au: 1.00% ( 0.55 At.%) Ag: 99.00% (99.45 At.%)			
$\rho_o = 1.97 \mu\Omega \text{cm}$				$\rho_o = 0.99 \mu\Omega \text{cm}$				$\rho_o = 0.59 \mu\Omega \text{cm}$				$\rho_o = 0.190 \mu\Omega \text{cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.0496			4	0.125 <sup>#</sup>	0.0987	0.0259 <sup>#</sup>	4	0.166			4	0.514		
6	0.0744			6	0.202 <sup>#</sup>	0.148	0.0539 <sup>#</sup>	6	0.248			6	0.771		
8	0.0992			8	0.275 <sup>#</sup>	0.197	0.0776 <sup>#</sup>	8	0.331			8	1.03		
10	0.124			10	0.344 <sup>#</sup>	0.247	0.0969 <sup>#</sup>	10	0.414			10	1.29		
15	0.186			15	0.498 <sup>#</sup>	0.370	0.128 <sup>#</sup>	15	0.621			15	1.93		
20	0.248			20	0.636 <sup>#</sup>	0.494	0.142 <sup>#</sup>	20	1.01	0.828	0.179 <sup>#</sup>	20	2.57		
25	0.305			25	0.743 <sup>#</sup>	0.598	0.145 <sup>#</sup>	25	1.18	1.00	0.180 <sup>#</sup>	25	2.90		
30	0.363			30	0.849 <sup>#</sup>	0.705	0.144 <sup>#</sup>	30	1.33	1.15	0.176 <sup>#</sup>	30	3.21		
40	0.571	0.465	0.106 <sup>#</sup>	40	1.01 <sup>#</sup>	0.873	0.137 <sup>#</sup>	40	1.52	1.36	0.163 <sup>#</sup>	40	3.51	3.28	0.225 <sup>#</sup>
50	0.655	0.557	0.0981 <sup>#</sup>	50	1.14 <sup>#</sup>	1.01	0.127 <sup>#</sup>	50	1.65	1.50	0.148 <sup>#</sup>	50	3.32	3.12	0.200 <sup>#</sup>
60	0.726	0.635	0.0914 <sup>#</sup>	60	1.23	1.11	0.118 <sup>#</sup>	60	1.73	1.59	0.137 <sup>#</sup>	60	3.11	2.93	0.179 <sup>#</sup>
70	0.801	0.715	0.0855 <sup>#</sup>	70	1.32	1.21	0.110 <sup>#</sup>	70	1.84	1.71	0.127 <sup>#</sup>	70	3.10	2.94	0.162 <sup>#</sup>
80	0.872	0.792	0.0803 <sup>#</sup>	80	1.42	1.32	0.104 <sup>#</sup>	80	1.95	1.83	0.118 <sup>#</sup>	80	3.11	2.96	0.148 <sup>#</sup>
90	0.944	0.869	0.0757 <sup>#</sup>	90	1.53	1.43	0.0968 <sup>#</sup>	90	2.05	1.94	0.111 <sup>#</sup>	90	3.18	3.04	0.137 <sup>#</sup>
100	1.01	0.940	0.0716 <sup>#</sup>	100	1.62	1.53	0.0908 <sup>#</sup>	100	2.14	2.04	0.105 <sup>#</sup>	100	3.26	3.13	0.128 <sup>#</sup>
150	1.32	1.26	0.0566 <sup>#</sup>	150	2.00	1.92	0.0706 <sup>#</sup>	150	2.53	2.45	0.0799 <sup>#</sup>	150	3.50	3.41	0.0941 <sup>#</sup>
200	1.56	1.51	0.0471 <sup>#</sup>	200	2.27	2.21	0.0577 <sup>#</sup>	200	2.79	2.73	0.0643 <sup>#</sup>	200	3.67	3.59	0.0737 <sup>#</sup>
250	1.76	1.72	0.0404 <sup>#</sup>	250	2.49	2.44	0.0488 <sup>#</sup>	250	2.98	2.93	0.0538 <sup>#</sup>	250	3.77	3.71	0.0605 <sup>#</sup>
273	1.84	1.80	0.0380 <sup>#</sup>	273	2.57	2.52	0.0456 <sup>#</sup>	273	3.05	3.00	0.0500 <sup>#</sup>	273	3.77	3.71	0.0558 <sup>#</sup>
300	1.93	1.90	0.0355 <sup>#</sup>	300	2.64	2.60	0.0423 <sup>#</sup>	300	3.11	3.06	0.0462 <sup>#</sup>	300	3.81	3.75	0.0512 <sup>#</sup>
350	2.08	2.05	0.0318 <sup>#</sup>	350	2.77	2.74	0.0374 <sup>#</sup>	350	3.21	3.17	0.0405 <sup>#</sup>	350	3.84*	3.79	0.0444 <sup>#</sup>
400	2.21*	2.18	0.0287 <sup>#</sup>	400	2.88*	2.85	0.0335 <sup>#</sup>	400	3.29*	3.26	0.0360 <sup>#</sup>	400	3.87*	3.83	0.0391 <sup>#</sup>
500	2.40*	2.38	0.0242 <sup>#</sup>	500	3.03*	3.00	0.0277 <sup>#</sup>	500	3.39*	3.36	0.0295 <sup>#</sup>	500	3.87*	3.84	0.0316 <sup>#</sup>
600	2.55*	2.53	0.0209 <sup>#</sup>	600	3.13*	3.11	0.0237 <sup>#</sup>	600	3.45*	3.43	0.0250 <sup>#</sup>	600	3.85*	3.82	0.0265 <sup>#</sup>
700	2.66*	2.64	0.0185 <sup>#</sup>	700	3.19*	3.17	0.0206 <sup>#</sup>	700	3.47*	3.45	0.0217 <sup>#</sup>	700	3.82*	3.80	0.0229 <sup>#</sup>
800	2.73*	2.72	0.0165 <sup>#</sup>	800	3.22*	3.20	0.0183 <sup>#</sup>	800	3.48*	3.46	0.0192 <sup>#</sup>	800	3.79*	3.77	0.0201 <sup>#</sup>
900	2.77*	2.76	0.0150 <sup>#</sup>	900	3.27*	3.21	0.0165 <sup>#</sup>	900	3.45*	3.44	0.0171 <sup>#</sup>	900	3.72*	3.70	0.0179 <sup>#</sup>
1000	2.80*	2.79	0.0137 <sup>#</sup>	1000	3.22*	3.20	0.0149 <sup>#</sup>	1000	3.41*	3.40	0.0155 <sup>#</sup>	1000	3.65*	3.64	0.0161 <sup>#</sup>
1100	2.83*	2.82	0.0126 <sup>#</sup>	1100	3.20*	3.19	0.0137 <sup>#</sup>	1100	3.38*	3.36	0.0142 <sup>#</sup>	1100	3.58*	3.56	0.0147 <sup>#</sup>
1245	2.87*	2.86	0.0114 <sup>#</sup>	1240	3.18*	3.17	0.0123 <sup>#</sup>	1238	3.32*	3.31	0.0126 <sup>#</sup>	1236	3.50*	3.49	0.0132 <sup>#</sup>

<sup>†</sup> Uncertainties in the total thermal conductivity, k, are as follows:10.00 Au - 90.00 Ag:  $\pm 10\%$  below 273 K,  $\pm 7\%$  between 273 and 500 K, and  $\pm 10\%$  above 500 K.5.00 Au - 95.00 Ag:  $\pm 15\%$  below 40 K,  $\pm 10\%$  between 40 and 273 K,  $\pm 7\%$  between 273 and 500 K, and  $\pm 10\%$  above 500 K.3.00 Au - 97.00 Ag:  $\pm 15\%$  below 40 K,  $\pm 10\%$  between 40 and 273 K,  $\pm 7\%$  between 273 and 500 K, and  $\pm 10\%$  above 500 K.1.00 Au - 99.00 Ag:  $\pm 10\%$  below 273 K,  $\pm 7\%$  between 273 and 500 K, and  $\pm 10\%$  above 500 K.<sup>#</sup> Provisional value.<sup>\*</sup> In temperature range where no experimental thermal conductivity data are available.

TABLE 22. RECOMMENDED THERMAL CONDUCTIVITY OF GOLD-SILVER ALLOY SYSTEM (continued) †  
 [Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

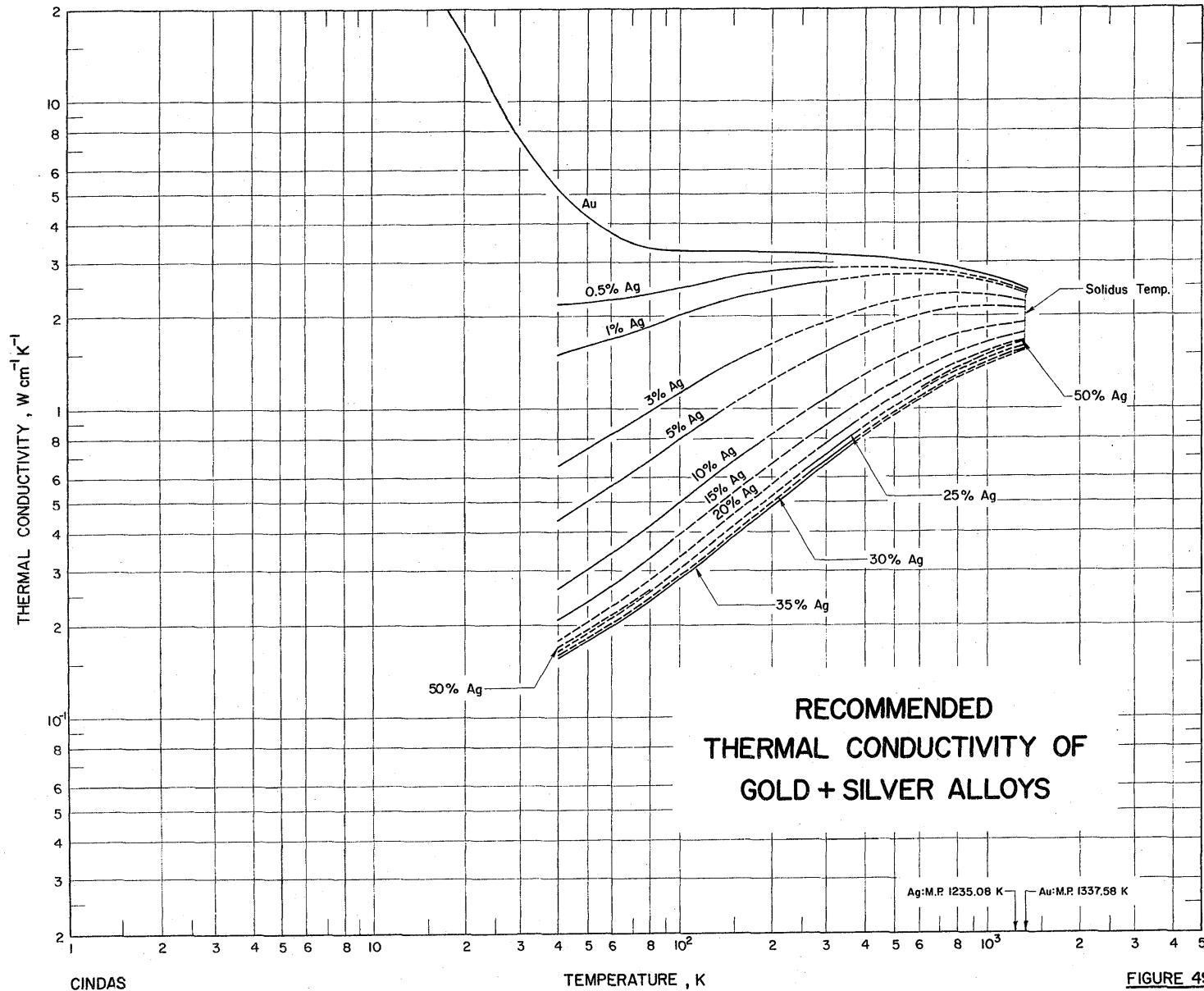
Au: 0.50% ( 0.28 At.%) Ag: 99.50% (99.72 At.%)			
$\rho_0 = 0.0800 \mu\Omega \text{cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>
4		1.22	
6		1.83	
8		2.44	
10		3.05	
15		4.58	
20		6.11	
25		6.08	
30		6.20	
40	5.20	4.93	0.266‡
50	4.41	4.18	0.232‡
60	3.86	3.66	0.204‡
70	3.73	3.55	0.182‡
80	3.72	3.56	0.164‡
90	3.74	3.59	0.149‡
100	3.79	3.65	0.138‡
150	3.90	3.80	0.0989‡
200	3.95	3.88	0.0768‡
250	4.01	3.95	0.0625‡
273	4.01	3.96	0.0576‡
300	4.03	3.98	0.0527‡
350	4.03	3.99	0.0455‡
400	4.03‡*	3.99	0.0400‡
500	4.01‡*	3.98	0.0322‡
600	3.97‡*	3.95	0.0270‡
700	3.92‡*	3.90	0.0232‡
800	3.87‡*	3.85	0.0203‡
900	3.79‡*	3.77	0.0181‡
1000	3.71‡*	3.69	0.0163‡
1100	3.64‡*	3.62	0.0148‡
1236	3.55‡*	3.54	0.0133‡

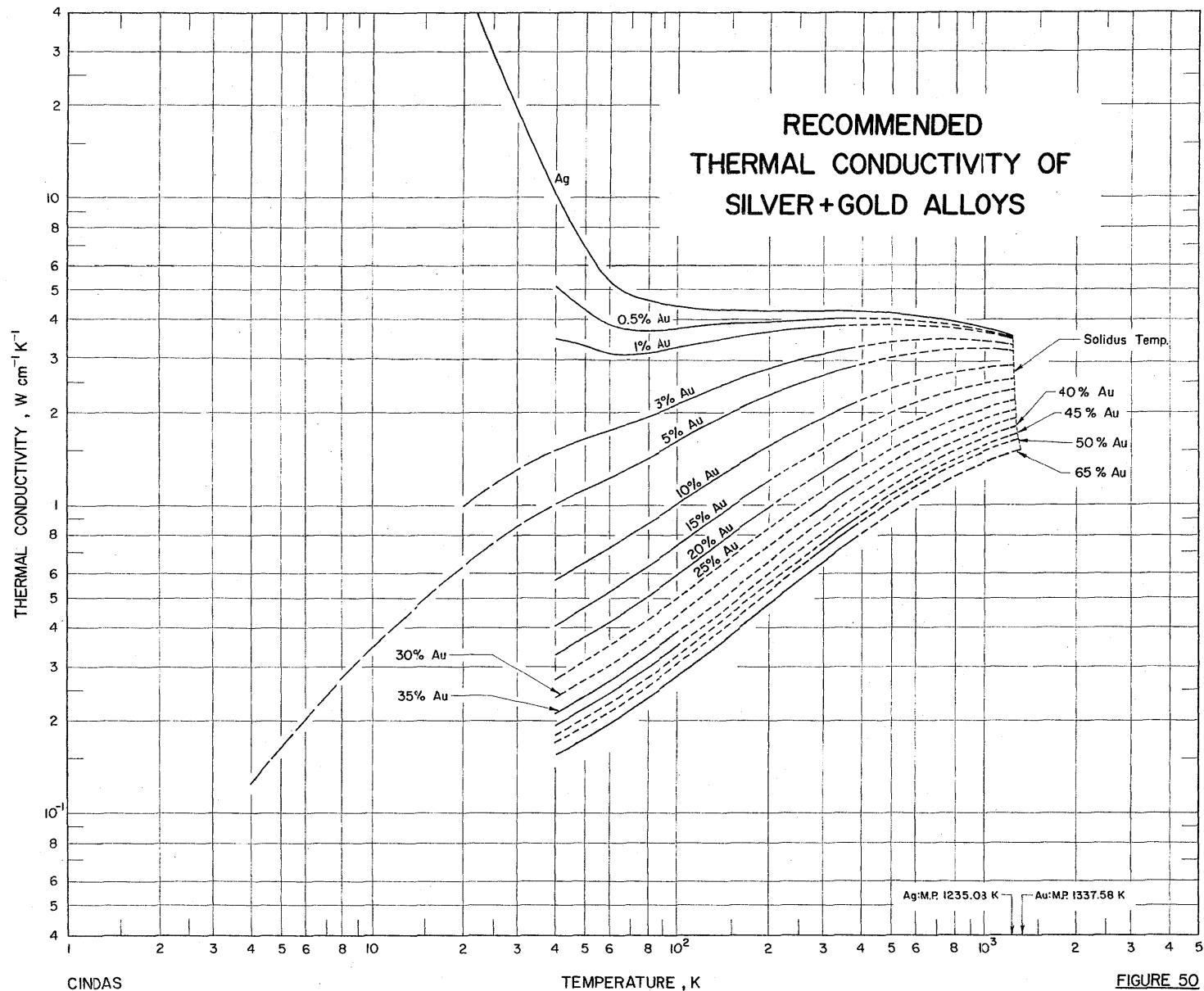
† Uncertainties in the total thermal conductivity, k, are as follows:  
 0.50 Au - 99.50 Ag: ±10%.

‡ Provisional value.

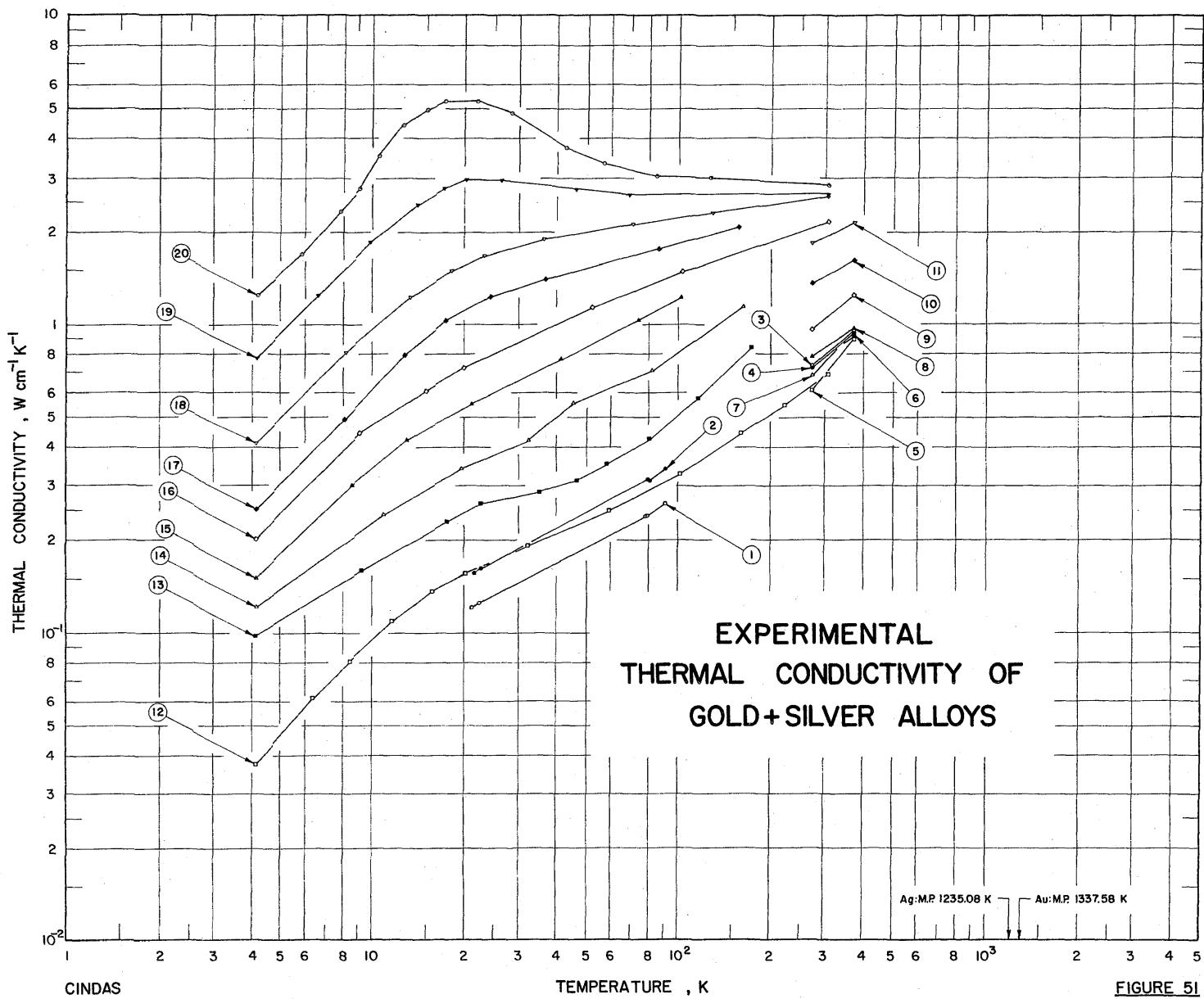
\* In temperature range where no experimental thermal conductivity data are available.

**RECOMMENDED  
THERMAL CONDUCTIVITY OF  
GOLD + SILVER ALLOYS**





**EXPERIMENTAL  
THERMAL CONDUCTIVITY OF  
GOLD+SILVER ALLOYS**



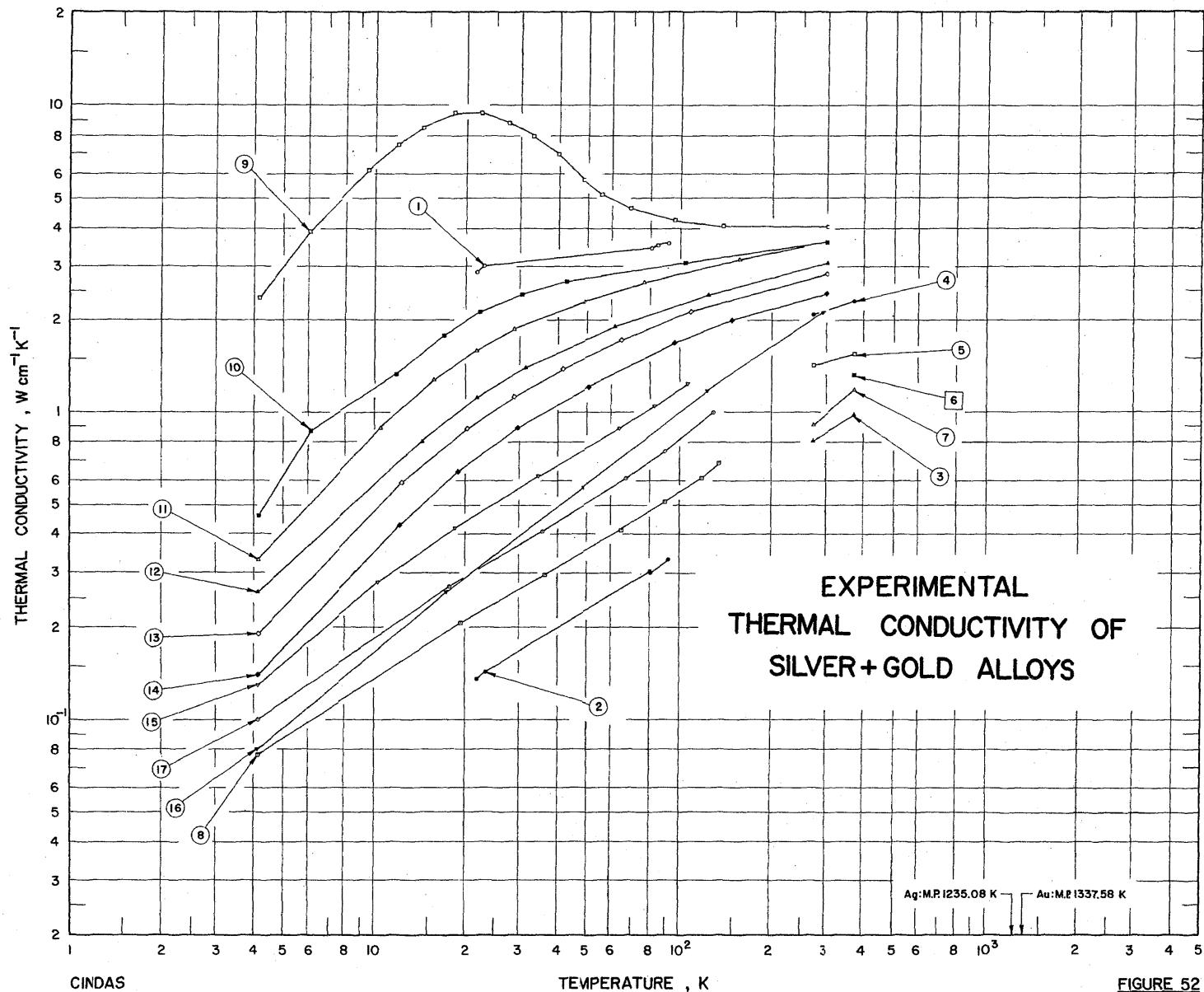
**FIGURE 52**

TABLE 23. THERMAL CONDUCTIVITY OF GOLD + SILVER ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION

Cur. Ref. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent) Au      Ag	Composition (continued), Specifications, and Remarks	
1	61	Grüneisen, E. and Redleman, H.	1934	L	21-91	6	64.6 35.4	Calculated composition; single crystal; electrical resistivity 8.85, 9.32, and $10.8 \mu\Omega$ cm at 22, 83, and 273 K, respectively.	
2	61	Grüneisen, E. and Redleman, H.	1934	L	22-92	7	84.5 15.5	Calculated composition; single crystal; electrical resistivity 6.69, 7.16, and $8.69 \mu\Omega$ cm at 22, 83, and 273 K, respectively.	
3	63	Sedström, E.	1919	T	273, 373		54.62 45.38	Calculated composition; specimen rolled and drawn to 1 mm thick; heated 0.5 hr at temperature near the melting point; electrical conductivity 9.1 and $8.4 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 0 and 100 C, respectively.	
4	63	Sedström, E.	1919	T	273, 373		60.32 39.68	Similar to the above specimen except electrical conductivity 9.1 and $8.5 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 0 and 100 C, respectively.	
5	63	Sedström, E.	1919	T	273, 373		65.46 34.54	Similar to the above specimen except electrical conductivity 7.2 and $7.2 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 0 and 100 C, respectively.	
6	63	Sedström, E.	1919	T	273, 373		69.17 30.83	Similar to the above specimen except electrical conductivity 8.9 and $8.4 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 0 and 100 C, respectively.	
7	63	Sedström, E.	1919	T	273, 373		73.19 26.81	Similar to the above specimen except electrical conductivity 9.1 and $8.5 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 0 and 100 C, respectively.	
8	63	Sedström, E.	1919	T	273, 373		81.23 18.77	Similar to the above specimen except electrical conductivity 10.2 and $9.6 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 0 and 100 C, respectively.	
9	63	Sedström, E.	1919	T	273, 373		88.82 11.18	Similar to the above specimen except electrical conductivity 13.2 and $12.4 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 0 and 100 C, respectively.	
10	63	Sedström, E.	1919	T	273, 373		93.84 6.16	Similar to the above specimen except electrical conductivity 18.1 and $15.9 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 0 and 100 C, respectively.	
11	63	Sedström, E.	1919	T	273, 373		97.26 2.74	Similar to the above specimen except electrical conductivity 25.1 and $22.0 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 0 and 100 C, respectively.	
12	94	Crisp, R. S. and Rungis, J.	1970	L	4.1-307		35.39	Calculated composition from atomic percent; specimen purchased in three batches from Cambridge Metals Research Ltd., England, prepared from 99.999 and 99.9999 Au and 99.9999 Ag; about 0.5 to 1 mm in diameter and about 1 to 5 cm long; drawn down, etched, washed in distilled water and alcohol, dried and sealed into quartz capsules with 1/3 atmosphere of oxygen and then annealed for 72 hr at 900 C.	
13	94	Crisp, R. S. and Rungis, J.	1970	L	4.1-173		12.7	Similar to the above specimen except the electrical resistivity reported as $6.038$ and $8.107 \mu\Omega$ cm at 0 and 273 K, respectively.	
14	94	Crisp, R. S. and Rungis, J.	1970	L	4.1-165		4.43	Similar to the above specimen except the electrical resistivity reported as $2.603$ and $4.695 \mu\Omega$ cm at 0 and 273 K, respectively.	
15	94	Crisp, R. S. and Rungis, J.	1970	L	4.1-100		2.29	Similar to the above specimen except the electrical resistivity reported as $1.404$ and $3.517 \mu\Omega$ cm at 0 and 273 K, respectively.	
16	94	Crisp, R. S. and Rungis, J.	1970	L	4.1-307		1.33	Similar to the above specimen except the electrical resistivity reported as $0.855$ and $2.991 \mu\Omega$ cm at 0 and 273 K, respectively.	
17	94	Crisp, R. S. and Rungis, J.	1970	L	4.1-156		1.05	Similar to the above specimen except the residual electrical resistivity reported as $0.670 \mu\Omega$ cm.	
18	94	Crisp, R. S. and Rungis, J.	1970	L	4.1-307		0.47	Similar to the above specimen except the electrical resistivity reported as $0.370$ and $2.421 \mu\Omega$ cm at 0 and 273 K, respectively.	

TABLE 23. THERMAL CONDUCTIVITY OF GOLD + SILVER ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION (continued)

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent)		Composition (continued), Specifications, and Remarks
							Au	Ag	
19	94	Crisp, R.S. and Rungis, J.	1970	L	4.1-307		0.203		Similar to the above specimen except the electrical resistivity reported as 0.135 and 2.209 $\mu\Omega$ cm at 0 and 273 K, respectively.
20	94	Crisp, R.S. and Rungis, J.	1970	L	4.2-307		0.082		Similar to the above specimen except the electrical resistivity reported as 0.053 and 2.128 $\mu\Omega$ cm at 0 and 273 K, respectively.
21*	172	Kapoor, A., Rowlands, J.A., and Woods, S.B.	1974	L	0.65-4.0		94.26	5.74	Calculated composition (10 a/o Ag); 4 mm <sup>2</sup> in cross section and 10 cm long; prepared by induction melting 99.999 pure metals in argon, resulted ingot rolled to size; cold-worked; residual electrical resistivity 2.90 $\mu\Omega$ cm.
22*	172	Kapoor, A., et al.	1974	L	0.69-4.0				The above specimen annealed in vacuum at 1000 K for 12 hr; residual electrical resistivity 2.71 $\mu\Omega$ cm.

\* Not shown in figure.

TABLE 24. THERMAL CONDUCTIVITY OF SILVER + GOLD ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent) Ag      Au	Composition (continued), Specifications, and Remarks
1	61	Grüneisen, E. and Reddemann, H.	1934	L	22-92	4	99.3      0.7	Calculated composition; wire specimen; electrical resistivity 0.163, 0.473, and 1.63 $\mu\Omega$ cm at 22, 83, and 273 K, respectively.
2	61	Grüneisen, E. and Reddemann, H.	1934	L	22-92	5	62.2      37.8	Calculated composition; single crystal; wire specimen; electrical resistivity 6.87, 7.25, and 8.57 $\mu\Omega$ cm at 22, 83, and 273 K, respectively.
3	63	Sedström, E.	1919	T	273, 373		55.84      44.16	Calculated composition; wire specimen 1 mm in diameter; rolled and drawn; annealed at close to melting point for 0.5 hr; electrical conductivity 10.3 and $9.7 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 0 and 100 C, respectively.
4	63	Sedström, E.	1919	T	273, 373		91.22      8.78	Similar to the above specimen; electrical conductivity 29.3 and $24.2 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 0 and 100 C, respectively.
5	63	Sedström, E.	1919	T	273, 373		80.74      19.26	Similar to the above specimen except electrical conductivity 19.5 and $16.0 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 0 and 100 C, respectively.
6	63	Sedström, E.	1919	T	273.2		76.34      23.66	Similar to the above specimen except electrical conductivity 14.7 and $13.5 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 0 and 100 C, respectively.
7	63	Sedström, E.	1919	T	273, 373		68.63      31.37	Similar to the above specimen except electrical conductivity 12.5 and $11.5 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 0 and 100 C, respectively.
8	94	Crisp, R. S. and Rungis, J.	1970	L	4.2-136		40.31	Calculated composition from atomic percent; specimen purchased in three batches from Cambridge Metals Research Ltd., England; prepared from 99.9999 Ag and 99.999 and 99.9999 Au; about 0.5 to 1 mm in diameter and about 1 to 5 cm long; drawn down, etched, washed in distilled water and alcohol, dried and sealed into quartz capsules with 1/3 atmosphere of oxygen and then annealed for 72 hr at 900 C; electrical resistivity reported as 7.084 and 8.874 $\mu\Omega$ cm at 0 and 273 K, respectively.
9	94	Crisp, R. S. and Rungis, J.	1970	L	4.1-136		0.164	Similar to the above specimen except the electrical resistivity reported as 0.033 and 1.532 $\mu\Omega$ cm at 0 and 273 K, respectively.
10	94	Crisp, R. S. and Rungis, J.	1970	L	4.1-300		1.25	Similar to the above specimen except the electrical resistivity reported as 0.249 and 1.758 $\mu\Omega$ cm at 0 and 273 K, respectively.
11	94	Crisp, R. S. and Rungis, J.	1970	L	4.1-300		1.43	Similar to the above specimen except the electrical resistivity reported as 0.285 and 1.788 $\mu\Omega$ cm at 0 and 273 K, respectively.
12	94	Crisp, R. S. and Rungis, J.	1970	L	4.1-300		2.47	Similar to the above specimen except the electrical resistivity reported as 0.493 and 2.052 $\mu\Omega$ cm at 0 and 273 K, respectively.
13	94	Crisp, R. S. and Rungis, J.	1970	L	4.1-300		2.97	Similar to the above specimen except the electrical resistivity reported as 0.593 and 2.126 $\mu\Omega$ cm at 0 and 273 K, respectively.
14	94	Crisp, R. S. and Rungis, J.	1970	L	4.1-300		3.95	Similar to the above specimen except the electrical resistivity reported as 0.768 and 2.507 $\mu\Omega$ cm at 0 and 273 K, respectively.
15	94	Crisp, R. S. and Rungis, J.	1970	L	4.2-106		9.27	Similar to the above specimen except the electrical resistivity reported as 1.813 and 3.408 $\mu\Omega$ cm at 0 and 273 K, respectively.
16	94	Crisp, R. S. and Rungis, J.	1970	L	4.2-294		9.94	Similar to the above specimen except the electrical resistivity reported as 1.923 and 3.581 $\mu\Omega$ cm at 0 and 273 K, respectively.
17	94	Crisp, R. S. and Rungis, J.	1970	L	4.1-129		16.87	Similar to the above specimen except the electrical resistivity reported as 3.303 and 4.958 $\mu\Omega$ cm at 0 and 273 K, respectively.

#### 4.9. Iron-Nickel Alloy System

The iron-nickel alloy system does not form a continuous series of solid solutions at low temperatures. There is an  $\alpha$  phase bounded on the right by a line extending from 0% Ni at about 1183 K passing through 9% Ni at 473 K and a  $\gamma$  phase bounded on the left by a line extending from 0% Ni at about 1183 K passing through 74% Ni near 473 K. In addition, there is a martensitic transformation in alloys containing up to 27 At.% Ni quenched from above about 770 K, resulting in a metastable  $\alpha_2$  phase. The phase diagram is further complicated by magnetic transitions: at about 1030 K in the  $\alpha$  phase, at about 673 K in the  $\alpha + \gamma$  phase mixture, and on a curve reaching a maximum of 895 K at about 65% Ni in the  $\gamma$  phase. Finally, there is an order-disorder transformation based on  $\text{FeNi}_3$  covering a wide range of composition, about 50 to 80% Ni, which has a maximum transition temperature of about 776 K.

There are 99 sets of experimental data available for the thermal conductivity of this alloy system. However, of the 64 data sets available for Fe + Ni alloys listed in table 26 and shown in figure 57, 34 sets are merely single data points, and of the 35 data sets for Ni + Fe alloys listed in table 27 and shown in figure 58, five sets are single data points and 21 sets are for temperatures below 4.5 K. Few of these data sets are on binary alloys and those for the low Ni alloys are presumably not for the equilibrium phase. Since much of the data for the Fe-rich region is for low alloy steels containing other impurities which affect the resistivity as well as the thermal conductivity, essentially it is  $\varrho_0$  that specifies the composition and the thermal conductivity. In this connection, the provisional values for Fe-3% Ni are from 12% to 15% below the values for an Fe-3.15% Ni specimen [191] (Fe + Ni curve 64), measured after this analysis was completed, over the temperature range from 90 K to 400 K. The resistivity of this specimen at 90 K is  $6.98 \mu\Omega \text{ cm}$  while the residual resistivity cited for the provisional values is  $7.20 \mu\Omega \text{ cm}$  corresponding to a resistivity of  $8.67 \mu\Omega \text{ cm}$  at 90 K, a value 20% greater than that for the Fe-3.15% Ni specimen. Accordingly, the tabulated values should be used with caution taking account of the resistivity of the material.

For Fe + Ni alloys, no specimen containing less than 3% Ni was measured below 100 K. The conductivity-composition curve for 300 K was constructed based on the data of Powell and Hickman [96] (Fe + Ni curves 3 and 4), of Kohlhaas and Kierspe [97] (Fe + Ni curves 30, 31, and 63), and of Ingersoll et al. [98] (Fe + Ni curves 7-16). The specimens reported in [96] and [97] were well annealed, and the electrical resistivity measurements were consistent with the thermal conductivity results. No heat treatments were mentioned about the specimens of Ingersoll et al., but their results are the only systematic measurements made on a number of alloys covering a wide range of composition. The data of Ingersoll et al. thus provided important information on the variation of thermal conductivity with composition. The electronic thermal conductivities calculated from eq (12) were found to be unreliable for some temperatures and compositions: those alloys containing more than 20% Ni at temperatures above 300 K. Both the total  $k$  values and the calculated values of  $k_e$  at 300

K were plotted on a conductivity-composition graph and the differences between  $k$  and  $k_e$  were taken as  $k_s$ . The  $k_s$  values at lower and higher temperatures were obtained by extrapolation according to the appropriate theoretical temperature dependence. Except for those alloys containing more than 20% Ni at temperatures above 300 K, the total conductivity was obtained by adding the extrapolated  $k_s$  to the calculated  $k_e$ . For those alloys containing more than 20% Ni at temperatures above 300 K, the extrapolated  $k_s$  values were subtracted from the values of the total conductivity derived from the experimental data to obtain the values of  $k_e$ . In the process of calculating the electronic thermal conductivity, the correction due to the thermoelectric power was not made at this time because anomalous variation of thermoelectric power with composition at 260 °C was reported by Wang et al. [103] which requires further study. Since the corrections would be small, no more than 0.2% for all compositions except for the 30% Ni alloy, for which it comes to nearly 1% at 260 °C, the total thermal conductivity should not be in too large an error without this correction.

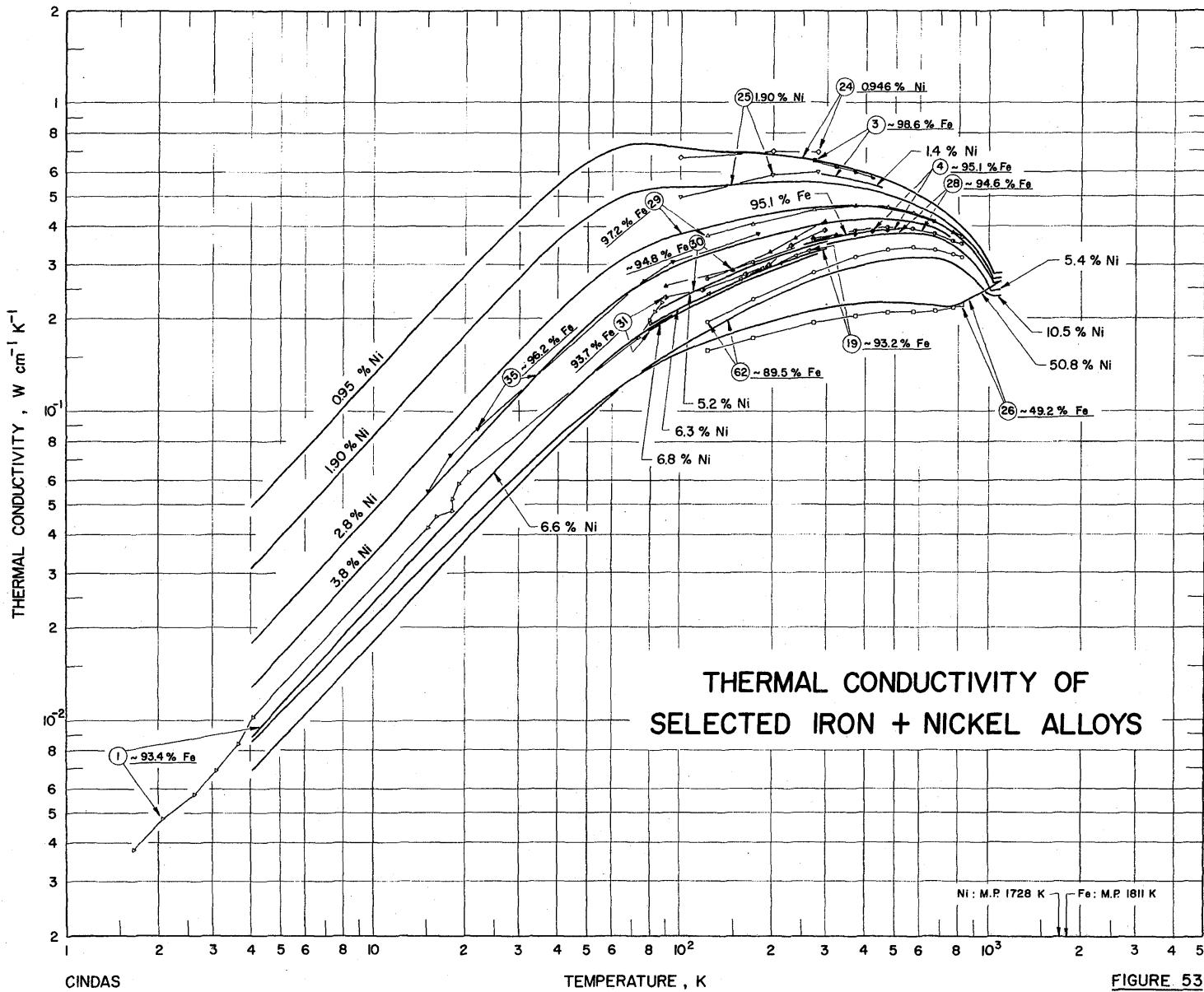
For Ni+Fe alloys, the conductivity-composition curve for  $k_s$  at 300 K was extrapolated from the Fe+Ni part to the Ni+Fe portion using the  $k$  value of Moore et al. [187] (Ni+Fe curve 36) for an alloy with 75.93% Ni as a reference point. That is, the sum of the extrapolated  $k_s$  value at 75% Ni and the  $k_e$  value calculated from the selected electrical resistivity for this composition was required to approximate the Moore et al. value. The  $k_e$  values for all compositions from 4 to 1100 K were calculated from the selected electrical resistivities, and the  $k_s$  values at 300 K were extrapolated to higher temperatures following the temperature dependence of eq (35). At low temperatures, all data [81, 100, 105, 106] indicate that  $k_s$  is proportional to  $T$ , and the  $k_s$  values were extrapolated to higher temperature to join the  $k_s$  values extrapolated from 300 K to lower temperatures. The total thermal conductivity for each composition was then obtained by adding  $k_s$  to  $k_e$ , except below 60 K for alloys containing 5% iron or less. The respective  $\varrho_0$  values were obtained based solely on the experimental data of ref. [81]. The correction due to the thermoelectric power, which would be no more than 2% of the total thermal conductivity for any composition at any temperature, was not made at this time for the same reason as for the Fe+Ni alloys. The recommended values are for totally disordered alloys only; there may be an order-disorder transformation in Ni+Fe alloys over a wide range of compositions.

A graphical comparison of the recommended total thermal conductivity values with selected experimental data is given in figures 53 and 54. The smooth solid curves in these figures were obtained by interpolating the recommended values of table 25 in order to obtain thermal conductivity values for the desired alloy compositions. For iron-rich alloys shown in figure 53, the recommended values are in agreement with the data of Chari and de Nobel [99] (Fe+Ni curve 1), of de Nobel [100] (Fe+Ni curve 35), and of Kohlhass and Kierspe [97] (Fe+Ni curves 30 and 31) at low temperatures to within 10%, and with the data of Powell and Hickman [96] (Fe+Ni curves 3 and 4), of Bäcklund [101] (Fe+Ni curves 24 and 25), and of Watson and Robinson [102] (Fe+Ni curves 19, 26, 28,

29, and 62) at higher temperatures to within 12%. For nickel-rich alloys shown in figure 54, the recommended values agree with the data of Berger and Rivier [107] (Ni+Fe curve 7), of Farrell and Greig [81] (Ni+Fe curves 12-14), and of de Nobel [100] (Ni+Fe curve 35) at low temperatures to within 5%, and with the data of Shelton and Swanger [108] (Ni+Fe curves 3-5), and of Moore et al. [187] (Ni+Fe curve 36) at higher temperatures to within 10%.

The recommended values for  $k$ ,  $k_e$ , and  $k_g$  are tabulated in table 25 for 25 alloy compositions, for most of which the temperature range covered is from 4 to 1100 K. These values are for disordered alloys which have not been severely cold worked or quenched. The values for  $k$  are also presented in figures 55 and 56. The recommended curves for Fe-rich alloys containing 35 to 45% Ni are also shown in figure 56 in order to show more clearly the systematic variation of the thermal conductivity with alloy composition and to clarify the confu-

sion in figure 55 due to crossover of curves. No values are given at temperatures above 1100 K at this time since there is a phase transformation in iron at 1183 K and it is as yet not known what effect such a transformation has on the lattice thermal conductivity of these alloys. It is noted that at high temperatures the differences between the  $k$  values of 5% and 10% nickel alloys are rather large. This is caused by the discontinuity of the Curie temperature at 5.5% nickel, where it drops from 1038 K to 677 K as nickel content increases [104]. The values of residual electrical resistivity for the alloys are also given in table 25. The uncertainties of the  $k$  values are stated in a footnote to table 25, while the uncertainties of the  $k_e$  and  $k_g$  values are indicated by their being designated as recommended, provisional, or typical values. The ranges of uncertainties of recommended, provisional, and typical values are less than  $\pm 15\%$ , between  $\pm 15$  and  $\pm 30\%$ , and greater than  $\pm 30\%$ , respectively.



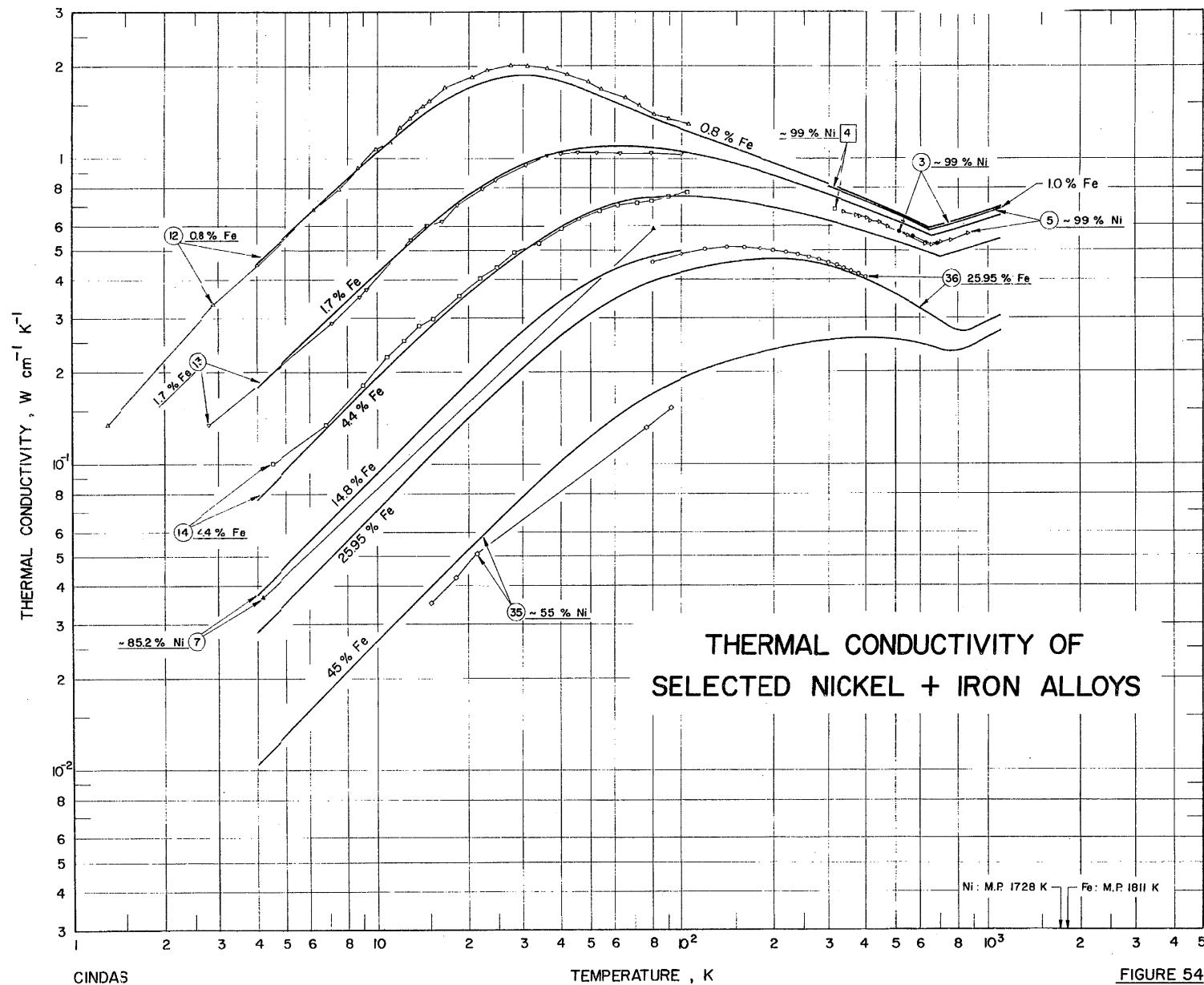


TABLE 25. RECOMMENDED THERMAL CONDUCTIVITY OF IRON-NICKEL ALLOY SYSTEM<sup>†</sup>[Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Fe: 99.50% (99.52 At. %) Ni: 0.50% ( 0.48 At. %)				Fe: 99.00% (99.05 At. %) Ni: 1.00% ( 0.95 At. %)				Fe: 97.00% (97.14 At. %) Ni: 3.00% ( 2.86 At. %)				Fe: 95.00% (95.23 At. %) Ni: 5.00% ( 4.77 At. %)			
$\rho_o = 1.20 \mu\Omega \text{ cm}$				$\rho_o = 2.40 \mu\Omega \text{ cm}$				$\rho_o = 7.20 \mu\Omega \text{ cm}$				$\rho_o = 10.8 \mu\Omega \text{ cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.0868 <sup>*‡</sup>			4	0.0445 <sup>*‡</sup>			4	0.0148 <sup>*‡</sup>	0.0136 <sup>#</sup>	0.00125 <sup>#</sup>	4	0.00978 <sup>#</sup>	0.00905 <sup>#</sup>	0.000732 <sup>#</sup>
6	0.133 <sup>*‡</sup>			6	0.0688 <sup>*‡</sup>			6	0.0229 <sup>*‡</sup>	0.0204 <sup>#</sup>	0.00250 <sup>#</sup>	6	0.0151 <sup>#</sup>	0.0136 <sup>#</sup>	0.00147 <sup>#</sup>
8	0.180 <sup>*‡</sup>			8	0.0924 <sup>*‡</sup>			8	0.0312 <sup>*‡</sup>	0.0271 <sup>#</sup>	0.00408 <sup>#</sup>	8	0.0205 <sup>#</sup>	0.0181 <sup>#</sup>	0.00239 <sup>#</sup>
10	0.229 <sup>*‡</sup>			10	0.120 <sup>*‡</sup>			10	0.0398 <sup>*‡</sup>	0.0339 <sup>#</sup>	0.00592 <sup>#</sup>	10	0.0261 <sup>#</sup>	0.0226 <sup>#</sup>	0.00347 <sup>#</sup>
15	0.351 <sup>*‡</sup>			15	0.187 <sup>*‡</sup>			15	0.0623 <sup>#</sup>	0.0508 <sup>#</sup>	0.0115 <sup>#</sup>	15	0.0407 <sup>#</sup>	0.0339 <sup>#</sup>	0.00678 <sup>#</sup>
20	0.471 <sup>*‡</sup>			20	0.255 <sup>*‡</sup>			20	0.0852 <sup>#</sup>	0.0672 <sup>#</sup>	0.0180 <sup>#</sup>	20	0.0559 <sup>#</sup>	0.0452 <sup>#</sup>	0.0107 <sup>#</sup>
25	0.586 <sup>*‡</sup>			25	0.320 <sup>*‡</sup>			25	0.108 <sup>#</sup>	0.0835 <sup>#</sup>	0.0250 <sup>#</sup>	25	0.0712 <sup>#</sup>	0.0562 <sup>#</sup>	0.0150 <sup>#</sup>
30	0.697 <sup>*‡</sup>			30	0.386 <sup>*‡</sup>			30	0.132 <sup>#</sup>	0.0991 <sup>#</sup>	0.0325 <sup>#</sup>	30	0.0866 <sup>#</sup>	0.0670 <sup>#</sup>	0.0196 <sup>#</sup>
40	0.879 <sup>*‡</sup>			40	0.508 <sup>*‡</sup>			40	0.178 <sup>#</sup>	0.130 <sup>#</sup>	0.0481 <sup>#</sup>	40	0.116 <sup>#</sup>	0.0867 <sup>#</sup>	0.0294 <sup>#</sup>
50	0.998 <sup>*‡</sup>			50	0.602 <sup>*‡</sup>			50	0.220 <sup>#</sup>	0.157 <sup>#</sup>	0.0632 <sup>#</sup>	50	0.143 <sup>#</sup>	0.104 <sup>#</sup>	0.0391 <sup>#</sup>
60	1.04 <sup>*‡</sup>	0.774 <sup>#</sup>	0.265 <sup>#</sup>	60	0.667 <sup>*‡</sup>	0.465 <sup>#</sup>	0.202 <sup>#</sup>	60	0.256 <sup>#</sup>	0.179 <sup>#</sup>	0.0770 <sup>#</sup>	60	0.168 <sup>#</sup>	0.120 <sup>#</sup>	0.0485 <sup>#</sup>
70	1.02 <sup>*‡</sup>	0.737 <sup>#</sup>	0.288 <sup>#</sup>	70	0.701 <sup>*‡</sup>	0.478 <sup>#</sup>	0.223 <sup>#</sup>	70	0.287 <sup>#</sup>	0.198 <sup>#</sup>	0.0889 <sup>#</sup>	70	0.190 <sup>#</sup>	0.133 <sup>#</sup>	0.0563 <sup>#</sup>
80	0.984 <sup>*‡</sup>	0.684 <sup>#</sup>	0.300 <sup>#</sup>	80	0.709 <sup>*‡</sup>	0.474 <sup>#</sup>	0.235 <sup>#</sup>	80	0.310 <sup>#</sup>	0.212 <sup>#</sup>	0.0979 <sup>#</sup>	80	0.208 <sup>#</sup>	0.144 <sup>#</sup>	0.0639 <sup>#</sup>
90	0.938 <sup>*‡</sup>	0.635 <sup>#</sup>	0.303 <sup>#</sup>	90	0.704 <sup>*‡</sup>	0.464 <sup>#</sup>	0.240 <sup>#</sup>	90	0.328 <sup>#</sup>	0.224 <sup>#</sup>	0.104 <sup>#</sup>	90	0.223 <sup>#</sup>	0.154 <sup>#</sup>	0.0688 <sup>#</sup>
100	0.899 <sup>#</sup>	0.599 <sup>#</sup>	0.300 <sup>#</sup>	100	0.697 <sup>#</sup>	0.457 <sup>#</sup>	0.240 <sup>#</sup>	100	0.342 <sup>#</sup>	0.234 <sup>#</sup>	0.108 <sup>#</sup>	100	0.236 <sup>#</sup>	0.164 <sup>#</sup>	0.0724 <sup>#</sup>
150	0.816 <sup>#</sup>	0.555 <sup>#</sup>	0.261 <sup>#</sup>	150	0.678 <sup>#</sup>	0.465 <sup>#</sup>	0.213 <sup>#</sup>	150	0.387 <sup>#</sup>	0.282 <sup>#</sup>	0.105 <sup>#</sup>	150	0.282 <sup>#</sup>	0.208 <sup>#</sup>	0.0742 <sup>#</sup>
200	0.783 <sup>#</sup>	0.566 <sup>#</sup>	0.217 <sup>#</sup>	200	0.673 <sup>#</sup>	0.494 <sup>#</sup>	0.179 <sup>#</sup>	200	0.417 <sup>#</sup>	0.325 <sup>#</sup>	0.0923 <sup>#</sup>	200	0.315 <sup>#</sup>	0.248 <sup>#</sup>	0.0671 <sup>#</sup>
250	0.746 <sup>#</sup>	0.564 <sup>#</sup>	0.182 <sup>#</sup>	250	0.654 <sup>#</sup>	0.503 <sup>#</sup>	0.151 <sup>#</sup>	250	0.434 <sup>#</sup>	0.354 <sup>#</sup>	0.0800 <sup>#</sup>	250	0.341 <sup>#</sup>	0.282 <sup>#</sup>	0.0589 <sup>#</sup>
273	0.733 <sup>#</sup>	0.564 <sup>#</sup>	0.169 <sup>#</sup>	273	0.650 <sup>#</sup>	0.509 <sup>#</sup>	0.141 <sup>#</sup>	273	0.444 <sup>#</sup>	0.369 <sup>#</sup>	0.0750 <sup>#</sup>	273	0.349 <sup>#</sup>	0.294 <sup>#</sup>	0.0553 <sup>#</sup>
300	0.711 <sup>#</sup>	0.555 <sup>#</sup>	0.156 <sup>#</sup>	300	0.637 <sup>#</sup>	0.507 <sup>#</sup>	0.130 <sup>#</sup>	300	0.446 <sup>#</sup>	0.377 <sup>#</sup>	0.0695 <sup>#</sup>	300	0.358 <sup>#</sup>	0.306 <sup>#</sup>	0.0519 <sup>#</sup>
350	0.673 <sup>#</sup>	0.537 <sup>#</sup>	0.136 <sup>#</sup>	350	0.612 <sup>#</sup>	0.499 <sup>#</sup>	0.113 <sup>#</sup>	350	0.451 <sup>#</sup>	0.390 <sup>#</sup>	0.0613 <sup>#</sup>	350	0.368 <sup>#</sup>	0.322 <sup>#</sup>	0.0458 <sup>#</sup>
400	0.637 <sup>#</sup>	0.517 <sup>#</sup>	0.120 <sup>#</sup>	400	0.586 <sup>#</sup>	0.486 <sup>#</sup>	0.100 <sup>#</sup>	400	0.450 <sup>#</sup>	0.395 <sup>#</sup>	0.0545 <sup>#</sup>	400	0.376 <sup>#</sup>	0.335 <sup>#</sup>	0.0408 <sup>#</sup>
500	0.575 <sup>#</sup>	0.478 <sup>#</sup>	0.0972 <sup>#</sup>	500	0.541 <sup>#</sup>	0.460 <sup>#</sup>	0.0814 <sup>#</sup>	500	0.442 <sup>#</sup>	0.397 <sup>#</sup>	0.0446 <sup>#</sup>	500	0.385 <sup>#</sup>	0.352 <sup>#</sup>	0.0335 <sup>#</sup>
600	0.522 <sup>#</sup>	0.440 <sup>#</sup>	0.0817 <sup>#</sup>	600	0.497 <sup>#</sup>	0.429 <sup>#</sup>	0.0685 <sup>#</sup>	600	0.428 <sup>#</sup>	0.390 <sup>#</sup>	0.0376 <sup>#</sup>	600	0.386 <sup>#</sup>	0.358 <sup>#</sup>	0.0284 <sup>#</sup>
700	0.471 <sup>#</sup>	0.401 <sup>#</sup>	0.0702 <sup>#</sup>	700	0.452 <sup>#</sup>	0.393 <sup>#</sup>	0.0591 <sup>#</sup>	700	0.400 <sup>#</sup>	0.367 <sup>#</sup>	0.0325 <sup>#</sup>	700	0.370 <sup>#</sup>	0.346 <sup>#</sup>	0.0245 <sup>#</sup>
800	0.417 <sup>#</sup>	0.355 <sup>#</sup>	0.0616 <sup>#</sup>	800	0.403 <sup>#</sup>	0.351 <sup>#</sup>	0.0518 <sup>#</sup>	800	0.362 <sup>#</sup>	0.333 <sup>#</sup>	0.0286 <sup>#</sup>	800	0.338		
900	0.367 <sup>#</sup>	0.312 <sup>#</sup>	0.0548 <sup>#</sup>	900	0.355 <sup>#</sup>	0.309 <sup>#</sup>	0.0462 <sup>#</sup>	900	0.321 <sup>#</sup>	0.295 <sup>#</sup>	0.0255 <sup>#</sup>	900	0.305		
1000	0.319 <sup>#</sup>	0.269 <sup>#</sup>	0.0494 <sup>#</sup>	1000	0.309 <sup>#</sup>	0.267 <sup>#</sup>	0.0416 <sup>#</sup>	1000	0.281 <sup>#</sup>	0.258 <sup>#</sup>	0.0230 <sup>#</sup>	1000	0.263		
1100	0.289 <sup>#</sup>	0.244 <sup>#</sup>	0.0451 <sup>#</sup>	1100	0.281 <sup>#</sup>	0.243 <sup>#</sup>	0.0379 <sup>#</sup>	1100	0.261 <sup>#</sup>			1100	0.250		

<sup>†</sup> Uncertainties in the total thermal conductivity, k, are as follows:99.50 Fe - 0.50 Ni:  $\pm 15\%$  up to 700 K and  $\pm 10\%$  above 700 K.99.00 Fe - 1.00 Ni:  $\pm 15\%$  up to 700 K and  $\pm 10\%$  above 700 K.97.00 Fe - 3.00 Ni:  $\pm 15\%$  up to 700 K and  $\pm 10\%$  above 700 K.95.00 Fe - 5.00 Ni:  $\pm 15\%$  up to 700 K and  $\pm 10\%$  above 700 K.<sup>#</sup> Provisional value.<sup>\*</sup> Typical value.<sup>\*</sup> In temperature range where no experimental thermal conductivity data are available.

TABLE 25. RECOMMENDED THERMAL CONDUCTIVITY OF IRON-NICKEL ALLOY SYSTEM (continued)<sup>†</sup>[Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Fe: 90.00% (90.44 At.%) Ni: 10.00% (9.56 At.%)				Fe: 85.00% (85.63 At.%) Ni: 15.00% (14.37 At.%)				Fe: 80.00% (80.79 At.%) Ni: 20.00% (19.21 At.%)				Fe: 75.00% (75.93 At.%) Ni: 25.00% (24.07 At.%)			
$\rho_o = 14.8 \mu\Omega \text{ cm}$				$\rho_o = 17.1 \mu\Omega \text{ cm}$				$\rho_o = 19.4 \mu\Omega \text{ cm}$				$\rho_o = 22.6 \mu\Omega \text{ cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.00697 <sup>‡</sup>	0.00661 <sup>‡</sup>	0.000364 <sup>‡</sup>	4	0.00598 <sup>‡</sup>	0.00571 <sup>‡</sup>	0.000267 <sup>‡</sup>	4	0.00525 <sup>‡</sup>			4	0.00450 <sup>‡</sup>		
6	0.0107 <sup>‡</sup>	0.00990 <sup>‡</sup>	0.000752 <sup>‡</sup>	6	0.00911 <sup>‡</sup>	0.00857 <sup>‡</sup>	0.000538 <sup>‡</sup>	6	0.00800 <sup>‡</sup>			6	0.00684 <sup>‡</sup>		
8	0.0144 <sup>‡</sup>	0.0132 <sup>‡</sup>	0.00120 <sup>‡</sup>	8	0.0123 <sup>‡</sup>	0.0114 <sup>‡</sup>	0.000881 <sup>‡</sup>	8	0.0108 <sup>‡</sup>			8	0.00923 <sup>‡</sup>		
10	0.0183 <sup>‡</sup>	0.0165 <sup>‡</sup>	0.00176 <sup>‡</sup>	10	0.0156 <sup>‡</sup>	0.0143 <sup>‡</sup>	0.00129 <sup>‡</sup>	10	0.0137 <sup>‡</sup>			10	0.0117 <sup>‡</sup>		
15	0.0284 <sup>‡</sup>	0.0248 <sup>‡</sup>	0.00345 <sup>‡</sup>	15	0.0240 <sup>‡</sup>	0.0215 <sup>‡</sup>	0.00253 <sup>‡</sup>	15	0.0210 <sup>‡</sup>			15	0.0179 <sup>‡</sup>		
20	0.0385 <sup>‡</sup>	0.0330 <sup>‡</sup>	0.00548 <sup>‡</sup>	20	0.0326 <sup>‡</sup>	0.0286 <sup>‡</sup>	0.00405 <sup>‡</sup>	20	0.0284 <sup>‡</sup>			20	0.0243 <sup>‡</sup>		
25	0.0489 <sup>‡</sup>	0.0412 <sup>‡</sup>	0.00775 <sup>‡</sup>	25	0.0412 <sup>‡</sup>	0.0355 <sup>‡</sup>	0.00575 <sup>‡</sup>	25	0.0359 <sup>‡</sup>			25	0.0308 <sup>‡</sup>		
30	0.0593 <sup>‡</sup>	0.0491 <sup>‡</sup>	0.0102 <sup>‡</sup>	30	0.0499 <sup>‡</sup>	0.0423 <sup>‡</sup>	0.00760 <sup>‡</sup>	30	0.0435 <sup>‡</sup>			30	0.0372 <sup>‡</sup>		
40	0.0790 <sup>‡</sup>	0.0636 <sup>‡</sup>	0.0154 <sup>‡</sup>	40	0.0669 <sup>‡</sup>	0.0553 <sup>‡</sup>	0.0116 <sup>‡</sup>	40	0.0583 <sup>‡</sup>			40	0.0498 <sup>‡</sup>		
50	0.0977 <sup>‡</sup>	0.0770 <sup>‡</sup>	0.0207 <sup>‡</sup>	50	0.0830 <sup>‡</sup>	0.0673 <sup>‡</sup>	0.0157 <sup>‡</sup>	50	0.0721 <sup>‡</sup>			50	0.0619 <sup>‡</sup>		
60	0.115 <sup>‡</sup>	0.0889 <sup>‡</sup>	0.0260 <sup>‡</sup>	60	0.0978 <sup>‡</sup>	0.0780 <sup>‡</sup>	0.0198 <sup>‡</sup>	60	0.0848 <sup>‡</sup>			60	0.0733 <sup>‡</sup>		
70	0.130 <sup>‡</sup>	0.0993 <sup>‡</sup>	0.0309 <sup>‡</sup>	70	0.111 <sup>‡</sup>	0.0872 <sup>‡</sup>	0.0236 <sup>‡</sup>	70	0.0967 <sup>‡</sup>			70	0.0839 <sup>‡</sup>		
80	0.143 <sup>‡</sup>	0.108 <sup>‡</sup>	0.0354 <sup>‡</sup>	80	0.122 <sup>‡</sup>	0.0954 <sup>‡</sup>	0.0271 <sup>‡</sup>	80	0.107 <sup>‡</sup>			80	0.0933 <sup>‡</sup>		
90	0.154 <sup>‡</sup>	0.115 <sup>‡</sup>	0.0391 <sup>‡</sup>	90	0.133 <sup>‡</sup>	0.103 <sup>‡</sup>	0.0304 <sup>‡</sup>	90	0.117 <sup>‡</sup>			90	0.102 <sup>‡</sup>		
100	0.163 <sup>‡</sup>	0.121 <sup>‡</sup>	0.0421 <sup>‡</sup>	100	0.143 <sup>‡</sup>			100	0.126 <sup>‡</sup>			100	0.110 <sup>‡</sup>		
150	0.208 <sup>‡</sup>	0.161 <sup>‡</sup>	0.0469 <sup>‡</sup>	150	0.182 <sup>‡</sup>			150	0.161 <sup>‡</sup>			150	0.142 <sup>‡</sup>		
200	0.239 <sup>‡</sup>	0.195 <sup>‡</sup>	0.0437 <sup>‡</sup>	200	0.210 <sup>‡</sup>			200	0.188 <sup>‡</sup>			200	0.164 <sup>‡</sup>		
250	0.263 <sup>‡</sup>	0.224 <sup>‡</sup>	0.0390 <sup>‡</sup>	250	0.233 <sup>‡</sup>			250	0.208 <sup>‡</sup>			250	0.182 <sup>‡</sup>		
273	0.272 <sup>‡</sup>	0.235 <sup>‡</sup>	0.0370 <sup>‡</sup>	273	0.240 <sup>‡</sup>			273	0.216 <sup>‡</sup>			273	0.188 <sup>‡</sup>		
300	0.281 <sup>‡</sup>	0.246 <sup>‡</sup>	0.0349 <sup>‡</sup>	300	0.248 <sup>‡</sup>			300	0.224 <sup>‡</sup>			300	0.195 <sup>‡</sup>		
350	0.293 <sup>‡</sup>	0.262 <sup>‡</sup>	0.0311 <sup>‡</sup>	350	0.259 <sup>‡</sup>			350	0.235 <sup>‡</sup>			350	0.205 <sup>‡</sup>		
400	0.303 <sup>‡</sup>	0.275 <sup>‡</sup>	0.0279 <sup>‡</sup>	400	0.267 <sup>‡</sup>			400	0.244 <sup>‡</sup>			400	0.213 <sup>‡</sup>		
500	0.313 <sup>‡</sup>			500	0.275 <sup>‡</sup>			500	0.255 <sup>‡</sup>			500	0.222 <sup>‡</sup>		
600	0.319 <sup>‡</sup>			600	0.286 <sup>‡</sup>			600	0.263 <sup>‡</sup>			600	0.237 <sup>‡</sup>		
700	0.316 <sup>‡</sup>			700	0.284 <sup>‡</sup>			700	0.264 <sup>‡</sup>			700	0.241 <sup>‡</sup>		
800	0.297 <sup>*</sup>			800	0.274 <sup>*</sup>			800	0.255			800	0.233		
900	0.270 <sup>*</sup>			900	0.254 <sup>*</sup>	0.243	0.0114 <sup>‡</sup>	900	0.238 <sup>*</sup>	0.228	0.0101 <sup>‡</sup>	900	0.220 <sup>*</sup>	0.211	0.00920 <sup>*</sup>
1000	0.240 <sup>*</sup>	0.228	0.0121 <sup>‡</sup>	1000	0.237 <sup>*</sup>	0.227	0.0103 <sup>‡</sup>	1000	0.228 <sup>*</sup>	0.219	0.00911 <sup>‡</sup>	1000	0.218 <sup>*</sup>	0.210	0.00838 <sup>*</sup>
1100	0.238 <sup>*</sup>	0.227	0.0110 <sup>‡</sup>	1100	0.233 <sup>*</sup>	0.224	0.00939 <sup>‡</sup>	1100	0.219 <sup>*</sup>	0.211	0.00837 <sup>‡</sup>	1100	0.224 <sup>*</sup>	0.216	0.00771 <sup>*</sup>

<sup>†</sup> Uncertainties in the total thermal conductivity, k, are as follows:90.00 Fe - 10.00 Ni:  $\pm 15\%$  up to 700 K and  $\pm 10\%$  above 700 K.85.00 Fe - 15.00 Ni:  $\pm 15\%$  up to 700 K and  $\pm 10\%$  above 700 K.80.00 Fe - 20.00 Ni:  $\pm 15\%$  up to 700 K and  $\pm 10\%$  above 700 K.75.00 Fe - 25.00 Ni:  $\pm 15\%$  up to 700 K and  $\pm 10\%$  above 700 K.<sup>‡</sup> Provisional value.<sup>\*</sup> Typical value.<sup>\*</sup> In temperature range where no experimental thermal conductivity data are available.

TABLE 25. RECOMMENDED THERMAL CONDUCTIVITY OF IRON-NICKEL ALLOY SYSTEM (continued)<sup>†</sup>

[Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Fe: 70.00% (71.04 At.%) Ni: 30.00% (28.96 At.%)				Fe: 65.00% (66.13 At.%) Ni: 35.00% (33.87 At.%)				Fe: 60.00% (61.19 At.%) Ni: 40.00% (38.81 At.%)				Fe: 55.00% (56.23 At.%) Ni: 45.00% (43.77 At.%)			
$\rho_0 = 22.7 \mu\Omega \text{ cm}$				$\rho_0 = 59.1 \mu\Omega \text{ cm}$				$\rho_0 = 36.1 \mu\Omega \text{ cm}$				$\rho_0 = 22.0 \mu\Omega \text{ cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.00315 <sup>‡</sup>			4	0.00180 <sup>‡</sup>			4	0.00442 <sup>‡</sup>			4	0.00610 <sup>*‡</sup>		
6	0.00480 <sup>‡</sup>			6	0.00277 <sup>‡</sup>			6	0.00666 <sup>‡</sup>			6	0.00917 <sup>*‡</sup>		
8	0.00650 <sup>‡</sup>			8	0.00378 <sup>‡</sup>			8	0.00887 <sup>‡</sup>			8	0.0122 <sup>*‡</sup>		
10	0.00824 <sup>‡</sup>			10	0.00482 <sup>‡</sup>			10	0.0111 <sup>‡</sup>			10	0.0153 <sup>*‡</sup>		
15	0.0127 <sup>‡</sup>			15	0.00757 <sup>‡</sup>			15	0.0166 <sup>‡</sup>			15	0.0228 <sup>*‡</sup>		
20	0.0174 <sup>‡</sup>			20	0.0105 <sup>‡</sup>			20	0.0222 <sup>‡</sup>			20	0.0305 <sup>*‡</sup>		
25	0.0220 <sup>‡</sup>			25	0.0135 <sup>‡</sup>			25	0.0276 <sup>‡</sup>			25	0.0379 <sup>*‡</sup>		
30	0.0267 <sup>‡</sup>			30	0.0166 <sup>‡</sup>			30	0.0328 <sup>‡</sup>			30	0.0451 <sup>*‡</sup>		
40	0.0361 <sup>‡</sup>			40	0.0227 <sup>‡</sup>			40	0.0431 <sup>‡</sup>			40	0.0588 <sup>*‡</sup>		
50	0.0452 <sup>‡</sup>			50	0.0289 <sup>‡</sup>			50	0.0526 <sup>‡</sup>			50	0.0713 <sup>*‡</sup>		
60	0.0538 <sup>‡</sup>			60	0.0350 <sup>‡</sup>			60	0.0613 <sup>‡</sup>			60	0.0819 <sup>*‡</sup>		
70	0.0617 <sup>‡</sup>			70	0.0407 <sup>‡</sup>			70	0.0689 <sup>‡</sup>			70	0.0921 <sup>*‡</sup>		
80	0.0691 <sup>‡</sup>			80	0.0460 <sup>‡</sup>			80	0.0757 <sup>‡</sup>			80	0.100 <sup>*‡</sup>		
90	0.0757 <sup>‡</sup>			90	0.0510 <sup>‡</sup>			90	0.0815 <sup>‡</sup>			90	0.108 <sup>*‡</sup>		
100	0.0820 <sup>‡</sup>			100	0.0554 <sup>‡</sup>			100	0.0862 <sup>‡</sup>			100	0.114 <sup>*‡</sup>		
150	0.106 <sup>‡</sup>			150	0.0721 <sup>‡</sup>			150	0.102			150	0.135		
200	0.123 <sup>‡</sup>			200	0.0825			200	0.112			200	0.149		
250	0.136 <sup>‡</sup>			250	0.0905			250	0.119			250	0.158		
273	0.141 <sup>‡</sup>			273	0.0938			273	0.121			273	0.161		
300	0.146			300	0.0973			300	0.124			300	0.164		
350	0.154			350	0.104			350	0.129			350	0.168		
400	0.161			400	0.110			400	0.133			400	0.172		
500	0.175			500	0.124			500	0.141			500	0.177		
600	0.189			600	0.139			600	0.151			600	0.182		
700	0.197			700	0.155			700	0.166			700	0.190	0.180	0.00988 <sup>#</sup>
800	0.197	0.187	0.00950 <sup>‡</sup>	800	0.170	0.161	0.00913 <sup>‡</sup>	800	0.182	0.173	0.00893 <sup>‡</sup>	800	0.204	0.195	0.00882 <sup>#</sup>
900	0.200*	0.191	0.00849 <sup>‡</sup>	900	0.184*	0.176	0.00818 <sup>‡</sup>	900	0.198*	0.190	0.00807 <sup>‡</sup>	900	0.219	0.211	0.00795 <sup>#</sup>
1000	0.208*	0.200	0.00771 <sup>‡</sup>	1000	0.199*	0.192	0.00740 <sup>‡</sup>	1000	0.212*	0.204	0.00736 <sup>‡</sup>	1000	0.233	0.226	0.00725 <sup>#</sup>
1100	0.216*	0.209	0.00704 <sup>‡</sup>	1100	0.210*	0.203	0.00676 <sup>‡</sup>	1100	0.223*	0.216	0.00679 <sup>‡</sup>	1100	0.245	0.238	0.00668 <sup>#</sup>

<sup>†</sup> Uncertainties in the total thermal conductivity, k, are as follows:

70.00 Fe - 30.00 Ni:  $\pm 20\%$  below 300 K and  $\pm 12\%$  above 300 K.

65.00 Fe - 35.00 Ni:  $\pm 20\%$  below 200 K and  $\pm 12\%$  above 200 K.

60.00 Fe - 40.00 Ni:  $\pm 20\%$  below 150 K,  $\pm 10\%$  between 150 and 500 K, and  $\pm 12\%$  above 500 K.

55.00 Fe - 45.00 Ni:  $\pm 20\%$  below 150 K,  $\pm 8\%$  between 150 and 500 K, and  $\pm 10\%$  above 500 K.

<sup>‡</sup> Provisional value.

<sup>\*</sup> Typical value.

<sup>#</sup> In temperature range where no experimental thermal conductivity data are available.

TABLE 25. RECOMMENDED THERMAL CONDUCTIVITY OF IRON-NICKEL ALLOY SYSTEM (continued)<sup>†</sup>[Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Fe: 50.00% (51.25 At. %) Ni: 50.00% (48.75 At. %)				Fe: 45.00% (46.24 At. %) Ni: 55.00% (53.76 At. %)				Fe: 40.00% (41.21 At. %) Ni: 60.00% (58.79 At. %)				Fe: 35.00% (36.15 At. %) Ni: 65.00% (63.85 At. %)			
$\rho_0 = 14.8 \mu\Omega \text{ cm}$				$\rho_0 = 10.9 \mu\Omega \text{ cm}$				$\rho_0 = 7.95 \mu\Omega \text{ cm}$				$\rho_0 = 5.97 \mu\Omega \text{ cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.00819 <sup>#‡</sup>			4	0.0105			4	0.0139*			4	0.0181*		
6	0.0123 <sup>#‡</sup>			6	0.0158			6	0.0210*			6	0.0272*		
8	0.0164 <sup>#‡</sup>			8	0.0211			8	0.0279*			8	0.0362*		
10	0.0205 <sup>#‡</sup>			10	0.0264			10	0.0349*			10	0.0453*		
15	0.0308 <sup>#‡</sup>			15	0.0399			15	0.0524*			15	0.0680*		
20	0.0410 <sup>#‡</sup>			20	0.0529			20	0.0698*			20	0.0906*		
25	0.0511 <sup>#‡</sup>			25	0.0657			25	0.0864*			25	0.112*		
30	0.0609 <sup>#‡</sup>			30	0.0781			30	0.103*			30	0.133*		
40	0.0794 <sup>#‡</sup>			40	0.102			40	0.134*			40	0.173*		
50	0.0956 <sup>#‡</sup>			50	0.123			50	0.161*			50	0.207*		
60	0.110 <sup>#‡</sup>			60	0.142			60	0.184*			60	0.236*		
70	0.122 <sup>#‡</sup>			70	0.157			70	0.202*			70	0.259*		
80	0.132 <sup>#‡</sup>			80	0.170			80	0.217*			80	0.278*		
90	0.142 <sup>#‡</sup>			90	0.181			90	0.229*			90	0.293*		
100	0.149 <sup>#‡</sup>			100	0.190			100	0.239*			100	0.305*		
150	0.174			150	0.220			150	0.270*			150	0.342*		
200	0.190			200	0.237			200	0.289*			200	0.359*		
250	0.202			250	0.247			250	0.299*			250	0.361*		
273	0.206			273	0.251			273	0.301*			273	0.358*		
300	0.210			300	0.254			300	0.302*			300	0.353*		
350	0.216			350	0.257			350	0.301*			350	0.346*		
400	0.218			400	0.257			400	0.295*			400	0.334*		
500	0.219			500	0.254			500	0.281*			500	0.309*		
600	0.220			600	0.247 <sup>#‡</sup>	0.236	0.0109 <sup>#‡</sup>	600	0.269*	0.258	0.0111 <sup>#‡</sup>	600	0.288*	0.276	0.0115 <sup>#‡</sup>
700	0.216	0.206	0.00962 <sup>#‡</sup>	700	0.236 <sup>#‡</sup>	0.226	0.00958 <sup>#‡</sup>	700	0.250*	0.240	0.00974 <sup>#‡</sup>	700	0.262*	0.252	0.0100 <sup>#‡</sup>
800	0.221	0.213	0.00858 <sup>#‡</sup>	800	0.234 <sup>#‡</sup>	0.225	0.00854 <sup>#‡</sup>	800	0.244*	0.235	0.00868 <sup>#‡</sup>	800	0.251*	0.242	0.00893 <sup>#‡</sup>
900	0.236	0.228	0.00774 <sup>#‡</sup>	900	0.245 <sup>#‡</sup>	0.237	0.00771 <sup>#‡</sup>	900	0.252*	0.244	0.00783 <sup>#‡</sup>	900	0.258*	0.250	0.00807 <sup>#‡</sup>
1000	0.250	0.243	0.00706 <sup>#‡</sup>	1000	0.259 <sup>#‡</sup>	0.252	0.00701 <sup>#‡</sup>	1000	0.266*	0.259	0.00714 <sup>#‡</sup>	1000	0.272*	0.265	0.00736 <sup>#‡</sup>
1100	0.261	0.254	0.00650 <sup>#‡</sup>	1100	0.271 <sup>#‡</sup>	0.265	0.00648 <sup>#‡</sup>	1100	0.278*	0.271	0.00659 <sup>#‡</sup>	1100	0.284*	0.277	0.00679 <sup>#‡</sup>

<sup>†</sup> Uncertainties in the total thermal conductivity, k, are as follows:50.00 Fe - 50.00 Ni:  $\pm 15\%$  below 150 K,  $\pm 8\%$  between 150 and 500 K, and  $\pm 14\%$  above 500 K.45.00 Fe - 55.00 Ni:  $\pm 12\%$  below 100 K,  $\pm 10\%$  between 100 and 500 K, and  $\pm 20\%$  above 500 K.40.00 Fe - 60.00 Ni:  $\pm 12\%$  below 200 K and  $\pm 20\%$  above 200 K.35.00 Fe - 65.00 Ni:  $\pm 12\%$  below 200 K and  $\pm 20\%$  above 200 K.<sup>#</sup> Provisional value.<sup>\*</sup> Typical value.<sup>\*</sup> In temperature range where no experimental thermal conductivity data are available.

TABLE 25. RECOMMENDED THERMAL CONDUCTIVITY OF IRON-NICKEL ALLOY SYSTEM (continued)<sup>†</sup>  
 [Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Fe: 30.00% (31.06 At.%) Ni: 70.00% (68.94 At.%)				Fe: 25.00% (25.95 At.%) Ni: 75.00% (74.05 At.%)				Fe: 20.00% (20.81 At.%) Ni: 80.00% (79.19 At.%)				Fe: 15.00% (15.65 At.%) Ni: 85.00% (84.35 At.%)			
$\rho_0 = 4.72 \mu\Omega \text{ cm}$				$\rho_0 = 3.83 \mu\Omega \text{ cm}$				$\rho_0 = 3.32 \mu\Omega \text{ cm}$				$\rho_0 = 2.84 \mu\Omega \text{ cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.0225			4	0.0275			4	0.0317			4	0.0371 <sup>‡</sup>		
6	0.0338 <sup>‡</sup>			6	0.0412 <sup>*</sup>			6	0.0476 <sup>*</sup>			6	0.0556 <sup>‡</sup>		
8	0.0451 <sup>‡</sup>			8	0.0550 <sup>*</sup>			8	0.0634 <sup>*</sup>			8	0.0742 <sup>‡</sup>		
10	0.0563 <sup>*</sup>			10	0.0688 <sup>*</sup>			10	0.0793 <sup>*</sup>			10	0.0928 <sup>‡</sup>		
15	0.0845 <sup>‡</sup>			15	0.103 <sup>*</sup>			15	0.119 <sup>*</sup>			15	0.139 <sup>‡</sup>		
20	0.113 <sup>*</sup>			20	0.138 <sup>*</sup>			20	0.159 <sup>*</sup>			20	0.184 <sup>‡</sup>		
25	0.139 <sup>*</sup>			25	0.170 <sup>*</sup>			25	0.195 <sup>*</sup>			25	0.228 <sup>‡</sup>		
30	0.164 <sup>*</sup>			30	0.201 <sup>*</sup>			30	0.230 <sup>*</sup>			30	0.269 <sup>‡</sup>		
40	0.214 <sup>*</sup>			40	0.256 <sup>*</sup>			40	0.294 <sup>*</sup>			40	0.338 <sup>‡</sup>		
50	0.257 <sup>*</sup>			50	0.301 <sup>*</sup>			50	0.343 <sup>*</sup>			50	0.392 <sup>‡</sup>		
60	0.294 <sup>‡</sup>			60	0.339 <sup>*</sup>			60	0.383 <sup>*</sup>			60	0.432 <sup>‡</sup>		
70	0.323 <sup>*</sup>			70	0.367 <sup>*</sup>			70	0.413 <sup>*</sup>			70	0.458 <sup>‡</sup>		
80	0.345 <sup>*</sup>			80	0.388 <sup>*</sup>			80	0.433 <sup>*</sup>			80	0.476 <sup>‡</sup>		
90	0.362 <sup>*</sup>			90	0.404 <sup>*</sup>			90	0.447 <sup>*</sup>			90	0.488 <sup>‡</sup>		
100	0.374 <sup>‡</sup>			100	0.417 <sup>*</sup>			100	0.457 <sup>*</sup>			100	0.498 <sup>‡</sup>		
150	0.405 <sup>‡</sup>			150	0.453 <sup>*</sup>			150	0.485 <sup>*</sup>			150	0.515 <sup>‡</sup>		
200	0.416 <sup>‡</sup>			200	0.465 <sup>*</sup>			200	0.494 <sup>*</sup>			200	0.516 <sup>‡</sup>		
250	0.410 <sup>‡</sup>			250	0.458 <sup>*</sup>			250	0.482 <sup>*</sup>			250	0.500 <sup>‡</sup>		
273	0.407 <sup>‡</sup>			273	0.449 <sup>*</sup>			273	0.473 <sup>*</sup>			273	0.494 <sup>‡</sup>		
300	0.400 <sup>‡</sup>			300	0.438			300	0.464			300	0.481 <sup>‡</sup>		
350	0.385 <sup>‡</sup>			350	0.419			350	0.441			350	0.458 <sup>*</sup>	0.435	0.0234 <sup>‡</sup>
400	0.365 <sup>‡</sup>			400	0.399 <sup>*</sup>			400	0.420 <sup>*</sup>			400	0.439 <sup>*</sup>	0.418	0.0210 <sup>‡</sup>
500	0.333 <sup>‡</sup>			500	0.356 <sup>*</sup>	0.342	0.0146 <sup>‡</sup>	500	0.373 <sup>*</sup>	0.357	0.0158 <sup>‡</sup>	500	0.395 <sup>*</sup>	0.378	0.0175 <sup>‡</sup>
600	0.304 <sup>‡</sup>	0.292	0.0118 <sup>‡</sup>	600	0.320 <sup>*</sup>	0.308	0.0125 <sup>‡</sup>	600	0.337 <sup>*</sup>	0.323	0.0136 <sup>‡</sup>	600	0.360 <sup>*</sup>	0.345	0.0150 <sup>‡</sup>
700	0.274 <sup>‡</sup>	0.264	0.0103 <sup>‡</sup>	700	0.288 <sup>*</sup>	0.277	0.0109 <sup>‡</sup>	700	0.309 <sup>*</sup>	0.297	0.0119 <sup>‡</sup>	700	0.333 <sup>*</sup>	0.320	0.0131 <sup>‡</sup>
800	0.258 <sup>‡</sup>	0.249	0.00918 <sup>‡</sup>	800	0.270 <sup>*</sup>	0.260	0.00971 <sup>‡</sup>	800	0.287 <sup>*</sup>	0.276	0.0106 <sup>‡</sup>	800	0.316 <sup>*</sup>	0.304	0.0117 <sup>‡</sup>
900	0.264 <sup>‡</sup>	0.256	0.00828 <sup>‡</sup>	900	0.273 <sup>*</sup>	0.264	0.00876 <sup>‡</sup>	900	0.289 <sup>*</sup>	0.280	0.00949 <sup>‡</sup>	900	0.325 <sup>*</sup>	0.315	0.0105 <sup>‡</sup>
1000	0.279 <sup>‡</sup>	0.271	0.00754 <sup>‡</sup>	1000	0.288 <sup>*</sup>	0.280	0.00798 <sup>‡</sup>	1000	0.305 <sup>*</sup>	0.297	0.00863 <sup>‡</sup>	1000	0.339 <sup>*</sup>	0.330	0.00950 <sup>‡</sup>
1100	0.291 <sup>‡</sup>	0.284	0.00695 <sup>‡</sup>	1100	0.301 <sup>*</sup>	0.294	0.00734 <sup>‡</sup>	1100	0.319 <sup>*</sup>	0.311	0.00796 <sup>‡</sup>	1100	0.352 <sup>*</sup>	0.343	0.00876 <sup>‡</sup>

<sup>†</sup> Uncertainties in the total thermal conductivity, k, are as follows:

30.00 Fe - 70.00 Ni:  $\pm 12\%$  below 200 K and  $\pm 20\%$  above 200 K.

25.00 Fe - 75.00 Ni:  $\pm 10\%$  below 100 K,  $\pm 6\%$  between 100 and 500 K, and  $\pm 15\%$  above 500 K.

20.00 Fe - 80.00 Ni:  $\pm 12\%$  below 100 K,  $\pm 6\%$  between 100 and 500 K, and  $\pm 15\%$  above 500 K.

15.00 Fe - 85.00 Ni:  $\pm 15\%$  below 100 K,  $\pm 8\%$  between 100 and 500 K, and  $\pm 15\%$  above 500 K.

<sup>‡</sup> Provisional value.

<sup>\*</sup> Typical value.

\* In temperature range where no experimental thermal conductivity data are available.

TABLE 25. RECOMMENDED THERMAL CONDUCTIVITY OF IRON-NICKEL ALLOY SYSTEM (continued)†  
[Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Fe: 10.00% (10.46 At. %) Ni: 90.00% (89.54 At. %)				Fe: 5.00% (5.24 At. %) Ni: 95.00% (94.76 At. %)				Fe: 3.00% (3.15 At. %) Ni: 97.00% (96.85 At. %)				Fe: 1.00% (1.05 At. %) Ni: 99.00% (98.95 At. %)			
$\rho_o = 2.38 \mu\Omega \text{ cm}$				$\rho_o = 1.62 \mu\Omega \text{ cm}$				$\rho_o = 1.04 \mu\Omega \text{ cm}$				$\rho_o = 0.364 \mu\Omega \text{ cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.0447‡			4	0.0683‡			4	0.0963‡			4	0.276‡		
6	0.0670‡			6	0.103‡			6	0.146‡			6	0.405‡		
8	0.0894‡			8	0.137‡			8	0.195‡			8	0.530‡		
10	0.112‡			10	0.170‡			10	0.243‡			10	0.655‡		
15	0.167‡			15	0.247‡			15	0.352‡			15	0.943‡		
20	0.220‡			20	0.320‡			20	0.449‡			20	1.17‡		
25	0.271‡			25	0.387‡			25	0.538‡			25	1.31‡		
30	0.317‡			30	0.446‡			30	0.612‡			30	1.39‡		
40	0.399‡			40	0.544‡			40	0.725‡			40	1.45‡		
50	0.454‡			50	0.611‡			50	0.798‡			50	1.43‡		
60	0.495‡			60	0.657‡			60	0.838‡			60	1.39‡		
70	0.521‡			70	0.684‡			70	0.857‡			70	1.34‡		
80	0.537‡			80	0.697‡			80	0.864‡			80	1.29‡		
90	0.545‡*			90	0.702‡			90	0.865‡			90	1.24‡		
100	0.550‡			100	0.703			100	0.861‡			100	1.20		
150	0.561‡			150	0.680*			150	0.816*			150	1.04*		
200	0.555‡			200	0.659*			200	0.760*			200	0.937*		
250	0.538‡			250	0.628*			250	0.714*			250	0.862*		
273	0.529‡			273	0.619*			273	0.695*			273	0.835*		
300	0.517‡			300	0.602*			300	0.675*			300	0.808*		
350	0.492‡	0.464	0.0282‡	350	0.573*	0.528	0.0448‡	350	0.646*	0.586	0.0596‡	350	0.759*	0.668	0.0913‡
400	0.469‡	0.444	0.0253‡	400	0.548*	0.508	0.0400‡	400	0.616*	0.563	0.0531‡	400	0.718*	0.638	0.0802‡
500	0.430‡	0.409	0.0210‡	500	0.504*	0.471	0.0328‡	500	0.571*	0.527	0.0435‡	500	0.652*	0.586	0.0666‡
600	0.398‡*	0.383	0.0180‡	600	0.482*	0.454	0.0278‡	600	0.534*	0.497	0.0367‡	600	0.598*	0.544	0.0543‡
700	0.377‡*	0.367	0.0157‡	700	0.459*	0.435	0.0240‡	700	0.513*	0.481	0.0318‡	700	0.592*	0.545	0.0468‡
800	0.370‡*	0.364	0.0139‡	800	0.479*	0.458	0.0211‡	800	0.534*	0.506	0.0280‡	800	0.615*	0.574	0.0410‡
900	0.385‡*	0.378	0.0126‡	900	0.495*	0.476	0.0189‡	900	0.552*	0.527	0.0249‡	900	0.638*	0.602	0.0364‡
1000	0.399‡*	0.388	0.0114‡	1000	0.510*	0.493	0.0170‡	1000	0.572*	0.550	0.0225‡	1000	0.660*	0.627	0.0328‡
1100	0.413‡*	0.402	0.0105‡	1100	0.523*	0.508	0.0155‡	1100	0.590*	0.570	0.0205‡	1100	0.681*	0.651	0.0299‡

† Uncertainties in the total thermal conductivity, k, are as follows:

10.00 Fe - 90.00 Ni:  $\pm 15\%$  below 100 K,  $\pm 8\%$  between 100 and 500 K, and  $\pm 15\%$  above 500 K.  
 5.00 Fe - 95.00 Ni:  $\pm 15\%$  below 100 K,  $\pm 6\%$  between 100 and 500 K, and  $\pm 10\%$  above 500 K.  
 3.00 Fe - 97.00 Ni:  $\pm 15\%$  below 150 K,  $\pm 6\%$  between 150 and 500 K, and  $\pm 8\%$  above 500 K.  
 1.00 Fe - 99.00 Ni:  $\pm 15\%$  below 100 K,  $\pm 10\%$  between 100 and 250 K, and  $\pm 6\%$  above 250 K.

‡ Provisional value.

\* Typical value.

\* In temperature range where no experimental thermal conductivity data are available.

TABLE 25. RECOMMENDED THERMAL CONDUCTIVITY OF IRON-NICKEL ALLOY SYSTEM (continued)†

[Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Fe: 0.50% ( 0.53 At. %)			
Ni: 99.50% (99.47 At. %)			
$\rho_0 = 0.182 \mu\Omega \text{ cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.545‡		
6	0.796‡		
8	1.04‡		
10	1.29‡		
15	1.85‡		
20	2.10‡		
25	2.33‡		
30	2.32‡		
40	2.19‡		
50	2.01‡		
60	1.84‡		
70	1.69‡		
80	1.57‡		
90	1.47‡		
100	1.38		
150	1.13*		
200	0.994*		
250	0.914*		
273	0.884*		
300	0.852*		
350	0.801	0.695	0.106‡
400	0.758	0.665	0.0932‡
500	0.686	0.611	0.0752‡
600	0.625	0.562	0.0630‡
700	0.621	0.567	0.0542‡
800	0.643	0.596	0.0474‡
900	0.667*	0.625	0.0422‡
1000	0.689*	0.651	0.0380‡
1100	0.708*	0.673	0.0346‡

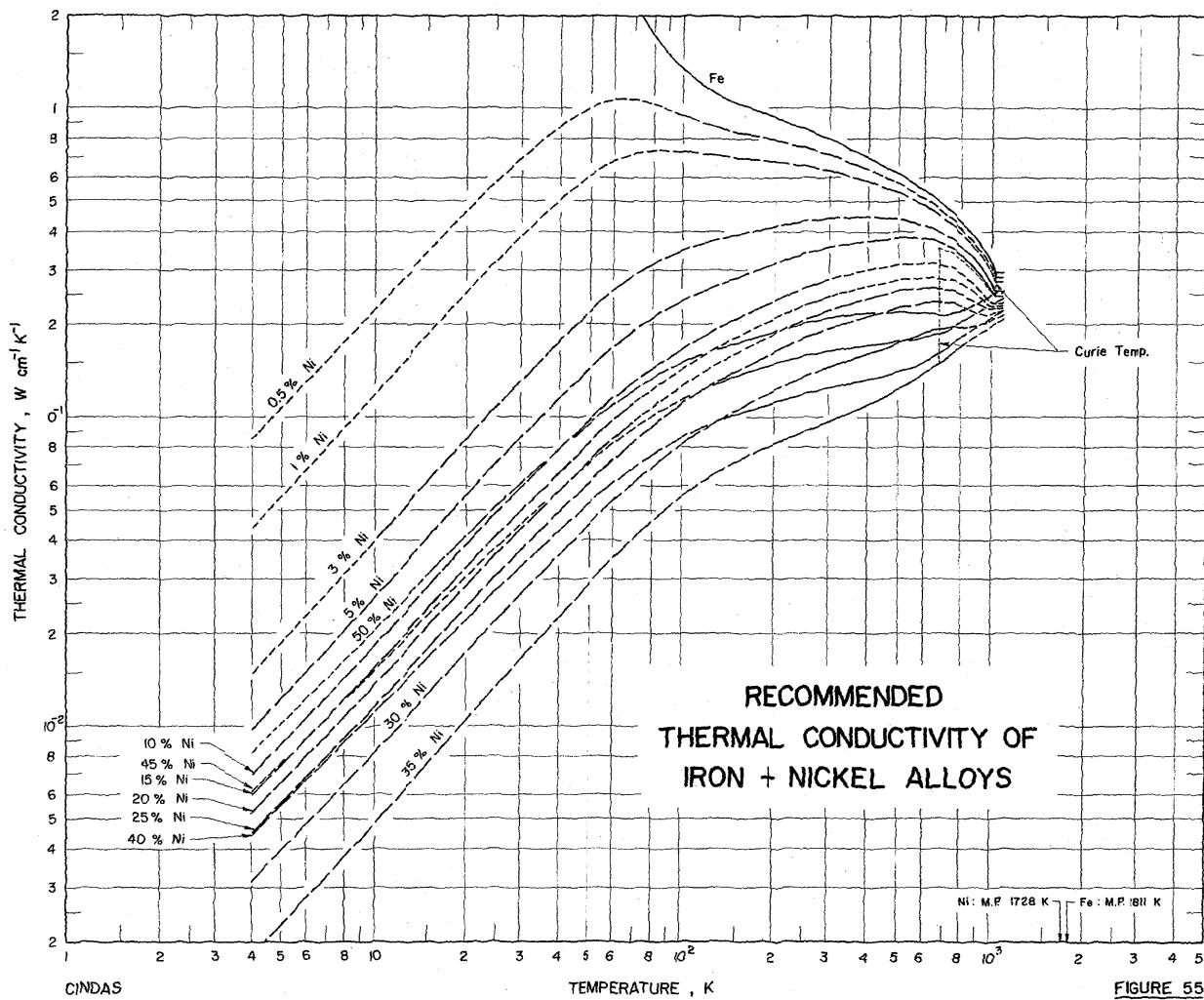
† Uncertainties in the total thermal conductivity, k, are as follows:

0.50 Fe - 99.50 Ni: ± 20% below 100 K, ± 10% between 100 and 250 K, and ± 6% above 250 K.

‡ Provisional value.

\* Typical value.

\* In temperature range where no experimental thermal conductivity data are available.



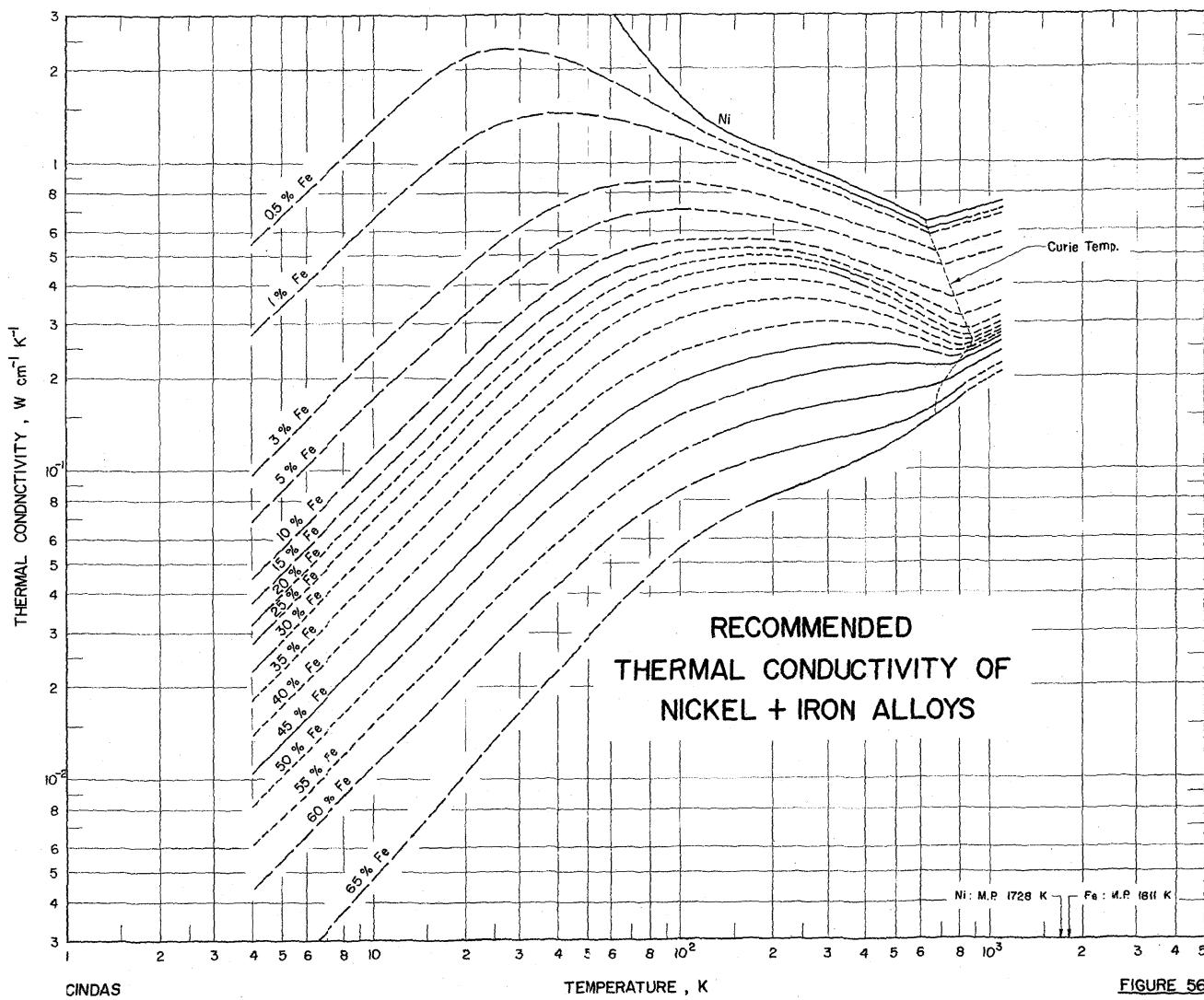
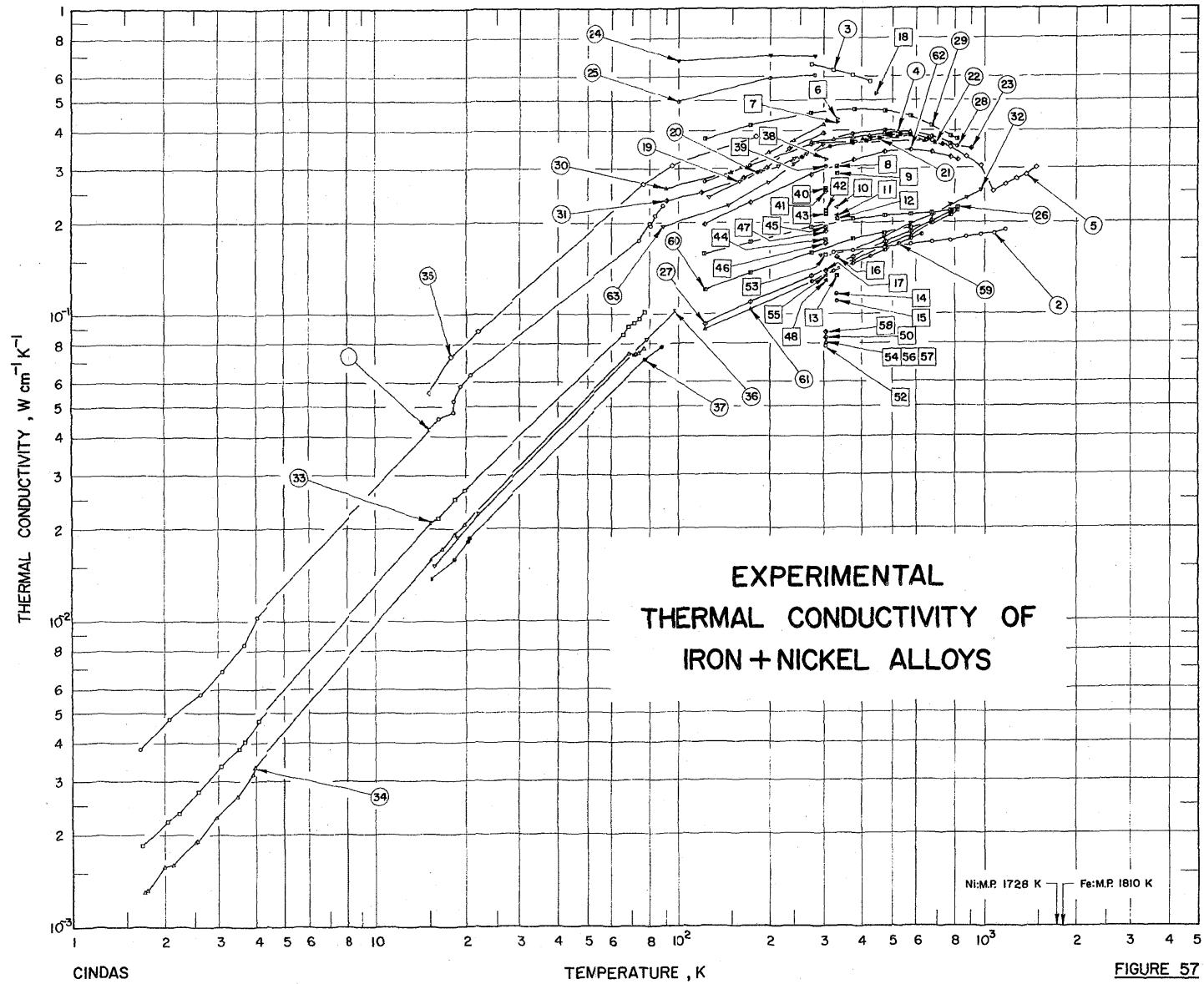


FIGURE 56

**EXPERIMENTAL  
THERMAL CONDUCTIVITY OF  
IRON + NICKEL ALLOYS**



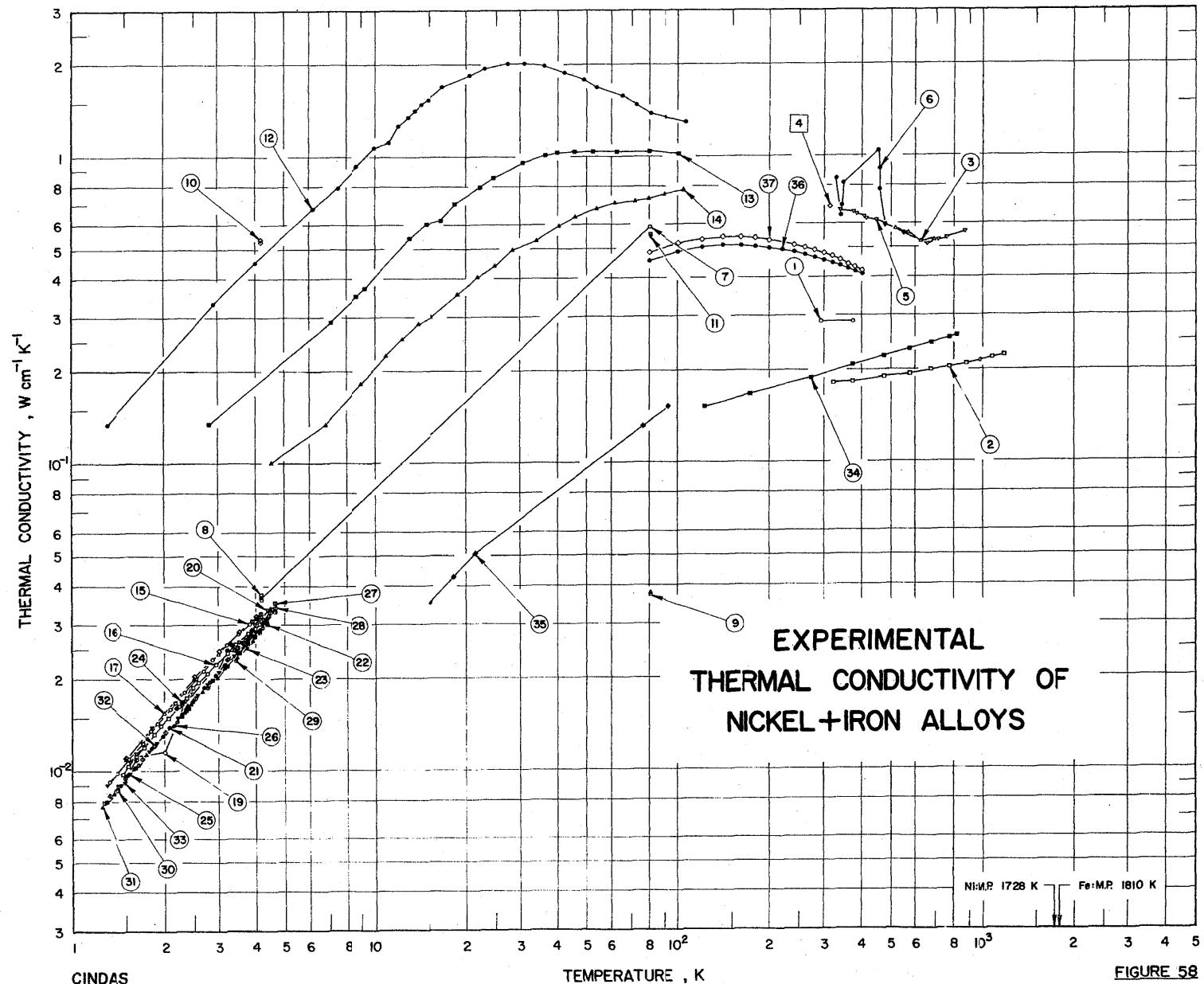


FIGURE 58

TABLE 26. THERMAL CONDUCTIVITY OF IRON + NICKEL ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent) Fe Ni	Composition (continued), Specifications, and Remarks
1	99	Chari, M. S. R. and de Nobel, J.	1959	L	1.6-88	3703	Bal. 5.10	0.34 Mn, 0.16 Si, 0.11 C, 0.04 S, and 0.041 P; 7.5 mm diameter rod specimen; heated to 800 C and cooled in furnace.
2	132	Silverman, L.	1953	C	323-1173	42% Ni-iron	55.8 43.91	0.22 Mn, 0.050 C, and 0.003 S; annealed at 950 C; Advance used as comparative material.
3	96	Powell, R. W. and Hickman, M. J.	1939	C	273-423	Carbon steel; 1	Bal. 0.55	0.38 Mn, 0.08 Cu, 0.06 C, 0.039 As, 0.035 S, 0.03 Mo, 0.022 Cr, 0.017 P, 0.01 Si, and 0.001 Al; 1 in. diameter and 8 in. long; annealed at 930 C; density 7.871 g cm <sup>-3</sup> ; electrical resistivity 11.9, 14.6, 17.8, 21.1, and 24.9 $\mu\Omega$ cm at 0, 50, 100, 150, and 200 C, respectively.
4	96	Powell, R. W. and Hickman, M. J.	1939	C	273-573	Alloy steel; 9	Bal. 3.47	0.55 Mn, 0.325 C, 0.18 Si, 0.17 Cr, 0.086 Cu, 0.034 S, 0.032 P, 0.023 As, 0.04 Mo, 0.01 V, and 0.006 Al; annealed at 860 C; density 7.855 g cm <sup>-3</sup> ; electrical resistivity 25.5, 28.4, 31.5, 34.9, 38.5, 42.5, and 46.8 $\mu\Omega$ cm at 0, 50, 100, 150, 200, 250, and 300 C, respectively.
5	162	Powell, R. W.	1946	→	273-1473			The above specimen; thermal conductivity values calculated from measured electrical resistivity by the Wiedemann-Franz relation using extrapolated values of Lorenz function obtained from the previous thermal conductivity measurements.
6	98	Ingersoll, L. R., Mussel, O. F., Swartz, D. L., Smith, H. F., Thompson, C. G., Mahre, M. A., Frederickson, J. F. and Hubbard, D. R.	1920	L	330	144E	Bal. 1.07	<0.1 C; electrolytic.
7	98	Ingersoll, L. R., et al.	1920	L	330	144F	Bal. 1.93	<0.1 C; electrolytic.
8	98	Ingersoll, L. R., et al.	1920	L	330	144J	Bal. 7.05	<0.1 C; electrolytic.
9	98	Ingersoll, L. R., et al.	1920	L	330	157D	Bal. 10.20	<0.1 C; electrolytic.
10	98	Ingersoll, L. R., et al.	1920	L	330	144M	Bal. 13.11	<0.1 C; electrolytic.
11	98	Ingersoll, L. R., et al.	1920	L	330	144P	Bal. 19.21	<0.1 C; electrolytic.
12	98	Ingersoll, L. R., et al.	1920	L	330	166G	Bal. 22.11	<0.1 C; electrolytic; electrical resistivity reported as 38.7, 45.4, 53.4, 62.7, 72.5, 82.1, 108.3, and 111.6 $\mu\Omega$ cm at 273.2, 373.2, 473.2, 573.2, 673.2, 773.2, 873.2, and 973.2 K, respectively.
13	98	Ingersoll, L. R., et al.	1920	L	330	154S	Bal. 25.20	<0.1 C; electrolytic.
14	98	Ingersoll, L. R., et al.	1920	L	330	166C	Bal. 28.42	<0.1 C; electrolytic.
15	98	Ingersoll, L. R., et al.	1920	L	330	166L	Bal. 35.09	<0.1 C; electrolytic; electrical resistivity reported as 90.3, 100.0, 108.1, 115.2, 119.4, 123.2, 125.9, and 129.3 $\mu\Omega$ cm at 273.2, 373.2, 473.2, 573.2, 673.2, 773.2, 873.2, and 973.2 K, respectively.
16	98	Ingersoll, L. R., et al.	1920	L	330	166O	Bal. 47.08	<0.1 C; electrolytic; electrical resistivity reported as 44.2, 60.0, 75.6, 92.1, 103.3, 109.3, 112.3, and 114.0 $\mu\Omega$ cm at 273.2, 373.2, 473.2, 573.2, 673.2, 773.2, 873.2, and 973.2 K, respectively.
17	131	Ellis, W. C., Morgan, F. L. and Sager, G. F.	1928	P	305	Climax	Bal. 30.0	2.5 mm diameter and 25 mm long; density 8.01 g cm <sup>-3</sup> ; electrical conductivity $1.052 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 32 C; thermal conductivity value calculated from measured thermal diffusivity and specific heat capacity.

TABLE 26. THERMAL CONDUCTIVITY OF IRON + NICKEL ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION (continued)

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent) Fe      Ni	Composition (continued), Specifications, and Remarks
18	163	Marue, H.	1925	C	446	Nickel steel	Bal.      3.41	0.45 C; steel used as comparative material.
19	102	Watson, T.W. and Robinson, H.E.	1961	L	125-263	AISI 2515	94.076      4.91	0.52 Mn, 0.33 Si, and 0.14 C; specimen about 2.54 cm in diameter and about 37 cm long; furnished by International Nickel Co.; normalized at 1144.3 K, tempered at 866.5 K.
20	102	Watson, T.W. and Robinson, H.E.	1961	L	183-483	AISI 2515		The above specimen, run 2.
21	102	Watson, T.W. and Robinson, H.E.	1961	L	372-573	AISI 2515		The above specimen, run 3.
22	102	Watson, T.W. and Robinson, H.E.	1961	L	400-696	AISI 2515		The above specimen, run 4.
23	102	Watson, T.W. and Robinson, H.E.	1961	L	423-908	AISI 2515		The above specimen, run 5.
24	101	Bäcklund, N.G.	1961	L	100-280	3	0.946	Original material supplied by Heraeus, Inc.; re-melted and rolled into bars with a cross-section of about 15 mm <sup>2</sup> and a length of 100 mm; after a short rolling, annealed at 1373 K for 2 hr in evacuated silica tubes, then rolled to final form and annealed at about 773 K for 10 hr; electrical resis- tivity 3.4, 7.9, and 12.9 $\mu\Omega$ cm at 90, 193, and 290 K, respectively.
25	101	Bäcklund, N.G.	1961	L	100-280	5	1.90	Similar to the above specimen; electrical resistivity 5.3, 9.5, and 15.1 $\mu\Omega$ cm at 90, 193, and 290 K, respectively.
26	102	Watson, T.W. and Robinson, H.E.	1961	L	123-813	High-perm-49	49.503      49.15	0.44 Mn, 0.54 Si, 0.09 Cr, and 0.035 C; specimen 2.54 cm in diameter and 37 cm long; supplied by International Nickel Co.; packed in powder and annealed in hydrogen 5 hr at 922.1 K, 5 hr at 1450 K; furnace cooled to 700 K; data presented as a smooth curve.
27	102	Watson, T.W. and Robinson, H.E.	1961	L	123-813	Invar	63.97      35.41	0.13 Si, 0.06 C, and 0.04 Cr; specimen 2.54 cm in diameter and 37 cm long; supplied by International Nickel Co.; annealed 30 min at 1102.6 K, water- quenched, air-cooled at 588.7 K for 1 hr and at 369.3 K for 48 hr; data presented as a smooth curve.
28	102	Watson, T.W. and Robinson, H.E.	1961	L	123-813	AISI 2315	95.483      3.46	0.54 Mn, 0.32 Si, and 0.16 C; specimen 2.54 cm in diameter and 37 cm long; supplied by International Nickel Co.; normalized at 1172.5 K and tempered at 866.5 K; data presented as a smooth curve.
29	102	Watson, T.W. and Robinson, H.E.	1961	L	123-813	1% Ni	97.984      1.04	0.56 Mn, 0.27 Si, and 0.126 C; specimen 2.54 cm in diameter and 37 cm long; supplied by International Nickel Co.; normalized at 1200 K, tem- pered at 866.5 K; presented as a smooth curve.
30	97, 181	Kohlhaas, R. and Kierspe, W.	1965	L	90-298	10 Ni 14	3.75	0.45 Mn, 0.32 Si, and 0.06 C; heat-treated in air at 850 C for 0.5 hr and at 600 C for 2 hr; electrical resistivity 16.78, 21.80, 22.89, 24.31, 25.82, 27.08, 28.36, 29.50, and 30.70 $\mu\Omega$ cm at -190, -70, -50, -25, 0, 20, 40, 60, and 80 C, respectively.
31	97, 181	Kohlhaas, R. and Kierspe, W.	1965	L	90-298	12 Ni 19	4.75	0.40 Mn, 0.35 Si, and 0.086 C; same heat-treatment as above; electrical resistivity 18.26, 23.43, 24.51, 25.96, 27.81, 28.78, 29.98, 31.19, and 32.43 $\mu\Omega$ cm at -190, -70, -50, -25, 0, 20, 40, 60, and 80 C, respectively.
32	164	Bungardt, K. and Spyra, W.	1965	L	293-973	Ni 36	Bal.      36.91	0.32 Mn, 0.012 P, 0.08 Al, 0.05 Si, 0.06 Mo, 0.05 Co, 0.02 C, and 0.008 S; cylindrical specimen; heat-treated in water at 1000 C for 24 hr; electrical resistivity 78.1, 86.8, 96.3, 101.7, 105.7, 109.0, 112.2, 115.0, 117.5, 119.7, 121.3, and 123.7 $\mu\Omega$ cm at 20, 100, 200, 300, 400, 500, 600, 700, 800, 900, 1000, and 1100 C, respectively; smoothed values reported.

TABLE 26. THERMAL CONDUCTIVITY OF IRON + NICKEL ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION (continued)

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent) Fe Ni	Composition (continued), Specifications, and Remarks
33	99	Chari, M.S.R. and de Nobel, J.	1959	L	1.7-76	1287 I	11.39	0.93 Mn, 0.22 Si, and 0.18 C; 5.5 mm diameter rod specimen; heated to 800 C and cooled in furnace.
34	99	Chari, M.S.R. and de Nobel, J.	1959	L	1.7-76	1798 H	19.64	1.09 Mn and 0.43 C; 7.5 mm diameter rod specimen; same heat-treatment as the above specimen.
35	100	de Nobel, J.	1951	L	15-180	1287 D	1.92	0.72 Mn, 0.21 Si, and 0.14 C; 0.5 cm diameter and 4 cm long; heated to 800 C and cooled in furnace.
36	100	de Nobel, J.	1951	L	15-96	1449 A	31.4	0.82 Mn and 0.70 C; 0.5 cm diameter and 4 cm long; heated to 800 C and cooled in furnace.
37	100	de Nobel, J.	1951	L	15-87	3450-3	36.17	0.92 Mn, 0.09 S, and 0.16 C; 0.5 cm diameter and 4 cm long; heated to 1050 C and quenched in water.
38	165	Honda, K.	1918	E	303	2a	4.6	0.48 Cu, 0.31 Mn, 0.11 Si, 0.10 C, 0.028 P, 0.026 S, and 0.012 Co (calculated composition); 5 mm diameter and 20 cm long; prepared by melting together iron and nickel in a porcelain crucible, resulting alloy polished, forged, annealed, and filed to size; annealed at 900 C; electrical conductivity $3.62 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 30 C.
39	165	Honda, K.	1918	E	303	2b		Same composition, dimensions, and fabrication method as the above specimen; cooled once to -190 C in liquid air; electrical conductivity $3.64 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 30 C.
40	165	Honda, K.	1918	E	303	3a	9.2	0.67 Cu, 0.32 Mn, 0.11 C, 0.11 Si, 0.027 P, 0.025 S, and 0.024 Co (calculated composition); same dimensions and fabrication method as the above specimen; annealed at 900 C; electrical conductivity $2.81 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 30 C.
41	165	Honda, K.	1918	E	303	3b		Same composition, dimensions, and fabrication method as the above specimen; cooled once to -190 C in liquid air; electrical conductivity $2.76 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 30 C.
42	165	Honda, K.	1918	E	303	4a	12.8	0.87 Cu, 0.32 Mn, 0.12 C, 0.12 Si, 0.035 Co, 0.025 P, and 0.025 S (calculated composition); same dimensions and fabrication method as the above specimen; annealed at 900 C; electrical conductivity $2.65 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 30 C.
43	165	Honda, K.	1918	E	303	4b		Same composition, dimensions, and fabrication method as the above specimen; cooled once to -190 C in liquid air; electrical conductivity $2.56 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 30 C.
44	165	Honda, K.	1918	E	303	5a	18.5	1.06 Cu, 0.32 Mn, 0.13 C, 0.12 Si, 0.048 Co, 0.024 P, and 0.024 S (calculated composition); same dimensions and fabrication method as the above specimen; annealed at 900 C; electrical conductivity $2.22 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 30 C.
45	165	Honda, K.	1918	E	303	5b		Same composition, dimensions, and fabrication method as the above specimen; cooled once to -190 C in liquid air; electrical conductivity $2.42 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 30 C.
46	165	Honda, K.	1918	E	303	6a	21.2	1.17 Cu, 0.32 Mn, 0.135 C, 0.12 Si, 0.05 Co, 0.023 P, and 0.024 S (calculated composition); same dimensions and fabrication method as the above specimen; annealed at 900 C; electrical conductivity $2.01 \times 10^4 \Omega^{-1} \text{cm}^{-1}$ at 30 C.

TABLE 26. THERMAL CONDUCTIVITY OF IRON + NICKEL ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION (continued)

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent) Fe      Ni	Composition (continued), Specifications, and Remarks
47	165	Honda, K.	1918	E	303	6b		Same composition, dimensions, and fabrication method as the above specimen; annealed at 900 C; electrical conductivity $2.20 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 30 C.
48	165	Honda, K.	1918	E	303	7a	23.6	1.27 Cu, 0.32 Mn, 0.14 C, 0.12 Si, 0.061 Co, 0.024 S, and 0.022 P (calculated composition); same dimensions and fabrication method as the above specimen; annealed at 900 C; electrical conductivity $1.82 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 30 C.
49*	165	Honda, K.	1918	E	303	7b		Same composition, dimensions, and fabrication method as the above specimen; cooled once to -190 C in liquid air; electrical conductivity $2.33 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 30 C.
50	165	Honda, K.	1918	E	303	9a	27.7	1.44 Cu, 0.32 Mn, 0.15 C, 0.12 Si, 0.071 Co, 0.023 S, and 0.021 P (calculated composition); same dimensions and fabrication method as the above specimen; annealed at 900 C; electrical conductivity $1.07 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 30 C.
51*	165	Honda, K.	1918	E	303	9b		Same composition, dimensions, and fabrication method as the above specimen; cooled once to -190 C in liquid air; electrical conductivity $2.40 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 30 C.
52	165	Honda, K.	1918	E	303	10a	29.1	1.51 Cu, 0.32 Mn, 0.15 C, 0.12 Si, 0.075 Co, 0.023 S, and 0.021 P (calculated composition); same dimensions and fabrication method as the above specimen; annealed at 900 C; electrical conductivity $1.02 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 30 C.
53	165	Honda, K.	1918	E	303	10b		Same composition, dimensions, and fabrication method as the above specimen; cooled once to -190 C in liquid air; electrical conductivity $2.35 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 30 C.
54	165	Honda, K.	1918	E	303	11a	30.5	1.56 Cu, 0.32 Mn, 0.155 C, 0.12 Si, 0.078 Co, 0.023 S, and 0.020 P (calculated composition); same dimensions and fabrication method as the above specimen; annealed at 900 C; electrical conductivity $1.08 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 30 C.
55	165	Honda, K.	1918	E	303	11b		Same composition, dimensions, and fabrication method as the above specimen; cooled once to -190 C in liquid air; electrical conductivity $1.95 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 30 C.
56	165	Honda, K.	1918	E	303	12a	32.8	1.65 Cu, 0.33 Mn, 0.15 C, 0.12 Si, 0.084 Co, 0.023 S, and 0.019 P (calculated composition); same dimensions and fabrication method as the above specimen; annealed at 900 C; electrical conductivity $1.01 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 30 C.
57	165	Honda, K.	1918	E	303	12b		Similar to the above specimen except cooled once to -190 C in liquid air instead of annealing.
58	165	Honda, K.	1918	E	303	13a	36.9	1.83 Cu, 0.32 Mn, 0.17 C, 0.13 Si, 0.095 Co, 0.022 S, and 0.018 P (calculated composition); same dimensions and fabrication method as the above specimen; annealed at 900 C; electrical conductivity $1.25 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 30 C.
59	96	Powell, R. W. and Hickman, M.J.	1939	C	273-623	High-Ni steel; 14	28.37	0.89 Mn, 0.28 C, 0.15 Si, 0.030 Cu, 0.027 As, 0.012 Al, 0.009 P, 0.003 S, and trace Cr; 1 in. diameter and 8 in. long; heated to 950 C and cooled in water; electrical resistivity 84.0, 86.8, 89.9, 92.9, 95.9, 98.9, 102.0, and $104.8 \mu\Omega \text{ cm}$ at 0, 50, 100, 150, 200, 250, 300, and 350 C, respectively; iron used as comparative material.

\* Not shown in figure.

TABLE 26. THERMAL CONDUCTIVITY OF IRON + NICKEL ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION (continued)

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent) Fe      Ni	Composition (continued), Specifications, and Remarks
60	102	Watson, T.W. and Robinson, H.E.	1961	L	123-813	Low-exp-42	56.303    42.11	0.97 Mn, 0.16 Si, 0.09 Cr, and 0.085 C; specimen 2.54 cm in diameter and 37 cm long; supplied by International Nickel Co.; annealed for 30 min at 1088.7 K, furnace cooled; data presented as a smooth curve.
61	102	Watson, T.W. and Robinson, H.E.	1961	L	123-813	free cut Invar	62.233    35.84	0.81 Mn, 0.34 Si, 0.12 Cr, and 0.08 C; specimen 2.54 cm in diameter and 37 cm long; supplied by International Nickel Co.; annealed for 30 min at 1102.6 K, water quenched, and air cooled 1 hr at 588.7 K, then 48 hr at 369.3 K; data presented as a smooth curve.
62	102	Watson, T.W. and Robinson, H.E.	1961	L	123-813	% Ni	90.29    8.56	0.77 Mn, 0.28 Si, and 0.10 C; specimen 2.54 cm in diameter and 37 cm long; supplied by International Nickel Co.; normalized at (1650 + 1450 F) (1172 + 1031 K), tempered at 838.7 K; data presented as a smooth curve.
63	97, 181	Kohlhaas, R. and Kierspe, W.	1965	L	88-297	X8 Ni9	8.35	0.74 Mn, 0.28 Si, 0.051 C, 0.016 P, and 0.009 N; heat-treated in air at 790 C for 0.5 hr and at 570 C for 3.5 hr; electrical resistivity 22.66, 28.20, 29.34, 30.90, 32.56, 33.96, 35.21, 36.48, and 37.70 $\mu\Omega$ cm at -190, -70, -50, -25, 0, 20, 40, 60, and 80 C, respectively.
64*	191	Holder, T.K.	1977	L	87-402		3.15	0.15 O, < 0.01 Si, 0.005 Cu, 0.0028 C, 0.0018 H, and 0.0015 N; polycrystalline, photomicrograph showed specimen was not homogeneous single phase material; right circular cylindrical specimen 0.65 cm in diam and about 7.6 cm long; arc-cast, swaged, annealed in argon at 1223 K for 2 h, cooled to 873 K and held there for 20 hr, and furnace-cooled to room temperature; electrical resistivity 6.66, 8.20, 9.72, 11.10, 12.55, 14.03, 15.57, 17.36, 17.39, 19.00, 20.80, 22.67, and 24.00 $\mu\Omega$ cm at 82.6, 116.7, 148.7, 176.6, 205.2, 233.7, 262.1, 294.5, 295.1, 322.5, 352.3, 381.4, and 401.5 K, respectively; thermoelectric power 4.00, 5.21, 5.85, 5.97, 5.71, 5.12, 4.41, 3.53, 2.85, 2.78, 1.61, 0.70, -0.36, -1.29 $\mu\text{V K}^{-1}$ at 86.9, 113.2, 139.6, 170.2, 193.4, 219.0, 243.3, 268.5, 294.3, 296.2, 328.4, 352.7, 379.7, and 402.1 K, respectively; ratio of resistance at 273.15 K to that at 4.2 K was 3.00; thermal conductivity, electrical resistivity, and thermoelectric power accurate to within $\pm 1.2\%$ , $\pm 0.4\%$ , and $\pm 0.1 \mu\text{V K}^{-1}$ , respectively; preliminary calculations indicated thermal conductivity and electrical resistivity altered by as much as 1% by the presence of $\text{Fe}_3\text{O}_4$ ; data extracted from table.

\* Not shown in figure.

TABLE 27. THERMAL CONDUCTIVITY OF NICKEL + IRON ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent) Ni      Fe	Composition (continued), Specifications, and Remarks
1	98	Ingersall, L.R.	1920	L	293, 373	166 Q	75.06	<0.1 C; prepared from 99.97 pure iron and high-purity nickel by forging; 0.98 cm in diameter and 5.1 to 6.7 cm long; electrical resistivity 23.4, 31.3, 40.0, 51.0, 62.0, 70.2, 75.0, and 78.3 $\mu\Omega$ cm at 0, 100, 200, 300, 400, 500, 600, and 700 C, respectively.
2	132	Silverman, L.	1953	C	323-1173		50.85 48.5	0.12 Mn, 0.024 C, and 0.003 S; annealed at 950 C; Advance (55 Cu, 45 Ni) used as comparative material.
3	108	Shelton, S.M. and Swanger, W.H.	1933	C	512-685	N.S. nickel, commercial	99 <sup>+</sup> 0.6	0.14 Cu, 0.09 Mn, and 0.014 S; 2 cm in diameter and 15 cm long; lead used as comparative material.
4	108	Shelton, S.M. and Swanger, W.H.	1933	C	313.2	N.S. nickel, commercial		Similar to the above specimen.
5	108	Shelton, S.M. and Swanger, W.H.	1933	C	339-864	N.S. nickel, commercial		Similar to the above specimen except nickel used as comparative material.
6	166	Bell, I.P. and MacDonald, J.J.	1953	L	328-472	Nickel, commercial	99.4 0.2	0.1 Mg, 0.05 Co, 0.03 Sn, 0.026 C, 0.02 Si, 0.01 Cr, 0.01 Mn, 0.005 S, 0.003 Ti, and 0.002 each of Al and Pb; cylindrical specimen.
7	107	Berger, L. and Rivier, D.	1962	L	4.2, 80		85.2 14.8	0.2 cm diameter and 5.2 cm long; fused in an induction furnace under vacuo of $10^{-3}$ torr; the mixture of Ni and Fe supplied by Johnson-Matthey; cold-rolled, annealed at 1173 K for 2 hr, slowly cooled; electrical resistivity 3.78, 4.60, and 13.22 $\mu\Omega$ cm at 4.18, 80.5, and 292.7 K, respectively.
8	107	Berger, L. and Rivier, D.	1962	L	4.2			The above specimen measured in transverse magnetic fields ranging from 0.150 to 1.92 $\text{W m}^{-1}$ .
9	107	Berger, L. and Rivier, D.	1962	L	80			The above specimen measured in transverse magnetic fields ranging from 0.373 to 1.92 $\text{W m}^{-1}$ .
10	107	Berger, L. and Rivier, D.	1962	L	4.2			The above specimen measured in longitudinal magnetic fields ranging from 0.079 to 1.76 $\text{W m}^{-1}$ .
11	107	Berger, L. and Rivier, D.	1962	L	80			The above specimen measured in longitudinal magnetic fields ranging from 0.051 to 1.41 $\text{W m}^{-1}$ .
12	81	Farrell, T. and Greig, D.	1969	L	1.3-106		0.8	About 3 mm in diameter and 9 cm long; chill-cast under vacuum; annealed at 850 C for 15 hr; residual electrical resistivity 0.307 $\mu\Omega$ cm.
13	81	Farrell, T. and Greig, D.	1969	L	2.8-100		1.7	Similar to the above specimen except residual electrical resistivity 0.713 $\mu\Omega$ cm; electrical resistivity 7.99 $\mu\Omega$ cm at 0 C.
14	81	Farrell, T. and Greig, D.	1969	L	4.5-105		4.4	Similar to the above specimen except residual electrical resistivity 1.80 $\mu\Omega$ cm; electrical resistivity 9.84 $\mu\Omega$ cm at 0 C.
15	105	Yelon, W.B. and Berger, L.	1970	L	1.3-4.1	Permalloy	82 18	Calculated composition.
16	105	Yelon, W.B. and Berger, L.	1970	L	1.5-4.1	Permalloy	71 29	Calculated composition.
17	105	Yelon, W.B. and Berger, L.	1970	L	1.5-4.0	Permalloy		The above specimen measured in a longitudinal magnetic field of 0.781 T.
18*	105	Yelon, W.B. and Berger, L.	1970	L	1.5-4.0	Permalloy		The above specimen measured in a longitudinal magnetic field of 3.3 T.

\*Not shown in figure.

TABLE 27. THERMAL CONDUCTIVITY OF NICKEL + IRON ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION (continued)

Cur. No.	Ref. No.	Author(s)	Year:	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent) Ni      Fe	Composition (continued), Specifications, and Remarks
19	105	Yelon, W.B. and Berger, L.	1970	L	1.5-4.0	Permalloy		The above specimen measured in a longitudinal magnetic field of 5.94 T.
20	106, 177	Yelon, W.B. and Berger, L.	1970	L	1.6-4.4		29.8	Prepared by fusing Johnson-Matthey metals in argon atmosphere, remelting and casting into 0.5 in. rods in helium, swaging to 0.3125 in. in diameter, homogenizing in hydrogen at 1200 C for 38 hr, cooling to 900 C in vacuum and annealing for 2 hr; grain size 0.1 ~ 0.5 mm; electrical resistivity 4.24 $\mu\Omega$ cm at 4.2 K; run 7.
21	106, 177	Yelon, W.B. and Berger, L.	1970	L	1.5-4.4			The above specimen measured in a parallel magnetic field of 7.81 kG.
22	106, 177	Yelon, W.B. and Berger, L.	1970	L	1.6-4.4			The above specimen measured in a parallel magnetic field of 33.00 kG.
23	106, 177	Yelon, W.B. and Berger, L.	1970	L	1.6-4.4			The above specimen measured in a parallel magnetic field of 59.40 kG.
24	106, 177	Yelon, W.B. and Berger, L.	1970	L	1.5-4.3			The above specimen, no magnetic field; run 8.
25	106, 177	Yelon, W.B. and Berger, L.	1970	L	1.3-4.4			The above specimen measured in a parallel magnetic field of 7.81 kG.
26	106, 177	Yelon, W.B. and Berger, L.	1970	L	1.5-4.4			The above specimen measured in a parallel magnetic field of 59.40 kG.
27	106, 177	Yelon, W.B. and Berger, L.	1970	L	1.3-4.7		18.9	Same preparation method as the above specimen; grain size 0.1-0.5 mm; electrical resistivity 4.32 $\mu\Omega$ cm at 4.2 K; run 2.
28	106, 177	Yelon, W.B. and Berger, L.	1970	L	1.3-4.6			The above specimen measured in a parallel magnetic field of 7.15 kG.
29	106, 177	Yelon, W.B. and Berger, L.	1970	L	1.4-4.6			The above specimen measured in a parallel magnetic field of 59.40 kG.
30	106, 177	Yelon, W.B. and Berger, L.	1970	L	1.3-4.6			The above specimen measured in a parallel magnetic field of 7.15 kG; run 3.
31	106, 177	Yelon, W.B. and Berger, L.	1970	L	1.2-4.6			The above specimen measured in a parallel magnetic field of 33.00 kG.
32	106, 177	Yelon, W.B. and Berger, L.	1970	L	1.3-4.6			The above specimen measured in the same magnetic field; run 4.
33	106, 177	Yelon, W.B. and Berger, L.	1970	L	1.3-4.6			The above specimen measured in a parallel magnetic field of 59.40 kG.
34	102	Watson, T.W. and Robinson, H.E.	1961	L	123-813	HyMu 80	79.24 15.283	0.71 Mn, 0.19 Si, 0.08 Cr, and 0.049 C; 2.54 cm diameter and 37 cm long; supplied by International Nickel Co.; powder packed in, annealed in hydrogen at 922 K (1200 F) for 5 hr and at 1450 K (2150 F) for 5 hr, furnace cooled to 700 K (800 F), then cooled in hydrogen; smoothed values reported.
35	100	de Nobel, J.	1951	L	15-93	5277	57.5	1.31 Mn, 0.34 C, and 0.14 Si; as forged.

TABLE 27. THERMAL CONDUCTIVITY OF NICKEL + IRON ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION (continued)

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent)		Composition (continued), Specifications, and Remarks
							Ni	Fe	
36	187	Moore, J. P., Kollie, T. C., Graves, R. S., and McElroy, D. L.	1971	L	80-400	D1	75.4	24.2	< 0.1 total impurities; 2.5 cm diameter x 7.5 cm long; cast, machined, swaged, and lapped; annealed at 1375 K for 24 h and then quenched in ice water; electrical resistivity 42.5, 5.05, 5.55, 6.18, 6.90, 7.70, 8.65, 9.64, 10.75, 11.99, 13.35, 14.75, 16.20, 17.75, 19.44, 21.15, 22.95, and 24.77 $\mu\Omega$ cm at 4.2, 80, 100, 120, 140, 160, 180, 200, 220, 240, 260, 280, 300, 320, 340, 360, 380, and 400 K, respectively; smooth values reported.
37	187	Moore, J. P., et al.	1971	L	80-400	O1			The above specimen heated to 1350 K in a vacuum of $10^{-7}$ torr and cooled at a rate of 5 K min <sup>-1</sup> to room temperature; with high degree of local order; electrical resistivity 4.00, 4.77, 5.24, 5.80, 6.46, 7.19, 8.03, 9.00, 10.07, 11.22, 12.48, 13.78, 15.13, 16.56, 18.08, 19.69, 21.45, and 23.17 $\mu\Omega$ cm at 4.2, 80, 100, 120, 140, 160, 180, 200, 220, 240, 260, 280, 300, 320, 340, 360, 380, and 400 K, respectively; smooth values reported.

#### 4.10. Silver-Palladium Alloy System

The silver-palladium alloy system exhibits complete solid solubility and is analogous to the copper-nickel alloy system, but without the complications of ferromagnetic effects and with an electronic specific heat that is better behaved [109].

There are 32 sets of experimental data available for the thermal conductivity of this alloy system. However, of the 18 data sets available for Ag+Pd alloys listed in table 29 and shown in figure 63, six sets are merely single data points, and of the 14 sets for Pd+Ag alloys listed in table 30 and shown in figure 64 seven sets are single data points.

This alloy system is the most extensively studied among the noble metal-palladium alloy systems, but the only reliable experimental data on thermal conductivity are the low temperature measurements by Kemp et al. [110] (Pd+Ag curves 6-8 and Ag+Pd curves 6-14), Tainsh and White [111] (Ag+Pd curves 16-18), and Fletcher and Greig [84] (Pd+Ag curves 11-14). The early measurements by Schulze [93] (Pd+Ag curves 1-5 and Ag+Pd curves 1-5) of the room-temperature thermal conductivity of these alloys at intervals of 10% gave values that are considerable above the actual values in some cases. Even after correcting for the lattice component, the Lorenz ratios corresponding to Schulze's values for the 60, 70, and 80% Pd alloys are respectively 30, 44 and 35% greater than the classical value; it is unlikely that band structure effects could cause such large Lorenz ratios in these alloys at 298 K. On the other hand, the more recent measurements by Zolotukhin [112] at somewhat higher temperatures on specimens containing 25 and 50% Ag (Pd+Ag curves 9 and 10 and Ag+Pd curve 15) appear to be too low, in the second instance by approximately 25%.

This alloy system is one of the few in which the thermal conductivity has been measured over a very wide range of compositions from liquid helium temperatures to 100 K. The measurements by Kemp et al. were undertaken to obtain fundamental information about the electron-phonon interaction, in particular to see whether electrons interact with lattice waves of all polarizations, to determine the dependence of the interaction on electron concentration and to deduce, by interpolation between these and similar measurements on silver-cadmium alloys, the contribution of the electron-phonon interaction to the lattice thermal resistivity of silver. The study revealed the cusp-like behavior of the low temperature lattice conductivity as a function of composition, as discussed in section 2 on Theoretical Background, and led to additional measurements by Tainsh and White following further annealing at higher temperatures to determine whether or not this behavior was caused by the locking in of dislocations by solute atoms. While the cusp-like behavior persisted, it was found that an increase in the annealing temperature from 883 K to 1213 K resulted in increases of 30% or more in the lattice thermal conductivities of these specimens at liquid helium temperatures.

A comparison of the initial values calculated from eqs (12) and (35) in the region above the lattice component maximum with the experimental values of Kemp et al. revealed that the calculated values for the silver-rich alloys were too low, the total conductivity by as much as 8% and the lattice compo-

nent by as much as 25%. It was found that both the total and lattice thermal conductivities could be brought into good agreement with the experimental data for all compositions from 2 to 30% Pd by increasing the value of the lattice thermal conductivity of pure silver by 50%. Although such an increase does not require unreasonable values for the Debye temperature or the Grüneisen parameter in the equation used to estimate the lattice thermal conductivity of the elements, it raises considerable doubt as to the reliability of such estimates. While the separation of the electronic and lattice components of very dilute alloys at temperatures above that of the maximum of the lattice component involves some uncertainty, a 50% error in the lattice component is unlikely. Although excellent agreement was obtained for the lattice conductivities of both 2 and 5% Pd alloys, it was decided, in view of the conflicting evidence, not to report even provisional values for the lattice thermal conductivity of the dilute silver-rich alloys. In addition, while the measurements of Tainsh and White established that, in the region below its maximum, the lattice thermal conductivity of well-annealed samples is substantially greater than the values obtained from the first set of measurements, these later measurements were limited to temperatures below 10 K and to compositions of 2, 5, and 10% Pd and could, therefore, only serve as a rough guide for correcting the values of the lattice component obtained from measurements on specimens annealed at 883 K; accordingly, the values for the silver-rich alloys at temperatures below the maximum are provisional.

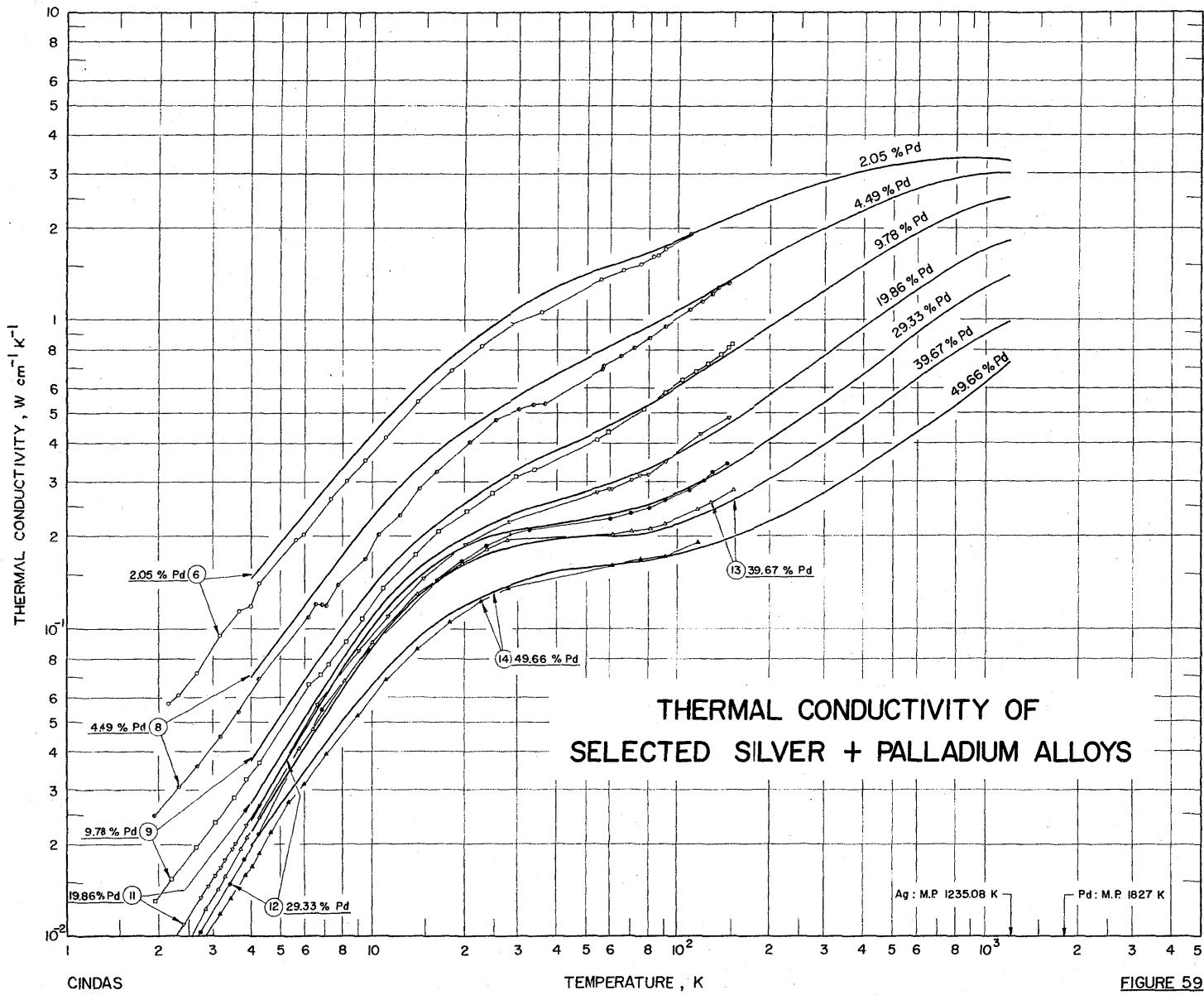
The lattice thermal conductivity of the palladium-rich alloys of this system was investigated by Fletcher and Greig, who measured the thermal conductivity of specimens containing 5, 10, 15, and 20% Ag from liquid helium temperatures to about 100 K. Their study showed that the strong electron-phonon interactions in these alloys greatly reduce the low temperature lattice thermal conductivity, causing its maximum to occur at much higher temperatures than in the silver-rich alloys. The increase in the temperature of the maximum of the lattice component is even greater than that shown in their graph because, at the higher temperatures, the method used to separate the electronic and lattice components yields values of the latter which are below the true values by an amount which increases with temperature, so that the lattice components of these alloys are still increasing at 100 K. This is consistent with the temperature of the maximum of  $k_g$  (100 K) deduced from the measurements by Kemp et al. on a specimen containing 30% Ag. Since the measurements on the Pd-rich alloys did not extend to temperatures above those of the lattice thermal conductivity maxima, the values of the lattice component in this region were obtained by smoothly joining plots of the values deduced from measurements to those calculated from eq (35). In doing this we were guided by the shape of the lattice thermal conductivity curves of the analogous Cu-Ni alloy system.

A graphical comparison of the recommended total thermal conductivity values with some of the experimental data is given in figures 59 and 60. The smooth solid curves in these figures were obtained by interpolating the recommended values of table 28 in order to obtain thermal conductivity values for the desired alloy compositions. For silver-rich

alloys shown in figure 59, the recommended values are in agreement with the data of Kemp et al. [110] (Ag+Pd curves 6, 8, 9, and 11-14) to within 7 to 12%. For palladium-rich alloys shown in figure 60, the recommended values agree with the data of Kemp et al. [110] (Pd+Ag curve 7) to within 5%, and with the data above 10 K of Fletcher and Greig [84] (Pd+Ag curves 11-14) to within 5 to 7%.

The recommended values for  $k$ ,  $k_e$ , and  $k_g$  are tabulated in table 28 for 25 alloy compositions covering the full range of temperature from 4 to 1200 K for most cases. These values are for alloys which have not been severely cold worked or quenched. The values for  $k$  are also presented in figures 61

and 62. In order to show more clearly the systematic variation of the thermal conductivity with alloy composition and to clarify the confusion in figure 62 due to crossover of curves, the recommended curves for palladium-rich alloys with 55 to 65% Pd are also shown in figure 61. The values of residual electrical resistivity for the alloys are also given in table 28. The uncertainties of the  $k$  values are stated in a footnote to table 28, while the uncertainties of the  $k_e$  and  $k_g$  values are indicated by their being designated as recommended or provisional values. The ranges of uncertainties of recommended and provisional values are less than  $\pm 15\%$  and between  $\pm 15$  and  $\pm 30\%$ , respectively.



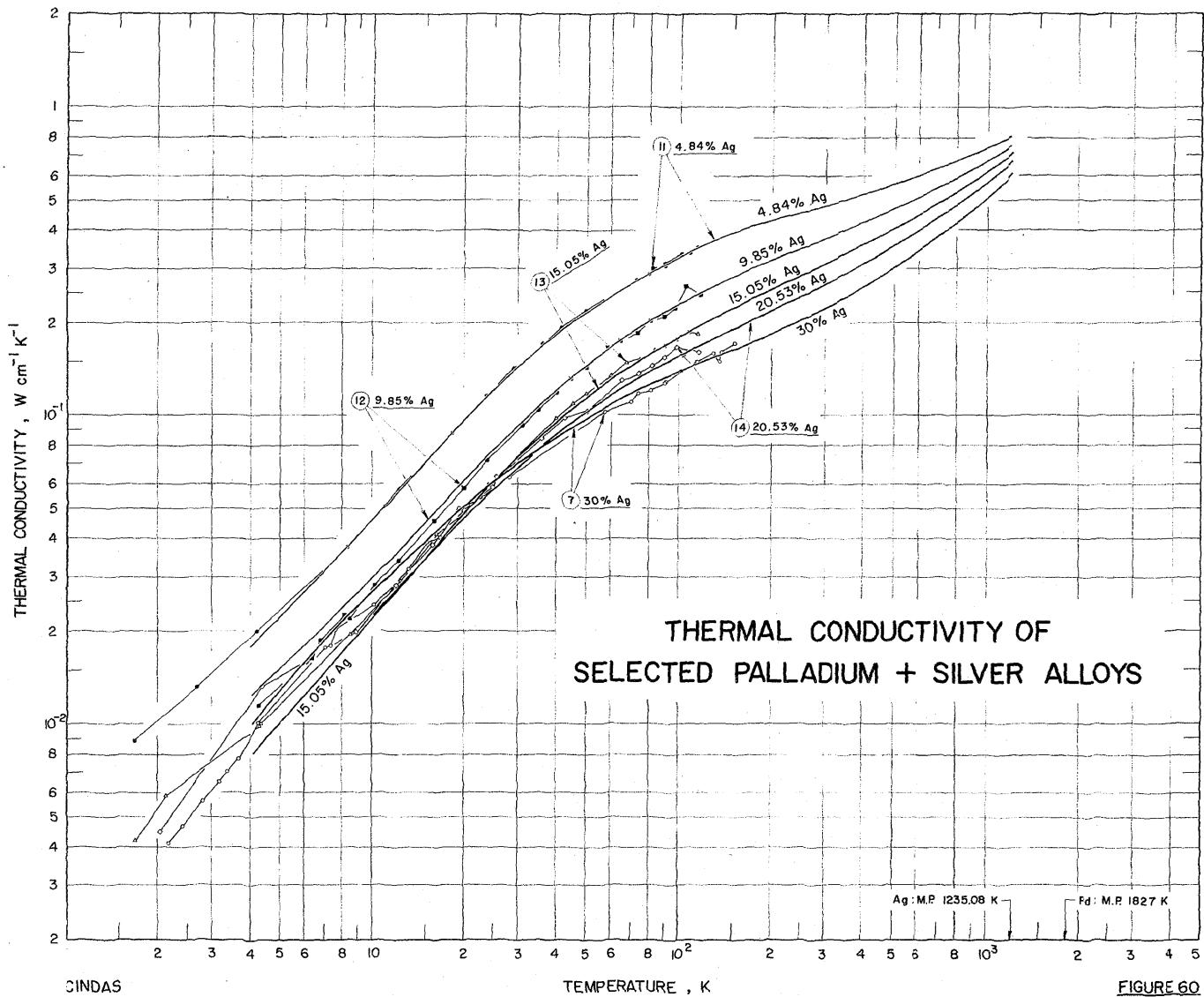


TABLE 28. RECOMMENDED THERMAL CONDUCTIVITY OF SILVER-PALLADIUM ALLOY SYSTEM<sup>†</sup>

[Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Ag: 99.50% (99.49 At.%) Pd: 0.50% (0.51 At.%)				Ag: 99.00% (98.99 At.%) Pd: 1.00% (1.01 At.%)				Ag: 97.00% (96.96 At.%) Pd: 3.00% (3.04 At.%)				Ag: 95.00% (94.93 At.%) Pd: 5.00% (5.07 At.%)			
$\rho_o = 0.2400 \mu\Omega\text{cm}$				$\rho_o = 0.4900 \mu\Omega\text{cm}$				$\rho_o = 1.390 \mu\Omega\text{cm}$				$\rho_o = 2.260 \mu\Omega\text{cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.449*	0.407	0.0415‡	4	0.230*‡	0.199	0.0310‡	4	0.0963‡	0.0703	0.0260‡	4	0.0634‡	0.0432	0.0202‡
6	0.698*	0.611	0.0865‡	6	0.365*‡	0.299	0.0655‡	6	0.159‡	0.105	0.0535‡	6	0.109‡	0.0649	0.0445‡
8	0.949*	0.814	0.135‡	8	0.505*‡	0.399	0.106‡	8	0.228‡	0.141	0.0870‡	8	0.160‡	0.0865	0.0735‡
10	1.20*	1.02	0.180‡	10	0.644*‡	0.499	0.145‡	10	0.300‡	0.176	0.124‡	10	0.212‡	0.108	0.104‡
15	1.78*	1.53	0.246‡	15	0.963*‡	0.748	0.215‡	15	0.453‡	0.264	0.189‡	15	0.319‡	0.162	0.157‡
20	2.33*	2.04	0.285‡	20	1.25*‡	0.997	0.254‡	20	0.571‡	0.352	0.219‡	20	0.405‡	0.216	0.189‡
25	2.65*	2.35	0.298‡	25	1.47*‡	1.20	0.272‡	25	0.665‡	0.433	0.232‡	25	0.467‡	0.262	0.205‡
30	2.84*	2.54	0.300‡	30	1.67*‡	1.39	0.276‡	30	0.748‡	0.513	0.235‡	30	0.521‡	0.311	0.210‡
40	3.03*	2.73	0.295‡	40	1.98*‡	1.69	0.272‡	40	0.892‡	0.661	0.231‡	40	0.612‡	0.404	0.208‡
50	3.04*			50	2.11*			50	1.01			50	0.685		
60	2.98*			60	2.18*			60	1.09			60	0.750		
70	3.00*			70	2.26*			70	1.18			70	0.814		
80	3.07*			80	2.35*			80	1.25			80	0.877		
90	3.10*			90	2.44*			90	1.33			90	0.938		
100	3.19*			100	2.52*			100	1.41			100	0.998		
150	3.40*			150	2.87*			150	1.76			150	1.27		
200	3.59*			200	3.12*			200	2.02*			200	1.51*		
250	3.74*			250	3.27*			250	2.24*			250	1.71*		
273	3.78*			273	3.33*			273	2.33*			273	1.80*		
300	3.82*			300	3.41*			300	2.43*			300	1.88*		
350	3.88*			350	3.50*			350	2.57*			350	2.04*		
400	3.90*			400	3.57*			400	2.69*			400	2.18*		
500	3.91*			500	3.63*			500	2.89*			500	2.41*		
600	3.90*			600	3.69*			600	3.03*			600	2.58*		
700	3.84*			700	3.67*			700	3.12*			700	2.72*		
800	3.81*			800	3.67*			800	3.18*			800	2.83*		
900	3.74*			900	3.62*			900	3.21*			900	2.89*		
1000	3.67*			1000	3.57*			1000	3.22*			1000	2.93*		
1100	3.60*			1100	3.51*			1100	3.22*			1100	2.96*		
1200	3.55*			1200	3.46*			1200	3.22*			1200	2.98*		

† Uncertainties in the total thermal conductivity, k, are as follows:

99.50 Ag - 0.50 Pd: ±10% below 40 K, ±7% between 40 and 300 K, and ±10% above 300 K.

99.00 Ag - 1.00 Pd: ±15% below 40 K and ±10% above 40 K.

97.00 Ag - 3.00 Pd: ±15% below 40 K and ±10% above 40 K.

95.00 Ag - 5.00 Pd: ±15% below 40 K and ±10% above 40 K.

‡ Provisional value.

\* In temperature range where no experimental thermal conductivity data are available.

TABLE 28. RECOMMENDED THERMAL CONDUCTIVITY OF SILVER-PALLADIUM ALLOY SYSTEM (continued)<sup>†</sup>  
 [Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Ag: 90.00% (89.88 At.%) Pd: 10.00% (10.12 At.%)				Ag: 85.00% (84.82 At.%) Pd: 15.00% (15.18 At.%)				Ag: 80.00% (79.78 At.%) Pd: 20.00% (20.22 At.%)				Ag: 75.00% (74.74 At.%) Pd: 25.00% (25.26 At.%)			
$\rho_0 = 4.46 \mu\Omega \text{cm}$				$\rho_0 = 6.46 \mu\Omega \text{cm}$				$\rho_0 = 8.41 \mu\Omega \text{cm}$				$\rho_0 = 10.60 \mu\Omega \text{cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.036‡	0.0219	0.0145‡	4	0.0299**	0.0151	0.0148‡	4	0.0270‡	0.0116	0.0154‡	4	0.0253**	0.00922	0.0161‡
6	0.0662‡	0.0329	0.0333‡	6	0.0553**	0.0227	0.0326‡	6	0.0518‡	0.0174	0.0344‡	6	0.0483**	0.0138	0.0345‡
8	0.100‡	0.0438	0.0562‡	8	0.0859**	0.0303	0.0550‡	8	0.0812‡	0.0232	0.0580‡	8	0.0764‡	0.0184	0.0580‡
10	0.135‡	0.0578	0.0775‡	10	0.119‡	0.0378	0.0810‡	10	0.112‡	0.0290	0.0825‡	10	0.107**	0.0230	0.0840‡
15	0.201‡	0.0822	0.119‡	15	0.182‡	0.0567	0.125‡	15	0.165‡	0.0436	0.121‡	15	0.159**	0.0346	0.124‡
20	0.253‡	0.110	0.143‡	20	0.224**	0.0756	0.148‡	20	0.200‡	0.0581	0.142‡	20	0.192**	0.0461	0.146‡
25	0.292‡	0.135	0.157‡	25	0.251**	0.0931	0.158‡	25	0.224‡	0.0717	0.152‡	25	0.213**	0.0569	0.156‡
30	0.324‡	0.161	0.163‡	30	0.272‡	0.111	0.161‡	30	0.241‡	0.0856	0.155‡	30	0.223**	0.0680	0.155‡
40	0.374‡	0.213	0.161‡	40	0.301**	0.147	0.154‡	40	0.263‡	0.113	0.150‡	40	0.238**	0.0901	0.148‡
50	0.417	0.261	0.156	50	0.326*	0.181	0.145	50	0.281	0.140	0.141	50	0.248*	0.112	0.136
60	0.454	0.307	0.147	60	0.351*	0.215	0.136	60	0.298	0.167	0.131	60	0.259*	0.133	0.126
70	0.491	0.352	0.139	70	0.375*	0.248	0.127	70	0.316	0.193	0.123	70	0.271*	0.154	0.117
80	0.527	0.396	0.131	80	0.400*	0.281	0.119	80	0.333	0.219	0.114	80	0.285*	0.175	0.110
90	0.565	0.441	0.124	90	0.427*	0.314	0.113	90	0.352	0.245	0.107	90	0.299*	0.195	0.104
100	0.602	0.485	0.117	100	0.452*	0.346	0.106	100	0.371	0.270	0.101	100	0.314*	0.216	0.0975
150	0.780	0.687	0.0930	150	0.581*	0.497	0.0840	150	0.472	0.392	0.0800	150	0.393*	0.316	0.0770
200	0.943*	0.866	0.0775	200	0.706*	0.636	0.0700	200	0.573*	0.506	0.0670	200	0.475*	0.410	0.0645
250	1.10*	1.03	0.0665	250	0.827*	0.766	0.0610	250	0.671*	0.613	0.0580	250	0.556*	0.500	0.0560
273	1.16*	1.10	0.0627	273	0.881*	0.823	0.0575	273	0.716*	0.661	0.0545	273	0.593*	0.540	0.0530
300	1.24	1.18	0.0586	300	0.942*	0.888	0.0539	300	0.766	0.715	0.0511	300	0.635*	0.586	0.0494
350	1.38*	1.32	0.0526	350	1.05*	1.00	0.0487	350	0.858*	0.812	0.0463	350	0.711*	0.667	0.0448
400	1.50*	1.45	0.0479	400	1.16*	1.11	0.0444	400	0.946*	0.904	0.0424	400	0.782*	0.741	0.0411
500	1.72*	1.68	0.0406	500	1.35*	1.31	0.0380	500	1.11*	1.07	0.0364	500	0.922*	0.886	0.0354
600	1.91*	1.88	0.0354	600	1.52*	1.49	0.0333	600	1.26*	1.23	0.0320	600	1.05*	1.02	0.0313
700	2.07*	2.04	0.0313	700	1.68*	1.65	0.0297	700	1.39*	1.36	0.0287	700	1.17*	1.14	0.0281
800	2.21*	2.18	0.0282	800	1.82*	1.80	0.0268	800	1.52*	1.50	0.0260	800	1.29*	1.26	0.0255
900	2.32*	2.30	0.0256	900	1.93*	1.91	0.0245	900	1.62*	1.60	0.0238	900	1.38*	1.36	0.0234
1000	2.41*	2.39	0.0235	1000	2.02*	2.00	0.0226	1000	1.71*	1.69	0.0220	1000	1.45*	1.43	0.0216
1100	2.47*	2.45	0.0217	1100	2.10*	2.08	0.0209	1100	1.79*	1.76	0.0204	1100	1.53*	1.51	0.0201
1200	2.53*	2.51	0.0201	1200	2.16*	2.14	0.0195	1200	1.84*	1.82	0.0191	1200	1.60*	1.58	0.0188

† Uncertainties in the total thermal conductivity, k, are as follows:

90.00 Ag - 10.00 Pd:  $\pm 15\%$  below 40 K and  $\pm 10\%$  above 40 K.

85.00 Ag - 15.00 Pd:  $\pm 20\%$  below 40 K and  $\pm 10\%$  above 40 K.

80.00 Ag - 20.00 Pd:  $\pm 20\%$  below 40 K and  $\pm 10\%$  above 40 K.

75.00 Ag - 25.00 Pd:  $\pm 20\%$  below 40 K and  $\pm 10\%$  above 40 K.

‡ Provisional value.

\* In temperature range where no experimental thermal conductivity data are available.

TABLE 28. RECOMMENDED THERMAL CONDUCTIVITY OF SILVER-PALLADIUM ALLOY SYSTEM (continued)<sup>†</sup>  
 [Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Ag: 70.00% (69.71 At. %) Pd: 30.00% (30.29 At. %)				Ag: 65.00% (64.69 At. %) Pd: 35.00% (35.31 At. %)				Ag: 60.00% (59.67 At. %) Pd: 40.00% (40.33 At. %)				Ag: 55.00% (54.66 At. %) Pd: 45.00% (45.34 At. %)			
$\rho_o = 13.01 \mu\Omega \text{cm}$				$\rho_o = 15.62 \mu\Omega \text{cm}$				$\rho_o = 18.44 \mu\Omega \text{cm}$				$\rho_o = 21.56 \mu\Omega \text{cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.0241‡	0.00751	0.0166‡	4	0.0231‡*	0.00626	0.0168‡	4	0.0222‡	0.00530	0.0169‡	4	0.0212‡*	0.00453	0.0167‡
6	0.0472‡	0.0113	0.0350‡	6	0.0439‡*	0.00938	0.0345‡	6	0.0410‡	0.00795	0.0330‡	6	0.0382‡*	0.00680	0.0314‡
8	0.0755‡	0.0150	0.0605‡	8	0.0690‡*	0.0125	0.0565‡	8	0.0646‡	0.0106	0.0540‡	8	0.0576‡*	0.00907	0.0485‡
10	0.102‡	0.0188	0.0835‡	10	0.0945‡*	0.0156	0.0789‡	10	0.0881‡	0.0132	0.0749‡	10	0.0778‡*	0.0113	0.0665‡
15	0.154‡	0.0282	0.126‡	15	0.144‡*	0.0235	0.121‡	15	0.134‡	0.0199	0.114‡	15	0.118‡*	0.0170	0.101‡
20	0.186‡	0.0376	0.148‡	20	0.175‡*	0.0313	0.144‡	20	0.163‡	0.0265	0.136‡	20	0.144‡*	0.0227	0.121‡
25	0.201‡	0.0464	0.155‡	25	0.191‡*	0.0387	0.152‡	25	0.179‡	0.0328	0.146‡	25	0.162‡*	0.0280	0.134‡
30	0.212‡	0.0555	0.156‡	30	0.201‡*	0.0463	0.155‡	30	0.189‡	0.0393	0.150‡	30	0.173‡*	0.0335	0.139‡
40	0.221‡	0.0736	0.147‡	40	0.210‡*	0.0614	0.149‡	40	0.197‡	0.0521	0.145‡	40	0.183‡*	0.0445	0.138‡
50	0.227	0.0913	0.136	50	0.214‡*	0.0763	0.138	50	0.200	0.0648	0.135	50	0.183‡	0.0553	0.128‡
60	0.235	0.109	0.126	60	0.216‡*	0.0909	0.125	60	0.201	0.0772	0.124	60	0.185‡	0.0659	0.119
70	0.243	0.126	0.117	70	0.220‡	0.106	0.114	70	0.201	0.0896	0.115	70	0.187‡	0.0764	0.111
80	0.252	0.143	0.109	80	0.227‡	0.120	0.107	80	0.205	0.102	0.107	80	0.191‡	0.0870	0.104
90	0.263	0.161	0.102	90	0.235‡	0.134	0.101	90	0.211	0.111	0.100	90	0.195‡	0.0974	0.0975
100	0.275	0.178	0.0965	100	0.245‡	0.149	0.0960	100	0.219	0.125	0.0940	100	0.200‡	0.108	0.0920
150	0.338	0.261	0.0765	150	0.294‡	0.219	0.0750	150	0.260	0.186	0.0740	150	0.232‡	0.158	0.0740
200	0.404*	0.340	0.0640	200	0.349‡	0.286	0.0625	200	0.304*	0.242	0.0620	200	0.268*	0.206	0.0620
250	0.471‡	0.415	0.0555	250	0.403*	0.349	0.0540	250	0.350*	0.296	0.0540	250	0.305*	0.251	0.0540
273	0.501*	0.449	0.0520	273	0.428*	0.377	0.0510	273	0.371*	0.320	0.0510	273	0.323*	0.272	0.0510
300	0.534	0.486	0.0484	300	0.457*	0.409	0.0479	300	0.396	0.348	0.0479	300	0.343*	0.295	0.0482
350	0.598*	0.555	0.0439	350	0.511*	0.468	0.0436	350	0.441*	0.397	0.0435	350	0.380*	0.336	0.0439
400	0.661*	0.621	0.0403	400	0.563*	0.523	0.0400	400	0.484*	0.444	0.0400	400	0.416*	0.376	0.0403
500	0.780*	0.745	0.0349	500	0.664*	0.629	0.0346	500	0.567*	0.532	0.0347	500	0.482*	0.447	0.0349
600	0.891*	0.860	0.0308	600	0.758*	0.727	0.0307	600	0.643*	0.613	0.0307	600	0.543*	0.512	0.0310
700	0.998*	0.970	0.0277	700	0.846*	0.818	0.0276	700	0.715*	0.687	0.0278	700	0.599*	0.571	0.0279
800	1.10*	1.07	0.0252	800	0.926*	0.901	0.0252	800	0.780*	0.754	0.0252	800	0.651*	0.626	0.0255
900	1.18*	1.16	0.0232	900	0.997*	0.974	0.0231	900	0.837*	0.813	0.0232	900	0.701*	0.677	0.0235
1000	1.26*	1.24	0.0215	1000	1.06*	1.04	0.0215	1000	0.889*	0.867	0.0216	1000	0.750*	0.728	0.0218
1100	1.32*	1.30	0.0200	1100	1.12*	1.10	0.0200	1100	0.938*	0.917	0.0201	1100	0.798*	0.778	0.0204
1200	1.39*	1.37	0.0187	1200	1.18*	1.16	0.0188	1200	0.984*	0.965	0.0189	1200	0.846*	0.827	0.0191

† Uncertainties in the total thermal conductivity, k, are as follows:

70.00 Ag - 30.00 Pd: ±20% below 40 K and ±10% above 40 K.

65.00 Ag - 35.00 Pd: ±20% below 40 K and ±10% above 40 K.

60.00 Ag - 40.00 Pd: ±20% below 40 K and ±10% above 40 K.

55.00 Ag - 45.00 Pd: ±20% below 40 K and ±10% above 40 K.

‡ Provisional value.

\* In temperature range where no experimental thermal conductivity data are available.

TABLE 28. RECOMMENDED THERMAL CONDUCTIVITY OF SILVER-PALLADIUM ALLOY SYSTEM (continued)<sup>†</sup>  
 [Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Ag: 50.00% (49.66 At.%) Pd: 50.00% (50.34 At.%)				Ag: 45.00% (44.66 At.%) Pd: 55.00% (55.34 At.%)				Ag: 40.00% (39.67 At.%) Pd: 60.00% (60.33 At.%)				Ag: 35.00% (34.69 At.%) Pd: 65.00% (65.31 At.%)			
$\rho_o = 27.44 \mu\Omega\text{cm}$				$\rho_o = 36.50 \mu\Omega\text{cm}$				$\rho_o = 40.15 \mu\Omega\text{cm}$				$\rho_o = 39.40 \mu\Omega\text{cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.0197 <sup>‡</sup>	0.00356	0.0161 <sup>‡</sup>	4	0.0174* <sup>‡</sup>	0.00268	0.0147 <sup>‡</sup>	4	0.0150* <sup>‡</sup>	0.00243	0.0126 <sup>‡</sup>	4	0.0132* <sup>‡</sup>	0.00248	0.0107 <sup>‡</sup>
6	0.0347 <sup>‡</sup>	0.00534	0.0294 <sup>‡</sup>	6	0.0292* <sup>‡</sup>	0.00402	0.0252 <sup>‡</sup>	6	0.0243* <sup>‡</sup>	0.00365	0.0206 <sup>‡</sup>	6	0.0200* <sup>‡</sup>	0.00372	0.0163 <sup>‡</sup>
8	0.0502 <sup>‡</sup>	0.00712	0.0431 <sup>‡</sup>	8	0.0411* <sup>‡</sup>	0.00536	0.0356 <sup>‡</sup>	8	0.0335* <sup>‡</sup>	0.00487	0.0286 <sup>‡</sup>	8	0.0268* <sup>‡</sup>	0.00496	0.0218 <sup>‡</sup>
10	0.0654 <sup>‡</sup>	0.00890	0.0565 <sup>‡</sup>	10	0.0527* <sup>‡</sup>	0.00669	0.0460 <sup>‡</sup>	10	0.0423* <sup>‡</sup>	0.00609	0.0362 <sup>‡</sup>	10	0.0332* <sup>‡</sup>	0.00620	0.0270 <sup>‡</sup>
15	0.0974 <sup>‡</sup>	0.0134	0.0840 <sup>‡</sup>	15	0.0755* <sup>‡</sup>	0.0100	0.0655 <sup>‡</sup>	15	0.0611* <sup>‡</sup>	0.00913	0.0520 <sup>‡</sup>	15	0.0476* <sup>‡</sup>	0.00930	0.0383 <sup>‡</sup>
20	0.118 <sup>‡</sup>	0.0178	0.100 <sup>‡</sup>	20	0.0914* <sup>‡</sup>	0.0134	0.0780 <sup>‡</sup>	20	0.0757* <sup>‡</sup>	0.0122	0.0635 <sup>‡</sup>	20	0.0599* <sup>‡</sup>	0.0124	0.0475 <sup>‡</sup>
25	0.131 <sup>‡</sup>	0.0220	0.109 <sup>‡</sup>	25	0.103* <sup>‡</sup>	0.0166	0.0860 <sup>‡</sup>	25	0.0866* <sup>‡</sup>	0.0151	0.0715 <sup>‡</sup>	25	0.0703* <sup>‡</sup>	0.0153	0.0550 <sup>‡</sup>
30	0.141 <sup>‡</sup>	0.0264	0.115 <sup>‡</sup>	30	0.111* <sup>‡</sup>	0.0199	0.0910 <sup>‡</sup>	30	0.0946* <sup>‡</sup>	0.0181	0.0765 <sup>‡</sup>	30	0.0793* <sup>‡</sup>	0.0183	0.0610 <sup>‡</sup>
40	0.152 <sup>‡</sup>	0.0349	0.117 <sup>‡</sup>	40	0.123* <sup>‡</sup>	0.0264	0.0965 <sup>‡</sup>	40	0.106* <sup>‡</sup>	0.0240	0.0820 <sup>‡</sup>	40	0.0933* <sup>‡</sup>	0.0243	0.0690 <sup>‡</sup>
50	0.157	0.0434	0.114	50	0.131* <sup>‡</sup>	0.0327	0.0985 <sup>‡</sup>	50	0.115* <sup>‡</sup>	0.0298	0.0850 <sup>‡</sup>	50	0.104* <sup>‡</sup>	0.0302	0.0740 <sup>‡</sup>
60	0.162	0.0518	0.110	60	0.137* <sup>‡</sup>	0.0390	0.0980 <sup>‡</sup>	60	0.122* <sup>‡</sup>	0.0356	0.0865 <sup>‡</sup>	60	0.113* <sup>‡</sup>	0.0359	0.0770 <sup>‡</sup>
70	0.165	0.0598	0.105	70	0.141* <sup>‡</sup>	0.0452	0.0960	70	0.128* <sup>‡</sup>	0.0414	0.0870 <sup>‡</sup>	70	0.121* <sup>‡</sup>	0.0417	0.0790 <sup>‡</sup>
80	0.168	0.0680	0.0995	80	0.144* <sup>‡</sup>	0.0514	0.0930	80	0.133* <sup>‡</sup>	0.0469	0.0860 <sup>‡</sup>	80	0.127* <sup>‡</sup>	0.0474	0.0795 <sup>‡</sup>
90	0.171	0.0760	0.0945	90	0.148* <sup>‡</sup>	0.0576	0.0900	90	0.138*	0.0526	0.0850	90	0.133* <sup>‡</sup>	0.0531	0.0800 <sup>‡</sup>
100	0.175	0.0841	0.0905	100	0.151*	0.0637	0.0870	100	0.142*	0.0582	0.0835	100	0.138* <sup>‡</sup>	0.0585	0.0800 <sup>‡</sup>
150	0.198*	0.123	0.0745	150	0.167*	0.0935	0.0735	150	0.159*	0.0859	0.0730	150	0.138*	0.0854	0.0730
200	0.222*	0.159	0.0630	200	0.186*	0.122	0.0635	200	0.175*	0.111	0.0640	200	0.177*	0.111	0.0655
250	0.250*	0.194	0.0555	250	0.206*	0.150	0.0560	250	0.193*	0.136	0.0570	250	0.195*	0.136	0.0590
273	0.263*	0.210	0.0525	273	0.216*	0.162	0.0535	273	0.202*	0.148	0.0543	273	0.204*	0.147	0.0565
300	0.278	0.228	0.0489	300	0.226*	0.176	0.0499	300	0.212	0.161	0.0513	300	0.214*	0.161	0.0532
350	0.304*	0.259	0.0445	350	0.249*	0.204	0.0454	350	0.233*	0.186	0.0467	350	0.233*	0.185	0.0484
400	0.330	0.289	0.0409	400	0.272*	0.231	0.0418	400	0.255*	0.212	0.0429	400	0.253*	0.208	0.0445
500	0.381	0.346	0.0354	500	0.318*	0.281	0.0362	500	0.297*	0.260	0.372	500	0.293*	0.254	0.0385
600	0.430*	0.398	0.0314	600	0.362*	0.330	0.0321	600	0.339*	0.306	0.0330	600	0.334*	0.299	0.0342
700	0.477*	0.449	0.0284	700	0.407*	0.378	0.0290	700	0.381*	0.352	0.0298	700	0.375*	0.344	0.0308
800	0.524*	0.498	0.0259	800	0.453*	0.426	0.0264	800	0.424*	0.397	0.0272	800	0.417*	0.389	0.0281
900	0.573*	0.549	0.0239	900	0.499*	0.474	0.0244	900	0.468*	0.443	0.0250	900	0.451*	0.435	0.0259
1000	0.622*	0.600	0.0221	1000	0.545*	0.522	0.0226	1000	0.511*	0.488	0.0232	1000	0.505*	0.481	0.0240
1100	0.672*	0.651	0.0207	1100	0.591*	0.570	0.0211	1100	0.556*	0.535	0.0217	1100	0.551*	0.529	0.0224
1200	0.723*	0.704	0.0194	1200	0.637*	0.617	0.0198	1200	0.602*	0.582	0.0204	1200	0.598*	0.577	0.0211

† Uncertainties in the total thermal conductivity, k, are as follows:

50.00 Ag - 50.00 Pd:  $\pm 15\%$  below 40 K, and  $\pm 10\%$  above 40 K.

45.00 Ag - 55.00 Pd:  $\pm 15\%$  below 60 K, and  $\pm 10\%$  above 40 K.

40.00 Ag - 60.00 Pd:  $\pm 15\%$  below 80 K, and  $\pm 10\%$  above 80 K.

35.00 Ag - 65.00 Pd:  $\pm 15\%$  below 100 K, and  $\pm 10\%$  above 100 K.

\* Provisional value.

\*\* In temperature range where no experimental thermal conductivity data are available.

TABLE 28. RECOMMENDED THERMAL CONDUCTIVITY OF SILVER-PALLADIUM ALLOY SYSTEM (continued)<sup>†</sup>  
 [Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Ag: 30.00% (29.71 At.%) Pd: 70.00% (70.29 At.%)				Ag: 25.00% (24.74 At.%) Pd: 75.00% (75.26 At.%)				Ag: 20.00% (19.78 At.%) Pd: 80.00% (80.22 At.%)				Ag: 15.00% (14.83 At.%) Pd: 85.00% (85.17 At.%)			
$\rho_0 = 35.11 \mu\Omega\text{cm}$				$\rho_0 = 29.95 \mu\Omega\text{cm}$				$\rho_0 = 24.13 \mu\Omega\text{cm}$				$\rho_0 = 18.15 \mu\Omega\text{cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.0108	0.00278	0.00800	4	0.00906*	0.00326	0.00580	4	0.00805	0.00405	0.00400	4	0.00807	0.00538	0.00269
6	0.0163	0.00418	0.0121	6	0.0140*	0.00489	0.00910	6	0.0127	0.00608	0.00665	6	0.0127	0.00808	0.00465
8	0.0218	0.00557	0.0162	8	0.0190*	0.00653	0.0125	8	0.0175	0.00810	0.00940	8	0.0177	0.0108	0.00685
10	0.0273	0.00696	0.0203	10	0.0241*	0.00816	0.0159	10	0.0225	0.0101	0.0124	10	0.0228	0.0135	0.00925
15	0.0399	0.0104	0.0295	15	0.0362*	0.0122	0.0240	15	0.0350	0.0152	0.0198	15	0.0359	0.0202	0.0157
20	0.0516	0.0139	0.0377	20	0.0480*	0.0163	0.0317	20	0.0472	0.0202	0.0270	20	0.0490	0.0244	0.0226
25	0.0618	0.0170	0.0448	25	0.0583*	0.0198	0.0385	25	0.0583	0.0243	0.0340	25	0.0620	0.0325	0.0295
30	0.0712	0.0203	0.0509	30	0.0681*	0.0236	0.0445	30	0.0690	0.0289	0.0401	30	0.0748	0.0383	0.0365
40	0.0868	0.0268	0.0600	40	0.0855*	0.0310	0.0545	40	0.0889	0.0379	0.0510	40	0.0979	0.0499	0.0480
50	0.0995	0.0332	0.0663	50	0.0995*	0.0383	0.0612	50	0.105	0.0465	0.0585	50	0.117	0.0608	0.0565
60	0.110	0.0394	0.0708	60	0.111*	0.0452	0.0660	60	0.119	0.0548	0.0645	60	0.134	0.0711	0.0625
70	0.119	0.0455	0.0735	70	0.121*	0.0521	0.0685	70	0.131	0.0629	0.0680	70	0.147	0.0809	0.0665
80	0.127	0.0516	0.0750	80	0.131*	0.0589	0.0718	80	0.142	0.0708	0.0710	80	0.160	0.0906	0.0695
90	0.134	0.0577	0.0760	90	0.138*	0.0657	0.0720	90	0.152	0.0787	0.0730	90	0.172	0.100	0.0720
100	0.140	0.0637	0.0760	100	0.145*	0.0723	0.0725	100	0.159	0.0864	0.0740	100	0.183	0.109	0.0740
150	0.165	0.0918	0.0735	150	0.176*	0.103	0.0725	150	0.197*	0.121	0.0760	150	0.227*	0.149	0.0780
200	0.187*	0.119	0.0675	200	0.201*	0.133	0.0685	200	0.226*	0.153	0.0725	200	0.261*	0.184	0.0770
250	0.207*	0.145	0.0615	250	0.224*	0.160	0.0635	250	0.250*	0.182	0.0680	250	0.289*	0.215	0.0740
273	0.215*	0.156	0.0590	273	0.234*	0.172	0.0615	273	0.261*	0.195	0.0655	273	0.301*	0.229	0.0720
300	0.225	0.170	0.0556	300	0.246*	0.187	0.0589	300	0.274	0.211	0.0632	300	0.314*	0.245	0.0693
350	0.245*	0.195	0.0506	350	0.266*	0.213	0.0535	350	0.296*	0.239	0.0573	350	0.338*	0.275	0.0628
400	0.265*	0.219	0.0465	400	0.287*	0.238	0.0491	400	0.319*	0.266	0.0526	400	0.362*	0.305	0.0575
500	0.305*	0.265	0.0402	500	0.329	0.287	0.0425	500	0.364*	0.319	0.0454	500	0.409*	0.360	0.0494
600	0.346*	0.310	0.0357	600	0.373*	0.335	0.0376	600	0.410*	0.370	0.0401	600	0.454*	0.411	0.0435
700	0.387*	0.355	0.0321	700	0.417*	0.384	0.0338	700	0.455*	0.419	0.0360	700	0.499*	0.460	0.0390
800	0.430*	0.401	0.0293	800	0.461*	0.430	0.0308	800	0.499*	0.466	0.0327	800	0.541*	0.506	0.0353
900	0.474*	0.447	0.0270	900	0.504*	0.476	0.0283	900	0.543*	0.513	0.0300	900	0.585*	0.552	0.0324
1000	0.518*	0.493	0.0250	1000	0.547*	0.521	0.0262	1000	0.586*	0.558	0.0278	1000	0.627*	0.597	0.0299
1100	0.565*	0.541	0.0233	1100	0.593*	0.569	0.0245	1100	0.630*	0.604	0.0259	1100	0.669*	0.641	0.0277
1200	0.613*	0.591	0.0219	1200	0.640*	0.617	0.0229	1200	0.675*	0.651	0.0242	1200	0.712*	0.686	0.0259

† Uncertainties in the total thermal conductivity, k, are as follows:

30.00 Ag - 70.00 Pd: ±10% below 100 K, ±7% between 100 and 300 K, and ±10% above 300 K.

25.00 Ag - 75.00 Pd: ±10% below 150 K, ±7% between 150 and 300 K, and ±10% above 300 K.

20.00 Ag - 80.00 Pd: ±10% below 150 K, ±7% between 150 and 300 K, and ±10% above 300 K.

15.00 Ag - 85.00 Pd: ±10% below 150 K, ±7% between 150 and 300 K, and ±10% above 300 K.

\* In temperature range where no experimental thermal conductivity data are available.

TABLE 28. RECOMMENDED THERMAL CONDUCTIVITY OF SILVER-PALLADIUM ALLOY SYSTEM (continued)<sup>†</sup>  
 [Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Ag: 10.00% ( 9.88 At.%) Pd: 90.00% (90.12 At.%)				Ag: 5.00% ( 4.94 At.%) Pd: 95.00% (95.06 At.%)				Ag: 3.00% ( 2.96 At.%) Pd: 97.00% (97.04 At.%)				Ag: 1.00% ( 0.99 At.%) Pd: 99.00% (99.01 At.%)			
$\rho_o = 12.16 \mu\Omega\text{cm}$				$\rho_o = 6.08 \mu\Omega\text{cm}$				$\rho_o = 3.670 \mu\Omega\text{cm}$				$\rho_o = 1.270 \mu\Omega\text{cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>	T	k	k <sub>e</sub>	k <sub>g</sub>
4	0.00955	0.00804	0.00151	4	0.0170	0.0161	0.000900	4	0.0266			4	0.0769		
6	0.0151	0.0121	0.00301	6	0.0261	0.0241	0.00199	6	0.0399			6	0.115		
8	0.0209	0.0161	0.00480	8	0.0355	0.0321	0.00342	8	0.0533			8	0.154		
10	0.0270	0.0201	0.00685	10	0.0454	0.0402	0.00515	10	0.0666			10	0.192		
15	0.0428	0.0301	0.0127	15	0.0708	0.0603	0.0105	15	0.0999			15	0.289		
20	0.0588	0.0394	0.0194	20	0.0969	0.0799	0.0170	20	0.133			20	0.385		
25	0.0744	0.0483	0.0261	25	0.120	0.0955	0.0240	25	0.153			25	0.416		
30	0.0898	0.0566	0.0332	30	0.143	0.112	0.0311	30	0.177			30	0.459		
40	0.119	0.0728	0.0460	40	0.184	0.139	0.0452	40	0.214			40	0.499		
50	0.144	0.0875	0.0560	50	0.217	0.159	0.0579	50	0.237			50	0.495		
60	0.165	0.101	0.0640	60	0.245	0.177	0.0682	60	0.254			60	0.482		
70	0.184	0.114	0.0700	70	0.269	0.192	0.0770	70	0.269			70	0.471		
80	0.200	0.126	0.0740	80	0.292	0.208	0.0842	80	0.285			80	0.472		
90	0.216	0.138	0.0780	90	0.312	0.222	0.0898	90	0.301			90	0.475		
100	0.230	0.149	0.0810	100	0.330	0.236	0.0940	100	0.313			100	0.479		
150	0.283*	0.195	0.0875	150	0.393*	0.287	0.106	150	0.358			150	0.482		
200	0.321*	0.233	0.0875	200	0.433*	0.325	0.108	200	0.389			200	0.490		
250	0.349*	0.265	0.0840	250	0.459*	0.356	0.103	250	0.417			250	0.502		
273	0.362*	0.280	0.0815	273	0.470*	0.370	0.0995	273	0.422			273	0.510		
300	0.376	0.297	0.0788	300	0.483*	0.387	0.0958	300	0.445	0.108		300	0.523	0.127	
350	0.400*	0.329	0.0711	350	0.504*	0.419	0.0858	350	0.477	0.0958		350	0.552	0.111	
400	0.424*	0.359	0.0649	400	0.525*	0.447	0.0777	400	0.503	0.0862		400	0.576	0.0989	
500	0.469*	0.414	0.0554	500	0.563*	0.497	0.0654	500	0.553	0.0718		500	0.624	0.0808	
600	0.514*	0.465	0.0485	600	0.602*	0.546	0.0566	600	0.599	0.0615		600	0.671	0.0682	
700	0.555*	0.511	0.0432	700	0.641*	0.591	0.0499	700	0.645	0.0538		700	0.718	0.0591	
800	0.595*	0.556	0.0390	800	0.676*	0.632	0.0446	800	0.685	0.0479		800	0.762	0.0521	
900	0.636*	0.600	0.0356	900	0.713*	0.673	0.0404	900	0.726	0.0431		900	0.806	0.0465	
1000	0.675*	0.642	0.0327	1000	0.746*	0.709	0.0369	1000	0.760	0.0392		1000	0.843	0.0421	
1100	0.715*	0.684	0.0303	1100	0.779*	0.745	0.0339	1100	0.795	0.0359		1100	0.881	0.0384	
1200	0.755*	0.727	0.0282	1200	0.812*	0.781	0.0314	1200	0.829	0.0332		1200	0.920	0.0353	

† Uncertainties in the total thermal conductivity, k, are as follows:

10.00 Ag - 90.00 Pd: ±10%.

5.00 Ag - 95.00 Pd: ±10%.

3.00 Ag - 97.00 Pd: ±10%.

1.00 Ag - 99.00 Pd: ±10%.

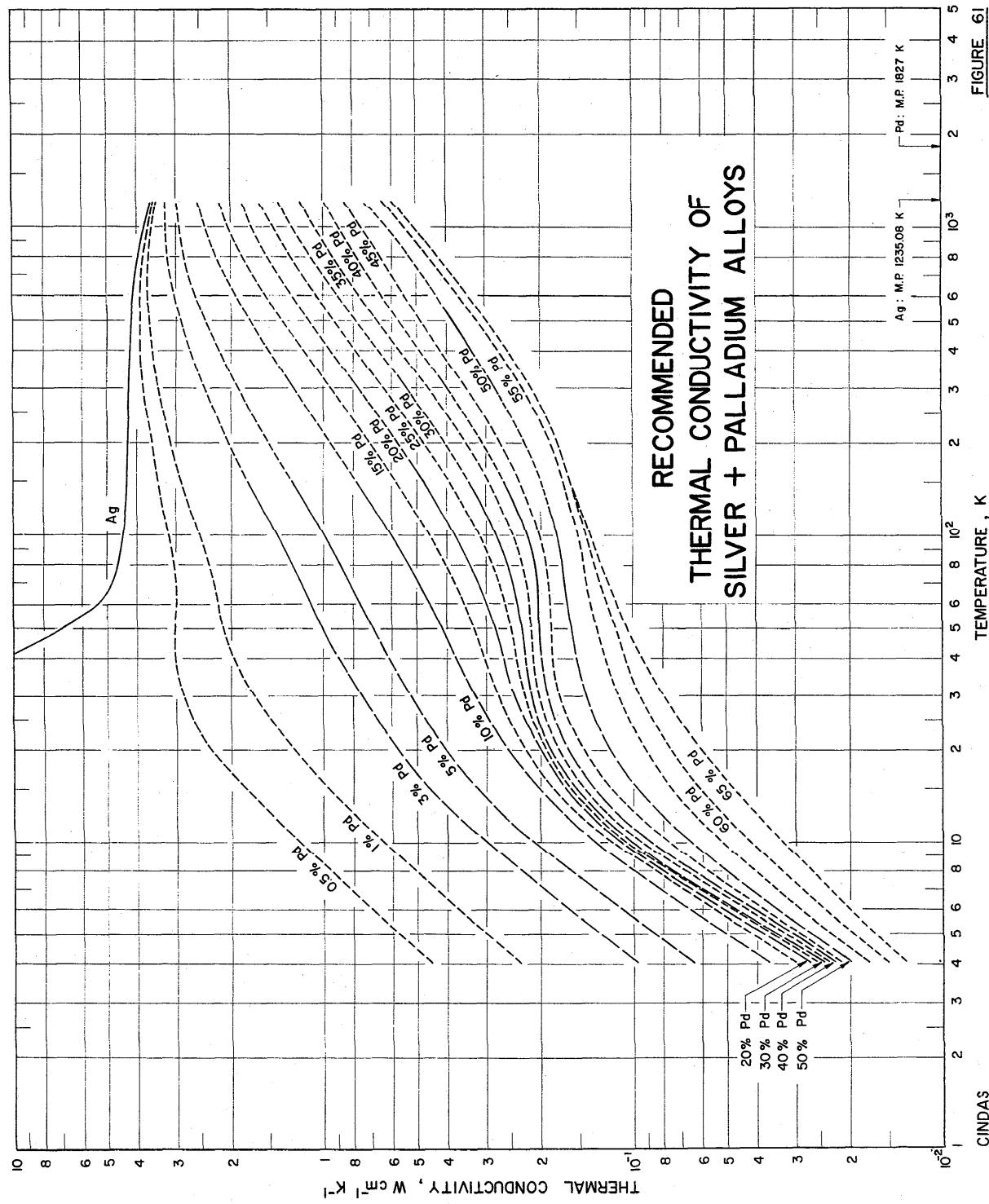
\* In temperature range where no experimental thermal conductivity data are available.

TABLE 28. RECOMMENDED THERMAL CONDUCTIVITY OF SILVER-PALLIUM ALLOY SYSTEM (continued)<sup>†</sup>[Temperature, T, K; Thermal Conductivity, k, W cm<sup>-1</sup> K<sup>-1</sup>; Electronic Thermal Conductivity, k<sub>e</sub>, W cm<sup>-1</sup> K<sup>-1</sup>; Lattice Thermal Conductivity, k<sub>g</sub>, W cm<sup>-1</sup> K<sup>-1</sup>]

Ag: 0.50% (.49 At.%) Pd: 99.50% (99.51 At.%)			
$\rho_0 = 0.660 \mu\Omega\text{cm}$			
T	k	k <sub>e</sub>	k <sub>g</sub>
4		0.148	
6		0.222	
8		0.296	
10		0.370	
15		0.555	
20		0.740	
25		0.703	
30		0.743	
40		0.757	
50		0.705	
60		0.642	
70		0.601	
80		0.577	
90		0.572	
100		0.563	
150		0.534	
200		0.529	
250		0.534	
273		0.540	
300	0.686*	0.551	0.134
350	0.694*	0.577	0.117
400	0.705*	0.602	0.103
500	0.732*	0.648	0.0837
600	0.767*	0.697	0.0704
700	0.802*	0.742	0.0607
800	0.838*	0.785	0.0533
900	0.878*	0.831	0.0475
1000	0.912*	0.869	0.0429
1100	0.949*	0.910	0.0391
1200	0.988*	0.952	0.0359

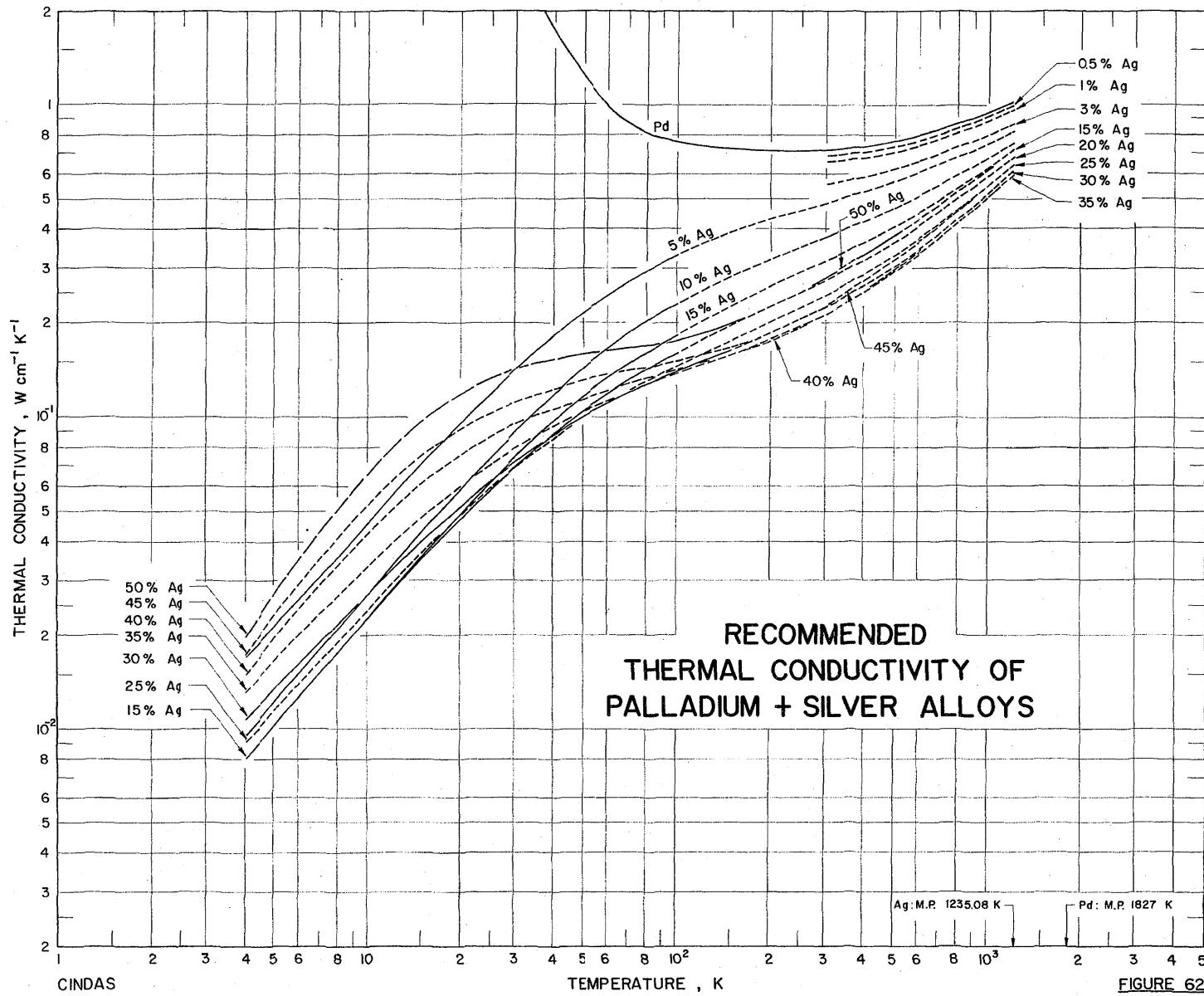
<sup>†</sup> Uncertainties in the total thermal conductivity, k, are as follows:0.50 Ag - 99.50 Pd:  $\pm 10\%$ .

\* In temperature range where no experimental thermal conductivity data are available.



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FIGURE 6



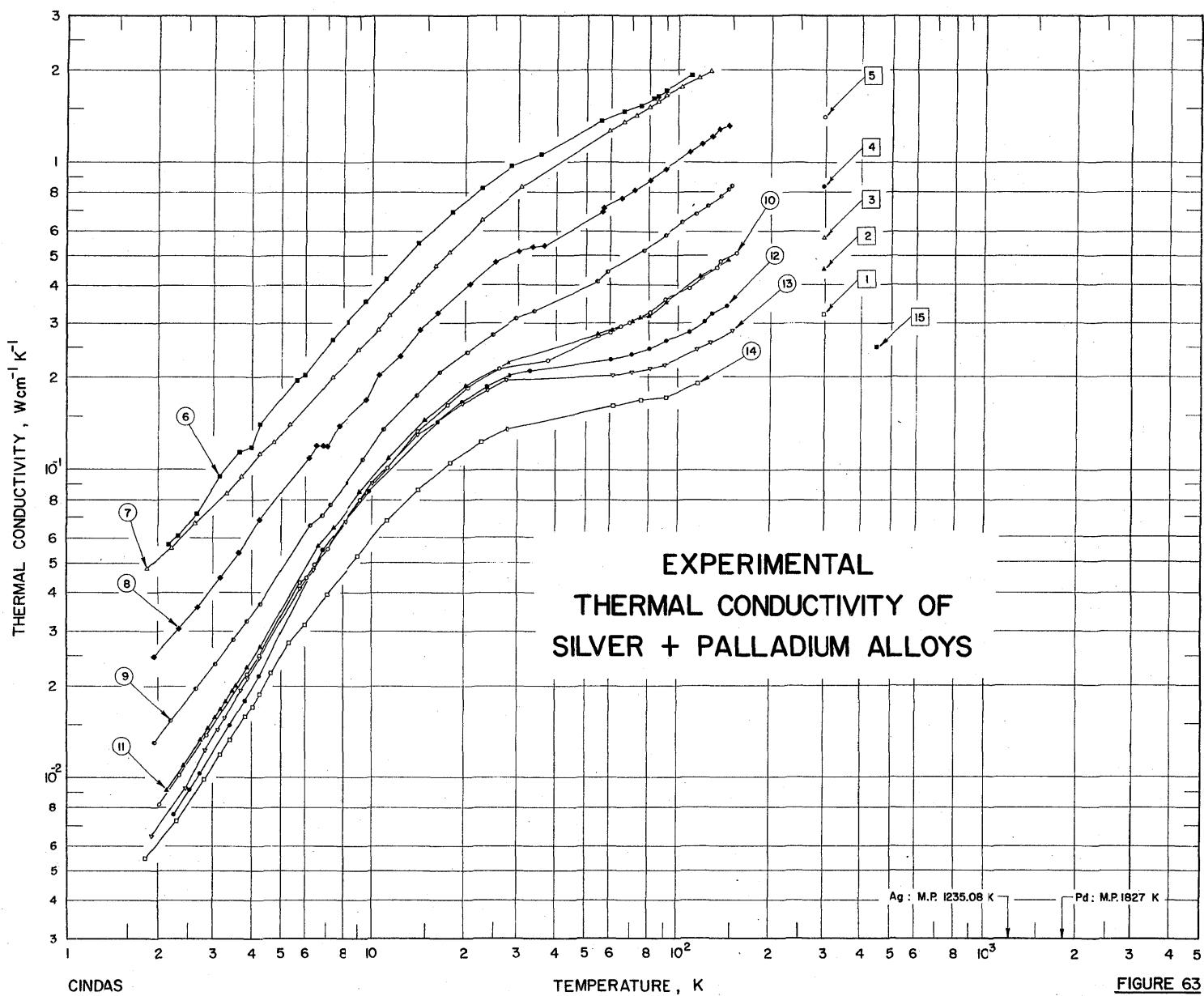


FIGURE 63

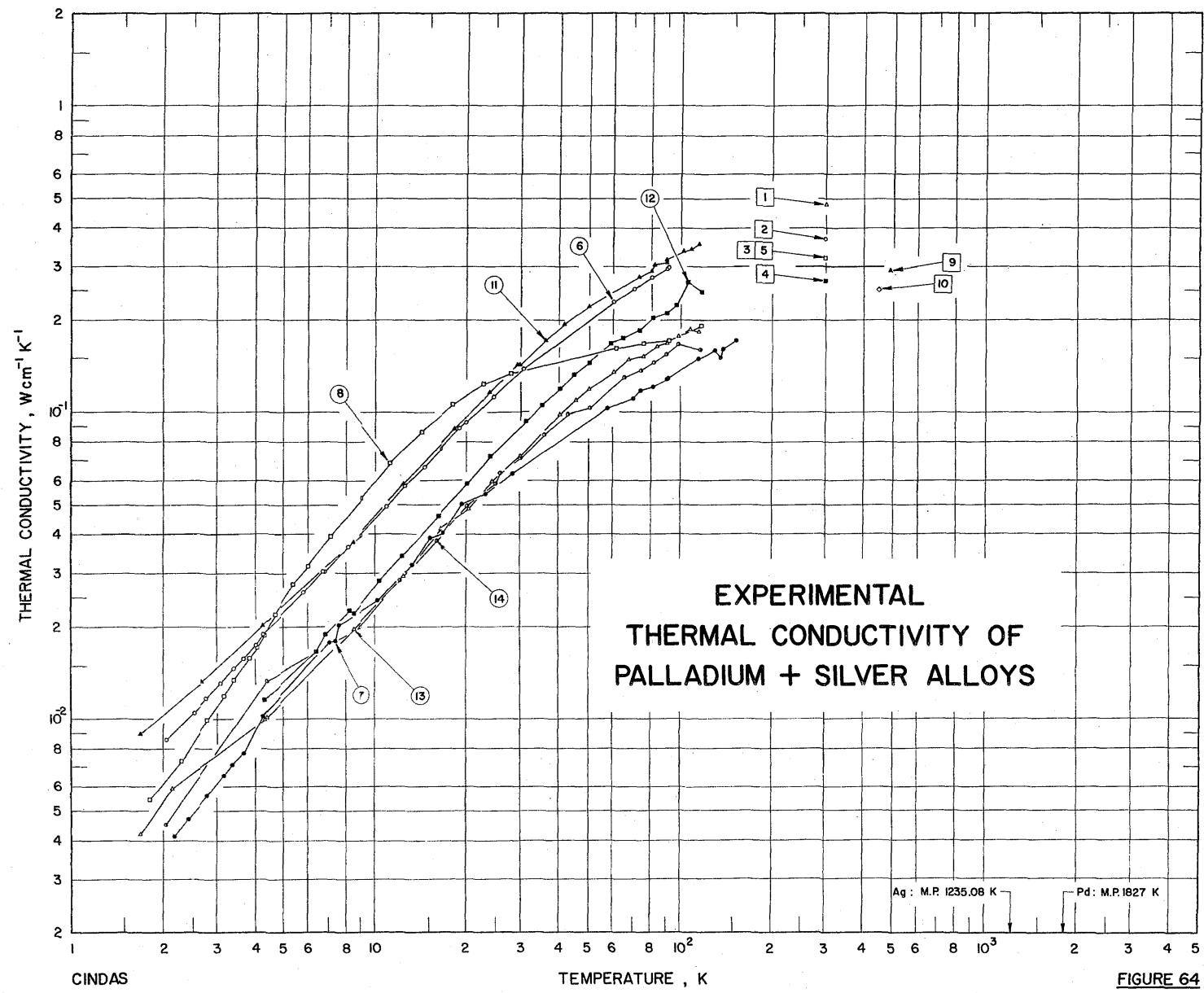


TABLE 29. THERMAL CONDUCTIVITY OF SILVER + PALLADIUM ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent) Ag      Pd	Composition (continued), Specifications, and Remarks
1	93	Schulze, F.A.	1911	E	298.2		50      50	1 mm wire specimen obtained from Firma Heraeus; electrical conductivity $3.03 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 25 C.
2	93	Schulze, F.A.	1911	E	298.2		60      40	1 mm wire specimen obtained from Firma Heraeus; electrical conductivity $4.56 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 25 C.
3	93	Schulze, F.A.	1911	E	298.2		70      30	1 mm wire specimen obtained from Firma Heraeus; electrical conductivity $6.43 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 25 C.
4	93	Schulze, F.A.	1911	E	298.2		80      20	1 mm wire specimen obtained from Firma Heraeus; electrical conductivity $9.47 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 25 C.
5	93	Schulze, F.A.	1911	E	298.2		90      10	1 mm wire specimen obtained from Firma Heraeus; electrical conductivity $16.14 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 25 C.
6	110	Kemp, W.R.G., Klemens, P.C., Sreedhar, A.K. and White, G.K.	1956	L	2.2-112		97.95      2.05	Rod specimen supplied by Johnson, Matthey and Co., Ltd.; annealed at 610 C; residual electrical resistivity $0.89 \mu\Omega \text{ cm}$ ; electrical resistivity $2.52 \mu\Omega \text{ cm}$ at 293 K.
7	110	Kemp, W.R.G., et al.	1956	L	1.8-128			The above specimen; strained; residual electrical resistivity $0.94 \mu\Omega \text{ cm}$ ; electrical resistivity $2.54 \mu\Omega \text{ cm}$ at 293 K.
8	110	Kemp, W.R.G., et al.	1956	L	1.9-147		95.01      4.99	Rod specimen supplied by Johnson, Matthey and Co., Ltd.; annealed at 610 C; residual electrical resistivity $2.20 \mu\Omega \text{ cm}$ ; electrical resistivity $3.91 \mu\Omega \text{ cm}$ at 293 K.
9	110	Kemp, W.R.G., et al.	1956	L	2.0-150		90.22      9.78	Rod specimen supplied by Johnson, Matthey and Co., Ltd.; annealed at 650 C; residual electrical resistivity $4.15 \mu\Omega \text{ cm}$ ; electrical resistivity $6.0 \mu\Omega \text{ cm}$ at 293 K.
10	110	Kemp, W.R.G., et al.	1956	L	2.3-157		80.14      19.86	Rod specimen supplied by Johnson, Matthey and Co., Ltd.; annealed at 650 C.
11	110	Kemp, W.R.G., et al.	1956	L	2.1-147		80.14      19.86	Rod specimen supplied by Johnson, Matthey and Co., Ltd.; annealed at 800 C; residual electrical resistivity $8.45 \mu\Omega \text{ cm}$ ; electrical resistivity $10.0 \mu\Omega \text{ cm}$ at 293 K.
12	110	Kemp, W.R.G., et al.	1956	L	2.2-145		70.67      29.33	Rod specimen supplied by Johnson, Matthey and Co., Ltd.; annealed at 800 C; residual electrical resistivity $12.78 \mu\Omega \text{ cm}$ ; electrical resistivity $14.66 \mu\Omega \text{ cm}$ at 293 K.
13	110	Kemp, W.R.G., et al.	1956	L	1.9-151		60.33      39.67	Rod specimen supplied by Johnson, Matthey and Co., Ltd.; annealed at 880 C; residual electrical resistivity $18.10 \mu\Omega \text{ cm}$ ; electrical resistivity $21.1 \mu\Omega \text{ cm}$ at 293 K.
14	110	Kemp, W.R.G., et al.	1956	L	1.8-117		50.34      49.66	Rod specimen supplied by Johnson, Matthey and Co., Ltd.; annealed at 880 C; residual electrical resistivity $27.7 \mu\Omega \text{ cm}$ ; electrical resistivity $27.7 \mu\Omega \text{ cm}$ at 293 K.
15	112	Zolotukhin, G.E.	1956	L	448.2		50.34      49.66	$0.66 \text{ cm}^2$ in cross-section and 1.35 cm long.

TABLE 29. THERMAL CONDUCTIVITY OF SILVER + PALLADIUM ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION (continued)

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent) Ag      Pd	Composition (continued), Specifications, and Remarks
16*	111	Tainsh, R.J. and White, G.K.	1962	L	2.2-7.9		97.95      2.05	The specimen for curve no. 6 has been reannealed at 940 C in an effort to ensure that dislocation density is reduced to a minimum; rod specimen of about 6 cm long and 3 to 5 mm in diameter; electrical resistivity reported as 0.962, 1.372, and 2.612 $\mu\Omega$ cm at 0, 90, and 293 K, respectively.
17*	111	Tainsh, R.J. and White, G.K.	1962	L	2.1-8.3		95.01      4.99	The specimen for curve no. 8 has been reannealed at 940 C in an effort to ensure that dislocation density is reduced to a minimum; rod specimen of about 6 cm long and 3 to 5 mm in diameter; electrical resistivity reported as 2.28, 2.68, and 3.87 $\mu\Omega$ cm at 0, 90, and 293 K, respectively.
18*	111	Tainsh, R.J. and White, G.K.	1962	L	2.3-7.9		90.22      9.78	The specimen for curve no. 9 has been reannealed to 940 C in an effort to ensure that dislocation density is reduced to a minimum; rod specimen of about 6 cm long and 3 to 5 mm in diameter; electrical resistivity reported as 4.37, 4.78, and 6.01 $\mu\Omega$ cm at 0, 90, and 293 K, respectively.

\* Not shown in figure.

TABLE 30. THERMAL CONDUCTIVITY OF PALLADIUM + SILVER ALLOYS -- SPECIMEN CHARACTERIZATION AND MEASUREMENT INFORMATION

Cur. No.	Ref. No.	Author(s)	Year	Method Used	Temp. Range, K	Name and Specimen Designation	Composition (weight percent) Pd      Ag	Composition (continued), Specifications, and Remarks	
1	93	Schulze, F.A.	1911	E	298.2		90      10	1 mm thick wire specimen obtained from Heraeus Co.; electrical conductivity $4.71 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 25 C.	
2	93	Schulze, F.A.	1911	E	298.2		80      20	1 mm thick wire specimen obtained from Heraeus Co.; electrical conductivity $3.21 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 25 C.	
3	93	Schulze, F.A.	1911	E	298.2		70      30	1 mm thick wire specimen obtained from Heraeus Co.; electrical conductivity $2.56 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 25 C.	
4	93	Schulze, F.A.	1911	E	298.2		60      40	1 mm thick wire specimen obtained from Heraeus Co.; electrical conductivity $2.38 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 25 C.	
5	93	Schulze, F.A.	1911	E	298.2		50      50	1 mm thick wire specimen obtained from Heraeus Co.; electrical conductivity $3.03 \times 10^4 \Omega^{-1} \text{ cm}^{-1}$ at 25 C.	
6	110	Kemp, W.R.G., Klemens, P.G., Sreedhar, A.K., and White, G.K.	1956	L	2.1-92		95      5	Rod specimen supplied by Johnson, Matthey and Co., Ltd.; annealed at 880 C; residual electrical resistivity $5.81 \mu\Omega \text{ cm}$ ; electrical resistivity $16.8 \mu\Omega \text{ cm}$ at 293 K.	
7	110	Kemp, W.R.G., et al.	1956	L	2.2-152		70      30	Similar to the above specimen except residual electrical resistivity $35.6 \mu\Omega \text{ cm}$ and electrical resistivity $40.9 \mu\Omega \text{ cm}$ at 293 K.	
8	110	Kemp, W.R.G., et al.	1956	L	1.8-117		50      50	Similar to the above specimen except residual electrical resistivity $27.7 \mu\Omega \text{ cm}$ and electrical resistivity $30.5 \mu\Omega \text{ cm}$ at 293 K.	
9	112	Zolotukhin, G.E.	1956	L	486.7		75      25	Cylindrical specimen.	
10	112	Zolotukhin, G.E.	1956	L	448.2		50      50	Cylindrical specimen.	
11	84	Fletcher, R. and Greig, D.	1967	L	1.7-117		4.84	Calculated composition from atomic percent; specimen lent by International Nickel Ltd.; annealed at 700 C for 24 hrs previously; outgassed at 500 C for 4-5 hrs; residual electrical resistivity reported as $5.92 \mu\Omega$ ; original data obtained through private communication with author.	
12	84	Fletcher, R. and Greig, D.	1967	L	4.3-118		9.85	Similar to the above specimen except the residual electrical resistivity reported as $12.18 \mu\Omega \text{ cm}$ .	
13	84	Fletcher, R. and Greig, D.	1967	L	1.7-115		15.05	Similar to the above specimen except the residual electrical resistivity reported as $18.0 \mu\Omega \text{ cm}$ .	
14	84	Fletcher, R. and Greig, D.	1967	L	2.1-116		20.53	Similar to the above specimen except the residual electrical resistivity reported as $24.5 \mu\Omega \text{ cm}$ .	

## 5. Conclusions and Recommendations

As evidenced by the exhaustively compiled experimental thermal conductivity data presented in this work for the ten selected binary alloy systems which are among those investigated most extensively, it is clear that even for these alloy systems serious gaps still exist in the thermal conductivity data for both the temperature and composition dependences and that most of the available data are widely divergent and subject to large uncertainty. The resulting recommended self-consistent thermal conductivity values that cover the full range of composition and temperature, therefore, go far beyond the limited experimental data.

In addition to the total thermal conductivity, recommended values are given also separately for the electronic and lattice components, for the very procedure used in the present study is based on the existence of the two components of thermal conductivity and the need to trace the dependence of each component separately on temperature and composition. If there is a dispute about the separation of the conductivity into components, the present work will help to clarify the matter, for it looks, for the first time, at the totality of the existing data, and points out what is necessary to reconcile it. By giving the separate components, this work makes it possible for the reader to trace the procedure used to generate the recommended values, and makes it possible to estimate the effects on thermal conductivity of changes in electrical resistivity and changes due to imperfections which primarily affect the lattice component. Furthermore, by pointing out the relative contribution of each component, this work allows the reader to judge how critical some of the approximations are in different temperature regions.

The recommended values are for alloys which are not ordered and have not been cold worked severely; the values would be higher for ordered alloys and lower at low temperatures for cold-worked alloys. For each of the alloy systems except two, the recommended values are given for 25 alloy compositions, which greatly facilitates interpolation for alloys with intermediate compositions.

The recommended values are based upon both the critically evaluated, analyzed, and synthesized experimental data and the calculated values generated by using the methods developed in this study for the calculation of the thermal conductivity of alloys. The methods developed are essentially semi-empirical since they require experimental information as input for calculations and adjustments. The reliability of the methods has been extensively tested using selected key sets of experimental data, which are considered reliable through critical evaluation and analysis, on alloys in the various binary alloy systems.

The method for the calculation of the electronic thermal conductivity is applicable for all temperatures to all types of binary alloys: non-transition, transition, solid solution, mechanical mixture, ordered, and disordered. The method for the calculation of the lattice thermal conductivity is applicable only to disordered solid-solution alloys at moderate and high temperatures. For ordered alloys, alloys of mechanical mixture, and for solid-solution alloys at low temperatures in the

region of the lattice conductivity maximum and below, there is no adequate method available for the calculation of the lattice thermal conductivity, and at present the lattice thermal conductivity must be derived from experimental data.

In the course of this study, a number of areas where further theoretical and experimental research is needed are identified. These areas of further research are recommended and listed below:

- (1) Experimental and theoretical work on band structure effects in binary alloys of transition elements and noble elements—in particular measurements on Cu + Pd and Pd + Cu alloys to determine the validity of large Lorenz ratios reported for this system.

- (2) Development of quantitative theory of impurity enhancement of phonon-electron interactions at low temperatures.

- (3) Measurements of alloy thermal conductivity down to liquid <sup>3</sup>He temperatures to determine the extent to which residual dislocations cause the cusp-like behavior of the composition dependence of the low-temperature lattice thermal conductivity.

- (4) Development of a theory of low-temperature lattice conduction in transition elements and high-residual-resistivity alloys.

- (5) Experimental and theoretical efforts on the lattice conductivity outside the region of solid solubility.

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